

## GENERAL <br> INSTRUMENT

# Microelectronics Data Catalog 

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# Index 1 <br> Part Number Index <br> Functional Index 





| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
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| 128K ROM | 131,072 bits organized 16,384 $\times 8$ | RO9128B/C/D | 2-28 |
| 256 K ROM | 262,144 bits organized $32,768 \times 8$ | RO9256 | 2-31 |
| $\begin{gathered} \text { 20K CARTRIDGE } \\ \text { ROM } \\ \hline \end{gathered}$ | 20,480 bits organızed $2048 \times 10$ | RO-3-9504 | 2-32 |
|  | 40,960 bits organized $4096 \times 10$ | RO9508 | 2-34 |
| $\begin{gathered} \hline \text { 80K CARTRIDGE } \\ \text { ROM } \\ \hline \end{gathered}$ | 81,920 bits organızed $8192 \times 10$ | R09580 | 2-37 |
| 160K CARTRIDGE ROM | 163,840 bits organızed 16,384 $\times 10$ | R09160 | 2-39 |
| Keyboard Encoder |  |  |  |
| CAPACITIVE KEYBOARD ENCODER | 4,592 bits organized as 112 keys $\times 4$ modes $\times 10$ bits, plus 112 bits for internal programing of function keys | AY-3-4592 | 2-42 |
|  |  | Character Generators |  |
| CHARACTER GENERATOR | 2,560 bits organized a $64-5 \times 8$ characters | RO-3-2513 | 2-54 |
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|  |  | Speech ROMs |  |
| SERIAL SPEECH ROM | 16,384 bits organızed $2048 \times 8$ | SPR016 | 2-64 |
|  | 32,768 bits organized $4096 \times 8$ | SPR032 | 2-70 |
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| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| Electrically Alterable Non-Volatile Memory |  |  |  |
| 82 BIT EAROM | 82 bits organızed $82 \times 1$ | ER0082 | 3-5 |
| $\begin{gathered} 700 \text { BIT } \\ \text { SERIAL EAROM } \end{gathered}$ | 700 bits organızed $50 \times 14$ | ER1451 | 3-8 |
| 1400 BIT SERIAL EAROM | 1400 bits organızed $100 \times 14$ | ER1400 | 3-11 |
| 512 BIT EAROM | 512 bits organized $32 \times 16$ | ER2051 | 3-14 |
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| 512 BIT EAROM | 512 bits organized $64 \times 8$ | ER2055 | 3-17 |
|  |  | ER2055IR | 3-17 |
|  |  | ER2055HR | 3-17 |
| 1K N-CHANNEL EEPROM | 1 K bits organızed $128 \times 8$ | ER5901 | 3-20 |
|  |  | ER5901IR | 3-20 |
|  |  | ER5901HR | 3-20 |
| 4096 BIT EAROM | 4096 bits organızed $1024 \times 4$ | ER3400 | 3-22 |
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| 16K N-CHANNEL EEPROM | 16K bits organized $2048 \times 8$ | ER5716 | 3-32 |
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| WORD ALTERABLE 16K BIT EEPROM | Electrically word alterable 16 K bits organized $2048 \times 8,5 \mathrm{~V}$ operation in read mode | ER5816 | 3-36 |
|  |  | ER5816IR | 3-36 |
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| WORD ALTERABLE 16K BIT EEPROM | Electrıcally word alterable 16 K bits organızed $2048 \times 8,5 \mathrm{~V}$ operation in all modes | ER5916 | 3-41 |
|  |  | ER5916IR | 3-41 |
|  |  | ER5916HR | 3-41 |
| Non-Volatile Static RAM |  |  |  |
| 4K N-CHANNEL NON-VOLATILE STATIC RAM | 4 K bits organized $512 \times 8$ | ER5304 | 3-48 |


| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
|  |  | PIC Series |  |
| $\begin{gathered} 8 \text { BIT } \\ \text { MICROCOMPUTER } \end{gathered}$ | The PIC1650 series of microcomputers contain RAM I/O and a central processing unit as well as a customer defined ROM to specify overall functional characteristics of the device | PIC1650A | 4-4 |
|  |  | PIC1650XT | 4-16 |
|  |  | PIC1654 | 4-28 |
|  |  | PIC1655A | 4-38 |
|  |  | PIC1655XT | 4-50 |
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|  |  | PIC1656 | 4-72 |
|  |  | PIC1670 | 4-85 |
| PIC Development Series |  |  |  |
| DEVELOPMENT MICROCOMPUTER | PIC microcomputer without ROM and with addition of a HALT pin. | PIC1664 | 4-96 |
|  |  | PIC16C63 | 4-110 |
|  |  | PIC1665 | 4-121 |
|  |  | PICAL/PICES II |  |
| PIC ASSEMBLER | Converts symbolic source programs for PIC series into object code | PICAL | 4-132 |
| $\begin{gathered} \text { PIC DEVELOPMENT } \\ \text { SYSTEM } \end{gathered}$ | In-circuit emulation and debug system-stand alone or peripheral. | PICES II | 4-134 |
| PIC Field Demo Systems |  |  |  |
| $\begin{aligned} & \hline \text { PIC FIELD DEMO } \\ & \text { SYSTEMS } \end{aligned}$ | Contains PIC microcomputer, PROMs and provisions for on-board RC oscillator or external clock | PFD Systems | 4-138 |



| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
|  |  | Speech Synthesis |  |
| NARRATOR'" SPEECH PROCESSOR | Natural speech, stand alone operation, wide operating voltage, expandable ROM, simple interface. | SP0256 | 5-5 |
|  |  | SP0256-AL2 | 5-9 |
|  |  | SP0232 | 5-9 |
|  |  | SPR000 | 5-9 |
| VOICE SYNTHESIS MODULE | Complete speech system, 16 seconds of speech, custom vocabularies, simple interface, 5 V operation | VSM2032 | 5-10 |
| SPEECH SYNTHESIZER | High quality speech, programmable filter, 5V operation, simple interface, double buffered input. | SP0250 | 5-12 |
| SPEECH FIELD DEVELOPMENT BOARD | 5 V operation, expandable EPROM, multiple speech synthesis, on-board oscillator. | SFD2000 | 5-15 |
|  |  | Sound Generation |  |
| PROGRAMMABLESOUNDGENERATOR | Full software control, 5 V operation, simple interface, triple analog output, general purpose I/O ports. | AY-3-8910 | 5-18 |
|  |  | AY-3-8912 | 5-18 |
|  |  | AY-3-8913 | 5-18 |
| TUNES SYNTHESIZER | Produces musical tunes from pre-programmed microcomputer | AY-3-1350 | 5-24 |


| FUNCTION | DESCRIPTION | $\begin{aligned} & \text { PART } \\ & \text { NUMBER } \end{aligned}$ | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| Dialers |  |  |  |
| PUSHBUTTON TELEPHONE DIALERS | Converts pushbutton input to rotary dial pulses. | AY-5-9151A/B | 6 -4 |
|  |  | AY-5-9152/B | 6-4 |
|  |  | AY-5-9153A/B | 6-4 |
|  |  | AY-5-9154A | 6-4 |
| LOOP DISCONNECT <br> DIALER | Pushbutton-rotary dial converter with re-dial. | AY-5-9158 | 6-11 |
| MULTI-FREQUENCY DIALER | Dialer with dual tone. | AY-5-9559 | 6-14 |
| Multi-Frequency Generators |  |  |  |
| $\qquad$ | Generates DTMF/tone telephone frequencies. | AY-3-9400 | 6-18 |
|  |  | AY-3-9410 | 6-18 |
|  |  | Code Conversion |  |
| CODEC | Duplex Delta-Sigma/PCM converter. | AY-3-9900 | 6-22 |
|  |  | Programmable Dialers |  |
| PROGRAMMABLE MICRO-COMPUTER TELEPHONE DIALERS | Single chip microcomputer pre-programmed for in-telephone applications. | TZ-2001 | 6-30 |
|  |  | TZ-2002 | 6-30 |
|  |  | TZ-2003 | 6-30 |

## Data Communications 7

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
|  |  | UAR/T Devices |  |
| UAR/T | Complete 5-8 bit receiver/transmitter interface. | AY-3-1015D | 7-4 |
| DUAL BAUD RATE GENERATORS | 16 Frequency, UART/USRT compatible. | AY-5-8116 | 7-13 |
|  |  | AY-5-8116T | 7-13 |
|  |  | AY-5-8136 | 7-13 |
|  |  | AY-5-8136T | 7-13 |
|  |  | Clocks |  |
| 4 DIGIT CLOCK RADIO | 12/24 Hour clock, 24 hour alarm, sleep timer, battery standby. | CK3300 | 7-18 |
|  |  | Appliances |  |
| DIGITAL THERMOMETER | Digital thermometer and temperature controller. | AY-3-1270 | 7-32 |
|  |  | Remote Control |  |
| REMOTE CONTROL TRANSMITTER | 256 Command PCM infrared transmitter. | AY-3-8470 | 7-42 |
| REMOTE CONTROL RECEIVER | 256 Command PCM infrared receiver. | AY-3-8475 | 7-48 |


| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| Uncommitted Logic Arrays |  |  |  |
| HIGH SPEED CMOS UNCOMMITTED LOGIC ARRAYS | Single mask, 5 ns gate delay, single supply voltage, CMOS technology, on-chip power-on reset. | LA03 | 8-3 |
|  |  | LA05 | 8-3 |
|  |  | LA10 | 8-3 |
|  |  | LA15 | 8-3 |
|  |  | LA20 | 8-3 |

Video 9

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
|  |  | Video Display |  |
| TELEVIEW SYSTEM | The Teleview system is a powerful system to display information on a TV receiver. It can store data from either telephone lines or TV RF signal information. | TELEVIEW System | 9-4 |
|  |  | PIC1650A | 9-9 |
|  |  | PIC1650-536 | 9-15 |
|  |  | AY-3-9710 | 9-28 |
|  |  | AY-3-9735 | 9-33 |
|  |  | Video Graphics |  |
| PERSONAL TERMINAL | The 8900 system is a programable video display system, capable of detailed graphics definition and manipulation | General Information | 9-42 |
|  |  | CP1610 | 9-22 |
|  |  | AY-3-8900 | 9-43 |
|  |  | AY-3-8900-1 | 9-43 |
|  |  | RO-3-9502 | 9-46 |
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|  |  | RO-3-9600 | 9-51 |
|  |  | RO-3-9504 | 9-54 |
|  |  | AY-3-8910 | 9-56 |
|  |  | AY-3-8912 | 9-56 |
|  |  | AY-3-8913 | 9-56 |
|  |  | AY-3-8915 | 9-57 |
|  |  | Video Games |  |
| BALL \& PADDLE | Six selectable games for one or two players, with vertical paddle motion | AY-3-8500 | 9-60 |
|  |  | AY-3-8500-1 | 9-60 |
| 8600 SERIES | The 8600 series games consist of a set of single chip TV game integrated circuits. | General Information | 9-63 |
| ROADRACE | One or two player games where racing skill in "traffic" generates the highest score. | AY-3-8603 | 9-64 |
| WARFARE | One or two player games featuring subs, destroyers, cargo ships, and spaceships. | AY-3-8605 | 9-65 |
| WIPEOUT | One or two player games where players "wipe out" objects by controlling a ball in the play area. | AY-3-8606 | 9-66 |
| SHOOTING GALLERY | Twelve games for one or two players using external photocell rifles for shooting. | AY-3-8607 | 9-68 |
| SUPERSPORT | Ten selectable games for one or two players, with vertical and horizontal paddle motion. | AY-3-8610 | 9-70 |
| MOTOR CYCLE | One player cycle game with variable skill selection. | AY-3-8765 | 9-72 |


| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
|  |  | Television |  |
| ECONOMEGA IIA DIGITAL TUNING SYSTEM | Provides electronic control of a varactor tuned TV from keyboard entry. | AY-3-8211 | 10-4 |
| FREQUENCY LOCKED LOOP TUNING SYSTEMS | Provides frequency locked loop tuning in radio, TV applications. | Economega III | 10-8 |
| PHASED LOCKED LOOP TUNING SYSTEM SYNTHESIZER | Provides PLL frequency synthesis for color TV tuning. | Economega IV | 10-19 |
|  |  | AY-3-2012 | 10-22 |
|  |  | CT2010 | 10-27 |
|  |  | CT2017 | 10-29 |
| PHASED LOCKED LOOP TV TUNING SYSTEM CONTROL | Provides control and interface for PLL television tuning | PIC1650-020 | 10-33 |
|  |  | ER1400 | 10-33 |
|  | Synthesizer/Counter |  |  |
| FREQUENCY SYNTHESIZER/ COUNTER | Provides a time base for frequency synthesizer countıng. | AY-5-8105 | 10-44 |
|  |  | EAROM |  |
| 512 BIT EAROM | 512 bits organızed $32 \times 16$. | ER2051 | 10-48 |
|  |  | ER2051 IR | 10-48 |
|  |  | ER2051 HR | 10-48 |



| FUNCTION | : DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
|  | , . . . . . | Read Only Memories |  |
| 16K ROM | 16,384 bits organized $2048 \times 8$ | RO-3-9316A/B/C | 2-4 |
|  |  | RO-3-9316HP | 244 |
| 32 K ROM | 32,768 bits organized 409 | RO-3-9332A/B/C | 2-7 |
|  |  | RO-3-9332HP | $2-7$ |
|  |  | RO-3-98338/C | 2-10 |
|  |  | RO-3-9333HR | 2-10 |
|  |  | RO9432B/C/D | 2-12 |
|  |  | RO94338/C/D | 2-14 |
| 64 K ROM | 65,536 bits organized $8192 \times 8$ | RO-3-93648/C | 2-16 |
|  |  | BO-3-9364HR | 2-16 |
|  |  | A0, 3-9365B/C | 2-19 |
|  |  | RO9464B/C/D | 2-22 |
|  |  | H09464AB/AC/AD | 2-22 |
|  |  | RO9B64B/C/D | 2-25 |
|  |  | R09864AB/AC/AD | 2-25 |
| 128 K ROM | 131,072 bits organized $16,384 \times 8$ | RO9128B/C/D | 2-28 |
| 256 K ROM | 262, 144 bits organized $32,768 \times 8$ | RO9256 | 2-31 |
| $\begin{gathered} \text { 20K CARTRIDGE } \\ \text { ROM } \\ \hline \end{gathered}$ | 20,480 bits organized $2048 \times 10$ | RO-3-9504 | 2-32 |
| 4OK CARTRIDGE ROM | 40,960 bits organized $4096 \times 10$ | RO9508 | 2-34 |
| $\begin{aligned} & \text { 80K CARTRIDGE } \\ & \text { ROM } \\ & \hline \end{aligned}$ | 81,920 bits organized $8192 \times 10$ | RO9580 | 2-37 |
| 160K CARTRIDGE <br> - ROMA | 163,840 bits organized $16,384 \times 10$ | RO9160 | $\therefore 289$ |
| K, Keyboard Encoder |  |  |  |
| CAPACITIVE KEYBOARD ENCODER | 4,592 bits organized as 112 keys $\times 4$ modes $\times 10$ bits, plus 112 bits for internal programing of function keys. | AY-3-4592 | 2-42 |
| ... | $\because$, $\because$ | Character Cenerators |  |
| CHARACTER GENERATOR | 2,560 bits organized a 64-6 $\times 8$ characters | RO-3-2513 | 2.54 |
|  | 16,384 bits organized as 2048-8, bit words | BO-3-9316CGII | 259 |
|  | , , | Speech ROMs |  |
| $\begin{gathered} \text { SERIAL } \\ \text { SPEECH } \\ \text { ROM } \end{gathered}$ | 16,384 bits organized $2048 \times 8$ | SPRO16 | 2-64 |
|  | 32,768 bits organized $4096 \times 8$ | SPR032 | 2-70 |
|  | 131,072 bits organized $16 \mathrm{~K} \times 8$ | SPR128 | 2.73 |



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2-2
$$

## GENERAL <br> INSTRUMENT

## Read Only Memories

| - UNCTION | DESCRIPTION | PART NUMBER | PACE NUMBER |
| :---: | :---: | :---: | :---: |
| 困相ROM | 16,384 bits organized $2048 \times 8$ | RO-3-9316A/B/C | 2-4 |
|  |  | RO-3-9316HR | 244 |
| $32 K$ ROM | 32,768 bits organized $4096 \times 8$ | RO-3-9332A/B/C | 2-7 |
|  |  | HO-3-9332 HR | $2-7$ |
|  |  | RO-3-9333B/C | $2 \cdot 10$ |
|  |  | RO-3-9333HR | 2-10 |
|  |  | RO9432E/C/D | 2-12 |
|  |  | RO9433E/C/D | 2-14 |
| 64 K ROM | 65,536 bits organtzed $8192 \times 8$ | RO-3-9364B/C | 2-16 |
|  |  | nO-3-9364HR | 2-16 |
|  |  | RO-3-9365B/C | 2 19 |
|  |  | RO9464B/C/D | 2-22 |
|  |  | RO9464AD/AC/AD | $2-22$ |
|  |  | RO9864B/C/D | 2-25 |
|  |  | RO9864AB/AC/AD | 225 |
| - 128KROM | 431,072 bits organized $16.384 \times 8$ | RO912ab/C/D | 228 |
| 256K ROM | 262,144 bits organized $32.768 \times 8$ | HO9356 | 231 |
| 20 CARTRIDGE ROM. | 20,480 bits organized $2048 \times 10$ | RO-3-9504 | 2-32 |
| ZOKCARTRIDGE ROM | 40,960 bits organized $4096 \times 10$ | h09508 | 2-34 |
| BOKCARTAIDGE | 81.920 bits organized $8192 \times 10$ | H09580 | 2-37 |
| 160K CAFTRIDGE | 163,840 bits orgänized $16.384 \times 10$ | RO9160 | 39 |

## 16,384 Bit Static Read Only Memory

## FEATURES

- $2048 \times 8$ Organization - Ideal for Microprocessor Memory Systems
- Single +5 Volt Supply
- TTL Compatible - All Inputs and Outputs
- Static Operation - No Clocks Required
- 850ns Maximum Access Time: RO-3-9316A
- 450ns Maximum Access Time: RO-3-9316B
- 350ns Maximum Access Time: RO-3-9316C
- Three-State Outputs - Under the Control of Three Mask-Programable Chip Select Inputs to Simplify Memory Expansion
- Totally Automated Custom Programing
- Zener Protected Inputs
- Glass Passivation Protection
- Pin Compatible With 2716 16K EPROM


## PIN CONFIGURATION

24 LEAD DUAL IN LINE

|  | Top View |  |
| :---: | :---: | :---: |
| A7 ${ }^{1}$ | 1 O | Pvcc ${ }^{(+5 v)}$ |
| A6- 2 | 223 | As |
| A5 3 | 322 | Pa9 |
| A4 | 421 | Cs3 |
| A3 5 | $5 \quad 20$ | $\square \mathrm{Cs} 1$ |
| A2 6 | $6 \quad 19$ | A10 |
|  | $7 \quad 18$ | PCS2 |
| AOL | $8 \quad 17$ | -08 |
| 01.9 | $9 \quad 16$ | $\square 07$ |
| 0210 | $10 \quad 15$ | P06 |
| 03 -11 | $11 \quad 14$ | P05 |
| GNDC 12 | $12 \quad 13$ | P04 |

## DESCRIPTION

The General Instrument RO-3-9316 is a 16,384 static Read Only Memory organized as 2048 8-bit words and is ideally suited for microprocessor memory applications. Fabricated in the General Instrument N-Channel Ion Implant process to enable operation from a single +5 Volt power supply, the RO-3-9316 offers the best combination of high performance, large bit storage and simple interfacing.


## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$\mathrm{V}_{\mathrm{CC}}$ and input voltages (with respect to GND) . . . . -0.3 V to +8.0 V
Storage Temperature . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted)
$V_{c c}=+5$ Volts $\pm 5 \%$
Operating Temperature $\left(T_{A}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ (HR: $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ ) Output Loading: One TTL load, $\mathrm{C}_{\mathrm{L}}$ тотet $=100 \mathrm{pf}$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

RO-3-9316A/B/C © RO-3-9316HR

| Characteristic | Sym | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Address, Chip Select Inputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\text {IH }}$ | 2 | - | - | V |  |
| Logic "0" | $V_{\text {IL }}$ | - | - | 0.8 | V |  |
| Leakage | $\mathrm{I}_{\text {LI }}$ | - | - | 10 | $\mu \mathrm{A}$ |  |
| Data Outputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | - | V | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ |
| Logic "0" | $\mathrm{V}_{\text {OL }}$ | - | - | 0.4 | $\mathrm{V}$ | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Leakage | ILO | - | - | 10 | $\mu \mathrm{A}$ |  |
| Power Supply Current |  |  |  |  |  |  |
| RO-3-9316A | Icc | - | 50 | 85 | mA | Outputs open |
| RO-3-9316B | Icc | - | 65 | 115 | mA | Outputs open |
| RO-3-9316C | ICC | - | - | 125 | mA | Outputs open |
| RO-3-9316A - RO-3-9316AHR |  |  |  |  |  |  |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Address, Chip Select Inputs |  |  |  |  |  |  |
| Cycle Time | $t_{C}$ | 800 | - | - | ns |  |
| Capacitance | $\mathrm{C}_{1}$ | - | 5 | 8 | pf | $F=1 \mathrm{MHz}$ |
|  | $\mathrm{C}_{1}$ | - | 8 | 10 | pf | $\mathrm{F}=1 \mathrm{MHz} ; \mathrm{RO}-3-9316 \mathrm{AHR}$ only |
| Data Outputs |  |  |  |  |  |  |
| Access Time | $\mathrm{t}_{\mathrm{ACC}}$ | - | 600 | 850 | ns |  |
| Chip Select Response Time | $\mathrm{t}_{\mathrm{R}}$ | - | 200 | 300 | ns |  |
| Capacitance | $\mathrm{C}_{0}$ | - | 8 | 10 | pf | $F=1 \mathrm{MHz}$ |

RO-3-9316B ■ RO-3-9316BHR

| AC CHARACTERISTICS |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Address, Chip Select Inputs |  |  |  |  |  |  |
| Cycle Time | $t_{c}$ | 400 | - | - | ns |  |
| Capacitance | $\mathrm{C}_{1}$ | - | 5 | 8 | pf | $F=1 \mathrm{MHz}$ |
|  | $\mathrm{C}_{1}$ | - | 8 | 10 | pf | $\mathrm{F}=1 \mathrm{MHz} ; \mathrm{RO}-3-9316 \mathrm{BHR}$ only |
| Data Outputs |  |  |  |  |  |  |
| Access Time | $t_{\text {ACC }}$ | - | 350 | 450 | ns |  |
| Chip Select Response Time | $\mathrm{t}_{\mathrm{R}}$ | - | 100 | 200 | ns |  |
| Capacitance | $\mathrm{C}_{0}$ | - | 8 | 10 | pf | $F=1 \mathrm{MHz}$ |

RO-3-9316C $=$ RO-3-9316CHR

| AC CHARACTERISTICS |  |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Address, Chip Select Inputs <br> Cycle Time | $\mathrm{t}_{\mathrm{C}}$ | 300 | - | - | ns |  |
| Capacitance | $\mathrm{C}_{1}$ | - | 5 | 8 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |
|  | $\mathrm{C}_{1}$ | - | 8 | 10 | pf | $\mathrm{F}=1 \mathrm{MHz} ; \mathrm{RO}-3-9316 \mathrm{CHR}$ only |
| Data Outputs |  |  |  |  |  |  |
| Access Time | $\mathrm{t}_{\mathrm{Acc}}$ | - | 250 | 350 | ns |  |
| Chip Select Response Time | $\mathrm{t}_{\mathrm{R}}$ | - | 100 | 200 | ns | $\mathrm{~F}=1 \mathrm{MHz}$ |
| Capacitance | $\mathrm{C}_{\mathrm{o}}$ | - | 8 | 10 | pf | $\mathrm{FF}=1$ |

[^0]TYPICAL SYSTEM APPLICATION
A complete system of 16 K words of ROM ( 8 bits/word) is easily obtained without any external address decoding by making use of programable chip select features and by wiring the outputs of eight different RO-3-9316 as shown in the figure below.

ADDRESS BUS

CHIP SELECT TABLE

|  |  |  | DEVICE |
| :---: | :---: | :---: | :---: |
| CS3 | CS2 | CS1 | SELECTED |
| 0 | 0 | 0 | $16 K 0$ |
| 0 | 0 | 1 | $16 K 1$ |
| 0 | 1 | 0 | $16 K 2$ |
| 0 | 1 | 1 | $16 K 3$ |
| 1 | 0 | 0 | $16 K 4$ |
| 1 | 0 | 1 | $16 K 5$ |
| 1 | 1 | 0 | $16 K 6$ |
| 1 | 1 | 1 | $16 K 7$ |



* utilized as addresses $A_{11}-A_{13}$

TIMING DIAGRAMS


ACCESS TIME (ADDRESS TO OUTPUT-CHIP SELECTED)


CHIP SELECT RESPONSE TIME (ADDRESS INPUTS STABLE)

## 32,768 Bit Static Read Only Memory

## FEATURES

- $4096 \times 8$ Organization - Ideal for Microprocessor Memory Systems
- Single +5 Volt Supply
- TTL Compatible - All Inputs and Outputs
- Static Operation - No Clocks Required
- 850ns Maximum Access Time: RO-3-9332A
- 450ns Maximum Access Time: RO-3-9332B
- 350ns Maximum Access Time: RO-3-9332C
- Three-State Outputs - Under the Control of Two MaskProgramable Chip Select Inputs to Simplify Memory Expansion
- Totally Automated Custom Programing
- Zener Protected Inputs
- Glass Passivation Protection
- Pin Compatible With 2532 EPROM
- Extended Temperature Ranges


## DESCRIPTION

The General Instrument RO-3-9332 is a 32,768 static Read Only Memory organized as 4096 eight bit words and is ideally suited for microprocessor memory applications. Fabricated in the General Instrument N -Channel Ion Implant process to enable operation from a single +5 Volt power supply, the RO-3-9332 offers the best combination of high performance, large bit storage, and simple interfacing of any MOS Read-Only Memory available today.

PIN CONFIGURATION
24 LEAD DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| A7 ${ }^{-1}$ | 24 | $\mathrm{V}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| A6 2 | 23 | A8 |
| A5 3 | 22 | ]a9 |
| A4 | 21 | Pcs2 |
| $\mathrm{A}^{\mathrm{C}}$ | 20 | PCS1 |
| A2 | 19 | Pa10 |
| A1 | 18 | A11 |
| AO | 17 | - 08 |
| 01 | 16 | $\square 07$ |
| 020 | 15 | P06 |
| 03.11 | 14 | P05 |
| GND 12 | 13 | O4 |

## BLOCK DIAGRAM



## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$\mathrm{V}_{\mathrm{CC}}$ and input voltages (with respect to GND) . . . . -0.3 V to +8.0 V Storage Temperature . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

## Standard Conditions (unless otherwise noted)

$V_{c c}=+5$ Volts $\pm 10 \%$
Operating Temperature ( $T_{A}$ ) $=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
(HR: $\mathrm{T}_{A}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ )
Output Loading: Two TTL Loads, $C_{L}$ TOTAL $=100 \mathrm{pf}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standara Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

RO-3-9332A/B ■ RO-3-9332HR

| Characteristic | Sym | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Address, Chip Select Inputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | - | V |  |
| Logic "0" | $V_{\text {IL }}$ | - | - | 0.8 | V |  |
| Leakage | $I_{\text {LI }}$ | - | - | 10 | $\mu \mathrm{A}$ |  |
| Data Outputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | - | V | $\mathrm{IOH}^{\text {O }}=-200 \mu \mathrm{~A}$ |
| Logic "0" | $\mathrm{V}_{\text {OL }}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Leakage | ILO | - | - | 10 | $\mu \mathrm{A}$ |  |
| Power Supply Current |  |  |  |  |  |  |
| RO-3-9332A | Icc | - | - | 80 | mA | Outputs open |
| RO-3-9332BHR | $\mathrm{I}_{\mathrm{cc}}$ | - | - | 125 | mA | Outputs open |
| RO-3-9332C | Icc | - | - | 140 | mA | Outputs open |

RO-3-9332A

| AC CHARACTERISTICS |  |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :--- |
| Address, Chip Select Inputs <br> Cycl Time | $\mathrm{t}_{\mathrm{C}}$ | 800 | - | - | ns |  |
| Capacıtance | $\mathrm{C}_{1}$ | - | 5 | 8 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |
| Data Outputs |  |  |  |  |  |  |
| Access Tıme | $\mathrm{t}_{\mathrm{ACC}}$ | - | 600 | 850 | ns | $\mathrm{~V}_{\mathrm{OH}}=2.20 \mathrm{~V}^{*}$ |
| Chıp Select Response Tıme | $\mathrm{T}_{\mathrm{R}}$ | - | 200 | 300 | ns | $\mathrm{ps}=1 \mathrm{MHz}$ |
| Capacıtance | $\mathrm{C}_{\mathrm{O}}$ | - | 8 | 10 | pf | $\mathrm{F}=10$ |

RO-3-9332B $=$ RO-3-9332BHR
AC CHARACTERISTICS Address, Chip Select Inputs Cycle Time
Capacitance
Data Outputs
Access Time
Chip Select Response Time Capacitance

|  |  |  |  |
| :---: | :---: | :---: | :---: |
| $t_{c}$ | 450 | - | - |
| $C_{1}$ | - | 5 | 8 |
| $\mathrm{C}_{1}$ | - | 8 | 10 |
| $t_{A C C}$ | - | 350 | 450 |
| $t_{t_{0}}$ | - | 100 | 200 |
| $\mathrm{C}_{\mathrm{o}}$ | - | 8 | 10 |


|  |  |
| :--- | :--- |
| ns <br> pf <br> pf | $\mathrm{F}=1 \mathrm{MHz}$ |
| ns | $\mathrm{F}=1 \mathrm{MHz}$; RO-3-9332BHR only |
| ns |  |
| pf | $\mathrm{V}_{\mathrm{OH}}=2.20 \mathrm{~V}^{*}$ |

RO-3-9332C

## AC CHARACTERISTICS

Address, Chip Select Inputs
Cycle Tıme
Capacitance
Data Outputs
Access Time
Chip Select Response Time Capacitance

|  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :--- |
| $\mathrm{t}_{\mathrm{C}}$ | 300 | - | - | ns |  |
| $\mathrm{C}_{1}$ | - | 5 | 8 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |
|  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{ACC}}$ | - | 250 | 350 | ns |  |
| $\mathrm{t}_{\mathrm{R}}$ | - | 100 | 200 | ns |  |
| $\mathrm{C}_{0}$ | - | 8 | 10 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |

[^1]

ACCESS TIME (ADDRESS TO OUTPUT-CHIP SELECTED)


CHIP SELECT RESPONSE TIME (ADDRESS INPUTS STABLE)

## RO9333B/C RO9333HR

## 32,768 Bit Static Read Only Memory

## FEATURES

- $4096 \times 8$ Organization - Ideal for Microprocessor Memory Systems
- Single +5 Volt Supply
- TTL Compatible - All Inputs and Outputs
- Static Operation - No Clocks Required
- Pin Compatible With 2732 EPROM
- 450ns Maximum Access Time: RO-3-9333B
- 350ns Maximum Accent Time: RO-3-9333C
- Extended Temperature Range
- Three State Outputs - Under the Control of Two Mask-

Programable Chip Select Inputs to Simplify Memory Expansion

- Totally Automated Custom Programing
- Zener Protected Inputs
- Glass Passivation Protection


## DESCRIPTION

The General Instrument RO-3-9333 is a 32,768 bit static Read Only Memory organized as 4096 eight bit words and is ideally suited for microprocessor memory applications. Fabricated in the General Instrument N -Channel Ion Implant process to enable operation from a single +5 Volt power supply, the RO-3-9333 offers the best combination of high performance, large bit storage, and simple interfacing of any MOS Read-Only Memory available today.

## BLOCK DIAGRAM



ELECTRICAL CHARACTERISTICS

## Maximum Ratings *

$\mathrm{V}_{\mathrm{CC}}$ and input voltages (with respect to GND) . . -0.3 V to +8.0 V
Storage Temperature . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)
$V_{c c}=+5$ Volts $\pm 10 \%$
Operating Temperature $\left(\mathrm{T}_{\mathrm{A}}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
( $\mathrm{HR}: \mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ )
Output Loading: Two TTL Loads, $C_{L}$ Total $=100 \mathrm{pf}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

RO-3-9333B/C $■$ RO-3-9333HR

| Characteristic | Sym | Min | Typ* | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Address, Chip Select Inputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | - | V |  |
| Logic "0" | $\mathrm{V}_{\text {IL }}$ | - | - | 0.8 | V |  |
| Leakage | $I_{\text {LI }}$ | - | - | 10 | $\mu \mathrm{A}$ |  |
| Data Outputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | - | V | $\mathrm{IOH}=-200 \mu \mathrm{~A}$ |
| Logic "0" | $\mathrm{V}_{\text {OL }}$ | - | - | 0.4 | V | $\mathrm{loL}^{\mathrm{OH}}=3.2 \mathrm{~mA}$ |
| Leakage | ILo | - | - | 10 | $\mu \mathrm{A}$ |  |
| Power Supply Current |  |  |  |  |  |  |
| RO-3-9333B | $\mathrm{I}_{\mathrm{cc}}$ | - | - | 125 | mA | Outputs Open |
| RO-3-9333BHR | $\mathrm{I}_{\mathrm{cc}}$ | - | - | 120 | mA | Outputs Open |
| RO-3-9333C | $\mathrm{I}_{\mathrm{cc}}$ | - | - | 140 | mA | Outputs Open |

RO-3-9333B ■ RO-3-9333BHR

AC CHARACTERISTICS
Address, Chip Select Inputs
Cycle Time
Capacitance

Data Outputs
Access Time
Chıp Select Response Tıme Capacitance

| $\begin{aligned} & \mathrm{t}_{\mathrm{C}} \\ & \mathrm{C}_{1} \\ & \mathrm{C}_{1} \end{aligned}$ | 450 - | 5 8 | $\begin{gathered} 8 \\ 10 \end{gathered}$ | ns pf pf | $\begin{aligned} & F=1 \mathrm{MHz} \\ & F=1 \mathrm{MHz} ; \text { RO-3-9333BHR } \\ & \quad \text { Only } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| tacc | - | 350 | 450 | ns | $\mathrm{V}_{\mathrm{OH}}=2.20 \mathrm{~V}^{*}$ |
| $\begin{aligned} & t_{\mathrm{R}} \\ & \mathrm{C}_{\mathrm{O}} \end{aligned}$ | - | $\begin{gathered} 100 \\ 8 \end{gathered}$ | $\begin{gathered} 200 \\ 10 \end{gathered}$ | $\begin{aligned} & \text { ns } \\ & \text { pf } \end{aligned}$ | $\mathrm{F}=1 \mathrm{MHz}$ |

RO-3-9333C

| AC CHARACTERISTICS <br> Address, Chip Select Inputs <br> Cycle Time <br> Capacitance | $\begin{aligned} & \mathrm{t}_{\mathrm{C}} \\ & \mathrm{C}_{1} \end{aligned}$ | $\begin{gathered} 300 \\ - \end{gathered}$ | $\overline{5}$ | $8$ | $\begin{aligned} & \text { ns } \\ & \text { pf } \end{aligned}$ | $\mathrm{F}=1 \mathrm{MHz}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Data Outputs <br> Access Time <br> Chip Select Response Time Capacitance | $\begin{array}{r} t_{A C C} \\ t_{R} \\ C_{0} \end{array}$ | - | $\begin{gathered} 250 \\ 100 \\ 8 \end{gathered}$ | $\begin{gathered} 350 \\ 200 \\ 10 \end{gathered}$ | $\begin{aligned} & \text { ns } \\ & \text { ns } \\ & \text { pf } \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{OH}}=2.20 \mathrm{~V}^{\star} \\ & \mathrm{F}=1 \mathrm{MHz} \end{aligned}$ |

*See Timing Diagram
** Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages

## TIMING DIAGRAMS



RO9432B/C/D

## 32,768 Bit Static Read Only Memory

FEATURES

- $4096 \times 8$ Organization

READ ONLY MEMORY

- Fully Static Operation-No Clocks Required
- Single $+5 \mathrm{~V} \pm 10 \%$ Supply
- 450ns Access Time: RO9432B
- 300ns Access Time: RO9432C
- 200ns Access Time: RO9432D
- Inputs and Outputs TTL Compatible
- Three State Outputs-Under the Control of Two Mask

Programable Chip Select Inputs

- Output Drive Capability of 2 TTL Loads and 100 pf
- Low Power Dissipation
- Totally Automated Custom Programing
- All Inputs Protected Against Static Charge
- Pin Compatible With 2532 EPROM


## DESCRIPTION

The RO9432 is a 32,768 bit fully static Read Only Memory utilizing MOS N-Channel Silicon Gate Ion Implanted technology. It is organized 4096 words by 8 bits and operates from a single +5 Volt

power supply with $\pm 10 \%$ supply tolerance. All inputs are TTL compatible, and the three-state outputs can drive 2 standard TTL loads each.

## BLOCK DIAGRAM



## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$\mathrm{V}_{\mathrm{CC}}$ and Input Voltages (with Respect to GND) .......... -0.5 V to +7.0 V
Storage Temperature $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted):
$\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 10 \%$
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Output Loading: Two TTL Loads $+\mathrm{C}_{\mathrm{L}}$ TOTAL $=100 \mathrm{pf}$


#### Abstract

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Low Voltage | $V_{I L}$ | -0.5 | - | 0.8 | V |  |
| Input High Voltage | $V_{I \mathrm{H}}$ | 2 | - | $V_{\mathrm{CC}}$ | V |  |
| Input Load Current | $\mathrm{I}_{\mathrm{IL}}$ | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IN}}=0$ to $\mathrm{V}_{\mathrm{CC}}$ |
| Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.40 | V | $\mathrm{I}_{\mathrm{OL}}=+3.2 \mathrm{~mA}$ |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A}$ |
| Output Leakage Current | $\mathrm{I}_{\mathrm{LO}}$ | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{OUT}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| Power Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | - | - | 100 | mA | All Inputs +5.5V,Outputs Unloaded |


| AC CHARACTERISTICS |  | R09432B |  | R09432C |  | RO9432D |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Max | Min | Max | Min | Max | Units | Conditions |
| Address Access Time | $t_{\text {ACC }}$ | - | 450 | - | 300 | - | 200 | ns |  |
| Chip Select to Output Delay Time | $\mathrm{t}_{\mathrm{co}}$ | - | 100 | - | 100 | - | 75 | ns |  |
| Chip Deselect to Output Float Time | $\mathrm{t}_{\mathrm{DF}}$ | - | 75 | - | 75 | - | 75 | ns |  |
| Previous Data Valid After Address Change | $\mathrm{t}_{\mathrm{OH}}$ | 20 | - | 20 | - | 20 | - | ns | . |
| Capacitance* |  |  |  |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | - | 7 | - | 7 | - | 7 | pf | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{F}=1 \mathrm{MHz}$ |
| Output Capacitance | $\mathrm{C}_{\text {OUt }}$ | - | 10 | - | 10 | - | 10 | pf | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{F}=1 \mathrm{MHz}$ |

* Not tested 100\%


## AC TEST CONDITIONS

Input Pulse Levels.
0.8 V to 2.2 V

Input Rise and Fall Times . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 20 ns
Timing Measurement Levels•
Input 1.5 V

Output . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 0.8 V and 2.0V
Output Load
2 TTL Loads +100pf (See Figure 1)

## CONDITIONS OF TEST FOR AC CHARACTERISTICS

## TIMING DIAGRAM



## DEFINITIONS

Access Time, $\mathrm{T}_{\mathrm{ACC}}$
Access time is the maximum time between the application of a valid Address and the corresponding Data Out.
Output Hold Delay, $\mathrm{T}_{\mathrm{OH}}$
Output hold delay is the minimum time after an Address change that the previous data remains valid.

Output Enable Time, $\mathrm{T}_{\text {co }}$
Output enable time is the maximum delay between Chip Selects becoming true and Output Data becoming valid.
Output Disable Time, $\mathrm{T}_{\mathrm{DF}}$
Output disable time is the delay between Chip Selects becoming false and output stages going to the high impedance state.

## 32,768 Bit Static Read Only Memory

## FEATURES

- $4096 \times 8$ Organization
- Fully Static Operation-No Clocks Required
- Single $+5 \mathrm{~V} \pm 10 \%$ Supply
- 450ns Access Time: RO9433B
- 300ns Access Time: RO9433C
- 200ns Access Time: RO9433D
- Inputs and Outputs TTL Compatible
- Three State Outputs-Under the Control of Two Mask Programable Chip Select Inputs
- Output Drive Capability of 2 TTL Loads and 100pf
- Low Power Dissipation
- Totally Automated Custom Programing
- All Inputs Protected Against Static Charge
- Pin Compatible With 2732 EPROM


## DESCRIPTION

The RO9433 is a 32,768 bit fully static Read Only Memory utilizing MOS N-Channel Silicon Gate Ion Implanted technology. It is organized 4096 words by 8 bits and operates from a single +5 Volt

## PIN CONFIGURATION

24 LEAD DUAL IN LINE

| Top View |  |  |  |
| :---: | :---: | :---: | :---: |
| A7 | $\bullet 1$ | 24 | $\mathrm{v}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| A6 | $\square^{2}$ | 23 | AB |
| A5 | $\square^{3}$ | 22 | A9 |
| A4 | 14 | 21 | A11 |
| A3 | $\mathrm{O}^{5}$ | 20 | cs1/Cs1 |
| A2 | -6 | 19 | A10 |
| A1 | 07 | 18 | cs2/Cs2 |
| A0 | 88 | 17 | $\bigcirc 8$ |
|  | $\square^{9}$ | 16 | 07 |
| 02 | 10 | 15 | 06 |
|  |  | 14 | 05 |
| GND | $\underline{12}$ | 13 | 04 |

power supply with $\pm 10 \%$ supply tolerance. All inputs are TTL compatible, and the three-state outputs can drive 2 standard TTL loads each.

## BLOCK DIAGRAM



## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
$\mathrm{V}_{\mathrm{CC}}$ and Input Voltages (with Respect to GND) ........... -0.5 V to +7.0 V
Storage Temperature $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted):
$V_{C C}=+5 \mathrm{~V} \pm 10 \%$
Operating Temperature $\mathrm{T}_{\mathrm{Al}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Output Loading: Two TTL Loads, $\mathrm{C}_{\mathrm{L}}$ TOTAL $=100 \mathrm{pf}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Address, $\overline{C H I P ~ S E L E C T S ~}$ <br> Inputs |  |  |  |  |  |  |
| Logic 1 " |  |  |  |  |  |  |
| Logic "0" | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |
| Leakage | $\mathrm{V}_{\mathrm{IL}}$ | 0 | - | 0.8 | V |  |
| Data Outputs |  | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| Logic "1" |  |  |  |  |  |  |
| Logic " 0 " | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A}$ |
| Leakege | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Power Supply Current | $\mathrm{I}_{\mathrm{LO}}$ | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{OUT}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |


| AC CHARACTERISTICS |  | RO9433B |  | RO9433C |  | R09433D |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Max | Min | Max | Min | Max | Units | Conditions |
| Address Access Time | $\mathrm{t}_{\mathrm{AcC}}$ | - | 450 | - | 300 | - | 200 | ns |  |
| Chip Select to Output Delay Time | ${ }_{\text {t }} \mathrm{c}$ | - | 100 | - | 100 | - | 75 | ns |  |
| Chip Deselect to Output Float Time | $\mathrm{t}_{\mathrm{DF}}$ | - | 75 | - | 75 | - | 75 | ns |  |
| Previous Data Valid After Address Change | $\mathrm{t}_{\mathrm{OH}}$ | 20 | - | 20 | - | 20 | - | ns |  |
| Capacitance* |  |  |  |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {IN }}$ | - | 7 | - | 7 | - | 7 | pf | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{F}=1 \mathrm{MHz}$ |
| Output Capacitance | $\mathrm{C}_{\text {OUT }}$ | - | 10 | - | 10 | - | 10 | pf | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{F}=1 \mathrm{MHz}$ |

* Not tested 100\%


## AC TEST CONDITONS

Input Pulse Levels 0.8 V to 2.2 V

Input Rise and Fall Times . .20 ns
Timing Measurement Levels:
Input
Output
........................ 0.8 V and 2.0 V
oad $\qquad$
$\qquad$ Output Load ............... 2 TTL Loads +100pf (See Figure 1)

CONDITIONS OF TEST FOR AC CHARACTERISTICS


## TIMING DIAGRAM



## DEFINITIONS

Access Time, $\mathrm{T}_{\mathrm{ACC}}$
Access time is the maximum time between the application of a valid Address and the corresponding Data Out.
Output Hold Delay, $\mathrm{T}_{\mathrm{OH}}$
Output hold delay is the minimum time after an Address change that the previous data remans valid.

Output Enable Time, $\mathrm{T}_{\text {co }}$
Output enable time is the maximum delay between Chip Selects becoming true and Output Data becoming valid.
Output Disable Time, $T_{D F}$
Output disable time is the delay between Chip Selects becoming false and output stages going to the high impedance state.

## 65,536 Bit Edge-Triggered Read Only Memory

## FEATURES

- $8192 \times 8$ Organization
- Single +5 Volt $\pm 10 \%$ Supply
- TTL Compatible - All Inputs and Outputs
- Edge Triggered Operation
- 450ns Maximum Access Time: RO-3-9364B
- 300ns Maximum Access Time: RO-3-9364C
- Three-State Outputs - Under the Control of Chip Enable Input
- 2 TTL Load/100pf Output Drive Compatibility
- Low Power Dissipation - 250 mW active, 150 mW Standby
- Totally Automated Custom Programing
- Zener Protected Inputs
- Glass Passivation Protection


## DESCRIPTION

The General Instrument RO-3-9364 is a 65,536 Bit Edge-Triggered Read Only Memory organized as 81928 -bit words and is ideally suited for microprocessor memory applications. Fabricated with General Instrument N-Channel Silicon Gate Technology, the RO-3-9364 provides the designer with a high performance, easy-to-use MOS circuit featuring operation from a single +5 Volt power supply and low power dissipation. The RO-3-9364 offers the best combination of high performance, large bit storage and simple interfacing of any MOS Read Only Memory available today.

## PIN CONFIGURATION

24 LEAD DUAL IN LINE

| Top View |  |  |  |
| :---: | :---: | :---: | :---: |
| A7 | $\bullet 1$ | 24 | $\mathrm{V}_{\mathrm{CC}}(-5 \mathrm{~V})$ |
| A6 | 2 | 23 | A8 |
| A5 | 3 | 22 | A9 |
| A4 | 4 | 21 | A12 |
| A3 | 5 | 20 | CE |
| A2 | 6 | 19 | A10 |
| A1 | 7 | 18 | A11 |
| A0 | 8 | 17 | O8 |
| 01 | - | 16 | 07 |
| 02 | 10 | 15 | 06 |
| 03 | 11 | 14 | 05 |
| GND | 12 | 13 | 04 |



## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$\mathrm{V}_{\mathrm{cc}}$ and Input Voltages (with Respect to GND) ........... -0.5 V to +7.0 V
Storage Temperature $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted):
$V_{c c}=+5 \mathrm{~V} \pm 10 \%$
Operating Temperature $T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

$$
\text { HR: } T_{A}=-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
$$

Output Loading: Two TTL Loads, $C_{L}$ total $=100$ pf

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

DC CHARACTERISTICS

|  |  | RO-3-9364B/C |  |  | RO-3-9364HR |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Typ** | Max | Min | Typ** | Max | Units | Conditions |
| Address, CHIP ENABLE |  |  |  |  |  |  |  |  |  |
| Inputs |  |  |  |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | - | 2 | - | - | V |  |
| Logic "0" | $\mathrm{V}_{\text {IL }}$ | - | - | 0.8 | - | - | 0.7 | V |  |
| Leakage | $I_{L I}$ | - | - | 10 | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{CC}}$ |
| Data Outputs |  |  |  |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | - | 2.4 | - | - | V | $\mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A}$ |
| Logic "0" | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{CL}}=3.2 \mathrm{~mA}$ |
| Leakage | ILO | - | - | 10 | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {CC }}$ |
| Power Supply Current |  |  |  |  |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{CC}} \text { (Active) RO-3-9364B }$ | - | - | - | 50 |  | N/A |  | mA | Output Loading 1M |
| RO-3-9364C | - | - | - | 50 |  | N/A |  |  | $\overline{\mathrm{CE}}$ at Minimum Cycle Time |
| $I_{\text {cc }}$ (Standby) RO-3-9364B | - | - | - | 30 |  | N/A |  | mA | $\overline{\mathrm{CE}}=$ Logic " 1 " |
| RO-3-9364C | - | - | - | 30 |  | N/A |  |  |  |
| RO-3-9364HR |  |  | N/A |  | - | - | 35 |  |  |

## AC CHARACTERISTICS

|  |  | RO-3-9364B |  |  | RO-3-9364C |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Typ** | Max | Min | Typ** | Max | Units | Conditions |
| Cycle Time | $\mathrm{t}_{\mathrm{C}}$ | 600 | - | - | 400 | - | - | ns |  |
| $\overline{\text { CE Pulse Width }}$ | $t_{C E}$ | 450 | - | - | 300 | - | - | ns |  |
| $\overline{\overline{C E}}$ Precharge Time | $t_{p}$ | 150 | - | - | 100 | - | - | ns | All Outputs Driving |
| $\overline{C E}$ Access Time | $t_{\text {AC }}$ | - | - | 450 | - | - | 300 | ns | \} Two TTL Loads |
| Output Turn Off Time | $\mathrm{t}_{\text {OFF }}$ | - | - | 150 | - | - | 150 | ns | and 100pf |
| Address Set Up Time | $\mathrm{t}_{\text {AS }}$ | 0 | - | - | 0 | - | - | ns | - |
| Address Hold Time | $t_{\text {AH }}$ | 90 | - | - | 75 | - | - | ns |  |
| Capacitance |  |  |  |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{1}$ | - | - | 7 | - | - | 7 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| Output Capacitance | $\mathrm{C}_{0}$ | - | - | 10 | - | - | 10 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |


|  |  | RO-3-9364HR *** |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Typ** | Max | Units | Conditions |
| Cycle Time | $\mathrm{t}_{\mathrm{C}}$ | 400 | - | - | ns |  |
| CE Pulse Width | $\mathrm{t}_{\mathrm{CE}}$ | 300 | - | - | ns |  |
| $\overline{\text { CE Precharge Time }}$ | $t_{P}$ | - | - | 150 | ns | All Outputs Driving |
| CE Access Time | $t^{\text {AC }}$ | - | - | 450 | ns | $\}$ Two TTL Loads |
| Output Turn Off Time | $\mathrm{t}_{\text {OfF }}$ | - | - | 150 | ns | and 100pf |
| Address Set Up Time | $\mathrm{t}_{\mathrm{AS}}$ | 0 | - | - | ns |  |
| Address Hold Time | $\mathrm{t}_{\text {AH }}$ | 75 | - | - | ns |  |
| Capacitance |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{1}$ | - | - | 7 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| Output Capacitance | $\mathrm{C}_{0}$ | - | - | 10 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |

[^2]
## OPERATION

The RO-3-9364 is controlled by the chip enable. A negative going edge at $\overline{C E}$ input will activate the device and latch the addresses into the on-chip address registers. Once the address hold time specification has been met, new address data can be applied in anticipation of the next cycle. The circuit can be put into an
automatic low power standby mode by maintaining the chip enable ( $\overline{C E}$ ) input at a TTL high level. In this mode, power dissipation is reduced as compared to unclocked devices which draw full power continuously.

## TIMING DIAGRAM



## 65,536 Bit Edge-Triggered Read Only Memory

## FEATURES

- $8192 \times 8$ Organization
- Single +5 Volt $+10 \%$ Supply
- TTL Compatible - All Inputs and Outputs
- Edge Triggered Operation
- 450ns Maximum Access Time: RO-3-9365B
- 300ns Maximum Access Time: RO-3-9365C
- Three-State Outputs - Under the Control of Chip Enable Input
- 2 TTL Load/100pf Output Drive Compatibility
- Low Power Dissipation - 250 mW Active, 150 mW Standby
- Totally Automated Custom Programing
- Zener Protected Inputs
- Glass Passivation Protection


## DESCRIPTION

The General Instrument RO-3-9365 is a 65,536 Bit Edge-Triggered Read Only Memory organized as 81928 -bit words and is ideally suited for microprocessor memory applications. Fabricated with General Instrument N-Channel Silicon Gate Technology, the RO-3-9365 provides the designer with a high performance, easy-to-use MOS circuit featuring operation from a single +5 Volt power supply and low power dissipation. The RO-3-9365 offers the best combination of high performance, large bit storage, and simple interfacing of any MOS Read Only Memory available today.

PIN CONFIGURATION
28 LEAD DUAL IN LINE



| INSTRUNERENT | RO-3-9365B/C |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

```
Maximum Ratings*
\(\mathrm{V}_{\mathrm{cc}}\) and Input Voltages (with Respect to GND) ........... -0.5 V to +7.0 V
Storage Temperature
``` \(\qquad\)
``` \(-65^{\circ} \mathrm{C}\) to \(+150^{\circ} \mathrm{C}\)
```

Standard Conditions (unless otherwise noted):
$V_{C C}=+5 \mathrm{~V} \pm 10 \%$
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Output Loading: Two TTL Loads, $C_{L}$ TOTAL $=100 \mathrm{pf}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| DC CHARACTERISTICS |  | RO-3-9365B/C |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| Address, CHIP ENABLE <br> Inputs <br> Logic " 1 " <br> Logic "0" <br> Leakage | $\mathrm{V}_{\text {IH }}$ $\mathrm{V}_{\text {IL }}$ $\mathrm{ILI}^{\text {L }}$ | 2 <br> - | - | - 0.8 10 | $\begin{gathered} \mathrm{V} \\ \mathrm{~V} \\ \mu \mathrm{~A} \end{gathered}$ |  |
| Data Outputs <br> Logic "1" <br> Logic "0" <br> Leakage | $\mathrm{V}_{\mathrm{OH}}$ <br> loL <br> ILO | 2.4 | - | - 0.4 10 | $\begin{gathered} V \\ \mathrm{~V} \\ \mu \mathrm{~A} \end{gathered}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=200 \mu \mathrm{~A} \\ & \mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA} \end{aligned}$ |
| Power Supply Current Icc (Active) <br> $I_{\text {cc }}$ (Standby) | - | - | - | 50 30 | mA mA | Output Loading 1M $\Omega$ and 100pf $\overline{C E}$ at Minimum Cycle Time $\overline{C E}=$ Logic " 1 " |

## AC CHARACTERISTICS

|  |  | RO-3-9365B |  |  | R0-3-9365C |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Typ | Max | Min | Typ** | Max | Units | Conditions |
| Cycle Time | ${ }^{\text {t }}$ c | 600 | - | - | 400 | - | - | ns |  |
| CE Pulse Width | $\mathrm{t}_{\mathrm{CE}}$ | 450 | - | - | 300 | - | - | ns |  |
| $\overline{C E}$ Precharge Time | $t_{p}$ | 150 | - | - | 100 | - | - | ns |  |
| $\overline{C E}$ Access Time | $t_{\text {AC }}$ | - | - | 450 | - | - | 300 | ns | All Outputs Driving |
| Output Turn Off Time | $\mathrm{t}_{\text {toff }}$ | - | - | 90 | - | - | 75 | ns | \} Two TTL Loads |
| Address Set Up Time | $\mathrm{t}_{\text {AS }}$ | 0 | - | - | 0 | - | - | ns | and 100pf |
| Address Hold Time | $\mathrm{t}_{\text {AH }}$ | 90 | - | - | 75 | - | - | ns |  |
| Output Enable Access Time | $\mathrm{t}_{\text {OEA }}$ | - | - | 80 | - | - | 100 | ns |  |
| Output Enable Data Off Time | $\mathrm{t}_{\text {oez }}$ | - | - | 60 | - | - | 75 | ns |  |
| Capacitance Input Capacitance | $\mathrm{C}_{1}$ | - | - | 7 | - | - | 7 | pf |  |
| Output Capacitance | C c | - | - | 10 | - | - | 10 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |

[^3]| RO-3-9365B/C | INSTRUMENE |
| :---: | :---: |

## OPERATION

The RO-3-9365 is controiled by the chip enable (CE) and output enable ( $\overline{\text { E }}$ ). A negative going edge at the CE input will activate the device and latch the addresses into the on-chip address registers. The output buffers, under the control of $\overline{O E}$, will become active in $\overline{C E}$ access time ( $\mathrm{t}_{\mathrm{ac}}$ ) if the output enable access time ( $\mathrm{t}_{\text {OEA }}$ ) requirement is met. The on chip address register allows addresses to be changed after the specified hold time ( $\mathrm{t}_{\mathrm{an}}$ ) in preparation for
the next cycle. The outputs will remain valid and active until either $\overline{C E}$ or $\overline{O E}$ is returned to the inactive state. After output turn off time ( $\mathrm{t}_{\mathrm{off}}$ ) the output buffers will go to a high impedance state. The CE input must remain inactive (high) between subsequent cycles for time ( $t_{p}$ ) to allow for precharging the nodes of the internal circuitry.


# 65,536 Bit Static Read Only Memory 

## FEATURES

- $8192 \times 8$ Organization
- Fully Static Operation
- Single $+5 \mathrm{~V} \pm 10 \%$ Supply
- Inputs and Outputs TTL Compatible
- Three State Outputs
- Output Drive Capability of 2 TTL Loads and 100pf
- 24 Pin JEDEC Approved Pinout


## DESCRIPTION

The General Instrument RO9464 and RO9464A are 65,536 Bit Static Read Only Memories organized as 8192 eight-bit words and are ideally suited for microprocessor memory applications. Fabricated with General Instrument N-Channel Silicon Gate Technology, the RO9464 and RO9464A provide the designer with a high performance, easy to use MOS circuit featuring operation from a single +5 Volt power supply and low power dissipation. The RO9464 and RO9464A offer the best combination of high performance, large bit storage and simple interfacing of any MOS Read Only Memory available today.
The RO9464 offers a programable chip select on pin 20. The RO9464A offers an automatic power down feature on pin 20. Power down is controlled by the Chip Enable ( $\overline{\mathrm{CE}}$ ) input. When $\overline{\mathrm{CE}}$ goes high, the device will automatically power down and remain in a low power standby mode as long as $\overline{\mathrm{CE}}$ remains high.

## PIN CONFIGURATION <br> 24 LEAD DUAL IN LINE





CHIP SELECT (CS) IS PROGRAMABLE ACTIVE LOW, ACTIVE HIGH, OR DON'T CARE

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*

Supply Voltage to Ground Potential ....................... -0.5 V to +7.0 V
Applied Output Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.5 V to +7.0 V
Applied Input Voltage ..................................... -0.5 V to +7.0 V
Power Dissipation ............................................................ . . 1.0W
Standard Conditions (unless otherwise noted):
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
$V_{C C}=+5 \mathrm{~V} \pm 10 \%$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :--- |
| Output High Level | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A}$ |
| Output Low Level | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Input High Level | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |
| Input Low Level | $\mathrm{V}_{\mathrm{IL}}$ | -0.5 | - | 0.8 | V |  |
| Input Leakage Current | $\mathrm{I}_{\mathrm{LI}}$ | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| Output Leakage Current | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{OUT}}=\mathrm{OV}$ to $\mathrm{V}_{\mathrm{CC}}$ |  |
| Operating Supply Current | $\mathrm{I}_{\mathrm{LO}}$ | - | - | 100 | mA | Note 1 |
| Standby Supply Current | - | - | 12 | mA | Note 2 |  |

AC CHARACTERISTICS

|  |  | $\begin{aligned} & \text { RO9 } \\ & \text { RO9 } \end{aligned}$ | $\begin{aligned} & \text { 64B } \\ & 64 A B \end{aligned}$ | $\begin{aligned} & \text { RO9 } \\ & \text { RO9 } \end{aligned}$ | $\begin{aligned} & 64 \mathrm{C} \\ & 64 \mathrm{AC} \end{aligned}$ | $\begin{aligned} & \text { RO9 } \\ & \text { RO9 } \end{aligned}$ | $\begin{aligned} & \text { 64D } \\ & \text { 64AD } \end{aligned}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Max | Min | Max | Min | Max | Units | Conditions |
| Cycle Time | $\mathrm{t}_{\mathrm{CrC}}$ | 450 | - | 300 | - | 200 | - | ns |  |
| Address Access Time | $\mathrm{t}_{\mathrm{AA}}$ | - | 450 | - | 300 | - | 200 | ns |  |
| Output Hold After Address Change | $\mathrm{t}_{\mathrm{OH}}$ | 20 | - | 20 | - | 20 | - | ns |  |
| Chip Enable Access Time | $\mathrm{t}_{\text {ACE }}$ | - | 450 | - | 300 | - | 200 | ns | Note 4 |
| Chip Select Access Time | $\mathrm{t}_{\text {ACS }}$ | - | 150 | - | 100 | - | 85 | ns | Note 3 |
| Output Low Z Delay | $\mathrm{t}_{\text {Lz }}$ | 20 | - | 20 | - | 20 | - | ns | Note 5 |
| Output High $Z$ Delay | $\mathrm{t}_{\mathrm{Hz}}$ | - | 75 | - | 75 | - | 75 | ns | Note 6 |
| Power Up Time | $\mathrm{t}_{\mathrm{Pu}}$ | 0 | 20 | 0 | 20 | 0 | 20 | ns | Notes 4, 7 |
| Power Down Time | $\mathrm{t}_{\text {PD }}$ | - | 150 | - | 100 | - | 100 | ns | Note 4 |
| Capacitance** |  |  |  |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{1}$ | - | 7 | - | 7 | - | 7 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| Output Capacitance | $\mathrm{C}_{0}$ | - | 10 | - | 10 | - | 10 | pf | $F=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |

[^4]TIMING DIAGRAMS
Propagation Delay from Address ( $\overline{C E}$ LOW or CS = Active)


Propagation Delay from Chip Enable, Chip Select or Output Enable (Address Valid)


## AC TEST CONDITIONS

Input Pulse Levels $\qquad$ .

Input Rise and Fall Times. . . . . . . . . . . . . . . . . . 20 nsec
Timing Measurement Levels: Input . . . . . . . . . . . . 1.5V
Output . 0.8 V and 2.0 V
Output Load See Figure 1


Fig. 1

## 65,536 Bit Static Read Only Memory

## FEATURES

- $8192 \times 8$ Organization
- Fully Static Operation
- Single $+5 \mathrm{~V} \pm 10 \%$ Supply
- Inputs and Outputs TTL Compatible
- Three State Outputs
- 28 Pin JEDEC Approved Pinout (RO9864A)


## DESCRIPTION

The General Instrument RO9864 and RO9864A are 65,536 Bit Static Read Only Memories organized as 8192 eight-bit words and are ideally suited for microprocessor memory applications. Fabricated with General Instrument N-Channel Silicon Gate Technology, the RO9864 and RO9864A provide the designer with a high performance, easy to use MOS circuit featuring operation from a single +5 Volt power supply and low power dissipation. The RO9864 and RO9864A offer the best combination of high performance, large bit storage and simple interfacing of any MOS Read Only Memory available today.
The RO9864 offers a four input chip select (CS3 and CS4 are on Pin 22 and 20 respectively) enables usage in large memory applications.
The RO9864A offers an automatic power down feature. On Pin 20 power down is controlled by the Chip Enable ( $\overline{\mathrm{CE}}$ ) input. When $\overline{\mathrm{CE}}$ goes high, the device will automatically power down and remain in a low power standby mode as long as $\overline{\mathrm{CE}}$ remains high. The RO9864A offers an Output Enable ( $\overline{\mathrm{OE}})$, on Pin 22, that eliminates bus contention in applications using large memory systems.

## PIN CONFIGURATION

28 LEAD DUAL IN LINE


## BLOCK DIAGRAM



| INSTRUERAL | RO9864B/C/D $=$ RO9864AB/AC/AD |
| :--- | :--- |

## ELECTRICAL CHARACTERISTICS

| Maximum Ratings* |  |
| :---: | :---: |
| Storage Temperature | $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Supply Voltage to Ground Potential | -0.5 V to +7.0 V |
| Applied Output Voltage | -0.5 V to +7.0 V |
| Applied Input Voltage | -0.5 V to +7.0 V |
| Power Dissipation | 1.0W |

Standard Conditions (unless otherwise noted):
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
$V_{C C}=+5 \mathrm{~V} \pm 10 \%$


#### Abstract

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :--- |
| Output High Level | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A}$ |
| Output Low Level | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Input High Level | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |
| Input Low Level | $\mathrm{V}_{\mathrm{IL}}$ | -0.5 | - | 0.8 | V |  |
| Input Leakage Current | $\mathrm{I}_{\mathrm{LI}}$ | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{CC}}$ |
| Output Leakage Current | $\mathrm{I}_{\mathrm{LO}}$ | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{OUT}}=\mathrm{V}_{\mathrm{CC}}$ |
| Operating Supply Current | - | - | 100 | mA | Note |  |
| Standby Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | - | - | 12 | mA | Note 2 |

AC CHARACTERISTICS

|  |  | $\begin{aligned} & \text { RO9864B } \\ & \text { RO9864AB } \end{aligned}$ |  | $\begin{aligned} & \text { RO9864C } \\ & \text { RO9864AC } \end{aligned}$ |  | $\begin{aligned} & \text { RO9864D } \\ & \text { RO9864AD } \end{aligned}$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Max | Min | Max | Min | Max | Units | Conditions |
| Cycle Time | $\mathrm{t}_{\mathrm{crc}}$ | 450 | - | 300 | - | 200 | - | ns |  |
| Address Access Time | $\mathrm{t}_{\mathrm{AA}}$ | - | 450 | - | 300 | - | 200 | ns |  |
| Output Hold After Address Change | $\mathrm{t}_{\mathrm{OH}}$ | 20 | - | 20 | - | 20 | - | ns |  |
| Chip Enable Access Time | $\mathrm{t}_{\text {ACE }}$ | - | 450 | - | 300 | - | 200 | ns | Note 2 |
| Chip Select Access Time | $\mathrm{t}_{\text {ACS }}$ | - | 75 | - | 75 | - | 75 | ns | Note 3 |
| Output Enable Access Time | $\mathrm{t}_{\text {AOE }}$ | - | 75 | - | 75 | - | 75 | ns | Note 2 |
| Output Low Z Delay | $\mathrm{t}_{\mathrm{Lz}}$ | 20 | - | 20 | - | 20 | - | ns | Note 4 |
| Output High Z Delay | $\mathrm{t}_{\mathrm{Hz}}$ | - | 75 | - | 75 | - | 75 | ns | Note 5 |
| Power Up Time | $\mathrm{t}_{\mathrm{Pu}}$ | 0 | 20 | 0 | 20 | 0 | 20 | ns | Notes 2, 6 |
| Power Down Time | $\mathrm{t}_{\text {PD }}$ | - | 100 | - | 100 | - | 100 | ns | Notes 2, 6 |
| Capacitance** |  |  |  |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{1}$ | - | 7 | - | 7 | - | 7 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |
| Output Capacitance | $\mathrm{C}_{0}$ | - | 10 | - | 10 | - | 10 | pf | $\mathrm{F}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |

[^5]| Part <br> Number | Maximum <br> Access Time | Operating <br> Current | Standby <br> Current |
| :---: | :---: | :---: | :---: |
| RO98864B | 450 ns | 100 mA | NA |
| RO98864C | 300 ns | 100 mA | NA |
| RO9864D | 200 ns | 100 mA | NA |
| RO9864AB | 450 ns | 100 mA | 12 mA |
| RO9864AC | 300 ns | 100 mA | 12 mA |
| RO9864AD | 200 ns | 100 mA | 12 mA |

## TIMING DIAGRAMS

Propagation Delay from Address $\overline{\mathbf{C E}}=\overline{\mathbf{O E}}=$ LOW,CS $/ \mathbf{C S}=$ Active


Propagation Delay from Chip Enable, Chip Select or Output Enable (Address Valid)


## AC TEST CONDITIONS

Input Pulse Levels
Input Rise and Fall Times.
Timing Measurement Levels: Int ........ 20 nsec
Output .. 0.8 V and 2.0 V
Output Load ........................... See Figure 1

## 131,072 Bit Static Read Only Memory

## FEATURES

- $16,384 \times 8$ Organization
- Single +5 Volt Supply
- 450ns Max Access Time: RO9128B
- 300ns Max Access Time: RO9128C
- 200ns Max Access Time: RO9128D
- Totally Static Operation
- Three State Outputs
- All TTL Compatible Inputs/Outputs
- 28 Pin JEDEC Approved Pinout


## DESCRIPTION

The General Instrument RO9128 is a 131,072 Bit Static Read Only Memory organized as 16,384 eight-bit words and is ideally suited for microprocessor memory applications. Fabricated with General Instrument N-Channel Silicon Gate Technology, the RO9128 provides the designer with a high performance, easy to use MOS circuit featuring operation from a single +5 Volt power supply and low power dissipation.
The RO9128 offers a power down feature controlled by the Chip Enable ( $\overline{C E}$ ) input. When $\overline{C E}$ goes high, the device will automatically power down and remain in a low power standby mode as long as $\overline{C E}$ remains high.


The Output Enable ( $\overline{\mathrm{OE}}$ ), and Chip Select (CS1) functions eliminate bus contention in multiple memory device systems.

## BLOCK DIAGRAM



CHIP SELECT (CS1) IS PROGRAMABLE ACTIVE LOW, ACTIVE HIGH, OR DON'T CARE

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
$\mathrm{V}_{\mathrm{CC}}$ and Input Voltages (with Respect to GND) .......... -0.5 V to +7.0 V
Storage Temperature ...................................... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$V_{C C}=+5 \mathrm{~V} \pm 10 \%$
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Output Loading: Two TTL Loads, $C_{L}$ TOTAL $=100 \mathrm{pf}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Address, $\overline{\mathbf{C E}}, \overline{\mathrm{OE}}, \mathbf{C S} 1$ Inputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | 2.0 | - | $\mathrm{V}_{\mathrm{cc}}$ | v |  |
| Logic "0" | $V_{\text {IL }}$ | 0 | - | 0.8 | V |  |
| Leakage | $\mathrm{I}_{\mathrm{LI}}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{cc}}$ |
| Data Outputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{v}_{\mathrm{cc}}$ | v | $\mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A}$ |
| Logic "0" | $\mathrm{V}_{\text {OL }}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Leakage | $\mathrm{I}_{\mathrm{LO}}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {cc }}$ |
| Power Supply Current Icc (Active) | - | - | - | 100 | mA | Output Unloaded, Chip Enabled |
| $\mathrm{I}_{\mathrm{CC}}$ (Standby) | - | - | -- | 12 | mA | $\overline{C E}=2.0 \mathrm{~V}$ |

AC CHARACTERISTICS

|  |  | RO9128B |  | RO9128C |  | RO9128D |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristics | Sym | Min | Max | Min | Max | Min | Max | Units | Conditions |
| Address Access Time | $t_{\text {ACC }}$ | - | 450 | - | 300 | - | 200 | ns |  |
| Address Hold After Address Change | $\mathrm{t}_{\mathrm{OH}}$ | 20 | - | 20 | - | 20 | - | ns |  |
| Chip Enable Access Time | $\mathrm{t}_{\text {ACE }}$ | - | 450 | - | 300 | - | 200 | ns |  |
| Chip Select, Output Enable Access Time | $\mathrm{t}_{\text {ACS }}$ | - | 100 | - | 100 | - | 75 | ns | Note 1 |
| Output Low Z Delay | $\mathrm{t}_{\text {LZ }}$ | 20 | - | 20 | - | 20 | - | ns | Note 2 |
| Output High Z Delay | $\mathrm{t}_{\mathrm{Hz}}$ | - | 75 | - | 75 | - | 75 | ns | Note 3 |
| Power-Up Time | $\mathrm{t}_{\mathrm{Pu}}$ | 0 | 20 | 0 | 20 | 0 | 20 | ns | Note 4 |
| Power-Down Time | $\mathrm{t}_{\mathrm{PO}}$ | - | 100 | - | 100 | - | 100 | ns |  |
| Capacitance** |  |  |  |  |  |  |  |  |  |
| Input Capacitance Output Capacitance | - | 7 10 | - | 7 10 | - | 7 10 | - | pf | $\begin{aligned} & \mathrm{F}=1 \mathrm{MHz}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \\ & \mathrm{~F}=1 \mathrm{MHz}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ |

## NOTES:

1. Access time to Valid Data (assuming data previously Enabled and addressed), measured from $\overline{\mathrm{OE}}$ and CS 1 going low, whichever occurs last.
2. Output low impedance delay (Data Invalid/Valid) is measured from $\overline{\mathrm{OE}}$ and $\overline{\mathrm{CE}}$ going low, or CS1 going active, whichever occurs last.
3. Output high impedance delay is measured from $\overline{\mathrm{OE}}$ or $\overline{\mathrm{CE}}$ going high or CS1 going Inactive whichever occurs first.
4. Power Up Time is not added to Chip Enable Access Time ( $t_{A C E}$ ).
**Capacitance is periodically sampled and is not $100 \%$ tested.
$\square$

## TIMING DIAGRAMS

Propagation Delay from Address $\overline{\mathbf{C E}}=\overline{\mathrm{OE}}=$ LOW,CS/CS $=$ Active


AC TEST CONDITIONS
Input Pulse Levels
0.8 V to 22 V

Input Rise and Fall Times.
... 20 nsec
Tıming Measurement Levels. Input . . . . . . . . . . . . 1.5V
Output Load . ............................. See Figure 1


Fig. 1

## 262,144 Bit Static Read Only Memory

## FEATURES

- $32,768 \times 8$ Organization
- Single +5 Volt Supply
- Maximum 300ns Access Time
- Totally Static Operation
- Three State Outputs
- All TTL Compatible Inputs/Outputs
- 28 Pin JEDEC and MOSTEK Standard Pinout


## DESCRIPTION

The General Instrument RO9256 is a 262,144 Bit Static Read Only Memory organized as 32,768 by 8 -bit and is ideally suited for microprocessor memory applications. Fabricated with General Instrument N-Channel Silicon Gate Technology, the RO9256 provides the designer with a high performance, easy to use MOS circuit featuring operation from a single +5 Volt power supply and low power dissipation.
The RO9256 offers a power down feature controlled by the Chip Enable ( $\overline{\mathrm{CE}}$ ) input. When $\overline{\mathrm{CE}}$ goes high, the device will automatically power down and remain in a low power standby mode as long as CE remains high.
An additional feature of Output Enable ( $\overline{\mathrm{OE}}$ ) function eliminates bus contention in multiple bus microprocessor systems.


## BLOCK DIAGRAM



## 20K Cartridge ROM

## FEATURES

- Mask Programable Storage Providing $2048 \times 10$ Bit Words
- 16 Bit On-Chip Address Latch
- Memory Map Circuitry to Place the 2K ROM Page Within a 65K Memory Area
- 16 Bit Tri-State Bus with Higher 6 Bits Driven to Zero During Read Operations


## CIRCUIT REQUIREMENTS

The RO-3-9504 operates as the program memory for systems using a CP1610 microprocessor. It is configured as $2048 \times 10$ bit words and contains several features which reduce the device count in a practical microprocessor application.

## DESCRIPTION

From initialization, the RO-3-9504 waits for the first address code i.e., BAR. For this address code and all subsequent address sequences, the 9504 reads the 16 -bit external bus and latches the value into its address register.
The 9504 contains a programable memory map location for its own 2 K page, and if a valid address is detected, the particular address location will transfer its contents to the chip output buffers. If the control code following the address cycle was a READ, the 9504 will output the 10 bits of addressed data and drive a logic zero on the top six bits of the bus.

INPUT CONTROL SIGNALS

| BDIR | BC1 | BC2 | Equivalent <br> Signal | Decoded Function |
| :---: | :---: | :---: | :---: | :--- |
| 0 | 0 | 0 | NACT | No ACTion, D0-D15 = High Impedance |
| 0 | 0 | 1 | IAB | No Action |
| 0 | 1 | 0 | ADAR | Address Data to Address Register, D0-D15 = High Impedance |
| 0 | 1 | 1 | DTB (READ) | Data To Bus, D0-D15 = Input |
| 1 | 0 | 0 | BAR | Bus to Address Register |
| 1 | 0 | 1 | DWS | No Action |
| 1 | 1 | 0 | DW | No Action |
| 1 | 1 | 1 | INTAK | INTerrupt AcKnowledge |

## TIMING DIAGRAM



| RO-3-9504 | INSTRUNERAK |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $100^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
All Input or Output Voltages with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . .$.

Standard Conditions (unless otherwise stated):
$\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+55^{\circ} \mathrm{C}$
$V_{C C}=+4.85 \mathrm{~V}-+5.15 \mathrm{~V}$
$\mathrm{V}_{\mathrm{ss}}=0.0 \mathrm{~V}$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

## DC CHARACTERISTICS

| Characteristics | Sym | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |
| Input Logic Low | $\mathrm{V}_{\text {IL }}$ | 0 | 0.7 | V |  |
| Input Logic High | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | $\mathrm{V}_{\mathrm{cc}}$ | V |  |
| Input Leakage | VIL | - | 5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| Capacitance | - | - | 10 | pf | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |
| CPU BUS Outputs |  |  |  |  |  |
| Output Logic Low | $\mathrm{V}_{\mathrm{OL}}$ | 0 | 0.5 | V | $\mathrm{I}_{\mathrm{OL}}=1.5 \mathrm{~mA}+150 \mathrm{pf}$ |
| Output Logic High | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | $\mathrm{V}_{\mathrm{cc}}$ | $v$ | $\mathrm{I}_{\mathrm{OH}}=-200 \mu \mathrm{~A}^{+150 \mathrm{pf}}$ |
| Supply Current $V_{C C}$ Supply | $I_{\text {cc }}$ | - | 120 | mA | $25^{\circ} \mathrm{C}$ |

## AC CHARACTERISTICS

| Characteristics | Sym | Min | Max | Units |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |
| Address Set Up | $\mathrm{t}_{\mathrm{as}}$ | 400 | - | ns |  |
| Address Overlap | $\mathrm{t}_{\mathrm{ao}}$ | 65 | - | ns |  |
| CPU BUS Outputs |  |  |  |  |  |
| Turn ON Delay | $\mathrm{t}_{\mathrm{da}}$ | - | 350 | ns |  |
| Turn OFF Delay | $\mathrm{t}_{\mathrm{do}}$ | 85 | - | ns |  |
| Access Time | $\mathrm{t}_{\mathrm{ac}}$ | - | 1.5 | $\mu \mathrm{~s}$ |  |

RO9508

## 40K Cartridge ROM

## FEATURES

- Mask Programable Storage Providing $4096 \times 10$ Bit Words
- 16 Bit On-Chip Address Latch
- Control Decoder
- Programable Memory Map Circuitry to Place 4K ROM Page Within 65K Word Memory Space Located on 4K Page Boundaries


## REQUIREMENTS

The RO9508 operates as the program memory for systems using a CP1600 series microprocessor. It is configured as $4096 \times 10$ bit words and contains several features which reduce the device count in a practical microprocessor application.

## DESCRIPTION

The RO9508 contains a programable memory map location for its own 4 K page and if a valid address is detected, the particular addressed location will transfer its contents to the chip output buffers. If the control code following the address cycle was a Read, the RO9508 will output the 10 bits of addressed data and also drive a logic zero on the top 6 bits of the bus.

## PIN CONFIGURATION

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|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| $V_{\text {cc }}$ | $\bullet 1$ | 28 | BC 1 |
| NC | 2 | 27 | BC2 |
| NC | 3 | 26 | BDIR |
| DB15 | 4 | 25 | DBO |
| NC | 5 | 24 | DB1 |
| DB14 | 6 | 23 | DB2 |
| DB13 | 7 | 22 | NC |
| DB12 | 8 | 21 | DB3 |
| DB11 | 9 | 20 | DB4 |
| DB10 | 10 | 19 | DB5 |
| NC | 11 | 18 | NC |
| DB9 | 12 | 17 | DB6 |
| DB8 | 13 | 16 | DB7 |
| NC | 14 | 15 | $\mathrm{V}_{\text {s }}$ |

## BUS CONTROL SIGNALS

| BDIR | BC2 | BC1 | Signal | Decoded Function |
| :---: | :---: | :---: | :---: | :--- |
| 0 | 0 | 0 | NACT | No ACTion, D0-D15 = High Impedance <br> 0 |
| 0 | 1 | ADAR | Address Data to Address Register, <br> DO-D15 = High Impedance |  |
| 0 | 1 | 0 | IAB | No Action |
| 0 | 1 | 1 | DTB | Data To Bus, D0-D15 = Input |
| 1 | 0 | 0 | BAR | Bus to Address Register |
| 1 | 0 | 1 | DW | No Action |
| 1 | 1 | 0 | DWS | No Action |
| 1 | 1 | 1 | INTAK | INTerrupt AcKnowledge |

## TIMING DIAGRAM



ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias $\qquad$ $0^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
All Input or Output Voltages with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . .,-0.2 \mathrm{~V}$ to +9.0 V
$\mathrm{V}_{\mathrm{CC}}$ with Respect to $\mathrm{V}_{\mathrm{Ss}}$ -0.2 V to +9.0 V

Standard Conditions (unless otherwise noted):
Ambient Temperature $0^{\circ} \mathrm{C}$ to $+55^{\circ} \mathrm{C}$
$V_{C C}=+4.85 \mathrm{~V}$ to +5.15 V
$\mathrm{V}_{\mathrm{Ss}}=0 \mathrm{~V}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |  |
| Input Logic Low | $\mathrm{V}_{\mathrm{IL}}$ | 0 | - | 0.7 | V |  |
| Input Logic High | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |
| Input Leakage | $\mathrm{V}_{\mathrm{IL}}$ | - | - | 5 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| CPU Bus Outputs | $\mathrm{V}_{\mathrm{OL}}$ | 0 | - | 0.5 | V | $\mathrm{I}_{\mathrm{OL}}=1.5 \mathrm{~mA}$ |
| Output Logic Low | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=80 \mu \mathrm{~A}$ |
| Output Logic High |  |  |  |  |  |  |
| Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | - | - | 120 | mA | $\mathrm{~V}_{\mathrm{CC}}=5.15 \mathrm{~V} @ 25^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\mathrm{CC}}$ Supply |  |  |  |  |  |  |

## AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |  |
| Address Set Up | $\mathrm{t}_{\mathrm{AS}}$ | 300 | - | - | ns |  |
| Address Overlap | $\mathrm{t}_{\mathrm{AO}}$ | - | - | 65 | ns |  |
| CPU Bus Outputs |  |  |  |  |  |  |
| Turn ON Delay | $\mathrm{t}_{\mathrm{DA}}$ | - | - | 350 | ns |  |
| Turn OFF Delay | $\mathrm{t}_{\mathrm{DO}}$ | 85 | - | - | ns |  |
| Access Time | $\mathrm{t}_{\mathrm{AC}}$ | - | - | 1.5 | $\mu \mathrm{~s}$ |  |



## 80K Cartridge ROM

## FEATURES

- Mask Programable Storage Providing $8192 \times 10$ Bit Words
- 16 Bit On-Chip Address Latch
- Control Decoder
- Programable Memory Map Circuitry to Place 8K ROM Page Within 65K Word Memory Space Located on Two Independent 4K Boundaries


## CIRCUIT REQUIREMENTS

The RO9580 operates as the program memory for systems using a CP1600 series microprocessor.
It is configured as $8192 \times 10$ bit words and contains several features which reduce the device count in a practical microprocessor application.

## DESCRIPTION

The RO9580 contains a programable memory map location for its own 8 K page and if a valid address is detected, the particular addressed location will transfer its contents to the chip output buffers. If the control code following the address cycle was a Read, the RO9580 will output the 10 bits of addressed data and also drive

PIN CONFIGURATION
28 LEAD DUAL IN LINE
 a logic zero on the top 6 bits of the bus.

## BUS CONTROL SIGNALS

| BDIR | BC2 | BC1 | Signal | Decoded Function |
| :---: | :---: | :---: | :---: | :--- |
| 0 | 0 | 0 | NACT | No ACTion, DO-D15 = High Impedance <br> 0 |
| 0 | 1 | ADAR | Address Data to Address Register, <br> DO-D15 = High Impedance |  |
| 0 | 1 | 0 | IAB | No Action |
| 0 | 1 | 1 | DTB | Data To Bus, D0-D15 = Input |
| 1 | 0 | 0 | BAR | Bus to Address Register |
| 1 | 0 | 1 | DW | No Action |
| 1 | 1 | 0 | DWS | No Action |
| 1 | 1 | 1 | INTAK | INTerrupt AcKnowledge |

## TIMING DIAGRAM



RO9580

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$

All Input or Output Voltages with Respect to $\mathrm{V}_{\mathrm{ss}} \ldots \ldots \ldots . .-0.2 \mathrm{~V}$ to +12 V

Standard Conditions (unless otherwise noted):
Ambient Temperature: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
$\mathrm{V}_{\mathrm{CC}}=+4.50 \mathrm{~V}$ to +5.50 V ,
$\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |  |
| Input Logic Low | $\mathrm{V}_{\mathrm{IL}}$ | 0 | - | 0.8 | V |  |
| Input Logic High | $\mathrm{V}_{\mathrm{OH}}$ | 2 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |
| Input Leakage | $\mathrm{V}_{\mathrm{IL}}$ | - | - | 5 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| CPU Bus Outputs | $\mathrm{V}_{\mathrm{OL}}$ | 0 | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Output Logic Low | $\mathrm{V}_{\mathrm{OH}}$ | 24 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Output Logic High |  |  |  |  |  |  |
| Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | - | - | 75 | mA |  |
| $\mathrm{~V}_{\mathrm{CC}}$ Supply |  |  |  |  |  |  |

## AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |  |
| Address Set Up | $\mathrm{t}_{\mathrm{AS}}$ | 300 | - | - | ns |  |
| Address Overlap | $\mathrm{t}_{\mathrm{AO}}$ | 50 | - | 65 | ns |  |
| CPU Bus Outputs |  |  |  |  |  |  |
| Turn ON Delay | $\mathrm{t}_{\mathrm{DA}}$ | - | - | 300 | ns |  |
| Turn OFF Delay | $\mathrm{t}_{\mathrm{DO}}$ | 80 | - | 250 | ns |  |
| Access Time | $\mathrm{t}_{\mathrm{AC}}$ | - | - | 15 | $\mu \mathrm{~s}$ |  |

R09160

## 160K Cartridge ROM

## FEATURES

- Mask Programable Storage Providing $16,384 \times 10$ Bit Words
- 16 Bit On-Chip Address Latch
- Control Decoder
- Programable Memory Map Circuitry to Place 16K ROM Page Within 65K Word Memory Space Located on Four Independent 4K Boundaries


## REQUIREMENTS

The RO9160 operates as the program memory for systems using a CP1600 series microprocessor.
It is configured as $16 \mathrm{~K} \times 10$ bit words and contains several features which reduce the device count in a practical microprocessor application.

## DESCRIPTION

The RO9160 contains a programable memory map location for its own 16 K page and if a valid address is detected, the particular addressed location will transfer its contents to the chip output buffers. If the control code following the address cycle was a Read, the RO9160 will output the 10 bits of addressed data and also drive a logic zero on the top 6 bits of the bus.

PIN CONFIGURATION
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BUS CONTROL SIGNALS

| BDIR | BC2 | BC1 | Signal | Decoded Function |
| :---: | :---: | :---: | :---: | :--- |
| 0 | 0 | 0 | NACT | No ACTion, D0-D15 = High Impedance |
| 0 | 0 | 1 | ADAR | Address Data to Address Register, <br> D0-D15 = High Impedance |
| 0 | 1 | 0 | IAB | No Action |
| 0 | 1 | 1 | DTB | Data To Bus, D0-D15 = Input |
| 1 | 0 | 0 | BAR | Bus to Address Register |
| 1 | 0 | 1 | DW | No Action |
| 1 | 1 | 0 | DWS | No Action |
| 1 | 1 | 1 | INTAK | INTerrupt AcKnowledge |

## TIMING DIAGRAM



| INSTRUERENT | RO9160 |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias $0^{\circ} \mathrm{C}$ to $+100^{\circ} \mathrm{C}$
Storage Temperature $\qquad$

All Input or Output Voltages with Respect to $\mathrm{V}_{\text {Ss }} \ldots . . . .$.
$\mathrm{V}_{\mathrm{cc}}$ with Respect to $\mathrm{V}_{\text {SS }} \ldots . .$. . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.2 V to +12 V
Standard Conditions (unless otherwise noted):
Ambient Temperature: $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
$\mathrm{V}_{\mathrm{CC}}=+4.50 \mathrm{~V}$ to +5.50 V
$\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |  |
| Input Logic Low | $\mathrm{V}_{\mathrm{IL}}$ | 0 | - | 0.8 | V |  |
| Input Logic High | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | $\mathrm{V}_{\mathrm{CC}}$ | V |  |
| Input Leakage | $\mathrm{V}_{\mathrm{IL}}$ | - | - | 5 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| CPU Bus Outputs | $\mathrm{V}_{\mathrm{OL}}$ | 0 | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Output Logic Low | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Output Logic High |  |  |  |  |  |  |
| Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | - | - | 75 | mA |  |
| $\mathrm{~V}_{\mathrm{CC}}$ Supply |  |  |  |  |  |  |

AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |  |
| Address Set Up | $\mathrm{t}_{\mathrm{AS}}$ | 300 | - | - | ns |  |
| Address Overlap | $\mathrm{t}_{\mathrm{AO}}$ | 50 | - | 65 | ns |  |
| CPU Bus Outputs |  |  |  |  |  |  |
| Turn ON Delay | $\mathrm{t}_{\mathrm{DA}}$ | - | - | 300 | ns |  |
| Turn OFF Delay | $\mathrm{t}_{\mathrm{DO}}$ | 80 | - | 250 | ns |  |
| Access Time | $\mathrm{t}_{\mathrm{AC}}$ | - | - | 1.5 | $\mu \mathrm{~s}$ |  |

## INSTRUNERAL

## Keyboard Encoder

| FUNCTION | DESCRIPTION | PART <br> NUMBER | PAGE <br> NUMBER |
| :---: | :---: | :---: | :---: |
| CAPACITIVE <br> KEYBOARD <br> ENCODER | 4,592 bits organized as 112 keys $\times 4$ modes $\times 10$ bits, plus 112 bits for internal <br> programing of function keys. | AY-3-4592 | $2-42$ |

## Capacitive Keyboard Encoder

## FEATURES

- 128 Key Keyboard Encoder: 112 Fully Decoded Keys, 16 Discrete Function Keys
- 112 Keys With 4 Modes, 10 Bit Output
- Key Validation Logic Protects Against Bounce
- N-Key Roll Over or 2-Key Roll Over
- Internal ROM Allows Any Keys to Control SHIFT CTRL, SHIFT LOCK and ALPHA LOCK
- ALPHA LOCK and SHIFT LOCK Indicator Lines
- Any Key Down (AKD) Strobe
- Single +5 Volt Power Supply
- Programable Coding of Standard and Special Function Keys
- Zener Diode Protection on All I/O Pins
- Low Power Consumption, Less Than 2 MW per Key
- Usable with Capacitive, Magnetic, Inductive, Hall Effect, or Mechanical Keyboard Switches
- Inputs and Outputs TTL and CMOS Compatible
- Internal Oscillator


## DESCRIPTION

The General Instrument AY-3-4592 is a unique dual pulse scanning encoder and keyboard controller for 112 keys in four modes and 16 programable discrete function keys. ROM programing permits any keys to control the shift control and lock functions The AY-3-4592 can be used with capacitive, inductive (magnetic) or switch closure type switches since it works on pulse detection.


The AY-3-4592 is fabricated with General Instrument N-Channel MOS technology on a single chip containing a 4592 bit ROM, a 128 bit shift register and an internal oscillator.

## BLOCK DIAGRAM



| AY-3-4592 | INSTRUMERAL |
| :---: | :---: |

## PIN FUNCTIONS

| Pin No. | Name | Symbol | Function |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Ground | GND | Ground Pin |  |  |  |  |  |  |
| 2-10 | Data Out | D1-D9 | Data Outputs, D1 through D9 |  |  |  |  |  |  |
| 11 | Data Out | D10 | Data Output D10. See AY-3-4592 options for complete description |  |  |  |  |  |  |
| 12 | Key Inhibit | KBINH | Logic "1" on KBINH will inhibit the processing of Key closures and prevent new output codes. See AY-3-4592 options for other custom options. |  |  |  |  |  |  |
| 13 | Lockout/rollover | LO/RO | High for 2 Key Rollover operation, low for $\mathbf{N}$ Key Rollover operation. This input is a high impedance Schmitt trigger with thresholds of approximately $1 / 4$ (low) and $3 / 4$ (high) of $\mathrm{V}_{\mathrm{cc}}$. This allows easy interfacing with very slow RC circuits for such functions as "repeat delay". LO/RO is internally "anded" with AKD/STB; if either is low, $N$ Key rollover is automatically selected. |  |  |  |  |  |  |
| 14-16 | Y-Address | YA, YB, YC | Y Address lines select one of eight Y inputs through external multiplexer. Scan sequence is Y 7 to YO |  |  |  |  |  |  |
| 17-27, 30-32 | X Outputs | X0-X13, X5-X7 | X output drivers for Matrix scanning. Scan sequence is X 15 to X 0 . Each driver generates 8 pairs of pulses each scanning cycle. |  |  |  |  |  |  |
| 28, 29 | X15, 14 | X15, X14 | X15 is programed as a "discrete output" key in the standard part. Optionally it may be programed as an error flag or as a Matrix drive line. See AY-3-4592 options. Unlike X0-X13, neither X14 nor X15 have associated ROM output codes. These lines are used to enable separate discrete keys to be debounced using an addressable latch as illustrated in figure 2. |  |  |  |  |  |  |
| 33 | Alpha Lock Indicator | ALI | ALI will indicate if op code XX101 is selected. (See operation codes). In the standard device there is no other function. If alpha lock is selected as an option, op code XX101 will result in bit 6 being replaced by bit 9 when a key is depressed. |  |  |  |  |  |  |
| 34 | Shift Lock Indicator | SLI | SLI will indicate if op code XX011 is selected (see operation codes). In the standard device this op code will also select the shift lock function. |  |  |  |  |  |  |
| 35 | Key Pressed | $\overline{\mathrm{KPD}}$ | $\overline{\text { KPD }}$ is used to shift the threshold of the external sense amplifier in order to provide hysteresis to improve noise immunity. In addition KPD may be inverted to provide the data input to the 8 bit latches for decoding X14 and X15. When a key closure is detected KPD is generated causing the 8 bit latch output to go high. See figure 2. |  |  |  |  |  |  |
| 36 | CLOCK | CLK | Resistor/capacitor tie point for the internal oscillator. Nominal frequencies and scan times are shown below: |  |  |  |  |  |  |
|  |  |  |  |  |  |  |  |  |  |
|  |  |  | R | Freq | Scan time | Freq | Scan time | Freq | Scan time |
|  |  |  | $5 K$ 10 K 25K | 13 MHz 8 MHz 4 MHz | 15 msec 23 msec 48 msec | 12 MHz .8 MHz 3 MHz | 17 msec 27 msec 60 msec | 71 MHz 45 MHz 20 MHz | $\begin{aligned} & 28 \mathrm{msec} \\ & 43 \mathrm{msec} \\ & 100 \mathrm{msec} \end{aligned}$ |
| 37 | Reset | $\overline{\text { POR }}$ | Reset clears all internal registers and flip flops. Suggested circuit for power on reset is illustrated in Figure 1. |  |  |  |  |  |  |
| 38 | Matrix Input | $\overline{\text { MATIN }}$ | Input from external multiplexer. Senses signal from $X-Y$ scan of depressed key. |  |  |  |  |  |  |
| 39 | Any Key Down Strobe | AKD | AKD is low when no key is depressed. When a key is depresed AKD goes high. If, while one key is held, a second key is depressed, AKD will go low for 2 clock cycles. |  |  |  |  |  |  |
| 40 | Power | $\mathrm{V}_{\mathrm{cc}}$ | Power supply +5 V input |  |  |  |  |  |  |



## OPERATION

Keys are connected in a $16 \times 8$ matrix. Scanning of the matrix is performed by the encoder in conjunction with an external, multiplexer. The encoder provides a 3 bit binary address (YA, YB, $Y C$ ) used to scan each of eight possible sense lines ( $Y$-lines). The drive lines ( $X$-lines) are each pulsed low by the encoder. If a key is closed, the pulse is coupled from the drive to the sense lines, amplified, and sent to the encoder. When used to encode reactive switches, a detection circuit is necessary between the output of the multiplexer and the MATIN input to the encoder. In this manner, each matrix cross-point is interrogated in turn. Each matrix cross-point is given a unique binary code that is determined by the internal scan counters. This code is used to address a ROM which generates the output codes (such as ASCII or other customer defined codes). The output of the ROM is entered into an output holding register when the key is determined to be a valid key closure. Only the cross-points on XO through X13 can have output codes: X14 and X15 can be used for scanning discrete keys.
An internal oscillator controls the matrix scanning rate. The minimum scanning time is 1.7 ms , at a 1.2 MHz clock. This allows a burst typing speed equivalent to over 250 words/min. When a key is depressed, a matrix address from an $X$ driver and $Y$ input line representing that key is loaded into a 7 bit latch. On the second keyboard scan, the matrix address and the stored address are compared. If the two addresses match, the ROM 10 bit word at that address is loaded into the data holding register. This data remains valid until the next key is depressed. The internal error flag is set, if this option was utilized, whenever there is a mismatch between 7 bit addresses.
Two negative pulses must be detected during the $\overline{\text { MATIN }}$ timing window for the depression to be recognized.

## Keyboard Selection

The AY-3-4592 keyboard encoder can be used with a wide variety of available keyboards. An external multiplexing circuit and one external sense amplifier can be tailored to the user's specific requirements. As shown in Figure 1, the sense amplifier detects changes in voltage caused by variations in the switch impedance as a key is depressed and released. Given the key switch impedances for depressed and released states, the values of $R x$ and Rh can be chosen to guarantee switch closure detection and noise margins. $R x$ is chosen to match the capacitor or reactor time constants. For example, given a variable capacitance keyboard switch with C1 = 100pf, and C2 $=10$ pf for depressed and released positions respectively, with a 1.5 MHz oscillator and $R x=$ 10 Kohm, a depressed key would make a 4.7 volt pulse while a raised key would produce a 2.6 volt pulse. The potentiometer would then be set for best noise immunity with minimum pulse
width, 90 ns for all keys. The hysteresis resistor, Rh , is chosen at roughly ten times the value of $R x$ to provide increased noise immunity for detected key depressions.

## Operation Codes

Depending on the internal programing of the AY-3-4592, keys may have one of three different functions. Keys on matrix line X0 through $X 13$ have, in addition to the output code bits, a function flag bit (FFB). If the FFB is programed as a zero, the key produces a data output when depressed.
When FFB is a one, the key is a "function" key for which bits 1-5 determine the function. These bits are referred to as the op code and are used to provide special functions such as shift, shift lock, alpha lock, etc. Bits 6-10 are not used.
Op codes may be programed to provide data outputs as well as change the mode of operation Data when outputted is not latched as are normal coded outputs.
Bits 1-3 indicate what operation the key will perform; per table 1. Bit 4 programed as one indicates a down-coded key, for which the 10 data bits programed in the shift mode level of ROM are outputted when the key is depressed.
Bit 5 programed as one indicates an up-coded key for which the 10 data bits programed in the control mode level of ROM are outputted when the key is released.
Neither bit 4 nor 5 will have any effect on the operational control of bits 10-3.

| Table 1 |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Op-Code |  |  |  |  | Function |
| 5 | 4 | 3 | 2 | 1 |  |
| X | X | 0 | 0 | 0 | Function key (with up/down codes)* |
| X | $X$ | 0 | 0 | 1 | Right Shift Key |
| X | $X$ | 0 | 1 | 0 | Left Shift Key |
| X | X | 0 | 1 | 1 | Shift Lock Key or Discrete Key (output SLI) |
| X | $X$ | 1 | 0 | 0 | Control Key |
| X | X | 1 | 0 | 1 | Alpha Lock Key or Discrete Key (output ALI) |
| X | 0 | 1 | 1 | 0 | Error Reset Key or discrete key (output X15) |
| X | X | 1 | 1 | 1 | Discrete Key (output D10) |

[^6]
## OPTIONS

| Pin or Function | Option |
| :---: | :---: |
| X15 | X 15 may be programed as <br> 1) an X-output to provide a second set of 8 discrete lines <br> 2) a discrete output which indicates when a function key with op code XX110 is depressed <br> 3) an Error Flag Indicator (EFI). See Error Flag <br> In the AY-3-4592 STD X15 is a discrete output |
| Error Flag | When this option is selected, the AY-3-4592 has the capability of detecting multiple key depressions during the same scan cycle. When selected, the error flag may be programed to generate KBINH and or appear at the X15 output. The error flag may be reset by three methods. If the automatic reset is selected/the flag will be reset when the error causing Key is released. <br> Op-code XX110 may be programed on a function key to reset the error flag. <br> If pin 12 is programed for KBINH error flag will be reset by pulsing pin 12 high. The reset will occur on the negative edge of the KBINH signal; the pulse must be at least 16 clock cycles. <br> Error flag causes KBINH and is automatically reset. |
| Alpha Lock | When programed for Alpha lock, the function key with op-code XX101 will cause the bit 6 output to be replaced by bit 9 . Bit 9 is not altered. Alpha lock is normally used to force printing of upper case characters irrespective of the shift function. Op Code XX101 will also cause an output on ALI (pin 33). <br> When Alpha lock is not programed, op code XX101 will result in an output on ALI (pin 33). <br> Op code XX101 may be programed for momentary action, or latched push-on, push-off alternating action. ALI may be programed for normally low or high output. <br> Op code XX101 is momentary action. ALI is normally low. <br> The AY-3-4592 STD is not programed for Alpha lock, although there will be an output on ALI. |
| Shift Lock | When programed for shift lock, the function key with op-code XX011 will cause normal electronic shift action. Op code XX011 will also cause an output on SLI (pin 34). <br> If shift lock is not programed, op code XX011 will simply cause an output on SLI. SLI may be programed for normally low or high output. <br> The AY-3-4592 STD is programed for shift lock operation with SLI normally low. |
| KBINH | KBINH, Keyboard Inhibit, may be programed to be caused by Pin 12 high, by the error flag, or both. In addition, function keys with up or down codes may be programed, as a group, to be inhibited by KBINH. This is the KCl Out option. <br> When pin 12 is programed to cause KBINH, a high input on pin 12 will inhibit processing of common keys. If a key is depressed while the KBINH signal is present, output and output strobe will be generated when KBINH is released. |
|  | The AY-3-4592 STD has KBINH actuated by pin 12 high, and by the error flag. The KCI In option is used, that is, the function key operation is independent of KBINH. |
| D10 | D10, pin 11, may be programed as the output for the memory bit 10 or as a discrete output. As a discrete output, pin 10 is switched from its normal state (programable as high or low) by the function key with opcode XX111. <br> The AY-3-4592 STD is programed for D10 as a discrete key, normally low. |
| Key Type | Keys may be either normally open or normally closed. The AY-3-4592 STD is designed for normally open keys. |


| GENERAL | AY-3-4592 |
| ---: | ---: |

## ELECTRICAL CHARACTERISTICS

| Maximum Ratings* |  |
| :---: | :---: |
| $\mathrm{V}_{\mathrm{cc}}$ | -0.3 Volts to +7.0 Volts |
| Maximum voltage with | .......... +0.3 Volts |
| Storage Temperature | .. $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperatur | 0 to $70^{\circ} \mathrm{C}$ |

READ ONLY MEMORY
Standard Conditions (unless otherwise noted)
$\mathrm{V}_{\mathrm{cc}}=5.0 \mathrm{~V}{ }_{ \pm 5} \%$
$\mathrm{T}_{\mathrm{A}}=0^{\circ}$ to $70^{\circ} \mathrm{C}$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum ratıng conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Symbol | Min. | Typ.** | Max. | Unit | Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Data Output "1" Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 3.5 | - | - | V | $\mathrm{I}_{\mathrm{OH}}=50 \mu \mathrm{~A}, 25 \mathrm{pf}$ |
| Data Output "0" Voltage | $\mathrm{V}_{\text {OL }}$ | - | - | 0.5 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| All Inputs "1" Voltage | $\mathrm{V}_{\text {IH }}$ | 2.2 | - | - | V | except $\overline{\text { POR, }}$ 2KRO |
| All Inputs " 0 " Voltage | $\mathrm{V}_{\text {IL }}$ | - | - | 0.8 | V | except $\overline{\text { POR, }}$ 2KRO |
| All Inputs Leakage | $\mathrm{I}_{\mathrm{IH}}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {in }}=5 \mathrm{~V}$ |
| X Output "1" Voltage | $\mathrm{X}_{\mathrm{OH}}$ | 3.5 | - | - | V | $\mathrm{I}_{\mathrm{OH}}=50 \mu \mathrm{~A}, 100 \mathrm{pf}$ |
| X Output " 0 " Voltage | $\mathrm{X}_{\mathrm{OL}}$ | - | - | 0.5 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| AKd Output Voltage | $\mathrm{V}_{\text {A }}$ | - | - | 0.6 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| $\overline{\text { MATIN }}$ Input Voltage | $\mathrm{V}_{\mathrm{X}}$ | - | - | 0.4 | V |  |
| $\overline{\text { POR, }}$, KRR high threshold | $V_{\text {SH }}$ | - | 1.3 | - | V | Schmitt trigger |
| $\overline{\mathrm{POR}}, 2 \mathrm{LRO}$ low threshold | $V_{S L}$ | - | 3.7 | - | V | Schmitt trigger |
| Power Supply Current | $I_{\text {cc }}$ | - | 35 | 60 | mA | $\mathrm{Vcc}=5.3 \mathrm{~V}$ |
| Clock Frequency | $\phi$ | 200 | - | 1200 | kHz |  |
| Matrix Delay | $\mathrm{t}_{1}$ | - | - | 250 | ns |  |
| Input pulse width | $\mathrm{t}_{2}$ | 90 | - | - | ns |  |
| X Output pulse width | $\mathrm{t}_{\mathrm{x}}$ | 1.7 | - | - | $\mu \mathrm{s}$ |  |
| X Output fall time | $t_{\text {XF }}$ | - | - | 150 | ns | $\mathrm{V}_{\text {OH }}=4.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{OL}}=0.4 \mathrm{~V}$ |
| $X$ Output rise tıme | $t_{\text {xR1 }}$ | - | - | 150 | ns | $\mathrm{V}_{\text {OH }}=2.4 \mathrm{~V}, \mathrm{~V}_{\text {OL }}=0.4 \mathrm{~V}$ |
| $X$ Output rise time | $t_{\text {XR2 } 2}$ | - | - | 500 | ns | $\mathrm{V}_{\mathrm{OH}}=3.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{OL}}=0.4 \mathrm{~V}$ |
| $X$ Output rise time | $t_{\text {XR } 3}$ | - | - | 1500 | ns | $\mathrm{V}_{\mathrm{OH}}=4.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{OL}}=0.4 \mathrm{~V}$ |
| $\overrightarrow{\mathrm{KPD}}-\mathrm{X}$ Output set time | $\mathrm{T}_{\mathrm{KX}}$ | 500 | - | - | ns |  |
| X Output-KPD hold time | $t_{\text {xK }}$ | 100 | - | - | ns |  |
| Data out to AKD time | $t_{\text {OA }}$ | 1.7 | - | - | $\mu \mathrm{s}$ |  |

[^7]

## CODE CHART / AY-3-4592-STD

## $X X Y$ <br> 000 001 002 002 003 004 005 006 007 010 011 012 013 014 015 016 017 020 021 022 023 024 025 026 027 030 031 032 033 034 035 030 037 040 041 042 043 044 045 040 047 050 051

| 001 | 0000000701 | Right Shift |
| :---: | :---: | :---: |
| 002 | 0.090000010 | Left Shitt |
| 003 | 0200000011 | Shift Lock |
| 004 | 00000n0100 | Control |
| 005 | 0000000101 | ALI |
| 006 | 0000000110 | X15 |
| 007 | 0000000111 | D10 |
| OCE | 0011001110 | 1 |
| 154 | 0111100100 | ESC |
| OCD | 0011091101 | 2 |
| OCD | 0011001101 | 2 |
| 188 | 0110001000 | w |
| 18 E | 0110001110 | 9 |
| 18 C | 0110001100 | S |
| 19 E | 0110011110 | a |
| 185 | 0110000101 | $z$ |
| 175 | 0101111111 | NUL |
| OCB | 0011001011 | 4 |
| OCC | 0011091100 | 3 |
| 180 | 0110001101 | $r$ |
| 19 A | 0110011010 | e |
| 198 | 0110011011 | $d$ |
| 187 | 0110000111 | * |
| 19 C | 0110011100 | c |
| 17 E | 0101111110 | SOH |
| 170 | 0101111101 | STX |
| 0 CA | 0011001010 | 5 |
| 188 | 01100n101! | $t$ |
| 199 | $011001: 001$ | 1 |
| 198 | 0110011000 | 9 |
| 189 | n110001701 | $v$ |
| 190 | 0110011101 | b |
| 176 | 0101111100 | ETX |
| 0 Cr | c011001000 | 7 |
| 069 | 0011001001 | 6 |
| 186 | 0110000110 | $y$ |
| 197 | 0110010111 | - |
| 191 | 0110010001 | $n$ |
| $00^{9}$ | 0011001001 | 6 |
| 00F | 0011011111 | SP |
| 178 | 0101111011 | EOT |
| $0 C^{7}$ | 0011000111 | 8 |
| $0 C^{8}$ | 0011001000 | 7 |
| 18 A | 0110001010 | $u$ |
| 195 | 0110010101 | J |
| 194 | 0110010100 | k |
| 192 | 0110010010 | m |
| $00^{3}$ | 0011010011 |  |
| 174 | 0101111010 | ENQ |
| 0 Co | 0011000110 | 9 |
| 0 C 7 | 0011000111 | 8 |
| 146 | 0110010110 | 1 |
| 190 | 0110010000 | - |
| 194 | 0110010100 | $k$ |
| 193 | 0110816011 | 1 |
| 192 | 0110010010 | m |
| 179 | 0101111001 | ACK |
| OCF | 0011001111 | $\emptyset$ |
| $00^{6}$ | 0011000110 | 9 |
| 178 | 0101111000 | BEL |


| HEX | binary |
| :---: | :---: |
| 3 FF | 1111111111 |
| 3 FF | 111111111 |
| 3 FF | 111111118 |
| 3 FF | 111111111 |
| $3 F F$ | 111:11111 |
| 3 FF | 1111111111 |
| 3 FF | 1111111111 |
| ODE | 0011011110 |
| 154 | 0111100100 |
| 18 F | 0110111114 |
| 000 | 0011011101 |
| $1{ }^{18}$ | n110101000 |
| 1aE | 0110101110 |
| ${ }_{1} \mathrm{~A} C$ | 0110101100 |
| 18 E | 0110111110 |
| $1{ }^{1} 5$ | n110100101 |
| 175 | 0101111111 |
| 003 | n011011011 |
| ODC | 0011011100 |
| 140 | 0110101101 |
| 18 A | 0110111010 |
| 188 | 0110111011 |
| $1 A^{7}$ | 0110100111 |
| 18 C | 0110111100 |
| 178 | 0101111110 |
| 170 | 0101111101 |
| ODA | 0011011010 |
| 1 AB | 0110101011 |
| 189 | 0110111001 |
| 188 | 0110111000 |
| 149 | 0110101001 |
| 180 | 0110111101 |
| 175 | 0101111100 |
| 009 | 0011011001 |
| 009 | 0011011001 |
| 1 Ab | 0110100110 |
| 187 | 0110110111 |
| 181 | 0110110001 |
| ec 3 | 0011000011 |
| 00F | 0011011111 |
| 178 | 0101111011 |
| 005 | 0011010101 |
| 008 | 0011011000 |
| 14 a | 0110101010 |
| 285 | 0110110101 |
| 184 | 0110110100 |
| 182 | 0110110010 |
| 0 C 3 | 0011000011 |
| 17 A | 0101111010 |
| 007 | 0011010111 |
| 007 | 0011010111 |
| 186 | 0110110110 |
| 180 | 0110110000 |
| $1{ }^{1} 4$ | 0110100100 |
| 183 | 0110110011 |
| 142 | C110100010 |
| 179 | 0101211001 |
| 006 | 0011010110 |
| 006 | 0011010110 |
| 178 | 0101111000 |


| HEX | binary |
| :---: | :---: |
| $3 F F$ | 1111111111 |
| 3 FF | 1111111111 |
| 3 FF | 111111111 |
| 3 FF | 1111111111 |
| $3 F F$ | 1111111111 |
| 3 FF | 1111111111 |
| 3 FF | 1111111111 |
| OCE | 0011001110 |
| $1 E 4$ | 0111100100 |
| OCD | 0011001101 |
| OCD | 0011001101 |
| 1 E 8 | 0111101000 |
| 1 EE | 0111101110 |
| 18 C | 0111101100 |
| 1 FE | 0111111110 |
| 1 E5 | 0111100101 |
| 175 | 0101111111 |
| OCB | 0011001011 |
| OCC | 0011001100 |
| 180 | 0111101101 |
| $1 f 4$ | 0111111010 |
| 158 | 0111111011 |
| 1 E 7 | 0111100111 |
| 1FG | 0111111100 |
| 178 | 0101111110 |
| 170 | 0101111101 |
| OCA | 0011001010 |
| $1 \mathrm{~EB}^{\text {B }}$ | 0111101011 |
| 179 | 0111111001 |
| 158 | 0111111000 |
| 1 E 9 | 0111101001 |
| 170 | 0111111101 |
| 176 | 0101111100 |
| 0 C 8 | 0011001000 |
| OC9 | 0011001001 |
| 1 E 6 | 0111100110 |
| 157 | 0111110111 |
| 1 F 1 | 0111110001 |
| $00^{\circ}$ | 0011001001 |
| ODF | 0011011111 |
| 178 | 0101111011 |
| OC7 | 0011000111 |
| OC8 | 0011001000 |
| 1EA | 0111101010 |
| $1 F 5$ | 0111110101 |
| 154 | 0111110100 |
| 152 | 0111110010 |
| 003 | 0011010011 |
| 174 | 0101111010 |
| OC 6 | 0011000110 |
| 0 C 7 | 0011000.111 |
| 156 | 0111110110 |
| 1 F 0 | 0111110000 |
| 154 | 0111110100 |
| 153 | 0111110011 |
| 152 | 0111110010 |
| 179 | 0101111001 |
| OCF | 0011001111 |
| 0 Cb | 0011000110 |
| 178 | 0101111000 |



## CODE CHART / AY-3-4592-STD


lag - Programmed
X15 - Discrete output, normally low
Krror Fig - Set by high on pin 12 or error flag Function keys not inhibited by KBINH
Shift Lag - Reset by releasing error-causing key
Alpha Lock - Inhibted ALI normaliy low, set by OP code XX10
D10 - Discrete output normally low
Key Type - Normally open


Bit 8 - Programmed low for "mono mode" keys, for which the output is the same in all modes Bits 1-7 - "Inverted" ASCII data bits


Fig. 1 SAMPLE KEYBOARD DESIGN ROM CODED KEYS


Fig. 2 SAMPLE KEYBOARD DESIGN DISCRETE FUNCTION KEYS

## GENERAL INSTRUMENT

## Character Generators

| FINCTION | DESCPIPTION . | PART NUMEER | PAGE <br> NUMBER |
| :---: | :---: | :---: | :---: |
| CHARACTER GENERATOR | 2,560 bits organized as $64-5 \times 8$ characters | RO-3-2513 | 2-54 |
|  | 16,384 bits organized as 2048-8 bit words | RO-3-9316ccll | 2-59 |

## Character Generator

## FEATURES

- $64 \times 8 \times 5$ Organızation - Ideal for Systems Requiring a Row Scan $5 \times 7$ Dot Matrix Character Generator
- Single +5 Volt Supply
- TTL Compatible - All Inputs and Outputs
- Static Operation - No Clocks Required
- 450ns Maximum Access Time
- 175mW Maximum Power
- Three-State Outputs - Under the Control of an Output Inhibit Input to Simplify Memory Expansion
Standard ASCII (RO-3-2513/CGR-001) or Totally Automated Custom Programing Available
- Zener Protected Inputs
- Glass Passivation Protection


## DESCRIPTION

The General Instrument RO-3-2513 is a 2560 bit Read-Only Memory organized as 512 five bit words and is ideally suited for use as a Character Generator. Fabricated in the General Instrument advanced GIANT II N-Channel Ion-Implant process to enable operation from a single +5 Volt power supply, the RO-3-2513 can store, for high speed raster scan CRT displays, a full 64 characters in a standard $5 \times 7$ dot matrix format.
The RO-3-2513 is available pre-programed with ASCII encoded $5 \times 7$ characters (General Instrument part no. RO-3-2513/CGR0001) a direct replacement in pin connection, operation, and character font for the Signetics 2513/CM2140. The RO-3-2513 is also available reprogramed with lower case ASCII encoded $5 \times 7$ characters (General Instrument part no. RO-3-2513/CGR-005), a direct replacement for the Signetics 2513/CM3021

## PIN CONFIGURATION

24 LEAD DUAL IN LINE

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| NCO | $\bullet 1$ | 24 | $\mathrm{v}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| NC- | 2 | 23 | PNC |
| NC- | 3 | 22 | РA9 |
| 01. | 4 | 21 | PA8 |
| 02. | 5 | 20 | DA7 |
| 03 | 6 | 19 | ]a6 |
| 04 C | 7 | 18 | चA5 |
| 05 | 8 | 17 | ]a4 |
| NC | 9 | 16 | चA3 |
| GND | 10 | 15 | Pa2 |
| OUT INH ${ }^{\text {a }}$ | 11 | 14 | PA1 |
| NC | 12 | 13 | - C |

A separate publication, RO-3-2513 Custom Coding Information, available from General Instrument Sales Offices, describes the punched card and truth table format for custom programing of the RO-3-2513 memory.

## BLOCK DIAGRAM



## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$\mathrm{V}_{\mathrm{CC}}$ and input voltages (with respect to GND) . . . . . . . . . . . . -0.3 to +0.0 V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature $\left(T_{A}\right) \ldots \ldots \ldots \ldots \ldots \ldots \ldots . . . \ldots 0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted)
$V_{c C}=+5$ Volts $\pm 5 \%$
Operating Temperature $\left(\mathrm{T}_{\mathrm{A}}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Output Loading: One TTL load, $\mathrm{C}_{\mathrm{L}}$ total $=50 \mathrm{pf}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Address, Output Inhibit Inputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | 2.2 | - | - | V |  |
| Logic "0" | $V_{\text {IL }}$ | - | - | 0.65 | V |  |
| Leakage | $\mathrm{I}_{\text {LI }}$ | - | - | 10 | $\mu \mathrm{A}$ |  |
| Data Outputs |  |  |  |  |  |  |
| Logic "1" | $\mathrm{V}_{\text {OH }}$ | 2.2 | - | - | V | $\mathrm{I}_{\text {OH }}=100 \mu \mathrm{~A}$ |
| Logic "0" | $\mathrm{V}_{\text {oL }}$ | - | - | 0.5 | V | $\mathrm{l}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Leakage | $\mathrm{I}_{\text {Lo }}$ | - | - | 10 | $\mu \mathrm{A}$ |  |
| Power Supply Current Icc | - | - | 25 | 35 | mA | Outputs open |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Inputs |  |  |  |  |  |  |
| Cycle Time | $\mathrm{t}_{\mathrm{c}}$ | 400 | - | - | ns |  |
| Capacitance | $\mathrm{C}_{1}$ | - | 5 | 8 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |
| Data Outputs |  |  |  |  |  |  |
| Access Time | $\mathrm{t}_{\text {AcC }}$ | 75 | 250 | 450 | ns |  |
| Inhibit Response Time | $t_{\text {R }}$ | - | 150 | 240 | ns |  |
| Capacitance | Co | - | 8 | 10 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |

[^8]
## TIMING DIAGRAMS


A. ACCESS TIME (ADDRESS TO OUTPUT-OUTPUT INHIBIT AT LOGIC ' 0 ')

B. INHIBIT RESPONSE TIME (ADDRESS INPUTS STABLE)

| INSTRUERAL | RO－3－2513 |
| :---: | :---: |

R0－3－2513－001 STANDARD PATTERN CHARACTER FORMAT（Upper Case ASCII）

The RO－3－2513／CGR－001 is a pre－programed version of the RO－3－2513 series with ASCII encoding and the character font shown below．A logic＂ 1 ＂represents an input or output voltage nominally equal to Vcc（ +5 V ）and a logic＂ 0 ＂represents a voltage nominally equal to GND（OV）．
An example demonstrating the correspondence of device outputs and addressing sequence to the $5 \times 7$ dot matrix font is shown below：
CHARACTER
ADDRESS

| RO－3－2513／CGR－001 <br> Address Bit | A9 | A8 | A7 | A6 | A5 | A4 |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| ASCII Bit | 6 | 5 | 4 | 3 | 2 | 1 |
| ASCII upper case＂S＂ <br> Character | 0 | 1 | 0 | 0 | 1 | 1 |

ROW
ADDRESS

| $A_{3}$ | $A_{2}$ | $A_{1}$ |
| :--- | :--- | :--- | :--- |
| 0 | 0 | 0 |
| 0 | 0 | 1 |
| 0 | 1 | 0 |
| 0 | 1 | 1 |
| 1 | 0 | 0 |
| 1 | 0 | 1 |
| 1 | 1 | 0 |
| 1 | 1 | 1 |$\quad$| 0 | 0 | 0 | 0 | 0 |
| :--- | :--- | :--- | :--- | :--- |
| 0 | 1 | 1 | 1 | 0 |
| 1 | 0 | 0 | 0 | 1 |$\quad$| 1 | 0 | 0 | 0 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- |
| 0 | 1 | 1 | 1 | 0 |
| 0 | 0 | 0 | 0 | 1 |
| 1 | 0 | 0 | 0 | 1 |
| 0 | 1 | 1 | 1 | 0 |


| R0－3－2513／C CHARACTER ADDRESS $A_{6}$ | CGR-O <br> $\mathrm{A}_{5}$ | $\begin{array}{r} 1 \\ A_{9} \\ A_{8} \\ A_{4} A_{7} \end{array}$ | ${ }^{0} 0$ | ${ }^{0} 1$ | $\begin{array}{lll}0 & \\ & 1 \\ & \\ & 0\end{array}$ | $\begin{array}{lll}0 & \\ & 1 \\ & 1\end{array}$ | ${ }^{1} 0$ | ${ }^{1} 0$ | $\begin{array}{lll}1 & \\ & 1 \\ & & 0\end{array}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 0 | 0 | \％ | \＃ | \＃ | $\#$ | \＃ | \＃ | \＃ | \＃ |
| 0 | 0 | 1 | \#\# |  |  |  |  |  |  | $\ldots$ |
| 0 | 1 | 0 | \＃ |  | 苗 |  |  | \#\# |  | \＃\＃ |
| 0 | 1 | 1 | \＃ |  | \％ |  | \％ |  | \＃ | \＃冊 |
| 1 | 0 | 0 | \＃ |  |  | \# | 世界 | \＃\＃ |  | \＃ |
| 1 | 0 | 1 | 표 | \＃ | \# | $\#$ | \＃ | \＃\＃ | \＃ | \＃冉 |
|  | 1 | 0 | 品 | \＃ | \＃ | \＃ | 8 | \＃\＃ | \＃ | \＃ |
|  | 1 |  | \＃ | \＃ | \＃ |  |  | \＃ | $\#$ |  |

RO-3-2513-005 STANDARD PATTERN CHARACTER FORMAT (Upper Case ASCII)

The RO-3-2513/CGR-005 is a pre-programed version of the RO-3-2513 series with ASCII encoding and the character font shown below. A logic " 1 " represents an input or output voltage nominally equal to $\mathrm{V}_{\mathrm{CC}}(+5 \mathrm{~V})$ and a logic " 0 " represents a voltage nominally equal to GND (OV).
An example demonstrating the correspondence of device outputs and addressing sequence to the $5 \times 7$ dot matrix font is shown below:


| INSTRUMENE | RO-3-2513 |
| ---: | :---: |

## TYPICAL CHARACTERISTIC CURVES



## Character Generator

## FEATURES

- 128 Character Row Scan Including 96 Standard ASCII Characters
- $5 \times 7$ Dot Matrix Character Generator
- Single +5 Volt Supply
- TTL Compatible - All Inputs and Outputs
- Static Operation - No Clocks Required
- 450ns Maximum Access Time
- Three-Stage Outputs for Bus Interface
- EPROM 2716 Pin Compatible


## DESCRIPTION

The General Instrument RO1286 is a 16,384 Bit Static Read-Only Memory organized as 2048 8-bit words and is ideally suited for use as a Character Generator. Fabricated in the General Instrument N-Channel Ion Implant process to enable operation from a single +5 Volt power supply, the RO1286 can store for high speed raster scan CRT displays, a full 128 characters in a standard $5 \times 7$ dot matrix format.

PIN CONFIGURATION
24 PIN DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| A7 ${ }^{\bullet 1}$ | 24 | $\mathrm{V}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| A6 2 | 23 | A8 |
| A5 3 | 22 | A9 |
| A 40 | 21 | CS3 |
| A3 5 | 20 | CS1 |
| A2 6 | 19 | A10 |
| A1 ${ }^{1}$ | 18 | CS2 |
| A 08 | 17 | - 05 |
| nc ${ }^{1}$ | 16 | $\bigcirc 4$ |
| NC 10 | 15 | $\bigcirc$ |
| NC 11 | 14 | $\bigcirc 2$ |
| GND 12 | 13 | 21 |

BLOCK DIAGRAM


| GENERAL | RO-3-9316CGII |
| ---: | :---: |
| INSTRUMENT |  |

## DESCRIPTION

The chip is selected by applying the proper logic levels to the 3 -chip select pins (PIN 20, 18, and 21). A 7 -bit binary word must be present at the address inputs, A4-A10 of the character generator, to select a character (one out of the 128 programed characters). The dot matrix of selected characters is generated by cycling line count address input A0-A3 through the line counts necessary to generate the characters. A dot is generated when an output is a" 1 ".
CHIP SELECT
CS1 CS2 CS3

0 0 | 1 |
| :---: |

CHARACTER ADDRESS

| CS1 CS2 CS3 | A10 | A9 | A8 | A7 | A6 | A5 | A4 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 |

LINE COUNT

| A3 | A2 | A1 | A0 |
| :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 1 |
| 0 | 0 | 1 | 0 |
| 0 | 0 | 1 | 1 |
| 0 | 1 | 0 | 0 |
| 0 | 1 | 0 | 1 |
| 0 | 1 | 1 | 0 |
| 0 | 1 | 1 | 1 |
| 1 | 0 | 0 | 0 |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$\mathrm{V}_{\mathrm{CC}}$ and Input Voltages (with Respect to GND) ........... -0.3 V to +8.0 V

Operating Temperature $\left(T_{A}\right) \ldots \ldots \ldots \ldots \ldots \ldots \ldots . . .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$V_{C C}=+5 \mathrm{~V} \pm 5 \%$
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Output Loading: One TTL Load, $C_{L}$ TOTAL $=100 \mathrm{pf}$

## Example of Generating the Character ' H ':



* Exceeding these ratings could cause permanent damage to this device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Address, CHIP SELECT <br> Inputs |  |  |  |  |  |  |
| Logic "1" |  |  |  |  |  |  |
| Logic "0" | $\mathrm{V}_{\mathrm{IH}}$ | 2 | - | - | V |  |
| Leakage | $\mathrm{V}_{\mathrm{IL}}$ | - | - | 0.8 | V |  |
| Data Outputs | $\mathrm{I}_{\mathrm{LI}}$ | - | - | 10 | $\mu \mathrm{~A}$ |  |
| Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | - | V | $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Logic "0" | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Leakage | $\mathrm{I}_{\mathrm{LO}}$ | - | - | 10 | $\mu \mathrm{~A}$ |  |
| Power Supply Current <br> RO-3-9316B-CC1 |  |  |  |  |  |  |

AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Address, CHIP SELECT <br> Inputs |  |  |  |  |  |  |
| Cycle Time | $t_{C}$ | 400 | - | - | ns |  |
| Data Outputs |  |  |  |  |  |  |
| Access Time | $\mathrm{t}_{\mathrm{ACc}}$ | - | 350 | 450 | ns |  |
| Chip Select Response Time | $\mathrm{t}_{\mathrm{R}}$ | - | 100 | 200 | ns |  |
| Capacitance |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\mathrm{l}}$ | - | 5 | 8 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |
| Output Capacitance | $\mathrm{C}_{\mathrm{O}}$ | - | 8 | 10 | pf | $\mathrm{F}=1 \mathrm{MHz}$ |

## TIMING DIAGRAMS



ACCESS TIME (ADDRESS TO OUTPUT-CHIP SELECTED)


CHIP SELECT RESPONSE TIME (ADDRESS INPUTS STABLE)

RO1286 Character set in Hexadecimal Representation:

| Character | Hex No. | Character | Hex No. | Character | Hex No. | Character | Hex No. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| - | 00 | SP | 20 | @ | 40 | 1 | 60 |
| A | 01 | ! | 21 | A | 41 | a | 61 |
| B | 02 | " | 22 | B | 42 | b | 62 |
| C | 03 | \# | 23 | C | 43 | c | 63 |
| D | 04 | \$ | 24 | D | 44 | d | 64 |
| E | 05 | \% | 25 | E | 45 | e | 65 |
| F | 06 | \& | 26 | F | 46 | $f$ | 66 |
| $\underline{\mathrm{G}}$ | 07 | , | 27 | G | 47 | g | 67 |
| H | 08 | 1 | 28 | H | 48 | h | 68 |
| I | 09 | ) | 29 | 1 | 49 | 1 | 69 |
| J | OA | * | 2A | $J$ | 4A | j | 6A |
| K | OB | + | 2B | K | 4B | k | 6B |
| $\underline{L}$ | OC | , | 2C | L | 4C | 1 | 6C |
| M | OD | - | 2D | M | 4D | m | 6D |
| N | OE | - | 2E | N | 4E | n | 6E |
| $\underline{O}$ | OF | 1 | 2F | 0 | 4F | 0 | 6 F |
| $\underline{P}$ | 10 | 0 | 30 | P | 50 | p | 70 |
| $\underline{Q}$ | 11 | 1 | 31 | Q | 51 | q | 71 |
| R | 12 | 2 | 32 | R | 52 | $r$ | 72 |
| S | 13 | 3 | 33 | S | 53 | s | 73 |
| T | 14 | 4 | 34 | T | 54 | t | 74 |
| $\underline{\text { U }}$ | 15 | 5 | 35 | U | 55 | u | 75 |
| $\underline{\text { V }}$ | 16 | 6 | 36 | V | 56 | $v$ | 76 |
| $\underline{W}$ | 17 | 7 | 37 | W | 57 | w | 77 |
| $\underline{X}$ | 18 | 8 | 38 | $X$ | 58 | x | 78 |
| $\underline{Y}$ | 19 | 9 | 39 | Y | 59 | $y$ | 79 |
| $\underline{Z}$ | 1 A | : | 3A | Z | 5A | z | 7A |
| $\uparrow$ | 1B | ; | 3B | [ | 5B | 1 | 7B |
| 1 | 1 C | $<$ | 3C | \} | 5C | ' | 7 C |
| $\leftarrow$ | 1D | $=$ | 3D | ] | 5D | \} | 7D |
| $\rightarrow$ | 1E | $>$ | 3E | $\wedge$ | 5E | $\sim$ | 7E |
| £ | 1F | $?$ | 3F | - | 5F | - | 7F |


| INSTRUERAL | RO-3-9316CGII |
| :--- | :---: |

RO1286 CHARACTER ADDRESS


## InsIRUMENENT

## Speech ROMs

| FUNCTION | DESCRIPTION | PART NUMBER | PACE NUMBER |
| :---: | :---: | :---: | :---: |
| SERAAL ROM | 16,384 bits organized $2048 \times 8$ | SPR016 | 2.64 |
|  | 32.768 bits organized $4096 \times 8$ | SPR032 | 2.70 |
|  | 131,072 bits organized 16K $\times 8$ | SPR128 | $2-73$ |

## SPR016

## 16,384 Bit Serial Read Only Memory

## FEATURES

- $2048 \times 8$ Bit ROM Organization
- Serial In/Parallel Out Shift Register
- Single Supply Voltage +5 V
- Interfaced to SP0256
- Totally Automatic Custom Programing


## DESCRIPTION

The SPR016 is a serial Read Only Memory with $2048 \times 8$ bits of ROM. The data is addressed by an internal program counter (PC). The device also contains a serial in/parallel out shift register, which is used to assemble an address to be parallel loaded into the PC.
The device operates with a single supply (nominally +5 V ) which may be powered down when the system is inactive. When the SPR016 is interfaced to the SP0256 Speech Processor, the ROM enable input is used to avoid bus conflict on the serial out pin during the SPR016 power up.
The SPR016 is constructed on a single monolithic chip utilizing the General Instrument low voltage N -Channel Ion Implant technology.

## PIN CONFIGURATION

16 LEAD DUAL IN LINE


PIN ASSIGNMENTS (PRELIMINARY)

| Pin Number | Name | Function |
| :---: | :--- | :--- |
| 9 | ROM ENABLE | $\begin{array}{l}\text { Active low chip select used in system to eliminate bus conflict at system start-up. When } \\ \text { brought high, ROM ENABLE Tri-States Serial Out. }\end{array}$ |
| 14 | SERIAL IN | $\begin{array}{l}\text { Serial Input used to load } 16 \text { bit address into device. } \\ 10\end{array}$ |
| 7 | SERIAL OUT | Output pin used to shift out data byte. |
| 8 | CS1 | Active high chip select. Will Tri-State Serial output when low. |
| 4 | ROM CLOCK | Active low chip select. Will Tri-State Serial output when high. |
| 1 | VSS | 1.56 MHz clock input from SP0256 speech processor. |
| 2 | C3 | Ground pin. |
| 16 | C2 |  |
| 15 | C1 |  |$\} \quad$|  |
| :--- |
| 11 |

Fig. 1 INTERFACE OF SPR016 ROM TO SP0256 SPEECH PROCESSOR

| INSTRUMERAL | SPR016 |
| :---: | :---: |

TABLE 1 SPR016 CONTROL STATES

| C1 | C2 | C3 | Name | Function |
| :---: | :---: | :---: | :--- | :--- |
| 0 | 0 | 0 | NOP | No action taken <br> Accepts data from the serial input, synchronous to the externally supplied ROM clock. <br> This data is shifted into the ASR holding register in preparation for loading into the PC. <br> Although ASR is 16 bits long, it is not necessary to load all 16 bits of address |
| Aequentially in one ASR load. |  |  |  |  |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*


Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted):
$\mathrm{V}_{\mathrm{DD}}=+4.6 \mathrm{~V}$ to +7.0 V
Operating Temperature $=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

## Supply Current

$$
\begin{array}{lll}
\mathrm{I}_{\mathrm{DD}}=25 \mathrm{~mA} & \mathrm{~V}_{\mathrm{DD}}=7.0 \mathrm{~V} & \text { ROM clock frequency typically } 1.56 \mathrm{MHz} \\
& \mathrm{~V}_{S S}=0.0 \mathrm{~V} & \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}
\end{array}
$$

* Exceeding these ratings could cause permanent damage to this device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  | . |  |  |
| ROM ENABLE, SERIAL IN, CS1, $\overline{\mathrm{CS} 2}$, C1, C2, C3 |  |  |  |  |  |  |
| ROM Clock |  |  |  |  |  |  |
| Logic "0" | $\mathrm{V}_{\mathrm{IL}}$ | 0 | - | 0.6 | V |  |
| Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | $V_{D D}$ | v |  |
| Capacitance | $\mathrm{C}_{\text {IN }}$ | - | - | 10 | pf |  |
| Leakage | lic | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {PIN }}=\mathrm{V}_{\mathrm{DD}}$ Volts, all others grounded |
| Outputs |  |  |  |  |  |  |
| SERIAL OUT |  |  |  |  |  |  |
| Logic "0" | $\mathrm{V}_{\mathrm{OL}}$ | 0 | - | 0.6 | V | $\mathrm{I}_{\mathrm{L}}=1.6 \mathrm{~mA}$ |
| Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.5 | - | $V_{D D}$ | V | $\mathrm{I}_{\mathrm{L}}=-50 \mu \mathrm{~A}$ |
| Leakage | $\mathrm{I}_{\text {LO }}$ | - | - | 10 | $\mu \mathrm{A}$ | Output Tristated |

## AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| ROM Clock Freq. <br> Output Enable Delay Time <br> from RE, CS1, $\overline{\mathrm{CS} 2}$ | F | 1.555 | 1.56 | 1.565 | MHz | 48\% to 52\% Duty Cycle Positive <br> Independent of ROM Clock |
| Output Disable Delay Time <br> from CS1, $\overline{R E}, \overline{C S 2}$ | $\mathrm{t}_{\mathrm{OE}}$ | - | - | 120 | ns |  |
| Serial In Set Up Time | $\mathrm{t}_{\mathrm{OD}}$ | - | - | 120 | ns |  |
| Control Bus Set Up Time | $\mathrm{t}_{\mathrm{SPIN}}$ | 120 | - | - | ns |  |
| Serial Output Access Time | $\mathrm{t}_{\mathrm{CIN}}$ | 180 | - | - | ns |  |
| Address Select Access Time <br> Address Deselect Access Time | $\mathrm{t}_{\mathrm{ACC}}$ | - | - | 360 | ns |  |

## NOTE:

1. $T$ is the cycle time, in nanoseconds of the ROM clock input


Fig. 2 SPR016 INTERFACE TIMING

## SERIAL IN SETUP TIME



CONTROL BUS SETUP TIME


SERIAL OUT ACCESS TIME


## OUTPUT ENABLE RELAY TIME



OUTPUT DISABLE RELAY TIME

ROM ENABLE, CS2


## ADDRESS SELECT ACCESS TIME



ADDRESS DE-SELECT TIME


## 32,768 Bit Serial Read Only Memory

## FEATURES

- $4096 \times 8$ Bit Organization
- Single +5 Volt Supply
- Tri-State Outputs
- Totally Automated Custom Programing
- Zener Protected Inputs
- Glass Passivation Protection


## DESCRIPTION

The General Instrument SPR032 is a 32,768 Bit Serial Read Only Memory organized as 4096 eight-bit words and is ideally suited for interfacing with the SP0256 Speech Processor Fabricated in the General Instrument advanced N-Channel Ion-Implant process to enable operation from a single +5 Volt power supply, up to 10 SPR032s can be interfaced to the SP0256 without buffering.

PIN CONFIGURATION
16 PIN DUAL IN LINE


GENERAL
PIN ASSIGNMENTS (PRELIMINARY)

| Pin Number | Name | Function |
| :---: | :---: | :---: |
| 9 | ROM ENABLE | Active low chip select used in system to eliminate bus conflict at system start-up. When brought high, ROM Enable Tri-States Serial Out (Pin 3). |
| 14 | SERIAL IN | Serial Input used to load 16 bit address into device. |
| 10 | SERIAL OUT | Output pin used to shift out data byte. |
| 7 | CS1 | Active high chip select. Will Tri-State Serial output when low. |
| 8 | $\overline{\mathrm{CS} 2}$ | Active low chip select. Will Tri-State Serial output when high. |
| 4 | ROM CLOCK | 1.56 MHz clock input from SP0256 speech processor. |
| 1 | $\mathrm{V}_{\text {ss }}$ | Ground pin. |
| 2 | C3 |  |
| 16 | C2 | Control pins decoded to determine device function. |
| 15 | C1 |  |
| 11 | VDD | Positive supply pin ( +4.6 V to +7.0 V ). |



Fig. 1 INTERFACE OF SPR032 ROM TO SP0256 SPEECH PROCESSOR

| INSTRUERAL | SPRO32 |
| ---: | :---: |

TABLE 1 SPR032 CONTROL STATES

| C1 | C2 | C3 |  | FUNCTION |
| :---: | :---: | :---: | :--- | :--- |
| 0 | 0 | 0 | NOP |  |
| 0 | 0 | 1 | ASR Load | No action taken. <br> Accepts data from the serial input, synchronous to the externally supplied ROM clock. <br> This data is shifted into the ASR holding register in preparation for loading into the PC. <br> Although ASR is 16 bits long, it is not necessary to load all 16 bits of address <br> sequentially in one ASR load. |
| 0 | 1 | 0 | PC Load | Loads the contents of the ASR register into the PC. |
| 0 | 1 | 1 | DSR Load | Loads the 8 bits of data pointed to by the present value of the least significant 11 bits of <br> the PC into the data output shift register (DSR). At the completion of the DSR load the |
| 1 | 0 | 0 | DSR Shift Out | PC is incremented. <br> Shifts out the contents of DSR to the serial out pin, synchronous to the ROM clock. |
| 1 | 0 | 1 | RET. Register Load | Loads the return register (RET) with the current value of the P.C. |
| 1 | 1 | 0 | Loads the PC with the contents of the RET register. |  |
| 1 | 1 | 1 | NOP | No action taken. |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings

VDD.... . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -3 to +12V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$


## Standard Conditions (unless otherwise stated)

$\mathrm{V}_{\mathrm{DD}}=+4.6 \mathrm{~V}$ to +7.0 V
Operating Temperature $=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

## Supply Current

$I_{D D}=25 \mathrm{~mA}$

$$
V_{D D}=7.0 \mathrm{~V}
$$

ROM clock frequency typically 1.56 MHz

$$
\mathrm{V}_{\mathrm{ss}}=0.0 \mathrm{~V}
$$

$\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$
*Exceedıng these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

DC ChARACTERISTICS

| Characteristics | Sym | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |
| ROM ENABLE, SERIAL IN, |  |  |  |  |  |
| CS1, CS2, C1, C2, C3 |  |  |  |  |  |
| ROM Clock |  |  |  |  |  |
| Logic 0 | $\mathrm{V}_{\mathrm{IL}}$ | 0 | 0.6 | V |  |
| Logic 1 | $\mathrm{V}_{\mathrm{IH}}$ | 24 | $V_{D D}$ | $v$ |  |
| Capacitance | $\mathrm{C}_{\text {IN }}$ | - | 10 | pf |  |
| Leakage | ILC | - | 10 | $\mu \mathrm{A}$ | V Pin $=\mathrm{V}_{\mathrm{DD}}$ Volts, all others grounded |
| Outputs |  |  |  |  |  |
| SERIAL OUT |  |  |  |  |  |
| Logic 0 | $\mathrm{V}_{\mathrm{OL}}$ | 0 | 0.6 | V | $\mathrm{I}_{\mathrm{L}}=1.6 \mathrm{~mA}$ |
| Logic 1 | $\mathrm{V}_{\mathrm{OH}}$ | 2.5 | $\mathrm{V}_{\mathrm{DD}}$ | V | $\mathrm{I}_{\mathrm{L}}=-50 \mu \mathrm{~A}$ |
| Leakage | ILO | - | 10 | $\mu \mathrm{A}$ | Output Tristated |

## TIMING DIAGRAM



SPR128

## 131,072 Bit Serial Read Only Memory

## FEATURES

- $16 \mathrm{~K} \times 8$ Organization
- Single +5 Volt Supply
- Tri-State Serial Output
- Totally Automated Custom Programing
- Zener Protected Inputs
- Glass Passivation Protection


## DESCRIPTION

The General Instrument SPR128 is a 131,072 Bit Serial Read Only Memory organized as 16,384 eight-bit words and is ideally suited for interfacing with the SP0256 Speech Processor. Fabricated in the General Instrument advanced N -Channel Ion Implant process to enable operation from a single +5 Volt power supply, up to 4 SPR128s can be interfaced to the SP0256 without buffering.

## PIN CONFIGURATION

24 LEAD DUAL IN LINE

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{v}_{\mathrm{ss}}$ | ${ }^{\bullet} 1$ | 24 | C2 |
|  | 2 | 23 | C1 |
| NC | 3 | 22 | SER IN |
| ROM CLOCK | 4 | 21 | NC |
| NC | 5 | 20 | NC |
| NC | 6 | 19 | NC |
|  | 7 | 18 | NC |
| NC | 8 | 17 | NC |
| NC | 9 | 16 | NC |
|  | 10 | 15 | $V_{D D}$ |
| CS1 | 11 | 14 | SER OUT |
|  | 12 | 13 | ROM ENABLE |

$\square$
INSTRUMENT

## PIN ASSIGNMENTS

| Pin Number | Name | Function |
| :---: | :---: | :---: |
|  | ROM ENABLE | Active low chip select used in system to eliminate bus conflict at system start-up. When brought high, $\overline{\text { ROM ENABLE Tri-States Serial Out. }}$ |
|  | SERIAL IN | Serial Input used to load 16 bit address into device. |
|  | SERIAL OUT | Output pin used to shift out data byte. |
|  | CS1 | Active high chip select. Will Tri-State Serial output when low. |
|  | $\overline{\mathrm{CS} 2}$ | Active low chip select. Will Tri-State Serial output when high. |
|  | ROM CLOCK | 1.56 MHz clock input from SP0256 speech processor. |
|  | $\mathrm{V}_{\text {ss }}$ | Ground pin. |
|  | $\mathrm{C} 31$ |  |
|  | $\left.\begin{array}{l}\mathrm{C} 2 \\ \mathrm{C} 1\end{array}\right\}$ | Control pins decoded to determine device function |
|  | VDD | Positive supply pin ( +4.6 V to +7.0 V ) |



Fig. 1 INTERFACE OF SPR 128 ROM TO SP 0256 SPEECH PROCESSOR

## TABLE 1 SPR128 CONTROL STATES

| C1 | C2 | C3 |  | Function |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | NOP | No action taken. |
| 0 | 0 | 1 | ASR Load | Accepts data from the serial input, synchronous to the externally supplied ROM clock. This data is shifted into the ASR holding register in preparation for loading into the PC. Although ASR is 16 bits long, it is not necessary to load all 16 bits of address sequentially in one ASR load. |
| 0 | 1 | 0 | PC Load | Loads the contents of the ASR register into the PC. |
| 0 | 1 | 1 | DSR Load | Loads the 8 bits of data pointed to by the present value of the least significant 14 bits of the PC into the data output shift register (DSR). At the completion of the DSR load the $P C$ is incremented. |
| 1 | 0 | 0 | DSR Shift-Out | Shifts out the contents of DSR to the serial out pin, synchronous to the ROM clock. |
| 1 | 0 | 1 | RET Register Load | Loads the return register (RET) with the current value of the PC. |
| 1 | 1 | 0 | Return | Loads the PC with the contents of the RET register. |
| 1 | 1 | 1 | NOP | No action taken |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings


Storage Temperature............................
Lead Temperature (soldering) $10 \mathrm{Sec} \ldots \ldots \ldots \ldots \ldots \ldots \ldots . .+333^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated)
$\mathrm{V}_{\mathrm{DD}}=+4.6 \mathrm{~V}$ to +7.0 V
Operating Temperature $=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

## Supply Current

$$
\begin{array}{lll}
\mathrm{I}_{\mathrm{DD}}=25 \mathrm{~mA} & \mathrm{~V}_{\mathrm{DD}}=7.0 \mathrm{~V} & \mathrm{ROM} \text { clock frequency typically } 156 \mathrm{MHz} \\
& \mathrm{~V}_{\mathrm{SS}}=0.0 \mathrm{~V} & \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}
\end{array}
$$

*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

DC CHARACTERISTICS

| Characteristics | Sym | Min | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Inputs |  |  |  |  |  |
| ROM ENABLE, SERIAL IN, |  |  |  |  |  |
| CS1, CS2, C1, C2, C3 |  |  |  |  |  |
| ROM Clock | $V_{I L}$ | 0 | 0.6 | V |  |
| Logıc 0 | $V_{I H}$ | 2.4 | $V_{D D}$ | V |  |
| Logic 1 | $\mathrm{C}_{\mathrm{IN}}$ | - | 10 | pf |  |
| Capacitance | $\mathrm{C}_{\mathrm{IN}}$ | - | 10 | $\mu \mathrm{~A}$ | V Pin $=V_{\mathrm{DD}}$ Volts, all others grounded |
| Leakage |  |  |  |  |  |
| Outputs |  |  |  |  |  |
| SERIAL OUT | $\mathrm{V}_{\mathrm{OL}}$ | 0 | 0.6 | V | $\mathrm{I}_{\mathrm{L}}=1.6 \mathrm{~mA}$ |
| $\quad$ Logic 0 | $\mathrm{V}_{\mathrm{OH}}$ | 25 | $\mathrm{~V}_{\mathrm{DD}}$ | V | $\mathrm{I}_{\mathrm{L}}=-50 \mu \mathrm{~A}$ |
| Logic 1 | $\mathrm{I}_{\mathrm{LO}}$ | - | 10 | $\mu \mathrm{~A}$ | Output Tristated |
| Leakage |  |  |  |  |  |

## TIMING DIAGRAM




# Electrically Alterable Non-Volatile Memory 

| FUNCTION | DESCRIPTION | PART NUMBER | Page <br> NUMBER |
| :---: | :---: | :---: | :---: |
| Electrically Alterable Non-Volatle Memory |  |  |  |
| 82 BIT EAROM | 82 bits organized $82 \times 1$ | ER0082 | 3-5 |
| $\begin{aligned} & 700 \text { BIT } \\ & \text { SERIAL EAROM } \end{aligned}$ | 700 bits organized $50 \times 14$ | ER1451 | 3-8 |
| 1400 BIT SERIAL EAROM | 1400 bits organized $100 \times 14$ | En1400 | 3-11 |
| - 512 BIT EAROM | 512 bits organized $32 \times 16$ | ER2051 | 3-14 |
|  |  | En20511R | 3-14 |
|  |  | ER2051HR | 3-14 |
| 512 BIT EAROM | 512 bits organized $64 \times 8$ | ER2055 | 3-17 |
|  |  | ER2055iP | 3-17 |
|  |  | ER2055HR | 3-17 |
| 1K N-CHANNEL. EEPROM | 1 K bits organized $128 \times 8$ | ER5901 | 3-20 |
|  |  | ER59011R | 3-20 |
|  |  | ER5901HR | 3-20 |
| 4096 BIT EAROM | 4096 bits organized $1024 \times 4$ | ER3400 | 3-22 |
|  |  | ER34001/IR | 3-22 |
|  |  | ER3400HR | 3-22 |
| 8992 BIT EAROM | 8192 bits organized $2048 \times 4$ | ER28101R | 3-28 |
|  |  | ER2B10HR | 3-28 |
| 16 K N-CHANNEL EEPROM | 16K bits organized $2048 \times 8$ | ER5716 | 3-32 |
|  |  | ER5716:1R | 3-32 |
|  |  | ER5゙7164R | 3-32 |
| WORD ALTERABLE 16K BIT EEPROM | Electrically word alterable 16 K bits organized $2048 \times 8,5 \mathrm{~V}$ operation in read mode. | ER5816 | 3-36 |
|  |  | ER58161R | 3-36 |
|  |  | ER5816HR | 3-36 |
| WORD ALTERABLE 16 K BIT EEPROM | Electrically word alterable 16 K bits organized $2048 \times 8,5 \mathrm{~V}$ operation in all modes. | ER5916 | 3-41 |
|  |  | ER5916IR | 3-41 |
|  |  | ER5916HR | 3-41 |
| Non-Volatile Static RAM |  |  |  |
| $4 \mathrm{~K} \mathrm{~N}-\mathrm{CHANNEL}$ NON-VOLATLLE STATIC RAM | 4 K bits organized $512 \times 8$ | ER5304 | 3-48 |

## GENERAL <br> INSTRUMENT

## Electrically Alterable Non-Volatile Memory

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| 82 BIT EAROM | 82 bits organized $82 \times 1$ | ER0082 | 3-5 |
| 700 BIT SERIAL EAROM | 700 bits organized $50 \times 14$ | ER1451 | 3-8 |
| 1400 BIT SERIAL EAROM | 1400 bits organized $100 \times 14$ | ER1400 | 3-11 |
| 512 BIT EAROM | 512 bits organized $32 \times 16$ | ER2051 | 3-14 |
|  |  | ER20511R | 3-14 |
|  |  | ER2051HR | 3-14 |
| 512 BIT EAROM | 512 bits organized $64 \times 8$ | ER2055 | 3-17 |
|  |  | ER2055iR | 3-17 |
|  |  | ER2055HR | 3-17 |
| 1K N-CHANNEL. EEPROM | 1 K bits organized $128 \times 8$ | ER5901 | 3-20 |
|  |  | ER5901IR | 3-20 |
|  |  | ER5901HR | 3-20 |
| 4096 BIT EAROM | 4096 bits organized $1024 \times 4$ | ER3400 | $3-22$ |
|  |  | ER34001/IR | 3-22 |
|  |  | En3400HR | 3-22 |
| 8192 BIT EAROM | 8192 bits organized $2048 \times 4$ | ER28101R | 3-28 |
|  |  | ER2810HR | 3-28 |
| TGK N-CHANNEL. EEPROM | 16 K bits organized $2048 \times 8$ | ER5716 | 3-32 |
|  |  | ER5716IR | 3-32 |
|  |  | ERS716HR | 3-32 |
| WORD ALTERABLE 16K BIT EEPROM | Electrically word alterable 16 K bits organized $2048 \times 8,5 \mathrm{~V}$ operation in read mode. | ER5816 | 3-36 |
|  |  | ER5816IR | 3-36 |
|  |  | ER5816HR | 3-36 |
| WORD ALTERABLE 16 K BIT EEPROM | Electrically word alterable 66 K bits organized $2048 \times 8,5 \mathrm{~V}$ operation in alf modes. | ER5916 | 3-41 |
|  |  | ER5916IR | 3-41 |
|  |  | ER5916HR | 3-41 |

## 82 Bit Electrically Alterable Read Only Memory

## FEATURES

- $82 \times 1$ bit organizatıon
- Addressing by two 4-bit BCD digits
- $+5,-30 \mathrm{~V}$ power supplies
- Set inputs have debounce circuits
- Bit erasable
- $100 \mu \mathrm{sec}$ Read Access Time
- Minimum Data Retention, 7 years unpowered, 2 years powered
- P-Channel output transistor, open drain, pull down resistor
- Control, Address and Data Inputs TTL or CMOS compatible
- Ideally suited for T V. receiver channel selection


## DESCRIPTION

The ER0082 is a $82 \times 1$ bit electrically alterable read only memory. This device can be used as part of a television receiver tuner control system. The memory is programmed by the user to maintain a record of channels the user wishes to be tuned, and is non-volatile in that the information stored within is not affected by the condition of or the sequencing of power supplied to the chip.

## OPERATION

## Memory Address

The address is provided by two positive logic binary coded decimal (BCD) digits, LSD $\left(A_{0}-A_{3}\right)$ and MSD ( $A_{4}-A_{7}$ ) (least and most significant digits), i e. 8 bits which supply the address of a bit in the memory. There is an address in memory associated with each of the BCD numbers 2 through 83. Addresses outside the range of 2 to 83 at the LSD and MSD inputs do not cause any modification of the stored bits or change in the output data

Example. Address $83=10000011\left(A_{7} . A_{0}\right)$
Address $2=00000010\left(A_{7} . . A_{0}\right)$
Address changes must occur only during CS high and must be stable at least $20 \mu$ s before $\overline{\mathrm{CS}}$ goes low.

## Memory Read

The negative transition of $\overline{\mathrm{CS}}$ (from a " 1 " level to a " 0 " level) initiates a memory read cycle, except when the transition occurs during a memory alteration cycle, in which case the transition is ignored A read cycle will cause the DATA OUT pin to indicate the state of the memory bit read The DATA OUT pin will retain the state untll either CS goes to " 1 " or a memory alteration cycle is initiated. DATA OUT will show the contents of the address $100 \mu \mathrm{~s}$ after $\overline{\mathrm{CS}}$ starts falling When $\overline{\mathrm{CS}}$ is high the DATA OUT pin is low. The DATA OUT pin is internally pulled up to the positive supply, $V_{\text {ss }}$ and for a " 0 " output the DATA OUT pin floats with an external pull-down ( $10 \mathrm{~K} \Omega$ ) to ground.

## Memory Alteration

A memory alteration cycle is initiated only when the SET DATA " 0 " or the SET DATA " 1 " input, but not both, has been continuously at " 0 " for the specified debounce time. This allows an input to be entered via a contact closure to ground using switches. These inputs are connected to $V_{\text {ss }}$ via internal pull-ups During the alteration cycle the address is held latched within the LSI. Changes in the address and SET DATA inputs are ignored, and the DATA OUT pin is held at " 0 " Only one memory bit may be erased or written during any single memory alteration cycle The alteratıon cycle, once ınitiated, must go to completion. Upon

completion of an alteration cycle or the fall of CS whichever occurs last, the memory bit corresponding to the current input address will be read and output on the DATA OUT terminal. A memory read of a bit altered due to SET DATA " 0 " input will cause the DATA OUT pin to be " 0 " Similarly, a read of a bit altered due to a SET DATA " 1 " input will cause the DATA OUT pin to be " 1 ". The SET DATA inputs have internal circuits to provide delays for interfacing to mechanical switches or relays. Each successful debounce of a SET DATA input will initiate only one memory alteration cycle. Another alteration cycle will not occur until both


SET DATA inputs have remained continuously at a " 1 " level for the specified release time and only one of the SET DATA inputs has again been successfully debounced. After an alteration cycle is complete, a read cycle may not be initiated by CS until 3 cycles of the clock on the "Timing" input pin have occurred (about 12.5 ms for a nominal 200 Hz frequency).

## Timing

This is an input provided for external components used for a timıng reference. A resistor ( 680 K ) and a capacitor ( $.01 \mu \mathrm{~F}$ ) may be connected to this input to provide a 200 Hz nominal clock frequency A lower capacitor or resistor value will provide a higher frequency The timer will run only during a read cycle, alteration cycles, or while timing a debounce or release. Increasing the clock frequency will shorten these times. The frequency can vary from 50 Hz min to 500 Hz max. and may be measured on the timing pın

## PIN FUNCTIONS

| NAME | FUNCTIONS |
| :---: | :---: |
| $\mathrm{A}_{0}-\mathrm{A}_{7}$ | Address bus used to select 1 of 82 addresses |
| $\overline{C S}$ | Chip select. An active low sıgnal which enables or disables the data out pin. |
| Data Out | DATA OUT is a single bit indicating the state of the addressed memory cell. |
| Set Data 0 <br> Set Data 1 | These are inputs by which the user can modify the memory contents. |
| TI | Provides a timing reference for internal timing cycles |
| TEST | A TEST pin which provides a connection to $\mathrm{V}_{\mathrm{m}}$, an internal voltage used for evaluating chip memory performance in normal operation this pin should be left unconnected. |
| $\mathrm{V}_{\text {ss }}$ | Substrate Supply. Nominally +5 V . |
| $\mathrm{V}_{\text {NEG }}$ | Power supply input Nominally -30V |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All input and outputs (except $\mathrm{V}_{\text {NEG }}$ ) with respect to $\mathrm{V}_{\text {SS }} \ldots-20 \mathrm{~V}$ to +0.3 V
$\mathrm{V}_{\mathrm{NEG}}$ with respect to $\mathrm{V}_{\mathrm{SS}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -40 V
Storage temperature (No Data Retention) . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage temperature (with Data Retention)
Operating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Unpowered . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)

[^9]$\mathrm{V}_{\mathrm{SS}}=+4.5 \mathrm{~V}$ to +80 V
$V_{S S}-V_{N E G}=-32 \mathrm{~V}$ to -38 V
Operatıng Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |
| Input Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | $V_{s s}-20$ | $V_{\text {ss }}+.3$ | V |  |
| Input Logic "0" | $\mathrm{V}_{\mathrm{IL}}$ | $v_{\text {ss }}-10$ | $V_{\text {ss }}-4.1$ | V |  |
| Input Leakage | $\mathrm{I}_{\mathrm{L}}$ | - | 10 | $\mu \mathrm{A}$ |  |
| Output Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | - | $\mathrm{V}_{\mathrm{ss}}-.5$ | V | @ 0.5mA |
| Power Supply | Iss | 4 | 20 | mA |  |
| Power Dissipation | Pss | 130 | 700 | mW |  |
| AC CHARACTERISTICS |  |  |  |  |  |
| Read Cycle Time | - | 130 | - | $\mu \mathrm{s}$ |  |
| Read Access Time | ta | - | 100 | $\mu \mathrm{s}$ | from fall of $\overline{C S}$ |
| Memory Alteration Time | - | 200 | - | ms |  |
| Time between Memory Alteration Cycles | tc | 12.5 | - | ms |  |
| Debounce Time for Changing Memory | $t_{B}$ | 12.5 | 37.5 | ms |  |
| Address Setup Time | ts | 20 | - | $\mu \mathrm{s}$ |  |
| Address Hold Time | $\mathrm{tH}_{4}$ | 100 | - | $\mu \mathrm{s}$ |  |
| Reset Time | to | 2 | 30 | $\mu \mathrm{s}$ | from rise of $\overline{C S}$ |
| Input Rise \& Fall Times | - | . 03 | 30 | ms | on all inputs |
| EAROM CHARACTERISTICS |  |  |  |  |  |
| Data Retention, Power Off (Storage) | - | 7 | - | Years | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Data Retention, Power On | - | 2 | - | Years | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ |
| Read Cycles Per Cell | - | $10^{7}$ | - | - | no loss of data |
| Erase/Write Cycles per Cell | - | $10^{3}$ | - | cycles | 10 year retention |
| Erase/Write Cycles per Cell | - | $10^{4}$ | - | cycles | 1 year retention |

TIMING DIAGRAMS
READ OPERATION

OR SET DATA 1


NOTE 1 Data will be valid until the next positive $\overline{C S}$ transition or until initiation of an alteration cycle


NOTE 1 Address may change here, but should not change if verification of correct alteration is
required

## 700 Bit Serial Electrically Alterable Read Only Memory

## FEATURES

- 50 word $\times 14$ bit organization
- Addressing by two consecutive one-of-ten codes
- Word alterable
- 10 year data storage
- TTL compatible signal levels
- Write/erase time 10 ms


## DESCRIPTION

The ER1451 is a serial input/output 700 bit electrically erasable and reprogrammable ROM, organızed as 50 words of 14 bits each. Data and address are communicated in serial form via a one-pin bidirectional bus. Its operation is similar to the ER1400 in all respects, except that it has only half the memory capacity The address, in the form of two consecutive one-of-ten codes, is shifted in with the fırst ten bits indıcatıng the MSD Address 49 is the highest valid address For this reason during the first five clock cycles of an ACCEPT ADDRESS function the data input is ignored

Mode selection is by a 3 bit code applied to C1, C2 and C3
Before writing, a selected locatıon must be preconditioned by an Erase operation. Data is then stored by internal negative writing pulses that selectively tunnel charge into the oxide-nitride interface of the gate insulator of the 700 MNOS memory transistors. When the writing voltage is removed the charge trapped at the interface is manifested as a negative shift in the threshold voltage of the selected memory transistors.

## PIN CONFIGURATION

14 LEAD DUAL IN LINE

N.C. = No external connection for normal usage

BLOCK DIAGRAM


## PIN FUNCTIONS

| Name | Function |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Data | In the Accept Address and Accept Data modes, this pin is an input pin for address and data respectively When outputting data it has TTL drive capability, while in all other modes it is left floating. |  |  |  |
| $\mathrm{V}_{\text {M }}$ | Used for testing purposes only Must be left unconnected for normal operation |  |  |  |
| $\mathrm{V}_{\text {Ss }}$ | Chip substrate Normally connected to +5 V |  |  |  |
| $V_{G G}$ | DC supply Normally connected to -30 Volt supply |  |  |  |
| Clock | Timing reference Required for all operations May be left at logic one when device is in standby |  |  |  |
| C1, C2, C3 | Mode control pins Their operation is as follows |  |  |  |
|  | C | C2 | C3 | Function |
|  |  | 1 |  | Standby-The output buffer is left floating If the clock is maintained, the contents of the Address and Data Registers will remain unchanged |
|  | 1 | 0 | 0 | Accept Address-Data presented at the I/O pin is shifted into the Address Register with each clock pulse Addressing is by two consecutive one-of-ten codes |
|  | 0 | 1 | 1 | Read-The address word is read from memory into the data register. |
|  | 0 | 1 | 0 | Shift Data Out-The output driver is enabled and the contents of the Data Register are shifted out one bit with each clock pulse |
|  | 1 | 0 | 1 | Erase-The word stored at the addressed location is erased to all zeroes. |
|  |  | 0 |  | Accept Data-The data register accepts serial data presented at the I/O pin The Address Regıster remains unchanged |
|  |  | 0 |  | Write-The word contained in the Data Register is written into the location designated by the Address Register |
|  |  | 1 |  | Not Used |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs (except $\mathrm{V}_{\mathrm{GG}}$ ) with respect to $\mathrm{V}_{\mathrm{SS}} . .-20 \mathrm{~V}$ to +03 V $V_{G G}$ with respect to $V_{S S}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -40 V
Storage temperature (No Data Retention) . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Storage temperature (with Data Retention)

Operatıng . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$
Unpowered . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+80^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)
$\mathrm{V}_{\mathrm{SS}}=+5$ Volts $\pm 5 \%$ GND $=0$ Volts
$V_{G G}=-30$ Volts $\pm 5 \%$
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristics | Sym | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Input Logic "0" | $V_{\text {IL }}$ | $V_{S S}-150$ | - | +08 | Volts |  |
| Input Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | $V_{S S}-1.5$ | - | $V_{S S}+03$ | Volts |  |
| Input Leakage | $\mathrm{I}_{\mathrm{L}}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=-10 \mathrm{~V}$ |
| Output Logic "0" | $\mathrm{V}_{\mathrm{OL}}$ | - | - | +04 | Volts | $\mathrm{I}_{\mathrm{OL}}=32 \mathrm{~mA}$ |
| Output Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | $V_{\text {SS }}-1.5$ | - | $\mathrm{V}_{\text {SS }}$ | Volts | $\mathrm{I}_{\mathrm{OH}}=3.2 \mathrm{~mA}$ |
| Power Consumption | $\mathrm{P}_{\mathrm{GG}}$ |  | - | 300 | mW |  |
| Power Supply Current | $\mathrm{I}_{\mathrm{GG}}$ | - | - | 80 | mA |  |
|  | Iss | - | - | 8.0 | mA |  |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Clock Frequency | $\mathrm{f} \phi$ | 100 | 140 | 170 | kHz |  |
| Clock Duty Cycle | D $\phi$ | 35 | 50 | 65 | \% |  |
| Write Time | tw | 10.0 | 150 | 240 | ms |  |
| Erase Time | te | 100 | 150 | 240 | ms |  |
| Rise, Fall Time | tr, tf | - | - | 1.0 | $\mu \mathrm{s}$ |  |
| Control, Data Set Up Tıme | $\mathrm{t}_{\mathrm{CS}}$ | 1 | - | - | $\mu \mathrm{s}$ |  |
| Control, Data Hold Tıme | $\mathrm{t}_{\mathrm{CH}}$ | 0 | - | - | $\mu \mathrm{s}$ |  |
| Propagatıon Delay | $\mathrm{t}_{\text {PW }}$ | - | - | 200 | $\mu \mathrm{s}$ | Load: 2 TTL gates +100 pf |
| Non-Volatıle Data Storage | $\mathrm{T}_{\text {S }}$ | 10 | - | - | Years | See Note 1. |
| Number of Erase/Write Cycles | $\mathrm{N}_{\mathrm{W}}$ | - | - | $10^{4}$ | - | Per word. See Note 2. |
| Number of Read Accesses Between Writes | $\mathrm{N}_{\text {RA }}$ | $10^{9}$ | - | - | - | Per word |

[^10]* Exceedıng these ratings could cause permanent damage to the device This is a stress rating only and functional operation of this device at these conditions is not implied-operatıng ranges are specified in Standard Conditions. Exposure to absolute maxımum ratıng conditions for extended perıods may affect device reliability Data labeled "typical" is presented for design guidance only and is not guaranteed.
$\square$


## TIMING DIAGRAMS



Fig. 1 ACCEPT ADDRESS


Fig. 2 READ


Fig. 4 ERASE


Fig. 6 WRITE

$T_{\text {PW }}$ measured initially from control line transition to data out then measured from the positive clock edges to data changes Timing measurements made at $V_{S S}-2$ and 08 Volt points

Fig. 3 SHIFT DATA OUT


Fig. 5 ACCEPT DATA


Fig. 7 INPUT TIMING

## 1400 Bit Serial Electrically Alterable Read Only Memory

## FEATURES

- 100 word $x 14$ bit organization
- Addressing by two consecutive one-of-ten codes
- Single - 35 Volt supply
- Word alterable
- 10 year data storage
- MOS compatible signal levels

■ Write/erase time. 10 ms

## DESCRIPTION

The ER1400 is a serial input/output 1400 bit electrically erasable and reprogrammable ROM, organized as 100 words of 14 bits each. Data and address are communicated in serial form via a one-pin bidirectional bus.

Mode selection is by a 3 bit code applied to $\mathrm{C} 1, \mathrm{C} 2$ and C 3 .
Before writing, a selected location must be preconditioned by an Erase operation Data is then stored by internal negative writing pulses that selectively tunnel charge into the oxide-nitride interface of the gate insulator of the 1400 MNOS memory transistors. When the writing voltage is removed the charge trapped at the interface is manifested as a negative shift in the threshold voltage of the selected memory transistors.

PIN CONFIGURATIONS Standard package 14 LEAD DUAL IN LINE

Special Order Package 8 LEAD TO-8 (ER1400T)


NC = No external connection for normal usage

BLOCK DIAGRAM


| INSTRUMERENT | ER1400 |
| :---: | :---: |

PIN FUNCTIONS

| Name | Function |
| :--- | :--- |
| Data |  |
| $V_{M}$ |  |
| $V_{S S}$ |  |
| $V_{G G}$ |  |
| $C 1, C 2, C 3$ |  |$\quad$| In the Accept Address and Accept Data modes, this pin is an input pin for address and data respectively. |
| :--- |
| When outputting data it has MOS drive capability, while in all other modes it is left floating. |
| Used for testing purposes only. Must be left unconnected for normal operation. |
| Chip substrate. Normally connected to ground. |
| DC supply. Normally connected to Vss -35 Volt supply. |
| Timing reference. Required for all operations. May be left at logic zero when device is in standby. |
| Mode control pins. Their operation is as follows: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs (except $\mathrm{V}_{\mathrm{GG}}$ ) with respect to $\mathrm{V}_{\mathrm{SS}}$. . -20 V to +0.3 V
$V_{G G}$ with respect to $V_{S S}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -40 V
Storage temperature (No Data Retention) . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Storage temperature (with Data Retention)
Operating . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$
Unpowered. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+80^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$V_{S S}=G N D$
$V_{G G}=-35 \mathrm{~V} \pm 8 \%$
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Symbol | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Input logic "1" | $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\text {ss }}-150$ | - | $\mathrm{V}_{\text {ss }}-80$ | Volts |  |
| Input logic "0" | $\mathrm{V}_{1}$ | $\mathrm{V}_{\text {ss }}-10$ | - | $\mathrm{V}_{\text {ss }}+0.3$ | Volts |  |
| Input leakage | IL | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=-15 \mathrm{~V}$ |
| Output logic "1" | VoL | - | - | $\mathrm{Vss}^{-120}$ | Volts | Load $=1.5 \mathrm{Meg}, 100 \mathrm{pF}$ |
| Output logic "0" | Vor | $\mathrm{V}_{\text {ss }}-10$ | - | $\mathrm{Vss}_{\text {ss }}+03$ | Volts | $I_{\text {sounce }}=200 \mu \mathrm{~A}$ |
| Power consumption | $\mathrm{P}_{\mathrm{GG}}$ | - | - | 300 | mW |  |
| Power supply current | lag | - | - | 80 | mA |  |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Clock Frequency | ${ }^{\text {f }}$ ¢ | 10.0 | 14.0 | 17.0 | kHz |  |
| Clock duty cycle | D $\phi$ | 35 | 50 | 65 | \% |  |
| Write time | tw | 100 | 15.0 | 24.0 | ms |  |
| Erase tıme | te | 10.0 | 15.0 | 24.0 | ms |  |
| Rise, fall time | tr, tf | - | - | 10 | $\mu \mathrm{s}$ |  |
| Control, Data set up tıme | $\mathrm{tcs}^{\text {ct }}$ | 1 | - | - | $\mu \mathrm{s}$ |  |
| Control, Data hold time | $\mathrm{t}_{\mathrm{CH}}$ | 0 | - | - | $\mu \mathrm{s}$ |  |
| Propagation delay | tpw | - | - | 200 | $\mu \mathrm{s}$ | Load - 1 Meg. 100pF |
| Non-volatile data storage | Ts | 10 | - | - | Years | See Note 1. |
| Number of erase/write cycles | $\mathrm{N}_{\mathrm{w}}$ | - | - | $10^{4}$ | - | Per word. See Note 2. |
| Number of read accesses between writes | $N_{\text {RA }}$ | $10^{9}$ | - | - | - | Per word |

[^11]
## TIMING DIAGRAMS



NOTE Addressing is via two consecutive one-of-ten codes Address 99 is illustrated
Fig. 1 ACCEPT ADDRESS


Fig. 2 READ


Fig. 4 ERASE


Fig. 6 WRITE


Fig. 8 TYPICAL OUTPUT SOURCE CURRENT vs OUTPUT VOLTAGE


Tpw measured initially from control line transition to data out, then measured from the positive clock edges to data changes Timing measurements are made at $V_{s s}-2$ and -10 volt points

Fig. 3 SHIFT DATA OUT


Fig. 5 ACCEPT DATA


Fig. 7 INPUT TIMING


Fig. 9 TYPICAL OUTPUT SINK CURRENT vs OUTPUT VOLTAGE

## 512 Bit Electrically Alterable Read Only Memory

- 32 word $x 16$ bit organization
- 5 bit binary addressing
- $+5,-28 \mathrm{~V}$ power supplies
- Word Alterable
- 10 year data storage for ER2051 (at $+70^{\circ} \mathrm{C}$ )
- 1 year data storage for ER2051 IR (at $+85^{\circ} \mathrm{C}$ ) and ER2051 HR (at $+125^{\circ} \mathrm{C}$ )
- TTL compatibility with pull-up resistors on inputs
- Tri-state outputs
- Read Time: $1 \mu \mathrm{~s}$ (ER2051), $2 \mu \mathrm{~s}$ (ER2051 IR and ER2051 HR)
- Write/Erase Time. 50 ms (ER2051), 100 ms (ER2051 HR)
- No Voltage switching required
- Chip select
- Two extended temperature ranges

$$
-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \text { (Industrial) Part \# ER2051 IR }
$$

$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (Hi-Rel) Part \# ER2051 HR

## DESCRIPTION

The ER2051, ER2051 IR and ER2051 HR are fully decoded $32 \times 16$ electrically erasable and reprogrammable ROMs Write, erase, and read voltages are switched internally via a 2-bit code applied to C1 and C2.
Data is stored by applying negative writing pulses that selectively tunnel charge into the oxide-nitride interface of the gate insulator of the 512 MNOS memory transistors. When the writing voltage is removed the charge trapped at the interface is manifested as a negative shift in the threshold voltage of the selected memory transistors.
The EAROM may be operated with the $\mathrm{V}_{\text {ss }}$ power supply between +5 V and +10 V olts, as long as the $\mathrm{V}_{\mathrm{SS}}-\mathrm{V}_{\mathrm{GG}}$ always equals 33 Volts Thus, $\mathrm{V}_{\text {ss }}$ can be +5 Volts for TTL compatibility or up to +10 Volts for CMOS compatibility, if $\mathrm{V}_{\mathrm{GG}}$ Is appropriately adjusted. The ER2051 IR and ER2051 HR are screened to Mil Std 883B/ method 50041 /level B, pre-cap visual inspection, environmental testing, burn-in and external visual They are available in 28 lead ceramic dual in line packages.

## OPERATION

Data is stored in a two transistor memory cell. After the cell is preconditioned by an erase signal (which causes a positive shift in the threshold of both transistors), data is written into one of the transistors makıng its threshold more negative. A sensing flip flop is used to read the memory cell and presents a logic high or low to the output depending on which transistor is "written."


It is important to note two things. first, that an erase is required before a wire to precondition the cell, and second, that after an erase, both transistors will have the same threshold voltage and valid data will not be present at the output.
The ER2051, ER2051 IR and ER2051 HR EAROMs use dynamic, edge triggered circuits internally. This requires either a mode change, a clock or a transition of the chip select between successive operations Thus successive operations in the same mode must be separated by transitions of one of these four lines. Clock pulses are not normally required during erase or write operations, but are needed for successive operations if the chip select is held high, ie, applications where one EAROM is used

PIN FUNCTIONS

| $\mathrm{A}_{0}-\mathrm{A}_{4}$ | 5-Bit Word Address |
| :---: | :---: |
| $\mathrm{D}_{0}-\mathrm{D}_{15}$ | Data input and output pins |
| CS | Chip Select Chip selected at logic " 1 " When chip select is at logic " 0 ", outputs are open circuit, read, write and erase are disabled Power is reduced |
| C1, C2 | Mode Control Inputs |
|  | $\frac{\mathrm{C} 1}{0} \quad \frac{\mathrm{C} 2}{1} \quad$ Erase Mode stored data is erased at addressed location |
|  | 1 Don't Care Read Mode addressed data read after clock pulse Output data retained at output pins until chip <br> - deselected or control lines switched <br> $0 \quad 0 \quad$ Write Mode input data written at addressed location Clock not required |
| CLK | Clock input Puise to logic "1" for read operation |
| $\mathrm{V}_{\text {SS }}$ | Substrate supply Normally at +5 volts |
| $\mathrm{V}_{\mathrm{GI}}$ | Ground Input |
| $V_{G G}$ | Power Supply Input Normally at -28 volts |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All input and outputs (with respect to $\mathrm{V}_{\mathrm{SS}}$ ) . . . . . . . . . . . -35 V to +0.3 V
Storage temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering temperature of leads ( 10 seconds) . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Standard Conditions (for TTL compatibility)
$V_{S S}=+5 \mathrm{~V} \pm 5 \%$
$V_{G G}=-28 \mathrm{~V} \pm 5 \%$
$\mathrm{v}_{\mathrm{GI}}=\mathrm{GND}$
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ for ER2051
$T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for ER2051 IR
$T_{A}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ for ER2051 HR

Output Load $=100 \mathrm{pf}, 1 \mathrm{TTL}$ load
*Exceedıng these ratings could cause permanent damage to the device This is a stress rating only and functional operation of this device at these conditions is not implied-operatıng ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | ER2051 |  |  | ER2051 IR/ER2051 HR |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ.** | Max. | Min. | Typ.** | Max. | Units | Conditions |
| DC CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Input Logic " 1 " | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\text {ss }}-15$ | - | $\mathrm{v}_{\text {ss }}+03$ | $V_{\text {ss }}-15$ | - | $\mathrm{V}_{\text {ss }}+03$ | V |  |
| Input Logic "0" | VIL | $\mathrm{V}_{\text {ss }}-15$ | - | 08 | $V_{\text {ss }}-10$ | - | 06 | v |  |
| Output Logic "1" | $\mathrm{V}_{\text {OH }}$ | $\mathrm{V}_{\text {ss }}-15$ | - | - | $V_{s s}-15$ | - | - | $v$ | $\mathrm{I}_{\text {OH }}=100 \mu \mathrm{~A}$ |
| Output Logic "0" | VoL | - | - | 06 | - | - | 06 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ for $\mathrm{V}_{\mathrm{SS}}=5 \mathrm{~V}$ |
| Input Leakage | IL | - | 2 | 10 | - | 2 | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}-15$ |
| Output Leakage | Io | - | 2 | 10 | - | 2 | 10 | $\mu \mathrm{A}$ | Chip deselected |
| Power Supply Current |  |  |  |  |  |  |  |  |  |
| Read | $I_{\text {GG }}$ | - | - | 14 | - | - | 18 | mA |  |
| Write | $\mathrm{I}_{\mathrm{GG}}$ | - | - | 11 | - | - | 15 | mA | ItGg returned |
| Erase | $\mathrm{I}_{\mathrm{GG}}$ | - | - | 11 | - | - | 15 | mA | $\left\{\right.$ through $\mathrm{V}_{\text {ss }}$ |
| Deselected | $\mathrm{I}_{\mathrm{GG}}$ | - | - | 9 | - | - | 12 | mA |  |
| AC CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Access Time | $t_{\text {ACC }}$ | - | - | 1.0 | - | - | 2.0 | $\mu \mathrm{s}$ |  |
| Clock Pulse width | tpw | 20 | - | 200 | 20 | - | 200 | $\mu \mathrm{s}$ |  |
| Erase Cycle Time | $\mathrm{t}_{\mathrm{E}}$ | 50 | - | 2000 | 100 | - | 2000 | ms |  |
| Write Cycle Time | $\mathrm{tw}_{\text {w }}$ | 50 | - | 2000 | 100 | - | 2000 | ms |  |
| Read Cycle Time | $t_{\text {f }}$ | 35 | - | 240 | 4.5 | - | 25 | $\mu \mathrm{s}$ |  |
| Address to Clock Tıme | $t_{A}$ | 50 | - | - | 50 | - | - | ns |  |
| Data Set Up Time | tos | 50 | - | - | 50 | - | - | ns |  |
| Data Hold Time | $\mathrm{t}_{\mathrm{t}}$ | 50 | - | - | 50 | - | - | ns |  |
| Control to Address \& Data Change | $\mathrm{tc}_{0}$ | 0 | - | - | 0 | - | - | ns |  |
| Number of Reads/Word Refresh | $\mathrm{N}_{\text {RA }}$ | $10^{\prime \prime}$ | - | - | $10^{\prime \prime}$ | - | - |  |  |
| Number of Erase/Write Cycles | $\mathrm{N}_{\mathrm{w}}$ | $10^{6}$ | - | - | $10^{5}$ | - | - | - |  |
| Input Capacitance, all pins | $\mathrm{C}_{10}$ | - | 8 | 15 | - | 8 | 15 | pF |  |
| Unpowered Data Storage Time | ts | 10 | - | - | 1 | - | - | Years | at max temperature |
| Power Dissipation Read Cycle | $\mathrm{P}_{\mathrm{D}}$ | - | 450 | 500 | - | 450 | 500 | mW | at $25^{\circ} \mathrm{C} \mathrm{V}_{\text {SS }}=+5, \mathrm{~V}_{\text {GG }}=-29$ |
|  | $\mathrm{P}_{\mathrm{D}}$ |  | applica | able | - | - | 500 | mW | at $125^{\circ} \mathrm{C} \mathrm{V}_{\text {SS }}=+5, \mathrm{~V}_{\mathrm{GG}}=-29$ |
|  | $\mathrm{P}_{\mathrm{D}}$ |  | applica |  | - | - | 600 | mW | at $-55^{\circ} \mathrm{C} \mathrm{V}_{\text {SS }}=+5, \mathrm{~V}_{\mathrm{GG}}=-29$ |
| Pulse Rise, fall time | $\mathrm{t}_{\text {R1 }} \mathrm{t}_{\text {fr }}$ | 10 | - | 100 | 10 | - | 100 | ns |  |

[^12]TIMING DIAGRAM


ER2055
ER2055IR ER2055HR

## 512 Bit Electrically Alterable Read Only Memory

## FEATURES

- 64 word x 8 bit organization
- 6 bit binary addressing
- $+5,-28 \mathrm{~V}$ power supplies
- Word Alterable
- 10 year data storage for ER2055 (at $+70^{\circ} \mathrm{C}$ )
- 1 year data storage for ER2055 IR (at $+85^{\circ} \mathrm{C}$ ) and ER2055 HR (at $+125^{\circ} \mathrm{C}$ )
- TTL compatible with pull-up resistors on inputs
- Tri-state outputs
- Read Time: $2 \mu \mathrm{~s}$ (ER2055), $4 \mu \mathrm{~s}$ (ER2055 IR and ER2055 HR)

■ Write/Erase Time: 50 ms (ER2055), 100 ms (ER2055 HR)

- No voltage switching required
- 2 chip selects
- Two extended temperature ranges:
$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (Industrial) Part \# ER2055 IR
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ (Hi-Rel) Part \# ER2055 HR


## DESCRIPTION

The ER2055 is a fully decoded $64 \times 8$ electrically erasable and reprogrammable ROM. Write, erase, and read voltages are switched internally via a 2-bit code applied to C 1 and C 2 .
Data is stored by applying negative writing pulses that selectively tunnel charge into the oxide-nitride interface of the gate insulator of the 512 MNOS memory transistors. When the writing voltage is removed the charge trapped at the interface is manifested as a negative shift in the threshold voltage of the selected memory transistors.

## OPERATION

Data is stored in a two transistor memory cell. After the cell is preconditioned by an erase signal (which causes a positive shift in the threshold of both transistors), data is written into one of the transistors making its threshold more negative. A sensing flip flop is used to read the memory cell and presents a logic high or low to the output depending on which transistor is "written".
The ER2055 EAROM may be operated with $\mathrm{V}_{\text {ss }}$ between +5 and +10 volts for either TTL or CMOS compatibility. The negative power supply, $\mathrm{V}_{\mathrm{GG}}$, should be adjusted so that the difference between $V_{S S}$ and $V_{G G}$ is always 33 volts.
It is important to note two things: first, that an erase is required before a write to precondition the cell, and second, that after an erase, both transistors will have the same threshold voltage and valid data will not be present at the output.


The ER2055 EAROM uses dynamic edge triggered circuits internally. This requires either a mode change, a clock or a transition of the chip selects between successive operations. Thus successive operations in the same mode must be separated by transition of one of these four lines. Clock pulses are not normally required during erase or write operations, but are needed for successive operations if the chip is continuously selected, i.e., applications where one EAROM is used.
The ER2055IR and ER2055HR are screened to Mil Std. 883B/ method 5004. 1/level B, pre-cap visual inspection, environmental testing, burn-in and external visual. They are available in 28 lead ceramic dual in-line packages.

## PIN FUNCTIONS




## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs (with respect to $\mathrm{V}_{\text {SS }}$ ). . . . . . . . . . . -35 V to +03 V
Storage temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering temperature of leads ( 10 seconds) . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Standard Conditions (for TTL Compatibility)
$V_{S S}=+5 \mathrm{~V} \pm 5 \%$
$V_{G G}=-28 \mathrm{~V} \pm 5 \%$
$\mathrm{V}_{\mathrm{GI}}=\mathrm{GND}$
Operatıng Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ for ER2055
$\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for ER20551R
$\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ for ER2055HR
Output Load $=100 \mathrm{pF}$, 1 TTL load

* Exceeding these ratıngs could cause permanent damage to the device This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | ER2055 |  |  | ER2055 IR/ER2055 HR |  |  | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ.** | Max. | Min. | Typ.** | Max. |  |  |
| DC CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Input Logic "1" | $\mathrm{V}_{1}$ | $\mathrm{V}_{\mathrm{ss}}-1.5$ | - | $\mathrm{v}_{\mathrm{ss}}+0.3$ | $\mathrm{V}_{\mathrm{ss}}-1.5$ | - | $\mathrm{v}_{\text {ss }}+0.3$ | v |  |
| Input Logic "0" | VIL | $\mathrm{V}_{\text {ss }}-15$ | - | 0.8 | $V_{\text {ss }}-10$ | - | 0.6 | v |  |
| Output Logic "1" | Voh | $\mathrm{V}_{\text {ss }}-1.5$ | - | - | $V_{s s}-1.5$ | - | - | V | $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Output Logic "0" | VoL |  | - | 0.6 | - | - | 0.6 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ for $\mathrm{V}_{\mathrm{ss}}=5 \mathrm{~V}$ |
| Input Leakage | $\mathrm{I}_{\mathrm{L}}$ | - | 2 | 10 | - | 2 | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {ss }}-15$ |
| Output Leakage | Io | - | 2 | 10 | - | 2 | 10 | $\mu \mathrm{A}$ | Chip deselected |
| Power Supply Current |  |  |  |  |  |  |  |  |  |
| Read | $\mathrm{I}_{\mathrm{GG}}$ | - | 8 | 10 | - | 8 | 18 | mA | Iss approx. $\mathrm{I}_{\text {g }}$ |
| Write | $\mathrm{I}_{\mathrm{GG}}$ | - | 6 | 7 | - | 6 | 9 | mA | $\mathrm{I}_{\text {ss }}$ approx. $\mathrm{I}_{\text {g }}$ |
| Erase | $\mathrm{I}_{\mathrm{GG}}$ | - | 4 | 7 | - | 6 | 8 | mA | $\mathrm{I}_{\text {ss }}$ approx. $\mathrm{I}_{\text {GG }}$ |
| Deselected | $\mathrm{I}_{\mathrm{GG}}$ | - | 4 | 7 | - | 4 | 6 | mA | Iss approx. $\mathrm{I}_{\text {GG }}$ |
| AC Characteristics |  |  |  |  |  |  |  |  |  |
| Clock Pulse width | tpw | 20 | - | 20.0 | 2.0 | - | 20.0 | $\mu \mathrm{s}$ |  |
| Erase Cycle Time | $\mathrm{t}_{\mathrm{E}}$ | 50 | - | 200.0 | 100 | - | 200.0 | ms |  |
| Write Cycle Time | ${ }^{\text {tw }}$ | 50 | - | 200.0 | 100 | - | 200.0 | ms |  |
| Read Cycle Time | $t_{\text {c }}$ | 5.0 | - | 24.0 | 6.0 | - | 25.0 | $\mu \mathrm{s}$ |  |
| Address to Clock Time | $t_{A}$ | 50 | - | - | 50 | - | - | ns |  |
| Data Set Up Time | tos | 50 | - | - | 50 | - | - | ns |  |
| Data Hold Time | $\mathrm{t}_{\mathrm{t}}$ | 50 | - | - | 50 | - | - | ns |  |
| Control to Address \& Data Change | $\mathrm{tc}_{0}$ | 0 | - | - | 0 | - | - | ns |  |
| Number of Reads/Word Refresh | $\mathrm{N}_{\text {RA }}$ | $10^{11}$ | - | - | $10^{11}$ | - | -، |  |  |
| Number of Erase/Write Cycles | $\mathrm{N}_{\mathrm{w}}$ | $10^{6}$ | - | - | $10^{5}$ | - | - | - |  |
| Input Capacitance, all pins | $\mathrm{C}_{10}$ | - | 6 | 10 | - | 6 | 10 | pF |  |
| Unpowered Data Storage Time | ts | 10 | - | - | 1 | - | - | Years | at max. temperature |
| Power Dissipation Read Cycle | Po | - | 450 | 500 | - | 450 | 500 | mW | at $25^{\circ} \mathrm{C} \mathrm{V}_{\text {Ss }}=+5, \mathrm{~V}_{\mathrm{GG}}=-29$ |
|  | $\mathrm{P}_{\mathrm{D}}$ |  | applica |  | - | - | 500 | mW | at $125^{\circ} \mathrm{C}$ V $\mathrm{VS}=+5, \mathrm{~V}_{\text {GG }}=-29$ |
|  | PD |  | applica |  | - | - | 600 | mW | at $-55^{\circ} \mathrm{C} \mathrm{V}_{\text {SS }}=+5, \mathrm{~V}_{\mathrm{GG}}=-29$ |
| Pulse Rise, fall time | $t_{\text {R1 }} \mathrm{t}_{\mathrm{F}}$ | 10 | - | 100 | 10 | - | 100 | ns |  |

[^13]TIMING DIAGRAM


TYPICAL OUTPUT CHARACTERISTICS


TYPICAL SUPPLY CURRENT VS POWER SUPPLY VOLTAGE

## 1K N-Channel EEPROM

## FEATURES

- $128 \times 8$ bit organization, fully decoded
- SNOS si-gate technology
- Single +5 V power supply
- 100ns access tıme
- TTL compatible
- Word alterable
- Reprogramming time-user determined
- Automatic erase/write cycle


## DESCRIPTION

The ER5901 is intended for microcomputer applications which require a small non-volatile memory capable of fast operation with a mınimum of processor intervention. The fast access time, coupled with the ability to multiplex the address and data lines, through the Address Latch Enable (ALE) and $\overline{W E}$ inputs, will make it readily adaptable for use in most systems.
A single pulse on the $\overline{W E}$ input will cause the device to perform a complete erase/write cycle without any further processor intervention. The duration of this reprogramming cycle can be determined by means of an external RC time constant connected to the Tl input. During the reprogrammıng cycle a busy status is made available on the status line STA.
The combining of all these features on a single device has been achieved through innovative circuit design and N -channel Sigate technology.

## PIN CONFIGURATION 24 LEAD DUAL IN LINE



## BLOCK DIAGRAM



## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs with respect to Ground . . . . . . . . . . . +6 V to -0.3 V
Storage temperature (unpowered and
without data retention) . ............................. $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering temperature of leads ( 10 secs.) . . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)
$\mathrm{V}_{\mathrm{SS}}=\mathrm{GND}$
$\mathrm{V}_{\mathrm{cc}}=+5 \mathrm{~V} \pm 5 \%$ Volts
Operating Temperature Ranges $\mathrm{T}_{\mathrm{A}}: 0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ (Commercial)

$$
-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \text { (Industrial) }
$$

$$
-55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \text { (Military) }
$$

* Exceeding these ratings could cause permanent damage to the device This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maxımum ratıng conditions for extended periods may affect device reliability Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | 20 | - | $\mathrm{v}_{\mathrm{cc}}+03$ | V |  |
| Input Logic "0" | $\mathrm{V}_{\text {IL }}$ | -0.1 | - | +0.8 | V |  |
| Output Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 24 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}$ |
| Output Logic " 0 " | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Input Leakage Current | $\mathrm{I}_{11}$ | - | - | ** | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=5.25 \mathrm{~V}$ |
| Output Leakage Current | 1 OL | - | - | ** | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=525 \mathrm{~V}$ |
| Power Supply Requirements $V_{C C}$ Supply: |  |  |  |  |  |  |
| Chip Selected | $\mathrm{I}_{\mathrm{cc}}$ | - | 35 | 54 | mA | $\mathrm{V}_{\mathrm{CC}}=+5.5 \mathrm{~V}$ |
| Chip Deselected | $\mathrm{I}_{\mathrm{cc}}$ | - | 12 | 18 | mA | $\mathrm{V}_{\mathrm{CC}}=+5.5 \mathrm{~V}$ |
| Power Dissipation |  |  |  |  |  |  |
| Chip Selected | $\mathrm{P}_{\mathrm{D}}$ | - | 195 | 300 | mW | $\mathrm{V}_{\mathrm{CC}}=+55 \mathrm{~V}$ |
| Chip Deselected | $P_{\text {D }}$ | - | 66 | 100 | mW | $\mathrm{V}_{\mathrm{CC}}=+55 \mathrm{~V}$ |

** To be announced at a later date.
NOTE: 1. $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=5 \pm 5 \%$ Volts, unless otherwise specified.

## PIN FUNCTIONS

| Name | Function |
| :---: | :---: |
| A0-A6 | 7 bit binary word address. |
| D0-D7 | 8 bit data 1/O |
| $V_{\text {cc }}$ | Power supply $+5 \mathrm{~V} \pm 5 \%$ |
| GND | Chip Ground connection |
| $\overline{C E}$ | Chıp Enable input - used for chip selection |
| $\overline{\mathrm{OE}}$ | Output Enable input - gates data to output pins during Read. |
| $\overline{W E}$ | Write Enable input - enables a reprogramming cycle, input data latched on a positive edge. |
| ALE | Address Latch Enable input - address inputs latched on negative edge May be tied to $\overline{W E}$ when separate address and data lines are used |
| $\overline{\text { STA }}$ | Status output pin - low when chip is in reprogramming mode and cannot be accessed. |
| TI | Timing input - defines clock frequency for reprogramming, May be RC or other external clock |

## 4096 Bit Electrically Alterable Read Only Memory

## FEATURES

- 1024 word x 4 bit organızatıon
- Latched address and data inputs
- Word or block alterable
- 10 year data storage for ER3400
- 1 year data storage for ER3400IR at $+85^{\circ} \mathrm{C}$
- and ER3400HR at $+95^{\circ} \mathrm{C}$
- TTL compatıble with pull-up resistors on inputs
- Tri-state outputs
- Read access time 900 ns max.
- Write tıme. 1 ms Erase time 10 ms
- $10^{9}$ Read cycles/word between refresshes
- $10^{7}$ Read cycles/word for ER3400IR and ER3400HR
- Two extended temperature ranges


## DESCRIPTION

The ER3400 is a $1024 \times 4$ bit fully decóded Electrically Alterable Read Only Memory fabricated in General Instrument's proven MNOS technology. Address, control and data inputs are latched on board the device thus releasing these lines during Erase and Write operations Selection of one of the four modes of operation is made by settıng the appropriate binary code on control lines $\mathrm{C0}$ and C1 $\overline{\mathrm{CE}}$ is used for chip selection and latching of address and control lines. $\overline{\text { WE }}$ is used to sample and latch input data on D0-D3 during a Write operation.
Power sequencing protection circuitry is provided on the ER3400 to protect against the accidental alteration of data during power Up/Down. However, due to the unpredictable nature of power up and power down sequences in some systems, it is important to apply and remove the programming voltage $\mathrm{V}_{\mathrm{GG}}$ only when $\mathrm{V}_{\mathrm{SS}}$ and $V_{D D}$ are withın their specified limits
For applications requiring extended temperature ranges the ER3400I, ER3400IR and ER3400HR are available.

## PIN CONFIGURATION <br> 22 LEAD DUAL IN LINE



## RELATED APPLICATION NOTES

1217 The ER3400: an easy to use 4K EAROM
1218 Interfacing the ER3400 to an eight bit microcomputer
1220 Generating EAROM programming voltages from a 5 volt supply
1210 Data retention testıng of the ER3400

## PIN FUNCTIONS

| Name | Function |
| :---: | :---: |
| A0-A9 | 10-Bit Word Address |
| $\begin{aligned} & \mathrm{DO-D3} \\ & \overline{\mathrm{CE}} \\ & \mathrm{C} 0, \mathrm{C} 1 \end{aligned}$ | Data input and output pins |
|  | Chip Enable. Chip selected when $\overline{\mathrm{CE}}$ is pulsed to logic " 0 ". |
|  | Mode Control Inputs |
|  | $\underline{\mathrm{C} 0} \quad \underline{\mathrm{C} 1}$ |
|  | $0 \quad 1 \quad$ Block Erase Mode: erase operation performed on all words. |
|  | 11 Word Erase Mode: stored data is erased at addressed location. |
|  | $0 \quad 0 \quad$ Read Mode: addressed data read after leading edge of $\overline{\mathrm{CE}}$ pulse. |
|  | 10 Write Mode: input data written at addressed location. |
| $\overline{W E}$ | Write Enable. Input data read when $\bar{W} E$ is pulsed to logic "0". |
| $V_{\text {SS }}$ | Substrate supply. Normally at +5 volts. |
| $V_{G I}$ | Ground Input |
| $V_{\text {DD }}$ | Power Supply Input. Normally at -12 volts. |
| $V_{G G}$ | Power Supply Input. Normally at $\mathbf{- 3 0}$ volts. |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs except $\mathrm{V}_{\mathrm{GG}}$ (with respect to $\mathrm{V}_{\mathrm{SS}}$ ) . . . -20 V to +0.3 V Storage temperature (without data retention) .......... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering temperature of leads ( 10 seconds) . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Standard Condition (unless otherwise noted)
$V_{S S}=+5 \mathrm{~V}$ to $\pm 5 \%$
$V_{D D}=-12 V \pm 5 \%$
$V_{\mathrm{GG}}=-30 \mathrm{~V} \pm 5 \%$
$\mathrm{V}_{\mathrm{GI}}=\mathrm{GND}$
Operating Temperature $\left(\mathrm{T}_{\mathrm{A}}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ (ER3400)

$$
-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}(\mathrm{ER} 34001 / \mathrm{IR})
$$

$$
-55^{\circ} \mathrm{C} \text { to }+95^{\circ} \mathrm{C}(E R 3400 \mathrm{HR})
$$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum ratıng conditions for extended periods may affect device relıability Data labeled "typical" is presented for design guidance only and is not guaranteed.

|  |  | ER3400 |  |  | ER34001R/ER3400HR |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Characteristic | Sym | Min | Typ | Max | Min | Typ | Max | Unit | Conditions |
| DC CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Input Logic "1" | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\text {Ss }}-1.5$ | - | $\mathrm{V}_{\text {ss }}+0.15$ | $V_{s s}-10$ | - | $\mathrm{V}_{\text {ss }}+015$ | V | - |
| Input Logic "0" | $\mathrm{V}_{\mathrm{IL}}$ | -10 | - | 08 | -10 | - | 06 | V |  |
| Output Logic "1" | $\mathrm{V}_{\text {OH }}$ | $V_{\text {Ss }}-1.5$ | - | - | $\mathrm{V}_{\text {ss }}-1.5$ | - | - | V | $\mathrm{I}_{\mathrm{OH}}=2 \mathrm{~mA}$ |
| Output Logic "0" | VoL | - | - | 04 | - | - | 05 | V | $\mathrm{I}_{\mathrm{OL}}=2 \mathrm{~mA}$ |
| Control Input Leakage | ILC | - | - | -20 | - | - | -20 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {ON }}=\mathrm{V}_{\text {SS }}-15$ Volts |
| Data Input Leakage | ILo | - | - | -100 | - | - | -10.0 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {SS }}-15$ Volts |
| Power Supply Current |  |  |  |  |  |  |  |  |  |
| Vod Supply Current. Chip selected | $\mathrm{I}_{\mathrm{DD}}$ | - | - | -25.0 | - | - | -30.0 | mA | $\mathrm{V}_{\text {DD }}=\mathrm{V}_{\text {SS }}-17$ Volts |
| Chıp de-selected | IDD | - | - | -12.0 | - | - | -15.0 | mA | $V_{D D}=V_{S S}-17$ Volts |
| VGg Supply Current Write mode | $\mathrm{I}_{\mathrm{GG}}$ | - | - | -4.0 | - | - | -5.0 | mA | $\mathrm{V}_{\mathrm{GG}}=\mathrm{V}_{\text {SS }}-35 \mathrm{Volts}$ |
| $V_{\text {ss }}$ Supply Current. Chip selected | Iss | - | - | -310 | - | - | -37.0 | mA | $\mathrm{V}_{\mathrm{GG}}=\mathrm{V}_{\mathrm{SS}}-17 \mathrm{~V}, \mathrm{~V}_{\mathrm{GG}}=\mathrm{V}_{\mathrm{SS}}-35 \mathrm{~V}$ |
| Chip de-selected | Iss | - | - | -14.5 | - | - | -18.0 | mA | $\mathrm{V}_{\mathrm{GG}}=\mathrm{V}_{\mathrm{SS}}-17 \mathrm{~V}, \mathrm{~V}_{\mathrm{GG}}=\mathrm{V}_{\mathrm{SS}}-35 \mathrm{~V}$ |
| AC CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Input capacitance-control inputs | $\mathrm{Cr}_{1}$ | - | 6 | 8 | - | 6 | 8 | pf |  |
| Input capacitance-data inputs | Co | - | 8 | 10 | - | 8 | 10 | pf |  |



Input capacitance-control inputs Input capacitance-data inputs $\mathrm{C}_{0}$


| Characteristics | Sym | ER3400 |  | ER34001R/HR |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |  |
| Read Cycle Time | $t_{C Y}$ | 1700 | - | 1750 | - | ns |  |
| Address and Control to $\overline{\mathrm{CE}}$ | $t_{\text {D1 }}$ | 100 | - | 100 | - | ns |  |
| Address and Control Hold Time | $\mathrm{t}_{\mathrm{D} 2}$ | 250 | - | 350 | - | ns |  |
| $\overline{\text { CE R R }}$ ( ${ }^{\text {a }}$ to Data Tri-state | $t_{\text {D }}$ | 50 | 300 | 50 | 350 | ns |  |
| $\overline{\mathrm{CE}}$ High | $t_{\text {D4 }}$ | 700 | - | 750 | - | ns |  |
| Access Time | $\mathrm{t}_{\mathrm{A}}$ | - | 900 | - | 1000 | ns | Load $=2 \mathrm{~K}+100 \mathrm{pf}$ to $\mathrm{V}_{S S}$ |
| $\overline{C E}$ Pulse Width | $t_{\text {CE }}$ | 1 | 50 | 1 | 50 | $\mu \mathrm{s}$ |  |
| $\overline{C E}$ Rise, Fall Time | $t_{r}, t_{f}$ | 10 | 100 | 10 | 100 | ns |  |
| Number of Read Accesses per Location Between Refresh | $N_{\text {RA }}$ | $10^{9}$ | - | $10^{7}$ | - | - |  |

## READ OPERATION

Address and control line inputs are latched on the falling edge of $\overline{C E}$. With control lines $C 0$ and $C 1$ both low a read cycle will be initiated. After the access time $t_{A}$ the data read will be output on
data lines D0-D3. $\overline{C E}$ must be held high for a minimum of 700 ns between memory read cycles. To reduce power consumption the ER3400 may be operated with $V_{G G}$ held at $V_{S S}$ in the read mode.


## WORD ERASE OPERATION

An erase cycle is required prior to a write in order to precondition the memory cells to be written. A word erase operation erases only the four bits of the addressed memory location. The falling edge of $\overline{C E}$ latches the control inputs and the address of the word to be erased. The rising edge of $\overline{\mathrm{CE}}$ in the erase mode signals the start of the erase cycle which produces a positive shift in the threshold of the selected MNOS memory transistors. An erase operation must be termınated by a dummy read operation The dummy read need not occur on the same location as the preced-
ing erase, therefore, the state of the address lines A0-A9 are immaterial during the dummy read cycle. Data output during a dummy read cycle is not valid data.

## BLOCK ERASE OPERATION

A block erase operation erases all 4096 bits of memory to the " 1 " state, in all other respects the operation is identical to the word erase operation described above.


| Characteristics | Sym | ER3400 |  | ER34001R/HR |  | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max | Min | Max |  |  |
| Address and Control to $\overline{C E}$ | $t_{\text {D11 }}$ | 100 | - | 100 | - | ns |  |
| Address and Control Hold Time | $t_{\text {D12 }}$ | 250 | - | 350 | - | ns |  |
| CE Fall to WE Fall Delay | $t_{\text {D13 }}$ | 0 | - | 0 | - | ns | $\overline{\text { WE }}$ rise may overlap $\overline{C E}$ |
| $\overline{W E}$ Rise to $\overline{C E}$ Rise Delay | $t_{\text {D14 }}$ | -50 | - | -100 | - | ns | rise by 50 ns maximum |
| Data Stable to $\overline{W E}$ | $\mathrm{t}_{\mathrm{D} 15}$ | 0 | - | 0 | - | ns |  |
| WE Rise to End of Data Stable | $\mathrm{t}_{\mathrm{D} 16}$ | 100 | - | 100 | - | ns |  |
| CE Pulse Width | $t_{\overline{C E}}$ | 1 | 50 | 1 | 50 | $\mu \mathrm{s}$ |  |
| WE Pulse Width | $\mathrm{t}_{\overline{\mathrm{WE}}}$ | 500 | - | 650 | - | ns |  |
| Write Time | $\mathrm{t}_{\text {w }}$ | 1 | 2 | 1 | 2 | ms |  |
| $\overline{\text { CE Rise to Data Tri-state }}$ | $\mathrm{t}_{\text {D }}$ | 50 | 300 | 50 | 350 | ns |  |
| $\overline{\text { CE High (Dummy Read) }}$ | $\mathrm{t}_{\mathrm{D}}$ | 1500 | - | 1500 | - | ns |  |
| Unpowered Data Storage Tıme | $\mathrm{t}_{\text {s }}$ | 10 | - | 1 | - | YRS. | See Note 1 |
| Number of Reprogramming Cycles | $\mathrm{N}_{\mathrm{w}}$ | $10^{3}$ | - | $10^{3}$ | - | - | See Note 1 |
| Number of Read Accesses/Location between Refresh | $\mathrm{N}_{\text {RA }}$ | $10^{9}$ | - | $10^{9}$ | - | - |  |

NOTE 1: Does not imply end of useful life See "Write Operation" for further information.

## WRITE OPERATION

Control lines C0 and C1 along with address lines A0-A9 are latched on the falling edge of $\overline{C E}$ Input data on DO-D3 is latched on the risıng edge of $\overline{W E}$. WE may be tıed to $\overline{C E}$ for all operations, however, this separate latching allows the ER3400 to be used in certain systems where address and data busses are multıplexed. The writing of the selected memory transistors is initiated by the rising edge of $\overline{C E}$. $\overline{C E}$ must remain high for the duration of the write time. A write operation can only be termınated by a dummy read. To avoid bus contention, the data lines must be tri-stated prior to initiating the dummy read cycle. The data output by a dummy read cycle is not valid data. The dummy read need not
occur on the same location as the previous write, therefore, address line A0-A9 may be allowed to change during the dummy read cycle
The specification of 10 years non-volatile data retention after a minımum of $10^{3}$ reprogramming cycles is merely one point on the curve of retention versus reprogramming cycles and does not imply a sudden cut-off or end of life. As the number of Erase/Write cycles per address increases, a gradual, logarithmic reduction in data retention capability occurs with 1 year of retention being a typical figure after $10^{4}$ cycles.

g. 7 IGG vs. $\mathrm{V}_{\mathrm{GG}}-\mathrm{V}_{\mathrm{ss}}$ POWER SUPPLY VOLTAGE in READ MODE AND NOT SELECTED

## 8192 Bit Electrically Alterable Read Only Memory

## FEATURES

- 2048 word $x 4$ bit organization
- 11 bit binary addressing
- $\pm 5,-14,-24 \mathrm{~V}$ power supplies
- Block erasable
- 1 year unpowered data storage
- TTL compatible with pull up resistors on inputs
- Tri-state outputs
- Read time: $1.6 \mu \mathrm{~s}$
- Write time: 10 ms , erase time: 100 ms
- Chip select


## DESCRIPTION

The ER2810 IR and ER2810 HR are fully decoded $2048 \times 4$-bit electrically erasable and reprogrammable ROMs utilizing second-generation MNOS epitaxial processing technology.
Data is stored by applying negative writing pulses that selectively tunnel charge into the oxide-nitride interface of the gate insulator of the 8192 MNOS memory transistors. When the writing voltage is removed, the charge trapped at the interface is manifested as a negative shift in the threshold voltage of the selected memory transistors.

The ER2810 IR and ER2810 HR are screened to Mil Std. 883B/ method 5004.1/level B, pre-cap visual inspection, environmental testing, burn-in and external visual They are available in 24 lead

## PIN CONFIGURATION

24 LEAD DUAL IN LINE

Stored data may be accessed a minimum of $2 \times 10^{10}$ times without refresh and is non-volatile in the unpowered state in excess of one year. Data is erased by applying a $\mathrm{V}_{\mathrm{ss}}-28 \mathrm{~V}$ pulse to the erase substrate of the device. Data may be reprogrammed, without degradation of the retention time, up to $10^{5}$ times, beyond which a gradual, logarithmic fall off is seen. All outputs are at logic high when the device is in the erased state.

## BLOCK DIAGRAM



## ELECTRICAL CHARACTERISTICS

## Maximum Ratings＊


Storage temperature ．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．．$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering temperature of leads（10 seconds）
$+300^{\circ} \mathrm{C}$
＊Exceeding these ratings could cause permanent dam－ age to the device．This is a stress rating only and func－ tional operation of this device at these conditions is not implied－operating ranges are specified in Standard Conditions．Exposure to absolute maximum rating con－ ditions for extended periods may affect device relıability． Data labeled＂typical＂is presented for design guidance only and is not guaranteed．

RECOMMENDED OPERATING CONDITIONS $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for ER2810IR
$\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+95^{\circ} \mathrm{C}$ for ER2810HR

| Symbol | Parameter | Erase Mode |  |  | Write Mode |  |  | Read Mode |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\begin{aligned} & V_{11} \\ & V_{(1)} \end{aligned}$ | Supply Voltage Substrate supply voltage |  | V＂ | $V_{41}+0.3$ | $V_{1,}-29$ | $V_{\rightsquigarrow}-28$ | $V_{ぃ-27}$ | $V_{\Vdash}$－20 | $V_{\text {¢－1 }}$ | $V_{\text {い－18 }}$ | v |
|  |  | 4.75 | 5.0 | 5.25 | 4.75 | 5.0 | 5.25 | 4.75 | 5.0 | 5.25 | V |
| $V_{M}$ | Memory voltage | 4.75 | $\begin{aligned} & V_{" 1} \\ & V_{" 4} \end{aligned}$ | － | $V_{\text {י－29 }}$ | $V_{\rightsquigarrow,}$ | $V_{\text {¢－}}$－27 | $V_{51}-10.5$ | $V_{r i}-10$ | $V_{\text {¢－}}$－9．5 | V |
| $\mathrm{V}_{\mathrm{R}}$ | Reference voltage Erase substrate input high | － |  | － | ， | $V_{\text {い }}$ | － | V，－20 | $V_{4}$－19 | $V_{\text {¢－1 }} 18$ | V |
| $\mathrm{V}_{11}$ |  | $\mathrm{V}_{\text {い－0．4 }}$ | V＂ | $V_{14}+0.3$ | $V_{\text {¢ }}-0.4$ | V＂ | $v_{1}+0.3$ | $v_{\text {い }}-0.4$ | $V^{\prime \prime}$ | $v_{4}+0.3$ | V |
| $V_{1,1}$ | Erase substrate input low |  |  |  | Not Applicable |  |  |  |  |  | v |
| $\mathrm{V}_{\text {wh }}$ |  | $\begin{aligned} & V_{k-1.5} \\ & V_{w}-29 \end{aligned}$ | $V_{4}$ | $\begin{gathered} V_{14-27} \\ V_{14}+0.3 \end{gathered}$ |  |  |  |  |  |  | V |
| $\mathrm{V}_{\mathbf{w}}$ | Write control input low |  |  | $V_{\text {，}}$－4．4 | $V_{\text {cı－29 }}$ |  | $V_{\text {，}}$－4．4 |  | Applic |  | V |
| $V_{\text {¢ }}{ }_{\text {H }}$ | $\phi_{1}$ input high voltage | －Not Applicable |  |  | $V_{\square}$－0．8 | $V_{\text {¢ }}$ | $v_{41}+0.3$ | $V_{\text {¢ }}-0.8$ | $\mathrm{V}_{4}$ | $V_{14}+0.3$ | v |
| $V \phi_{\text {L }}$ | $\phi_{1}$ input low voltage |  |  |  | $V_{\text {¢ }}$－29 | $V_{\text {¢－28 }}$ | Vヶ－27 | $V_{\text {¢－25 }}$ | $\mathrm{V}_{4}$－19 | $\mathrm{V}_{5}$－18 | V |
| $\mathrm{V}_{\mathbf{H}}$ | Address and CS input high |  | on＇t Ca |  | $V_{\text {い－1 }}$ | V＂ | $\mathrm{V}_{\text {¢ }}+0.3$ | Vぃ－1．5 | $V_{\text {＂}}$ | $V_{\text {ss }}+0.3$ | V |
| $V_{11}$ | Address and CS input low |  | on＇t Ca |  | $\mathrm{V}_{\text {DD }}$ | － | $V_{1 s}-4.4$ | $\mathrm{V}_{10}$ | － | $\mathrm{V}_{\text {s－4．4 }}$ | V |
| $\mathrm{V}_{\mathrm{DH}}$ | Data input high voltage |  | on＇t Car |  | $V_{45}-1.5$ | $V_{\text {＂}}$ | $V_{6}+0.3$ |  | Applic |  | V |
| $\mathrm{V}_{10}$ | Data input low voltage |  | on＇t Car |  | $\mathrm{V}_{\mathrm{b},}$ | － | $V_{4}$ ¢－4．4 |  | Applic |  | $v$ |



STATIC ELECTRICAL CHARACTERISTICS $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for ER2810IR
$\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+95^{\circ} \mathrm{C}$ for ER2810HR
（NO EXTERNAL LOADS EXCEPT AS NOTED）

| Symbol | Parameter | Conditions All Pins at V，Unless Noted | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| In | Input leakage current（except pins 1，2， $4,5,6,7,8$ ，and 24）at $V_{s s}-15 \mathrm{~V}$ | $\phi 1=V_{\text {DD }}=V_{4-20}$ | － | － | －2．0 | $\mu \mathrm{A}$ |
| ${ }^{\prime} \phi_{1}$ | $\phi_{1}$ leakage current at $V_{«}$－29V | $\mathrm{V}_{\text {DD }}=\mathrm{V}_{\text {S }}-29, \bar{W}=\mathrm{V}_{\text {ss }}-25$ | － | － | －200 | $\mu \mathrm{A}$ |
| 10 | Output leakage current at $\mathrm{V}_{s s}-15 \mathrm{~V}$ | Chip deselected | － | － | －10．0 | $\mu \mathrm{A}$ |
| 11.1 | Erase leakage current at $V_{4},-28 \mathrm{~V}$ | $\overline{\mathrm{W}}=\mathrm{V}_{\text {心 }}-25$ | － | － | －200 | $\mu \mathrm{A}$ |
| $\mathrm{IbD}_{1}$ | $V_{D D}$ supply current－ read mode at $\mathrm{V}_{\mathrm{Ss}}-19 \mathrm{~V}$ | Outputs open（See Figure 6） | － | 16 | 20 | mA |
| $\mathrm{I}_{1010}$ | $V_{D D}$ supply current－ Write mode at $V_{\text {ss }}-28 \mathrm{~V}$ | Outputs open（See Figure 5） | － | 30 | 40 | mA |
| VOH | Data output high voltage－TTL load | One Series 7400 TTL load with $R_{S}=1 \mathrm{~K}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{SS}}$ | $\mathrm{V}_{\text {ss }}-1.5$ | － | － | V |
| Vol | Data output low voltage－TTL load | （See TTL Notes） | － | － | $\mathrm{V}_{\text {ss }}-10$ | v |
| $V_{\text {он }}$ | Data Output high voltage－MOS |  | $V_{s s}-1.5$ | － | － | $v$ |
| $\mathrm{V}_{\text {O }}$ | Data Output low voltage－MOS Unpowered nonvolatile data storage | $C_{L}=100 \mathrm{pF}$ <br> Typical write conditions | － | － | $\mathrm{V}_{\text {ss }}-14$ | $\underset{\text { Years }}{V}$ |

CAPACITANCE AT $V_{\text {IN }}=V_{\text {ss }}$ ，ALL OTHER PINS GROUNDED（ $\left.V_{s s}\right), \mathbf{f}=1 \mathrm{MHz}$

| Symbol | Parameter | Min | Typ | Max | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{1}$ | Address and chip select input capacitance | - | 5 | 7 | pF |
| $\mathrm{C}_{\mathbf{w}}$ | Write control input capacitance | - | 10 | 20 | pF |
| $\mathrm{C}_{31}$ | Strobe input capacitance | - | 10 | 15 | pF |
| $\mathrm{C}_{\phi_{1}}$ | $\phi_{1}$ Input Capacitance． | - | 40 | 50 | pF |
| $\mathrm{C}_{11}$ | Erase substrate capacitance | - | 600 | 700 | pF |
| $\mathrm{C}_{10}$ | Data input／output capacitance | 6 | 10 | pF |  |

ERASE CYCLE CHARACTERISTICS $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for ER2810IR
$\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+95^{\circ} \mathrm{C}$ for ER2810HR

| Symbol | Parameter | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{E}}$ | $\mathrm{V}_{\mathrm{FF}}$ erase pulse width | 100 | - | 1000 | ms |
| $t_{\text {R }}, \mathrm{t}_{\mathrm{F}}$ | $\mathrm{V}_{\text {FF }}$ rise time, $\mathrm{V}_{\text {FI }}$ fall time | 0.01 | - | 1.0 | ms |
| to | Write-erase overlap | 10 | - | - | $\mu \mathrm{S}$ |



WRITE CYCLE CHARACTERISTICS $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for ER2810IR
$T_{A}=-55^{\circ} \mathrm{C}$ to $+95^{\circ} \mathrm{C}$ for ER2810HR (See Note 3)

| Symbol | Parameter | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $N \phi_{\text {w }}$ | Number of $\phi_{1}$ write pulses at $100 \mu \mathrm{~s} \pm 10 \%, 5 \mu \mathrm{~s} \mathrm{~min}$. dead time between pulses) | 100 | 200 | 300 | Pulses |
| $t_{\text {b }}$ | Write control rise to pulsed $\phi_{1}$ rise delay | 500 | - | - | ns |
| ${ }_{\text {tos }}$ | Address change and chip select fall to pulsed $\phi_{1}$ rise delay | 500 | - | - | ns |
| $\mathrm{t}_{19}$ | Pulsed $\phi_{1}$ fall to address and chip select change delay | 0.0 | - | - | $\mu \mathrm{S}$ |
| $t_{\text {blo }}$ | Data input change to pulsed $\phi_{1}$ rise delay | 0.0 | - | - | $\mu \mathrm{S}$ |
| ${ }_{\text {til }}$ | Pulsed $\phi_{1}$ fall to data input change delay | 0.0 | - | - | $\mu \mathrm{S}$ |
| Nw | Number of times word may be rewritten | - | - | $10^{5}$ | - |

Write Control
$(\bar{W})$

Erase
Substrate
( $_{\text {EE }}$ )
Address $\left(A_{0} \rightarrow A_{10}\right)$
and/or
Chip Select (CS)
Pulsed $\phi_{1}$
$\left(\phi_{1}\right)$
Data Input
$\left(D_{1} \rightarrow D_{4}\right)$


NOTES: 1. Due to the dynamic nature of the circuit a " $\phi_{1}$ NOT" time in excess of $40 \mu$ sec may result in a floated output condition. Consequently data must be resampled with a $40 \mu \mathrm{sec}$ time period following the fall of $\phi_{1}$ to ensure its validity.
2. Several seconds may be required following a programming operation for the circuit to become operable in the read mode. If data is to be verified immediately following programming, a forward current of $+1 \mathrm{~mA} \pm 10 \%$ may be forced into the erase substrate junction (Pin $4, \mathrm{~V}_{E E}$ ), for a period not to exceed 10 milliseconds, to quickly dissipate charge trapped at internal circuit nodes.
3. Maximum power dissipation occurs during programming. When programming multichip systems where the application of programming voltages is required for several minutes, forced air cooling is recommended to reduce package temperature. Power is not reduced when chip is deselected.
4. All typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.
5. $\phi$ pulses are required after the fall of the chip select line to force the data outputs into a high impedance state.

| ER2810IR ■ ER2810HR | INSTRUMERAL |
| :---: | :---: |

READ CYCLE CHARACTERISTICS $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ for ER28101R
$T_{A}=-55^{\circ} \mathrm{C}$ to $+95^{\circ} \mathrm{C}$ for ER2810HR

| Symbol | Parameter <br> (See Figures 1 through 4) | Min | Typ | Max | Units |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $T_{A}$ <br> $t_{\phi_{1}}$ <br> $t_{D 1}$ <br> ${ }^{t_{D 2}}$ <br> $t_{D 3}$ <br> $t^{D_{4}}$ <br> $\mathrm{N}_{\text {RA }}$ | Access time <br> Pulse width (rise and fall times $\leqslant 50 \mathrm{~ns}$ ) (See Note 1) <br> Address and chip select change to $\phi_{1}$ fall delay <br> $\phi_{1}$ Rise to address and chip select change delay <br> $\phi_{1}$ Rise to data output valid delay (See Notes 1 and 2) <br> $\phi_{1}$ Fall to floated output delay <br> Number of read accesses/word between refresh |  | $\begin{aligned} & 16 \\ & - \\ & - \\ & - \end{aligned}$ | $\begin{gathered} 20 \\ 5000 \\ - \\ - \\ 750 \\ 300 \\ - \end{gathered}$ | $\mu \mathrm{s}$ <br> ns <br> ns <br> ns <br> ns <br> ns <br> - | See Note 1 See Note 1 |
| Chip Select (CS) <br> Address <br> $\left(A_{0} \rightarrow A_{10}\right)$ <br> $\phi_{1}$ <br> Data Output $\left(D_{1} \rightarrow D_{4}\right)$ |  | Floating <br> - - - |  | $\begin{aligned} & { }^{-{ }^{-1} D_{1}-1} \\ & { }^{t_{D 4}-1} \\ & \hline \text { alid } \\ & \hline \end{aligned}$ |  |  |

## PIN FUNCTIONS

## Chip Select (CS)

Must be in the high state to enable the data output terminals or to write data into the device

## Data Input/Output (D1-D4)

D1 through D4 are bidirectional data termınals Data are entered on these terminals during the write cycle and read out during the read cycle. When deselected, these terminals are in a floating condition.
Write Control (W)
The write control terminal must be in the low state in order to write data into the device.
Phase One ( $\phi 1$ )
During the write and read operations, pulses must be applied to the $\phi 1$ terminal to fully shift the memory transistor threshold voltage to its most negative state. This is required for voltage bootstrapping in the row-selection circuitry. The $\phi 1$ input is high level and not TTL-compatible.

NOTE. All control, address and data inputs are TTL-compatible with pull-up resistors.

## TTL INTERFACE



## ER2810 OPERATION



## MOS INTERFACE



## 16K N-Channel Electrically Erasable and Programmable ROM

## FEATURES

- 2048 word $\times 8$ bit organization, fully decoded
- Electrically Block Erasable with a 1sec., +25 V pulse
- Electrically Programmable-1ms per byte
- Single +5 V power supply in Read mode
- 300ns Access Time
- 10 year Non-Volatile Data Retention
- Static operation-no clocks
- N-Channel, Silicon gate SNOS technology
- Low Active Power Dissipation. 300 mW max.
- Pin for pin compatible with Hitachi HN48016
- Interchangeable with Intel 2716 EPROM


## DESCRIPTION

The ER5716 is an Electrically Erasable and Programmable Read Only Memory fabricated in N-Channel, Silicon Gate SNOS technology. Address decoding circuitry is provided on the chip and its operation is fully statıc, requiring no clocks. +5 volts only is required to perform a Read operation. An additional +25 V supply is necessary in the Erase and Write modes.
This device is pin for pin compatible with the HitachıHN48016 and is also interchangeable with the 2716 family of ultraviolet erasable EPROMs.
Being electrically erasable and programmable, the ER5716 need never be removed from the system for reprogramming since it may be performed, in the circuit, under system or end-user control Also eliminated is the danger of accidental erasure of data by ultraviolet irradiation.

## ER5716 VERSUS 2716

All pins of the two devices are functionally identical with the exception of pins 18 and 20 In order to make the ER5716 electrically alterable, the independent functions of Chip Enable

## PIN CONFIGURATION

24 pin dual in line

and Output Enable for the 2716 have been combined in the Chip Select ( $\overline{\mathrm{CS}}$ ) function of the ER5716, pin 20. Pin 18 retains the Program or Write function, but no longer serves as Chip Enable.

## DEVICE OPERATION

$V_{p}(p ı n 21)$ requires a d.c supply of +25 V in the Erase and Write modes, but remains at +5 V for all other operatıons. Reading may occur with $\mathrm{V}_{\mathrm{p}}$ at either level, however continuous operation of the device with $V_{p}$ at 25 V is not recommended.
Writing of data into the memory need not be sequential, it may be performed at any randomly selected byte location. However, writing is possible only after an Erase operation which removes all previously programmed data from the entire memory: individual word erasures are not possible

## BLOCK DIAGRAM



## MODES OF OPERATION

| PGM | $\mathbf{C S}$ | $\mathbf{V}_{\mathbf{P}}$ |  |
| :---: | :---: | :---: | :--- |
| 0 | 0 | +5 | READ-Data presented at the output pins a tıme, $t_{A}$ after an address change |
| Don't care | 1 | +5 | STANDBY-Chip deselected, data outputs in the high impedance state |
| Pulsed 0 to 1 | 1 | +25 | SINGLE WORD WRITE-Data at the data inputs is written to the selected address location |
| 0 | 0 | +25 | NOTE that correct writing can occur only if the chip has been previously erased |
| Pulsed 0 to 1 | 0 | +25 | ERASE-All 16,384 bits simultaneously erased to a logic ' 1 ' state. |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs except $V_{P}$ (with respect to $V_{S S}$ ) . . . -03 V to +7 V
$V_{p}$ (with respect to $V_{S S}$ ) . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +28 V
Storage temperature (with Data Retention) . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage temperature (without Data Retention) . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering temperature of leads ( 10 seconds) . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$V_{\mathrm{SS}}=$ GND
$V_{C C}=+5 \pm 5 \%$ volts
Programming Voltage, $\mathrm{V}_{\mathrm{P}}=+25 \mathrm{~V} \pm 1 \mathrm{~V}$
Operatıng Temperature range $\left(\mathrm{T}_{\mathrm{A}}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

$$
\begin{aligned}
& -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\
& -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
\end{aligned}
$$

DC CHARACTERISTICS

* Exceedıng these ratıngs could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operatıng ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ | Max | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Logic "1" | $\mathrm{V}_{\text {IH }}$ | 20 | - | $\mathrm{v}_{\mathrm{Cc}}+03$ | V |  |
| Input Logic "0" | $\mathrm{V}_{\mathrm{IL}}$ | -0.3 | - | 08 | V |  |
| Input Logic "1" (V $\mathrm{V}_{\text {only }}$ ) | $\mathrm{V}_{\mathrm{PH}}$ | $\mathrm{V}_{C C}-0.6$ | - | $\mathrm{V}_{C C}+0.6$ | V | See Note 1 |
| Output Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 24 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Output Logic "0" | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{V}_{\text {SS }}$ | - | 04 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Input Leakage (except Data) | $\mathrm{I}_{\mathrm{L}}$ | S | - | 2 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=58 \mathrm{~V}$ |
| Input Leakage (Data pins) | $\mathrm{I}_{\text {LD }}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=58 \mathrm{~V}$ |
| Output Leakage (Data pıns) | $\mathrm{I}_{\text {OD }}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {CC }}$ max |
| Power Supply Current V Supply: |  |  |  |  |  |  |
|  |  |  |  |  |  |  |
| Read mode | $\mathrm{I}_{P}$ | - | 4 | 7 | mA | $\mathrm{V}_{\mathrm{P}}=61 \mathrm{~V}$ |
| Write mode | $\mathrm{I}_{P}$ | - | 5 | 10 | mA | $V_{P}=26 \mathrm{~V}$ |
| Erase mode | $\mathrm{I}_{P}$ | - | 5 | 10 | mA | $\mathrm{V}_{\mathrm{P}}=26 \mathrm{~V}$ |
| $V_{\text {CC }}$ Supply. |  |  |  |  |  |  |
| Read mode | $\mathrm{I}_{\mathrm{CC}}$ | - | 32 | 50 | mA | $\overline{\mathrm{CS}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ |
| Write mode | $\mathrm{I}_{\mathrm{CC}}$ | - | 32 | 50 | mA | $\overline{\mathrm{CS}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}}$ |
| Erase mode | $\mathrm{I}_{\mathrm{CC}}$ | - | 32 | 50 | mA | $\overline{\mathrm{CS}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$ |
| Power Dissipation Read mode | $\mathrm{P}_{\mathrm{RD}}$ | - | 200 | 318 | mW | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{P}}=61 \mathrm{~V}$ |
| Write mode | $\mathrm{P}_{\text {WR }}$ | - | 306 | 535 | mW | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{P}}=26 \mathrm{~V}$ |
| Erase mode | $\mathrm{P}_{\text {ER }}$ | - | 306 | 535 | mW | $\mathrm{V}_{\mathrm{CC}}=55 \mathrm{~V}, \mathrm{~V}_{\mathrm{P}}=26 \mathrm{~V}$ |

NOTE: Characteristic data for ER5716IR/HR not available for inclusion at this time. Data available from General Instrument Distributors upon request.

AC CHARACTERISTICS

| Characteristic | Sym | Min | Typ | Max | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Capacitance-control inputs | $\mathrm{C}_{\mathrm{I}}$ | - | - | 7.5 | pF | $\mathrm{f}=1 \mathrm{MHz}$ |
| Input Capacitance-data inputs | $\mathrm{C}_{\text {D }}$ | - | - | 15 | pF | $\mathrm{f}=1 \mathrm{MHz}$ |
| Read Mode Characteristics |  |  |  |  |  |  |
| Read Access Tıme | $\mathrm{t}_{\mathrm{A}}$ | - | - | 300 | ns |  |
| Chip Select to Data Out delay | $t_{\text {D1 }}$ | - | - | 120 | ns | ( Output load 1TTL |
| Data hold time | $t_{\text {D2 }}$ | $\overline{10}$ | - | 100 | ns | $\}$ gate $+C_{L}=100 \mathrm{pF}$ |
| Address to Output float time | $\mathrm{t}_{\mathrm{D} 3}$ | 10 | - | - | ns | $\int$ ) |
| Write Mode Characteristics |  |  |  |  |  |  |
| Chip deselect to start of Write | $\mathrm{t}_{\mathrm{D} 11}$ | 200 | - | - | ns |  |
| Address and Data setup time | $\mathrm{t}_{\mathrm{D} 12}$ | 2 | - | - | $\mu \mathrm{s}$ |  |
| Data and $\overline{\mathrm{CS}}$ hold time | $\mathrm{t}_{\mathrm{D} 13}$ | 2 | - | - | $\mu \mathrm{s}$ |  |
| Chip Select to Output delay | $t_{\text {D14 }}$ | - | - | 120 | ns | See Note 2 |
| Address hold time | $\mathrm{t}_{\mathrm{D} 15}$ | 2 | - | - | $\mu \mathrm{s}$ |  |
| PGM pulse width | $t_{\text {PW }}$ | 800 | - | - | $\mu \mathrm{s}$ |  |
| PGM pulse rise and fall tımes | $\mathrm{t}_{\mathrm{r}, \mathrm{t}} \mathrm{t}_{\text {f }}$ | 5 | - | - | ns |  |
| Written state (data I/O) | $\mathrm{V}_{\mathrm{w}}$ | - | $\mathrm{V}_{\mathrm{IL}}, \mathrm{V}_{\mathrm{OL}}$ | - | V |  |
|  |  |  |  |  |  |  |
| $\overline{\mathrm{CS}}$ setup time | $\mathrm{t}_{\mathrm{D} 21}$ |  | - | - | $\mu \mathrm{s}$ |  |
| PGM to Output delay | $\mathrm{t}_{\mathrm{D} 22}$ | 2 | - | - | $\mu \mathrm{s}$ |  |
| PGM pulse width | $\mathrm{t}_{\mathrm{PE}}$ | 1 | - | - | sec |  |
| PGM pulse rise and fall times | $t_{r, ~}^{\text {, }}$ f | 5 | - | - | ns |  |
| Erased state (data I/O) | $V_{E}$ | - | VIn, VOH | - | V |  |

## NOTES:

1 The wide tolerance of this parameter allows the use of a driver circuit for switching $\mathrm{V}_{\mathrm{p}}$ between +5 V for reading and +25 V in the Erase and Write modes. Although all operations may be performed with +25 V applied to the chip, continuous operation is not recommended under these conditions
2. A Read immediately following a Write is not a required operation

NOTE: Characteristic data for ER5716IR/HR not avalable for inclusion at this time. Data available from General Instrument Distributors upon request

## TIMING DIAGRAM



Fig. 1 READ MODE TIMING


Fig. 2 WRITE MODE TIMING


Fig. 3 ERASE MODE TIMING

## Word Alterable 16K Bit Electrically Erasable and Programmable ROM

## FEATURES

- 5V operation in read mode
- Electrically Word or Block Erasable
- 2048 word $x 8$ bit organization, fully decoded
- Access time: 300 ns maximum
- 10 ms Erase and Write times
- Minimum of 10 years' non-volatile data retention
- N-Channel, Sigate, SNOS technology
- Unlimited Read capability
- Conforms to JEDEC byte-wide pinout standards
- Pin for pin compatible with Intel 2816 EEPROM
- Similar pinout to 2716 EPROM


## DESCRIPTION

The ER5816 is a high speed electrically word or block erasable and programmable memory fabricated in General Instrument's SNOS technology. Its microprocessor and microcomputer compatible architecture makes it very easy to interface with most popular processors, as does its 300 ns maximum access time.
Since the ER5816 is capable of being reprogrammed on a singlebyte basis while resident in the operating system, if offers greatly improved system flexibility over previous non-volatile alternatives such as ultraviolet EPROMs. In the case of program storage, software updates may be performed swiftly and easily from a normal system input device such as a keyboard or by downloading from a remote central processing unit via a data link. Where storage of data is necessary, the EEPROM may be programmed under user control from a simple input device as is the case in radio and television tuners, or under the automatic control of the host system, for example in recording system errors or failure modes. The key features of the device, in each case, are nonvolatile retention of information, electrical, in-system reprogrammability and reprogrammability on a single-byte basis which does not disturb data stored at adjacent locations. Further system flexibility is afforded by the Block Erase function, which erases all memory bits to the high state in readiness for rapid dumping of data at power loss or when extensive software updates are called for.
The ER5816 conforms to JEDEC byte-wide family standards. It is functionally and pin for pin compatible with the Intel 2816 EEPROM and also pin compatible with the 2716 EPROM. The ER5816, however, does not have special ramping requirements for the $\mathrm{V}_{\mathrm{PP}}$ supply voltage.

## PIN CONFIGURATION

24 PIN DUAL IN LINE


## OPERATION

Reading is a ripple-through operation initiated by an address change which results in valid data appearing at the output pins after the normal access time, $\mathrm{t}_{\mathrm{A}}$, provided that both $\overline{\mathrm{CE}}$ and $\overline{\mathrm{OE}}$ are low. Bus contention problems are minimized by the two-line control provided by CHIP ENABLE ( $\overline{\mathrm{CE}})$ and OUTPUT ENABLE ( $\overline{\mathrm{OE}})$ which also makes possible faster access than the normal access time to previously addressed data.
The single-byte Erase and Write operations are the same except that all input data bits must be a logical 1 for a Byte Erase. A Chip Erase is effected in the same way as a Byte Erase with the exception that the $\overline{\mathrm{OE}}$ input voltage $\left(\mathrm{V}_{\mathrm{OE}}\right)$ must fall in the range of +8 V to +15 V . All 16,384 bits are simultaneously erased to a logical high state by a Block Erase. It should be noted that corfect writing into memory will only occur if the addressed location has been preconditioned into the erased state by either a Byte or a Block Erase. Preconditioning may occur at any time prior to writing.
The specification of 10 years non-volatile data retention after a minimum of $10^{4}$ reprogramming cycles is merely one point on the curve of retention versus reprogramming cycles and does not imply a sudden cut-off or end of life. As the number of Erase/Write cycles per address increases, a gradual, logarithmic reduction in data retention capability occurs with 1 year of retention being a typical figure after $10^{5}$ cycles.


## PIN CONFIGURATION

| DEVICE | 2716 |  |  |  | ER5816 |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\begin{gathered} \overline{\mathrm{CE}} \\ \text { (18) } \end{gathered}$ | $\begin{gathered} \overline{O E} \\ (20) \end{gathered}$ | $\mathbf{v}_{\mathrm{pp}}$ (21) | 1/0 | $\begin{gathered} \overline{C E} \\ \text { (18) } \end{gathered}$ | $\begin{aligned} & \overline{O E} \\ & (20) \end{aligned}$ | $V_{p p}$ (21) | 1/0 |
| READ | $V_{\text {IL }}$ | $V_{\text {IL }}$ | +5 | $\mathrm{D}_{\text {OUT }}$ | $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\text {IL }}$ | +4 to +6 | $\mathrm{D}_{\text {OUT }}$ |
| BYTE ERASE | - | - | - | - | $\mathrm{V}_{\mathrm{LL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | +21 | $\mathrm{V}_{\mathrm{IH}}$ |
| BYTE WRITE | Pulsed | $\mathrm{V}_{\mathrm{IH}}$ | +25 | $\mathrm{D}_{\text {IN }}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\text {IH }}$ | +21 | $\mathrm{D}_{\text {in }}$ |
| CHIP ERASE |  | ULTRAVI | LET |  | $\mathrm{V}_{\mathrm{IL}}$ | +8 to +15 | +21 | $\mathrm{V}_{1 H}$ |
| STANDBY | $\mathrm{V}_{\mathrm{H}}$ | Don't Care | +5 | High-Z | $\mathrm{V}_{\mathrm{HH}}$ | Don't Care | +4 to +6 | High-Z |
| PROGRAM INHIBIT | $V_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IH}}$ | +25 | High-Z | $\mathrm{V}_{\mathrm{HH}}$ | Don't | Care | High-Z |


| Top View |  |  |  |
| :---: | :---: | :---: | :---: |
| A7 -1 | U |  | $\mathrm{V}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| A6 $\mathrm{Cl}^{2}$ |  | 23 | A8 |
| A5 ${ }^{3}$ |  | 22 |  |
| A4 4 |  | 21 | $\mathrm{V}_{\text {pp }}$ |
| A3 5 |  | 20 | OE |
| A2 ${ }^{6}$ | 2716 | 19 | A10 |
| A1 7 |  | 18 | CE |
| A0 ${ }^{8}$ |  | 17 | D7 |
| D0 $\square^{9}$ |  | 16 | D6 |
| D1 10 |  | 15 | D5 |
| D2 11 |  | 14 | D4 |
| GND 12 |  | 13 | D3 |



MODES OF OPERATION

| $\overline{C E}$ | $\overline{\mathrm{OE}}$ | $V_{\text {PP }}$ | D0-D7 |  | OPERATING MODE |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | +4 to +6 | Dout | READ | - Data stored at the addressed location appears at the output pins a time, $t_{A}$ after an address change. |
| 0 | 1 | +21 | $\mathrm{D}_{\text {IN }}=1$ | BYTE ERASE | - Only the selected word is erased to the ' 1 ' state. |
| 0 | 1 | +21 | $\mathrm{D}_{\text {IN }}$ | BYTE WRITE | - Data at the data inputs is written into the selected location. Note that correct writing may only occur if the location has been previously erased |
| 0 | +8 to +15 | $+21$ | $\mathrm{D}_{\text {IN }}=1$ | BLOCK ERASE | - The entire contents of memory is erased to the '1' state. |
| 1 | Don't Care |  | High-Z | CHIP DESELECTED |  |

## PIN FUNCTIONS

| NAME | FUNCTION |
| :---: | :---: |
| A0-A10 | 11-Bit Word Address |
| D0-D7 | Data input and output ports - high impedance in deselected mode. |
| $\mathrm{V}_{\text {cc }}$ | Power supply input Normally $+5 \pm 10 \%$ volts. |
| $\mathrm{V}_{\text {SS }}$ | Supply pin Normally at ground potentıal |
| $\overline{\mathrm{CE}}$ | Chıp enable ınput |
| $\overline{\mathrm{OE}}$ | Output enable input. |
| $V_{\text {PP }}$ | High Voltage power supply for erasing and writing In read mode, the +4 to +6 volt tolerance for the input voltage on this pin allows the use of voltage multiplier for generatıng the +21 V programming voltage |



ER5816 ■ ER5816IR ■ ER5816HR

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs with respect to Ground except

Input voltage, pins 20 and 21 with respect to Ground ....+24V to -0.3 V
Storage Temperature (unpowered and without data
retention) $\qquad$ . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering Temperature of Leads (10 seconds) .$+300^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted):
$\mathrm{V}_{\mathrm{SS}}=\mathrm{GND}$
$\mathrm{V}_{\mathrm{cc}}=+5 \pm 5 \%$ volts
Operatıng Temperature Ranges ( $\mathrm{T}_{\mathrm{A}}$ ): $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

$$
\begin{aligned}
& -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\
& -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
\end{aligned}
$$

## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Logic "1" (except pins 20 and 21) | $\mathrm{V}_{\mathrm{IH}}$ | 20 | - | $\mathrm{V}_{\mathrm{CC}}+0.3$ | V |  |
| Input Logic "0" | $\mathrm{V}_{\text {IL }}$ | -0.1 | - | +08 | v |  |
| Output Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}$ |
| Output Logic "0" | $\mathrm{V}_{\text {OL }}$ | $\mathrm{V}_{\mathrm{ss}}$ | - | 0.45 | v | $\mathrm{I}_{\mathrm{OL}}=2.1 \mathrm{~mA}$ |
| Input Leakage Current | 1 IL | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=5.25 \mathrm{~V}$ |
| Power Supply Requirements |  |  |  |  |  |  |
| $\mathrm{V}_{\text {pp }}$ Read Voltage | $V_{\text {PP }}$ | 4 | 5 | 6 | v | See Note 1 |
| $V_{\text {pp }}$ Erase/Write Voltage | $V_{\text {PP }}$ | 20 | 21 | 22 | v |  |
| Chip Erase Voltage | $V_{\text {OE }}$ | 8 | - | 15 | v | $\mathrm{I}_{\overline{\mathrm{OE}}}=10 \mu \mathrm{~A}$ |
|  |  |  |  |  |  |  |
| Chip Selected | $\mathrm{I}_{\mathrm{cc}}$ | - | 40 | 90 | mA |  |
| Chip Deselected | $\mathrm{I}_{\mathrm{cc}}$ | - | 15 | 25 | mA |  |
| $\mathrm{V}_{\text {Pp }}$ Supriy: |  |  |  |  |  |  |
| Read Mode | $\mathrm{I}_{\mathrm{PP}}$ | - | - | 5 | mA | $\mathrm{V}_{\mathrm{PP}}=6 \mathrm{~V}$ |
| Erase/Write/Block Erase Mode | $I_{\text {pp }}$ | - | - | 15 | mA | $V_{P P}=21 \mathrm{~V}, \overline{\mathrm{CE}}=\mathrm{V}_{1 \mathrm{~L}}$ |
| Program Inhibit Mode | $I_{\text {PP }}$ | - | - | 5 | mA | $V_{P P}=21 \mathrm{~V}, \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IH}}$ |
|  |  |  |  |  |  |  |
| Chip Selected | $\mathrm{P}_{\mathrm{D}}$ | - | 200 | 450 | mW |  |
| Chip Deselected | $P_{D}$ | - | 75 | 125 | mW |  |

## NOTE:

$1 \mathrm{~V}_{\mathrm{PP}}$ minimum in Read mode not to exceed $\mathrm{V}_{\mathrm{CC}}-0.6$.

## AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input capacitance | $\mathrm{C}_{1}$ | - | 4 | 6 | pF | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ |
| Output capacitance | $\mathrm{C}_{0}$ | - | - | 10 | pF | $V_{\text {OUT }}=0 \mathrm{~V}$ |
| Read Mode |  |  |  |  |  | All AC Test conditions: |
| Access time - Address to output delay | $t_{\text {A }}$ | - | - | 300 | ns | Output load: 1 TTL gate $+\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |
| CE to output delay | $t_{\text {CE }}$ | - | - | 350 | ns |  |
| OE to qutput delay | $\mathrm{t}_{\text {OE }}$ | 10 | - | 120 | ns | Input pulse levels• 05 V to 2.2 V |
| Data hold time | $\mathrm{t}_{\mathrm{DH}}$ | - | - | 100 | ns |  |
| Byte Erase/Write Mode |  |  |  |  |  |  |
| Address, CE and OE setup time | $\mathrm{t}_{\text {cs }}$ | 150 | - | - | ns |  |
| Data setup time | $t_{\text {DS }}$ | 0 | - | - | ns |  |
| Address, data, $\overline{\mathrm{CE}}$ and $\overline{\mathrm{OE}}$ hold time | $\mathrm{t}_{\mathrm{CH}}$ | 50 | - | - | $\mu \mathrm{s}$ |  |
| $\mathrm{V}_{\mathrm{PP}}$ Rise and Fall time | $t_{R}, t_{F}$ | 001 | - | 100 | $\mu \mathrm{s}$ |  |
| Erase time | $\mathrm{t}_{\mathrm{E}}$ | 9 | 10 | 15 | ms |  |
| Write time | $t_{\text {w }}$ | 9 | 10 | 15 | ms |  |
| Block Erase Mode |  |  |  |  |  |  |
| CE setup time | $\mathrm{t}_{\mathrm{CS}}$ | 150 | - | - | ns |  |
| CE hold tıme | $\mathrm{t}_{\mathrm{CH}}$ | 50 | - | - | $\mu \mathrm{s}$ |  |
| $V_{p P}$ Rise and Fall time | $t_{R}, t_{F}$ | 0.01 | - | . 100 | $\mu \mathrm{s}$ |  |
| $\overline{O E}$ to $V_{P P}$ set up time | $\mathrm{t}_{\mathrm{OS}}$ | 0 | - | - | ns |  |
| $\overline{\mathrm{OE}}$ hold time | $\mathrm{t}_{\mathrm{OH}}$ | 0 | - | - | ns |  |
| Block erase time | $t_{B E}$ | 9 | 10 | 15 | ms |  |

MEMORY CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Erase time - byte or block | $\mathrm{t}_{\mathrm{E}}$ | 9 | 10 | 15 | ms |  |
| Erased state | $\mathrm{V}_{\mathrm{E}}$ | - | $\mathrm{V}_{\mathrm{HH}}, \mathrm{V}_{\mathrm{OH}}$ | - | V |  |
| Write time | $\mathrm{t}_{\mathrm{W}}$ | 9 | 10 | 15 | ms |  |
| Writen state | $\mathrm{V}_{\mathrm{W}}$ | - | $\mathrm{V}_{\mathrm{IL}}, \mathrm{V}_{\mathrm{OL}}$ | - | V |  |
| Data retention time <br> (powered or unpowered) | $\mathrm{t}_{\mathrm{S}}$ | 10 | - | - | $\mathrm{Y}_{\mathrm{rs}}$ |  |
| Number of Erase/Write cycles per byte | $\mathrm{N}_{\mathrm{EW}}$ | $10^{4}$ | - | - | - | See Note 1 |
| Number of Read accesses between refresh | $\mathrm{N}_{\mathrm{RA}}$ | - | - | - | - | Unlımited |

NOTE
1 Does not imply end of useful life See "Operation" for further explanation.
TIMING DIAGRAMS


Fig. 1 READ MODE TIMING


Fig. 2 BYTE ERASE AND WRITE TIMING

## TIMING DIAGRAM



Fig. 3 block erase timing

## Word Alterable 16K Bit Electrically Erasable and Programmable ROM

## FEATURES

- No high voltages -+5 V only operation in all modes
- Electrically Word or Block Erasable
- 2048 word $x 8$ bit organization, fully decoded
- Access time: 300 ns maximum
- 20 ms Erase and Write times
- Minimum of 10 years' non-volatile data retention
- N-Channel, Si-Gate SNOS technology
- Unlimited Read capability
- Conforms to JEDEC byte-wide pinout standards
- Functionally equivalent to Intel 2816 EEPROM
- Similar pinout to 2716 EPROM


## DESCRIPTION

The ER5916 is a high speed electrically word or block erasable and programmable memory fabricated in General Instrument's SNOS technology. Its microprocessor and microcomputer compatible architecture makes it very easy to interface with most popular processors, as does its 300 ns maximum access time.
Making it even more attractive to the system design engineer is its +5 V only operation in all modes; no high voltages are required for erasing and writing. The ER5916, therefore, offers increased flexibility and opportunities for innovation in new designs since a large amount of data can now be stored in a non-volatile medium and selected portions of it altered with great ease during normal system operation.
This device conforms to JEDEC byte-wide family standards and is functionally compatible with the ER5816 and the Intel 2816 EEPROM. Some differences of pin functions and control logic levels are necessary due to the ER5916's 5 V only operation. Refer to the comparison of these two devices included in this data sheet.
Bus contention problems are minimized by the two-line control provided by CHIP ENABLE ( $\overline{\mathrm{CE}}$ ) and OUTPUT ENABLE ( $\overline{\mathrm{OE}}$ ). Programming operations are controlled by one TTL level input, WRITE ENABLE (WE).

## PIN CONFIGURATION <br> 24 PIN DUAL IN LINE


after the normal access time, $T_{A}$ has elapsed. $\overline{O E}$, when held high, disables the outputs and allows fast access to data when pulsed low.

Erasing and writing of one byte are essentially the same except that all input data bits must be held high for an erase operation.
A chip erase mode is also provided for applications such as program storage in which software updates are made at infrequent intervals. In this mode, all locations are erased into the ' 1 ' state with the same, 20 ms pulse as required for a single byte erase.
There is a trade-off to be made between the data retention time and the number of Erase/Write cycles performed per location. A gradual, logarithmic reduction in retention time is experienced as the number of Erase/Write cycles increases. The specified limit is merely one point on this curve and does not imply a sudden cut-off or end of life. After $10^{5}$ cycles a typical retention time is 1 year.

## OPERATION

Reading is a ripple-through operation initiated by an address change. If both $\overline{\mathrm{CE}}$ and $\overline{\mathrm{OE}}$ are low, data appears at the outputs

BLOCK DIAGRAM

$\square$
INSTRUMEREN
PIN CONFIGURATION

| DEVICE | 2716 |  |  |  | ER5816 |  |  |  | ER5916 |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\begin{aligned} & \text { CE } \\ & \text { (18) } \end{aligned}$ | $\begin{aligned} & \overline{O E} \\ & (20) \end{aligned}$ | $\mathbf{v}_{\mathrm{pp}}$ (21) | 1/0 | $\begin{aligned} & \hline \overline{C E} \\ & \text { (18) } \end{aligned}$ | $\begin{aligned} & \overline{O E} \\ & (20) \end{aligned}$ | $v_{\mathrm{pp}}$ (21) | 1/0 | $\begin{gathered} \hline \overline{C E} \\ (18) \end{gathered}$ | $\begin{aligned} & \overline{O E} \\ & \text { (20) } \end{aligned}$ | WE <br> (21) | 1/0 |
| READ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\text {IL }}$ | +5 | Dout | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\text {IL }}$ | +4 to +6 | $\mathrm{D}_{\text {OUt }}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IL}}$ | Dout |
| BYTE ERASE | - | - | - | - | $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IH}}$ | +21 | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IH}}$ |
| BYTE WRITE | Pulsed | $\mathrm{V}_{\mathrm{IH}}$ | +25 | $\mathrm{D}_{\mathrm{IN}}$ | $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IH}}$ | +21 | $\mathrm{D}_{\text {IN }}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{D}_{\text {IN }}$ |
| CHIP ERASE |  | ULTRAVIO | LET |  | $\mathrm{V}_{\text {IL }}$ | +8 to +15 | +21 | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | Don't Care |
| STANDBY | $\mathrm{V}_{\mathrm{IH}}$ | Don't Care | +5 | High-Z | $\mathrm{V}_{\mathrm{IH}}$ | Don't Care | +4 to +6 | High-Z | $\mathrm{V}_{\mathrm{IH}}$ | Don't | Care | High-Z |
| PROGRAM INHIBIT | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | +25 | High-Z | $\mathrm{V}_{\mathrm{IH}}$ | Don't | Care | High-Z | $\mathrm{V}_{\mathrm{IH}}$ | Don' | are | High-Z |




|  | Top View |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| A7 | $\bullet 1$ | $\checkmark$ | 24 | $\mathrm{v}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| A6 | 2 |  | 23 | A 8 |
| A5 | 3 |  | 22 | A9 |
| A4 | 4 |  | 21 | WE |
| A3 | 5 |  | 20 | $\overline{O E}$ |
| A2 | 6 | ER5916 | 19 | A10 |
| A1 | 7 |  | 18 | $\overline{C E}$ |
| A0 | 8 |  | 17 | D7 |
| DO | 9 |  | 16 | D6 |
| D1 | 10 |  | 15 | D5 |
| D2 | 11 |  | 14 | D4 |
| $\mathrm{v}_{\text {ss }}(\mathrm{GND})$ | 12 |  | 13 | D3 |

## MODES OF OPERATION

| $\overline{C E}$ | $\overline{O E}$ | WE | D0-D7 |  | OPERATING MODE |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | $\mathrm{D}_{\text {OUT }}$ | READ | - Data stored at the addressed location appears at the output pins a time, $t_{A}$ after an address change. |
| 0 | 1 | 1 | $\mathrm{D}_{\text {IN }}=1$ | BYTE ERASE | - Only the selected word is erased to the ' 1 ' state |
| 0 | 1 | 1 | $\mathrm{D}_{\text {IN }}$ | BYTE WRITE | - Data at the data inputs is written into the selected location. Note that correct writing may only occur if the location has been previously erased. |
| 0 | 0 | 1 | Don't Care | BLOCK ERASE | - The entire contents of memory is erased to the ' 1 ' state |
| 1 | Don' | Care | High-Z | CHIP DESELECTED |  |

## PIN FUNCTIONS

| NAME | FUNCTION |
| :---: | :--- |
| $\mathbf{A O - A 1 0}$ | 11-Bit Word Address |
| D0-D7 | Data input and output ports - high impedance in deselected mode |
| $\mathbf{V}_{\mathbf{C C}}$ | Power supply input. Normally $+5 \pm 10 \%$ volts. |
| $\mathbf{V}_{\mathbf{S S}}$ | Supply pin. Normally at ground potential. |
| $\overline{\mathbf{C E}}$ | Chip enable input. |
| $\overline{\mathbf{O E}}$ | Output enable input |
| $\mathbf{W E}$ | Write enable input |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs with respect to Ground except
pins 20 and 21 . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +6 V to -03 V
Input voltage, pins 20 and 21 with respect to Ground . .... +24 V to -0.3 V
Storage Temperature (unpowered and without data
retention)
$-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Soldering Temperature of Leads ( 10 seconds) . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$V_{\mathrm{SS}}=\mathrm{GND}$
$\mathrm{V}_{\mathrm{CC}}=+5 \pm 5 \%$ volts
Operating Temperature Ranges ( $\mathrm{T}_{\mathrm{A}}$ ): $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

$$
\begin{aligned}
& -40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\
& -55^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C}
\end{aligned}
$$

*Exceeding these ratings could cause permanent damage. Functional operation of this device at these conditions, or any other conditions outside those indicated in the operational sections of this specification, is not implied.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

DC CHARACTERISTICS

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Logic "1" (except pins 20 and 21) | $\mathrm{V}_{\mathrm{IH}}$ | 2.0 | - | $\mathrm{V}_{\mathrm{CC}}+0.3$ | V |  |
| Input Logic "1" (pins 20 and 21) | $\mathrm{V}_{\mathrm{IC}}$ | 2.0 | - | +22 | V |  |
| Input Logic "0" | $\mathrm{V}_{\mathrm{IL}}$ | -0.1 | - | +0.8 | V |  |
| Output Logic "1" | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{CC}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}$ |
| Output Logic "0" | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{V}_{\mathrm{SS}}$ | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=2.1 \mathrm{~mA}$ |
| Input Leakage Current | $\mathrm{I}_{\mathrm{IL}}$ | - | - | 10 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{IN}}=5.25 \mathrm{~V}$ |
| Power Supply Requirements |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ Supply: |  |  |  |  |  |  |
| Chip Selected | $\mathrm{I}_{\mathrm{CC}}$ | - | 40 | 90 | mA |  |
| Chip Deselected | $\mathrm{I}_{\mathrm{CC}}$ | - | 15 | 25 | mA |  |
| Power Dissipation: |  |  |  |  |  |  |
| Chip Selected | $\mathrm{P}_{\mathrm{D}}$ | - | 200 | 450 | mW |  |
| Chip Deselected | $\mathrm{P}_{\mathrm{D}}$ | - | 75 | 125 | mW |  |

NOTE 1: $\left(T_{A}\right)=-40$ to $+85^{\circ} \mathrm{C} \quad \mathrm{V}_{\mathrm{CC}}=+5 \pm 5 \%$, unless otherwise specified.

## AC CHARACTERISTICS

| Characteristic | Sym | Min | Tур | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input capacitance Output capacitance | $\begin{aligned} & \mathrm{C}_{\mathrm{I}} \\ & \mathrm{C}_{2} \end{aligned}$ | - | 4 | 6 10 | pF pF | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{OV} \\ & \mathrm{~V}_{\mathrm{OUT}}=\mathrm{OV} \end{aligned}$ |
| Read Mode <br> Access time - Address to output delay | $t_{\text {A }}$ | - | - | 300 | ns | All AC Test conditions: <br> Output load: 1TTL gate $+C_{L}=100 \mathrm{pF}$ |
| CE to output delay | $t_{\text {ce }}$ | - | - | 350 | ns |  |
| OE to output delay | $t_{\text {OE }}$ | 10 | - | 120 | ns | Input pulse levels: 0.5 V to 2.2 V |
| Data hold time | $\mathrm{t}_{\mathrm{DH}}$ | - | - | 100 | ns |  |
| Byte Erase/Write Mode |  |  |  |  |  |  |
| Address, CE and OE setup time | $\mathrm{t}_{\mathrm{cs}}$ | 200 | - | - | ns |  |
| Data setup time | $\mathrm{t}_{\mathrm{DS}}$ | 100 | - | - | ns |  |
| Address, data, CE and OE hold time | $\mathrm{t}_{\mathrm{CH}}$ | 2 | $\overline{25}$ | - | $\mu \mathrm{s}$ |  |
| Write time | $t_{w}$ | 20 | 25 | 30 | ms |  |
| Block Erase Mode |  |  |  |  |  |  |
| CE setup time | $\mathrm{t}_{\mathrm{cs}}$ | 200 | - | - | ns |  |
| CE hold time | $\mathrm{t}_{\mathrm{CH}}$ | 2 | - | - | $\mu \mathrm{s}$ |  |
| Block erase tıme | $t_{B E}$ | 20 | 25 | 30 | ms |  |

## MEMORY CHARACTERISTICS

| Characteristic | Sym | Min | Typ | Max | Units |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Erase time - byte or block | $t_{\mathrm{E}}$ | 20 | 25 | 30 | ms |  |
| Erased state | $\mathrm{V}_{\mathrm{E}}$ | - | $\mathrm{V}_{\mathrm{IH}}, \mathrm{V}_{\mathrm{OH}}$ | - | - |  |
| Write time | $\mathrm{t}_{\mathrm{W}}$ | 20 | 25 | 30 | ms |  |
| Written state | $\mathrm{V}_{\mathrm{W}}$ | - | $\mathrm{V}_{\mathrm{IL}}, \mathrm{V}_{\mathrm{OL}}$ | - | - |  |
| Data retention time | $\mathrm{t}_{\mathrm{S}}$ | 10 | - | - | Yrs |  |
| $\quad$ (powered or unpowered) |  |  |  |  |  |  |
| Number of Erase/Write cycles per byte | $\mathrm{N}_{\mathrm{EW}}$ | $10^{4}$ | - | - | - | See Note 1 |
| Number of Read accesses between refresh | $\mathrm{N}_{\mathrm{RA}}$ | - | - | - | - | Unlımited |

NOTE.

## TIMING DIAGRAMS



Fig. 1 READ MODE TIMING


Fig. 2 bYte erase and write timing

## TIMING DIAGRAM



Fig. 3 BLOCK ERASE TIMING

## GENERAL INSTRUMENT

## Non-Volatile Static RAM



## 4K N-CHANNEL NON-VOLATILE STATIC RAM

## FEATURES

- $512 \times 8$ bit organization, fully decoded RAM overlaid bit for bit with non-volatile EEPROM
- Single +5 V power supply
- 300 ns RAM cycle time
- TTL compatible
- Data can be recalled an unlimited number of times
- $10^{4}$ store cycles with 10 year data retention
- Power failure protection


## DESCRIPTION

The ER5304 is a high speed non-volatile Si-Gate RAM. The device contains 4 K bits of memory organized as a conventional 4 K static RAM overlaid bit-for-bit with a non-volatile 4K Electrically Erasable ROM (EEPROM). The device can be used as a conventional static RAM while the non-volatile data stored in the EEPROM remains unaffected. Non-volatile data can be transferred back and forth between the RAM and the EEPROM by simple STORE and ARRAY RECALL signals. During the lifetime of the device, data can be recalled from the EEPROM an unlimited number of times.
A single 5 V supply is the only power source ever required for any function. High voltage pulses or supplies are never required. All inputs and outputs are TTL compatible with Tri-state outputs. The device cycle time for both read and write is 300 ns .
The device is capable of protecting against data loss due to a power failure. One simple TTL signal saves the entire RAM contents. A non-volatile copy of all RAM data is internally stored in the EEPROM and can be recalled to the RAM when power returns. No battery backup is required.

## PIN CONFIGURATION <br> 24 PIN DUAL IN LINE




| ER5304 | INSTRUMERAL |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All Inputs and Outputs with Respect to Ground .......... -0.3 to +7 V Storage Temperature (without Data Retention) . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Storage Temperature (with Data Retention) .......... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Soldering Temperature of Leads ( 10 seconds) . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise stated):
$\mathrm{V}_{\mathrm{ss}}=$ GND
$V_{C C}=5 \pm 5 \%$ Volts
Operating Temperature $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

## DC CHARACTERISTICS

| Characteristics | Sym | Min | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :--- |
| Power Supply Current | $\mathrm{I}_{\mathrm{CC}}$ | - | 60 | mA | All Inputs $=5.25 \mathrm{~V} \mathrm{D}_{\mathrm{OUT}}$ Open $^{2}=\mathrm{T}_{\mathrm{A}}{ }^{\circ} \mathrm{C}$ |
| Output Leakage Current | $\mathrm{I}_{\mathrm{LO}}$ | -1.0 | +1.0 | $\mu \mathrm{~A}$ | $\mathrm{~V}_{\mathrm{OUT}}=\mathrm{GND}$ to $\mathrm{V}_{\mathrm{CC}}$ |
| Input Low Voltage | $\mathrm{V}_{\mathrm{IL}}$ | -.3 | .8 | V |  |
| Input High Voltage | 2.0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |  |  |
| Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | - | .4 | V | $\mathrm{I}_{\mathrm{OL}}=2.0 \mathrm{~mA}$ |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | V | $\mathrm{I}_{\mathrm{OH}}=1 \mathrm{~mA}$ |

## PIN FUNCTIONS

| NAME | FUNCTION |
| :--- | :--- |
| A0-A8 | Address Lines |
| DO-D7 | Data I/O |
| CS | Chip Select |
| $\overline{\text { WE }}$ | Write Enable <br> Transfers Data stored in EEPROM <br> back to RAM |
| $\overline{\text { ARRAY RECALL }}$ |  |
|  | Transfers Data from RAM into <br> Non-Volatile EEPROM <br> STORE |
|  | +5 Volts <br> Ground |


| PINS <br> MODE | $\begin{aligned} & \overline{\mathbf{C S}} \\ & \text { (13) } \end{aligned}$ | $\begin{aligned} & \overline{W E} \\ & \text { (10) } \end{aligned}$ | STORE <br> (9) | $\begin{gathered} \overline{\text { ARRAY }} \\ \overline{\text { RECALL }} \\ \text { (11) } \end{gathered}$ | DATA I/O (14-21) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Deselected (See Notes 1 \& 2) | 1 |  | Don't C |  | High Z |
| RAM Write | 0 | 0 | 1 | 1 | Data In |
| RAM Read | 0 | 1 | 1 | 1 | Data Out |
| EEPROM Store <br> (See Note 2) | 0 | 1 | 0 | 1 | High Z |
| EEPROM Recall | 0 | 1 | 1 | 0 | High Z |

NOTES:

1. Chip is deselected but may be automatically completing a store cycle.
2. $\overline{C S}$ and $\overline{\text { STORE }}$ must be low only to initiate a store cycle, after which the cycle will continue to completion automatically ( $\overline{C S}, \overline{S T O R E}=X$ ).


READ CYCLE


|  | Characteristics | Sym | Min | Typ | Max | Units |  |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Read Cycle Tıme | $\mathrm{t}_{\mathrm{RC}}$ | 300 | - | - | ns |  |
| Access Tıme | $\mathrm{t}_{\mathrm{A}}$ | - | - | 300 | ns |  |  |
| Chip Select to Output Valıd | $\mathrm{t}_{\mathrm{CO}}$ | - | - | 200 | ns |  |  |
| Output Hold from Address Change | $\mathrm{t}_{\mathrm{OH}}$ | 50 | - | - | ns |  |  |
| Chıp Deselect to Output in High Z | $\mathrm{t}_{\mathrm{HZ}}$ | 10 | - | 100 | ns |  |  |

## WRITE CYCLE



| Parameter | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Write Cycle Tıme | $\mathrm{t}_{\mathrm{WC}}$ | 300 | - | - | ns |  |
| Chıp Select to End of Write | $\mathrm{t}_{\mathrm{cW}}$ | 150 | - | - | ns |  |
| Address to Write Set-up Time | $\mathrm{t}_{\mathrm{AW}}$ | 50 | - | - | ns |  |
| Write Pulse Width | $\mathrm{t}_{\mathrm{wP}}$ | 100 | - | - | ns |  |
| Write Recovery Tıme | $\mathrm{t}_{\mathrm{wR}}$ | 25 | - | - | ns |  |
| Data Valid to End of Write | $\mathrm{t}_{\mathrm{OW}}$ | 100 | - | - | ns |  |
| Data Hold Tıme | $\mathrm{T}_{\mathrm{OH}}$ | 20 | - | - | ns |  |

In read and Write modes the device operates as a conventional static RAM The device is selected with a logic " 0 " level applied to the $\overline{C S}$ pin A logic " 1 " input on $\overline{W E}$ selects the Read mode, a logic " 0 " selects the Write mode Address lines must remain stable for
the duration of the Read or Write cycle Data outputs are in the high impedance state whenever the Device is deselected or during a store or Array Recall Cycle

A Store Cycle is initiated by applying two logic " 0 " level pulses to the STORE pin of a selected device This causes all 4096 bits of data in the EEPROM to be modified to an exact copy of the current RAM data. The original data in the RAM remains valıd. The $\overline{W E}$ and ARRAY RECALL inputs are inhibited during the store operation and the data outputs are Trı-stated. The inhibited inputs will

| ER5304 | INSTRUMERAL |
| :---: | :---: |

be enabled upon completion of the Store Operation if the STORE input is high. Data stored in the EEPROM remains valid with or without power supplied to the ER5304.
To prevent an unintentional Store Cycle during power-up or power-down either the STORE or $\overline{C S}$ input should be kept high by tying the input to $\mathrm{V}_{\mathrm{CC}}$ through a pull up resistor.


| Characteristics | $\mathbf{S y m}^{\text {Sym }}$ | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Store Cycle Time $\left(\mathrm{t}_{\text {SPD }}=5 \mathrm{~ms}\right)$ | $\mathrm{t}_{\text {STC }}$ | - | - | 10 | ms |  |
| Store Pulse Width | $\mathrm{t}_{\text {STP }}$ | 100 | - | - | ns |  |
| Chip Select to End of Store | $\mathrm{t}_{\text {CST }}$ | 125 | - | - | ns |  |
| Chip Select to Store Set-up Tıme | $\mathrm{t}_{\text {CSS }}$ | 25 | - | - | ns |  |
| Store Second Pulse Delay Time | $\mathrm{t}_{\text {SPD }}$ | 5 | - | - | ms |  |
| Store Reset Time | $\mathrm{t}_{\text {SRS }}$ | 300 | - | - | ns |  |



| Characteristics | Sym | Min | Typ | Max | Units |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Array Recall Cycle Tıme | $\mathrm{t}_{\mathrm{RCC}}$ | 1500 | 1000 | - | ns |  |
| Chıp Select to End of Recall | $\mathrm{t}_{\mathrm{CRC}}$ | 750 | - | - | ns |  |
| Recall Pulse Width | $\mathrm{t}_{\mathrm{RCP}}$ | 750 | - | - | ns |  |
| Chip Deselect to Output in Hıgh Z <br> Recalled Data Access Tıme from <br> $\quad$ End of Recall | $\mathrm{t}_{\mathrm{HZ}}$ | 10 | - | 100 | ns |  |

The Array Recall Cycle reads the non-volatile data stored in the EEPROM and copies it back into the RAM. A logic " 0 " on the ARRAY RECALL input of a selected device will initiate a cycle that in a single operatıon will overwrite all 4096 bits of data in the RAM with the data from the EEPROM The data in the EEPROM
remains unaltered. Once the EEPROM data is back in the RAM it can be accessed by normal RAM Read or Write cycles.
Data that has been stored properly in the non-volatile EEPROM of the ER5304 may be recalled an unlımited number of times during the lifetıme of the device.

# Microcomputer 

| PIC Series | $4-3$ |
| ---: | ---: |
| PIC Development Series | $4-95$ |
| PICAL | $4-131$ |
| PICES II | $4-134$ |
| PIC Field Demo Systems | $4-137$ |
| PIC Series Options | $4-139$ |
| PIC Series Order Form | $4-140$ |


| , FUnCTION |  | PART: NUMBER | PACE NUMBER |
| :---: | :---: | :---: | :---: |
| PIC Series |  |  |  |
| 8 BIT MCROCOMPUTEF | The PlC1650 series of microcomputers contain RAM $1 / O$ and a central processing unit as well as a customer defined ROM to specify overall functional characteristios of the device. | P1C1650A | 4.4 |
|  |  | PIC1650XT | 4-16 |
|  |  | PlC1654 | 4-28 |
|  |  | PIC1655A | $4 \times 38$ |
|  |  | P1C1655×T | 4-50 |
|  |  | P1C16C55 | 4.62 |
|  |  | Picis66 | 4-72 |
|  |  | P1C1670 | 4.85 |
| PIC Development Series |  |  |  |
| $\left\lvert\, \begin{gathered} \text { 8BIT } \\ \text { DEVELOPMENT } \\ \text { MICROCOMPUTER } \end{gathered}\right.$ | PIC microcomputer without ROM and with addition of a HALT pIn. | PlC1664 | 4.96 |
|  |  | P1C16C63: | 4-110 |
|  |  | P1C1665 | 4-121 |
|  |  | PICAL/PICES II |  |
| PIC ASSEMBLER | Converts symbolic source programs for PlC series into object code. | PCAL | 4.132 |
| PIC DEVELOPMENT SYSTEM | In-circuit emulation and debbug system-stand aione or peripheral. | PICES | 4-134 |
| PIC Field Demo Systems |  |  |  |
| $\begin{aligned} & \text { PIC FIELD DEMO } \\ & \text { SYSTEMS } \end{aligned}$ | Contains PIC microcomputer, PROMS and provisions for on-board RC oseilfator or external clock. | $\begin{aligned} & \text { PFD" } \\ & \text { Systems } \end{aligned}$ | 4-138 |


| FUNCTION | DESCRIPTION | PART NUMBER | page NUMBER |
| :---: | :---: | :---: | :---: |
| 8 BIT MICROCOMPUTEA | The PIC1650 series of microcomputers contain RAM L/O and a central processing unit as well as a customer defined ROM to specify overall functional characteristics of the device. | PIC1650A | 4-4 |
|  |  | PlC1650xT | 4-16 |
|  |  | PIC1654 | 4-28 |
|  |  | PIC1655A | 4-38 |
|  |  | PIC1655XT | 4-50 |
|  |  | PIC16C55 | 4-62 |
|  |  | PIC1656 | 4-72 |
|  |  | PIC1670 | 4-85 |

## 8 Bit Microcomputer

## FEATURES

- User programmable
- Intelligent controller for stand-alone applications
- 32 8-bit RAM registers
- $512 \times 12$-bit program ROM
- Arithmetic Logic Unit
- Real Tıme Clock/Counter
- Self-contanned oscillator
- Access to RAM registers inherent in instruction
- Wide power supply operating range ( 4.5 V to 7.0 V )
- Available in two temperature ranges: $0^{\circ}$ to $70^{\circ} \mathrm{C}$ and $-40^{\circ}$ to $85^{\circ} \mathrm{C}$
- 4 sets of 8 user defined TTL-compatible Input/Output lines
- 2 level stack for subroutine nesting


## DESCRIPTION

The PIC1650A microcomputer is an MOS/LSI device contanning RAM, I/O, and a central processing unit as well as customerdefined ROM on a single chip This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs. Keyboard scanning, display driving, and other system control functions can be done at the same time due to the power of the 8 -bit CPU
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device The 8-bit input/output registers provide latched lines for interfacıng to a limitless variety of applications. The PIC can be used to scan keyboards, drive displays, control electronic games and provide enhanced capabilities to vendıng machınes, traffic lights, radios, television, consumer appliances, industrial timıng and control applicatıons. The 12-bit instruction word format provides a powerful yet easy to use
instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC1650A is fabricated with N-Channel Ion Implant technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operating clock with only an external RC network (or buffered crystal oscillator signal, for greater accuracy) to establish the frequency Inputs and outputs are TTL-compatible
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling. Programs can be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PIC's operation can be verified in any hardware application by using the PIC1664. The PIC1664 is a ROM-less PIC microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands The PFD1000 Field Demo System is available containıng a PIC1664 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM. With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market.
A PIC Series Microcomputer Data Manual is avaılable which gives additional detailed data on PIC based system design.

## PIC1650A BLOCK DIAGRAM



## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC series microcomputer is based on a register file concept with simple yet powerful com－ mands designed to emphasize bit，byte，and register transfer operations．The instruction set also supports computing functions as well as these control and interface functions
Internally，the PIC is composed of three functional elements con－ nected together by a single bidirectional bus＇the Register File composed of 32 addressable 8－bit registers，an Arithmetıc Logic Unit，and a user－defined Program ROM composed of 512 words each 12 bits in width The Register File is divided into two func－ tıonal groups operational registers and general registers．The operatıonal registers include，among others，the Real Tıme Clock Counter Register，the Program Counter（PC），the Status Register，
and the I／O Registers The general purpose registers are used for data and control information under command of the instructions The Arithmetıc Logıc Unit contaıns one temporary workıng regis－ ter or accumulator（W Register）and gatıng to perform Boolean functions between data held in the working register and any file register
The Program ROM contains the operational program for the rest of the logic withın the controller Sequencıng of microinstructions is controlled via the Program Counter（PC）which automatically increments to execute in－line programs．Program control opera－ tions can be performed by Bit Test and Skip instructions，Jump instructions，Call instructions，or by loading computed addresses into the PC In addition，an on－chip two－level stack is employed to provide easy to use subroutine nesting Activating the $\overline{M C L R}$ input on power up initıalızes the ROM program to address $777_{8}$

## PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| OSC（input） | Oscillator input This signal can be driven by an external oscillator if a precise frequency of operation is required or an external RC network can be used to set the frequency of operation of the internal clock generator．This is a Schmitt trigger input． |
| RTCC（input） | Real Tıme Clock Counter Used by the microprogram to keep track of elapsed time between events The RTCC regıster increments on falling edges applied to this pin．This register can be loaded and read by the program This is a Schmitt trigger input． |
| RAO－7，RB0－7，RC0－7，RDO－7 （input／output） | User programmable input／output lines These lines can be inputs and／or outputs and are under direct control of the program． |
| $\overline{\text { MCLR（input）}}$ | Master Clear Used to initialize the internal ROM program to address $777_{8}$ and latch all I／O register high Should be held low at least $1-10 \mathrm{~ms}$ past the time when the power supply is valid for the oscillator to start up This is a Schmitt trigger input． |
| CLK OUT（output） | A signal derived from the internal oscillator．Used by external devices to synchronize them－ selves to PIC timing． |
| TEST | Used for testing purposes only．Must be grounded for normal operation |
| $V_{\text {D }}$ | Primary power supply |
| $\mathrm{V}_{\mathrm{xx}}$ | Output Buffer power．Used to enhance output current sinkıng capability． |
| $v_{\text {ss }}$ | Ground |

PIN CONFIGURATION
40 LEAD DUAL IN LINE

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| $\rightarrow \mathrm{Vss}$ | $\bullet 1$ | 40 | $\mathrm{V}_{\mathrm{xx}} \leftarrow$ |
| $\leftrightarrow \mathrm{RAOL}$ | 2 | 39 | $\mathrm{V}_{\text {DD }} \leftarrow$ |
| $\longleftrightarrow$ RA1 $[$ | 3 | 38 | $\overline{\overline{R T C C}} \longleftarrow$ |
| $\longleftrightarrow$ RA2 $\square^{\text {a }}$ | 4 | 37 | $\square \overline{M C L R}$ ¢ |
| $\rightarrow$ TEST | 5 | 36 | gosc $\leftarrow$ |
| $\leftrightarrow$ RA3 $\square$ | 6 | 35 | PCLK OUT $\rightarrow$ |
| $\longleftrightarrow$ RA4 ${ }^{\text {a }}$ | 7 | 34 | －RD7 $\longleftrightarrow$ |
| $\leftrightarrow$ RA5 | 8 | 33 | PRD6 $\longleftrightarrow$ |
| $\longleftrightarrow$ RA6 | 9 | 32 | PRD5 $\longleftrightarrow$ |
| $\leftrightarrow$ RA7 | 10 | 31 | －RD4 $\longleftrightarrow$ |
| $\leftrightarrow \mathrm{RBO}$ | 11 | 30 | PRD3 $\longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RB} 1{ }^{\text {a }}$ | 12 | 29 | PRD2 $\longleftrightarrow$ |
| $\leftrightarrow \mathrm{RB2} \square^{\square}$ | 13 | 28 | PRD1 $\longleftrightarrow$ |
| $\leftrightarrow \mathrm{RB3}$－ | 14 | 27 | 习RD0 $\longleftrightarrow$ |
| $\leftrightarrow$ RB4 | 15 | 26 | PRC7 $\longleftrightarrow$ |
| $\leftrightarrow \mathrm{RB5} \square^{\text {a }}$ | 16 | 25 | 习RC6 $\longleftrightarrow$ |
| $\leftrightarrow \mathrm{RB6}$ | 17 | 24 | 习RC5 $\longleftrightarrow$ |
| $\leftrightarrow$ RB7［ | 18 | 23 | PRC4 $\longleftrightarrow$ |
| $\leftrightarrow \mathrm{RCO}$ | 19 | 22 | －RC3 $\longleftrightarrow$ |
| $\leftrightarrow$ RC1 - | 20 | 21 | PRC2 $\longleftrightarrow$ |



## Basic Instruction Set Summary

Each PIC instruction is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " $f$ " represents a file register designator and "d" represents a destination designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

| PIC1650A | INSTRUNERAL |
| :---: | :---: |

PIC W register. If " $d$ " is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value.
For an oscillator frequency of 1 MHz the instruction execution time is $4 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $8 \mu \mathrm{sec}$.

BYTE-ORIENTED FILE REGISTER OPERATIONS


For $d=0, f \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic)
$d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$.)



## NOTES:

1. The 9th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an I/O register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).

| Instruction-Binary (Octal) |  |  |  |  | Name | Mnemonic, Operands | Equivalent Operation(s) | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 010 | 000 | 000 | 011 | (2003) | Clear Carry | CLRC | BCF 3, 0 | - |
| 010 | 100 | 000 | 011 | (2403) | Set Carry | SETC | BSF 3, 0 | - |
| 010 | 000 | 100 | 011 | (2043) | Clear Digit Carry | CLRDC | BCF 3, 1 | - |
| 010 | 100 | 100 | 011 | (2443) | Set Digit Carry | SETDC | BSF 3, 1 | - |
| 010 | 001 | 000 | 011 | (2103) | Clear Zero | CLRZ | BCF 3, 2 | - |
| 010 | 101 | 000 | 011 | (2503) | Set Zero | SETZ | BSF 3, 2 | - |
| 011 | 100 | 000 | 011 | (3403) | Skip on Carry | SKPC | BTFSS 3, 0 | - |
| 011 | 000 | 000 | 011 | (3003) | Skip on No Carry | SKPNC | BTFSC 3, 0 | - |
| 011 | 100 | 100 | 011 | (3443) | Skip on Digit Carry | SKPDC | BTFSS 3, 1 | - |
| 011 | 000 | 100 | 011 | (3043) | Skip on No Digit Carry | SKPNDC | BTFSC 3, 1 | - |
| 011 | 101 | 000 | 011 | (3503) | Skip on Zero | SKPZ | BTFSS 3, 2 | - |
| 011 | 001 | 000 | 011 | (3103) | Skip on No Zero | SKPNZ | BTFSC 3, 2 | - |
| 001 | 000 | 1 ff | $\mathrm{ff} \mathrm{f}^{\text {f }}$ | (1040) | Test File | TSTF f | MOVF f, 1 | Z |
| 001 | 000 | 0 ff | $f \mathrm{ff}$ | (1000) | Move File to W | MOVFW f | MOVF f, 0 | z |
| $\begin{aligned} & 00 \\ & 00 \end{aligned}$ | $\begin{aligned} & 001 \\ & 010 \end{aligned}$ | $\begin{aligned} & 1 \mathrm{ff} \\ & \mathrm{dff} \end{aligned}$ | $\begin{aligned} & f f f \\ & f f f \end{aligned}$ | $\begin{aligned} & (1140) \\ & (1200) \end{aligned}$ | Negate File | NEGF f,d | $\text { COMF f, } 1$ $\text { INCF } f, d$ | Z |
| 011 |  | 000 | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (1200) \end{aligned}$ | Add Carry to File | ADDCF f, d | $\text { BTFSC } 3,0$ INCF f, d | Z |
| 011 |  | diof | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | (3003) (0300) | Subtract Carry from File | SUBCF fid | $\begin{aligned} & \text { BTFSC } 3,0 \\ & \text { DECF } f, d \end{aligned}$ | Z |
| 011 |  | $\begin{aligned} & 100 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & \text { (3043) } \\ & (1200) \end{aligned}$ | Add Digit Carry to File | ADDDCF f, d | BTFSG 3,1 <br> INCF f,d | z |
| 011 |  |  | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3043) \\ & (0300) \end{aligned}$ | Subtract Digit Carry from File | SUBDCF f,d | BTFSC 3,1 DECF f,d | Z |
| 10 | kkk | kkk | kkk | (5000) | Branch | B k | GOTO k | - |
| 011 101 |  | 000 | 011 $k k k$ | $\begin{aligned} & \text { (3003) } \\ & (5000) \end{aligned}$ | Branch on Carry | BC k | BTFSC 3,0 GOTO $k$ | - |
| 011 10 | 100 $k k k$ | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | (3403) (5000) | Branch on No Carry | BNC k | BTFSS 3,0 GOTO k | - |
| 01 10 | 100 $k k k$ | 100 $k k k$ | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3043) \\ & (5000) \end{aligned}$ | Branch on Digit Carry | BDC k | $\text { BTFSC } 3,1$ GOTO k | - |
| 01 10 | 001 | 000 | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & (3443) \\ & (5000) \end{aligned}$ | Branch on No Digit Carry | BNDC k | BTFSS 3,1 GOTO $k$ | - |
| 01 10 | 101 $k k k$ | 000 | 011 $k k k$ | $\begin{aligned} & (3103) \\ & (5000) \end{aligned}$ | Branch on Zero | BZ $k$ | $\begin{aligned} & \text { BTFSC } 3,2 \\ & \text { GOTO k } \end{aligned}$ | - |
| 01 10 | 101 $k k k$ | 000 $k k k$ | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & (3503) \\ & (5000) \end{aligned}$ | Branch on No Zero | BNZ k | $\begin{aligned} & \text { BTFSS 3,2 } \\ & \text { GOTO k } \end{aligned}$ | - |

## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of an open collector TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a PIC I/O Port, the data is latched at the port and the pin
can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port latch must first be set to a high level under program control. This turns off $Q_{2}$, allowing the TTL open collector device to drive the pad, pulled up by $\mathbf{Q}_{1}$, which can source a minimum of $100 \mu \mathrm{~A}$. Care, however, should be exercised when using open collector devices due to the potentially high TTL leakage current which can exist in the high logic state.


## Programming Cautions

The use of the bidirectional I/O ports are subject to certain rules of operation. These rules must be carefully followed in the instruction sequences written for I/O operation.

## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten. For use as an input port the output latch must be set in the high state. Thus the external device inputs to the PIC circuit by forcing the latched output line to the low state or keeping the latched output high. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result. Caution must be used when using these instructions.

As an example a BSF operation on bit 5 of $F 7$ (port RC) will cause all eight bits of F7 to be read into the CPU. Then the BSF operation takes place on bit 5 and F7 is re-output to the output latches. If another bit of $\mathrm{F7}$ is used as an input (say bit 0 ) then bit 0 must be latched high. If during the BSF instruction on bit 5 an external device is forcing bit 0 to the low state then the input/output nature of the BSF instruction will leave bit 0 latched low after execution. In this state bit 0 cannot be used as an input until it is again latched high by the programmer. Refer to the examples below.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $t_{p d}$ (See I/O Timing Diagram) is greater than $1 / 4 \mathrm{t}_{\mathrm{cy}}(\mathrm{min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

## EXAMPLE 1:



What is thought to be happening:
BSF 7,5

| Read into CPU: | 00001111 |
| :--- | :--- |
| Set bit 5: | 00101111 |
| Write to F7: | 00101111 |

If no inpúts were low during the instruction execution, there would be no problem.

## EXAMPLE 2:



What could happen if an input were low: BSF 7,5

| Read into CPU: | 00001110 |
| :--- | :--- |
| Set bit 5: | 00101110 |
| Write to F7: | 00101110 |

In this case bit 0 is now latched low and is no longer useful as an input until set high again.

PIC1650A

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . . . . .$.
Power Dissipation
1000 mW
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS/PIC1650A
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ ${ }^{\text { }}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Output Buffer Supply Voltage | $V_{x x}$ | 4.5 | - | 10.0 | V | (Note 2) |
| Primary Supply Current | $I_{D D}$ | - | 30 | 55 | mA | All I/O pins @ $V_{\text {DD }}$ |
| Output Buffer Supply Current | Ixx | - | 1 | 5 | mA | All l/O pins @ V ${ }_{\text {DD }}$ (Note 3) |
| Input Low Voltage | $\mathrm{V}_{\mathrm{IL}}$ | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except MCLR, RTCC \& OSC) | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input Low-to-High Threshold Voltage (MCLR, $\overline{R T C C} \& ~ O S C)$ | $\mathrm{V}_{\text {ILH }}$ | $V_{D D}-1$ | 2.6 | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 2.4 \\ & 3.5 \end{aligned}$ | - | $\begin{aligned} & V_{D D} \\ & V_{D D} \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & I_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 4) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (1/O only) | $\mathrm{V}_{\text {OLI }}$ | - | - - - | $\begin{gathered} \hline 0.45 \\ 0.90 \\ 0.90 \\ 1.20 \\ 2.0 \end{gathered}$ | $\begin{aligned} & \hline \mathrm{V} \\ & \mathrm{v} \\ & \mathrm{~V} \\ & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=10.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{Xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=20.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \text { (Note } 5 \text { ) } \end{aligned}$ |
| Output Low Voltage (CLK OUT) | $\mathrm{V}_{\mathrm{OL} 2}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (Note 5) |
| Input Leakage Current ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RTCC}}$ ) | ILC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\mathrm{DD}}$ |
| Output Leakage Current (open drain I/O pins) | Iolc | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {PIN }} \leqslant 10 \mathrm{~V}$ |
| Input Low Current (all I/O ports) | $I_{1 L}$ | -0.2 | -0.6 | -1.6 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathbf{H}}$ | -0.1 | -0.4 | -1.4 | mA | $\mathrm{V}_{1 \mathrm{H}}=2.4 \mathrm{~V}$ |

†Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows:
$P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{I L}\right)\left(\left|I_{I L}\right|\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(\left|I_{O H}\right|\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$.
The term I/O refers to all interface pins; input, output or I/O.
2. $V_{x x}$ supply drives only the I/O ports.
3. The maximum $\mathrm{I}_{\mathrm{xx}}$ current will be drawn when all I/O ports are outputting a High.
4. Positive current indicates current into pin. Negative current indicates current out of pin.
5. Total $\mathrm{I}_{\mathrm{OL}}$ for all output pins (I/O ports plus CLK OUT) must not exceed 225 mA .

## DC CHARACTERISTICS/PIC1650AI

Operating Temperature $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Output Buffer Supply Voltage | $\mathrm{V}_{\mathrm{xx}}$ | 4.5 | - | 10.0 | V | (Note 2) |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | 30 | 60 | mA | All I/O pins @ $\mathrm{V}_{\mathrm{DD}}$ |
| Output Buffer Supply Current | $\mathrm{I}_{\mathrm{xx}}$ | - | 1 | 5 | mA | All I/O pins @ $\mathrm{V}_{\mathrm{DD}}$ (Note 3) |
| Input Low Voltage | $\mathrm{V}_{\mathrm{IL}}$ | -0.2 | - | 0.7 | V |  |
| Input High Voltage (except $\overline{M C L R}, \overline{R T C C}$ \& OSC) | $\mathrm{V}_{1+}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input Low-to-High Threshold Voltage ( $\overline{M C L R}, \overline{R T C C} \& O S C^{\prime}$ ) | $\mathrm{V}_{\text {ILH }}$ | $V_{D D}{ }^{-1}$ | 2.6 | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $V_{D D}$ | V | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 4) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (1/O only) | $\mathrm{V}_{\text {OL1 }}$ | - | - | $\begin{aligned} & 0.45 \\ & 0.90 \\ & 0.90 \\ & 1.20 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \mathrm{v} \\ & \mathrm{v} \\ & \mathrm{v} \\ & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & l_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & I_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & I_{\mathrm{OL}}=10.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & I_{\mathrm{OL}}=20.0 \mathrm{~mA}, \mathrm{v}_{\mathrm{xx}}=8.0 \mathrm{~V} \text { (Note } 5 \text { ) } \end{aligned}$ |
| Output Low Voltage (CLK OUT) | $\mathrm{V}_{\text {OL2 }}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (Note 5) |
| Input Leakage Current ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RTCC}}$ ) | ILC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\mathrm{DD}}$ |
| Output Leakage Current (open drain I/O pins) | Iolc | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {PIN }} \leqslant 10 \mathrm{~V}$ |
| Input Low Current (all I/O ports) | $I_{\text {IL }}$ | -0.2 | -0.6 | -1.8 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{H}}$ | -0.1 | -0.4 | -1.8 | mA | $\mathrm{V}_{1 \mathrm{H}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows: $P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{I L}\right)\left(\left|I_{I L}\right|\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(\left|I_{O H}\right|\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$. The term I/O refers to all interface pins; input, output or I/O.
2. $V_{x x}$ supply drives only the I/O ports.
3. The maximum $\mathrm{I}_{\mathrm{xx}}$ current will be drawn when all $\mathrm{I} / \mathrm{O}$ ports are outputting a High.
4. Positive current indicates current into pin. Negative current indicates current out of pin.
5. Total $\mathrm{I}_{\mathrm{OL}}$ for all output pins (I/O ports plus CLK OUTT) must not exceed 225 mA .

Standard Conditions (unless otherwise stated):

## AC CHARACTERISTICS/PIC1650A, PIC1650AI

Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ (PIC1650A), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (PIC1650AI)

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | $t_{C Y}$ | 4 | - | 20 | $\mu \mathrm{S}$ | $0.2 \mathrm{MHz}-1.0 \mathrm{MHz}$ external time base (Note 1) |
| $\overline{\text { RTCC Input }}$ <br> Period <br> High Pulse Width <br> Low Pulse Width | $\begin{gathered} t_{\text {RT }} \\ t_{\text {RTH }} \\ t_{\text {RTL }} \end{gathered}$ | $\left\|\begin{array}{c} t_{C Y}+0.2 \mu \mathrm{~s} \\ 1 / 2 t_{R T} \\ 1 / 2 t_{R T} \end{array}\right\|$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ |  |  | (Notes 2 and 3) |
| I/O Ports <br> Data Input Setup Time <br> Data Input Hold Time <br> Data Output Propagation Delay | $\begin{aligned} & t_{\mathrm{s}} \\ & t_{\mathrm{h}} \\ & \mathrm{t}_{\mathrm{pd}} \end{aligned}$ | $\begin{aligned} & - \\ & 0 \end{aligned}$ | $600$ | $\begin{gathered} 1 / 4 \mathrm{t}_{\mathrm{Cr}}-125 \\ - \\ 1000 \end{gathered}$ | ns ns ns | Capacitive load $=50 \mathrm{pF}$ |
| OSC Input <br> External Input Impedance High <br> External Input Impedance Low | $\mathrm{R}_{\mathrm{OSCH}}$ <br> $R_{\text {OSCL }}$ | 120 - | $\begin{aligned} & 800 \\ & 10^{6} \end{aligned}$ | 3500 - | $\begin{aligned} & \Omega \\ & \Omega \end{aligned}$ | $\left.\begin{array}{l} v_{\text {OSC }}=5 \mathrm{~V} \\ \mathrm{v}_{\text {OSC }}=0.4 \mathrm{~V} \end{array}\right\} \text { Applies to external }$ |

## $\dagger$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.

NOTES:

1. Instruction cycle period $\left(\mathrm{t}_{\mathrm{cy}}\right)$ equals four times the input oscillator time base period.

2 Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the RTCC input, CLK OUT may be directly tied to the RTCC input.
3. The maximum frequency which may be input to the $\overline{R T C C}$ pin is calculated as follows: $f_{(\text {max })}=\frac{1}{t_{R T(\text { min })}}=\frac{1}{t_{\mathrm{CY}(\text { min })}+0.2 \mu \mathrm{~s}}$ For example: if $\mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.


I/O TIMING

CLK OUT

INPUT
INCREMENT $\xrightarrow[\text { ADDRESS ROM }]{\longrightarrow}$
FOR NEXT INSTRUCTION


SCHMITT TRIGGER CHARACTERISTICS ( $\overline{\text { RTCC }}, \overline{M C L R}$ and OSC PINS) $\mathbf{T}_{A}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ (TYPICAL)


NOTES:

1. Low-to-High Threshold Voltage $\left(\mathrm{V}_{\text {TLH }}\right)$.
2. High-to-Low Threshold Voltage $\left(V_{T H L}\right)$.

PIC1650A OSCILLATOR OPTIONS (TYPICAL CIRCUITS)
RC OPTION OPERATION


BUFFERED CRYSTAL INPUT OPERATION


The buffer must be capable of driving $120 \Omega, \min$. ( $800 \Omega$, typ.) to 2.0 V . However, it is recommended that the pull-down transistor on the OSC pin be removed (an option) if OSC is to be driven externally.

EXTERNAL CLOCK INPUT OPERATION


MASTER CLEAR (TYPICAL CIRCUIT)


Master Clear requires $>10 \mathrm{~ms}$ delay before activation after power is applied to the $V_{D D}$ pin, for the oscillator to start up. To achieve this, an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function).

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the $V_{x x}$ supply and the output load. This chart shows the typical curves used to express the output drive capability.
$\mathrm{V}_{\mathrm{OH}}$ VS $\mathrm{IOH}_{\mathrm{OH}}$ (I/O PORTS) (TYPICAL)


POWER SUPPLY CURRENT VS TEMPERATURE (TYPICAL LIMITS)


## POWER DISSIPATION DERATING GRAPH



NOTES:

1. $70^{\circ} \mathrm{C}$ is the maximum operating temperature for standard parts.
2. $85^{\circ} \mathrm{C}$ is the maximum operating temperature for " I " suffix parts.

## PIC1650A EMULATION CAUTIONS

When emulating a PIC1650A using a PICES II development system certain precautions should be taken.
A. Be sure that the PICES II Module being used is programmed for the PIC1650A mode. (Refer to PICES II Manual). The PIC1664B contained within the module should have the MODE pin \#22 set to a high state.

1. This causes the $\overline{M C L R}$ to force all I/O registers high.
2. The OSC1 pin \#59 becomes a single clock input pin.
3. The interrupt system becomes disabled and the RTCC always counts on the trailing edges.
4. Bits 3 through 7 on file register F3 are all ones.
B. Make sure to only use two levels of stack within the program.
C. Make sure all I/O cautions contained in this spec sheet are used.
D. Be sure to use the 40 pin socket for the module plug.
E. Make sure that during an actual application the $\overline{M C L R}$ input swings from a low to high level a minimum of 1 msec after the supply voltage is applied to allow the oscillator to start up.
F. If an external oscillator drive is used, be sure that it can drive the $120 \Omega$ input impedance of the OSC pin on the PIC1664.
G. The cable length and internal variations may cause some parameter values to differ between the PICES II module and a production PIC1650A.

## PIC1650XT

## 8 Bit Microcomputer

## FEATURES

- User programmable
- Intelligent controller for stand-alone applications
- 32 8-bit RAM registers
- $512 \times 12$-bit program ROM
- Arithmetıc Logic Unit
- Real Time Clock/Counter
- Self-contained crystal oscillator
- Access to RAM registers inherent in instruction
- Wide power supply operating range ( 45 V to 70 V )
- Avalable in two temperature ranges $0^{\circ}$ to $70^{\circ} \mathrm{C}$ and $-40^{\circ}$ to $85^{\circ} \mathrm{C}$
- 4 sets of 8 user defined TTL-compatible Input/Output lines
- 2 level stack for subroutine nestıng


## DESCRIPTION

The PIC1650XT microcomputer is an MOS/LSI device containıng RAM, I/O, and a central processing unit as well as customerdefined ROM on a single chip This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs Keyboard scanning, display driving, and other system control functions can be done at the same time due to the power of the 8-bit CPU.
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device The 8 -bit input/output registers provide latched lines for interfacing to a limitless variety of applications The PIC can be used to scan keyboards, drive displays, control electronic games and provide enhanced capabilities to vending machines, traffic lights, radios, television, consumer appliances, industrial timing and control applications The 12-bit instruction word format provides a powerful yet easy to use
instruction repertoire emphasızing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC1650XT is fabricated with N -Channel Ion Implant technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operatıng clock with an external crystal, ceramic resonator or LC network to establish the frequency. Inputs and outputs are TTL-compatible.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committıng to mask tooling. Programs can be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems Once the application program is developed several options are available to insure proper performance. The PIC's operation can be verified in any hardware application by using the PIC1664 The PIC1664 is a ROM-less PIC microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands The PFD1000 Field Demo System is available containing a PIC1664 with sockets for erasable CMOS PROMs Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system Easy program debugging and changing is facilitated because the user's program is stored in RAM With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market
A PIC Series Microcomputer Data Manual is avallable which gives additional detailed data on PIC based system design


| PIC1650XT | INSTRUNERAL |
| :---: | :---: |

## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC series microcomputer is based on a register file concept with simple yet powerful commands designed to emphasize bit, byte, and register transfer operations The instruction set also supports computing functions as well as these control and interface functions
Internally, the PIC is composed cf three functional elements connected together by a single bidirectional bus the Register File composed of 32 addressable 8-bit regısters, an Arıthmetıc Logic Unit, and a user-defined Program ROM composed of 512 words each 12 bits in width. The Register File is divided into two functional groups. operational registers and general registers The operational registers include, among others, the Real Tıme Clock Counter Register, the Program Counter (PC), the Status Regıster,
and the I/O Registers The general purpose registers are used for data and control information under command of the instructions The Arithmetic Logic Unit contaıns one temporary workıng regıster or accumulator (W Register) and gating to perform Boolean functions between data held in the working register and any file register
The Program ROM contains the operational program for the rest of the logic within the controller Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs Program control operations can be performed by Bit Test and Skip instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC In addition, an on-chip two-level stack is employed to provide easy to use subroutine nestıng Activatıng the $\overline{M C L R}$ input on power up initializes the ROM program to address $777_{8}$

## PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| OSC1 (input), OSC2 (output) | Oscillator pins. The oscillator frequency can be set by a crystal ceramic resonator, external LC network or driven externally. The oscillator frequency is sixteen times the instruction frequency |
| RTCC (input) | Real Time Clock Counter Used by the microprogram to keep track of elapsed tıme between events The RTCC regıster increments on falling edges applied to this pin This register can be loaded and read by the program This is a Schmitt trigger input |
| RA0-7, RB0-7, RC0-7, RD0-7 (input/output) | User programmable input/output lines These lines can be inputs and/or outputs and are under direct control of the program |
| $\overline{\text { MCLR }}$ (input) | Master Clear Used to initialize the internal ROM program to address $777_{8}$ and latch all I/O register high Should be held low at least $1-10 \mathrm{~ms}$ past the tıme when the power supply is valid for the oscillator to start up. This is a Schmitt trigger input |
| CLK OUT (output) | A signal derived from the internal oscillator Used by external devices to synchronize themselves to PIC tıming |
| $V_{\text {D }}$ | Primary power supply |
| $\mathrm{V}_{\mathrm{xx}}$ | Output Buffer power Used to enhance output current sinkıng capability. |
| $v_{\text {ss }}$ | Ground |


| INSTRUERENT | PIC1650XT |
| :---: | :---: |

## REGISTER FILE ARRANGEMENT



The PIC1650XT has the same basic architecture as the PIC1650A with the additional enhancement described below:

## Self-Contained Oscillator

When a crystal, ceramic resonator or LC network is connected between the OSC1 and OSC2 pins, the self-contained oscillator will generate a frequency determined by the external components thus allowing an accurate timing reference, a crystal, to be used for time base control with a minimum of external parts.

The output of this oscillator is divided down by 16 to give the instruction cycle time of the microcomputer, thus with a 4 MHz crystal the instruction cycle time is $4 \mu \mathrm{~s}$.
When test mode is enabled, the basic instruction cycle tıme is a division of 4 of the frequency applied to OSC1 and OSC2 allowing simpler synchronizing of the device and tester.

## Basic Instruction Set Summary

Each PIC instruction is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " $f$ " represents a file register designator and "d" represents a destination designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

PIC W register. If "d" is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, " $b$ " represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value.
For an oscillator frequency of 4 MHz the instruction execution time is $4 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $8 \mu \mathrm{sec}$

## BYTE-ORIENTED FILE REGISTER OPERATIONS

(11-6)

| OP CODE | (5) | (4-0) |
| :---: | :---: | :---: | | (FILE \#) |
| :---: |

For $d=0, f \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic)
$d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$.
$d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$.)

| Instruction-Binary (Octal) |  |  |  |  | $\qquad$ <br> No Operation | Mnemonic, Operands |  | Operation S | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 000 | 000 | 000 | 000 | (0000) |  | NOP | - | - | None |
| 000 | 000 | 1 ff | fff | (0040) | Move W to f (Note 1) | MOVWF | f | W $\rightarrow$ f | None |
| 000 | 001 | 000 | 000 | (0100) | Clear W | CLRW | - | $0 \rightarrow W$ | Z |
| 000 | 001 | 1 ff | $\mathrm{ff}^{\text {f }}$ | (0140) | Clear f | CLRF | f | $0 \rightarrow f$ | Z |
| 000 | 010 | dff | $f \mathrm{ff}$ | (0200) | Subtract W from ${ }^{\text {f }}$ | SUBWF | f, d | $f-W \rightarrow d[f+\bar{W}+1 \rightarrow d]$ | C,DC,z |
| 000 | 011 | dff | $f \mathrm{ff}$ | (0300) | Decrement $f$ | DECF | $f, \mathrm{~d}$ | $f-1 \rightarrow d$ | z |
| 000 | 100 | dff | fif | (0400) | Inclusive OR W and $\dagger$ | IORWF | $f, \mathrm{~d}$ | WVf-d | Z |
| 000 | 101 | dff | fff | (0500) | AND W and f | ANDWF | $f, \mathrm{~d}$ | W-ftod | Z |
| 000 | 110 | dff | fff | (0600) | Exclusive OR W and $\mathfrak{f}$ | XORWF | $f, \mathrm{~d}$ | W@f-d | Z |
| 000 | 111 | dff | $\mathrm{ff}^{\mathrm{f}}$ | (0700) | Add W and f | ADDWF | $f, \mathrm{~d}$ | $w+i \rightarrow d$ | C,DC,z |
| 001 | 000 | dff | $f \mathrm{ff}$ | (1000) | Move f | MOVF | $f, \mathrm{~d}$ | $\xrightarrow{\rightarrow-\mathrm{d}}$ | Z |
| 001 | 001 | dff | $f f f$ | (1100) | Complement f | COMF | $f, \mathrm{~d}$ | $\bar{f} \rightarrow \mathrm{~d}$ | Z |
| 001 | 010 | dff | $f \mathrm{ff}$ | (1200) | Increment f | INCF | f, d | $\mathrm{f}+1-\mathrm{d}$ | Z |
| 001 | 011 | dff | fff | (1300) | Decrement f, Skıp if Zero | DECFSZ | $f, \mathrm{~d}$ | $\mathrm{f}-1 \rightarrow \mathrm{~d}$, skip if Zero | None |
| 001 | 100 | dff | fff | (1400) | Rotate Right f | RRF | $f, \mathrm{~d}$ | $f(\mathrm{n}) \rightarrow \mathrm{d}(\mathrm{n}-1), f(0) \rightarrow C, C \rightarrow d(7)$ | C |
| 001 | 101 | dff | fff | (1500) | Rotate Left f | RLF | f, d | $f(\mathrm{n}) \rightarrow \mathrm{d}(\mathrm{n}+1), f(7) \rightarrow C, C \rightarrow d(0)$ | ) C |
| 001 | 110 | dff | $f \mathrm{ff}$ | (1600) | Swap halves f | SWAPF | $f, \mathrm{~d}$ | $f(0-3) \leftrightharpoons f(4-7) \rightarrow d$ | None |
| 001 | 111 | dff | $f f f$ | (1700) | Increment f, Skıp if Zero | INCFSZ | $f, \mathrm{~d}$ | $\mathrm{f}+1 \rightarrow \mathrm{~d}$, skip if zero | None |



## NOTES:

1. The 9th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an I/O register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.
3. See notes on input only and output only ports.

PIC1650XT

## SUPPLEMENTAL INSTRUCTION SET SUMMARY

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).

| Instruction-Binary (Octal) |  |  |  |  | Name | Mnemonic, Operands | Equivalent Operation(s) | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 010 | 000 | 000 | 011 | (2003) | Clear Carry | CLRC | BCF 3, 0 | - |
| 010 | 100 | 000 | 011 | (2403) | Set Carry | SETC | BSF 3, 0 | - |
| 010 | 000 | 100 | 011 | (2043) | Clear Digit Carry | CLRDC | BCF 3, 1 | - |
| 010 | 100 | 100 | 011 | (2443) | Set Digit Carry | SETDC | BSF 3, 1 | - |
| 010 | 001 | 000 | 011 | (2103) | Clear Zero | CLRZ | BCF 3, 2 | - |
| 010 | 101 | 000 | 011 | (2503) | Set Zero | SETZ | BSF 3, 2 | - |
| 011 | 100 | 000 | 011 | (3403) | Skip on Carry | SKPC | BTFSS 3, 0 | - |
| 011 | 000 | 000 | 011 | (3003) | Skip on No Carry | SKPNC | BTFSC 3, 0 | - |
| 011 | 100 | 100 | 011 | (3443) | Skip on Digit Carry | SKPDC | BTFSS 3, 1 | - |
| 011 | 000 | 100 | 011 | (3043) | Skip on No Digit Carry | SKPNDC | BTFSC 3, 1 | - |
| 011 | 101 | 000 | 011 | (3503) | Skip on Zero | SKPZ | BTFSS 3, 2 | - |
| 011 | 001 | 000 | 011 | (3103) | Skip on No Zero | SKPNZ | BTFSC 3, 2 | - |
| 001 | 000 | 1 ff | fff | (1040) | Test File | TSTF f | MOVF f, 1 | z |
| 001 | 000 | 0 ff | $f f f$ | (1000) | Move File to W | MOVFW f | MOVF f, 0 | Z |
| 001 |  | $\begin{aligned} & 1 \mathrm{ff} \\ & d \mathrm{ff} \end{aligned}$ | $\begin{aligned} & f f \\ & f f \end{aligned}$ | $\begin{aligned} & (1140) \\ & (1200) \end{aligned}$ | Negate File | NEGF f,d | COMF f, 1 <br> INCF f, d | Z |
| $\begin{aligned} & 011 \\ & 001 \end{aligned}$ |  | $\begin{aligned} & 000 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (1200) \end{aligned}$ | Add Carry to File | ADDCF f, d | BTFSC 3,0 <br> INCF f, d | Z |
|  |  | $\begin{aligned} & 000 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (0300) \end{aligned}$ | Subtract Carry from File | SUBCF f,d | BTFSC 3,0 DECF f,d | z |
| 011 001 |  | $\begin{aligned} & 100 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & (3043) \\ & (1200) \end{aligned}$ | Add Digit Carry to File | ADDDCF f,d | BTFSG 3,1 <br> INCF f,d | Z |
| $\begin{aligned} & 011 \\ & 000 \end{aligned}$ |  | $\begin{aligned} & 100 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3043) \\ & (0300) \end{aligned}$ | Subtract Digit Carry from File | SUBDCF f,d | BTFSC 3,1 DECF f, d | Z |
| 101 | kkk | kkk | kkk | (5000) | Branch | B k | GOTO k | - |
| 011 101 |  |  | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & (3003) \\ & (5000) \end{aligned}$ | Branch on Carry | BC $k$ | $\begin{aligned} & \text { BTFSC 3,0 } \\ & \text { GOTO k } \end{aligned}$ | - |
| 011 101 | 100 $k k k$ | 000 | 011 $k k k$ | $\begin{aligned} & (3403) \\ & (5000) \end{aligned}$ | Branch on No Carry | BNC k | BTFSS 3,0 GOTO k | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 100 | 100 | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | (3043) (5000) | Branch on Digit Carry | BDC k | BTFSC 3,1 GOTO k | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 001 | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | (3443) (5000) | Branch on No Digit Carry | BNDC k | BTFSS 3,1 GOTO $k$ | - |
| 011 101 | 101 | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3103) \\ & (5000) \end{aligned}$ | Branch on Zero | BZ k | BTFSC 3,2 GOTO k | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | $\begin{aligned} & 101 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & 000 \\ & k k k \end{aligned}$ | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3503) \\ & (5000) \end{aligned}$ | Branch on No Zero | BNZ $k$ | BTFSS 3,2 GOTO k | - |


| PIC1650XT | INSTRUMERAL |
| :---: | :---: |

## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of an open collector TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a PIC I/O Port, the data is latched at the port and the pin
can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port latch must first be set to a high level under program control. This turns off $Q_{2}$, allowing the TTL open collector device to drive the pad, pulled up by $Q_{1}$, which can source a minimum of $100 \mu \mathrm{~A}$. Care, however, should be exercised when using open collector devices due to the potentially high TTL leakage current which can exist in the high logic state.

## TYPICAL INTERFACE-BIDIRECTIONAL I/O LINE



## Programming Cautions

The use of the bidirectional I/O ports are subject to certain rules of operation. These rules must be carefully followed in the instruction sequences written for I/O operation.

## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten. For use as an input port the output latch must be set in the high state. Thus the external device inputs to the PIC circuit by forcing the latched output line to the low state or keeping the latched output high. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result. Caution must be used when using these instructions.

As an example a BSF operation on bit 5 of $F 7$ (port RC) will cause all eight bits of F7 to be read into the CPU. Then the BSF operation takes place on bit 5 and F7 is re-output to the output latches. If another bit of F7 is used as an input (say bit 0 ) then bit 0 must be latched high. If during the BSF instruction on bit 5 an external device is forcing bit 0 to the low state then the input/output nature of the BSF instruction will leave bit 0 latched low after execution. In this state bit 0 cannot be used as an input until it is again latched high by the programmer. Refer to the examples below.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $t_{\text {pd }}$ (See I/O Timing Diagram) is greater than $1 / 4 t_{c y}(\mathrm{~min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

EXAMPLE 1:


What is thought to be happening:
BSF 7,5

$$
\begin{array}{ll}
\text { Read into CPU: } & 00001111 \\
\text { Set bit 5: } & 00101111 \\
\text { Write to F7: } & 00101111
\end{array}
$$

If no inputs were low during the instruction execution, there would be no problem.

EXAMPLE 2:


What could happen if an input were low:
BSF 7,5

| Read into CPU: | 00001110 |
| :--- | :--- |
| Set bit 5: | 00101110 |
| Write to F7: | 00101110 |

In this case bit 0 is now latched low and is no longer useful as an input until set high again.

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient Temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{SS}}$
(except Open Drain) . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +10.0 V
Power Dissipation (Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . 800mW
Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{ss}}$ (Open Drain) $\ldots . .-0.3$ to +10 V
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | - | 55 | mA | All I/O pins @ $\mathrm{V}_{\text {DD }}$ |
| Input Low Voltage | $\mathrm{V}_{1}$ | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except $\overline{M C L R}, \overline{R T C C}$ \& OSC1) | $\mathrm{V}_{1+1}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input High Voltage (OSC1) | $\mathrm{V}_{\mathrm{HH} 2}$ | $\mathrm{V}_{\mathrm{DD}}-1$ | - | $V_{D D}$ | V |  |
| Input Low-to-High Threshold Voltage (MCLR \& RTCC) | $\mathrm{V}_{\text {ILH }}$ | $V_{D D}{ }^{-1}$ | 2.6 | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 2.4 \\ & 3.5 \end{aligned}$ | - | $\begin{aligned} & V_{D D} \\ & V_{D D} \end{aligned}$ | $\begin{aligned} & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 2) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voitage (I/O only) | $\mathrm{V}_{\text {OL1 }}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$, (Note 3) |
| Input Leakage Current (MCLR, $\overline{\text { RTCC }}$ ) | ILC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\text {DD }}$ |
| Input Low Current (all I/O ports) | $1 / 1$ | -0.2 | - | -2.0 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ (internal pullup) |
| Input High Current (all I/O ports) | $\mathrm{I}_{\text {IK }}$ | -0.1 | -0.4 | -1.6 | mA | $\mathrm{V}_{\text {IH }}=2.4 \mathrm{~V}$ |
| Output Leakage Current (open drain I/O pins) | Iolc | - | - | 10 | $\mu \mathrm{A}$ | $0 \mathrm{~V} \leqslant \mathrm{~V}_{\text {PIN }} \leqslant 10 \mathrm{~V}$ |

$\dagger$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows:

$$
P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{L L}\right)\left(I_{I L}\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H}\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right) .
$$

2. Positive current indicates current into pin. Negative current indicates current out of pin.
3. Total $\mathrm{I}_{\mathrm{OL}}$ for all output pins must not exceed 175 mA .

| PIC1650XT | INSTRUMERAL |
| :---: | :---: |

Standard Conditions (unless otherwise stated):
AC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ $\dagger$ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | $\mathrm{t}_{\mathrm{CY}}$ | 4 | - | 20 | $\mu \mathrm{~s}$ | $0.2 \mathrm{MHz}-1.0 \mathrm{MHz}$ external time base <br> (Note 1) |
| $\overline{\text { RTCC Input }}$ |  |  |  |  |  |  |
| Period | $\mathrm{t}_{\mathrm{RT}}$ | $\mathrm{t}_{\mathrm{Cr}}+0.2 \mu \mathrm{~s}$ | - | - | - |  |
| High Pulse Width | $\mathrm{t}_{\mathrm{RTH}}$ | $1 / 2 \mathrm{t}_{\mathrm{RT}}$ | - | - | - |  |
| Low Pulse Width | $\mathrm{t}_{\mathrm{RTL}}$ | $1 / 2 \mathrm{t}_{\mathrm{RT}}$ | - | - | - | (Notes 2 and 4) |
| I/O Ports |  |  |  |  |  |  |
| Data Input Setup Time | $\mathrm{t}_{\mathrm{S}}$ | - | - | $1 / 4 \mathrm{t}_{\mathrm{Cr}}-125$ | ns |  |
| Data Input Hold Time | $\mathrm{t}_{\mathrm{h}}$ | 0 | - | - | ns |  |
| Data Output Propagation Delay | $\mathrm{t}_{\mathrm{pd}}$ | - | 500 | 900 | ns | Capacitive load $=50 \mathrm{pF}$ |

$\dagger$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Instruction cycle period $\left(\mathrm{t}_{\mathrm{cy}}\right)$ equals four times the input oscillator time base period.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the $\overline{\operatorname{RTCC}}$ input, CLK OUT may be directly tied to the RTCC input.
3 If an RTCC prescaler division ratio of $2,4,8$ or 16 is selected, the maximum rise and fall times of the signal input to the RTCC pin is 200 nsecs and its duty cycle must be between $40 \%$ and $60 \%$.
3. The maximum frequency which may be input to the $\overline{\mathrm{RTCC}}$ pin is calculated as follows:
$f_{(\text {max })}=\frac{1}{t_{R T} \text { (min) }}=\frac{1}{\mathrm{t}_{\mathrm{CY}(\text { min })}+0.2 \mu \mathrm{~S}}$
For example:

$$
\text { if } \mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}
$$

| INSTRUERENT | PIC1650XT |
| ---: | :---: |

## I/O TIMING



## CLK OUT TIMING



## $\overline{\text { RTCC TIMING }}$



SCHMITT TRIGGER CHARACTERISTICS ( $\overline{\text { RTCC }}, \overline{\text { MCLR }}$ and OSC PINS) $T_{A}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ (TYPICAL)


NOTES:

1. Low-to-High Threshold Voltage ( $\mathrm{V}_{\text {TLH }}$ ).
2. High-to-Low Threshold Voltage ( $\mathrm{V}_{\text {THL }}$ ).

## PIC1650XT OSCILLATOR OPTIONS (TYPICAL CIRCUITS)

## LC INPUT OPERATION



$$
\begin{gathered}
f_{\text {OsC }} \approx \frac{1}{2 \pi \sqrt{L\left(C_{L}+C_{I N T}\right)}}, \\
\text { where } C_{I N T}=10 \mathrm{pF} . \\
\text { Typical values for } 4 \mathrm{MHz} \text { operation: } \\
\qquad \begin{array}{c}
L=70 \mu H \\
C_{L}=10 \mathrm{pF}
\end{array}
\end{gathered}
$$

CRYSTAL INPUT OPERATION


* or ceramic resonator

EXTERNAL CLOCK INPUT OPERATION


## MASTER CLEAR (TYPICAL CIRCUIT)



Master Clear requires 10 ms delay (assuming a 4 MHz crystal) before activation after power is applied to the $\mathrm{V}_{D D}$ pin, for the crystal to start up. To achieve this, an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function).

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the $\mathrm{V}_{\mathrm{xx}}$ supply and the output load. This chart shows the typical curves used to express the output drive capability.
$\mathrm{V}_{\mathrm{OH}}$ VS $\mathrm{I}_{\mathrm{OH}}$ (I/O PORTS) (TYPICAL)


POWER SUPPLY CURRENT VS TEMPERATURE (TYPICAL LIMITS)


POWER DISSIPATION DERATING GRAPH


NOTES:
$1.70^{\circ} \mathrm{C}$ is the maximum operating temperature for standard parts.
2. $85^{\circ} \mathrm{C}$ is the maximum operating temperature for "I" suffix parts.

## PIC1650XT EMULATION CAUTIONS

When emulating a PIC1650XT using a PICES II development system certain precautions should be taken.
A. Be sure that the PICES II Module being used is programmed for the PIC1650XT mode. (Refer to PICES II Manual). The PIC1664 contained within the module should have the MODE pin \#22 set to a high state.

1. This causes the $\overline{M C L R}$ to force all I/O registers high.
2. The interrupt system becomes disabled and the RTCC always counts on the trailing edges.
3. Bits 3 through 7 on file register F3 are all ones.
B. Make sure to only use two levels of stack within the program.
C. Make sure all I/O cautions contained in this spec sheet are used.
D. Be sure to use the 40 pin socket for the module plug.
E. Make sure that during an actual application the $\overline{M C L R}$ input swings from a low to high level a minimum of 10 msec after the supply voltage is applied to allow for the crystal to start up.
F. The cable length and internal variations may cause some parameter values to differ between the PICES II module and a production PIC1650XT.
G. The emulator PFD board or PICES II module offers only "internal" oscillator operation (i.e. the crystal is on the PFD or module board), as the long cable might cause unreliable crystal operation.

PIC1654

## PRELIMINARY

## 8 Bit Microcomputer

## FEATURES

- 32 8-bit RAM registers
- $512 \times 12$-bit program ROM
- Arithmetic Logic Unit
- Real Time Clock/Counter
- Self-contained oscillator for crystal or LC network
- Access to RAM registers inherent in instruction
- Wide power supply operating range (4.5V to 7.0 V )
- Available in two temperature ranges: $0^{\circ}$ to $70^{\circ} \mathrm{C}$ and $-40^{\circ}$ to $85^{\circ} \mathrm{C}$
- 18 pin package
- 2 level stack for subroutine nesting
- Open drain option on all I/O lines
- 12 bi-directional I/O lines
- $2 \mu \mathrm{sec}$ instruction execution time


## DESCRIPTION

The PIC1654 microcomputer is an MOS/LSI device containing RAM, I/O, and a central processing unit as well as customerdefined ROM on a single chip. This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs. Keyboard scanning, display driving, and other system control functions can be done at the same time due to the power of the 8 -bit CPU.
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device. The 8 -bit input/output regısters provide latched lines for interfacing to a limitless variety of applications. The PIC can be used to scan keyboards, drive displays, control electronic games and provide enhanced capabilities to power tools, telecommunication systems, traffic lights, radios, television, consumer appliances, industrial timing and control applications. The 12-bit instruction word format provides a powerful yet
easy to use instruction repertorre emphasizing single bit manıpulation as well as logical and arithmetic operations using bytes.
The PIC1654 is fabricated with N-Channel Silicon Gate technology resulting in a high performance product with proven reliablity and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operatıng clock with an external crystal, ceramic resonator or LC network to establish the frequency. Inputs and outputs are TTL-compatible.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling Programs can be assembled into machine language using PICAL, a powerful macroassembler. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PIC's operation can be verified in any hardware application by using the PIC1664-1. The PIC1664-1 is a ROM-less PIC microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands. The PFD1007 Field Demo System is available containing a PIC1664-1 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM. With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market.
A PIC Series Microcomputer Data Manual is available which gives additional detailed data on PIC based system design.

PIC1654 BLOCK DIAGRAM


## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC series microcomputer is based on a register file concept with simple yet powerful commands designed to emphasize bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.
Internally, the PIC is composed of three functional elements connected together by a single bidirectional bus. the Register File composed of 32 addressable 8-bit registers, an Arithmetic Logic Unit, and a user-defined Program ROM composed of 512 words each 12 bits in width The Register File is divided into two functıonal groups operational registers and general registers The operatıonal registers include, among others, the Real Time Clock Counter Register, the Program Counter (PC), the Status Regıster,
and the I/O Registers The general purpose registers are used for data and control information under command of the instructions
The Arithmetic Logıc Unıt contaıns one temporary workıng regıster or accumulator (W Register) and gatıng to perform Boolean functions between data held in the working register and any file register
The Program ROM contains the operational program for the rest of the logic within the controller. Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs. Program control operations can be performed by Bit Test and Skip instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC. In addition, an on-chip two-level stack is employed to provide easy to use subroutıne nestıng Actıvatıng the $\overline{M C L R}$ input on power up initializes the ROM program to address $777_{8}$

## PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| OSC1 (input), OSC2 (output) | These pins are the time base inputs to which a crystal, ceramic resonator, LC network, or external single phase clock may be connected. The frequency of oscillation is 8 times the instruction cycle frequency. |
| RTCC (input) | Real Tıme Clock Counter. Used by the microprogram to keep track of elapsed time between events. The Real Tıme Clock Counter Register increments on falling edges applied to this pin. This register (F1) can be loaded and read by the program. This is a Schmitt trigger input A mask option will allow an internal clock signal whose period is equal to the instruction execution time to drive the real time clock counter register. In this mode, transitions in the $\overline{\text { RTCC }}$ pin will be disregarded. |
| RA0-3, (input/output) | 4 user programmable I/O lines (F5). |
| RB0-7 (input/output) | 8 user programmable I/O lines (F6). <br> All inputs and outputs are under direct control of the program. A mask option will allow any I/O pin at the time of ROM pattern definition to be open draın. |
| $\overline{M C L R}$ (input) | Master Clear. Used to initialize the internal ROM program to address $777_{8}$ and latch all I/O registers high. Should be held low $10-75 \mathrm{~ms}$ past the time when $V_{D D} \geqslant 4.5 \mathrm{~V}$, depending on the crystal start up time. |
| $v_{\text {D }}$ | Power supply |
| $v_{\text {ss }}$ | Ground. |

## PIN CONFIGURATION

18 LEAD DUAL IN LINE

PIC1654
REGISTER FILE ARRANGEMENT


## Basic Instruction Set Summary

Each PIC instruction is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " f " represents a file register designator and " $d$ " represents a destination designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

PIC W register. If "d" is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while " f " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value.
For an oscillator frequency of 4 MHz the instruction execution time is $2 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $4 \mu \mathrm{sec}$.

## BYTE-ORIENTED FILE REGISTER OPERATIONS

| $(11-6)$ | $(5)$ | $(4-0)$ |
| :---: | :---: | :---: |
| OP CODE | $d$ | $f$ (FILE \#) |

For $d=0, f-W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic) $d=1, f \rightarrow f$ ( $1 f d$ is omitted, assembler assigns $d=1$.)


## NOTES:

1. The 9th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an I/O register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.

SUPPLEMENTAL INSTRUCTION SET SUMMARY
The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).


## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of an open collector TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a PIC I/O Port, the data is latched at the port and the pin
can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port latch must first be set to a high level under program control. This turns off $Q_{2}$, allowing the TTL open collector device to drive the pad, pulled up by $Q_{1}$, which can source a minimum of $100 \mu \mathrm{~A}$. Care, however, should be exercised when using open collector devices due to the potentially high TTL leakage current which can exist in the high logic state.

## TYPICAL INTERFACE-BIDIRECTIONAL I/O LINE



## Programming Cautions

The use of the bidirectional I/O ports are subject to certain rules of operation. These rules must be carefully followed in the instruction sequences written for I/O operation.

## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten. For use as an input port the output latch must be set in the high state. Thus the external device inputs to the PIC circuit by forcing the latched output line to the low state or keeping the latched output high. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result. Caution must be used when using these instructions.

As an example a B6F operation on bit 5 of F6 (port RB) will cause all eight bits of $F 6$ to be read into the CPU. Then the BSF operation takes place on bit 5 and F6 is re-output to the output latches. If another bit of $\mathrm{F6}$ is used as an input (say bit 0 ) then bit 0 must be latched high. If during the BSF instruction on bit 5 an external device is forcing bit 0 to the low state then the input/output nature of the BSF instruction will leave bit 0 latched low after execution. In this state bit 0 cannot be used as an input until it is again latched high by the programmer. Refer to the examples below.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $\mathrm{t}_{\mathrm{pd}}$ (See I/O Timing Diagram) is greater than $1 / 4 t_{c y}(\mathrm{~min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

EXAMPLE 1:


What is thought to be happening:
BSF 6,5

| Read into CPU: | 00001111 |
| :--- | :--- |
| Set bit 5: | 00101111 |
| Write to F6: | 00101111 |

If no inputs were low during the instruction execution, there would be no problem.


What could happen if an input were low:
BSF 6,5

| Read into CPU: | 00001110 |
| :--- | :--- |
| Set bit 5: | 00101110 |
| Write to F6: | 00101110 |

In this case bit 0 is now latched low and is no longer useful as an unput until set high again.

PIC1654

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient Temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }}$
(except open drain) . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +9.0 V
Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{sS}}$ (open drain) . . . . . -0.3 V to +10 V
Power Dissipation (Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 800mW
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | - | 40 | mA | All I/O pins @ $\mathrm{V}_{\mathrm{DD}}$ |
| Input Low Voltage | $\mathrm{V}_{\mathrm{IL}}$ | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except MCLR, $\overline{R T C C}$ \& OSC1) | $\mathrm{V}_{1 H}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input High Voltage (MCLR, $\overline{\text { RTCC }}$ \& OSC1) | $\mathrm{V}_{1 \mathrm{H}_{2}}$ | $V_{D D}-1$ | - | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $V_{D D}$ | V | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ provided by internal pullups (Note 2) |
| Output Low Voltage (I/O only) | $\mathrm{V}_{\mathrm{OL} 1}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (Note 3) |
| Input Leakage Current (MCLR, $\overline{\text { RTCC }}$ ) | $\mathrm{I}_{\mathrm{LC}}$ | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\text {DD }}$ |
| Output Leakage Current (open drain pins) | $\mathrm{I}_{\mathrm{OL}}$ | - | - | 10 | $\mu \mathrm{A}$ | $0 \mathrm{~V} \leqslant \mathrm{~V}_{\text {PIN }} \leqslant 9 \mathrm{~V}$ |
| Input Low Current (all I/O ports) | $I_{\text {IL }}$ | -0.2 | - | -2.0 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ (internal pullup) |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{H}}$ | -0.1 | -0.4 | - | mA | $\mathrm{V}_{1 \mathrm{H}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$
NOTES:

1. Total power dissipation for the package is calculated as follows:
$P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{L L}\right)\left(I_{I L}\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H} \|\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$.
2. Positive current indicates current into pin. Negative current indicates current out of pin.
3. Total lol for all output pins must not exceed 175 mA .

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| PIC1654 | INSTRUERENT |
| :---: | :---: |

Standard Conditions (unless otherwise stated):

## AC CHARACTERISTICS

Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | ${ }^{\text {t }} \mathrm{Cr}$ | 2 | - | 10 | $\mu \mathrm{s}$ | $0.8 \mathrm{MHz}-4.0 \mathrm{MHz}$ external time base (Note 1) |
| $\overline{\text { RTCC }}$ Input <br> Period <br> High Pulse Width <br> Low Pulse Width | $t_{\text {RT }}$ <br> $t_{\text {RTH }}$ <br> $t_{\text {RTL }}$ | $\left\|\begin{array}{c} \mathrm{t}_{\mathrm{cr}}+0.2 \mu \mathrm{~s} \\ 1 / 2 \mathrm{t}_{\mathrm{cr}} \\ 1 / 2 \mathrm{t}_{\mathrm{Cr}} \end{array}\right\|$ | $-$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $-$ | Note 2 |

NOTE:

1. Instruction cycle period ( $t_{\mathrm{cy}}$ ) equals eight times the input oscillator time base period.
2. The maximum frequency which may be input to the $\overline{\mathrm{RTCC}}$ pin is calculated as follows:

$$
f_{(\max )}=\frac{1}{t_{R T}(\min )}=\frac{1}{t_{C Y(\min )}+0.2 \mu \mathrm{~S}}
$$

For example:

$$
\begin{aligned}
& \text { example: } \\
& \text { if } \mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz} \text {. }
\end{aligned}
$$



## PIC1654 OSCILLATOR OPTIONS (TYPICAL CIRCUITS)

## LC INPUT OPERATION



$$
\begin{aligned}
& \mathrm{f}_{\mathrm{OSC}} \approx \frac{1}{2 \pi \sqrt{L\left(C_{\mathrm{L}}+C_{I N T}\right)}}, \\
& \text { where } \mathrm{C}_{\mathrm{INT}}=10 \mathrm{pF} . \\
& \text { Typical values for 4MHz operation: } \\
& L_{L}=70 \mu \mathrm{H} \\
& C_{\mathrm{L}}=10 \mathrm{pF}
\end{aligned}
$$

CRYSTAL INPUT OPERATION


* or ceramic resonator


## EXTERNAL CLOCK INPUT OPERATION



$$
N C \longrightarrow \text { OSC2 (PIN 15) }
$$

## MASTER CLEAR (TYPICAL CIRCUIT)



Typical Values
$\mathrm{R}=100 \mathrm{~K}$
$\mathrm{C}=0.1 \mu \mathrm{f}$

The $\overline{M C L R}$ signal only needs to be active low for a minimum of 1 complete instruction cycle, but this assumes power is already applied, and the oscillator is running. For initial start-up at least a 10 ms delay after $\mathrm{V}_{\mathrm{D}} \geqslant 4.5 \mathrm{~V}$ should be typically allowed on $\overline{M C L R}$ for a 4 MHz crystal to start up.

## OUTPUT SINK CURRENT GRAPH (TYPICAL)



## PIC1655A

## 8 Bit Microcomputer

## FEATURES

- User programmable
- Intelligent controller for stand-alone applications
- 328 -bit RAM registers
- $512 \times 12$-bit program ROM
- Arithmetic Logic Unit
- Real Time Clock/Counter
- Self-contained oscillator
- Access to RAM registers inherent in instruction
- Wide power supply operating range ( 4.5 V to 7.0 V )
- Available in two temperature ranges: $0^{\circ}$ to $70^{\circ} \mathrm{C}$ and $-40^{\circ}$ to $85^{\circ} \mathrm{C}$
- 4 inputs, 8 outputs, 8 bi-directional I/O lines
- 2 level stack for subroutine nesting


## DESCRIPTION

The PIC1655A microcomputer is an MOS/LSI device contaınıng RAM, I/O, and a central processing unit as well as customerdefined ROM on a single chip. This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs. Keyboard scanning, display driving, and other system control functions can be done at the same time due to the power of the 8-bit CPU.
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device. The 8-bit input/output registers provide latched lines for interfacing to a limitless variety of applications. The PIC can be used to scan keyboards, drive displays, control electronic games and provide enhanced capabilities to vending machines, traffic lights, radios, television, consumer appliances, industrial timing and control applications. The 12-bit instruction word format provides a powerful yet easy to use

## PIC1655A BLOCK DIAGRAM

instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC1655A is fabricated with N-Channel Ion Implant technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operating clock with only an external RC network (or buffered crystal oscillator signal, for greater accuracy) to establish the frequency. Inputs and outputs are TTL-compatible.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling. Programs can be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PIC's operation can be verified in any hardware application by using the PIC1664. The PIC1664 is a ROM-less PIC microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands. The PFD1000 Field Demo System is available containing a PIC1664 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM. With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market.
A PIC Series Microcomputer Data Manual is available which gives additional detailed data on PIC based system design.


## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC series microcomputer is based on a register file concept with simple yet powerful commands designed to emphasize bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.
Internally, the PIC is composed of three functional elements connected together by a single bidirectional bus' the Register File composed of 32 addressable 8-bit registers, an Arithmetic Logic Unit, and a user-defined Program ROM composed of 512 words each 12 bits in width The Register File is divided into two functıonal groups: operatıonal registers and general registers. The operational registers include, among others, the Real Tıme Clock Counter Register, the Program Counter (PC), the Status Regıster,

| PIC1655A | INSTRUSKRAT |
| :---: | :--- |

and the I/O Registers. The general purpose registers are used for data and control information under command of the instructions. The Arithmetic Logic Unit contains one temporary working register or accumulator (W Register) and gating to perform Boolean functions between data held in the working register and any file register.
The Program ROM contains the operational program for the rest of the logic within the controller. Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs. Program control operations can be performed by Bit Test and Skip instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC. In addition, an on-chip two-level stack is employed to provide easy to use subroutine nesting. Activating the $\overline{M C L R}$ input on power up initializes the ROM program to address $777_{8}$.

## PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| OSC (input) | Oscillator input. This signal can be driven by an external oscillator if a precise frequency of operation is required or an external RC network can be used to set the frequency of operation of the internal clock generator. This is a Schmitt trigger input. |
| $\overline{\text { RTCC }}$ (input) | Real Time Clock Counter. Used by the microprogram to keep track of elapsed time between events. The RTCC register increments on falling edges applied to this pin. This register can be loaded and read by the program. This is a Schmitt trigger input. |
| RAO-3 (input) | 4 input lines. |
| RB0-7 (output) | 8 output lines. |
| RC0-7 (input/output) | 8 user programmable input/output lines. |
| $\overline{\text { MCLR }}$ (input) | Master Clear. Used to initialize the internal ROM program to address $777_{\mathrm{s}}$ and latch all I/O register high. Should be held low at least 1 ms past the time when the power supply is valid. This is a Schmitt trigger input. |
| CLK OUT (output) | A signal derived from the internal oscillator. Used by external devices to synchronize themselves to PIC timing. |
| TEST | Used for testing purposes only. Must be grounded for normal operation. |
| $V_{\text {D }}$ | Primary power supply. |
| $\mathrm{v}_{\mathrm{xx}}$ | Output Buffer power supply. Used to enhance output current sinking capability. |
| $\mathbf{v}_{\text {ss }}$ | Ground |

## PIN CONFIGURATION <br> 28 LEAD DUAL IN LINE

| INSTRUMERENT | PIC1655A |
| :--- | :--- |

REGISTER FILE ARRANGEMENT


## Basic Instruction Set Summary

Each PIC instructıon is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " $f$ " represents a file register designator and " $d$ " represents a destınation designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

| PIC1655A | INSTRERAL |
| :---: | :---: |

PIC W register. If " $d$ " is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value.
For an oscillator frequency of 1 MHz the instruction execution time is $4 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $8 \mu \mathrm{sec}$.

BYTE-ORIENTED FILE REGISTER OPERATIONS


For $d=0, f \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic) $d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$ )


## NOTES:

1. The 9th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an $I / O$ register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.
$\square$

## SUPPLEMENTAL INSTRUCTION SET SUMMARY

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).

| Instruction-Binary (Octal) |  |  |  |  | Name | Mnemonic, Operands | Equivalent Operation(s) | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 010 | 000 | 000 | 011 | (2003) | Clear Carry | CLRC | BCF 3, 0 | - |
| 010 | 100 | 000 | 011 | (2403) | Set Carry | SETC | BSF 3, 0 | - |
| 010 | 000 | 100 | 011 | (2043) | Clear Digit Carry | CLRDC | BCF 3, 1 | - |
| 010 | 100 | 100 | 011 | (2443) | Set Digit Carry | SETDC | BSF 3, 1 | - |
| 010 | 001 | 000 | 011 | (2103) | Clear Zero | CLRZ | BCF 3, 2 | - |
| 010 | 101 | 000 | 011 | (2503) | Set Zero | SETZ | BSF 3, 2 | - |
| 011 | 100 | 000 | 011 | (3403) | Skip on Carry | SKPC | BTFSS 3, 0 | - |
| 011 | 000 | 000 | 011 | (3003) | Skip on No Carry | SKPNC | BTFSC 3, 0 | - |
| 011 | 100 | 100 | 011 | (3443) | Skip on Digit Carry | SKPDC | BTFSS 3, 1 | - |
| 011 | 000 | 100 | 011 | (3043) | Skip on No Digit Carry | SKPNDC | BTFSC 3, 1 | - |
| 011 | 101 | 000 | 011 | (3503) | Skip on Zero | SKPZ | BTFSS 3, 2 | - |
| 011 | 001 | 000 | 011 | (3103) | Skip on No Zero | SKPNZ | BTFSC 3, 2 | - |
| 001 | 000 | 1 ff | ffif | (1040) | Test File | TSTF f | MOVF $\mathrm{f}, 1$ | z |
| 001 | 000 | 0 ff | fff | (1000) | Move File to W | MOVFW f | MOVF f, 0 | z |
| 001 |  | $\begin{aligned} & 1 \mathrm{ff} \\ & \mathrm{dff} \end{aligned}$ | $\begin{aligned} & \mathrm{ff} \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (1140) \\ & (1200) \end{aligned}$ | Negate File | NEGF f,d | $\begin{aligned} & \text { COMF f, } 1 \\ & \text { INCF f, } d \end{aligned}$ | z |
| $\begin{aligned} & 011 \\ & 001 \end{aligned}$ |  | $\begin{aligned} & 000 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (1200) \end{aligned}$ | Add Carry to File | ADDCF f, d | BTFSC 3,0 <br> INCF f, d | Z |
| 011 000 |  |  | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (0300) \end{aligned}$ | Subtract Carry from File | SUBCF f,d | BTFSC 3,0 DECF $\mathrm{f}, \mathrm{d}$ | Z |
| 011 001 |  | $\begin{aligned} & 100 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & f f f \end{aligned}$ | $\begin{aligned} & (3043) \\ & (1200) \end{aligned}$ | Add Digit Carry to File | ADDDCF f,d | BTFSG 3,1 <br> INCF f,d | z |
| $\begin{aligned} & 011 \\ & 000 \end{aligned}$ | $\begin{aligned} & 000 \\ & 011 \end{aligned}$ | $\begin{aligned} & 100 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3043) \\ & (0300) \end{aligned}$ | Subtract Digit Carry from File | SUBDCF f,d | BTFSC 3,1 <br> DECF f,d | z |
| 101 | kkk | kkk | kkk | (5000) | Branch | Bk | GOTO k | - |
| 011 101 | 000 | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3003) \\ & (5000) \end{aligned}$ | Branch on Carry | BC k | BTFSC 3,0 GOTO $k$ | - |
| 011 101 | 100 | 000 | 011 $k k k$ | $\begin{aligned} & (3403) \\ & (5000) \end{aligned}$ | Branch on No Carry | BNC $k$ | BTFSS 3,0 GOTO $k$ | - |
| 011 101 | 100 $k k k$ | 100 $k k k$ | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & (3043) \\ & (5000) \end{aligned}$ | Branch on Digit Carry | BDC $k$ | BTFSC 3,1 GOTO $k$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | $\begin{aligned} & 001 \\ & k k k \end{aligned}$ | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3443) \\ & (5000) \end{aligned}$ | Branch on No Digit Carry | BNDC $k$ | BTFSS 3,1 GOTO $k$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 101 $k k k$ | 000 $k k k$ | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3103) \\ & (5000) \end{aligned}$ | Branch on Zero | BZ $k$ | BTFSC 3,2 GOTO $k$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | $\begin{aligned} & 101 \\ & \text { kkk } \end{aligned}$ | 000 | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & (3503) \\ & (5000) \end{aligned}$ | Branch on No Zero | BNZ $k$ | BTFSS 3,2 GOTO k | - |

## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of an open collector TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a PIC I/O Port, the data is latched at the port and the pin
can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port latch must first be set to a high level under program control This turns off $Q_{2}$, allowing the TTL open collector device to drive the pad, pulled up by $Q_{1}$, which can source a minimum of $100 \mu \mathrm{~A}$ Care, however, should be exercised when using open collector devices due to the potentially high TTL leakage current which can exist in the high logic state.

TYPICAL INTERFACE-BIDIRECTIONAL I/O LINE


## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten. For use as an input port the output latch must be set in the high state. Thus the external device inputs to the PIC circuit by forcing the latched output line to the low state or keeping the latched output high. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result. Caution must be used when using these instructions. As an example a BSF operation on bit 5 of $\mathrm{F7}$ (port RC) will cause all eight bits of $F 7$ to be read into the CPU. Then the BSF operation takes place on bit 5 and F7 is re-output to the output latches. If another bit of $\mathrm{F7}$ is used as an input (say bit 0 ) then bit 0 must be latched high. If during the BSF instruction on bit 5 an external device is forcing bit 0 to the low state then the input/output nature of the BSF instruction will leave bit 0 latched low after execution. In this state bit 0 cannot be used as an input until it is again latched high by the programmer. Refer to the examples below.

## Input Only Port: (Port RA)

The input only port of the PIC1655A consists of the four L.SB's of F5 (port RA). An internal pull-up device is provided so that external pull-ups on open collector logic are unnecessary. The four MSB's of this port are always read as zeroes. Output operations to F5 are not defined. Note that the BTFSC and BTFSS instructions are input only operations and so can be used with F5. Also, file register instructions which leave the results in W can be used.

## Output Only Port: (Port RB)

The output only port of the PIC1655A consists of F6 (port RB). This port contains no input circuitry and is therefore not capable of instructions requiring an input followed by an output operation. The only instructions which can validly use F6 are MOVWF and CLRF.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $t_{p d}$ (See I/O Timing Diagram) is greater than $1 / 4 \mathrm{t}_{\mathrm{cy}}(\mathrm{min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

## EXAMPLE 1:



What is thought to be happening:
BSF 7,5

| Read into CPU: | 00001111 |
| :--- | :--- |
| Set bit 5: | 00101111 |
| Write to F7: | 00101111 |

If no inputs were low during the instruction execution, there would be no problem.

## EXAMPLE 2:



What could happen if an input were low:
BSF 7,5

| Read into CPU: | 00001110 |
| :--- | :--- |
| Set bit 5: | 00101110 |
| Write to F7: | 00101110 |

In this case bit 0 is now latched low and is no longer useful as an input until set high again.

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . . . . .$.
Power Dissipation (Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1000 mW
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS/PIC1655A
Operating Temperature $T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ ${ }^{\text {¢ }}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Output Buffer Supply Voltage | $\mathrm{V}_{\mathrm{xx}}$ | 4.5 | - | 10.0 | V | (Note 2) |
| Primary Supply Current | $\mathrm{I}_{\text {D }}$ | - | 30 | 50 | mA | All I/O pins @ V DD |
| Output Buffer Supply Current | 1 xx | - | 1 | 5 | mA | All I/O pins @ V $\mathrm{VDD}^{\text {( }}$ (Note 3) |
| Input Low Voltage | $\mathrm{V}_{\mathrm{IL}}$ | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except MCLR, $\overline{\text { RTCC }} \&$ OSC) | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input Low-to-High Threshold Voltage (MCLR, $\overline{\text { RTCC }} \&$ OSC) | $\mathrm{V}_{\text {ILLH }}$ | $V_{D D}{ }^{-1}$ | 2.6 | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 2.4 \\ & 3.5 \end{aligned}$ | - | $\begin{aligned} & V_{D D} \\ & V_{D D} \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 4) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (I/O only) | $\mathrm{V}_{\text {OL. } 1}$ | - - - | - - - | $\begin{aligned} & \hline 0.45 \\ & 0.90 \\ & 0.90 \\ & 1.20 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xX}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=10.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=20.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \text { (Note } 5 \text { ) } \end{aligned}$ |
| Output Low Voltage (CLK OUT) | $\mathrm{V}_{\mathrm{OL} 2}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (Note 5) |
| Input Leakage Current ( $\overline{\mathrm{MCL}} \overline{\mathrm{R}}, \overline{\mathrm{RTCC}}$ ) | $\mathrm{I}_{\mathrm{LC}}$ | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\mathrm{DD}}$ |
| Output Leakage Current (open drain I/O pins) | IoLC | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {PIN }} \leqslant 10 \mathrm{~V}$ |
| Input Low Current (all 1/O ports) | $\mathrm{I}_{\text {IL }}$ | -0.2 | -0.6 | -1.6 | mA | $\mathrm{V}_{\mathrm{LL}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\text {H }}$ | -0.1 | -0.4 | -1.4 | mA | $\mathrm{V}_{1 \mathrm{H}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.

NOTES:

1. Total power dissipation for the package is calculated as follows:
$P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{I L}\right)\left(I_{I L} \mid\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(\left|I_{O H}\right|\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$.
The term I/O refers to all interface pins; input, output or I/O.
2. $V_{x x}$ supply drives only the I/O ports.
3. The maximum $\mathrm{I}_{\mathrm{xx}}$ current will be drawn when all $\mathrm{I} / \mathrm{O}$ ports are outputting a High.
4. Positive current indicates current into pin. Negative current indicates current out of pin.
5. Total $I_{\mathrm{OL}}$ for all output pins (I/O ports plus CLK OUT) must not exceed 225 mA .

| PIC1655A | INSTRUNERAK |
| :---: | :---: |

DC CHARACTERISTICS/PIC1655AI
Operating Temperature $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Output Buffer Supply Voltage | $\mathrm{V}_{\mathrm{xx}}$ | 4.5 | - | 10.0 | V | (Note 2) |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | 30 | 60 | mA | All I/O pins @ $\mathrm{V}_{\mathrm{DD}}$ |
| Output Buffer Supply Current | $\mathrm{I}_{\mathrm{x}}$ | - | 1 | 5 | mA | All I/O pins @ V ${ }_{\text {DD }}$ (Note 3) |
| Input Low Voltage | $\mathrm{V}_{1}$ | -0.2 | - | 0.7 | V |  |
| Input High Voltage (except $\overline{M C L R}, \overline{R T C C} \& ~ O S C)$ | $\mathrm{V}_{1}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input Low-to-High Threshold Voltage (M̄CLR, $\overline{\text { RTCC }}$ \& OSC) | $\mathrm{V}_{\text {ILH }}$ | $V_{D D}{ }^{-1}$ | 2.6 | $V_{\text {DD }}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $V_{D D}$ | V | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 4) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (I/O only) | $\mathrm{V}_{\text {OLI }}$ | - | - | $\begin{aligned} & \hline 0.45 \\ & 0.90 \\ & 0.90 \\ & 1.20 \\ & 2.0 \end{aligned}$ | $\begin{aligned} & \hline v \\ & v \\ & v \\ & v \\ & v \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=10.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=20.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \text { ( } \text { Note } 5 \text { ) } \end{aligned}$ |
| Output Low Voltage (CLK OUT) | $\mathrm{V}_{\mathrm{OL} 2}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (Note 5) |
| Input Leakage Current ( $\overline{\text { MCLR }}, \overline{\text { RTCC }}$ ) | ILC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\mathrm{IN}} \leqslant \mathrm{V}_{\mathrm{DD}}$ |
| Output Leakage Current (open drain I/O pins) | Iolc | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {PIN }} \leqslant 10 \mathrm{~V}$ |
| Input Low Current (all I/O ports) | IIL | -0.2 | -0.6 | -1.8 | mA | $\mathrm{V}_{1 \mathrm{~L}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{H}}$ | -0.1 | -0.4 | -1.8 | mA | $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows: $P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{L L}\right)\left(\left|I_{I L}\right|\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(\left|I_{O H}\right|\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$. The term I/O refers to all interface pins; input, output or I/O.
2. $V_{x x}$ supply drives only the I/O ports.
3. The maximum $\mathrm{I}_{\mathrm{xx}}$ current will be drawn when all I/O ports are outputting a High.
4. Positive current indicates current into pin. Negative current indicates current out of pin.
5. Total $\mathrm{I}_{\mathrm{OL}}$ for all output pins (I/O ports plus CLK OUT) must not exceed 225 mA .

Standard Conditions (unless otherwise stated):

## AC CHARACTERISTICS/PIC1655A, PIC1655AI

Operating Temperature $T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ (PIC1655A), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (PIC1655AI)

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | $t_{C Y}$ | 4 | - | 20 | $\mu \mathrm{s}$ | $0.2 \mathrm{MHz}-1.0 \mathrm{MHz}$ external time base (Note 1) |
| RTCC Input <br> Period <br> High Pulse Width <br> Low Pulse Width | $\begin{gathered} t_{\mathrm{RT}} \\ \mathrm{t}_{\mathrm{RTH}} \\ \mathrm{t}_{\mathrm{RTL}} \end{gathered}$ | $\left\|\begin{array}{c} t_{C Y}+0.2 \mu s \\ 1 / 2 t_{R T} \\ 1 / 2 t_{R T} \end{array}\right\|$ |  | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ |  | (Notes 2 and 3) |
| I/O Ports <br> Data Input Setup Time <br> Data Input Hold Time <br> Data Output Propagation Delay | $\begin{aligned} & t_{s} \\ & t_{h} \\ & t_{p d} \end{aligned}$ | $\begin{aligned} & - \\ & 0 \\ & - \end{aligned}$ | $600$ | $\left\lvert\, \begin{gathered} 1 / 4 \mathrm{c}_{\mathrm{c}-}-125 \\ - \\ 1000 \end{gathered}\right.$ | ns ns ns | Capacitive load $=50 \mathrm{pF}$ |
| OSC Input <br> External Input Impedance High <br> External Input Impedance Low | $\mathbf{R}_{\mathrm{OSCH}}$ <br> $R_{\text {oscl }}$ | 120 - | $\begin{aligned} & 800 \\ & 10^{6} \end{aligned}$ | 3500 - | $\begin{aligned} & \Omega \\ & \Omega \end{aligned}$ | $\left.\begin{array}{l} v_{\text {OSC }}=5 \mathrm{~V} \\ v_{\text {OSC }}=0.4 \mathrm{~V} \end{array}\right\} \begin{aligned} & \text { Applies to external } \\ & \text { OSC drive only } . \end{aligned}$ |

†Typical data is at $T_{A}=25^{\circ} \mathrm{C}, V_{D D}=5.0 \mathrm{~V}$.
NOTES:

1. Instruction cycle period ( $t$ cy) equals four times the input oscillator time base period.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the RTCC input, CLK OUT may be directly tied to the RTCC input.
3. The maximum frequency which may be input to the RTCC pin is calculated as follows: $f_{(\text {max })}=\frac{1}{t_{R T(\text { min })}}=\frac{1}{t_{\mathrm{CY}(\text { min })}+0.2 \mu \mathrm{~s}}$ For example: if $\mathrm{t}_{\mathrm{cr}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.

| INSTRUERAL | PIC1655A |
| :---: | :---: |

I/O TIMING
Rise and fall times are load dependent
INPUT

> | $\mid$ INCREMENT |
| :--- |
| ADDRESS ROM |
| FOR NEXT |
| INSTRUCTION |



## CLK OUT TIMING



PIC1655A OSCILLATOR OPTIONS (TYPICAL CIRCUITS)
RC OPTION OPERATION



BUFFERED CRYSTAL INPUT OPERATION


The buffer must be capable of driving $120 \Omega, \min .(800 \Omega$, typ. $)$ to 2.0 V . However, it is recommended that the pull-down transistor on the OSC pin be removed (an option) if OSC is to be driven externally.

## EXTERNAL CLOCK INPUT OPERATION



MASTER CLEAR (TYPICAL CIRCUIT)


Master Clear requires $>1.0 \mathrm{~ms}$ delay before activation after power is applied to the $V_{D D}$ pin, for the oscillator to start up. To achieve this, an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function).

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the $V_{x x}$ supply and the output load. This chart shows the typical curves used to express the output drive capability.
$V_{O H}$ VS $I_{\text {OH }}$ (I/O PORTS) (TYPICAL)
POWER SUPPLY CURRENT VS TEMPERATURE (TYPICAL LIMITS)


POWER DISSIPATION DERATING GRAPH


NOTES:

1. $70^{\circ} \mathrm{C}$ is the maximum operating temperature for standard parts
2. $85^{\circ} \mathrm{C}$ is the maximum operating temperature for " $I$ " suffix parts.

## PIC1655A EMULATION CAUTIONS

When emulating a PIC1655A using a PICES II development system certain precautions should be taken.
A. Be sure that the PICES II Module being used is programmed for the PIC1650A mode. (Refer to the PICES Manual). The PIC1664 contained within the module should have the MODE pin \#22 set to a high state.

1. This causes the $\overline{M C L R}$ to force all I/O registers high.
2. The OSC 1 pin \#59 becomes a single clock input pin.
3. The interrupt system becomes disabled and the RTCC always counts on the trailing edges.
4. Bits 3 through 7 on file register F 3 are all ones.
B. Make sure to only use two levels of stack within the program.
C. Make sure all I/O cautions contained in this spec sheet are used.
D. Be sure to use the 28 pin socket for the module plug.
E. Make sure that during an actual application the MCLR input swings from a low to high level a minimum of 1 msec after the supply voltage is applied.
F. If an oscillator drive is used, be sure that it can drive the $120 \Omega$ input impedance of the OSC pin on the PIC1664.
G. The cable length and internal variations may cause some parameter values to differ between the PICES II module and a production PIC1655A.

## 8 Bit Microcomputer

## FEATURES

- User programmable
- Intelligent controller for stand-alone applications
- 32 8-bit RAM registers
- $512 \times 12$-bit program ROM
- Arithmetic Logic Unit
- Real Time Clock/Counter
- Self-contained crystal oscillator
- Access to RAM registers inherent in instruction
- Wide power supply operating range ( 4.5 V to 7.0 V )
- Available in two temperature ranges: $0^{\circ}$ to $70^{\circ} \mathrm{C}$ and $-40^{\circ}$ to $85^{\circ} \mathrm{C}$
- 4 inputs, 8 outputs, 8 bi-directional I/O lines
- 2 level stack for subroutine nesting
- Mask programmable prescaler for RTCC
- Mask programmable open drain option on all I/O lines


## DESCRIPTION

The PIC1655XT microcomputer is an MOS/LSI device containing RAM, I/O, and a central processing unit as well as customerdefined ROM on a single chip. This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs. Keyboard scanning, display driving, and other system control functions can be done at the same time due to the power of the 8 -bit CPU.
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device. The 8-bit input/output registers provide latched lines for interfacing to a limitless variety of applications. The PIC can be used to scan keyboards, drive displays, control electronic games and provide enhanced capabilities to vending machines, traffic lights, radios, television, consumer appliances, industrial timing and control applications. The 12-bit instruction word format provides a powerful yet easy to use
instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC1655XT is fabricated with N-Channel Ion Implant technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operating clock with an external crystal,ceramic resonator or LC network to establish the frequency. Inputs and outputs are TTL-compatible.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling. Programs can be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PIC's operation can be verified in any hardware application by using the PIC1664. The PIC1664 is a ROM-less PIC microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands. The PFD1000 Field Demo System is available containing a PIC1664 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM. With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market.
A PIC Series Microcomputer Data Manual is available which gives additional detailed data on PIC based system design.


## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC series microcomputer is based on a register file concept with simple yet powerful commands designed to emphasize bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.
Internally, the PIC is composed of three functional elements connected together by a single bidirectional bus: the Register File composed of 32 addressable 8-bit registers, an Arithmetic Logic Unit, and a user-defined Program ROM composed of 512 words each 12 bits in width. The Register File is divided into two functional groups: operational registers and general registers. The operational registers include, among others, the Real Time Clock Counter Register, the Program Counter (PC), the Status Register,
and the I/O Registers. The general purpose registers are used for data and control information under command of the instructions. The Arithmetic Logic Unit contains one temporary working register or accumulator (W Register) and gating to perform Boolean functions between data held in the working register and any file register.
The Program ROM contains the operational program for the rest of the logic within the controller Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs. Program control operations can be performed by Bit Test and Skip instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC. In addition, an on-chip two-level stack is employed to provide easy to use subroutine nesting. Activating the $\overline{M C L R}$ input on power up initıalizes the ROM program to address $777_{8}$.

PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| OSC1 (input), OSC2 (output) | Oscillator pins. The oscillator frequency can be set by a crystal, ceramic resonator, external LC network or driven externally. The oscillator frequency is sixteen times the instruction frequency. |
| RTCC (input) | Real Time Clock Counter. Used by the microprogram to keep track of elapsed time between events. The Real Time Clock Counter, Register increments on falling edges applied to this pin. This register can be loaded and read by the program. This is a Schmitt trigger input except when a prescaler division ratio of $2,4,8$ or 16 is selected in which case the input is TTL compatible. |
| RA0-3 (input) | 4 input lines |
| RB0-7 (output) | 8 output lines |
| RC0-7 (input/output) | 8 user programmable input/output lines <br> All inputs and outputs are under direct control of the program. |
| MCLR (input) | Master Clear. Used to initialize the internal ROM program to address 7778 and latch all I/O registers high. Should be held low at least 1 ms past the time when power supply is valid. This is a Schmitt trigger input. |
| CLK OUT (output) | A signal derived from the internal oscillator. Used by external devices to synchronize themselves to PIC timing. |
| $V_{\text {D }}$ | Primary power supply. |
| $\mathbf{V}_{\mathbf{x x}}$ | Output Buffer power supply. Used to enhance output current sinking capability. |
| $\mathbf{V}_{\mathbf{s s}}$ | Ground |

$\square$
REGISTER FILE ARRANGEMENT


The PIC1655XT has the same basic architecture as the PIC1655A with the additional enhancements described below:

## Real Time Clock Counter

The Real Time Clock Counter can be read from and written to under software control In addition, it can be used to count external events via the RTCC input. A prescaler counter between the RTCC input and the Real Time Clock Counter can be mask programmed to enable the RTCC register to increment every $1,2,4,8$, or 16 negative edges of the RTCC input pin
This allows the maximum frequency of the RTCC input to be (assume an instruction cycle time of $4 \mu \mathrm{~s}$ ):
Prescaler
Division Ratio
1
2
4
8
16

> Maximum Input Frequency
> 0.238 MHz
> 0.476 MHz
> 0.952 MHz
> 1.904 MHz
> 3.808 MHz

NOTE: The Schmitt trigger input is valid only when a division ratio of 1 is selected. Otherwise, the input is a normal TTL compatible input.

## Self-Contained Oscillator

When a crystal, ceramic resonator or LC network is connected between the OSC1 and OSC2 pins, the self-contaıned oscillator will generate a frequency determined by the external components thus allowing an accurate timing reference, a crystal, to be used for time base control with a minimum of external parts
The output of this oscillator "s divided down by 16 to give the instruction cycle time of the microcomputer, thus with a 4 MHz crystal the instruction cycle time is $4 \mu \mathrm{~s}$
When test mode is enabled, the basic instruction cycle tıme is a division of 4 of the frequency applied to OSC1 and OSC2 allowing simpler synchronizıng of the device and tester

## Basic Instruction Set Summary

Each PIC instruction is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " $f$ " represents a file register designator and " $d$ " represents a destination designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

PIC W register. If " $d$ " is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while " f " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value
For an oscillator frequency of 4 MHz the instruction execution time is $4 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $8 \mu \mathrm{sec}$.

## BYTE-ORIENTED FILE REGISTER OPERATIONS

| $(11-6)$ | (4-0) |  |
| :---: | :---: | :---: |
| OP CODE | $d$ | (FILE \#) |

For $d=0, f \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic) $d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$ )


## NOTES:

1. The 9th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2 Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide
2 When an I/O register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.
2. See notes on input only and output only ports (F5 and F6 respectively).
$\square$

## SUPPLEMENTAL INSTRUCTION SET SUMMARY

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).


## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of an open collector TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a PIC I/O Port, the data is latched at the port and the pin
can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port latch must first be set to a high level under program control. This turns off $Q_{2}$, allowing the TTL open collector device to drive the pad, pulled up by $Q_{1}$, which can source a minimum of $100 \mu \mathrm{~A}$. Care, however, should be exercised when using open collector devices due to the potentially high TTL leakage current which can exist in the high logic state.

TYPICAL INTERFACE-BIDIRECTIONAL I/O LINE


## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten. For use as an input port the output latch must be set in the high state. Thus the external device inputs to the PIC circuit by forcing the latched output line to the low state or keeping the latched output high. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result. Caution must be used when using these instructions. As an example a BSF operation on bit 5 of F7 (port RC) will cause all eight bits of $F 7$ to be read into the CPU. Then the BSF operation takes place on bit 5 and $F 7$ is re-output to the output latches. If another bit of F 7 is used as an input (say bit 0 ) then bit 0 must be latched high. If during the BSF instruction on bit 5 an external device is forcing bit 0 to the low state then the input/output nature of the BSF instruction will leave bit 0 latched low after execution. In this state bit 0 cannot be used as an input until it is again latched high by the programmer. Refer to the examples below.

## Input Only Port: (Port RA)

The input only port of the PIC1655XT consists of the four LSB's of F5 (port RA). An internal pull-up device is provided so that external pull-ups on open collector logic are unnecessary. The four MSB's of this port are always read as zeroes. Output operations to F 5 are not defined. Note that the BTFSC and BTFSS instructions are input only operations and so can be used with F5. Also, file register instructions which leave the results in W can be used.

## Output Only Port (Port RB)

The output only port of the PIC1655XT consists of F6 (port RB). This port contains no input circuitry and is therefore not capable of instructions requiring an input followed by an output operation. The only instructions which can validly use F6 are MOVWF and CLRF

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $t_{\text {pd }}$ (See I/O Timing Diagram) is greater than $1 / 4 \mathrm{c}_{\mathrm{cy}}(\mathrm{min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

## EXAMPLE 1:



What is thought to be happening:
BSF 7,5

| Read into CPU: | 00001111 |
| :--- | :--- |
| Set bit 5: | 00101111 |
| Write to F7: | 00101111 |

If no inputs were low during the instruction execution, there would be no problem.

EXAMPLE 2:


What could happen if an input were low-
BSF 7,5

| Read into CPU: | 00001110 |
| :--- | :--- |
| Set bit 5: | 00101110 |
| Write to F7: | 00101110 |

In this case bit 0 is now latched low and is no longer useful as an unput until set high again.

| INSTRUMENENT | PIC1655XT |
| ---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias $125^{\circ} \mathrm{C}$
Storage Temperature ..................................... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . . . . . .$.
Power Dissipation (Note 1) ............................................... . 800 mW
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | Min | Typ $\dagger$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | - | 65 | mA | All I/O pins @ V ${ }_{\text {DD }}$ (Note 5) |
| Output Buffer Supply Voltage | $\mathrm{V}_{\mathrm{xx}}$ | 4.5 | - | 10.0 | V | (Note 2) |
| Output Buffer Supply Current | $\mathrm{I}_{\mathrm{xx}}$ | - | 1 | 5 | mA | All I/O pins @ V ${ }_{\text {DD }}$ |
| Input Low Voltage | $\mathrm{V}_{1}$ | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except $\overline{\text { MCLR }}, \overline{\text { RTCC }}$, OSC1 When Prescaler $=2,4,8$ or 16) | $\mathrm{V}_{1+1}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input High Voltage (MCLR, $\overline{\text { RTCC }}$, OSC1 When Prescaler = 1) | $\mathrm{V}_{1 \mathrm{H} 2}$ | $V_{D D}-1$ | - | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 2.4 \\ & 3.5 \end{aligned}$ | - | $\begin{aligned} & V_{D D} \\ & V_{D D} \end{aligned}$ | $\begin{aligned} & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}(\text { Note } 3) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (1/O only) | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (Note 4) |
| Input Leakage Current ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RTCC}}$ ) | LC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\mathrm{DD}}$ |
| Output Leakage Current (open drain pins) | IOL | - | - | 10 | $\mu \mathrm{A}$ | $0 \mathrm{~V} \leqslant \mathrm{~V}$ pin $\leqslant 10 \mathrm{~V}$ |
| Input Low Current (all I/O ports) | 1 LL | -0.2 | - | -2.0 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{H}}$ | -0.1 | -0.4 | -1.6 | mA | $\mathrm{V}_{1 \mathrm{H}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$
NOTES:

1. Total power dissipation for the package is calculated as follows:
$P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{L L}\right)\left(I_{I} J\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H} \mid\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$.
2. $V_{x x}$ supply drives only the I/O ports.
3. Positive current indicates current into pin. Negative current indicates current out of pin.
4. Total Iol for all output pins must not exceed 175 mA .
5. $I_{D D}$ max current spec is preliminary and subject to change.

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Standard Conditions (unless otherwise stated):
AC CHARACTERISTICS.
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | ${ }^{\text {t }} \mathrm{Cr}$ | 4 | - | 20 | $\mu \mathrm{s}$ | $02 \mathrm{MHz}-10 \mathrm{MHz}$ external time base (Note 1) |
| $\overline{\text { RTCC }}$ Input <br> Period <br> High Pulse Width <br> Low Pulse Width | $\begin{gathered} t_{\text {RT }} \\ t_{\text {RTH }} \\ t_{\text {RTL }} \end{gathered}$ | $\left\|\begin{array}{c} t_{\mathrm{CY}}+0.2 \mu \mathrm{~s} \\ 1 / 2 t_{\mathrm{RT}} \\ 1 / 2 t_{\mathrm{RT}} \end{array}\right\|$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ |  | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | Prescaler division ratio $=1$ <br> (Notes 2 and 4) |
| I/O Ports <br> Data Input Setup Time <br> Data Input Hold Time <br> Data Output Propagation Delay | $\begin{aligned} & t_{s} \\ & t_{h} \\ & t_{p d} \end{aligned}$ | - | $\begin{aligned} & - \\ & - \\ & 500 \end{aligned}$ | $\left\lvert\, \begin{gathered} 1 / 4 \mathrm{cr}-125 \\ - \\ 900 \end{gathered}\right.$ | ns ns ns | Capacitive load $=50 \mathrm{pF}$ |


NOTES:

1. Instruction cycle period ( $\mathrm{t}_{\mathrm{CY}}$ ) equals four times the input oscillator time base period.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the $\overline{\operatorname{RTCC}}$ input, CLK OUT may be directly tied to the $\overline{\text { RTCC }}$ input.
3. If an $\overline{\operatorname{RTCC}}$ prescaler division ratio of $2,4,8$ or 16 is selected, the maximum rise and fall times of the signal input to the $\overline{\operatorname{RTCC}}$ pin is 200 nsecs and its duty cycle must be between $40 \%$ and $60 \%$
4. The maximum frequency which may be input to the $\overline{\text { RTCC }}$ pin for a division ratio of 1 is calculated as follows:
$f_{\text {(max })}=\frac{1}{t_{\text {RT (min) }}}=\frac{1}{t_{\mathrm{CY}(\text { min })}+0.2 \mu \mathrm{~S}}$
For example:
if $\mathrm{t}_{\mathrm{cr}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.

I/O TIMING


CLK OUT TIMING



## SCHMITT TRIGGER CHARACTERISTICS (Typical @ $25^{\circ} \mathrm{C}$ )



NOTES:

1. Low-to-High Threshold Voltage ( $\mathrm{V}_{\text {TLH }}$ ).
2. High-to-Low Threshold Voltage $\left(\mathrm{V}_{\text {THL }}\right)$.

PIC1655XT OSCILLATOR OPTIONS (TYPICAL CIRCUITS)
LC INPUT OPERATION


$$
f_{\mathrm{OSC}} \approx \frac{1}{2 \pi \sqrt{L\left(C_{L}+C_{I N T}\right)}},
$$

Typical values for 4 MHz operation:
$\mathrm{L}=70 \mu \mathrm{H}$
$C_{L}=10 \mathrm{pF}$

CRYSTAL INPUT OPERATION


* OR CERAMIC RESONATOR

EXTERNAL CLOCK INPUT OPERATION


MASTER CLEAR (TYPICAL CIRCUIT)


Master Clear requires 10 ms delay (assuming a 4 MHz crystal) before activation after power is applied to the $V_{D D}$ pin, for the crystal to start up. To achieve this, an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function).

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the $\mathrm{V}_{\mathrm{xx}}$ supply and the output load. This chart shows the typical curves used to express the output drive capability.
$V_{O H} V S I_{\text {OH }}$ (I/O PORTS) (TYPICAL)

## POWER SUPPLY CURRENT VS TEMPERATURE (TYPICAL LIMITS)



## POWER DISSIPATION DERATING GRAPH



NOTES:
$1.70^{\circ} \mathrm{C}$ is the maximum operating temperature for standard parts.
$2.85^{\circ} \mathrm{C}$ is the maximum operating temperature for " $I$ " suffix parts.

## PIC1655XT EMULATION CAUTIONS

When emulating a PIC1655XT using a PICES II development system certain precautions should be taken.
A. Be sure that the PICES II Module being used is programmed for the PIC1655XT mode. (Refer to PICES II Manual). The PIC1664 contained within the module should have the MODE pin \#22 set to a high state.

1. This causes the $\overline{M C L R}$ to force all I/O registers high.
2. The interrupt system becomes disabled and the RTCC always counts on the trailing edges.
3. Bits 3 through 7 on file register F3 are all ones.
B. Make sure to only use two levels of stack within the program.
C. Make sure all I/O cautions contained in this spec sheet are used.
D. Be sure to use the 28 pin socket for the module plug.
$E$ Make sure that during an actual application the $\overline{M C L R}$ input swings from a low to high level a minimum of 10 msec after the supply voltage is applied to allow for the crystal to start up.
F. The cable length and internal variations may cause some parameter values to differ between PICES II Module and a production PIC1655XT.
G. The emulator PFD board or PICES II Module offers only "internal" oscillator operation (i.e. the crystal is on the PFD or Module Board) as the long cable might cause unreliable crystal operation.

## 8 Bit Microcomputer

## FEATURES

- User programmable
- Intelligent controller for stand-alone applications
- 328 -bit RAM registers
- $512 \times 12$-bit program ROM
- Arithmetic Logıc Unit
- Real Time Clock/Counter
- Self-contained oscillator for crystal, ceramic resonator or RC network
- Access to RAM registers inherent in instruction
- Wide power supply operating range ( 2.5 V to 6.0 V )
- Low power dissipation
- 4 inputs, 8 outputs, 8 bi-directional I/O lines
- 2 level stack for subroutine nesting
- Software compatible with other PIC series microcomputers


## DESCRIPTION

The PIC16C55 microcomputer is a CMOS device containing RAM, I/O, and a central processing unit as well as customer-defined ROM on a single chip. This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs. Keyboard scanning, display driving, and other system control functions can be done at the same time due to the power of the 8-bit CPU.
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device The 8-bit input/output registers provide latched lines for interfacıng to a limitless variety of applications The PIC can be used to scan keyboards, drive displays, control electronic games and provide enhanced capabilities to power tools, telecommunications systems, radios, television, consumer appliances, industrial timing and control applications. The 12-bit instruction word format provides a powerful yet easy to use
instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC16C55 is fabricated with complementary MOS technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operating clock with only an external RC network (or crystal or ceramic resonator, for greater accuracy) to establish the frequency.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling. Programs can be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PIC's operation can be verified in any hardware application byusing the PIC16C63. The PIC16C63 is a ROM-less PIC microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands. The PIC Field Demo System is available containing a PIC16C63 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM. With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market.
A PIC Series Microcomputer Data Manual is available which gives additional detailed data on PIC based system design.


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## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC series mıcrocomputer is based on a register file concept with simple yet powerful commands designed to emphasize bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.
Internally, the PIC is composed of three functional elements connected together by a single bidirectional bus* the Register File composed of 32 addressable 8-bit registers, an Arithmetic Logic Unit, and a user-defined Program ROM composed of 512 words each 12 bits in width. The Register File is divided into two functional groups: operational registers and general registers. The operational registers include, among others, the Real Time Clock Counter Register, the Program Counter (PC), the Status Register,
and the I/O Registers The general purpose registers are used for data and control information under command of the instructions. The Arithmetic Logic Unit contains one temporary workıng register or accumulator (W Register) and gating to perform Boolean functions between data held in the working register and any file register
The Program ROM contains the operational program for the rest of the logic within the controller. Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs Program control operatıons can be performed by Bit Test and Skıp instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC. In addition, an on-chip two-level stack is employed to provide easy to use subroutine nesting

PIN FUNCTIONS

| Signal | Function |
| :--- | :--- |
| OSC1 (input), OSC2 (output) | Oscillator pins. These pins are used to derive the internal clock for the chip. A crystal, ceramic <br> resonator or RC network may be used in conjunction with OSC1 and OSC2. Additionally, OSC1 <br> may be driven by an external oscillator. |
| RTCC (input) | Real Time Clock Counter. File 1 increments on falling edges applied to this pin. This register <br> can be loaded and read by the program. <br> Dedicated input lines read under control of the program. The 4 MSB's are always read as logic <br> zeroes. <br> Dedicated output lines, user programmable under direct control of the program. <br> RAO-3 (input) <br> RBO-7 (output) <br> RCO-7 (input/output) <br> UCLR (input) <br> and/or outputs. <br> Master Clear. Used to initialize the internal ROM program to address 777 octal and set output <br> status latches into the high impedance state. |
| CLK OUT (output) | A signal derived from the internal oscillator. Used by external devices to synchronize them- <br> selves to PIC timing. <br> Used for testing purposes only. Must be connected to VSS or left open circuit for normal <br> operation. <br> Power supply. <br> Ground |
| $\mathbf{V}_{\text {DD }}$ |  |

## REGISTER FILE ARRANGEMENT

| File (Octal) | Function |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| F0 | Not a physically implemented register. FO calls for the contents of the File Select Register (low order 5 bits) to be used to select a file register. FO is thus useful as an indirect address pointer. For example, $\mathrm{W}+\mathrm{FO} \rightarrow \mathrm{W}$ will add the contents of the file regıster pointed to by the FSR (F4) to W and place the result in W |  |  |  |  |  |  |  |  |
| F1 | Real Time Clock Counter Register. This register can be loaded and read by the microprogram. The RTCC register keeps counting up after zero is reached. The counter increments on the falling edge of the input RTCC. However, if data are being stored in the RTCC register simultaneously with a negative transition on the RTCC pın, the RTCC register will contain the new stored value and the external transition will be ignored by the microcomputer. |  |  |  |  |  |  |  |  |
| F2 | Program Counter (PC). The PC is automatically incremented during each instruction cycle, and can be written into under program control (MOVWF F2) The PC is nine bits wide, but only its low order 8 bits can be read under program control. |  |  |  |  |  |  |  |  |
| F3 | Status Word Register. When F3 is the destination register, the status flags are overwritten. |  |  |  |  |  |  |  |  |
|  |  | (7) |  |  |  |  | (2) | (1) | (0) |
|  |  | 1 | 1 | 1 | 1 | 1 | Z | DC | C |
|  | $\begin{array}{ll}\text { C (Carry): } & \text { For ADD and SUB instructions, this bit is set if there is a carry out from the most significant bit of the } \\ \text { resultant. } \\ & \text { For ROTATE instructions, this bit is loaded with either the high or low order bit of the source }\end{array}$ |  |  |  |  |  |  |  |  |
|  | DC (Digit Carry). For ADD and SUB instructions, this bit is set if there is a carry out from the 4th low order bit of the resultant. $Z$ (Zero): $\quad$ Set if the result of an arithmetic operation is zero. |  |  |  |  |  |  |  |  |
| F4 | File Select Register (FSR). Low order 5 bits only are used. The FSR is used in generating effective file register addresses under program control. When accessed as a directly addressed file, the upper 3 bits are read as ones. |  |  |  |  |  |  |  |  |
| F5 | Input Register A (A0-A3). (A4-A7 defined as zeroes). Output operations to this register are not defined. |  |  |  |  |  |  |  |  |
| F6 | Output Register $B(B 0-B 7)$. When an instruction involving a read is executed on this port (all instructions except literal and control operations, NOP, MOVWF, CLRW and CLRF) the data will be read from the latch (not from the pins). |  |  |  |  |  |  |  |  |
| F7 | I/O Register C (C0-C7). For use as an input port, the output latch should be tristated. The input port is non-latching so an input must be present until read by an instruction. When an instruction involving a read is executed on this port (as in F6), the data will be read from the pins, whether or not it is tristated (i.e., selected as an input or an output). |  |  |  |  |  |  |  |  |
| F10-F37 | General Purpose Registers. |  |  |  |  |  |  |  |  |

## Basic Instruction Set Summary

Each PIC instruction is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " $f$ " represents a file register designator and " $d$ " represents a destination designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

| PIC16C55 | INSTRUMERAL |
| :---: | :---: |

PIC W register. If " $d$ " is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value.
For an oscillator frequency of 1 MHz the instruction execution time is $5 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $10 \mu \mathrm{sec}$.

## BYTE-ORIENTED FILE REGISTER OPERATIONS



For $d=0, f \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic)
$d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$ )


## LITERAL AND CONTROL

 OPERATIONS(7-0)

| Instruction-Binary (Octal) |  |  |  |  | Name |  |  | Operation Status Affected |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 000 | 000 | 000 | 010 | (0002) | Return | RETURN | - | Stack $\rightarrow$ PC | None |
| 000 | 000 | 0 ff | fff | (0000) | Tristate port f | TRIS | f | $\mathrm{W} \rightarrow$ Tristate status f [ $\mathrm{f}=\mathrm{F6}$ or F7] | None |
| 100 | 0kk | kkk | kkk | (4000) | Return and place Literal in W | - RETLW | k | $k \rightarrow W$, Stack $\rightarrow$ PC | None |
| 100 | 1 kk | kkk | kkk | (4400) | Call subroutıne (Note 1) | CALL | k | PC+1 $\rightarrow$ Stack, $k \rightarrow$ PC | None |
| 101 | kkk | kkk | kkk | (5000) | Go To address ( $k$ is 9 bits) | GOTO | k | $k \rightarrow P C$ | None |
| 110 | Okk | kkk | kkk | (6000) | Move Literal to W | MOVLW | k | $k \rightarrow W$ | None |
| 110 | 1 kk | kkk | kkk | (6400) | Inclusive OR Literal and W | IORLW | k | $k V W \rightarrow W$ | Z |
| 111 | Okk | kkk | kkk | (7000) | AND Literal and W | ANDLW | k | $k \cdot W \rightarrow W$ | Z |
| 111 | 1 kk | kkk | kkk | (7400) | Exclusive OR Literal and W | XORLW | k | $k \odot W \rightarrow W$ | Z |

## NOTES:

1. The 9 th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an I/O register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.
3. TRIS $f$ (where $f=6$ or 7 ) causes the contents of $W$ to be written to the tristate latches of the specified file. A one forces the pin to trist the output buffer to a high impedance state.

PIC16C55

## SUPPLEMENTAL INSTRUCTION SET SUMMARY

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).

| Instruction-Binary (Octal) |  |  |  |  | Name | Mnemonic, Operands | Equivalent Operation(s) | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 010 | 000 | 000 | 011 | (2003) | Clear Carry | CLRC | BCF 3, 0 | - |
| 010 | 100 | 000 | 011 | (2403) | Set Carry | SETC | BSF 3, 0 | - |
| 010 | 000 | 100 | 011 | (2043) | Clear Digit Carry | CLRDC | BCF 3, 1 | - |
| 010 | 100 | 100 | 011 | (2443) | Set Digit Carry | SETDC | BSF 3, 1 | - |
| 010 | 001 | 000 | 011 | (2103) | Clear Zero | CLRZ | BCF 3, 2 | - |
| 010 | 101 | 000 | 011 | (2503) | Set Zero | SETZ | BSF 3, 2 | - |
| 011 | 100 | 000 | 011 | (3403) | Skip on Carry | SKPC | BTFSS 3, 0 | - |
| 011 | 000 | 000 | 011 | (3003) | Skip on No Carry | SKPNC | BTFSC 3, 0 | - |
| 011 | 100 | 100 | 011 | (3443) | Skip on Digit Carry | SKPDC | BTFSS 3, 1 | - |
| 011 | 000 | 100 | 011 | (3043) | Skip on No Digit Carry | SKPNDC | BTFSC 3, 1 | - |
| 011 | 101 | 000 | 011 | (3503) | Skip on Zero | SKPZ | BTFSS 3, 2 | - |
| 011 | 001 | 000 | 011 | (3103) | Skip on No Zero | SKPNZ | BTFSC 3, 2 | - |
| 001 | 000 | 1 ff | ffif | (1040) | Test File | TSTF f | MOVF f, 1 | z |
| 001 | 000 | 0 ff | $f \mathrm{ff}$ | (1000) | Move File to W | MOVFW f | MOVF f, 0 | z |
| $\begin{aligned} & 001 \\ & 001 \end{aligned}$ | $\begin{aligned} & 001 \\ & 010 \end{aligned}$ | $\begin{aligned} & 1 \mathrm{ff} \\ & \mathrm{dff} \end{aligned}$ | $\begin{aligned} & f f \\ & f f f \end{aligned}$ | $\begin{aligned} & (1140) \\ & (1200) \end{aligned}$ | Negate File | NEGF f,d | $\begin{aligned} & \text { COMF f, } 1 \\ & \text { INCF f, d } \end{aligned}$ | z |
| 011 001 | 000 010 | $\begin{aligned} & 000 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (1200) \end{aligned}$ | Add Carry to File | ADDCF f, d | BTFSC 3,0 <br> INCF f, d | z |
| $\begin{aligned} & 011 \\ & 000 \end{aligned}$ | $\begin{aligned} & 000 \\ & 011 \end{aligned}$ | $\begin{aligned} & 000 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (0300) \end{aligned}$ | Subtract Carry from File | SUBCF f, d | $\begin{aligned} & \text { BTFSC } 3,0 \\ & \text { DECF } f, d \end{aligned}$ | Z |
| $\begin{aligned} & 011 \\ & 001 \end{aligned}$ | $\begin{aligned} & 000 \\ & 010 \end{aligned}$ | $\begin{aligned} & 100 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & \text { (3043) } \\ & \text { (1200) } \end{aligned}$ | Add Digit Carry to File | ADDDCF f,d | BTFSG 3,1 <br> INCF f,d | Z |
| 011 000 | 000 | 100 | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & \text { (3043) } \\ & \text { (0300) } \end{aligned}$ | Subtract Digit Carry from File | SUBDCF f,d | BTFSC 3,1 DECF f,d | Z |
| 101 | kkk | kkk | kkk | (5000) | Branch | B k | GOTO k | - |
| 011 101 | 000 | 000 $k k k$ | 011 $k k k$ | (3003) (5000) | Branch on Carry | BCk | BTFSC 3,0 GOTO k | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 100 | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3403) \\ & (5000) \end{aligned}$ | Branch on No Carry | BNC k | BTFSS 3,0 GOTO k | - |
| 011 101 | 100 | 100 $k k k$ | 011 $k k k$ | $\begin{aligned} & (3043) \\ & (5000) \end{aligned}$ | Branch on Digit Carry | BDC k | BTFSC 3,1 GOTO $k$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 001 | 000 $k k k$ | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3443) \\ & (5000) \end{aligned}$ | Branch on No Digit Carry | BNDC k | BTFSS 3,1 GOTO $k$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 101 $k k k$ | 000 | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & (3103) \\ & (5000) \end{aligned}$ | Branch on Zero | BZ $k$ | BTFSC 3,2 GOTO k | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | $\begin{aligned} & 101 \\ & k k k \end{aligned}$ | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3503) \\ & (5000) \end{aligned}$ | Branch on No Zero | BNZ k | BTFSS 3,2 GOTO k | - |


| PIC16C55 | INSTRUNERAL |
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## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of a tri-state TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a

PIC I/O Port, the data is latched at the port and the pin can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port must first be set to the high impedance state under program control. This turns off $Q_{1}$ and $Q_{2}$ and turns on $Q_{3}$ (if present), allowing the TTL tri-state device to drive the pin.


## Programming Cautions

The use of the bidirectional I/O ports are subject to certain rules of operation. These rules must be carefully followed in the instruction sequences written for I/O operation. (Note that for an output only port the latch, not the pin is read.)

## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten. For use as an input port the output must be set to the high impedance state via the tri-state latch. Thus the external device inputs to the PIC circuit by forcing the input line high or low. If the input lines are not tri-stated then refer to PIC1650A
programming cautions. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $t_{\text {pd }}$ (See $1 / O$ Timing Diagram) is greater than ${ }^{1 / 5 t_{c y}}(\mathrm{~min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

| GENERAL | PIC16C55 |
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## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient Temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{SS}}$ (Note 1) ..... -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$

Power Dissipation (Note 5) ............................................. 300 mW
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | Min | Typ ${ }^{\text { }}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | $V_{D D}$ | 2.5 | - | 6.0 | V |  |
| Supply Current | $\mathrm{I}_{\text {D }}$ | - | - | $\begin{aligned} & 2 \\ & 5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ | $\left.\begin{array}{l} \mathrm{V}_{\mathrm{DD}}=4 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{DD}}=6 \mathrm{~V} \end{array}\right\} \begin{aligned} & \text { All I/O pins tri-state, } \\ & \mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{sec} \end{aligned}$ |
| Input Low Voltage | $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\text {ss }}$ | - | $0.2 \mathrm{~V}_{\text {D }}$ | V |  |
| Input High Voltage | $\mathrm{V}_{\mathrm{IH}}$ | $0.8 \mathrm{~V}_{\text {DD }}$ | - | - | V |  |
| Output High Voltage (RB0-7, RC0-7) | $\mathrm{V}_{\mathrm{OH}}$ | $\left\lvert\, \begin{aligned} & \left\|\begin{array}{l} V_{D D}-0.4 \\ V_{D D}-0.4 \end{array}\right\| \end{aligned}\right.$ | - | - | $\begin{aligned} & \mathrm{V} \\ & \mathrm{v} \end{aligned}$ | $\begin{gathered} I_{\text {SOURCE }}=0.2 \mathrm{~mA}, V_{D D}=4.75 \mathrm{~V} \\ I_{\text {SOURCE }}=80 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{DD}}=2.5 \mathrm{~V} \end{gathered}$ |
| $\begin{aligned} & \text { Output Low Voltage (RBO-7, RC0-7) } \\ & \text { (Note 1) } \end{aligned}$ | $\mathrm{V}_{\text {OL }}$ | - | - | 0.4 | V | $\begin{aligned} & \mathrm{I}_{\mathrm{SINK}}=0.2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=2.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{SINK}}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V} \end{aligned}$ |
| Input Low Current (RA0-3, RC0-7) (Note 2) | ILL | - | - | 250 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DD}}=6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0.4 \mathrm{~V}$ |
| Input High Current (RA0-3, RCO-7) (Note 2) | $\mathrm{I}_{\mathrm{IH}}$ | 2 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}-0.4 \mathrm{~V}$ |
| Leakage Current (Note 3) | LC | -1 | - | 1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {PIN }} \leqslant \mathrm{V}_{\mathrm{DD}}$ |

$\dagger$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. The output pull-down transistor can be removed via a mask option to facilitate interfacing with external circuitry which has signal swings below $\mathrm{V}_{\mathrm{Ss}}$. If this is the case, the maximum voltage permitted to be applied to the pin is -12 V with respect to $\mathrm{V}_{\mathrm{DD}}$.
2. Current is being sourced by the internal pull-up resistors which are available as a mask option on ports RA0-3 and RC0-7. (RC0-7 have their pull-ups turned off when selected as outputs.)
3. This applies to ports RAO-3 and RCO-7 without the mask optional internal pull-up resistors, port RBO-7 and RC0-7 in the high impedance state, $\overline{\mathrm{RTCC}}, \overline{M C L R}$ and OSC 1.
4. Total output sink current for all output pins (including CLK OUT) must not exceed 50 mA . Total output source current must not exceed 20 mA . Maximum output sink or source current for each individual output must not exceed 10 mA .
5. Total power dissipation should not exceed 300 mW for the package. Power dissipation is calculated as follows:
$P_{D I S}=V_{D D}\left[I_{D D}-\Sigma\left(I_{I N}+I_{O H}\right)\right]+\Sigma\left(V_{D D}-V_{I N}\right)\left(I_{I N}\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H}\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$.

| PIC16C55 | INSTRUNERAL |
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Standard Conditions (unless otherwise stated):
AC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=2.5-6.0 \mathrm{~V}$ except as noted.

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Oscillator Frequency | fosc <br> fosc <br> fosc <br> fosc | $\begin{aligned} & 25 \\ & 25 \\ & 25 \\ & 25 \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & 1000 \\ & 1250 \\ & 1650 \\ & 1800 \end{aligned}$ | $\begin{aligned} & \mathrm{kHz} \\ & \mathrm{kHz} \\ & \mathrm{kHz} \\ & \mathrm{kHz} \end{aligned}$ | $\begin{aligned} & V_{D D}=2.5 \mathrm{~V} \\ & V_{D D}=3.2 \mathrm{~V} \\ & V_{D D}=5.0 \mathrm{~V} \\ & V_{D D}=6.0 \mathrm{~V} \end{aligned}$ |
| CLOCK OUT <br> Period (Instruction Cycle Time) <br> Pulse Width <br> Rise/Fall Time | $\begin{gathered} \mathrm{t}_{\mathrm{CY}} \\ \mathrm{t}_{\mathrm{CLKH}} \\ \mathrm{t}_{\mathrm{r}} / \mathrm{t}_{\mathrm{f}} \end{gathered}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | 5/fosc <br> $1 / \mathrm{f}_{\text {osc }}$ <br> - |  | $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ ns | (Note 1) <br> 1 TTL Load $+60 \mathrm{pF} \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |
| RTCC Input <br> Period <br> Pulse Width (High or Low Level) | $\begin{aligned} & t_{\text {RT }} \\ & t_{\mathrm{pw}} \end{aligned}$ | $\left\|\begin{array}{c} \mathrm{t}_{\mathrm{cr}}+0.2 \mu \mathrm{~s} \\ 500 \end{array}\right\|$ | - | - | ns | (Notes 2 and 3) |
| I/O Ports <br> Data Input Setup Time <br> Data Input Hold Time <br> Data Output Propagation Delay | $\begin{gathered} \mathrm{t}_{\mathrm{s}} \\ \mathrm{t}_{\mathrm{h}} \\ \mathrm{t}_{\mathrm{pd}} \end{gathered}$ | $-$ | $-$ | $\left\|\begin{array}{c} 1 / 5 \mathrm{t}_{\mathrm{Cr}}-300 \\ - \\ 1.6 \end{array}\right\|$ |  | $60 \mathrm{pF}+2.2 \mathrm{~K}$ to $0.8 \mathrm{~V}_{\mathrm{DD}}$ |

$\dagger_{\text {Typical data is at } T_{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$
NOTES:

1. Instruction cycle period ( $t_{c y}$ ) equals five times the input oscillator time base period.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the RTCC input, CLK OUT may be directly tied to the $\overline{\mathrm{RTCC}}$ input.
3. The maximum frequency which may be input to the $\overline{\mathrm{RTCC}}$ pin is calculated as follows:
$f_{(\text {max })}=\frac{1}{t_{R T(\text { min })}}=\frac{1}{t_{C Y(\text { mın })}+0.2 \mu \mathrm{~S}}$
For example:
if $\mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.

| INSENERAL | PIC16C55 |
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## I/O TIMING




## PIC16C55 OSCILLATOR OPTIONS (TYPICAL CIRCUITS)

RC OPTION OPERATION

$10 K \leqslant R \leqslant 1 M$.
TYPICAL VALUES
$R \geqslant 10 K$ $c \geqslant 100 \mathrm{pf}$

CRYSTAL INPUT OPERATION


EXTERNAL CLOCK INPUT OPERATION


## MASTER CLEAR



TYPICAL VALUES

$$
R=1 M
$$

$$
C=0.1 \mu \mathrm{~F}
$$

Master Clear may require up to a 75 ms delay before activation after power is applied to the $V_{D D}$ pin for a 1 MHz crystal to start up. To achieve this an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function). The RC oscillator option, shown above, should start up in less time.

## 8 Bit Microcomputer

## FEATURES

- Vectored interrupt servicing capability
- User programmable
- Intelligent controller for stand-alone applications
- 32 8-bit RAM registers
- $512 \times 12$-bit program ROM
- Arithmetic Logic Unit
- Real Time Clock/Counter
- Event counter capability
- Self-contained oscillator for RC network or crystal
- Access to RAM registers inherent in instruction
- Wide power supply operating range ( 4.5 V to 7.0 V )
- Available in two temperature ranges: $0^{\circ}$ to $70^{\circ} \mathrm{C}$ and $-40^{\circ}$ to $85^{\circ} \mathrm{C}$
- 4 inputs, 8 outputs, 8 bi-directional I/O lines
- 3 level stack for subroutine nesting
- Same PIC instruction sets as PIC1650A or PIC1655A with the addition of RETURN $\left(\mathrm{OOO}_{8}\right)$ instruction


## DESCRIPTION

The PIC1656 microcomputer is an MOS/LSI device containing RAM, I/O, and a central processing unit as well as customerdefined ROM on a single chip. This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs. Keyboard scanning, display driving, and other system control functions can be done at the same time due to the power of the 8-bit ALU.
The PIC1656 is designed for real-time control applications requiring external and internal clock-driven interrupts. The PIC1656 has 20 I/O lines organized as two 8-bit registers and the 4 LSB's of a third register.
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device The 8-bit input/output registers provide latched lınes for interfacing to a limitless variety of applications. The PIC can be used to scan keyboards, drive displays,
control electronic games and provide enhanced capabilities to vending machines, traffic lights, radios, television, consumer appliances, ındustrial tımıng and control applications The 12-bit instruction word format provides a powerful yet easy to use instruction repertoıre emphasizing single bit manıpulation as well as logical and arithmetic operations using bytes.
The PIC1656 is fabricated with N-Channel Ion Implant technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operating clock with an external crystal ceramic resonator or LC network to establish the frequency. Inputs and outputs are TTL-compatible.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling. Programs can be assembled into machine language using PICAL, elımınating the burden of coding with ones and zeros. PICAL is avaılable in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance The PIC's operation can be verified in any hardware application by using the PIC1664. The PIC1664 is a ROM-less PIC microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands. The PFD1010 Field Demo System is available containing a PIC1664 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM. With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market.
A PIC Serıes Microcomputer Data Manual is available which gives additional detalled data on PIC based system design.


| PIC1656 | INSTRUNERAN |
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## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC series microcomputer is based on a register file concept with simple yet powerful commands designed to emphasıze bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.

Internally, the PIC is composed of three functional elements connected together by a single bidirectional bus: the Register File composed of 32 addressable 8-bit registers, an Arithmetic Logic Unit, and a user-defined Program ROM composed of 512 words each 12 bits in width. The Register File is divided into two functional groups: operational registers and general registers. The operational registers include, among others, the Real Time Clock Counter Register, the Program Counter (PC), the Status Register,
and the I/O Registers. The general purpose registers are used for data and control information under command of the instructions. The Arithmetic Logic Unit contains one temporary workıng register or accumulator (W Register) and gating to perform Boolean functions between data held in the working register and any file register.
The Program ROM contains the operational program for the rest of the logic within the controller. Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs. Program control operations can be performed by Bit Test and Skip instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC. In addition, an on-chip two-level stack is employed to provide easy to use subroutine nesting. Activating the $\overline{M C L R}$ input on power up initializes the ROM program to address $777_{8}$

## PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| OSC1 (input), OSC2 (output) | Oscillator inputs. The oscillator frequency can be set by a crystal (if a precise frequency is required), ceramic resonator or LC network, or driven from an external source. |
| $\overline{\text { RT }}$ (input) | Real Time Input. Function is controlled by bits 4 and 7 of the Status Word Register (F3). A high-to-low transition of this pin will increment the RT register (event counter mode) or will initiate a vectored interrupt (external interrupt mode). |
| RA0-3 (input) | Dedicated input lines, read under direct control of the program. The 4 MSB 's are always read as logic zeroes. |
| RB0-7 (output) | Dedicated output lines, user programmable under direct control of the program. |
| RC0-7 (input/output) | User programmable input/output lines. These lines can be inputs and/or outputs and are under direct control of the program. |
| $\overline{M C L R}$ (input) | Master Clear. Used to initialize the internal ROM program to address 7778 and latch I/O registers F6 and F7 low. Also clears bits 3-7 of status register (F3). |
| CLK OUT (output) | A signal derived from the internal oscillator. Used by external devices to synchronize themselves to PIC timing. |
| TEST | Used for testing purposes only. Must be grounded for normal operation. |
| $V_{\text {D }}$ | Primary Power Supply. |
| $\mathbf{V}_{\text {ss }}$ | GND. |



| INSTRUNERAL | PIC1656 |
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## REGISTER FILE ARRANGEMENT

File
(Octal)

## Function

Not a physically implemented register. FO calls for the contents of the File Select Register (low order 5 bits) to be used to select a file register. FO is thus useful as an indirect address pointer. For example, $\mathrm{W}+\mathrm{FO} \rightarrow \mathrm{W}$ will add the contents of the file register pointed to by the FSR (F4) to the contents of W and place the result in W.
Real Time Clock Counter Register. This register can be loaded and read by the microprogram. The RTCC register keeps counting up after zero is reached. The counter increments on the falling edge of the input $\overline{\mathrm{RT}}$. However, if data are being stored in the RTCC register simultaneously with a negative transition on the RTCC pin, the RTCC register will contain the new stored value and the external transition will be ignored by the microcomputer.
Program Counter (PC). The PC is automatically incremented during each instruction cycle, and can be written into under program control (MOVWF F2). The PC is nine bits wide, but only its low order 8 bits can be read under program control.
Status Word Register. F3 can be altered under program control only via bit set, bit clear, or MOVWF F3 instruction.

| (7) | (6) | (5) | (4) | (3) | (2) | (1) | (0) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CNT | RTCR | IR | RTCE | IE | Z | DC | C |

BIT 0: Carry
(C) bit

For ADD and SUB instructions, this bit is set if there is a carry out from the most significant bit of the resultant.
For ROTATE instructions, this bit is loaded with either the high or low order bit of the source.
BIT 1: Digit Carry (DC) bit

BIT 2: Zero
(Z) bit

BITS: 3-7
For ADD and SUB instructions, this bit is set if there is a carry out from the 4th low order bit of the resultant.
Set if the result of an arithmetic operation is zero.
Interrupt Service Flags (Cleared on $\overline{M C L R}$ ).

BIT 3: Interrupt Enable (IE) status bit. When set to a one, this bit enables the external interrupt to occur when and if the interrupt request (IR) status bit (bit 5 ) is also set. When reset to a zero, the external interrupt is disabled.
BIT 4: Real Time Clock Enable (RTCE) status bit. When set to a one, this bit enables the real-time clock/counter interrupt to occur when and if the real-time clock interrupt request (RTCR) status bit (bit 6 ) is also set. When reset to a zero, the interrupt is disabled.
BIT 5: Interrupt Request (IR) status bit. This bit is set by a high-to-low transition on the $\overline{R T}$ pin, generating an interrupt request. If and when the interrupt enable (IE) bit (bit 3 ) is also set, an interrupt will occur. This causes the current PC address to be pushed onto the stack and the processor to execute the instruction at location $760_{8 .}$. The IR bit is then immediately cleared. Note that the IR bit can be set regardless of the state of the IE bit, thus requesting an interrupt which can be serviced or not at the programmer's option.
BIT 6: Real Time Clock/Counter Interrupt Request (RTCR) status bit. This bit is set when the RTCC register (File 1) transitions from a full count ( $377_{8}$ ) to a zero count $\left(\mathrm{OOO}_{8}\right)$. If and when the RTCE bit is also set, an interrupt will occur. This causes the current PC address to be pushed onto the stack and the processor to execute the instruction at location $740_{8}$. The RTCR bit is then immediately cleared. Note that the RTCR bit can be set regardless of the state of the RTCE bit, thus requesting an interrupt which can be serviced or not, at the programmer's option.

NOTE: Although the processor cannot be interrupted during an interrupt (i.e., until the RETFI instruction is executed), (an) other interrupt(s) can be requested (status bits 5 and/or 6 can be set). This will cause the processor to reinterrupt immediately upon its return from the current interrupt assuming the interrupt(s) is
(are) enabled. (Pending external interrupts have priority over pendıng real-tıme clock/counter interrupts.)
BIT 7: Count Select (CNT) status bit. When CNT bit is set to a one, the RTCC register will increment on each high-to-low transition at the $\overline{\mathrm{RT}}$ pin. If the CNT bit is sent to a zero, the RTCC register will increment at the internal clock rate ( $1 / 16$ of the frequency at the OSC pins).
File Select Register (FSR). Low order 5 bits only are used. The FSR is used in generating effective file register addresses under program control. When accessed as a directly addressed file, the upper 3 bits are read as ones.
Input Register A (A0-A3). A4-A7 defined as zeroes.
Output Register B (B0-B7)
1/O Register (C0-C7)
General Purpose Registers

## INTERRUPT LOGIC

The interrupt logic generates an interrupt request to the control unit to initıate a vectored interrupt. One of two possible interrupt requests (external interrupt request or RTCC interrupt request) can be generated. Only one interrupt at a tıme can be serviced. Nested interrupts are not possible since additional interrupts are disabled by an internal latch.
The contents of the status register indicate whether any interrupts are pending. If only one interrupt is pending, it is serviced immediately providing the interrupt is enabled (i.e., IE or RTCE is set) and the processor is not already servicing another interrupt If both external and RTCC interrupts are pending and enabled, the external interrupt has priority. If an external interrupt is input on the $\overline{R T}$ pin while another external interrupt is being serviced, a new external interrupt request will be generated to the processor which will reinterrupt immediately upon its return from the current interrupt.

## CAUTION

A return from an interrupt routine must not be executed using any other instruction but RETURN. If any other instruction is executed to restore the return address to the program counter, the interrupt logic will not be enabled. This effectively prevents any other interrupts from being serviced. If the interrupt routine contains subroutines, returns from the subroutines should be made using the RETLW instruction. If the RETURN instruction is used mistakenly, additional interrupts that occur while the first interrupt routine is in process will be enabled and can corrupt the interrupt routine in process.

## STACK

A three-level stack is provided to accommodate three return addresses. One level of the stack should be reserved to store the return address of an interrupt. The other two levels provide storage for two return addresses from a nested subroutıne.

NOTE: One level of the stack must always be available to accommodate an interrupt return address. When an interrupt occurs, the firmware automatically pushes the return address onto the stack. Should three subroutines be nested, the return address of the current subroutine will be destroyed. Only if the PIC1656 is not programmed for interrupts is it permissible to use all three levels of the stack for subroutines.

| PIC1656 | GENERAL |
| :---: | :---: |

## RTCC REGISTER

The RTCC register (F1), in conjunction with the status register, is programmable for internal clock or $\overline{\mathrm{RT}}$ clock operation
Bit 7 of the status register, when set to a one, selects the $\overline{R T}$ pin as the clocking source and, when reset to a zero, selects the internal clock as the clocking source. When the RTCC register transitions from a count of $377_{8}$ to a count of $000_{8}$, bit 6 (RTCR) of the status register sets to a one, requesting a real-time clock interrupt. An interrupt to $740_{8}$ is generated if RTCE (bit 4 ) is set.
The RTCC register can be preset and read under program control at any time. If the RTCC register is not used as a counter, it can be used as a general-purpose data register provided the $\overline{\mathrm{RT}}$ pin is tied low and CNT is set to a one. (Note MCLR resets CNT.)

## I/O REGISTERS (F5-F7)

The I/O interface consists of three I/O registers controlling 20 input/output lines. These registers (A, B, and C) are addressable as F5 through F7, respectively. Register A (F5) controls four dedicated non-latching input lines Register B (F6) controls eight dedicated latched output lines, and register C (F7) controls eight bidirectional input/output lines. As with the PIC1655A, register file $F-10$, which in the PIC1650A was I/O register $D$, is an additional general purpose register in the PIC1656.

## CLOCK GENERATOR

The internal timing rate of the PIC1656 is controlled by an external control source connected across two input pins, OSC 1 and OSC 2. This may be established by an RC network (RC control) connected across the OSC 1 and OSC 2 pins or by a non-buffered external crystal connected across the OSC 1 and OSC 2 pins.
The PIC1656 clock generator divides the frequency at the OSC 1 and OSC 2 pins by 16 to derive the internal machine cycle rate. $A$ 4 MHz frequency at the OSC 1 and OSC 2 pins will result in a $4 \mu \mathrm{~s}$ $(0.25 \mathrm{MHz})$ instruction cycle. This enables the use of a low-cost standard 3.58 MHz crystal to provide a machine cycle of approximately $4 \mu \mathrm{~s}$. Figure 14 illustrates both the crystal and RC input configurations to the OSC 1 and OSC 2 input pins.

| INTRENERAL | PIC1656 |
| :---: | :---: |

## Basic Instruction Set Summary

Each PIC instruction is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " $f$ " represents a file register designator and " $d$ " represents a destınation designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed If "d" is zero, the result is placed in the
BYTE-ORIENTED
FILE REGISTER
OPERATIONS

PIC W register. If "d" is one, the result is returned to the file register specified in the instruction
For bit-oriented instructions, " $b$ " represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located
For literal and control operations, " $k$ " represents an eight or nine bit constant or iiteral value.
For an oscillator frequency of 4 MHz the instruction execution time is $4 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $8 \mu \mathrm{sec}$.

| $(11-6)$ | (4) | (4) |
| :---: | :---: | :---: |
| OP CODE | $d$ | f (FILE \#) |

For $d=0, f \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic) $d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$.)


## NOTES:

1. The 9th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an I/O register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.
3. See notes on input only and output only ports (F5 and F6, respectively).

| PIC1656 | INSTRUMERAL |
| :---: | :---: |

## SUPPLEMENTAL INSTRUCTION SET SUMMARY

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).

| Instruction-Binary (Octal) |  |  |  |  | Name | Mnemonic, Operands | Equivalent Operation(s) | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 010 | 000 | 000 | 011 | (2003) |  |  | BCF 3, 0 | - |
| 010 | 100 | 000 | 011 | (2403) | Set Carry | SETC | BSF 3, 0 | - |
| 010 | 000 | 100 | 011 | (2043) | Clear Digit Carry | CLRDC | BCF 3, 1 | - |
| 010 | 100 | 100 | 011 | (2443) | Set Digit Carry | SETDC | BSF 3, 1 | - |
| 010 | 001 | 000 | 011 | (2103) | Clear Zero | CLRZ | BCF 3, 2 | - |
| 010 | 101 | 000 | 011 | (2503) | Set Zero | SETZ | BSF 3, 2 | - |
| 011 | 100 | 000 | 011 | (3403) | Skip on Carry | SKPC | BTFSS 3, 0 | - |
| 011 | 000 | 000 | 011 | (3003) | Skip on No Carry | SKPNC | BTFSC 3, 0 | - |
| 011 | 100 | 100 | 011 | (3443) | Skip on Digit Carry | SKPDC | BTFSS 3, 1 | - |
| 011 | 000 | 100 | 011 | (3043) | Skip on No Digit Carry | SKPNDC | BTFSC 3, 1 | - |
| 011 | 101 | 000 | 011 | (3503) | Skip on Zero | SKPZ | BTFSS 3, 2 | - |
| 011 | 001 | 000 | 011 | (3103) | Skip on No Zero | SKPNZ | BTFSC 3, 2 | - |
| 001 | 000 | 1 ff | $f \mathrm{ff}$ | (1040) | Test File | TSTF f | MOVF f, 1 | Z |
| 001 | 000 | 0 ff | ffif | (1000) | Move File to W | MOVFW $\ddagger$ | MOVF f, 0 | Z |
| 001 001 | 001 | $1 f f$ $d f f$ | $f f f$ $f f f$ | (1140) <br> (1200) | Negate File | NEGF f,d | COMF f, 1 <br> INCF f, d | Z |
| 011 001 | 000 010 | 000 $d f f$ | $\begin{aligned} & 011 \\ & \mathrm{f} f \end{aligned}$ | $\begin{aligned} & (3003) \\ & (1200) \end{aligned}$ | Add Carry to File | ADDCF f, d | BTFSC 3,0 <br> INCF f, d | Z |
| 011 000 | 000 011 | 000 $d f f$ | $\begin{aligned} & 011 \\ & \mathrm{ff} f \end{aligned}$ | $\begin{aligned} & (3003) \\ & (0300) \end{aligned}$ | Subtract Carry from File | SUBCF f,d | $\begin{aligned} & \text { BTFSC } 3,0 \\ & \text { DECF f, d } \end{aligned}$ | Z |
| 011 001 | 000 | 100 $d f f$ | $\begin{array}{ll} 011 \\ f f f \end{array}$ | $\begin{aligned} & (3043) \\ & (1200) \end{aligned}$ | Add Digit Carry to File | ADDDCF f,d | BTFSG 3,1 <br> INCF f,d | Z |
| 011 000 | 000 011 | 100 $d f f$ | 011 $f f f$ | $\begin{aligned} & (3043) \\ & (0300) \end{aligned}$ | Subtract Digit Carry from File | SUBDCF f,d | $\begin{aligned} & \text { BTFSC } 3,1 \\ & \text { DECF f,d } \end{aligned}$ | Z |
| 101 | kkk | kkk | kkk | (5000) | Branch | B k | GOTO k | - |
| 011 101 | 000 $k k k$ | 000 $k k k$ | 011 $k k k$ | (3003) $(5000)$ | Branch on Carry | BC k | $\begin{aligned} & \text { BTFSC 3,0 } \\ & \text { GOTO k } \end{aligned}$ | - |
| 011 101 | 100 $k k k$ | 000 $k k k$ | 011 $k k k$ | $\begin{aligned} & (3403) \\ & (5000) \end{aligned}$ | Branch on No Carry | BNC k | $\begin{aligned} & \text { BTFSS } 3,0 \\ & \text { GOTO k } \end{aligned}$ | - |
| 011 101 | 100 $k k k$ | 100 $k k k$ | 011 | (3043) $(5000)$ | Branch on Digit Carry | BDC k | $\begin{aligned} & \text { BTFSC } 3,1 \\ & \text { GOTO k } \end{aligned}$ | - |
| 011 10.1 | 001 $k k k$ | 000 $k k k$ | 011 $k k k$ | (3443) (5000) | Branch on No Digit Carry | BNDC k | $\begin{aligned} & \text { BTFSS } 3,1 \\ & \text { GOTO k } \end{aligned}$ | - |
| 011 101 | 101 $k k k$ | 000 $k k k$ | 011 $k k k$ | (3103) (5000) | Branch on Zero | BZ k | $\begin{aligned} & \text { BTFSC 3,2 } \\ & \text { GOTO k } \end{aligned}$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | $\begin{aligned} & 101 \\ & k k k \end{aligned}$ | $\begin{aligned} & 000 \\ & k k k \end{aligned}$ | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | (3503) <br> (5000) | Branch on No Zero | BNZ K | $\begin{aligned} & \text { BTFSS 3,2 } \\ & \text { GOTO k } \end{aligned}$ | - |

## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of an open collector TTL device (PIC is inputting). Each I/O port bit can be individually time multıplexed between input and output functions under software control When outputting thru a PIC I/O Port, the data is latched at the port and the pin
can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port latch must first be set to a high level under program control. This turns off $Q_{2}$, allowing the TTL open collector device to drive the pad, pulled up by $Q_{1}$, which can source a minimum of $100 \mu \mathrm{~A}$. Care, however, should be exercised when using open collector devices due to the potentially high TTL leakage current which can exist in the high logic state


## Bidirectional I/O Ports

The bidırectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten For use as an input port the output latch must be set in the high state. Thus the external device inputs to the PIC circuit by forcing the latched output line to the low state or keeping the latched output high. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result. Caution must be used when using these instructions. As an example a BSF operation on bit 5 of F7 (port RC) will cause all eight bits of F7 to be read into the CPU. Then the BSF operation takes place on bit 5 and F7 is re-output to the output latches. If another bit of F7 is used as an input (say bit 0 ) then bit 0 must be latched high If during the BSF instruction on bit 5 an external device is forcing bit 0 to the low state then the input/output nature of the BSF instruction will leave bit 0 latched low after execution. In this state bit 0 cannot be used as an input until it is again latched high by the programmer. Refer to the examples below.

## Input Only Port: (Port RA)

The input only port of the PIC1656 consists of the four LSB's of F5 (port RA). An internal pull-up device is provided so that external pull-ups on open collector logic are unnecessary. The four MSB's of this port are always read as zeroes. Output operations to F5 are not defined. Note that the BTFSC and BTFSS instructions are input only operations and so can be used with F5. Also, file register instructions which leave the results in $W$ can be used.

## Output Only Port: (Port RB)

The output only port of the PIC1656 consists of F6 (port RB). This port contains no input circuitry and is therefore not capable of instructions requiring an input followed by an output operation. The only instructions which can validly use F6 are MOVWF and CLRF.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $t_{p d}$ (See $1 / O$ Timing Diagram) is greater than $1 / 4 t_{c y}(\mathrm{~min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

## EXAMPLE 1:



What is thought to be happening:
BSF 7,5

| Read into CPU: | 00001111 |
| :--- | :--- |
| Set bit 5: | 00101111 |
| Write to F7: | 00101111 |

If no inputs were low during the instruction execution, there would be no problem.

## EXAMPLE 2:



What could happen if an input were low: BSF 7,5

| Read into CPU: | 00001110 |
| :--- | :--- |
| Set bit 5: | 00101110 |
| Write to F7: | 00101110 |

In this case bit 0 is now latched low and is no longer useful as an input until set high again.

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
Ambient temperature Under Bias . . . . . . . . . . . . . . . . . . . . . . . . $125^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} . . . . . . . . . . . . . . . ~-0.3 \mathrm{~V}$ to +12.0 V
Power Dissipation (Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1000mW
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS/PIC1656
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Primary Supply Current | $I_{\text {DD }}$ | - | 30 | 55 | mA | All I/O pins high |
| Input Low Voltage | $\mathrm{V}_{\mathrm{IL}}$ | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except MCLR, $\overline{R T}$ \& OSC1) | $\mathrm{V}_{\mathrm{iH1}}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input High Voltage (RT \& OSC1) | $\mathrm{V}_{1 \mathrm{H} 2}$ | $\mathrm{V}_{\mathrm{D}}{ }^{-1}$ | - | $\mathrm{V}_{\mathrm{DD}}$ | V |  |
| Input Low-to-High Threshold Voltage (MCLR) | $\mathrm{V}_{\text {ILH }}$ | $V_{D D}-1$ | 2.6 | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 2.4 \\ & 3.5 \end{aligned}$ | - | $\begin{aligned} & V_{D D} \\ & V_{D D} \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 2) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (1/O only) | $\mathrm{V}_{\text {OLI }}$ | - | - | $\begin{aligned} & \hline 0.45 \\ & 0.90 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline \mathrm{V} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=4.5 \mathrm{~V} \text { (Note 3) } \end{aligned}$ |
| Output Low Voltage (CLK OUT) | $\mathrm{V}_{\mathrm{OL2}}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{LL}}=1.6 \mathrm{~mA}$ (Note 3) |
| Input Leakage Current (MCLR, RT \& OSC1) | ILC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\text {DD }}$ |
| Output Leakage Current (open drain I/O pins) | IOLC | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {PIN }} \leqslant 10 \mathrm{~V}$ |
| Input Low Current (all I/O ports) | $\mathrm{I}_{11}$ | -0.2 | -0.6 | -1.6 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{H}}$ | -0.1 | -0.4 | -1.4 | mA | $\mathrm{V}_{\mathrm{HH}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows:
$P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{I L}\right)\left(\left|I_{I L}\right|\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H} \mid\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$.
The term I/O refers to all interface pins; input, output or I/O.
2. Positive current indicates current into pin. Negative current indicates current out of pin.
3. Total $I_{O L}$ for all output pins (I/O ports plus CLK OUT) must not exceed 225 mA .

| INSTRUERENT | PIC1656 |
| ---: | :---: |

DC CHARACTERISTICS/PIC1656I
Operating Temperature $T_{A}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Primary Supply Current | $I_{\text {DD }}$ | - | 30 | 60 | mA | All I/O pins high |
| Input Low Voltage | $\mathrm{V}_{\text {IL }}$ | -0.2 | - | 0.7 | V |  |
| Input High Voltage (except MCLR, $\overline{R T}$ \& OSC1) | $\mathrm{V}_{\mathrm{H} 1}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input High Voltage (RT \& OSC1) | $\mathrm{V}_{1 \mathrm{H}_{2}}$ | $\mathrm{V}_{\mathrm{DD}}{ }^{-1}$ | - | $V_{D D}$ | v |  |
| Input Low-to-High Threshold Voltage (MCLR) | $\mathrm{V}_{\mathrm{ILH}}$ | $V_{D D}-1$ | 2.6 | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 2.4 \\ & 3.5 \end{aligned}$ | - | $\begin{aligned} & \hline V_{D D} \\ & V_{D D} \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline \mathrm{V} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 2) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (I/O only) | $\mathrm{V}_{\mathrm{OL} 1}$ | - | - | $\begin{aligned} & 0.45 \\ & 0.90 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=4.5 \mathrm{~V} \text { (Note 3) } \end{aligned}$ |
| Output Low Voltage (CLK OUT) | $\mathrm{V}_{\mathrm{OL} 2}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{LL}}=1.6 \mathrm{~mA}$ (Note 3) |
| Input Leakage Current ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RT}}$ \& OSC1) | ILC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\text {DD }}$ |
| Output Leakage Current (open drain I/O pins) | IOLC | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {PIN }} \leqslant 10 \mathrm{~V}$ |
| Input Low Current (all I/O ports) | $\mathrm{I}_{1}$ | -0.2 | -0.6 | -1.8 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{H}}$ | -0.1 | -0.4 | -1.8 | mA | $\mathrm{V}_{\mathrm{iH}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows:
$P_{D}=\left(V_{D D}\right)+\Sigma\left(V_{D D}-V_{L L}\right)\left(I_{I U}\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H}\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right)$.
The term I/O refers to all interface pins; Input, Output or I/O.
2. Positive current indicates current into pin. Negative current indicates current out of pin.
3. Total $\mathrm{I}_{\mathrm{OL}}$ for all output pins (I/O ports plus CLK OUT) must not exceed 225 mA .

Standard Conditions (unless otherwise stated):
AC CHARACTERISTICS/PIC1656, PIC1656I
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ (PIC1656), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ (PIC1656I)

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | ${ }^{\text {t }} \mathrm{CY}$ | 4 | - | 20 | $\mu \mathrm{s}$ | $0.8 \mathrm{MHz}-4.0 \mathrm{MHz}$ external time base (Note 1) |
| RT Input <br> Period <br> High Pulse Width <br> Low Pulse Width | $\begin{gathered} t_{\mathrm{RT}} \\ \mathrm{t}_{\mathrm{RTH}} \\ \mathrm{t}_{\mathrm{RTL}} \end{gathered}$ | $\left\|\begin{array}{c} \mathrm{t}_{\mathrm{CY}}+0.2 \mu \mathrm{~s} \\ 1 / 2 \mathrm{t}_{\mathrm{RT}} \\ 1 / 2 \mathrm{t}_{\mathrm{RT}} \end{array}\right\|$ |  |  | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | (Notes 2 and 3) |
| I/O Ports <br> Data Input Setup Time <br> Data Input Hold Time <br> Data Output Propagation Delay | $\begin{aligned} & t_{s} \\ & t_{\mathrm{n}} \\ & \mathrm{t}_{\mathrm{pd}} \end{aligned}$ | - |  | $\left.\right\|^{1 / 4 \mathrm{t}_{\mathrm{cr}}-125}-$ | ns ns ns | Capacitive load $=50 \mathrm{pF}$ |
| OSC 1 Input <br> External Input Impedance High <br> External Input Impedance Low | $\mathrm{R}_{\mathrm{OSCH}}$ <br> $\mathrm{R}_{\mathrm{OSCL}}$ | - | $\begin{aligned} & 10^{6} \\ & 10^{6} \end{aligned}$ | - | $\begin{aligned} & \Omega \\ & \Omega \end{aligned}$ | $\left.\begin{array}{l} V_{O S C}=V_{D D}=5 \mathrm{~V} \\ V_{\text {OSC }}=0.4 \mathrm{~V} \end{array}\right\} \begin{aligned} & \text { Applies to external } \\ & \text { OSC drive only. } \end{aligned}$ |

## NOTES:

1. Instruction cycle period $\left(\mathrm{t}_{\mathrm{cy}}\right)$ equals sixteen times the input oscillator time base period.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the $\overline{\operatorname{RT}}$ input, CLK OUT may be directly tied to the $\overline{R T}$ input.
3. The maximum frequency which may be input to the $\overline{\mathrm{RTCC}}$ pin is calculated as follows: $f_{(\text {max })}=\frac{1}{\mathrm{t}_{\mathrm{RT}(\text { min })}}=\frac{1}{\mathrm{t}_{\mathrm{CY}(\text { min })}+0.2 \mu \mathrm{~s}}$
For example: if $\mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\text {max })}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.

## I/O TIMING



SCHMITT TRIGGER CHARACTERISTICS ( $\overline{\text { RTCC }}, \overline{\text { MCLR }}$ and OSC PINS) $\mathrm{T}_{\mathrm{A}}=\mathbf{2 5} \mathbf{2}^{\circ} \mathrm{C}$ (TYPICAL)


NOTES:

1. Low-to-High Threshold Voltage ( $\mathrm{V}_{\text {TLH }}$ ).
2. High-to-Low Threshold Voltage ( $\mathrm{V}_{\text {THL }}$ ).


## PIC1656 OSCILLATOR OPTIONS (Typical Circuits)

LC INPUT OPERATION


$$
\begin{gathered}
f_{\text {OSC }} \approx \frac{1}{2 \pi \sqrt{L\left(C_{L}+C_{I N T}\right)}} \\
\text { where } C_{I N T}=10 \mathrm{pF} . \\
\text { Typical values for } 4 \mathrm{MHz} \text { operation. } \\
L=70 \mu \mathrm{H} \\
C_{L}=10 \mathrm{pF}
\end{gathered}
$$

CRYSTAL INPUT OPERATION


* or ceramic resonator,


## EXTERNAL CLOCK INPUT OPERATION



## MASTER CLEAR (TYPICAL CIRCUIT)



Master Clear requires $>1.0 \mathrm{~ms}$ delay before activation after power is applied to the $V_{D D} p i n$, for the oscillator to start up To achieve this, an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function).

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the $V_{x x}$ supply and the output load This chart shows the typical curves used to express the output drive capability

## $\mathbf{V}_{\text {OH }}$ VS $I_{\text {OH }}$ (I/O PORTS) (TYPICAL)



POWER SUPPLY CURRENT VS TEMPERATURE (TYPICAL LIMITS)



## POWER DISSIPATION DERATING GRAPH



NOTES:

1. $70^{\circ} \mathrm{C}$ is the maximum operating temperature for standard parts.
$2.85^{\circ} \mathrm{C}$ is the maximum operating temperature for " $I$ " suffix parts.

## PIC1656 EMULATION CAUTIONS

When emulating a PIC1656 using a PICES II development system certain precautions should be taken.
A. Be sure that the PICES II Module being used is programmed for the PIC1656 mode. (Refer to PICES II Manual). The PIC1664 contained within the module should have the MODE pin \#22 set to a low state.

1. This causes the $\overline{M C L R}$ to register F 5 high and register $\mathrm{F6}$, and F7 low.
2. The OSC becomes a two input clock (pins 1 \& 28).
3. The interrupt system becomes enabled and the RT always counts on the trailing edges.
4. Bits 3 through 7 on file register F3 are used for interrupt service.
B. Three levels of stack can be used within the program. If interrupts are used, allow one level of the stack for interrupt servicing. C. Make sure all I/O cautions contained in this spec sheet are used.
D. Be sure to use the 28 pin socket for the module plug.
E. Make sure that during an actual application that the MCLR input swings from a low to high level a minimum of 1 msec after the supply voltage is applied.
F. The cable length and internal variations may cause some parameter values to differ between the PICES II module and a production PIC1656.

## PIC1670

## 8 Bit Microcomputer

## FEATURES

- $1024 \times 13$-bit Program ROM
- $64 \times 8$-bit RAM ( 16 special purpose registers)
- Arithmetic Logic Unit
- Sophisticated interrupt structure
- 6 level pushdown stack
- Versatile self contained oscillator
- $2.0 \mu \mathrm{~s}$ instruction execution time
- Wide power supply operating range (4.5-5.5 volts)
- 4 sets of 8 user defined TTL compatible I/O lines
- Available in two temperature ranges: $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ and $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.


## DESCRIPTION

The PIC1670 microcomputer is an MOS/LSI device containing RAM, I/O, and a central processing unit as well as customerdefined ROM on a single chip. This combination produces a low cost solution for applications which require sensing individual inputs and controlling individual outputs. Keyboard scanning, display driving, and system control functions can be done at the same time due to the power of the 8 -bit CPU.
The internal ROM contains a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device. The 8-bit input/output registers provide latched lines for interfacing to a limitless variety of applications. The PIC can be used to scan keyboards, drive displays, control electronic games and provide enhanced capabilities to vending machines, traffic lights, radios, television, consumer appliances, industrial timing and control applications. The 13-bit instruction word format provides a powerful yet easy to use
instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC1670 is fabricated with N-Channel Silicon Gate technology resulting in a high performance product. Only a single wide range power supply is required for operation. An on-chip oscillator provides the operating clock with either an external crystal or RC network to establish the frequency. Inputs and outputs are. TTL-compatible, with open-drain option available.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling. Programs can be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PIC's operation can be verified in any hardware application by using the PIC1665. The PIC1665 is a ROM-less PIC 1670 microcomputer with additional pins to connect external PROM or RAM and to accept HALT commands. The PFD 1020 Field Demo System is available containing a PIC1665 with sockets for erasable PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with emulation and debugging capability in either a stand-alone mode or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM. With these development tools, the user can quickly and confidently order the masking of the PIC's ROM and bring his application into the market.
$\square$

## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC1670 microcomputer is based on a register file concept with simple yet powerful instruction commands designed to optimize the code for bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.

Internally, the functional blocks of the PIC1670 are connected by an 8-bit bidirectional bus: the 648 -bit registers of which the first 16 are special purpose, an Arithmetic Logic Unit, and a user defined program ROM composed of $1024 \times 13$ words. The register file is divided into two functional groups: operational registers and general purpose registers. The first sixteen are the operational registers and they include the Real Time Clock Counter A and B, four I/O registers, two Status registers, a Program Counter and a File Select Register. The general purpose registers are used for data and control information under command of the instructions.

The Arithmetic Logic Unit contains one temporary working register (W Register), an adder, and hardware for decimal adjust. Manipulation between data in the working register and any other register can be performed.
The Program ROM contains the user defined application program and is supported by an instruction decoder and instruction register. Sequencing of microinstructions is controlled via the Program Counter ( PC ) which automatically increments to execute in-line programs. The Program Counter is modified by bit test, jump, call or branch instructions and the lower 8-bits can be modified for computed addresses by file register instructions. In addition, an on-chip six level stack is employed to push and pull the contents of the program counter. This provides easy to use subroutine nesting. Activating the MCLR input on power-up initializes the ROM program to address 1777 $_{8}$

## PIN FUNCTIONS

| Signai | Function |
| :---: | :---: |
| OSC1 (input), OSC2 (output) | Oscillator pins. The on-board oscillator can be driven by an external crystal, ceramic resonator or LC network, or an external clock via these pins. |
| $\overline{\text { RT }}$ (input) | Real Time Input. Negative transitions on this pin increment the RTCC (F6) register. This pin can also be used for an interrupt input. This pin uses a Schmitt trigger input. There is no internal active pull-up device. |
| RA0-7, RB0-7, RC0-7, RD0-7 | User programmable input/output lines. These lines can be used as inputs and/or outputs and are under direct control of the program. |
| $\overline{M C L R}$ (Input) | Master Clear. Used to initialize the internal ROM program to address $1777_{8}$, latch all I/O registers high, and disables the interrupts. This pin uses a Schmitt trigger input. There is no internal active pull-up device. |
| TEST | Test pin. This pin is used for testing purposes only. It must be grounded for normal operation. |
| $V_{\text {D }}$ | Power supply pin. |
| $\mathrm{V}_{\text {ss }}$ | Ground pin. |
| CLKOUT | Clock Output. A signal derived from the internal oscillator. May be used by external circuitry to synchronize with PIC1670 timing. |

## PIN CONFIGURATION 40 LEAD DUAL IN LINE

| Top View |  |
| :---: | :---: |
| OSC1 $\square^{\bullet 1}$ | $40 \square \mathrm{~V}_{00} \leftarrow$ |
| $\leftarrow$ OSC2 $\mathrm{H}_{2}$ | $39 \square \overline{\text { MCLR }}<$ |
| $\leftrightarrow$ RAO ${ }^{3}$ |  |
| $\leftrightarrow$ RA1 ${ }^{4}$ | 37 R RD7 $\longleftrightarrow$ |
| $\longleftrightarrow$ RA2 ${ }^{5}$ | $36 \mathrm{RD6} \longleftrightarrow$ |
| $\longleftrightarrow$ RA3 ${ }^{6}$ | $35] \mathrm{RD} 5 \longleftrightarrow$ |
| $\leftarrow$ CLKOUT - 7 | $34 \square \mathrm{RD} 4 \longleftrightarrow$ |
| $\leftrightarrow$ RA4 ${ }^{\text {d }} 8$ | $33 \mathrm{PRD3} \longleftrightarrow$ |
| $\longleftrightarrow$ RA5 ${ }^{\text {a }}$ | $32] \mathrm{RD} 2 \longleftrightarrow$ |
| $\leftrightarrow$ RA6 ${ }^{10}$ | $31 \square \mathrm{RD1}$ ¢ |
| $\leftrightarrow$ RA7 11 | $30 \mathrm{RDO} \longleftrightarrow$ |
| $\leftrightarrow$ RB0 ${ }^{12}$ | $29 . \mathrm{RC7} \leftrightarrows$ |
| $\longleftrightarrow$ RB1-13 | 28 ®RC6 $\longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RB2} \mathrm{Cl}_{14}$ | 27 R RC5 $\longleftrightarrow$ |
| $\longleftrightarrow$ RB3 15 | $26] \mathrm{RC} 4 \longleftrightarrow$ |
| $\leftrightarrow$ RB4 16 | $25]$ RC3 $\longleftrightarrow$ |
| $\leftrightarrow$ RB5 17 | 24 - $\mathrm{RC} 2 \longleftrightarrow$ |
| $\leftrightarrow \mathrm{RB6}-18$ | $23 \square \mathrm{RC} 1 \longleftrightarrow$ |
| $\leftrightarrow$ RB7 - 19 | 22 RCO $<$ |
| $\longrightarrow \mathrm{Vss}^{\text {- }} 20$ | $21 \sim T E S$ |


| PIC1670 | INSTRUNERANT |
| :---: | :---: |

## REGISTER FILE ARRANGEMENT



## Basic Instruction Set Summary

Each PIC instruction is a 13 -bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " f " represents a file register designator and " $d$ " represents a destination designator. The file register designator specifies which one of the PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the PIC W register. If
" $d$ " is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value.
For an oscillator frequency of 4 MHz the instruction execution time is $2.0 \mu \mathrm{sec}$ unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $4.0 \mu \mathrm{sec}$.


|  |  |  |  |  |  |  | (12-6) |  | 0) |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  | OP CODE |  | E \#) |  |  |  |  |  |  |
|  | ruction | - Binary | Octal) |  |  |  | Name |  |  |  | Mnemon | nic, Operands | Operation |  | Status Affected |
| 1 | 000 | 000 | 1 f 1 | 1 | f | (10000) | Move file to W |  |  |  | MOVFW | f | - W |  | z |
| , | 000 | 001 | 191 | 1 | 19 | (10100) | Clear file |  |  |  | CLRF | i | 0-1 |  | z |
| 1 | 000 | 010 | 119 | 1 | f | (10200) | Rotate file right/ | carry |  |  | RRNCF | 1 | $f(\mathrm{n}) \rightarrow \mathrm{d}(\mathrm{n}-1)$ | f(0), $-f(7)$ | - |
| 1 | 000 | 011 | 111 | 1 | 1 f | (10300) | Rotate file left/no | arry |  |  | RLNCF | f | $f(\mathrm{n}) \rightarrow \mathrm{d}(\mathrm{n}+1)$ | f(7), $-f(0)$ | - |
| 1 | 000 | 100 | $1 f 1$ | 1 | 1 f | (10400) | Compare file to | skıp | < W |  | CPFSLT | f | f-W. Skip if | $\mathrm{C}=0$ | - |
| 1 | 000 | 101 | 119 | 19 | 1 f | (10500) | Compare file to | skıp | $F=W$ |  | CPFSEQ | O | f-W, Skıp if | $\underline{z}=1$ | - |
| 1 | 000 | 110 | 119 |  | 11 | (10600) | Compare file to | skıp | > W |  | CPFSGT | T | f -W. Skip if | $\bar{Z} \cdot C=1$ | - |
| 1 | 000 | 111 | 111 | 19 | f 1 | (10700) | Move file to itsel |  |  |  | TESTF | - | $t \rightarrow f$ |  | z |
| BIT ORIENTED FILE REGISTER OPERATIONS |  |  |  |  |  |  | (12-9) |  | (8-6) |  |  | (5-0) |  |  |  |
|  |  |  |  |  |  |  | OP CODE |  |  | (BIT \#) |  | f (FILE \#) |  |  |  |
| Instruction-Binary (Octal) |  |  |  |  |  |  | Name |  |  |  | Mnemonic, Operands |  | Operation |  | Status Affected |
| 0 | 100 | bbb | fif |  | 19 | (04000) | Bit clear file |  |  |  | $\overline{B C F}$ | f.b | 0-f(b) |  | - |
| 0 | 101 | $b b b$ | fif |  | 1 | (05000) | Bit set file |  |  |  | BSF <br> BTFSC | f.b | 1-f(b) |  | - |
| 0 | 110 | bbb |  |  | 19 | (06000) | Bit test skıp if clear |  |  |  |  | f.b | Bit Test f(b) | skip if clear | - |
| 0 | 111 | bbb | 1 ff | 1 | 1 | (07000) | Bit test. skip if set |  |  |  | BTFSS | $f \mathrm{~b}$ | Bit Test $f(\mathrm{~b})$ | skip if set | - |


| LITERAL AND CONTROL OPERATIONS |  |  |  |  |  | (12-8) |  | (7-0) |  | Operation | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | OP CODE |  | RAL) |  |  |  |
| Instruction-Binary (Octal) |  |  |  |  |  | Name |  | Mnemonic, Operands |  |  |  |
| 0 | 000 | 000 | 000 | 000 | (00000) | No Operation |  | NOP | - | - | - |
| 0 | 000 | 000 | 000 | 001 | (00001) | Halt in PIC1665 |  | HALT | - | - | - |
| 0 | 000 | 000 | 000 | 010 | (00002) | Return from int |  | RETFI | - | Stack - PC | - |
| 0 | 000 | 000 | 000 | 011 | (00003) | Return from Sub |  | RETFS | - | Stack - PC | - |
| 1 | 001 | 0 kk | k k k | k k k | (11000) | Move Literal to |  | MOVLW | k | $k \div w$ | - |
| 1 | 001 | 1 kk | kkk | kkk | (11400) | Add Literal to W |  | ADDLW | k | $k+W-W$ | OV.C.DC.z |
| 1 | 010 | 0kk | kkk | kkk | (12000) | Inclusive OR Lit |  | IORLW | k | kVW-W | z |
| 1 | 010 | 1 kk | kkk | kkk | (12400) | And Literal and |  | ANDLW | k | k.w-w | z |
| 1 | 0111 | 0 kk | kkk | kkk | (13000) | Exclusive OR Li |  | XORLW | k | $k \oplus W-W$ | z |
| 1 | 011 | 1 kk | k k k | k $k$ k | (13400) | Return and load |  | RETLW | k | $k \rightarrow$ W. Stack $\rightarrow$ PC | - |



## NOTE:

DAW Decimal Adjust W
This instruction adjusts the eight bit number in the W register to form two valid BCD (binary coded decimal) digits, one in the lower and one in the upper nibble. (The results will only be meaningful if the number in $W$ to be adjusted is the result of adding together two valid two digit $B C D$ numbers.)
The adjustment obeys the following two step algorithm.
1 If the lower nibble is greater than 9 or the digit carry flag (DC) is set, 06 is added to the $W$ register.
2 Then, if the upper nibble is greater than 9 or the carry from the original or step 1 addition is set, 60 is added to the $W$ register The carry bit is set if there is a carry from the original, step 1 or step 2 addition.

## INTERRUPT SYSTEM

The interrupt system of the PIC1670 is comprised of an external interrupt and a real-time clock counter interrupt. These have different interrupt vectors, enable bits and status bits. Both interrupts are controlled by the status register (F5)** shown below.

| NOT USED | CNTE | A/B | CNTS | RTCIR | XIR | RTCIE | XIE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $7^{*}$ | 6 | 5 | 4 | 3 | 2 | 1 | 0 |

*Bit 7 is unused and is read as zero.
**Register 5 will power up to all zeroes.

## EXTERNAL INTERRUPT

On any high to low transition of the $\overline{R T}$ pin the external interrupt request (XIR) bit will be set. This request will be serviced if the external interrupt enable (XIE) bit is set or if it is set at a later point in the program. The latter allows the processor to store a request (without interrupting) while a critical timing routine is being executed. Once external interrupt service is initiated, the processor will clear the XIR bit, delay one cycle (to execute the current instruction), then push the current program counter onto the stack and execute the instruction at location $1760_{8}$. It takes three to four instruction cycles from the transition on the $\overline{R T}$ pin until the instruction at $1760_{8}$ is executed. No new interrupts can be serviced until a return from interrupt (RETFI) instruction has been executed.

## REAL-TIME CLOCK INTERRUPT

The real-time clock counter (RTCCA \& RTCCB, file registers F6 and F7) have a similar mechanism of interrupt service. The RTCCA register will increment if the count enable (CNTE) bit is set. If this bit is not set the RTCCA \& RTCCB will maintain their present contents and can therefore be used as general purpose

| PIC1670 | INSTRUMERAT |
| :---: | :---: |

RAM registers. The count source (CNTS) bit selects the clocking source for RTCCA. If CNTS is cleared to a ' 0 ', then RTCCA will use the internal instruction clock and increment at $1 / 8$ the frequency present on the OSC pins. If CNTS is set to a ' 1 ', then RTCCA will increment on each high to low transition of the RT pin. RTCCB can only be incremented when RTCCA makes a transition from $377_{8}$ to 0 and the $A / B$ status bit is set. This condition links the two eight bit registers together to form one sixteen bit counter. An interrupt request under these conditions will occur when the combined registers make a transition from $177777_{8}$ to 0 . If, however, the A/B bit is not set, then RTCCA will be the only incrementing register and an interrupt request will occur when RTCCA makes a transition from $377_{8}$ to 0 . (In this setup the RTCCB register will not increment and can be used as a general purpose RAM register.) Once a request has come from the real-time clock counter, the real-time clock interrupt request (RTCIR) bit will be set. At this point, the request can either be serviced immediately if the realtime clock interrupt enable (RTCIE) bit is set or be stored if RTCIE is not set. The latter allows the processor to store a real-time clock interrupt while a critical timing routine is being executed. Once interrupt service is initiated, the processor will clear the RTCIR bit, delay one cycle (to execute the current instruction), then push the present program counter onto the stack and execute the instruction at location $1740_{8}$ It takes three instruction cycles from when the RTCC ( $A$ or $B$ ) overflows until the instruction of 1740 is executed. No new interrupts can be serviced until a RETFI instruction has been executed.
The RETFI instruction $\left(00002_{8}\right)$ must be used to return from any interrupt service routine if any pending interrupts are to be serviced. External interrupts have priority over RTCC driven interrupt in the event both types occur simultaneously. Interrupts cannot be nested but will be serviced sequentially. The existence of any pending interrupts can be tested via the state of the XIR (bit 2) and RTCIR (bit 3) in the status word F5.


| INSTRUMEANT | PIC1670 |
| :---: | :---: |

## INPUT/OUTPUT CAPABILITY

The PIC1670 provides four complete quasi-bidirectional input/ output ports. A simplified schematic of an I/O pin is shown below. The ports occupy address locations in the register file space of the PIC1670. Thus, any instruction that can operate on a general purpose register can operate on an I/O port. Two locations in the register file space are allocated for each I/O port. Port RA0-7 is addressable as either F10 or F11. Port RB0-7 is addressable as either F12 or F13. Port RC0-7 is addressable as either F14 or F15 and Port RD0-7 is addressable as either F16 or F17. AnI/O port READ on its odd-numbered location will interrogate the chip pins while an I/O port READ on its even-numbered location will interrogate the internal latch in that I/O port. This simplifies programming in cases where a portion of a single port is used for inputting only, while the remainder is used for outputing as illustrated in the following example.


Here, the low 3 bits of port RA are used as output-only, while the high 5 bits are used as input-only. During power on reset ( $\overline{\mathrm{MCLR}}$ low), the latches in the I/O ports will be set high, turning off all pull down transistors as represented by $Q_{2}$ in Figure 1. During program execution if we wish to interrogate an input pin, then, for example, BTFSS 11,6
will test pin RA6 and skip the next instruction if that pin is set. If we wish to modify a single output, then, for example, BCF 10,2
will force RA2 to zero because its internal latch will be cleared to zero. This will turn on $Q_{2}$ and pull the pin to zero.
The way this instruction operates internally is the CPU reads file 10 into the A.L.U., modifies the bit and re-outputs the data to file 10 . If the pins were read instead, any input which was grounded externally would cause a zero to be read on that bit. When the CPU re-outputted the data to the file, that bit would be cleared to zero, no longer useful as an input until set high again.
During program execution, the latches in bits 3-7 should remain in the high state. This will keep $Q_{2}$ off, allowing external circuitry full control of pins RA3-RA7, which are being used here as input.

## BIDIRECTIONAL INPUT-OUTPUT PORT



Figure 1

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient Temperature Under Bias ....................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Storage Temperature ..................................... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{ss}} \ldots \ldots \ldots . . . . .$.
Power Dissipation .1000 mW

Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 5.5 | V |  |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | - | 100 | mA | All I/O pins high |
| Input Low Voltage (except $\overline{\text { MCLR }} \& \overline{\mathrm{RT}}$ ) | VIL | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except $\overline{\mathrm{MCLR}}, \overline{\mathrm{RT}}$, OSC1) | $\mathrm{V}^{\text {IH1 }}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input High Voltage ( $\overline{\text { MCLR }}, \overline{\mathrm{RT}}$ OSC1) | $\mathrm{V}_{\mathrm{IH} 2}$ | $V_{D D}-1$ | - | $V_{D D}$ | V |  |
| Output High Voltage | V OH | 24 | - | $V_{D D}$ | V | $\begin{gathered} \text { IoH }=-100 \mu \mathrm{~A} \text { provided by } \\ \text { internal pullups (Note } 2 \text { ) } \end{gathered}$ |
| Output Low Voltage (I/O and CLK OUT) | VoL | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{L}}=16 \mathrm{~mA}$ |
| Input Leakage Current ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RT}}, \mathrm{OSC} 1)$ | ILC | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\text {DD }}$ |
| Input Low Current (all I/O ports) | IIL | -0.2 | -0.6 | -2.0 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$, internal pullup |
| Input High Current (all I/O ports) | IIH | -0.1 | -0.4 | - | mA | $\mathrm{V}_{1 H}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows:

$$
P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{I L}\right)\left(I_{I L} \|\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H} \mid\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right) .
$$

2. Positive current indicates current into pin. Negative current indicates current out of pin.
3. Total $\mathrm{I}_{\mathrm{OL}}$ for all output pin (I/O ports plus CLK OUT) must not exceed 175 mA .

## Standard Conditions (unless otherwise stated):

## AC CHARACTERISTICS

Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ | Max | Unils | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | tcy | 2.0 | - | 8 | $\mu \mathrm{s}$ | $4 \mathrm{MHz}-1 \mathrm{MHz}$ external time base (Note 1) |
| $\overline{\text { RT }}$ Input |  |  |  |  |  | (Note 2) |
| Period | $t_{\text {RT }}$ | toy | - | - | - |  |
| High Pulse Width | $\mathrm{trith}^{\text {the }}$ | 1/2tcy | - | - | - |  |
| Low Pulse Width | $\mathrm{tata}_{\text {ati }}$ | 1/2tcy | - | - | - |  |
| I/O Ports |  |  |  |  |  |  |
| Data Input Setup Time | ts | - | - | 1/4tcy - 125 | ns |  |
| Data Input Hold Time | tb | 0 | - | - | ns |  |
| Data Output Propagatıon Delay | tpd | - | 500 | 800 | ns | Capacitive load $=50 \mathrm{pF}$ |

## NOTES:

1. Instruction cycle period ( $t_{\mathrm{cy}}$ ) equals eight times the input oscillator time base period.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the $\overline{\mathrm{RT}}$ input, CLK OUT may be directly tied to the $\overline{\mathrm{RT}}$ input. The minimum times specified represent theoretical limits.

| GENERAL | PIC1670 |
| ---: | :---: |

## I/O TIMING

CLK OUT
CLK OUT

INPUT


## CLK OUT TIMING



## $\overline{\text { RTCC }}$ TIMING



## SCHMITT TRIGGER CHARACTERISTICS (Typical)

$$
(\overline{\mathrm{RT}}, \overline{\mathrm{MCLR}}) \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}
$$



## PIC1670 OSCILLATOR OPTIONS (TYPICAL CIRCUIT)

LC OPERATION

$f_{\mathrm{OSC}} \approx \frac{1}{2 \pi \sqrt{L\left(C_{\mathrm{L}}+\mathrm{C}_{\text {INT }}\right)}}$,
where $\mathrm{C}_{\mathrm{INT}}=10 \mathrm{pF}$.

Typical values for 4 MHz operation:
$\mathrm{L}=70 \mu \mathrm{H}$
$\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$

## CRYSTAL INPUT OPERATION



* or ceramic resonator, parallel resonant ( $0.8-5.0 \mathrm{MHz}$ )


## EXTERNAL CLOCK INPUT OPERATION



## MASTER CLEAR (TYPICAL CIRCUIT)



Master Clear requires 10 ms delay (assuming a 4 MHz crystal) before activation after power is applied to the $V_{D D}$ pin, for the crystal to start up. To achieve this, an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function).

POWER DISSIPATION DERATING GRAPH


NOTES:

1. $70^{\circ} \mathrm{C}$ is the maximum operating temperature for standard parts.
$285^{\circ}$ is the maximum operating temperature for "I" suffix parts

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the output load. This chart shows the typical curve used to express the output drive capability.

## $\mathrm{V}_{\mathrm{OH}}$ VS $\mathrm{I}_{\mathrm{OH}}$ (I/O PORTS)

(Typical)


## INSTRUNERAL

## PIC Development Series

| FUNCTION | , DESCRIPTION | PART number | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| $\square$ | PIC microcomputer without ROM and with addition of a HALT pin. | PIC1664 | 4-96 |
|  |  | PlC16C63 | 4-110 |
|  |  | PIC1665 | 4-121 |

## 8 Bit Development Microcomputer

## FEATURES

- PIC microcomputer with ROM removed
- Useful for engineering prototyping of PIC applications
- PIC ROM address \& data lines brought out to pins
- HALT pin for single stepping or stopping program execution
- MODE pin for selection of PIC1650A/1655A or PIC1656 emulation
- User programmable via external memory
- 328 -bit RAM registers
- Arithmetic Logic Unit
- User defined TTL-compatible Input and Output lines
- Real Time Clock/Counter
- Self-contained oscillator
- Access to RAM registers inherent in instruction
- Wide power supply operating range (4.5V to 7.0 V )


## DESCRIPTION

The PIC1664 development microcomputer is an MOS/LSI device containing RAM, I/O, and a central processing unit on a single chip. The PIC1664 MOS/LSI is functionally identical to the PIC microcomputers except that the ROM is removed and the ROM address and data lines are brought out, requiring a 64-pin package. The addition of a HALT pin gives the user the ability to stop as well as single-step the chip. The logic level applied to a MODE pin determines whether the PIC1664 emulates a PIC1650A/1655A or a PIC1656.
The external ROM can contain a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device. The 8-bit input/output registers provide latched lines for interfacing to a limitless variety of applications.

The 12-bit instruction word format provides a powerful yet easy to use instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC Series is fabricated with N-Channel Ion Implant technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operating clock with only an external RC network (or buffered crystal oscillator signal, for greater accuracy) to establish the frequency. Inputs and outputs are TTL-compatible.
Extensive hardware and software support is available to aid the user in developing an application program and to verify performance before committing to mask tooling. Application notes and sample programs are used to develop programs which can then be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PFD Field Demo Systems are available containing a PIC1664 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with stand-alone emulation and debugging operation or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM.

## PIC1664 GENERAL BLOCK DIAGRAM



## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC1664 microcomputer is based on a register file concept with simple yet powerful commands designed to emphasize bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.
Internally, the PIC1664 is composed of three functional elements connected together by a single bidirectional bus: the Register File composed of 32 addressable 8-bit registers, an Arithmetic Logic Unit, and a user-defined external ROM composed of 512 program words each 12 bits in width. The Register File is divided into two functional groups: operational registers and general register. The operational registers include, among others, the Real Time Clock Counter Register, the Program Counter (PC), the Status Register, and the I/O Registers. The general purpose registers are used for data and control information under command of the instructions.

The Arithmetic Logic Unit contains one temporary working register or accumulator (W Register) and gating to perform Boolean functions between data held in the working register and any file register.
Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs. Program control operations can be performed by Bit Test and Skip instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC. In addition, an onchip two-level stack is employed to provide easy to use subroutine nesting. Activating the MCLR input on power up initializes the external ROM program to address 7778.

| PIN FUNCTIONS |  |
| :---: | :---: |
| Signal | Function |
| MODE (input) | Mode input. Used to set the PIC1664 to emulate the PIC1650A/PIC1655A (logic "one") or the PIC1656 (logic "zero"). The mode must be selected before MCLR is brought high. |
| OSC1 (input) OSC2 (output) | Oscillator pins. When the MODE switch selects PIC1650A/1655A operation OSC1 becomes a single input clock using either RC control or a buffered crystal. When the PIC1664 is in the PIC1656 mode both OSC1 and OSC2 are used as a two input clock using either crystal, ceramic resonator or LC network. |
| $\overline{\mathrm{RT}}$ (input) | Real Time Clock input. This pin increments the Real Time Clock Counter Register 1 on high to low transitions applied to this input. This pin has different modes of operation depending on the MODE input as well as the contents of F3, the Status Register. In PIC1650A/1655A mode this pin emulates the RTCC pin. In the PIC1656 mode this pin emulates the $\overline{\text { RT }}$ pin. |
| RAO-7, RBO-7, RC0-7, RDO-7 (input/output) | User programmable input/output lines. These lines can be inputs and/or outputs and are under direct control of the program During emulation of the PIC1655A or PIC1656, Register D will become internal general purpose File Register 10; I/O lines RD0-7 will be undefined and must be left unconnected. |
| $\overline{M C L R}$ (input) | Master Clear. Used to initialize the internal ROM program to address 777 ${ }_{\mathrm{s}}$ and latch all I/O registers high (for PIC1650A/1655A) or I/O registers F6 and F7 low and F5 high (for PIC1656). Also clears bits 3-7 of status register (F3) (for PIC1656). This pin should be held low at least $1-10 \mathrm{~ms}$ after the power supply is valid for the oscillator to start up. $\overline{M C L R}$ has no internal pullup resistor. |
| $v_{\text {D }}$ | Primary Power supply input. |
| $\mathrm{v}_{\mathrm{xx}}$ | Output buffer power supply input. Used to increase current sinking capability when emulating the PIC1650A and PIC1655A. When emulating the PIC1656 this pin must be connected to $\mathrm{V}_{\mathrm{DD}}$. |
| CLK OUT (output) | A signal derived from the internal oscillator. Used by external devices to synchronize themselves to PIC timing. The OSC frequency is divided by 4 for PIC1650A/1655A mode or by 16 for the PIC1656 mode. |
| HALT (input) | Halt. When high this input suspends execution of the next instruction. No data is lost and after HALT is brought low execution proceeds exactly as if no HALT signal had been applied. |
| HALT ACK (output) | Halt Acknowledge. This output is high when the PIC1664 is halted either due to an active HALT input or execution of the HALT instruction ( $0001_{\mathrm{g}}$ ). In the first case HALT ACK is brought back low when the PIC1664 begins execution when the HALT input is brought low; and in the second case it is brought low using $\overline{M C L R}$ or by first raising and then lowering the HALT input. |
| D0-D11 (input) | Data Input. These twelve lines accept twelve bit PIC instruction codes generated by an external source DO is the LSB of the instruction. |
| A0-A8 (output) | Address Output. These nine lines represent the address of the next instruction to be executed by the PIC1664. AO is the LSB of the address. |



## MODE PIN OPERATION

The mode pin is used to select either PIC1650A/1655A emulation or PIC1656 emulation.
With the MODE pin set high, the PIC1664 is set to emulate the PIC1650A/1655A. Specifically:

1. MCLR will force all I/O registers high.
2. OSC1 becomes a single clock input. The PIC1664 will execute instructions at one fourth the OSC frequency.
3. The interrupt system is disabled and the RTCC always counts on trailing edges.
4. Bits 3-7 of F3 are ones.

When the MODE input is low, the PIC1664 will emulate the PIC1656 circuit. Specifically:

1. MCLR will force I/O registers F6 and F7 low and F5 high.
2. OSC1 and OSC2 become a two input clock supporting crystals, ceramic resonators, or RC networks. The PIC1664 will execute instructions at one sixteenth the OSC frequency.
3. The interrupt system is connected and the interrupt/RTCC operation is as described in the PIC1656 data sheet.
4. Bits 3-7 of F3 are used for interrupt service.

To insure proper chip operation, the Mode pin should be preset before $\overline{M C L R}$ is brought high at initialization. "Dynamic-type" switching of this pin during processor operation will result in undefined conditions and must be avoided.

## PROGRAMMING CAUTIONS

The PIC1664 is designed as a development circuit for emulating the operation of the PIC1650A, PIC1655A and PIC1656. While all circuits in the PIC series have the same basic architecture and instruction set, there are differences which require attention on the part of the user to insure that all conditions are met for proper
operation of the PIC1664 with respect to the target PIC circuit (either PIC1650A, PIC1655A, or PIC1656). The following checklist should be used to achieve proper emulation.

1. The MODE pin must be properly set (high for PIC1650A/ PIC1655A or low for PIC1656).
2. With the MODE pin high OSC1 is a single clock input. A low on the MODE pin enables the two input clock.
3. For PIC1650A and PIC1655A emulation, bits 3-7 of F3 (the status register) should be considered undefined.
4. For PIC1655A and PIC1656 emulation bits 4-7 of F5 (the input only file) should be tied to $\mathrm{V}_{\text {ss }}$ (ground) as these bits are always read as low inputs.
5. For PIC1655A and PIC1656 emulation the pins corresponding to $\mathrm{F1O}_{8}$ (I/O port RD on the PIC1650A) should be left unconnected. In this way $\mathrm{F1O}_{8}$ will operate as an internal register as is appropriate for the PIC1655A and PIC1656. 6. The I/O Programming Caution on page 3-11 describing the I/O variations between the PIC1650A and the PIC1655A/ PIC1656 must be carefully followed. The PIC1664 contains all bidirectional input/output ports as required for PIC1650A emulation. The I/O structure variation used in PIC1655A and PIC1656 require careful adherence to the cautions listed in the following pages.
6. The RETURN ( $0002_{8}$ ) instruction is not supported by the PIC1650A and PIC1655A and should not be used when emulating these parts. The HALT instruction ( $0001_{\mathrm{g}}$ ) is not recognized by any PIC circuit other than the PIC1664.
7. For PIC1656 emulation the $V_{x x}$ pin must be tied directly to $V_{D D}$ as there is no $V_{x x}$ pin on the PIC1656.


| PIC1664 | INSTRUMERAL |
| :---: | :---: |

## REGISTER FILE ARRANGEMENT

| File <br> (Octal) | Function |
| :--- | :--- |
| F0 | Not a physically implemented register. FO calls for the contents of the File Select Register (low order 5 bits) to be used to select <br> a file register. FO is thus useful as an indirect address pointer. For example, W $+F 0 \rightarrow W$ will add the contents of the file register <br> pointed to by the FSR (F4) to the contents of $W$ and place the result in W. |
| F1 | Real Time Clock Counter Register. This register can be loaded and read by the microprogram. The RTCC register keeps <br> counting up after zero is reached. The counter increments on the falling edge of the input RT. However, If data are being stored <br> in the RTCC register simultaneously with a negative transition on the RTCC pin, the RTCC register will contain the new stored <br> value and the external transition will be ignored by the microcomputer <br> Program Counter (PC). The PC is automatically incremented during each instruction cycle, and can be written into under <br> program control (MOVWF F2). The PC is nine bits wide, but only its low order 8 bits can be read under program control. <br> Status Word Register. F3 can be altered under program control only via bit set, bit clear, or MOVWF F3 instruction. |


| (7) | (6) | (5) | (4) | (3) | (2) | (1) | (0) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CNT | RTCR | IR | RTCE | IE | Z | DC | C |

## BIT 0: Carry

(C) bit

BIT 1: Digit Carry (DC) bit

BIT 2: Zero
(Z) bit

## BITS: 3-7

For ADD and SUB instructions, this bit is set if there is a carry out from the most significant bit of the resultant.
For ROTATE instructions, this bit is loaded with either the high or low order bit of the source

D: 3 -7
BIT 3: Interrupt Enable (IE) status bit. When set to a one, this bit enables the external interrupt to occur when and if the interrupt request (IR) status bit (bit 5) is also set. When reset to a zero, the external interrupt is disabled.
BIT 4. Real Time Clock Enable (RTCE) status bit. When set to a one, this bit enables the real-time clock/counter interrupt to occur when and if the real-tıme clock interrupt request (RTCR) status bit (bit 6 ) is also set. When reset to a zero, the interrupt is disabled.
BIT 5: Interrupt Request (IR) status bit. This bit is set by a high-to-low transition on the $\overline{R T}$ pin, generating an interrupt request. If and when the interrupt enable (IE) bit (bit 3 ) is also set, an interrupt will occur. This causes the current PC address to be pushed onto the stack and the processor to execute the instruction at location $760_{8}$. The IR bit is then immediately cleared. Note that the IR bit can be set regardless of the state of the IE bit, thus requesting an interrupt which can be serviced or not at the programmer's option.
BIT 6: Real Time Clock/Counter Interrupt Request (RTCR) status bit This bit is set when the RTCC register (File 1) transitions from a full count ( $377_{8}$ ) to a zero count $\left(000_{8}\right)$. If and when the RTCE bit is also set, an interrupt will occur This causes the current PC address to be pushed onto the stack and the processor to execute the instruction at location $740_{8}$. The RTCR bit is then immediately cleared. Note that the RTCR bit can be set regardless of the state of the RTCE bit, thus requestıng an interrupt which can be serviced or not, at the programmer's option.

NOTE. Although the processor cannot be interrupted during an interrupt (i e, until the RETFI instruction is executed), (an) other interrupt(s) can be requested (status bits 5 and/or 6 can be set) This will cause the processor to reinterrupt immediately upon its return from the current interrupt assuming the interrupt(s) is (are) enabled (Pending external interrupts have priority over pending real-tıme clock/counter interrupts )
BIT 7: Count Select (CNT) status bit. When CNT bit is set to a one, the RTCC register will increment on each high-to-low transition at the $\overline{R T}$ pin. If the CNT bit is sent to a zero, the RTCC register w.!l increment at the internal clock rate ( $1 / 16$ of the frequency at the OSC pins).
File Select Register (FSR). Low order 5 bits only are used. The FSR is used in generating effective file register addresses under program control. When accessed as a directly addressed file, the upper 3 bits are read as ones.
F5 Input Register A (A0-A3). A4-A7 defined as zeroes.
F6 Output Register B (B0-B7)
F7
F10-F37
General Purpose Registers
is gikiciran

## Basic Instruction Set Summary

Each PIC instruction is a 12-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " $f$ " represents a file register designator and "d" represents a destination designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

PIC W register. If " $d$ " is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, " $b$ " represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nıne bit constant or literal value.
For an oscillator frequency of 1 MHz for PIC1650A and PIC1655A ( 4 MHz for PIC1656) the instruction execution time is $4 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction. In these two cases, the instruction execution time is $8 \mu \mathrm{sec}$.

BYTE-ORIENTED
FILE REGISTER OPERATIONS
(5)
(4-0)
d f (FILE \#)

For $d=0, f \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic) $d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$ )


## NOTES:

1. The 9 th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an $I / O$ register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).

| Instruction-Binary (Octal) |  |  |  |  | Name | Mnemonic, Operands | Equivalent Operation(s) | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 010 | 000 | 000 | 011 | (2003) | Clear Carry | CLRC | BCF 3, 0 | - |
| 010 | 100 | 000 | 011 | (2403) | Set Carry | SETC | BSF 3, 0 | - |
| 010 | 000 | 100 | 011 | (2043) | Clear Digit Carry | CLRDC | BCF 3, 1 | - |
| 010 | 100 | 100 | 011 | (2443) | Set Digit Carry | SETDC | BSF 3, 1 | - |
| 010 | 001 | 000 | 011 | (2103) | Clear Zero | CLRZ | BCF 3, 2 | - |
| 010 | 101 | 000 | 011 | (2503) | Set Zero | SETZ | BSF 3, 2 | - |
| 011 | 100 | 000 | 011 | (3403) | Skip on Carry | SKPC | BTFSS 3, 0 | - |
| 011 | 000 | 000 | 011 | (3003) | Skip on No Carry | SKPNC | BTFSC 3, 0 | - |
| 011 | 100 | 100 | 011 | (3443) | Skip on Digit Carry | SKPDC | BTFSS 3, 1 | - |
| 011 | 000 | 100 | 011 | (3043) | Skip on No Digit Carry | SKPNDC | BTFSC 3, 1 | - |
| 011 | 101 | 000 | 011 | (3503) | Skip on Zero | SKPZ | BTFSS 3, 2 | - |
| 011 | 001 | 000 | 011 | (3103) | Skip on No Zero | SKPNZ | BTFSC 3, 2 | - |
| 001 | 000 | 1 ff | fff | (1040) | Test File | TSTF f | MOVF f, 1 | z |
| 001 | 000 | 0 ff | $f \mathrm{ff}$ | (1000) | Move File to W | MOVFW f | MOVF f, 0 | z |
|  |  | $\begin{aligned} & 1 \mathrm{ff} \\ & d \mathrm{ff} \end{aligned}$ | $\begin{aligned} & \mathrm{fff} \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & (1140) \\ & (1200) \end{aligned}$ | Negate File | NEGF f,d | $\begin{aligned} & \text { COMF f, } 1 \\ & \text { INCF f, } d \end{aligned}$ | Z |
|  |  | $\begin{aligned} & 000 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & f+f \end{aligned}$ | $\begin{aligned} & \text { (3003) } \\ & \text { (1200) } \end{aligned}$ | Add Carry to File | ADDCF f, d | $\begin{aligned} & \text { BTFSC } 3,0 \\ & \text { INCF f, d } \end{aligned}$ | Z |
|  |  | $\begin{aligned} & 000 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (0300) \end{aligned}$ | Subtract Carry from File | SUBCF f,d | $\begin{aligned} & \text { BTFSC } 3,0 \\ & \text { DECF } \mathrm{f}, \mathrm{~d} \end{aligned}$ | z |
| 011 |  |  | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & \text { (3043) } \\ & \text { (1200) } \end{aligned}$ | Add Digit Carry to File | ADDDCF f,d | BTFSG 3,1 <br> INCF f,d | z |
| 011 000 | 000 | $\begin{aligned} & 100 \\ & d f f \end{aligned}$ | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3043) \\ & (0300) \end{aligned}$ | Subtract Digit Carry from File | SUBDCF f,d | BTFSC 3,1 <br> DECF f,d | Z |
| 101 | kkk | kkk | kkk | (5000) | Branch | B k | GOTO k | - |
| 011 101 | 000 $k k k$ | 000 $k k k$ | 011 $k k k$ | (3003) $(5000)$ | Branch on Carry | BC k | $\begin{aligned} & \text { BTFSC } 3,0 \\ & \text { GOTO k } \end{aligned}$ | - |
| 011 101 |  | 000 $k k k$ |  | $\begin{aligned} & (3403) \\ & (5000) \end{aligned}$ | Branch on No Carry | BNC k | $\begin{aligned} & \text { BTFSS 3,0 } \\ & \text { GOTO k } \end{aligned}$ | - |
| 011 101 | 100 $k k k$ | 100 $k k k$ | 011 $k k k$ | $\begin{aligned} & \text { (3043) } \\ & (5000) \end{aligned}$ | Branch on Digit Carry | BDC k | $\text { BTFSC } 3,1$ GOTO k | - |
| 011 101 | 001 $k k k$ | 000 $k k k$ | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | (3443) $(5000)$ | Branch on No Digit Carry | BNDC k | BTFSS 3,1 GOTO $k$ | - |
| 011 101 | 101 $k k k$ | 000 | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3103) \\ & (5000) \end{aligned}$ | Branch on Zero | BZ k | BTFSC 3,2 GOTO $k$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 101 $k k k$ | 000 $k k k$ | $\begin{aligned} & 011 \\ & \text { kkk } \end{aligned}$ | $\begin{aligned} & (3503) \\ & (5000) \end{aligned}$ | Branch on No Zero | BNZ k | $\begin{aligned} & \text { BTFSS } 3,2 \\ & \text { GOTO k } \end{aligned}$ | - |

## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of an open collector TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a PIC I/O Port, the data is latched at the port and the pin
can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port latch must first be set to a high level under program control. This turns off $Q_{2}$, allowing the TTL open collector device to drive the pad, pulled up by $Q_{1}$, which can source a minimum of $100 \mu \mathrm{~A}$. Care, however, should be exercised when using open collector devices due to the potentially high TTL leakage current which can exist in the high logic state.

TYPICAL INTERFACE-BIDIRECTIONAL I/O LINE


## Programming Cautions

The use of the bidirectional I/O ports are subject to certain rules of operation These rules must be carefully followed in the instruction sequences written for 1/O operation

## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction The outputs are latched and remain unchanged until the output latch is rewritten For use as an input port the output latch must be set in the high state. Thus the external device inputs to the PIC circuit by forcing the latched output line to the low state or keeping the latched output high This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result. Caution must be used when using these instructions.

As an example a BSF operation on bit 5 of 77 (port RC) will cause all eight bits of F7 to be read into the CPU. Then the BSF operation takes place on bit 5 and $F 7$ is re-output to the output latches. If another bit of F7 Is used as an input (say bit 0 ) then bit 0 must be latched high. If during the BSF instruction on bit 5 an external device is forcing bit 0 to the low state then the input/output nature of the BSF instruction will leave bit 0 latched low after execution. In this state bit 0 cannot be used as an input until it is again latched high by the programmer. Refer to the examples below.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pın may be read into the CPU rather than the new state. This will happen if $t_{p d}$ (See I/O Timing Diagram) is greater than $1 / 4 t_{\text {cy }}(\min )$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

## EXAMPLE 1:



What is thought to be happening
BSF 7,5

| Read into CPU: | 00001111 |
| :--- | :--- |
| Set bit 5: | 00101111 |
| Write to F7: | 00101111 |

If no inputs were low during the instruction execution, there would be no problem.

## EXAMPLE 2:



What could happen if an input were low:
BSF 7,5

| Read into CPU | 00001110 |
| :--- | :--- |
| Set bit 5 | 00101110 |
| Write to F7: | 00101110 |

In this case bit 0 is now latched low and is no longer useful as an input until set high again.

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient temperature Under Bias...................................... $125^{\circ} \mathrm{C}$
Storage Temperature . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . . . . . . . .$.
Power Dissipation. 1000 mW

Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS/PIC1664
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 7.0 | V |  |
| Output Buffer Supply Voltage | $\mathrm{V}_{\mathrm{xx}}$ | 4.5 | - | 10.0 | V | (Note 2) |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | 30 | 55 | mA | All I/O pins @ V $\mathrm{VD}^{\text {d }}$ |
| Output Buffer Supply Current | Ixx | - | 1 | 5 | mA | All I/O pins @ V DD (Note 3) |
| Input Low Voltage | $\mathrm{V}_{\mathrm{IL}}$ | -0.2 | - | 0.8 | V |  |
| Input High Voltage (except $\overline{M C L R}, \overline{R T}$ \& OSC1) | $\mathrm{V}_{\mathrm{H}}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input Low-to-High Threshold Voltage ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RT}} \& \mathrm{OSC}_{1}$ in PIC1650A/55A mode) | $\mathrm{V}_{\text {ILH }}$ | $\mathrm{V}_{\mathrm{DD}}{ }^{-1}$ | 2.6 | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{aligned} & 2.4 \\ & 3.5 \end{aligned}$ | - | $\begin{aligned} & V_{D D} \\ & V_{D D} \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}(\text { Note } 4) \\ & \mathrm{I}_{\mathrm{OH}}=0 \end{aligned}$ |
| Output Low Voltage (I/O only) | $\mathrm{V}_{\text {OL1 }}$ | $\begin{aligned} & \text { - } \\ & \text { - } \\ & - \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \\ & - \end{aligned}$ | $\begin{gathered} 0.45 \\ 0.90 \\ 0.90 \\ 1.20 \\ 2.0 \end{gathered}$ | $\begin{aligned} & \mathrm{v} \\ & \mathrm{v} \\ & \mathrm{v} \\ & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{v}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA}, \mathrm{v}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=10.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OL}}=20.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=8.0 \mathrm{~V} \text { (Note } 5 \text { ) } \end{aligned}$ |
| Output Low Voltage A0-A8 CLK OUT HALT ACK | $\mathrm{V}_{\mathrm{OL} 2}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (Note 5) |
| Input Leakage Current ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RT}}$ ) | $\mathrm{I}_{\mathrm{LC}}$ | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\mathrm{IN}} \leqslant \mathrm{V}_{\mathrm{DD}}$ (note 6) |
| Input Low Current (all I/O ports) | IIL | -0.2 | -0.6 | -1.6 | mA | $\mathrm{V}_{1 \mathrm{~L}}=0.4 \mathrm{~V}$ internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{H} 1}$ | -0.1 | -0.4 | -1.4 | mA | $\mathrm{V}_{\mathrm{HH}}=2.4 \mathrm{~V}$ |
| Input High Current (HALT) | $\mathrm{I}_{\mathrm{H} 2}$ | - | 50 | 200 | $\mu \mathrm{A}$ | $\mathrm{V}_{1 H}=2.4 \mathrm{~V}$ internal pulidown |
| OSC Input (PIC1650/55 MODE) <br> External Input Impedance High | $\mathrm{R}_{\text {OSCH }}$ | 120 | 800 | 3500 | $\Omega$ | $\mathrm{V}_{\mathrm{OSC}}=\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \text {. (Applies to external }$ OSC drive only.) |
| External Input Impedance Low | $\mathrm{R}_{\text {OSCL }}$ | - | $10^{6}$ | - | $\Omega$ | $\mathrm{V}_{\text {OsC }}=0.4 \mathrm{~V}$ |
| OSC Input (PIC1656 MODE) OSC1 External Input Low Voltage | $\begin{array}{\|c} \mathrm{V}_{11} \\ \text { (OSC1) } \\ \hline \end{array}$ | -0.2 | - | 0.8 | V |  |
| OSC1 External Input High Voltage | $\begin{gathered} \mathrm{V}_{\mathrm{HH}} \\ (\mathrm{OSC} 1) \end{gathered}$ | $V_{D D^{-1}}$ | - | - | v |  |

†Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$
notes:

1. Total power dissipation for the package is calculated as follows:
$P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{I L}\right)\left(I_{I L}\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H} \mid\right)+\Sigma\left(V_{O L}\right)\left(I_{\mathrm{OL}}\right)$.
The term I/O refers to all interface pins; input, output or I/O.
2. $V_{X x}$ supply drives only the I/O ports.
3. The maximum $I_{x x}$ current will be drawn when all I/O ports are outputting a High.
4. Positive current indicates current into pin. Negative current indicates current out of pin.
5. Total lol for all output pins (I/O ports plus CLK OUT) must not exceed 225 mA .
6. Also applies to OSC1 pin in PIC1656 mode.

| INSTRUMRAL | PIC1664 |
| :---: | :---: |

Standard Conditions (unless otherwise stated):
AC CHARACTERISTICS
Operating Temperature $T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| - Characteristics | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | $t_{c r}$ | 4 | - | 20 | $\mu \mathrm{s}$ | $0.2 \mathrm{MHz}-1.0 \mathrm{MHz}$ external time base 1650A/1655A mode $0.8 \mathrm{MHz}-4.0 \mathrm{MHz}$ external time base 1656 mode (Note 1) |
| RT Input <br> Period <br> High Pulse Width <br> Low Pulse Width | $\begin{gathered} \mathrm{t}_{\mathrm{RT}} \\ \mathrm{t}_{\mathrm{RTH}} \\ \mathrm{t}_{\mathrm{RTL}} \end{gathered}$ | $\left\|\begin{array}{c} t_{\mathrm{Cr}}+0.2 \mu \mathrm{~s} \\ 1 / 2 t_{\mathrm{RT}} \\ 1 / 2 t_{\mathrm{RT}} \end{array}\right\|$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | (Notes 2 and 3) |
| I/O Ports <br> Data Input Setup Time <br> Data Input Hold Time <br> Data Output Propagation Delay | $\begin{aligned} & t_{s} \\ & t_{\mathrm{n}} \\ & \mathrm{t}_{\mathrm{pd}} \end{aligned}$ | $\overline{-}$ |  | $\left\|\begin{array}{c} 1 / 4 \mathrm{c}_{\mathrm{cr}}-125 \\ - \\ 1000 \end{array}\right\|$ | ns <br> ns ns | Capacitive load $=50 \mathrm{pF}$ |
| HALT ACK Output Propogation Delay | $t_{H A}$ | - | 200 | - | ns |  |
| $A_{0}-A_{8}$ Output Propogation Delay | $t_{\text {AD }}$ | - | 350 | - | ns |  |
| $\mathbf{D}_{0}-\mathbf{D}_{11}$ Input Set-up Time | $\mathrm{t}_{\mathrm{DS}}$ | 0 | - | - | ns |  |
| $\mathrm{D}_{0}-\mathrm{D}_{11}$ Input Hold Time | $\mathrm{t}_{\mathrm{DH}}$ | 200 | - | - | ns |  |

${ }^{\dagger}$ Typical data is at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Instruction cycle period ( $t_{\mathrm{cy}}$ ) equals four times the input oscillator time base period for 1650A/1656A operation or sixteen times oscillator time base period for 1656 operation.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the RTCC input, CLK OUT may be directly tied to the $\overline{R T} / \overline{R T C C}$ input without any loss of counts.
3. The maximum frequency which may be input to the $\overline{\operatorname{RTCC}}$ pin is calculated as follows:
$f_{(\text {max })}=\frac{1}{t_{R T(\text { min })}}=\frac{1}{t_{\mathrm{CY}(\text { min })}+0.2 \mu \mathrm{~S}}$
For example:
if $\mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.

## I/O TIMING



SCHMITT TRIGGER CHARACTERISTICS ( $\overline{\operatorname{RTCC}}, \overline{\text { MCLR }}$ and OSC PINS) $\mathrm{T}_{\mathrm{A}}=\mathbf{2 5} \mathbf{2 0}^{\circ} \mathrm{C}$ (TYPICAL)


NOTES:

1. Low-to-High Threshold Voltage ( $\mathrm{V}_{\mathrm{TLH}}$ ). 2. High-to-Low Threshold Voltage ( $\mathrm{V}_{\mathrm{THL}}$ ).

| GENERAL | PIC1664 |
| ---: | ---: |

PIC1664 OSCILLATOR OPTIONS (TYPICAL CIRCUITS)
RC OPTION OPERATION


$V_{D D}=5.0 \mathrm{~V}$
$\mathrm{C}=47 \mathrm{pF}$
$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

BUFFERED CRYSTAL INPUT OPERATION


The buffer must be capable of driving $120 \Omega$, min. ( $800 \Omega$, typ.) to 20 V However, it is recommended that the pull-down transistor on the OSC pin be removed (an option) if OSC is to be driven externally.

## EXTERNAL CLOCK INPUT OPERATION



## PIC1664 OSCILLATOR OPTIONS (TYPICAL CIRCUITS)

LC INPUT OPERATION


$$
\begin{aligned}
f_{\mathrm{OSC}} & \frac{1}{2 \pi \sqrt{L\left(C_{L}+C_{I N T}\right)}}, \\
& \text { where } C_{I N T}=10 \mathrm{pF} .
\end{aligned}
$$

Typical values for 4 MHz operation:
$\mathrm{L}=70 \mu \mathrm{H}$
$\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$

## CRYSTAL INPUT OPERATION



* or ceramic resonator

EXTERNAL CLOCK INPUT OPERATION


MASTER CLEAR (TYPICAL CIRCUIT)


Master Clear requires $>10 \mathrm{~ms}$ delay before activation after power is applied to the $V_{D D}$ pin, for the oscillator to start up. To achieve this, an external RC confıguration as shown can be used (assuming $V_{D D}$ is applied as a step function)

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the $V_{x x}$ supply and the output load This chart shows the typical curves used to express the output drive capability.
$\mathrm{V}_{\mathrm{OH}}$ VS $\mathrm{I}_{\mathrm{OH}}$ (I/O PORTS) (TYPICAL)


POWER SUPPLY CURRENT VS TEMPERATURE (TYPICAL LIMITS)


| PIC1664 | INSTRUNERENT |
| :---: | :---: |

## PIC1650A/PIC1655A EMULATION CAUTIONS

When emulating a PIC1650A or PIC1655A using a PICES II development system certain precautions should be taken.
A. Be sure that the PICES II Module being used is programmed for the PIC1650A/PIC16655A mode. (Refer to PICES II Manual). The PIC1664 contained within the module should have the MODE pin \#22 set to a high state.

1. This causes the $\overline{M C L R}$ to force all I/O registers high.
2. The OSC1 pin \#59 becomes a single clock input pin.
3. The interrupt system becomes disabled and the RTCC always counts on the trailing edges.
4. Bits 3 through 7 on file register F3 are all ones.
B. Make sure to only use two levels of stack within the program.
C. Make sure all I/O cautions contained in this spec sheet are used.
D. Be sure to use the 40 pin socket for the PIC1650A and the 28 pin socket for the PIC1655A module plugs.
E. Make sure that during an actual application that the $\overline{M C L R}$ input swings from a low to high level a minimum of 1 msec after the supply voltage is applied.
F. If an external oscillator drive is used, be sure that it can drive the $120 \Omega$ input impedance of the OSC pin on the PIC1664.
G. The cable length and internal variations may cause some parameter values to differ between the PICES II module and a production PIC1650A and PIC1655A.

## PIC1656 EMULATION CAUTIONS

When emulating a PIC1656 using a PICES II development system certain precautions should be taken.
A. Be sure that the PICES II Module being used is programmed for the PIC1656 mode. (Refer to PICES II Manual). The PIC1664 contained within the module should have the MODE pin \#22 set to a low state.

1. This causes the $\overline{M C L R}$ to force $F 5$ register high and F6 and F7 low.
2. The OSC1 pin \#59 becomes a single clock input pin.
3. The interrupt system becomes enabled and the $\overline{\mathrm{RT}}$ always counts on the trailing edges.
4. Bits 3 through 7 on file register F3 are used for interrupt servicing.
B. All three levels of stack can be used within the program. If interrupts are used, allow one level of the stack for interrupt servicing.
C. Make sure all I/O cautions contained in this spec sheet are used.
D. Be sure to use the 28 pin socket for the module plug.
E. Make sure that during an actual application that the MCLR input swings from a low to high level a minimum of 1 msec after the supply voltage is applied.
F. The cable length and internal variations may cause some parameter values to differ between the PICES II module and a production PIC1656.

## PRELIMINARY

## 8 Bit Development Microcomputer

## FEATURES

- PIC microcomputer with ROM removed
- Useful for engineering prototyping of PIC applications
- ROM address \& data lines brought out to pins
- HALT pin for single stepping or stopping program execution
- 50/55 pin for selection of PIC16C50 or PIC16C55 emulation
- 32 8-bit RAM registers
- Arithmetic Logic Unit
- Real Time Clock/Counter
- Self-contained oscillator
- Access to RAM registers inherent in instruction

■ Wide power supply operating range ( 2.5 V to 6.0 V )

## DESCRIPTION

The PIC16C63 development microcomputer is a CMOS/LSI device containing RAM, I/O, and a central processing unit on a single chip.
The PIC16C63 CMOS/LSI device is functionally identical to the PIC16C55 microcomputer except that the ROM is removed and the ROM address and data lines are brought out, requiring a 64 -pin package. The addition of a HALT pin gives the user the ability to stop as well as single-step the chip. The logic level applied to the $\overline{50} / 55$ pin determines whether the PIC16C63 emulates a PIC16C50 or PIC16C55.
The external ROM can contain a customer-defined program using the PIC's powerful instruction set to specify the overall functional characteristics of the device. The 8 -bit input/ouput registers
provide latched lines for interfacing to a limitless variety of applications.
The 12-bit instruction word format provides a powerful yet easy to use instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC Series is fabricated with complimentary MOS technology resulting in a high performance product with proven reliability and production history. Only a single wide range power supply is required for operation, and an on-chip oscillator provides the operating clock with only an external RC network (or crystal oscillator for greater accuracy) to establish the frequency.
Extensive hardware and software support is available to aid the user in developing this application program and to verify performance before committing to mask tooling. Application notes and sample programs are used to develop programs which can then be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is avallable in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PFD Field Demo Systems are available containing a PIC16C63 with sockets for erasable CMOS PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with stand-alone emulation and debugging operation or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM.

PIC16C63 GENERAL BLOCK DIAGRAM


## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC16C63 microcomputer is based on a register file concept with simple yet powerful commands designed to emphasize bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.
Internally, the PIC16C63 is composed of three functional elements connected together by a single bidirectional bus: the Register File composed of 32 addressable 8-bit registers, an Arithmetic Logic Unit, and a user-defined external ROM composed of 512 program words each 12 bits in width. The Register File is divided into two functional groups: operational registers and general register. The operational registers include, among others, the Real Time Clock Counter Register, the Program Counter (PC), the Status Register, and the I/O Registers. The general purpose regis-
ters are used for data and control information under command of the instructions.
The Arithmetic Logic Unit contains one temporary working register or accumulator (W Register) and gating to perform Boolean functions between data held in the working register and any file register.
Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs. Program control operations can be performed by Bit Test and Skip instructions, Jump instructions, Call instructions, or by loading computed addresses into the PC. In addition, an onchip two-level stack is employed to provide easy to use subroutine nesting. Activating the MCLR input on power up initializes the external ROM program to address $777_{8}$.

## PIN FUNCTIONS

| Signal | Function |
| :--- | :--- |
| $\mathbf{5 0 / 5 5}$ (input) | Used to set the PIC16C63 to emulate the PIC16C55 (logic "one") or the PIC16C50 (logic "zero"). The <br> mode must be selected before $\overline{M C L R}$ is brought high. This pin has an internal pullup. <br> OSC1 (input), OSC2 <br> Oscillator pins. Both OSC 1 and OSC 2 are used as a two pin oscillator clock using either crystal, ceramic <br> resonator or RC network or OSC 1 can be driven by an external clock signal. <br> Real Time input. This pin increments the Real Time Clock Counter Register 1 on high to low transitions <br> applied to this input. <br> User programmable input/output lines. These lines can be inputs and/or outputs and are under direct <br> control of the program. During emulation of the PIC16C55, Register D will b3come internal general |
| (input/output) |  |
| purpose File Register 10; Register B will become an output only file. Any instruction involving a read |  |
| (all instructions except literal and control operations, NOP, MOVWF, CLRW and CLRF) will not read the |  |



PIC16C63

## MODE PIN OPERATION

The mode pin is used to select either PIC16C50 emulation or PIC16C55 emulation.
With the $\overline{50} / 55$ pin set high, the PIC16C63 is set to emulate the PIC16C55. Specifically:

1. I/O port RD is general purpose register.
2. I/O port RB is output only.

When the MODE input is low, the PIC16C63 will emulate the PIC16C50 circuit. Specifically:

1. All ports will be I/O.

To insure proper chip operation, the $\overline{50} / 55$ pin should be preset before $\overline{M C L R}$ is brought high at initialization. "Dynamic-type" switching of this pin during processor operation will result in undefined conditions and must be avoided.

## PROGRAMMING CAUTIONS

The PIC16C63 is designed as a development circuit for emulating the operation of the PIC16C50 and PIC16C55. While all circuits in
the PIC series have the same basic architecture and instruction set, there are differences which require attention on the part of the user to insure that all conditions are met for proper operation of the PIC16C63 with respect to the target PIC circuit (either PIC16C50 or PIC16C55). The following checklist list should be used to achieve proper emulation.

1 The $\overline{50} / 55$ pin must be properly set (high for PIC16C55 or low for PIC16C50).
2 For PIC16C55 emulation bits 4-7 of F5 (the input only file) should be tied to $V_{S S}$ (ground) as these bits are always read as low inputs
3. For PIC16C55 emulation the pins corresponding to $\mathrm{F} 10_{8}$ (I/O port RD on the PIC16C50) should be left unconnected. In this way $\mathrm{F1O}$ s will operate as an internal register as is appropriate for the PIC16C55.
4. The HALT instruction (00018) is not recognized by any PIC circuit other than the PIC16C63.

## PIN CONFIGURATION

64 LEAD DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| $\longrightarrow \mathrm{v}_{\mathrm{ss}}{ }^{\bullet}{ }^{\bullet}$ | 64 | $\mathrm{v}_{\text {Do }} \longleftarrow$ |
| $\longrightarrow$ 50/55 ${ }^{\text {a }}$ | 63 | ПTCCC $\longleftarrow$ |
| $\longleftarrow \mathrm{AB}^{3}$ | 62 | HALT $\leftarrow$ |
| $\longleftrightarrow$ RAO $\mathrm{H}^{4}$ | 61 | $\overline{\square S}_{\overline{M C L E}}$ |
| $\longleftrightarrow \mathrm{RA}_{1} \mathrm{~S}^{5}$ | 60 | halt ack |
| $\longleftrightarrow$ RA2 $\mathrm{H}^{6}$ | 59 | P OSC $1 \longleftrightarrow$ |
| $\longleftarrow \mathrm{A}^{-1}{ }^{7}$ | 58 | Oosc $2 \longrightarrow$ |
| $\longleftarrow \mathrm{A}_{6} \mathrm{C}^{8}$ | 57 | D0 $\leftarrow$ |
| $\longleftrightarrow$ RA3 $\mathrm{Cl}{ }^{\text {a }}$ | 56 | D1 |
| $\longleftarrow$ A5 ${ }^{\text {c }} 10$ | 55 | $\mathrm{D} 2 \leftarrow$ |
| $\longleftrightarrow$ RA4 ${ }^{11}$ | 54 | RD7 $\longleftrightarrow$ |
| $\longleftrightarrow$ RA5 $\mathrm{H}^{12}$ | 53 | RD6 $\longleftrightarrow$ |
| $\longleftarrow$ A 4 ¢ ${ }^{13}$ | 52 | D3 5 |
| $\longleftrightarrow$ RA6 - 14 | 51 | RD5 $\longleftrightarrow$ |
| $\longleftrightarrow$ RA7 ${ }^{15}$ | 50 | RD4 $4 \longleftrightarrow$ |
| $\longleftarrow$ A3 - 16 | 49 | D4 4 |
| $\longleftrightarrow$ RBO $\square^{17}$ | 48 | RDO $3 \longleftrightarrow$ |
| $\longleftrightarrow$ RB1 ${ }^{\text {c }} 18$ | 47 | RD2 $\longleftrightarrow$ |
| $\longleftarrow$ A2 $\square^{19}$ | 46 | O5 $\longleftarrow$ |
| $\longleftrightarrow \mathrm{RB2} \mathrm{Cl}^{20}$ | 45 | RD1 $\longleftrightarrow$ |
| $\longleftrightarrow$ RB3 $\mathrm{H}_{21}$ | 44 | RDO $\longleftrightarrow$ |
| NC- ${ }^{22}$ | 43 | P06 |
| - clk out ${ }^{23}$ | 42 | PCC7 $\longleftrightarrow$ |
| $\longleftarrow \mathrm{Al}^{24}$ | 41 | D07 |
| $\longleftrightarrow$ RB4 - 25 | 40 | RC6 $\longleftrightarrow$ |
| $\longleftrightarrow$ RB5 ${ }^{\text {a }} 26$ | 39 | D88 |
| $\longleftarrow \mathrm{AOH}_{27}$ | 38 | RRC5 $\longleftrightarrow$ |
| $\longleftrightarrow$ RB6 $\mathrm{Cl}^{28}$ | 37 | $\mathrm{QRC}^{\mathrm{RC}} \longleftrightarrow$ |
| $\longleftrightarrow$ R87 $\square^{29}$ | 36 | D $09 \leftarrow$ |
| $\longrightarrow$ D11-30 | 35 | $\mathrm{P}^{\mathrm{RC} 3} \longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RCO} \mathrm{B}_{31}$ | 34 | R RC2 $\leftarrow$ |
| $\longleftrightarrow$ RC1 [ 32 | 33 | -D10 |


| PIC16C63 | INSTRUMERAL |
| :---: | :---: |

REGISTER FILE ARRANGEMENT


## Basic Instruction Set Summary

Each PIC instruction is 12 -bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction. The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations.
For byte-oriented instructions, " f " represents a file register designator and "d" represents a destınation designator. The file register designator specifies which one of the 32 PIC file registers is to be utilized by the instruction. The destination designator specifies where the result of the operation performed by the instruction is to be placed. If " $d$ " is zero, the result is placed in the

PIC W register. If "d" is one, the result is returned to the file register specified in the instruction.
For bit-oriented instructions, "b" represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located.
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value.
For an oscillator frequency of 1 MHz the instruction execution time is $5 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction In these two cases, the instruction execution time is $10 \mu \mathrm{sec}$

BYTE-ORIENTED FILE REGISTER OPERATIONS


For $d=0, t \rightarrow W$ (PICAL accepts $d=0$ or $d=W$ in the mnemonic) $d=1, f \rightarrow f$ (If $d$ is omitted, assembler assigns $d=1$.)

| Instruction-Binary (Octal) |  |  |  |  | Nome | Mnemonic, Operands |  | Operation St | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 000 | 000 | 000 | 000 | (0000) |  | NOP |  | - | None |
| 000 | 000 | off | fff | (0000) | Tri-state port f | TRIS | f | $W \rightarrow$ Tristate status $f$ | None |
| 000 | 000 | 1 ff | $f f f$ | (0040) | Move W to f (Note 1) | MOVWF | f | W $\rightarrow$ f | None |
| 000 | 001 | 000 | 000 | (0100) | Clear W | CLRW | - | $0 \rightarrow \mathrm{~W}$ | Z |
| 000 | 001 | 1 ff | $\mathrm{ff} \mathrm{f}^{\text {f }}$ | (0140) | Clear f | CLRF | f | $0 \rightarrow f$ | Z |
| 000 | 010 | dff | $f \mathrm{ff}$ | (0200) | Subtract W from f | SUBWF | f, d | $f-W \rightarrow d[f+\bar{W}+1 \rightarrow d]$ | C, DC, Z |
| 000 | 011 | dff | $f f f$ | (0300) | Decrement f | DECF | f, d | $f-1 \rightarrow d$ | Z |
| 000 | 100 | dff | fff | (0400) | Inclusive OR W and f | IORWF | f, d | WVf $\rightarrow$ d | Z |
| 000 | 101 | dff | $f \mathrm{ff}$ | (0500) | AND W and f | ANDWF | f, d | $W \cdot f \rightarrow d$ | Z |
| 000 | 110 | dff | $f \mathrm{ff}$ | (0600) | Exclusive OR W and f | XORWF | f, d | $W \oplus f \rightarrow d$ | Z |
| 000 | 111 | dff | $f \mathrm{ff}$ | (0700) | Add W and f | ADDWF | f, d | $W+f \rightarrow d$ | C, DC, Z |
| 001 | 000 | dff | fff | (1000) | Move f | MOVF | f, d | $\xrightarrow{\dagger} \rightarrow \mathrm{d}$ | Z |
| 001 | 001 | dff | $f \mathrm{ff}$ | (1100) | Complement f | COMF | f, d | $\overline{\mathrm{f}} \rightarrow \mathrm{d}$ | z |
| 001 | 010 | dff | $f \mathrm{ff}$ | (1200) | Increment f | INCF | f, d | $f+1 \rightarrow \mathrm{~d}$ | Z |
| 001 | 011 | dff | $f \mathrm{ff}$ | (1300) | Decrement f , Skip if Zero | DECFSZ | f, d | $\mathrm{f}-1 \rightarrow \mathrm{~d}$, skip if Zero | None |
| 001 | 100 | dff | $f \mathrm{ff}$ | (1400) | Rotate Right $\dagger$ | RRF | f, d | $f(\mathrm{n}) \rightarrow \mathrm{d}(\mathrm{n}-1), \mathrm{f}(0) \rightarrow \mathrm{C}, \mathrm{C} \rightarrow \mathrm{d}(7)$ | C |
| 001 | 101 | dff | fff | (1500) | Rotate Left f | RLF | f, d | $f(\mathrm{n}) \rightarrow \mathrm{d}(\mathrm{n}+1), f(7) \rightarrow C, C \rightarrow d(0)$ | C |
| 001 | 110 | dff | $f \mathrm{ff}$ | (1600) | Swap halves f | SWAPF | f, d | $f(0-3) \leftrightharpoons f(4-7) \rightarrow d$ | None |
| 001 | 111 | dff | $f \mathrm{ff}$ | (1700) | Increment f, Skip if Zero | INCFSZ | f, d | $\mathrm{f}+1 \rightarrow \mathrm{~d}$, skip if zero | None |


| BIT-ORIENTED FILE REGISTER OPERATIONS |  |  |  |  | (11-8) |  | (7-5) |  |  | (4-0) |  |  | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | OP CODE | b (BI | IT \#) |  | $f$ (FILE |  |  |  |
| Instruction-Binary (Octal) |  |  |  |  | Name |  |  | Mnemonic, Operands |  |  | Operation |  |  |
| 010 | 0bb | $b f f$ | fff | (2000) | Bit Clear f |  |  | BCF |  | f, b |  | f(b) | None |
| 010 | 1 bb | $b f f$ | fff | (2400) | Bit Set f |  |  | BSF |  | f, b |  | f(b) | None |
| 011 | Obb | bff | $f \mathrm{ff}$ | (3000) | Bit Test f, Skip if Clear |  |  | BTFSC |  | f, b |  | it Test $\mathrm{f}(\mathrm{b})$ : skip if clear | None |
| 011 | 1 bb | $b f f$ | $f \mathrm{ff}$ | (3400) | Bit Test f, Skip if Set |  |  |  | FSS | f, b |  | t Test f(b). skip is set | None |
|  |  |  |  |  | (11-8) |  |  |  | (7-0) |  |  |  |  |
| LITERAL AND CONTROL OPERATIONS |  |  |  |  |  | OP CODE | $k$ (LITERAL) |  |  |  |  |  |  |
| Instruction-Binary (Octal) |  |  |  |  | Name |  | Mnemonic, Operands |  |  |  |  | Operation | Status Affected |
| 000 | 000 | 000 | 010 | (0002) |  |  |  | RETURN |  | - |  | ack-PC | None |
| 100 | 0 kk | kkk | kkk | (4000) | ReturnReturn and place Literal in W |  |  |  | TLW | k |  | W, Stack $\rightarrow$ PC | None |
| 100 | 1 kk | kkk | kkk | (4400) | Call subroutine (Note 1) |  |  | CAL | LL | k |  | $\mathrm{C}+1 \rightarrow$ Stack, $\mathrm{k} \rightarrow \mathrm{PC}$ | None |
| 101 | kkk | kkk | kkk | (5000) | Go To address ( $k$ is 9 bits) |  |  |  | то | k |  | $\rightarrow P C$ | None |
| 110 | Okk | kkk | kkk | (6000) | Move Literal to W |  |  |  | VLW | k |  | $\rightarrow$ W | None |
| 110 | 1 kk | kkk | kkk | (6400) | Inclusive OR Literal and W |  |  |  | RLW | k |  | VW $\rightarrow$ W | Z |
| 111 | Okk | kkk | kkk | (7000) | AND Literal and W Exclusive OR Literal and W |  |  |  | NDLW | k |  | W $\rightarrow$ W | z |
| 111 | 1 kk | kkk | kkk | (7400) |  |  |  |  | RLW | k |  | Q $-W$ | Z |

## NOTES:

1. The 9th bit of the program counter in the PIC is zero for a CALL and a MOVWF F2. Therefore, subroutines must be located in program memory locations $0-377_{8}$. However, subroutines can be called from anywhere in the program memory since the Stack is 9 bits wide.
2. When an I/O register is modified as a function of itself, the value used will be that value present on the output pins. For example, an output pin which has been latched high but is driven low by an external device, will be relatched in the low state.
3. TRIS $f$ ( where $f=6$ or 7 for PIC16C55 or $5,6,7,10$ for PIC16C50) causes the contents of $W$ to be written to the tri-state latches of the specified file. A one forces the pin to tri-state the output buffer to a high impedance state.

SUPPLEMENTAL INSTRUCTION SET SUMMARY

The following supplemental instructions summarized below represent specific applications of the basic PIC instructions. For example, the "CLEAR CARRY" supplemental instruction is equiv-
alent to the basic instruction BCF 3,0 ("Bit Clear, File 3, Bit 0"). These instruction mnemonics are recognized by the PIC Cross Assembler (PICAL).

| Instruction-Binary (Octal) |  |  |  |  | Name | Mnemonic, Operands | Equivalent Operation(s) | Status Affected |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 010 | 000 | 000 | 011 | (2003) | Clear Carry | CLRC | BCF 3, 0 | - |
| 010 | 100 | 000 | 011 | (2403) | Set Carry | SETC | BSF 3, 0 | - |
| 010 | 000 | 100 | 011 | (2043) | Clear Digtt Carry | CLRDC | BCF 3, 1 | - |
| 010 | 100 | 100 | 011 | (2443) | Set Digit Carry | SETDC | BSF 3, 1 | - |
| 010 | 001 | 000 | 011 | (2103) | Clear Zero | CLRZ | BCF 3, 2 | - |
| 010 | 101 | 000 | 011 | (2503) | Set Zero | SETZ | BSF 3, 2 | - |
| 011 | 100 | 000 | 011 | (3403) | Skip on Carry | SKPC | BTFSS 3, 0 | - |
| 011 | 000 | 000 | 011 | (3003) | Skip on No Carry | SKPNC | BTFSC 3, 0 | - |
| 011 | 100 | 100 | 011 | (3443) | Skip on Digit Carry | SKPDC | BTFSS 3, 1 | - |
| 011 | 000 | 100 | 011 | (3043) | Skip on No Digit Carry | SKPNDC | BTFSC 3, 1 | - |
| 011 | 101 | 000 | 011 | (3503) | Skip on Zero | SKPZ | BTFSS 3, 2 | - |
| 011 | 001 | 000 | 011 | (3103) | Skip on No Zero | SKPNZ | BTFSC 3, 2 | - |
| 001 | 000 | 1 ff | $f \mathrm{ff}$ | (1040) | Test File | TSTF f | MOVF f, 1 | z |
| 001 | 000 | 0 ff | $f f$ | (1000) | Move File to W | MOVFW f | MOVF f, 0 | z |
| $\begin{array}{ll} 001 \\ 001 \end{array}$ | $\begin{array}{lll} 0 & 0 & 1 \\ 0 & 10 \end{array}$ | $\begin{aligned} & 1 \mathrm{ff} \\ & \mathrm{dff} \end{aligned}$ | $\begin{aligned} & f f \\ & f f \end{aligned}$ | $\begin{aligned} & (1140) \\ & (1200) \end{aligned}$ | Negate File | NEGF f,d | $\begin{aligned} & \text { COMF } f, 1 \\ & \text { INCF } f, d \end{aligned}$ | z |
| 011 001 | 000 | 000 | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & \text { (3003) } \\ & (1200) \end{aligned}$ | Add Carry to File | ADDCF f, d | BTFSC 3,0 <br> INCF f, d | z |
| 011 000 | 000 | 000 | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & (3003) \\ & (0300) \end{aligned}$ | Subtract Carry from File | SUBCF f,d | BTFSC 3,0 <br> DECF f, d | Z |
| 011 001 | 000 | 100 $d f f$ | $\begin{aligned} & 011 \\ & \mathrm{fff} \end{aligned}$ | $\begin{aligned} & \text { (3043) } \\ & (1200) \end{aligned}$ | Add Digit Carry to File | ADDDCF f,d | BTFSG 3,1 <br> INCF f,d | z |
| 011 000 | 000 | 100 | $\begin{aligned} & 011 \\ & \mathrm{ff} \end{aligned}$ | $\begin{aligned} & \text { (3043) } \\ & \text { (0300) } \end{aligned}$ | Subtract Digit Carry from File | SUBDCF f,d | BTFSC 3,1 DECF $\mathrm{f}, \mathrm{d}$ | Z |
| 101 | kkk | kkk | kkk | (5000) | Branch | B k | GOTO k | - |
| 011 101 | 000 | 000 | 011 $k k k$ | $\begin{aligned} & (3003) \\ & (5000) \end{aligned}$ | Branch on Carry | $B C k$ | BTFSC 3,0 GOTO k | - |
| 011 101 | 100 | 000 | 011 $k k k$ | $\begin{aligned} & (3403) \\ & (5000) \end{aligned}$ | Branch on No Carry | BNC k | BTFSS 3,0 GOTO k | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 100 | 100 $k k k$ | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3043) \\ & (5000) \end{aligned}$ | Branch on Digit Carry | BDC k | BTFSC 3,1 GOTO $k$ | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 001 | 000 | 011 $k k k$ | $\begin{aligned} & (3443) \\ & (5000) \end{aligned}$ | Branch on No Digit Carry | BNDC k | BTFSS 3,1 GOTO $k$ | - |
| 011 101 | 101 $k k k$ | 000 | 011 $k k k$ | $\begin{aligned} & (3103) \\ & (5000) \end{aligned}$ | Branch on Zero | BZ k | BTFSC 3,2 GOTO k | - |
| $\begin{aligned} & 011 \\ & 101 \end{aligned}$ | 101 $k k k$ | $\begin{aligned} & 000 \\ & k k k \end{aligned}$ | $\begin{aligned} & 011 \\ & k k k \end{aligned}$ | $\begin{aligned} & (3503) \\ & (5000) \end{aligned}$ | Branch on No Zero | BNZ k | BTFSS 3,2 GOTO k | - |


| Ingivinicin | PIC16C63 |
| :--- | :--- |

## I/O Interfacing

The equivalent circuit for an I/O port bit is shown below as it would interface with either the input of a TTL device (PIC is outputting) or the output of a tri-state TTL device (PIC is inputting). Each I/O port bit can be individually time multiplexed between input and output functions under software control. When outputting thru a

PIC I/O Port, the data is latched at the port and the pin can be connected directly to a TTL gate input. When inputting data thru an I/O Port, the port must first be set to the high impedarice state under program control. This turns off $Q_{1}$ and $Q_{2}$ and turns on $Q_{3}$ (if present), allowing the TTL tri-state device to drive the pin.


## Programming Cautions

The use of the bidirectional I/O ports are subject to certain rules of operation. These rules must be carefully followed in the instruction sequences written for I/O operation. (Note that for an output only port the latch, not the pin is read.)

## Bidirectional I/O Ports

The bidirectional ports may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction. The outputs are latched and remain unchanged until the output latch is rewritten. For use as an input port the output must be set to the high impedance state via the tri-state latch. Thus the external device inputs to the PIC circuit by forcing the input line high or low. If the input lines are not tri-stated then refer to PIC1650A
programming cautions. This principle is the same whether operating on individual bits or the entire port.
Some instructions operate internally as input followed by output operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation, and re-output the result.

## Successive Operations on Bidirectional I/O Ports

Care must be exercised if successive instructions operate on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU (MOVF, BIT SET, BIT CLEAR, and BIT TEST) is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. This will happen if $t_{\text {pd }}$ (See I/O Timing Diagram) is greater than $1 / 5 t_{c y}(\mathrm{~min})$. When in doubt, it is better to separate these instructions with a NOP or other instruction.

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient Temperature Under Bias $\qquad$ $125^{\circ} \mathrm{C}$
Storage Temperature $\qquad$ $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\text {sS }}$ (Note 1) ..... -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Power Dissipation (Note 5) ..... 300 mW
Voltage on $\mathrm{V}_{\mathrm{DD}}$ with Respect to $\mathrm{V}_{\mathrm{SS}} \ldots \ldots \ldots \ldots \ldots \ldots . .$.

## Standard Conditions (unless otherwise stated): DC CHARACTERISTICS

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristics | Sym | Min | Typ ${ }^{\text { }}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | $V_{D D}$ | 2.5 | - | 6.0 | V |  |
| Supply Current | $l_{\text {D }}$ | - | - | $\begin{aligned} & 2 \\ & 5 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ | $\left.\begin{array}{\|l} \mathrm{V}_{\mathrm{DD}}=4 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{DD}}=6 \mathrm{~V} \end{array}\right\} \begin{aligned} & \text { All I/O pins tri-state, } \\ & \mathrm{t}_{\mathrm{Cr}}=4 \mu \mathrm{sec} \end{aligned}$ |
| Input Low Voltage | $\mathrm{V}_{1}$ | $\mathrm{V}_{\text {S }}$ | - | $0.2 V_{D D}$ | V |  |
| Input High Voltage | $\mathrm{V}_{\mathrm{H}}$ | $0.8 \mathrm{~V}_{\mathrm{DD}}$ | - |  | v |  |
| Output High Voltage (RB0-7, RC0-7) | $\mathrm{V}_{\mathrm{OH}}$ | $\begin{array}{\|l\|} \hline V_{D D}-0.4 \\ V_{D D}-0.4 \\ \hline \end{array}$ |  | - | $\begin{aligned} & \mathrm{v} \\ & \mathrm{v} \end{aligned}$ | $\begin{array}{r} I_{\text {SOURCE }}=0.2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V} \\ I_{\text {SOURCE }}=80 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{DD}}=2.5 \mathrm{~V} \\ \hline \end{array}$ |
| Output Low Voltage (RBO-7, RC0-7) (Note 1) | $\mathrm{V}_{\text {OL }}$ | - | - | 0.4 | V | $\begin{aligned} \mathrm{I}_{\mathrm{SINK}} & =0.2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=2.5 \mathrm{~V} \\ \mathrm{I}_{\mathrm{SINK}} & =1.6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=4.75 \mathrm{~V} \end{aligned}$ |
| Input Low Current (RAO-3, RCO-7) (Note 2) | $1 / 1$ | - | - | 250 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{DD}}=6 \mathrm{~V}, \mathrm{~V}_{1 \mathrm{I}}=0.4 \mathrm{~V}$ |
| Input High Current (RA0-3, RC0-7) (Note 2) | $\mathrm{I}_{\mathrm{H}}$ | 2 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}-0.4 \mathrm{~V}$ |
| Leakage Current (Note 3) | LC | -1 | - | 1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\mathrm{PIN}} \leqslant \mathrm{V}_{\mathrm{DD}}$ |
| Input Low Current (HALT) | $I_{1 L}$ | 15 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%$ |
| Input High Current (HALT) | $\mathrm{I}_{\mathrm{H}}$ | - | - | $\begin{gathered} 250 \\ 40 \end{gathered}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{1 H}=\mathrm{V}_{\mathrm{DD}}-0.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \% \\ & \mathrm{~V}_{\mathrm{HH}}=2.1 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=2.5 \mathrm{~V} \end{aligned}$ |

$\dagger_{\text {Typical data is at }} T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. The output pull-down transistor can be removed via a mask option to facilitate interfacing with external circuitry which has signal swings below $\mathrm{V}_{\mathrm{Ss}}$. If this is the case, the maximum voltage permitted to be applied to the pin is -12 V with respect to $\mathrm{V}_{\mathrm{DD}}$.
2. Current is being sourced by the internal pull-up resistors which are avajlable as a mask option on ports RA0-3 and RC0-7. (RC0-7 have their pull-ups turned off when selected as outputs.)
3. This applies to ports RAO-3 and RCO-7 without the mask optional internal pull-up resistors, port RB0-7 and RCO-7 in the high impedance state, $\overline{\mathrm{RTCC}}, \overline{M C L R}$ and OSC 1.
4. Total output sink current for all output pins (including CLK OUT) must not exceed 50 mA . Total output source current must not exceed 20 mA . Maximum output sink or source current for each individual output must not exceed 10 mA .
5. Total power dissipation should not exceed 300 mW for the package. Power dissipation is calculated as follows:

$$
P_{D I S}=V_{D D}\left[\left(I_{D D}\right)-\Sigma\left(I_{I N}+I_{O H}\right)\right]+\Sigma\left(V_{D D}-V_{I N}\right)\left(I_{I N}\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H}\right)+\Sigma\left(V_{\mathrm{OL}}\right)\left(I_{\mathrm{OL}}\right)
$$

Standard Conditions (unless otherwise stated):
AC CHARACTERISTICS
Operating Temperature $T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=2.5-6.0 \mathrm{~V}$ except as noted.

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Oscillator Frequency | $f_{\mathrm{osc}}$ <br> fosc <br> fosc <br> fosc | $\begin{aligned} & 25 \\ & 25 \\ & 25 \\ & 25 \end{aligned}$ | $\begin{aligned} & - \\ & - \\ & - \end{aligned}$ | $\begin{aligned} & 1000 \\ & 1250 \\ & 1650 \\ & 1800 \end{aligned}$ | $\begin{aligned} & \mathrm{kHz} \\ & \mathrm{kHz} \\ & \mathrm{kHz} \\ & \mathrm{kHz} \end{aligned}$ | $\begin{aligned} & V_{D D}=2.5 \mathrm{~V} \\ & V_{D D}=3.2 \mathrm{~V} \\ & V_{D D}=5.0 \mathrm{~V} \\ & V_{D D}=6.0 \mathrm{~V} \end{aligned}$ |
| CLOCK OUT <br> Period (Instruction Cycle Time) <br> Pulse Width <br> Rise/Fall Time | $\begin{gathered} \mathbf{t}_{\mathrm{CY}} \\ \mathrm{t}_{\mathrm{CLKH}} \\ \mathrm{t}_{\mathrm{r}} / \mathrm{t}_{\mathrm{f}} \end{gathered}$ | $-$ | 5/fosc <br> $1 /$ fosc <br> - |  |  | (Note 1) <br> 1 TTL Load $+50 \mathrm{pF} \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ |
| RTCC Input <br> Period <br> Pulse Width (High or Low Level) | $\begin{aligned} & t_{\mathrm{RT}} \\ & \mathrm{t}_{\mathrm{pw}} \end{aligned}$ | $\left\|\begin{array}{c} \mathrm{t}_{\mathrm{Cr}}+0.2 \mu \mathrm{~s} \\ 500 \end{array}\right\|$ | $-$ | $-$ | ns | (Notes 2 and 3) |
| I/O Ports <br> Data Input Setup Time <br> Data Input Hold Time <br> Data Output Propagation Delay | $\begin{aligned} & \mathrm{t}_{\mathrm{s}} \\ & \mathrm{t}_{\mathrm{n}} \\ & \mathrm{t}_{\mathrm{pd}} \end{aligned}$ | $-$ |  | $\left\|\begin{array}{c} 1 / 5 \mathrm{t}_{\mathrm{cr}}-300 \\ - \\ 1.6 \end{array}\right\|$ | ns ns $\mu \mathrm{s}$ | $60 \mathrm{pF}+2.2 \mathrm{~K}$ to $0.8 \mathrm{~V}_{\mathrm{DD}}$ |
| HALT ACK Output Propogatıon Delay | $t_{\text {HA }}$ | - | - | 600 | ns | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%, 1 \mathrm{TTL}+60 \mathrm{pF}$ load |
| $\mathrm{A}_{0}-\mathrm{A}_{\mathbf{8}}$ Output Propogatıon Delay | $\mathrm{t}_{\text {AD }}$ | - | - | 1 | $\mu \mathrm{s}$ | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \pm 5 \%, 10 \mu \mathrm{~A}+60 \mathrm{pF}$ load |
| $\mathrm{D}_{0}-\mathrm{D}_{11}$ Input Set-up time | $\mathrm{t}_{\mathrm{DS}}$ | 30 | - | - | ns | $V_{D D}=5 \mathrm{~V} \pm 5 \%$ |
| $\mathrm{D}_{0}-\mathrm{D}_{11}$ Input Hold Time | $\mathrm{t}_{\mathrm{DH}}$ | 300 | - | - | ns | $V_{D D}=5 \mathrm{~V} \pm 5 \%$ |

$\dagger_{\text {Typical data is at }} \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$

## NOTES:

1. Instruction cycle period ( $\mathrm{t}_{\mathrm{cr}}$ ) equals five tımes the input oscillator time base period
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the $\overline{\operatorname{RTCC}}$ input, CLK OUT may be directly tied to the RTCC input.
3. The maximum frequency which may be input to the $\overline{\mathrm{RTCC}}$ pın is calculated as follows:

$$
f_{(\text {max })}=\frac{1}{t_{R T} \text { (min) }}=\frac{1}{t_{C Y} \text { (min) }}+0.2 \mu \mathrm{~s}
$$

For example:
if $\mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\max )}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.

## I/O TIMING




PIC16C63 EMULATION OSCILLATOR OPTIONS (TYPICAL CIRCUITS)

RC OPTION OPERATION

$10 K \leqslant R \leqslant 1 M$.
TYPICAL VALUES $R \geqslant 10 K$
$C \geqslant 100 \mathrm{pF}$

## EXTERNAL CLOCK INPUT OPERATION



## MASTER CLEAR



TYPICAL VALUES

$$
R=1 M
$$

$$
\mathrm{C}=0.1 \mu \mathrm{~F}
$$

Master Clear may require up to a 75 ms delay before activation after power is applied to the $\mathrm{V}_{D D}$ pin for a $\mathbf{1 M H z}$ crystal to start up. To achieve this an external RC configuration as shown can be used (assuming $\mathrm{V}_{\mathrm{DD}}$ is applied as a step function). The RC oscillator option, shown above, should start up in less time.

## PIC1665

## 8 Bit Development Microcomputer

## FEATURES

- PIC1670 microcomputer with ROM removed
- Useful for engineering prototyping of PIC applications
- PIC ROM address \& data lines brought out to pins
- HALT pin for single stepping or stopping program execution
- User programmable via external memory
- 64 8-bit RAM registers
- Arithmetic Logic Unit
- User defined TTL-compatible Input and Output lines
- Real Time Clock/Counter
- Self-contained oscillator
- Access to RAM registers inherent in instruction
- Power supply operating range ( 4.5 V to 5.5 V )


## DESCRIPTION

The PIC1665 development microcomputer is an MOS/LSI device containing RAM, I/O, and a central processing unit on a single chip.
The PIC1665 MOS/LSI device is functionally identical to the PIC1670 microcomputer except that the ROM is removed and the ROM address and data lines are brought out, requiring a 64-pin package. The addition of a HALT pin gives the user the ability to stop as well as single-step the chip.
The external ROM can contain a customer-defined program using the PIC's powerful instruction set to specify the overall
functional characteristics of the device. The 8-bit input/ouput registers provide latched lines for interfacing to a limitless variety of applications.
The 13-bit instruction word format provides a powerful yet easy to use instruction repertoire emphasizing single bit manipulation as well as logical and arithmetic operations using bytes.
The PIC1665 is fabricated with N-Channel Si-gate technology resulting in a high performance product with proven reliability and production history. Only a single power supply is required for operation, and an on-chip oscillator provides the operating clock with an external crystal, ceramic resonator or LC network to establish the frequency. Inputs and outputs are TTL-compatible.
Extensive hardware and software support is available to aid the user in developing this application program and to verify performance before committing to mask tooling. Application notes and sample programs are used to develop programs which can then be assembled into machine language using PICAL, eliminating the burden of coding with ones and zeros. PICAL is available in a Fortran IV version that can be run on many popular computer systems. Once the application program is developed several options are available to insure proper performance. The PFD1020 Field Demo System is available containing a PIC1665 with sockets for erasable PROMs. Finally, the PICES II (PIC In-Circuit Emulation System) provides the user with stand-alone emulation and debugging operation or operation as a peripheral to a larger computer system. Easy program debugging and changing is facilitated because the user's program is stored in RAM.

## PIC1665 BLOCK DIAGRAM



| INSTRUMERENT | PIC1665 |
| :--- | :--- |

## ARCHITECTURAL DESCRIPTION

The firmware architecture of the PIC1665 microcomputer is based on a register file concept with simple yet powerful instruction commands designed to optimize the code for bit, byte, and register transfer operations. The instruction set also supports computing functions as well as these control and interface functions.
Internally, the functional blocks of the PIC1665 are connected by an 8-bit bidirectional bus: the 64 8-bit registers of which the first 16 are special purpose, an Arithmetic Logic Unit, and a user defined external PROM composed of $1024 \times 13$ bit words. The register file is divided into two functional groups: operational registers and general purpose registers. The first sixteen are the operational registers and they include the Real Time Clock/Counters A and B, four I/O registers, two Status registers, a Program Counter and a File Select Register. The general purpose registers are used for data and control information under command of the instructions.

The Arithmetic Logic Unit contains one temporary working register (W Register), an adder, and hardware for decimal adjust. Manipulation between data in the working register and any other register can be performed.
The external PROM contains the user defined application program and is supported by an instruction decoder and instruction register. Sequencing of microinstructions is controlled via the Program Counter (PC) which automatically increments to execute in-line programs. The Program Counter is modified by bit test, jump, call or branch instructions and the lower 8-bits can be modified for computed addresses by file register instructions. (Note: The upper 2 bits are not affected.) In addition, an on-chip six level stack is employed to push and pull the contents of the program counter. This provides easy to use subroutine nesting. Activating the $\overline{M C L R}$ input on power-up initializes the external ROM program to address 17778 .

## PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| OSC 1 (Input) OSC 2 (Output) | Oscillator pins. The on-board oscillator can be driven by an external crystal, an RC network, or an external clock via these pins. |
| $\overline{\mathrm{RT}}$ (Input) | Real Time input. Negative transitions on this pin increments the RTCC (F6) register. This pin can also be used for an interrupt input. This pin uses a Schmitt trigger input. There is no internal active pull-up device. |
| RA0-RA7, RB0-RB7, RC0-RC7, RDO-RD7 | User programmable input/output lines. These lines can be inputs and/or outputs and are under direct control of the program. |
| $\overline{\text { MCLR }}$ (Input) | Master Clear. Used to initialize the internal ROM program to address $1777_{\mathrm{s}}$, latch all I/O registers high, and disable the interrupt system. This pin uses a Schmitt trigger input. There is no internal active pull-up device. |
| $V_{\text {DD }}$ | Power supply pin. |
| $\mathrm{V}_{\text {ss }}$ | Ground pin. |
| CLKOUT | Clock Output. A signal derived from the internal oscillator. May be used by external circuitry to synchronize with PIC1665 timing. |
| HALT/ACK | Halt/Halt Acknowledge. This is a bidirectional I/O pin used in conjunction with CLKOUT. The pin is an input when CLKOUT is low, and an output when CLKOUT is high. Inputting a high when CLKOUT is low will suspend execution of the next instruction. No data is lost and after HALT/ACK is brought low execution proceeds exactly as if no halt signal had been applied. This pin can also be used to restart the PIC1665 after a HALT instruction $\left(00001_{\mathrm{g}}\right)$ has been executed. During the time CLKOUT is high, the pin will have an open drain output configuration and therefore requires an external pullup resistor. The output is high whenever the PIC1665 is halted either due to an active input to the HALT/ACK pin or the execution of the HALT instruction. HALT/ACK will output a low when the PIC1665 resumes execution of the program. This pin must be grounded when it is not used. |
| D0-D12 (Input) | Data input. These thirteen lines accept the thirteen bit PIC instruction codes generated by an external source. DO is the LSB of the instruction. |
| A0-A10 (Output) | Address Output. These eleven lines represent the address of the next instruction to be executed by the PIC1665. They are capable of addressing up to 2048 words of memory. AO is the LSB of the address. |

## PIN CONFIGURATION <br> 64 LEAD DUAL IN LINE

| Top View |  |
| :---: | :---: |
|  | 64 7D5 |
| $\longrightarrow \mathrm{D6} \mathrm{Cl}^{2}$ | 63 D 4 4 |
| $\longrightarrow \mathrm{D7}^{3}$ | $62 \mathrm{P}^{\text {D } 3} \longleftarrow$ |
| $\longrightarrow \mathrm{D8} \mathrm{Cl}_{4}$ | 61 DD2 $\longleftarrow$ |
| $\longrightarrow$ D9 [5 | 60 DD1 $\leftarrow$ |
| $\longrightarrow$ D10 ${ }^{6}$ | $59 \square \mathrm{DO} \longleftarrow$ |
| $\longrightarrow$ D11 ${ }^{7}$ | 58 ®AO $\longrightarrow$ |
| $\longrightarrow \mathrm{D12}^{8}$ | $57 \square A 1 \longrightarrow$ |
| $\longleftrightarrow \mathrm{RCO} \mathrm{O}^{9}$ | 56 A A2 $\longrightarrow$ |
| $\longleftrightarrow$ RC1 ${ }^{\text {d }} 10$ | 55 A A3 $\longrightarrow$ |
| $\longleftrightarrow$ RC2 ${ }^{\text {a }} 11$ | $54 \square \mathrm{~A} 4 \longrightarrow$ |
| $\longleftrightarrow$ RC3 ${ }^{12}$ | $53 \square \mathrm{RB} 7 \longleftrightarrow$ |
| $\longleftrightarrow$ RC4 ${ }^{13}$ | 52马RB6 $\longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RC5}-14$ | 51]RB5 $\longleftrightarrow$ |
| $\longleftrightarrow$ RC6 ${ }^{\text {d }} 15$ | 50 RB4 $4 \longleftrightarrow$ |
| $\longleftrightarrow$ RC7 16 | 49 R R $3 \longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RDO}-17$ | 48]RB2 $\longleftrightarrow$ |
| $\longleftrightarrow$ RD1 18 | 47 RRB1 $\longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RD2} \mathrm{Cl}^{19}$ | $46 \square$ RB0 $\longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RD3} \mathrm{Cl}^{20}$ | 45 R RA7 $\longleftrightarrow$ |
| $\longleftrightarrow \mathrm{RD4} \mathrm{H}_{21}$ | $44 \square$ RA6 6 |
| $\longleftrightarrow$ RD5 ${ }^{22}$ | 43 RA5 $\longleftrightarrow$ |
| $\longleftrightarrow$ RD6 [23 | 42 R RA4 $4 \longleftrightarrow$ |
| $\longleftrightarrow$ RD7 ${ }^{\text {24 }}$ | $41 \square$ RA3 $\longleftrightarrow$ |
| $\longleftarrow$ CLK OUT ${ }^{\text {d }} 25$ | 40] RA2 $\longleftrightarrow$ |
| $\rightarrow \overline{\text { MCLR }}$ | $39 \mathrm{RA} 1 \longleftrightarrow$ |
| $\longleftrightarrow$ HALT ACK 27 | $38 \square \mathrm{RAO}$ ¢ |
| $\rightarrow$ RT ${ }^{28}$ | 37 Q A5 $\longrightarrow$ |
| $\longrightarrow \mathrm{V}_{D} \mathrm{H}^{29}$ | $36 \square$ A6 $\longrightarrow$ |
| $\longrightarrow$ OSC1-30 | 35 P A7 $\longrightarrow$ |
| $\longleftarrow$ OSC2 ${ }^{31}$ | 34 P A8 $\longrightarrow$ |
| $\longleftarrow \mathrm{A} 10 \mathrm{~L}_{-32}$ | 33 A A $\longrightarrow$ |

## REGISTER FILE ARRANGEMENT




## INTERRUPT SYSTEM

The interrupt system of the PIC1665 is comprised of an external interrupt and a real-time clock counter interrupt. These have different interrupt vectors, enable bits and status bits. Both interrupts are controlled by the status register (F5)** shown below.

*Bit 7 is unused and is read as zero
**Register 5 will power up to all zeroes

## EXTERNAL INTERRUPT

On any high to low transition on the $\overline{R T}$ pin the external interrupt request (XIR) bit will be set. This request will be serviced if the external interrupt enable (XIE) bit is set or if it is set at a later point in the program. The latter allows the processor to store a request (without interrupting) while a critical timing routine is being executed. Once exțernal interrupt service is initiated, the processor will clear the XIR bit, delay one cycle (to execute the current instruction), then push the current program counter on to the stack and execute the instruction at location $1760_{8}$. It takes three to four instruction cycles from the transition on the RT pin until the instruction at $1760_{8}$ is executed. No new interrupts can be serviced until a return from interrupt (RETFI) instruction has been executed.

## REAL-TIME CLOCK INTERRUPT

The real-time clock counter (RTCCA \& RTCCB, file registers F6 and F7) have a similar mechanism of interrupt service. The RTCCA register will increment if the count enable (CNTE) bit is set. If this bit is not set the RTCCA \& RTCCB will maintain their present contents and can therefore be used as general purpose RAM registers. The count source (CNTS) bit selects the clocking source for RTCCA. If CNTS is cleared to a ' 0 ', then RTCCA will use the internal instruction clock and increment at $1 / 8$ the frequency present on the OSC pins. If CNTS is set to a ' 1 ', then RTCCA will increment on each high to low transition of the RT pin. RTCCB can only be incremented when RTCCA makes a transition from $377_{8}$ to 0 and the $A / B$ status bit is set. This condition links the two eight bit registers together to form one sixteen bit counter. An interrupt request under these conditions will occur when the combined registers make a transition from $177777_{8}$ to 0 . If, however, the $A / B$ bit is not set, then RTCCA will be the only incrementing register and an interrupt request will occur when RTCCA makes a transition from $377_{8}$ to 0 . (In this setup the

RTCCB register will not increment and can be used as a general purpose RAM register). Once a request has come from the realtime clock counter, the real-time clock interrupt request (RTCIR) bit will be set. At this point, the request can either be serviced immediately if the real-time clock interrupt enable (RTCIE) bit is set or be stored if RTCIE is not set. The latter allows the processor to store a real-time clock interrupt while a critical timing routine is being executed. Once interrupt service is initiated, the processor will clear the RTCIR bit, delay one cycle (to execute the current instruction), then push the present program counter on to the stack and execute the instruction at location 1740 . It takes three instruction cycles from when the RTCC (A or B) overflows until the instruction at $1740_{8}$ is executed. No new interrupts can be serviced until a RETFI instruction has been executed.
The RETFI instruction $\left(00002_{8}\right)$ must be used to return from any interrupt service routine if any pending interrupts are to be serviced. External interrupts have priority over RTCC driven interrupt in the event both types occur simultaneously. Interrupts cannot be nested but will be serviced sequentially. The existence of any pending interrupts can be tested via the state of the XIR (bit 2) and RTCIR (bit 3) in the status word F5.

## HALT OPERATION

Program execution in the PIC1665 can be suspended in two ways. The first is by applying a logic high input level on the HALT/ACK pin when CLKOUT is low The operation of the PIC1665 will be suspended until the HALT/ACK pin is brought low. At that point program execution will begin with the next instruction present on the Data Lines. Program execution can also be suspended using the HALT instruction. In order to restart the PIC1665 after execution of a HALT instruction, the MCLR pin must be brought low, or the HALT/ACK pin must be brought high for one complete cycle and then low again.
In both cases, when CLKOUT is high, the HALT/ACK pin will output a high level whenever the PIC1665 is in the halt mode provided an external pullup resistor is used.
When the PIC1665 is in the halt mode the RTCCA and RTCCB registers cannot be incremented by the internal clock, or by high to low transitions on the $\overline{\operatorname{RT}}$ pin. If a high to low transition occurs on the $\overline{R T}$ pin, then the XIR bit (Bit 2 of file 5 ) will be set. If the XIE bit (bit 0 of file 5 ) is set, then an interrupt will occur immediately after program execution begins.

## TYPICAL HALT CIRCUIT



## Basic Instruction Set Summary

Each PIC instruction is a 13-bit word divided into an OP code which specifies the instruction type and one or more operands which further specify the operation of the instruction The following PIC instruction summary lists byte-oriented, bit-oriented, and literal and control operations
For byte-oriented instructions, " $f$ " represents a file register designator and " $d$ " represents a destination designator The file register designator specifies which one of the PIC file registers is to be utilized by the instruction The destination designator specifies where the result of the operation performed by the instruction is to be placed if " $d$ " is zero, the result is placed in the PIC $W$ the PIC W
register If " $d$ " is one, the result is returned to the file register specified in the instruction
For bit-oriented instructions, " $b$ " represents a bit field designator which selects the number of the bit affected by the operation, while " $f$ " represents the number of the file in which the bit is located
For literal and control operations, " $k$ " represents an eight or nine bit constant or literal value
For an oscillator frequency of 5 MHz the instruction execution time is $2.0 \mu \mathrm{sec}$, unless a conditional test is true or the program counter is changed as a result of an instruction in these two cases, the instruction execution time is $4.0 \mu \mathrm{sec}$.


|  |  |  |  |  |  | (12-6) (5) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | OP CODE | f (FILE \#) |  |  |  |  |
| Instruction-Binary (Octal) |  |  |  |  |  | Name |  | Mnemon | perands | Operation | Status Affected |
| 1 | 000 | 000 | f f f | fif | (10000) | Move file to W |  | MOVFW | f | $t-\mathrm{w}$ | z |
| 1 | 000 | 001 | $f \mathrm{ff}$ | fif | (10100) | Clear file |  | CLRF | f | 0-1 | Z |
| 1 | 000 | 010 | $f \mathrm{ff}$ | $f$ ff | (10200) | Rotate file right | carry | RRNCF | f | $f(\mathrm{n})-\mathrm{d}(\mathrm{n}-1), \mathrm{f}(0), \rightarrow f(7)$ | - |
| 1 | 000 | 011 | $f f$ f | $f \mathrm{ff}$ | (10300) | Rotate file lett/n |  | RLNCF | f | $f(\mathrm{n}) \rightarrow \mathrm{d}(\mathrm{n}+1), \mathrm{f}(7), \rightarrow \mathrm{f}(0)$ | - |
| 1 | 000 | 100 |  | fif | (10400) | Compare file to | skip if $\mathrm{F}<\mathrm{W}$ | CPFSLT | f | $f-W$, Skıp if $\mathrm{C}=0$ | - |
| 1 | 000 | 101 | $f \mathrm{ff}$ | $f$ fif | (10500) | Compare file to | skip if $F=W$ | CPFSEQ | f | $f-W$. Skıp if $Z=1$ | - |
| 1 | 000 | 110 | fif | f f ${ }^{\text {f }}$ | (10600) | Compare file to | skip if $F>W$ | CPFSGT | $f$ | $\mathrm{f}-\mathrm{W}$. Skıp if $\bar{Z} \cdot \mathrm{C}=1$ | - |
| 1 | 000 | 111 | $f$ f f | ffif | (10700) | Move file to itse |  | TESTF | - | $t \rightarrow 1$ | z |





Note 1:
DAW: Decimal Adjust W
This instruction adjusts the eight bit number in the $W$ regıster to form two valıd BCD (binary coded decımal) digits, one in the lower and one in the upper nibble (The results will only be meaningful if the number in $W$ to be adjusted is the result of adding together two valıd two digit BCD numbers.)
The adjustment obeys the following two step algorithm.

1. If the lower nibble is greater than 9 or the digit carry flag (DC) is set, 06 is added to the $W$ register.
2. Then, if the upper nibble is greater than 9 or the carry from the original or step 1 addition is set, 60 is added to the $W$ register. The carry bit is set if there is a carry from the original, step 1 or step 2 addition


PIC1665

## INPUT/OUTPUT CAPABILITY

The PIC1665 provides four complete quasi-bidirectional input/ output ports. A simplified schematic of an I/O pin is shown below. The ports occupy address locations in the register file space of the PIC1665. Thus, any instruction that can operate on a general purpose register can operate on an I/O port. Two locations in the register file space are allocated for each I/O port. Port RAO-7 is addressable as either F10 or F11. Port RB0-7 is addressable as either F12 or F13. Port RC0-7 is addressable as either F14 or F15 and Port RDO-7 is addressable as either F16 or F17. An I/O port READ on its odd-numbered location will interrogate the chip pins while an I/O port READ on its even-numbered location will interrogate the internal latch in that I/O port. This simplifies programming in cases where a portion of a single port is used for inputting only, while the remainder is used for outputting as illustrated in the following example.


Here, the low 3 bits of port RA are used as output-only, while the high 5 bits are used as input-only. During power on reset (MCLR low), the latches in the I/O ports will be set high, turning off all pull down transistors as represented by $\mathrm{Q}_{2}$ in Figure 1. During program execution if we wish to interrogate an input pin, then, for example,

BTFSS 11,6
will test pin RA6 and skip the next instruction if that pin is set. If we wish to modify a single output, then, for example,

BCF 10,2
will force RA2 to zero because its internal latch will be cleared to zero. This will turn on $A_{2}$ and pull the pin to zero.
The way this instruction operates internally is the CPU reads file 10 into the A.L.U., modifies the bit and re-outputs the data to file 10. If the pins were read instead, any input which was grounded externally would cause a zero to be read on that bit. When the CPU re-outputted the data to the file, that bit would be cleared to zero, no longer useful as an input until set high again.
During program execution, the latches in bits 3-7 should remain in the high state. This will keep $A_{2}$ off, allowing external circuitry full control of pins RA3-RA7, which are being used here as input.

## BIDIRECTIONAL INPUT-OUTPUT PORT



Figure 1

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Ambient Temperature Under Bias ...................................... $70^{\circ} \mathrm{C}$
Storage Temperature ..................................... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots \ldots \ldots . .$.
Power Dissipation . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 1000mW
Standard Conditions (unless otherwise stated):
DC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ ${ }^{\dagger}$ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.5 | - | 5.5 | V |  |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | - | 100 | mA | All I/O pins high |
| Input Low Voltage (except $\overline{\text { MCLR }} \& \overline{\mathrm{RT}}$ ) | $\mathrm{V}_{\text {IL }}$ | 0.2 | - | 0.8 | V |  |
| Input High Voltage (except MCLR, RT, OSC1) | $\mathrm{V}_{\mathrm{IH} 1}$ | 2.4 | - | $V_{D D}$ | V |  |
| Input High Voltage ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RT}}$, OSC1) | $\mathrm{V}_{\mathrm{IH} 2}$ | $V_{D D}{ }^{-1}$ | - | $V_{D D}$ | V |  |
| Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $V_{D D}$ | V | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A} \text { provided by } \\ & \text { internal pullups (Note 2) } \end{aligned}$ |
| Output Low Voltage (I/O, AO-A9, HALT ACK, CLK OUT) | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Input Leakage Current ( $\overline{\mathrm{MCLR}}, \overline{\mathrm{RT}}, \mathrm{OSC} 1)$ | $\mathrm{I}_{\mathrm{LC}}$ | -5 | - | +5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\mathrm{DD}}$ |
| Input Low Current (all I/O ports) | $\mathrm{I}_{\mathrm{IL}}$ | 0.2 | 0.6 | -2.0 | mA | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$, internal pullup |
| Input High Current (all I/O ports) | $\mathrm{I}_{\mathrm{IH}}$ | 0.1 | 0.4 | - | mA | $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}$ |

$\dagger$ Typical data is at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$.
NOTES:

1. Total power dissipation for the package is calculated as follows:

$$
P_{D}=\left(V_{D D}\right)\left(I_{D D}\right)+\Sigma\left(V_{D D}-V_{L L}\right)\left(I_{L L}\right)+\Sigma\left(V_{D D}-V_{O H}\right)\left(I_{O H}\right)+\Sigma\left(V_{O L}\right)\left(I_{O L}\right) .
$$

2. Positive current indicates current into pin. Negative current indicates current out of pin.
3. Total $\mathrm{I}_{\mathrm{OL}}$ for all output pin (I/O ports plus CLK OUT) must not exceed 175 mA .

Standard Conditions (unless otherwise stated):
AC CHARACTERISTICS
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Instruction Cycle Time | $\mathrm{t}_{\mathrm{cy}}$ | 2.0 | - | 8 | $\mu \mathrm{~s}$ | $4 \mathrm{MHz}-.1 \mathrm{MHz}$ external time base <br> (Note 1) |
| $\overline{\text { RT Input }}$ |  |  |  |  |  | (Note 2) |
| Perıod | $\mathrm{t}_{\mathrm{RT}}$ | $\mathrm{t}_{\mathrm{Cr}}+0.2 \mu \mathrm{~s}$ | - | - | - | $($ Notes 2 and 3) |
| High Pulse Width | $\mathrm{t}_{\mathrm{RTH}}$ | $1 / 2 \mathrm{t}_{\mathrm{RT}}$ | - | - | - |  |
| Low Pulse Width | $\mathrm{t}_{\mathrm{RTL}}$ | $1 / 2 \mathrm{t}_{\mathrm{RT}}$ | - | - | - |  |
| I/O Ports |  |  |  |  |  |  |
| Data Input Setup Time | $\mathrm{t}_{\mathrm{s}}$ | - | - | $1 / 4 \mathrm{t}_{\mathrm{cy}}-125$ | ns |  |
| Data Input Hold Time | $\mathrm{t}_{\mathrm{n}}$ | 0 | - | - | ns |  |
| Data Output Propagation Delay | $\mathrm{t}_{\mathrm{pd}}$ | - | 500 | 800 | ns | Capacitive load =50pF |
| HALT ACK Output Propagation Delay | $\mathrm{t}_{\mathrm{HA}}$ | - | 200 | - | ns |  |
| A0-A9 Output Propagation Delay | $\mathrm{t}_{\mathrm{AD}}$ | - | 350 | - | ns |  |
| D0-D12 Input Set-Up Time | $\mathrm{t}_{\mathrm{DS}}$ | 0 | - | - | ns |  |
| D0-D12 Input Hold Time | $\mathrm{t}_{\mathrm{DH}}$ | 200 | - | - | ns |  |

## NOTES:

1. Instruction cycle period ( $\mathrm{t}_{\mathrm{cy}}$ ) equals eight times the input oscillator time base period.
2. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the $\overline{R T}$ input, CLK OUT may be directly tied to the $\overline{\mathrm{RT}}$ input. The minimum times specified represent theoretical limits.
3. The maximum frequency which may be input to the $\overline{\text { RTCC }}$ bin is calculated as follows: $f_{(\max )}=\frac{1}{f_{\text {RT (min) }}}=\frac{1}{f_{C Y(\text { min })}+0.2 \mu \mathrm{~s}}$ For example: if $\mathrm{t}_{\mathrm{CY}}=4 \mu \mathrm{~s}, \mathrm{f}_{(\text {max })}=\frac{1}{4.2 \mu \mathrm{~s}}=238 \mathrm{KHz}$.
$\square$



## SCHMITT TRIGGER CHARACTERISTICS (Typical)

$(\overline{\mathrm{RT}}, \overline{\mathrm{MCLR}}) \mathrm{T}_{\mathrm{A}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$


## PIC1665 OSCILLATOR OPTIONS (Typical Circuits)

LC Operation


$$
\begin{gathered}
\mathrm{f}_{\mathrm{OSC}} \approx \frac{1}{2 \pi \sqrt{L_{\left(C_{\mathrm{L}}+C_{I N T}\right)}}}, \\
\text { where } \mathrm{C}_{\text {INT }}=10 \mathrm{pF} .
\end{gathered}
$$

Typical values for 4 MHz operation: $\mathrm{L} \approx 70 \mu \mathrm{H}$ $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$

CRYSTAL INPUT OPERATION


* or ceramic resonator,
parallel resonant
( $0.8-5.0 \mathrm{MHz}$ ).

EXTERNAL CLOCK INPUT OPERATION

$\square$

MASTER CLEAR (Typical Circuit)


Master Clear requires 10 ms delay (assuming a 5 MHz crystal) before activation after power is applied to the $\mathrm{V}_{\mathrm{DD}}$ pin, for the crystal to start up. To achieve this, an external RC configuration as shown can be used (assuming $V_{D D}$ is applied as a step function).

## OUTPUT SINK CURRENT GRAPH



The Output Sink Current is dependent on the output load. This chart shows the typical curve used to express the output drive capability.
$\mathrm{V}_{\mathrm{OH}}$ VS $\mathrm{I}_{\mathrm{OH}}$ (I/O PORTS)


## PICAL/PICES II

| FUNCTION |  | PART | PAGE <br> NUMBER |
| :---: | :---: | :---: | :---: | :---: |
| NUMBER |  |  |  |
| PICASSEMBLER | Converts symbolio source programe for PIC series into object code. | PICAL | 4 -132 |
| PIC DEVELOPMENT <br> SYSTEM: | In-circuit emutation and debug system-stand atone or peripheral. | PICES II | $4-134$ |

## PICAL

## PIC Cross Assembler

## FEATURES

- Symbolic machine operation codes (opcodes, mnemonics)
- Symbolic address assignment and reference
- Relative addressing
- Data creation statements
- Storage reservation statements
- Assembly listing control statements
- Character codes may be specified as ASCII or EBCDIC
- Addresses can be generated as constants
- Comments and remarks may be encoded for documentation
- Cross reference table listing


## DESCRIPTION

The PICAL Cross Assembler is used for the General Instrument family of microcomputers including the PIC1650A, 1654, 1655A, 16C55, 1656, 1670, 1671 and 1672. The function of this Cross Assembler program is to translate the Symbolic Code into the machine code required by the actual processors. The assembler program is written in Fortran IV to achieve compatibility with most computer systems, including those manufactured by DEC, Data General, Hewlett-Packard, Xerox, and others. It is modular and may be executed in an overlay mode should memory restrictions make that necessary. The program is approximately 3850 Fortran card images in length, $20 \%$ of which are comments. The program is written in ANSI standard Fortran IV and no facility peculiar to one machine was utilized. This was done in order to eliminate Fortran compatibility problems.
The mnemonic Operation Codes are identical to those used in other PIC literature and in other software products. This has been done to eliminate any possible problems of program compatibility and to obviate the necessity of learning new assembly languages. In addition, several directives and features are implemented and described in the PICAL Users Manual.
The assembler is a two pass program that builds a symbol table, issues helpful error messages, produces an easily read program listing and symbol table, and creates an object and symbol table module.
The assembler features macro capability, symbolic and relative addressing, forward references, complex expression evaluation, cross reference listing and a versatile set of directives.
The assembler program, written in Fortran, is usually supplied as 9 track, $1600 \mathrm{BPI}, 80$ column card image records, unblocked and unlabeled magnetic tapes in either EBCDIC or ASCII code. The label on the tape reel will clearly specify the information.
The program is also supplied in compiled version for appropriate media and machines, including the Data General $\mu \mathrm{Nova}^{\circledR}$ system.

## ASSEMBLER LANGUAGE

An assembly language program is written in symbolic machine language. It is comprised of statements. A statement is either a symbolic instruction, a directive statement, a macro statement, or a comment.
The symbolic machine instruction is a written specification for a particular machine operation expressed by symbolic operation codes and sometimes symbolic addresses or operands.
A directive statement is a statement which is not translated into a
machine instruction, but rather is interpreted as a directive to the assembler program.
Statements are always written in a particular format. This format is depicted below.
$\longdiv { \text { Label field operation field operand field comment field } }$

## SYNTAX

The Assembler Language is a language like any other. That is, it has a character set, vocabulary, rules of grammar, and allows for individuals to define new words or elements. The rules that describe the language are termed the syntax of the language.
For an expression or statement in assembler language to be translated by the assembly program it must be written correctly in accord with the rules of syntax.
A symbol is a sequence of characters. The first character in a symbol must be alphabetic or the special characters ?, \$, or \&. Special characters except for the above three may not be used in a symbol. Imbedded blanks are not permitted. The user is cautioned not to use symbols that start with the? character as the assembler generates "local" symbols starting with this character.
Only the first six characters of a symbol are used by the Assembler to define that symbol; the remaining characters are for documentation. The parameter that dictates the number of characters used to define a symbol may be changed in the Fortran Source code.
A constant is an invariant quantity. It may be an arithmetic value or a character code. There are several ways of specifying constants in this assembler language.
Octal constants may be defined as a sequence of numeric characters optionally preceded by a plus sign or a minus sign. If unsigned, the value is assumed to be positive. Decimal constants are defined in the same manner but preceded by a decimal point.
In most cases constants must be contained in one 8 bit word. A constant can contain an unsigned number with a value from 0 to 255. When a constant is negative its equivalent two's complement representation is generated and placed in the field specified. An eight bit two's complement number can range from -128 to +127 . Whenever an attempt is made to place a constant in a field for which it is too large, an error message is generated by the assembler.
An expression is a sequence of one or more symbols, constants, or other expressions separated by the arithmetic operators,+- , *, /. Parentheses are used in the normal manner to establish the correct order of the arithmetic operators. Expressions are evaluated left to right with multiplication and division being performed before addition and subtraction.
The expression must resolve to a single unique value. All expressions are evaluated modulo 65536 and hence are all 16 bit quantities. In most cases the value of the final expression must be contained in a 12 bit word.

## DIRECTIVES

The directives or pseudo-operations are written as ordinary statements in the assembler language, but rather than being translated into equivalent machine language, they are interpreted as commands to the assembler itself.
Through use of these directives, the Assembler will reserve memory space, define bytes of data, control the listing, assign values to symbols, etc.

The directives are:

| ORG | Set Program Origin |
| :--- | :--- |
| END | End of Assembly |
| EQU | Equate a Symbol to an Expression |
| SET | Set a Symbol equal to an Expression |
| DATA | Data Definition |
| RES | Reserve Storage |
| ZERO | Reserve Storage and fill with zeros |
| PAGE | Advance Listing Form to next page |
| SPAC | Space lines on listing |
| TITLE | Set Program Heading |
| LIST | List the Elements Specified |
| OPTION | Set Program Options (same as LIST) |
| NLIST | Suppress listing of the Elements Specified |
| IF | Conditional Assembly Statement |
| ELSE | Conditional Assembly Statement Converse |
| ENDIF | End Conditional Assembly Code |

## MACROS

A macro is a sequence of instructions that can be inserted in the assembly source text by encoding a single instruction, the macro call. The macro definition is written only once and can be called any number of times. The macro definition may contain parameters which can be changed for each call. The macro facility simplifies the coding of programs, reduces the chance of programmer error, and makes programs easier to understand as the source code need only be changed in one location, the macro definition.
A macro definition consists of three parts: a heading, a body, and a terminator. This definition must precede any macro call. A macro may be redefined at any time with the latest definition of a macro name applying to a macro call. A standard assembler mnemonic (e.g. CLRF) may also be redefined by defining a macro with the name CLRF. In this case all subsequent uses of the CLRF instruction in the program will cause the macro to be expanded. The PIC assembler which is precompiled for the InteI MDS® does not have a MACRO capability due to the possibly limited memory space available.

## USING THE ASSEMBLER

The Assembler is written entirely in Fortran and is comprised of a main program and several subroutines. The main program appears first on the tape and the last subroutine is followed by a tape mark. The Assembler may be compiled from the tape.
The Assembler should be compiled and its object module stored on some secondary storage device. If desired, the Assembler may be compiled and linked to perform in the overlay mode. Communications between subprograms is via blank common and subroutine call parameters.
The Assembler is a two pass Assembler wherein the source code is scanned twice. During the first pass the labels are examined and placed into a symbol table. Certain errors may be detected during Pass One; these will be displayed on the output listing.
During Pass Two, the object code is completed, symbolic addresses resolved, a listing and object module are produced. Certain errors, not detected during Pass One may be detected and displayed on the listing.
At the end of the Assembly process a symbol table or cross reference table may be displayed.
The following steps are taken to assemble a source program:

1. Write a program utilizing the instruction mnemonics of the PIC Instruction Set and directives. Encode the argument fields with constants, labels, symbolic addresses, etc.
2. Transfer the source program to some computer readable medium; cards, tape, etc. This medium should correspond to the input device expected by the Assembler. On some systems device assignments may be changed during the course of an assembly by utilizing proper system control cards.
3. Load the source code
4. Execute the Assembler Program.
5. Get listing and object module as output.

During Pass Two of the assembly process a program listing is produced. The listing displays all information pertaining to the assembled program, both assembled data and the users original source statements.
The listing may be used as a documentation tool through the inclusion of the comments and remarks that describe the function of the particular program segment.
The main purpose of the listing is to convey all pertinent information about the assembled program, i.e. the memory addresses and their contents. The load module, also produced during Pass Two, contains the address and content information but in a format that can be read by people only with great effort.

## TYPICAL ASSEMBLER LISTING



## USERS MANUAL

A complete description of the PICAL Cross Assembler program with detailed explanations of how it is used is contained in the PICAL Users Manual.

## PICES II

## PIC In-Circuit Emulation System

## FEATURES

- Complete in-circuit emulation and debug capability
- Multiple system configurations to match user requirements
- Standard serial interface for system integration
- Powerful 16-bit microprocessor for system control
- Multiple breakpoints, single step, program trace and editing capabilities
- On-board diagnostics for system hardware troubleshooting


## DESCRIPTION

The PICES II is an in-circuit emulation and debug system designed to provide the user with a complete tool for testing, troubleshooting, and modifying both the software program for the PIC circuit as well as the total system application. The PICES II is a self-contained unit which can operate in a stand-alone configuration or as a peripheral device to a host processor.

## ARCHITECTURE

The PICES II system contains two processors. The User Processor is a ROM-less PIC microcomputer with external RAM. With the RAM loaded with the user's application program, the ROMless PIC emulates the operation of the entire PIC family. An 18, 28 or 40 pin in-circuit emulation cable attaches the ROM-less PIC to the application system. The Control Processor is a CP1600 sixteen bit microprocessor with 12 K of program ROM and 2 K of RAM. This processor controls the functions of the PICES II including I/O interfacing, manipulation of the User Processor and interpretation and execution of the PICES II command set.

## OPERATION

STAND-ALONE MODE: The PICES II is attached directly to a serial I/O device; typically a teletype. The user program is entered either using the paper tape reader/punch unit on the teletype or by manually setting each location in the PIC program memory to the desired value. Once the program memory is loaded, all PICES II emulation and debug commands can be issued on the teletype keyboard and PICES II responses are returned on the teletype printer. The serial interface can be either RS232C or current loop and the baud rate is switch selectable.
PERIPHERAL MODE: The PICES II can be configured such that the unit itself is peripheral to another computer system. The PICES II can be attached as an additional peripheral device or in

## PIC IN-CIRCUIT EMULATION SYSTEM


series with the system TTY or CRT device. In this mode the user's computer facility can become a one station total development system. The computer text editor is used to develop the PIC source code. The Fortran PIC cross assembler will translate this source code into PIC machine code; the machine code is then downloaded into the PICES II. All PICES II commands are entered through the system terminal. Minor modifications can be done directly to the PICES II. Major changes require re-editing the source code, re-assembling and loading of the PICES II.

## DATA MANUAL

A detailed PICES II Data Manual is available. This manual describes the installation and operation of the PICES II system. Included in the manual are explanations of the command set with examples for illustration.


## INSTRUNERAL

## PIC Field Demo Systems

| PUNCTION: | $\therefore$ DESCRIPTION | PART NUMBER | PACE NUMBER |
| :---: | :---: | :---: | :---: |
| PIC FIELDDEMO SWSTEMS | Contains PIC microcomputer, PROMs and provistons for on-board RC oscillator or external clock. | PFD <br> Systems | 4-138 |

## PFD SYSTEMS

## PIC Field Demo Systems

## FEATURES

- Single +5 V operation
- On-board clock
- Optional external clock and reset
- Program storage in EPROM
- Dimensions: $4^{\prime \prime} \times 438^{\prime \prime}$
- In circuit emulation cable length: 14"


## DESCRIPTION

The PIC Field Demo Systems provide the user with a compact and portable method of evaluating and demonstrating application performance before the commitment is made to ROM masking of the PIC circuit. The PFD systems consist of a single printed circuit module containing a ROM-less PIC microcomputer with external Erasable/Programmable Read Only Memory (EPROM) attached. The EPROM contains the user's application program. An 18, 28 or 40 lead ribbon cable attaches to the PFD Module terminating with a DIP plug providing emulation of the PIC circuit in the application.
Provision for jumper options on the PFD Series module allows the user to select various modes of operation as appropriate to the application. Internal or external clock and power supply is available.

## ORDERING INFORMATION

The PFD Module comes complete with a ROM-less PIC microcomputer. EPROMs and an in-circuit-emulation cable. Order the module to emulate the particular PIC circuit to be emulated.

| TARGET |
| :---: | :---: |
| MICROCOMPUTER |$\quad$ PFD SYSTEM | PIC1650 | PFD1000 |
| :---: | :---: |
| PIC1654 | PFD1007 |
| PIC1655 | PFD1000 |
| PIC1656 | PFD1010 |
| PIC16C55 | PFD2010 |
| PIC1670 | PFD1020 |

DATA MANUAL
A complete description of the PFD systems are contained in the PIC Field Demo Systems Data Manual.


## EXTENDED TEMPERATURE RANGE

PIC series microcomputers are available in two temperature ranges. The preceding data sheets describe the commercial grade device, $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ centigrade. An industrial/automotive temperature range version is available. The $-40^{\circ}$ to $85^{\circ}$ centigrade option is specified with the addition of a suffix, $I$, to the part number.

The specifications for these devices differ from their commercial grade counterparts in a few electrical parameters, typically interface voltage/current levels. Refer to the data sheets for details.

## OPEN DRAIN OPTIONS

## PIC1650A, PIC1670

## Open-Drain I/O Ports

Any or all of the I/O lines may be specified by the customer to be open drain, that is, the internal pull-up device will be removed. This enables the outputs to be pulled up to +10.0 V maximum with an external pull-up resistor, allowing easy interface to external devices requiring a logic one level greater than $V_{D D}$ of the PIC. In the logic one state, the leakage current of the $1 / O$ port is $\pm 5 \mu \mathrm{~A}$, maximum.
The customer shall specify on the "PIC Series Order Form" the pin number and port name (e.g., "RB3") of each port required to be open drain.

## PIC1655A, PIC1656

Open Drain I/O, Input and Output Ports
Any or all of the I/O, input only or output only lines may be specified by the customer to be open drain, that is, the internal pull-up device will be removed. This enables the outputs to be pulled up to +10.0 V maximum with an external pull-up register, allowing easy interface to external devices requiring a logic one
level greater than $V_{D D}$ of the PIC. In the logic one state, the leakage current of the I/O port is $\pm 5 \mu \mathrm{~A}$, maximum.

The customer shall specify on the "PIC Series Order Form" the pin number and port name (e.g., "RB3") of each port required to be open drain.

## PIC16C55

Input-only, Output-only and I/O Ports
Any or all of the input-only and I/O lines may be specified to have an internal pull-up resistor inserted via a mask option. This allows easy interface to an external transistor or switch without the need for an external pull-up resistor. Furthermore, any or all of the output-only or I/O pull-down transistors can be specified to be removed via a mask option. This facilitates interfacing with external circuitry which has signal swings below $\mathrm{V}_{\mathrm{SS}}$. In this case the maximum voltage permitted to be applied to the pin is -12 V with respect to $V_{D D}$

## PIC1654

Optional Internal Connection to RTCC
A mask option will allow an internal clock signal whose period is equal to the instruction execution time to drive the real time clock/counter register. In this mode, transitions in the $\overline{\text { TTCC }}$ pin will be disregarded.

## PIC1655XT

## Prescaler Division Ratio

A mask option will allow the division ratio of the RTCC prescaler to be selected as $1,2,4,8$ or 16 . Consult the data sheet for the details.

Customer Name
Address


PIC PART NUMBER
CUSTOMER MARKING REQUIREMENT: STANDARD ■ SPECIAL■ $\qquad$
PIC TEMPERATURE RANGE SELECTION:
$0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C} \square-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ 口

OPEN DRAIN OPTION:
Are any pins to have their internal pull-up resistor removed? (In the case of PIC16C55, are any input-only or I/O pins to have an internal pull-up resistor inserted?) YES $\square$ NO $\square$
In the case of the PIC16C55, are any output-only or I/O pins to have the internal pull-down transistor removed. YES $\square$ NO $\square$
If the answer to any of the above questions is yes, please complete the chart below for all I/O pins. YES $\square$ NO $\square$

$\begin{array}{ll}\text { Speech Synthesis } & 5-3 \\ \text { Sound Generation } & 5-17\end{array}$

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
|  |  | Speech Synthesis |  |
| $\begin{aligned} & \text { NARRATOR } \\ & \text { SPEECH } \\ & \text { PROCESSOR } \end{aligned}$ | Natural speech, stand alone operation, wide operating voltage, expandable ROM, simple interface. | SP0256 | 5-5 |
|  |  | SP0256-AL2 | 5-9 |
|  |  | SP0232 | $5-9$ |
|  |  | SPRD000 | 5-9 |
| VOICE SYNTHESIS MODULE | Complete speech system, 16 seconds of speech, custom vocabutaries, simple interface, 5 V operation. | VSM2032 | 5-10 |
| SPEECH SYNTHESIZER | High quality speech, programmable filter, 5 V operation, simple interface, double buffered input | SP0250 | 5-12 |
| SPEECH FIELD DEVELOPMENT BOARD | 5 V operation, expandable EPROM, multiple speech synthesis, on-board oscillator. | SFD2000 | 5-15 |
|  |  | Sound Generation |  |
| PROGRAMMABLE SOUND GENERATOR | Full software control, $5 V$ operation, simple interface, triple analog output, general purpose $1 / 0$ porss. | AY-3-8910 | 5-18 |
|  |  | AY-3-8912 | 5-18 |
|  |  | AY-3-8913 | 5-18 |
| TUNES SYNTHESIZEF | Produces musical tunes from pre-programmed microcomputer. | AY-3-1350 | 5-26 |

## Speech Synthesis

| - FUNCTEN | DESCRIPTION | PART NUMBER | PACF <br> NUNBER |
| :---: | :---: | :---: | :---: |
| NAFFATOR ${ }^{\text {™ }}$ SPEECH PROCESSOR | Natural speech, stand alone operation, wide operating voltage, expandable POM, simple interface. | SP0256 | 5-5 |
|  |  | \$P0256-A12 | 5-9 |
|  |  | SP0232 | 5-9 |
|  |  | \$PR000 | 5-9. |
| VOICE SYNTHESIS MODULE | Complete speech system, 16 seconds of speech, custom vocabularies, simple interface $5 V$ operatión. | VSM2032 | $5-16$ |
| $\begin{gathered} \text { SPEECH } \\ \text { SYNTHESIZER } \end{gathered}$ | High qualfy speech, programmable filter, 5 V operation, simple interface, double buffered input: | SP0250 | 5-12 |
| SPEECH FIELD DEVELOPMENT BOARD | SV operation, expandabie EPROM, muttipla speech synthesis, on+board oscitator. | SFPR000 | 5-1艁 |



## SP0256

## Narrator ${ }^{\text {TM }}$ Speech Processor

## FEATURES

- Natural Speech
- Stand Alone Operation with Inexpensive Support Components
- Wide Operating Voltage
- Word, Phrase, or Sentence Library, ROM Expandable
- Expandable to 491 K of ROM Directly
- Simple Interface to Most Microcomputers or Microprocessors
- Supports L.P.C. Synthesis: Formant Synthesis: Allophone Synthesis


## GENERAL DESCRIPTION

The SP0256 (Speech Processor) is a single chip N-Channel MOS LSI device that is able, using its stored program, to synthesize speech or complex sounds.
The achievable output is equivalent to a flat frequency response ranging from 0 to 5 KHz , a dynamic range of 42dB, and a signal to noise ratio of approximately 35 dB .
The SP0256 incorporates four basic functions:

- A software programmable digital filter that can be made to model a VOCAL TRACT.
- A 16K ROM which stores both data and instructions (THE PROGRAM).
- A MICROCONTROLLER which controls the data flow from the ROM to the digital filter, the assembly of the "word strings" necessary for linking speech elements together, and the amplitude and pitch information to excite the digital filter.
- A PULSE WIDTH MODULATOR that creates a digital output which is converted to an analog signal when filtered by an external low pass filter.


## PIN CONFIGURATION <br> 28 LEAD DUAL IN LINE



APPLICATIONS

- Telecommunications
- Appliances
- Computer Peripherals
- Automotive
- Personal Computers
- Toys/Games
- Educational Aids



## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$V_{D 1}, V_{D D}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-0.3 V$ to $+12 V$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Clock
Crystal Frequency . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 3.12MHz

## DC CHARACTERISTICS

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Primary Supply Voltage | $V_{D D}$ | 4.6 | - | 7 | V |  |
| Standby Supply Voltage | $V_{D 1}$ | 4.6 | - | 7 | V |  |
| Primary Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | - | 90 | mA | $\mathrm{V}_{\text {D1 }}, \mathrm{V}_{\text {DD }}=7.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |
| Standby Supply Current | $\mathrm{I}_{\mathrm{D} 1}$ | - | - |  | mA | $\mathrm{V}_{\text {SS }}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |
| Inputs <br> A1-A8, $\overline{A L D}$, SER IN, TEST, SE Logic 0 | $\mathrm{V}_{\text {IL }}$ | 0 | - | 0.6 | V |  |
| Logic 1 | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{D} 1}$ | V |  |
| Capacitance | $\mathrm{C}_{\text {IN }}$ | - | - | 10 | pf |  |
| Leakage | $\mathrm{I}_{\mathrm{LC}}$ | - | - | $\pm 10$ | $\mu \mathrm{A}$ |  |
| $\overline{\text { RESET, }} \overline{\text { SBY RESET }}$ Logic 0 | $\mathrm{V}_{\text {IL1 }}$ | 0 | - | 0.6 | V |  |
| Logic 1 | $\mathrm{V}_{\mathrm{IH} 1}$ | 3.6 | - | $\mathrm{V}_{\mathrm{D} 1}$ | V |  |
| Oscillator Leakage OSC 1 | - | 1.0 | - | 10 | $\mu \mathrm{A}$ | No Load, OSC1 $=7.0 \mathrm{~V}$ |
| Outputs <br> SBY, DIGITAL OUT, C1, C2, C3, $\overline{L R Q}$, ROM DISABLE, ROM CLOCK, SER OUT Logic 0 | $\mathrm{V}_{\mathrm{OL}}$ | 0 | - | 0.6 | V | 0.72mA (2 LS TTL Loads) |
| Logic 1 | $\mathrm{V}_{\mathrm{OH}}$ | 3.5 | - | $\mathrm{V}_{\mathrm{D} 1}$ | V | $-50 \mu \mathrm{~A}$ (2 LS TTL Loads) |

## AC CHARACTERISTICS

Operating Temperature: $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Frequency | - | - | 3120 | - | MHz | Crystal |
| $\overline{\text { Reset, } \overline{\text { SBY Reset }}}$ | $\mathrm{t}_{\mathrm{pw} 1}$ | 100 | - | - | $\mu \mathrm{s}$ |  |
| $\overline{\text { ALD }(<800 \mathrm{~ns})}$ | $\mathrm{t}_{\mathrm{pw} 2}$ | 200 | - | 800 | ns |  |
| A1-A8 Set Up | $\mathrm{t}_{\mathrm{s} 2}$ | 160 | - | - | ns |  |
| A1-A8 Hold | $\mathrm{t}_{\mathrm{h} 2}$ | 160 | - | - | ns |  |
| $\overline{\text { ALD }(\geqslant 800 \mathrm{~ns})}$ | $\mathrm{t}_{\mathrm{pw} 3}$ | 800 | - | - | ns |  |
| A1-A8 Set Up | $\mathrm{t}_{\mathrm{s} 3}$ | 0 | - | - | ns |  |
| A1-A8 Hold | $\mathrm{t}_{\mathrm{h} 3}$ | 1200 | - | - | ns |  |
| $\overline{\text { LRQ }}$ | $\mathrm{t}_{\mathrm{pd} 0}$ | - | - | 640 | ns |  |
| SBY | $\mathrm{t}_{\mathrm{pd} 0}$ | - | - | 640 | ns |  |

INSTRUMERAL


Fig. 1 TIMING DIAGRAM

## PIN FUNCTIONS

| Pin Number | Name | Function |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {SS }}$ | Ground |
| 2 | RESET | A logic 0 resets the SP. Must be returned to a logic 1 for normal operation. |
| 3 | ROM DISABLE | For use with an external serial speech ROM. A logic 1 disables the external ROM. |
| 4,5,6 | C1,C2, 31 | Output control lines used by an external serial speech ROM. |
| 7 | $V_{D D}$ | Primary power supply. |
| 8 | SBY | STANDBY. A logic 1 output indicates that the SP is inactive (i.e., not talking) and $V_{D D}$ can be powered down externally to conserve power. When the SP is reactivated by an address being loaded, SBY will go to a logic 0 |
| 9 | $\overline{L R Q}$ | $\overline{L O A D ~ R E Q U E S T . ~} \overline{L R Q}$ is a logic 1 output whenever the input buffer is full. When $\overline{L R Q}$ goes to a logic 0 , the input port is loaded by placing the 8 address bits on A1-A8 and pulsing the $\overline{\text { ALD }}$ input. |
| $\begin{array}{r} 10,11,13,14 \\ 15,16,17,18 \end{array}$ | $\begin{aligned} & \text { A8,A7,A6,A5, } \\ & \text { A4,A3,A2,A1 } \end{aligned}$ | 8-bit address which defines any one of 256 speech entry points. |
| 12 | SER OUT | SERIAL ADDRESS OUT. This output transfers a 16-bit address serially to an external speech ROM. |
| 19 | SE | STROBE ENABLE. Normally held in a logic 1 state. When tied to ground, ALD is disabled and the SP will automatically latch in the address on the input bus approximately $1 \mu \mathrm{~s}$ after detecting a logic 1 on any address line. |
| 20 | $\overline{\text { ALD }}$ | $\overline{\text { ADDRESS LOAD. A negative pulse on this input loads the } 8 \text { address bits into the }}$ input port. The leading edge of this pulse causes $\overline{L R Q}$ to go high. |
| 21 | SER IN | SERIAL IN. This is an 8-bit serial data input from an external speech ROM. |
| 22 | TEST | A logic 1 places the SP in test mode. This pin should normally be grounded. |
| 23 | $V_{\text {D1 }}$ | Standby power supply for the interface logic and controller. |
| 24 | DIGITAL OUT | Pulse width modulated digital speech output which, when filtered by a 5 kHz low pass filter and amplified, will drive a loudspeaker. |
| 25 | $\overline{\text { SBY RESET }}$ | STANDBY RESET. A logic 0 resets the interface logic. Normally should be a logic 1. |
| 26 | ROM CLOCK | 1.56 MHz clock for an external serial speech ROM. |
| 27 | OSC 1 | XTAL IN. Input connection for a 3.12 MHz crystal. |
| 28 | OSC 2 | XTAL OUT. Output connection for a 3.12 MHz crystal. |


| INSTRUERAL | SP0256 |
| :---: | :---: |



Fig. 2 TYPICAL APPLICATION STAND ALONE CONFIGURATION


Fig. 3 TYPICAL APPLICATION MICROCOMPUTER INTERFACE

## Allophone Based Speech Processor

## DESCRIPTION

This product is the SP0256 Speech Processor preprogrammed with a standard ROM Pattern contaıning 64 allophones. Through the concatenation of selected allophones the user can construct any word in the English language, thereby providing an unlimited vocabulary at a data rate of less than 100 bits/second.

## DATA MANUAL

A complete description of the SP0256-AL2 is contained in the Allophone Speech Synthesis Manual.

## 32K Speech Processor

## DESCRIPTION

This product is pin for pin compatible with the SP0256 Speech Processor. This enhanced version of the SP0256 contains 32K of internal ROM
$\dagger$ For future release.


## Speech Interface Chip

## DESCRIPTION

The SPR000 is designed to interface a standard ROM, PROM, or EPROM to the SP0256 Speech Processor to provide a large amount of vocabulary expansion. This interface contains all the logic necessary to allow data communication under control of the Speech Processor. Two chip selects are provided, (CS1 and CS2), for use in systems where it is desirable to bank blocks of memory under external control With the capability of addressing 64K bytes of memory the SPR000 is ideal for applications such as SP0256 testing, and speech ROM emulation.

## Voice Synthesis Module

## FEATURES

- Complete Speech System
- Stores Approximately 16 Seconds of Speech
- Custom Vocabularies Available
- Simple Digital Interface (TTL)
- 5 Volt Power Supply ( $\pm 5 \%$ )
- Audio Output: 200mw
- Operating Temperature $0^{\circ}$ to $55^{\circ} \mathrm{C}$
- Dimensions: $3.25^{\prime \prime} \times 5.0^{\prime \prime}$


## DESCRIPTION

The VSM2032 utilizes latest state-of-the-art technology to synthesize speech. The module contains three MOS/LSI devices fabricated with N -Channel Ion Implant Processing resulting in a high performance product with proven reliability and production history.
The module can be easily interfaced to any digital system; eight TTL compatible signals are used to select the spoken phrase. Once selected, the VSM2032 requires no support from the user's circuit. It enunciates the phrase and signals when complete.

## INTERFACE

The VSM2032 is interfaced using a 15 -pin card edge connector (Amphenol 225-21521-401 (117) or equivalent). The phrase to be spoken is selected with a 7-bit address ( $\mathrm{S}_{0}-\mathrm{S}_{6}$ ). This data is
strobed into the module using $\overline{\text { STROBE }}$. The module will drive the busy line ( $\overline{\mathrm{BUSY}}$ ) low while it is speaking. During this time, new data will not be accepted.
The module is initialized by applying two low pulses to the $\overline{\operatorname{RESET}}$ pin.
The audio output is available on both the card edge connector and on the module. It is designed to drive an $8 \Omega$ load with 200 mw of power.

## VOCABULARY

The standard VSM2032 can enunciate the thirty-two words and syllables listed below. Alternate vocabularies are available (contact regional sales office for information).
Numbers less than one billion can be enunciated using this phrase set. For example, 1214.1 would be generated by concatenating the following phrases:
| one || thousand || two || hundred || four || teen || point || one|
$\begin{array}{lllllllll}18 & 16_{8} & 2_{8} & 15_{8} & 4_{8} & 24_{8} & 32_{8} & 1_{8}\end{array}$
Addresses $40_{8}-177_{8}$ are not used with this phrase set. The VSM2032 will lock up if invalid addresses are used.

## DATA MANUAL

Complete detailed instructions and description are contained in the VSM2032 application manual.

|  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Octal | $\mathbf{s}_{\mathbf{6}} \mathbf{S}_{\mathbf{5}} \mathbf{S}_{\mathbf{4}} \mathbf{S}_{\mathbf{3}} \mathbf{S}_{\mathbf{2}} \mathbf{S}_{\mathbf{1}} \mathbf{S}_{\mathbf{0}}$ | Phrase |  |  |  |  |  |  |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | ZERO |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | ONNE |
| 2 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | TWO |
| 3 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | THREE |
| 4 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | FOUR |
| 5 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | FIVE |
| 6 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | SIX |
| 7 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | SEVEN |
| 10 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | EIGHT |
| 11 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | NINE |
| 12 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | TEN |
| 13 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | ELEVEN |
| 14 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | TWELVE |
| 15 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | HUNDRED |
| 16 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | THOUSAND |
| 17 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | MILLION |

## ADDRESS

| Octal | $\mathbf{S}_{\mathbf{6}} \mathbf{S}_{\mathbf{5}} \mathbf{S}_{\mathbf{4}} \mathbf{S}_{\mathbf{3}} \mathbf{S}_{\mathbf{2}} \mathbf{S}_{\mathbf{1}} \mathbf{S}_{\mathbf{0}}$ | Phrase |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 20 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | TWEN |
| 21 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | THIR |
| 22 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | FIF |
| 23 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | TY |
| 24 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | TEEN |
| 25 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | PLUS |
| 26 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | MINUS |
| 27 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | TIMES |
| 30 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | OVER |
| 31 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | EQUALS |
| 32 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | POINT |
| 33 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | ERROR |
| 34 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | IT IS |
| 35 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | AM |
| 36 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | PM |
| 37 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | OH |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias $0^{\circ} \mathrm{C}$
Storage Temperature $\qquad$ $-55^{\circ}$ to $+100^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to GND -0.3 V to +12.0 V

Standard Conditions (unless otherwise stated):
Operating Temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+55^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | $V_{p}$ | 4.75 | - | 5.25 | V |  |
| Supply Current | $I_{p}$ | - | 190 | 280 | mA | Audio Off |
| $\mathrm{S}_{0}-\mathrm{S}_{6}$ Low Voltage | $V_{\text {IL1 }}$ | -0.2 | - | 0.8 | V |  |
| $\mathrm{S}_{0}-\mathrm{S}_{6}$ High Voltage | $\mathrm{V}_{1 \mathrm{H} 1}$ | 2.4 | - | $V_{p}$ | V |  |
| $\overline{\text { RESET }}$ \& STROBE Low Voltage | $V_{\text {IL2 }}$ | -0.2 | - | 0.8 | V |  |
| $\overline{\text { RESET }}$ \& STROBE High Voltage | $\mathrm{V}_{1 \mathrm{H} 2}$ | $\mathrm{V}_{\mathrm{p}-1}$ | - | $V_{p}$ | V |  |
| $\overline{\text { BUSY }}$ Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | -1 | - | 0.8 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (NOTE 1) |
| BUSY Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $V_{p}$ | V | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ |
| Input Low Current | $\mathrm{I}_{\text {IL }}$ | -0.2 | -0.6 | -1.6 | mA |  |
| Input High Current | $\mathrm{I}_{\text {IH }}$ | -0.1 | -0.4 | - | mA | $\mathrm{V}_{1 \mathrm{H}}=2.4 \mathrm{~V}$ |
| Audio Output | $\mathrm{A}_{\mathrm{p}}$ | - | - | 200 | mW | $8 \Omega$ LOAD |

## NOTE:

1. Positive current indicates current into module. Negative current indicates current out of module.

## AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESET Low Time | $\mathrm{t}_{\mathrm{RL}}$ | 5 | - | - | $\mu \mathrm{s}$ | Two resets are required |
| $\overline{\text { RESET High Time }}$ | $\mathrm{t}_{\text {RH }}$ | 200 | - | 500 | $\mu \mathrm{s}$ |  |
| Data Hold Time | $t_{\text {dH }}$ | 50 | - | - | $\mu \mathrm{s}$ |  |
| Data Setup Time | $\mathrm{t}_{\mathrm{DS}}$ | 0 | - | - | ns |  |
| BUSY Response Time High | $\mathrm{t}_{\text {BRH }}$ | - | - | 40 | $\mu \mathrm{s}$ |  |
| STROBE Setup Time | $\mathrm{t}_{\mathrm{ss}}$ | 0 | - | - | ns |  |
| STROBE Low Time | $\mathrm{t}_{\text {SL }}$ | 5 | - | - | $\mu \mathrm{s}$ |  |
| BUSY Response Time Low | $\mathrm{t}_{\mathrm{BRL}}$ | - | - | - | - | Determined by Length of Phrase |



## SP0250

## Speech Synthesizer

## FEATURES

- High Quality Speech Synthesizer/Programmable Digital Filter
- Single +5 Volt Supply
- Simple Interface to a Microcomputer or Microprocessor Based System
- TTL Compatible 8 Bit Bus Interface
- Handshaking
- Double Buffered Input
- On Chip Pulse Width Modulator


## DESCRIPTION

The SP0250 speech synthesizer is an N-channel MOS LSI device capable of generating high quality speech with the natural inflection and emphasis of the original speaker. Operation requires one or more ROMs to store speech data and a microcomputer/ processor such as the General Instrument PIC1650A.
The microcomputer fetches a data block from the ROM, formats it into a $15 \times 8$ bit speech data frame and transfers it to the SP0250 8 -bit port using two handshaking signals. This speech data frame, which includes such information as pitch period, amplitude, voiced/unvoiced, number of repetitions and filter coefficients "programs" the synthesizer to produce one frame of speech output.
The achievable output has a frequency response of 100 Hz to 5 kHz , a dynamic range of 42 dB and a signal to noise ratio of approximately 35 dB .


The SP0250 is controlled by 15 programmable eight bit parameter registers which hold the following information: voiced/unvoiced, pitch period, repeat count, amplitude and 12 digital filter coefficients.
Bit six of the repeat register is used to select either voiced or unvoiced source operation. If voiced mode is selected, the pitch

## BLOCK DIAGRAM OF SP0250


period register determines the spacing between the scaled unit impulses applied to the digital filter. The repeat register indicates the number of full pitch periods which will be synthesized before the 15 parameter registers are updated. The amplitude register in both voiced and unvoiced mode controls the gain of the source.

Data request and Data present are the handshaking signals used by the SP0250 and the microcomputer to transfer speech data.

| SP0250 | INSTRUNERAL |
| :---: | :---: |

The SP0250 drives the Data Request line high when it is ready to accept a $15 \times 8$ speech frame (Data Request stays high until the entire frame has been input). When the microcomputer sees a logic 1 on Data Request, it will begin to send speech data. The microcomputer outputs 8 bits to the SP0250 followed by a Data Present pulse. This procedure is repeated until the entire 15 byte frame has been transferred.

## PIN FUNCTIONS

| Pin Number | Name | Function |
| :---: | :---: | :---: |
| 15 | $V_{\text {DD }}$ | Positive Power Supply |
| 1 | $V_{\text {ss }}$ | Ground |
| Clock |  |  |
| 12 | XTAL IN |  |
| 10 | XTAL OUT | 3.12MHz crystal and associated circuitry are connected here. |
| Inputs |  |  |
| 22 | $\overline{\text { Reset }}$ | Two high to low transitions on this input resets the chip. |
| 23-28, 2, 3 | D0-D7 Data Bus | Input 8 bit data bus. |
| 5 | Data Present | Input strobe for 8 bit data bus. |
| 4, 16, 7, 18 |  | Must be grounded for proper chip operation. |
| Outputs |  |  |
|  |  |  |
|  | Data Request | This output requests data be sent to the chip. |
| 19 | Digital Out | Chip output. Open collector, requires a pull-up. |
| 9 | 3.120MHz CPU Clock | Buffered push-pull output. |
| 14 | 0.4457MHz GROM Clock | Buffered push-pull output with a $3: 4$ high to low ratio. |

TEST PINS

| Pin Number | Name | Function |
| :---: | :---: | :---: |
| Test Inputs |  |  |
| 7 | Direct Data Mode | A logic 1 on this input causes the data bus to be loaded directly into the source register in the chip. |
| 18 | ROM Test | A logic 1 on this input causes the ROM outputs to appear on the SERIAL DATA Pin. |
| Test Outputs |  |  |
| 20 | SYNC | Buffered push-pull test output. 640ns positive pulse with 312 clock duty cycle. |
| 21 | Serial Data | Buffered push-pull test output. Monitors the internal data bus. |
| 8 | 1.56MHz Data Clock | Buffered push-pull square wave output. |
| 13 | 1.04 MHz PIC Clock | Buffered push-pull output. 3:4 high to low ratio. |


| INSENERAL | SP0250 |
| ---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

V cc
Storage Temperature . ....................................... $-25^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Lead Temp (Soldering) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 10Sec @ $+330^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated)
$V_{\mathrm{cc}}=+4.6 \mathrm{~V}$ to +5.5 V
Operating Temperature $=0^{\circ} \mathrm{C}$ to $+55^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristic | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 10 Inputs: |  |  |  |  |  |
| Reset D0-D7, Data Present |  |  |  |  |  |
| Logic 0 | 0 | - | 0.6 | v |  |
| Logic 1 | 2.4 | - | V cc | V |  |
| Leakage | - | - | 10 | $\mu \mathrm{A}$ | 5.5V |
| 1 Clock Input: |  |  |  |  |  |
| Logic 0 | 0 | - | 0.6 | v |  |
| Logic 1 | 4 | - | V cc | V |  |
| Leakage | - | - | 10 | $\mu \mathrm{A}$ | 5.5V |
| 2 Test Inputs |  |  |  |  |  |
| Direct Data Mode, ROM Test |  |  |  |  |  |
| Logic 0 | 0 | - | 0.6 | V |  |
| Logic 1 | 2.4 | - | V cc | V |  |
| Capacitance | - | - | 10 | pf |  |
| Leakage | - | - | 10 | $\mu \mathrm{A}$ | 5.5V |
| 3 P/P Outputs |  |  |  |  |  |
| Data Request, CPU Clock, GROM Clock |  |  |  |  |  |
| Logic 1 | 3.5 | - | $\mathrm{V}_{\mathrm{cc}}$ | v | $-50 \mu \mathrm{~A}$ |
| 10/C Output |  |  |  |  |  |
| Logic 0 | 0 | - | 0.6 | V | 2.2 K |
| Logic 1 | - | - | 10 | $\mu \mathrm{A}$ | 5.0V Source |
| Power on $\mathrm{V}_{\mathrm{DD}}=\mathrm{I} C \mathrm{C}$ | - | 50 | 75 | mA@ |  |
|  |  |  |  | $25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{DD}}=5.5$ |
|  |  |  |  |  | $\mathrm{V}_{\text {ss }}=0.0$ |
|  |  |  |  |  | No Loads |

AC CHARACTERISTICS

| Characteristic | Min | Typ | Max | Units |  | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Frequency Clock Period | - | 3.12 320 | - | $\begin{gathered} \mathrm{MHz} \\ \mathrm{~ns} \end{gathered}$ | Square Wave |  |
| Data Present Logic 1 Logic 0 | $\begin{aligned} & 1.5 \\ & 10 \end{aligned}$ | - | - | $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ |  |  |
| Reset D0-D7 <br> Set Up <br> Hold | $\begin{gathered} 1000 \\ 1.5 \\ 1.5 \end{gathered}$ | - | - | $\begin{aligned} & \mu \mathrm{s} \\ & \mu \mathrm{~s} \\ & \mu \mathrm{~s} \end{aligned}$ |  |  |
| P/P Test Output <br> Serial Data <br> Logic 0 <br> Logic 1 | $\begin{gathered} 0 \\ 3.5 \end{gathered}$ | - | 0.6 Vcc | $\begin{aligned} & \text { V } \\ & \text { v } \end{aligned}$ | No Load |  |
|  |  |  |  |  |  |  |

## Speech Field Development Board

## FEATURES

- 5 Volts $\pm 5 \%$, Single Supply Operation
- Expandable to 256 K Bits of EPROM
- Supports LPC Synthesis, Formant Synthesis, and Allophone Synthesis
- On Board Crystal Oscillator
- Dimensions: 4" x 6.25"
- Cable Length: $14{ }^{\prime \prime}$


## DESCRIPTION

The Speech Field Development System is an EPROM based version of the SP0256 Speech Processor and speech ROMs. It is used to demonstrate and test synthetic speech or complex sounds before they are committed to masked ROM. The SFD2000 emulates up to 256 K bits of expansion ROM.

The address, DAC output and control signals are made available on a 28 pin header/cable that connects to the board. Power ( $\mathrm{V}_{\mathrm{D} 1}$ and $V_{D D}$ ) for the module is supplied via a 3 pin connector or can be strapped for internal operation. The voltage input to $V_{D 1}$ and $V_{D D}$ lines must be limited to 5 Volts $\pm 5 \%$.
The SP0256 Speech Processor executes the 8 bits of data and modifies the appropriate parameters of the Vocal Tract Model (VTM) to create the desired sound sequence.
The SFD module comes complete with an SP0256, SPR000 and sockets for eight 2732 EPROMs. A cable is provided to interface the SFD2000 to the user's system.

DATA MANUAL
A complete description of the SFD2000 system is contained in the Speech Field Development Data Manual.

## SFD2000 BLOCK DIAGRAM




## GENERAL INSTRUMENT

## Sound Generation

| FUNCTION | \% DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| PROGRAMMA |  | AY-3-8910 | 5-18 |
| SOUND | Fulisoftware contro, 5 V operation, simple interface, triple analog output, general purposel/O ports. | AY-3-8912 | 5-18 |
| GENERAIOR | , | AY-3-8913 | 5-18 |
| TUNES SYNTHESIZER | Produces mustal tunes from pre-programmed microcomputerx | AY-3-1350 | , 5-26 |

# Programmable Sound Generator 

## FEATURES

- Full Software Control of Sound Generation
- Interfaces to Most 8-Bit and 16-Bit Microprocessors
- Three Independently Programmed Analog Outputs
- Two 8-Bit General Purpose I/O Ports (AY-3-8910)
- One 8-Bit General Purpose I/O Port (AY-3-8912)
- Single +5 Volt Supply


## DESCRIPTION

The AY-3-8910/8912/8913 Programmable Sound Generator (PSG) is a LSI Circuit which can produce a wide variety of complex sounds under software control The AY-3-8910/8912/8913 is manufactured in the General Instrument N-Channel Ion Implant Process Operation requires a single +5 V power supply, a TTL compatıble clock, and a microprocessor controller such as the General Instrument 16-bit CP1610 or one of the PIC1650 series of 8-bit microcomputers

The PSG is easily interfaced to any bus oriented system Its flexibility makes it useful in applications such as music synthesis, sound effects generation, audible alarms, tone signalling and FSK modems The analog sound outputs can each provide 4 bits of logarithmic digital to analog conversion, greatly enhancing the dynamic range of the sounds produced
In order to perform sound effects while allowing the processor to continue its other tasks, the PSG can contınue to produce sound after the initial commands have been given by the control processor The fact that realistic sound production often involves more than one effect is satisfied by the three independently controllable channels available in the PSG

All of the circuit control signals are digital in nature and intended to be provided directly by a microprocessor/microcomputer This means that one PSG can produce the full range of required sounds with no change in external circuitry Since the frequency response of the PSG ranges from sub-audible at its lowest frequency to postaudible at its highest frequency, there are few sounds which are beyond reproduction with only the simplest electrical connections
Since most applications of a microprocessor/PSG system would also require interfacing between the outside world and the microprocessor. this facility has been designed into the PSG The AY-3-8910 has two general purpose 8 -bit I/O ports and is supplied in a 40 lead package the AY-3-8912 has one port and 28 leads the AY-3-8913 has no ports and 24 leads

## PIN FUNCTIONS

DA7--DA0 (input/output/high impedance) pins 30--37 (AY-3-8910) Data/Address 7-0: pıns 21--28 (AY-3-8912) pins 4--11 (AY-3-8913)
These 8 lines comprise the 8 -bit bidirectional bus used by the microprocessor to send both data and addresses to the PSG and to receive data from the PSG In the data mode, DA7--DA0 correspond to Register Array bits B7--B0 In the address mode, DA3--DA0 select the register number ( $0--17_{8}$ ) and a DA7--DA4 in conjunction with address inputs $\overline{\mathrm{A} 9}$ and A 8 for the high order address (chip select)

A8 (input) pin 25 (AY-3-8910)
pin 17 (AY-3-8912)
pin 23 (AY-3-8913)
$\overline{\mathrm{A} 9}$ (Input) pin 24 (AY-3-8910)
pin 22 (AY-3-8913)
(not provided on AY-3-8912)
$\overline{\text { Address 9, }}$, Address 8
These "extra" address bits are made available to enable the positioning of the PSG (assigning a 16 word memory space) in a total 1,024 word memory area rather than in a 256 word memory area as defined by address bits DA7--DA0 alone If the memory size does not require the use of these extra address lines they may be left unconnected as each is provided with either an on-chip pull down ( $\overline{\mathrm{A} 9}$ ) or pull-up (A8) resistor In "noisy" environments, however, it is recommended that $\overline{\mathrm{A} 9}$ and A8 be tied to an external ground and +5 V , respectively, if they are not to be used

## PIN CONFIGURATIONS

40 LEAD DUAL IN LINE AY-3-8910

| Top View |  |  |  |
| :---: | :---: | :---: | :---: |
| $V_{\text {ss }}$ (GND) | ${ }^{\bullet 1}$ | $\bigcirc 40$ | $\mathrm{V}_{\text {cc }}(+5 \mathrm{~V})$ |
| NC | 2 | 39 | TEST 1 |
| ANALOG CHANNEL B | 3 | 38 | ANALOG CHANNEL C |
| ANALOG CHANNEL A | 4 | 37 | DAO |
| NC | 5 | 36 | DA1 |
| IOB7 | 6 | 35 | DA2 |
| IOB6 | 7 | 34 | DA3 |
| IOB5 | 8 | 33 | DA4 |
| IOB4 | -9 | 32 | DA5 |
| IOB3 |  | 31 | DA6 |
| IOB2 |  | 30 | DA7 |
| IOB1 |  | 29 | BC1 |
| IOBO |  | 28 | BC2 |
| IOA7 | 14 | 27 | BDIR |
| IOA6 |  | 26 | TEST 2 |
| IOA5 | $\square^{16}$ | 25 | A8 |
| IOA4 |  | 24 | A9 |
| IOA3 | - 18 | 23 | RESET |
| IOA2 |  | 22 | CLOCK |
| IOA1 |  | 21 | IOAO |

28 LEAD DUAL IN LINE
AY-3-8912

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| ANALOG CHANNEL C | $\bullet 1$ | 28 | DAO |
| TEST 1 | 2 | 27 | DA1 |
| $V_{\text {cc }}(+5 \mathrm{~V})$ |  | 26 | DA2 |
| ANALOG CHANNEL B | 4 | 25 | DA3 |
| ANALOG CHANNEL A | 5 | 24 | DA4 |
| $V_{\text {ss }}$ (GND) | 6 | 23 | DA5 |
| IOA7 |  | 22 | DA6 |
| IOA6 | 8 | 21. | DA7 |
| IOA5 | 9 | $20 \square$ | BC1 |
| IOA4 |  | 19 | BC2 |
| IOA3 | 11 | 18 | BDIR |
| IOA2 | 12 | 17 | A8 |
| IOA1 | 13 | 16 | $\overline{\text { RESET }}$ |
| IOAO | 14 | 15 | CLOCK |

24 LEAD DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| $\mathrm{V}_{\text {ss }}$ (GND) | $\bullet 1$ V | 24 CHIP SELECT |
| BDIR | 2 | 23- A8 |
| BC1 | 3 | $22 . \overline{\text { A9 }}$ |
| DA7 | 4 | 210 RESET |
| DA6 | 5 | 20.7 CLOCK |
| DA5 | 6 | 19 V Ss (GND) |
| DA4 | 7 | 18 ANALOG C |
| da3 | 8 | 17.1 ANALOG A |
| DA2 | 9 | 16 T NO CONNECT |
| DA1 | 10 | 15 ANALOG B |
| Dat | 11 | 14.7 TEST IN |
| test out | 12 | ${ }_{13}{ }^{\text {b }}$ cc |

RESET (ınput) pin 23 (AY-3-8910) pin 21 (AY-3-8913) pin 16 (AY-3-8912)
For initialızation/power-on purposes, applyıng a logic " 0 " (ground) to the Reset pin will reset all registers to " 0 " The Reset pin is provided with an on-chip pull-up resistor.
CLOCK (input) pin 22 (AY-3-8910) pin 20 (AY-3-8913) pin 15 (AY-3-8912)
This TTL-compatible input supplies the timing reference for the Tone, Noise and Envelope Generators

## BDIR, BC2, BC1 (ınputs) pins 27,28,29 (AY-3-8910)

pins 18,19,20 (AY-3-8912) pins 2, 3 (No BC2 on AY-3-8913
Bus DIRection, Bus Control 2,1
These bus control signals are,generated directly by the CP1610 series of microprocessors to control all external and internal bus operations in the PSG When using a processor other than the CP1610, these signals can be provided either by comparable bus signals or by simulating the signals on I/O lines of the processor. The PSG decodes these signals as illustrated in the following

| $\frac{\mathbf{x}}{\mathbf{o}}$ | §̃ | $\bar{\oplus}$ | $\begin{gathered} \text { CP1610 } \\ \text { FUNCTION } \end{gathered}$ | PSG FUNCTION |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | NACT | INACTIVE See 010 (IAB). |
| 0 | 0 | 1 | ADAR | LATCH ADDRESS See 111 (INTAK) |
| 0 | 1 | 0 | IAB | INACTIVE. The PSG/CPU bus is inactive DA7--DAO are in a high impedance state |
| 0 | 1 | 1 | DTB | READ FROM PSG This signal causes the contents of the register which is currently addressed to appear on the PSG/CPU bus DA7--DAO are in the output mode |
| 1 | 0 | 0 | BAR | LATCH ADDRESS See 111 (INTAK)' |
| 1 | 0 | 1 | DW | INACTIVE See 010 (IAB) |
| 1 | 1 | 0 | DWS | WRITE TO PSG This signal indicates that the bus contains register data which should be latched into the currently addressed register DA7--DA0 are in the input mode |
| 1 | 1 | 1 | INTAK | LATCH ADDRESS This signal indicates that the bus contains a register address which should be latched in the PSG. DA7--DA0 are in the input mode |

While interfacing to a processor other than the CP1610 would simply require simulating the above decoding, the redundancies in the PSG functions vs bus control signals can be used to advantage in that only four of the eight possible decoded bus functions are required by the PSG. This could simplify the programming of the bus control signals to the following, which would only require that the processor generate two bus control signals (BDIR and BC1, with BC2 tied to +5 V ) This is the case with the AY-3-8913 with BC2 pulled high internally


ANALOG CHANNEL A, B, C (outputs) pins 4, 3, 38 (AY-3-8910) pins 5, 4, 1 (AY-3-8912) pins 17, 15, 18 (AY-3-8913)
Each of these signals is the output of its corresponding D/A Converter, and provides an up to 1 V peak-peak signal representing the complex sound waveshape generated. by the PSG.

## IOA7--IOAO (input/output) pins 14--21 (AY-3-8910) <br> pins $7--14$ (AY-3-8912) (not provided on $A Y-3-8913$ ) <br> IOB7--IOB0 (input/output) pins 6--13 (AY-3-8910) <br> (not provided on AY-3-8912) (not provided on AY-3-8913) Input/Output A7--A0, B7--B0

Each of these two parallel input/output ports provides 8 bits of parallel data to/from the PSG/CPU bus from/to any external devices connected to the IOA or IOB pins Each pin is provided with an onchip pull-up resistor, so that when in the "input" mode, all pins will read normally high Therefore, the recommended method for scanning external switches would be to ground the input bit.
TEST 1: pin 39 (AY-3-8910) pin 14 (AY-3-8913) pin 2 (AY-3-8912) TEST 2: pin 26 (AY-3-8910) pin 12 (AY-3-8913)
(not connected on AY-3-8912)
These pins are for General Instrument test purposes only and should be left open-do not use as tie-points.
$\mathbf{V}_{\text {cc }}:$ pin 40 (AY-3-8910) pin 13 (AY-3-8913) pin 3 (AY-3-8912)
Nominal +5 Volt power supply to the PSG
$V_{\text {ss }}$ pin 1 (AY-3-8910) pin 19 (AY-3-8913) pin 6 (AY-3-8912) Ground reference for the PSG

## CHIP SELECT (Input) Pin 24 (AY-3-8913 only)

This input signal goes low to enable the PSG to read data on the data bus or write data from the data bus to one of the internal registers. For these above operatıons to occur, this signal must be true in addition to the current bus address being a valid PSG address This signal must be valid for all read and write operations The pin has an internal pull down to $\mathrm{V}_{\mathrm{Ss}}$.

AY-3-8910 $=$ AY-3-8912
AY-3-8913

## ARCHITECTURE

The AY-3-8910/8912/8913 is a register oriented Programmable Sound Generator (PSG) Communication between the processor and the PSG is based on the concept of memory-mapped I/O Control commands are issued to the PSG by writing to 16 memory-mapped registers. Each of the 16 registers within the PSG is also readable so that the microprocessor can determine, as necessary, present states or stored data values.
All functions of the PSG are controlled through the 16 registers which once programmed, generate and sustain the sounds, thus freeing the system processor for other tasks

## REGISTER ARRAY

The princıpal element of the PSG is the array of $16 \mathrm{read} / \mathrm{write}$ control registers These 16 registers look to the CPU as a block of memory and as such occupy a 16 word block out of 1,024 possible addresses The 10 address bits ( 8 bits on the common data/address bus, and 2 separate address bits A8 and $\overline{\mathrm{A9}}$ ) are decoded as follows


The four low order address bits select one of the 16 registers (RO-R178). The six high order address bits function as "chip selects" to control the tri-state bidirectional buffers (when the high order address bits are "incorrect", the bidirectional buffers are forced to a high impedance state). High order address bits $\overline{\mathrm{A} 9}, \mathrm{~A} 8$ are fixed in the PSG design to recognize a 01 code, high order address bits DA7-DA4 may be mask-programmed to any 4-bit code by a special order factory mask modification. Unless otherwise specified, address bits DA7--DA4 are programmed to recognize only a 0000 code. A valid high order address latches the register address (the low order 4 bits) in the Register Address Latch/Decoder block A latched address will remain valid untıl the receıpt of a new address, enabling multıple reads and writes of the same register contents without the need for redundant re-addressing

Conditioning of the Register Address Latch/Decoder and the Bidirectional Buffers to recognize the bus function required (inactive, latch address, write data, or read data) is accomplished by the Bus Control Decode block.

## SOUND GENERATING BLOCKS

The basic blocks in the PSG which produce the programmed sounds include-
Tone Generators produce the basic square wave tone frequen-

NoIse Generator
Mixers

Amplitude Control

Envelope Generator

D/A Converters

## I/O PORTS

Two additional blocks are shown in the PSG Block Diagram which have nothing directly to do with the production of sound-these are the two I/O Ports (A and B) Since virtually all uses of microproces-sor-based sound would require interfacing between the outside world and the processor, this facility has been included in the PSG. Data to/from the CPU bus may be read/written to either of two 8-bit I/O Ports without affecting any other function of the PSG. The I/O Ports are TTL-compatible and are provided with internal pull-ups on each pin. Both Ports are available on the AY-3-8910; only I/O Port A is available on the AY-3-8912; no ports are available on the AY-3-8913


## OPERATION

Since all functions of the PSG"are controlled by the processor via a series of register loads, a detalled description of the PSG operation can best be accomplished by relatıng each PSG function to the control of its correspondıng register The function of creatıng or programming a specific sound or sound effect logically follows the control sequence listed:

| Operation | Registers | Function |
| :---: | :---: | :---: |
| Tone Generator Control | R0--R5 | Program tone periods |
| Noise Generator Control | R6 | Program noise period |
| Mixer Control | R7 | Enable tone and/or noise on selected channels |
| Amplitude Control | R10--R12 | Select "fixed" or "envelopevariable" amplitudes |
| Envelope Generator Control | R13--R15 | Program envelope period and select envelope pattern |

## Tone Generator Control

## (Registers R0, R1, R2, R3, R4, R5)

The frequency of each square wave generated by the three Tone Generators (one each for Channels $A, B$, and $C$ ) is obtained in the PSG by first counting down the input clock by 16, then by further countıng down the result by the programmed 12-bit Tone Period value. Each 12-bit value is obtained in the PSG by combining the contents of the relative Coarse and Fine Tune registers, as illustrated in the following

| Coarse Tune |
| :---: |
| Register |

R1
R3
R5
Channel
A
B
C
Fine Tune
Register
R0
R2
R4


## Noise Generator Control

(Register R6)
The frequency of the noise source is obtained in the PSG by first counting down the input clock by 16, then by further counting down the result by the programmed 5-bit Noise Period value This 5-bit value consists of the lower 5 bits ( $\mathrm{B} 4-\mathrm{BO}$ ) of register R6, as illustrated in the following


## Mixer Control-I/O Enable

## (Register R7)

Register R7 is a multi-function Enable register which controls the three Noise/Tone Mixers and the two general purpose I/O Ports
The Mixers as previously described, combine the noise and tone frequencies for each of the three channels The determination of combining neither/either/both noise and tone frequencies on each channel is made by the state of bits B5--B0 of R7
The direction (input or output) of the two general purpose I/O Ports (IOA and IOB) is determined by the state of bits B7 and B6 of R7
These functions are illustrated in the following


## Amplitude Control

## (Registers R10, R11, R12)

The amplitudes of the signals generated by each of the three $D / A$ Converters (one each for Channels $A, B$, and $C$ ) is determined by the contents of the lower 5 bits (B4--B0) of registers R10, R11, and R12 as illustrated in the following


## Envelope Generator Control

(Registers R13, R14, R15)
To accomplish the generation of fairly complex envelope patterns, two independent methods of control are provided in the PSG first, it is possible to vary the frequency of the envelope using registers R13 and R14; and second, the relative shape and cycle pattern of the envelope can be varied using register R15 The following paragraphs explain the details of the envelope control functions, describing first the envelope period control and then the envelope shape/cycle control

## ENVELOPE PERIOD CONTROL (Registers R13, R14)

The frequency of the envelope is obtained in the PSG by first counting down the input clock by 256 ; then by further counting down the result by the programmed 16 -bit Envelope Period value. This 16-bit value is obtained in the PSG by combining the contents of the Envelope Coarse and Fine Tune registers, as illustrated in the following


## ENVELOPE SHAPE/CYCLE CONTROL (Register R15)

The Envelope Generator further counts down the envelope frequency by 16 , producing a 16 -state per cycle envelope pattern as defined by its 4-bit counter output, E3 E2 E1 E0 The particular shape and cycle pattern of any desired envelope is accomplished by controlling the count pattern (count up/count down) of the 4-bit counter and by defining a single-cycle or repeat-cycle pattern
This envelope shape/cycle control is contained in the lower 4 bits (B3--B0) of register R15 Each of these 4 bits controls a function in the envelope generator, as illustrated in the following

Envelope Shape/Cycle
Control Register (R15)

$\qquad$ GENERAL
INSTRUVENT


Fig. 1 ENVELOPE SHAPE/CYCLE OPERATION


## I/O Port Data Store <br> (Registers R16, R17)

Registers R16 and R17 function as intermedıate data storage registers between the PSG/CPU data bus (DA0--DA7) and the two 1/O ports (IOA7--IOAO and IOB7--IOBO) Both ports are avallable in the AY-3-8910, only I/O Port A is available in the AY-3-8912 none are avaılable on the AY-3-8913 Using registers R16 and R17 for the transfer of I/O data has no effect on sound generation

## D/A Converter Operation

Since the primary use of the PSG is to produce sound for the highly imperfect amplitude detection mechanism of the human ear, the D/A conversion is performed in logarithmic steps with a normalized voltage range of from 0 to 1 Volt . The specific amplitude control of each of the three D/A Converters is accomplished by the three sets of 4-bit outputs of the Amplitude Control block, while the Mixer outputs provide the base signal frequency (Noise and/or Tone).


Fig. 3 D/A CONVERTER OUTPUT


Fig. 4 SINGLE TONE WITH ENVELOPE SHAPE/CYCLE PATTERN 1010


Fig. 5 MIXTURE OF THREE TONES WITH FIXED AMPLITUDES

Maximum Ratings*
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
$V_{C C}$ and all other Input/Output
Voltages with Respect to $\mathrm{V}_{\mathrm{ss}}$. . . . . . . . . . . . . . . . . . . . -0.3 V to +8.0 V
Standard Conditions (unless otherwise noted):
$V_{\mathrm{cc}}=+5 \mathrm{~V} \pm 5 \%$
$\mathrm{V}_{\mathrm{SS}}=\mathrm{GND}$
Operating Temperature $=0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


[^14]

Fig. 6 ANALOG CHANNEL OUTPUT TEST CIRCUIT

| INSTRUMRAL | AY-3-8910 ■ AY-3-8912 |
| :---: | :---: |
| AY-3-8913 |  |

ELECTRICAL CHARACTERISTICS (AY-3-8913)

Maximum Ratings*

Operating Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
$\mathrm{V}_{\mathrm{CC}}$ and all other Input/Output Voltages

Standard Conditions (unless otherwise noted):
$V_{C C}=+5 \mathrm{~V} \pm 5 \%$
$\mathrm{V}_{\mathrm{ss}}=\mathrm{GND}$
Operating Temperature $=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Sym | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |
| Input Voltage Levels Low Level High Level | $\begin{aligned} & V_{I L} \\ & V_{I H} \end{aligned}$ | 0 2.2 | $\begin{aligned} & 0.7 \\ & \mathrm{~V}_{\mathrm{cc}} \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |  |
| Output Voltage Levels (except Analog Channel Outputs) |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\mathrm{OL}}$ | 0 | 0.4 | V | 1 TTL Load |
| High Level | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | $\mathrm{V}_{\mathrm{cc}}$ | V | +100pf |
| Analog Channel Outputs Power Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{O}} \\ & \mathrm{I}_{\mathrm{Cc}} \end{aligned}$ | - | 2000 85 | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{~mA} \end{aligned}$ | Test Circuit: Fig. 6 |
| AC CHARACTERISTICS |  |  |  |  |  |
| Clock Input |  |  |  |  |  |
| Frequency | $\mathrm{f}_{\mathrm{c}}$ | 1 | 2.5 | MHz | $)$ |
| Rise Time | $t_{r}$ | - | 50 | ns |  |
| Fall Time | $t_{\text {f }}$ | $\overline{40}$ | 50 | ns | \% Fig. 7 |
| Duty Cycle | - | 40 | 60 | \% | ( Fig. 7 |
| Bus Signals (BDIR, BC2, BC1) Associative Delay Time | $t_{B D}$ | - | 50 | ns |  |
| Reset |  |  |  |  |  |
| Reset Pulse Width |  | 5 | - | $\mu s$ |  |
| Reset to Bus Control Delay Time | $t_{\text {RB }}$ | 100 | - | ns | \} Fig. 8 |
| A9, A8, DA7--DA0 (Address Mode) <br> Address Setup Time <br> Address Hold Time | $t_{\text {AS }}$ $t_{\text {AH }}$ | 300 50 | - | ns | $\}$ Fig. 9 |
| DA7--DAO (Write Mode) |  |  |  |  |  |
| Write Data Pulse Width | $t_{\text {DW }}$ | 1800 | - | ns |  |
| Write Data Setup Time | $t_{\text {DS }}$ | 50 | - | ns | Fig. 10 |
| Write Data Hold Time | $t_{\text {DH }}$ | 100 | - | ns |  |
| DA7--DA0 (Read Mode) Read Data Access Time | $t_{\text {DA }}$ | - | 350 | ns |  |
| DA7--DA0 (Inactive Mode) |  |  |  |  | \} Fig. 11 |
| Tristate Delay Time | $t_{\text {TS }}$ | - | 400 | ns |  |



Fig. 11 READ DATA TIMING

## AY-3-1350

## Tunes Synthesizer

## FEATURES

- 25 Different Tunes Plus 3 Chimes
- Mask Programmable with Customer Specified Tunes for Toys, Musical Boxes, etc.
- Minimal External Components
- Automatic Switch-Off Signal at End of Tune for Power Savings
- Envelope Control to Give Organ or Piano Quality
- Sequential Tune Mode
- 4 Door Capability When Used as Doorchime
- Operation with Tunes in External PROM if Required
- Single Supply ( +5 V ) Operation


## DESCRIPTION

The AY-3-1350 is an N-Channel MOS microcomputer based synthesizer of pre-programmed tunes for applications in toys, musical boxes, and doorchimes. The standard device has a set of 25 different popular and classical tunes chosen for their international acceptance. In addition there are 3 chimes making a total of 28 tunes.

The chip is mask-programmable during manufacture enabling the quantity user to select his own music. Up to 28 tunes of varying length can be chosen.
The device has multi-mode operation making it suitable for a wide variety of applications.

## TUNES

The standard AY-3-1350 contains the following tunes:
AO Toreador
B0 William Tell
C0 Hallelujah Chorus
D0 Star Spangled Banner
E0 Yankee Doodle
A1 John Brown's Body
B1 Clementine
C1 God Save the Queen
D1 Colonel Bogey
E1 Marseillaise

A2 America, America
B2 Deutschland Leid
C2 Wedding March
D2 Beethoven's 5th
E2 Augustine

## PIN CONFIGURATION <br> 28 LEAD DUAL IN LINE



A3 O Sole Mio
B3 Santa Lucia
C3 The End
D3 Blue Danube
E3 Brahms' Lullaby
A4 Hell's Bells
B4 Jingle Bells
C4 La Vie en Rose
D4 Star Wars
E4 Beethoven's 9th

Chime X Westminster Chime
Chime Y Simple Chime
Chime Z Descendıng Octave Chime

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Storage Temperature .................................. $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any pin with respect to ground (Vss) ....... - 0.3 V to +10.0 V
Standard Conditions (unless otherwise noted)
Operating Temperature $\left(\mathrm{T}_{\mathrm{A}}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristics | Sym | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |
| Primary Supply Voltage | Vod | 4.5 | 7 | V |  |
| Output Buffer Supply Voltage | Vxx | 4.5 | 9 | V |  |
| Primary Supply Current | loo | - | 55 | mA | No load |
| Output Buffer Supply Current | Ixx | - | 5 | mA | No load |
| Logic Input Low Voltage | $\mathrm{V}_{\text {IL }}$ | -0.2 | 0.8 | V |  |
| Logic Input High Voltage (Note 2) (Except RESET and OSC when driven externally) | $\mathrm{V}^{\mathrm{IH}_{1}}$ | 2.4 | Vod | V |  |
| Logic Input High Voltage <br> (RESET and OSC) | $\mathrm{V}_{1 \mathrm{H}_{2}}$ | 4 | Vod | V |  |
| Logic Output High Voltage (Note 2) | VOH | 2.4 |  | V | $\mathrm{IOH}=100 \mu \mathrm{~A}$ |
| Logic Output Low Voltage | VOL | - | 0.45 | V | $\mathrm{loL}=1.6 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{xx}}=4.5 \mathrm{~V}$ |
|  | - | - | 0.90 | V | $1 \mathrm{~L}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=9 \mathrm{~V}$ |
|  | - | - | 0.50 | V | $\mathrm{IOL}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{xx}}=9 \mathrm{~V}$ |
|  | - | - | 0.90 | V | $\begin{aligned} & \mathrm{IoL}=10 \mathrm{~mA}, \mathrm{Vxx}=9 \mathrm{~V} \\ & \\ & (\text { Note 1) } \end{aligned}$ |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
| CLK OUT Output |  |  |  |  |  |
| Period | tcr | 4 | 20 | $\mu \mathrm{s}$ |  |
| High Pulse Width | tclenh | $1 / 4$ tcy |  |  |  |
| Low Pulse Width | tclec | $3 / 4 \mathrm{tcy}$ |  |  |  |

NOTES: 1. Total lol for all registers must be less than 150mA under any conditions
2. Except following pins which have open drain outputs/inputs: 6, 7, 8, 12 and 13.
3. Test circuit:


| INSENERAL | AY-3-1350 |
| ---: | :---: |



Fig. 1 SYSTEM DIAGRAM

## OPERATION SUMMARY

Use of the AY-3-1350 can be split into three groups which are described in detail in separate sections:
ONE CHIP AY-3-1350 system generating 25 tunes plus 3 chimes which have been pre-programmed into the standard device
ONE CHIP AY-3-1350 system generating any number of tunes desired. This involves mask programming during manufacture and is usually not suitable for small quantity production.

TWO CHIP AY-3-1350 plus PROM system generating any tunes desired as above, but using the standard device so that applications, including small quantities, become feasible. (CMOS gate also required.)

## ONE CHIP STANDARD AY-3-1350 SYSTEM

## Typical Implementation

There are many ways to connect the standard device depending on the exact application. Figure 1 shows just one implementation of the device in a doorchime. This circuit gives access to all 25 tunes from switch $A$ and one of 5 tunes from switch $C$ as well as the descending active chime from switch B. The tune selected for switch $B$ follows the tunes list according to the setting of the two tune select switches (A-E and 0-4). The tune selected from switch C in Figure 1 is one of the five tunes AO through EO depending on the setting of the letter switch. For example, with the letter switch set at $E$ and the number switch set at 4, the tunes available will be:
Switch A: Beethoven's 9th (E4)
Switch C: Yankee Doodle (EO)
Switch B- Descending Octave Chime (Chime Z)
When the letter switch is in position $F$ there will be chimes on all doors independent of the number switch setting as follows*
Switch A: Westminster Chime
Switch C• Simple Chime
Switch B: Descending Octave Chime
There is virtually no power consumption in the standby condition (external transistor leakages only). When any door switch is activated the circuit powers up, plays a tune, and then automatically powers down again to conserve the battery, even if the operator keeps his finger on the switch to the end of the tune. He must release it and re-press to play again with the circuit in Figure 1. Activating any of the door switches will pull point A to ground
turning on the PNP transistor in the power supply line. This causes +5 V to be applied to the AY-3-1350 and the first operation of the chip is to put ON/OFF (pin 12) to logic 0 . This maintains the power through the PNP, even after the switch is released. The device can turn off its own power at the end of a tune by raising ON/OFF to logic 1.
Figure 1 shows only a typical one-chip implementation. Further options come from use of different switching and/or from use of the next tune facilities built into the chip. These will now be considered in turn.

## Switching Options

In Figure 1 the Switch C Group Select pin (16) is not connected, and one of the five tunes ( AO through EO) will play if switch C is activated. Other number groups can be chosen by connecting the Switch C Group Select pin as follows:

## TABLE 2

| Switch C Group Select pin (16) <br> is connected to: | Switch C Tunes |
| :---: | :---: |
| no other pin | AO-E0 |
| Tune Select 1 (pin 20) | A1-E1 |
| Tune Select 2 (pin 19) | A2-E2 |
| Tune Select 3 (pin 18) | A3-E3 |
| Tune Select $4($ pin 9$)$ | A4-E4 |

Which of the five possible switch C tunes will be played depends on the current setting of the LETTER SWITCH A-E.
Switch $C$ selection can be made by hard-wire connection for a permanent selection or a third switch can be added for an additional group selection feature.

## LED Direct Drive

$V_{x x}$ drives the gate of the output buffer, allowing adjustment of drive capability-

| Vxx | Vout | Isink (typ.) |
| :---: | :---: | :---: |
| 5 V | 0.4 V | 2.5 mA |
| 5 V | 0.7 V | 42 mA |
| 10 V | 04 V | 5.8 mA |
| 10 V | 0.7 V | 10.0 mA |
| 10 V | 1.0 V | 14.1 mA |

Using the power-up circuit of Figure 1, the AY-3-1350 will have +5 V applied and be latched within a few microseconds (dependant upon external components) from any bell-push closing. The device starts to operate when the RESET pin reaches logic 1 (about 10 ms with components shown) but in fact the tune select switches are not interrogated until approximately 6 ms later. The total is sufficient for most bell-pushes to complete any bounce period and for a firm selection of tunes to be made.

## Next Tune Facilities

At the end of tune play the circuit of Figure 1 powers down because ON/OFF (pin 12) is raised to a logic 1. This simplified flow diagram in Figure 3 shows that before the power down there is a test for connection between NEXT TUNE (pin 10) then RESTART (pin 17) with TUNESELECT 4 ( $\operatorname{pin} 9$ ). At this time NEXT TUNE (pin 10) then RESTART (pin 17), which are normally at logic 1, output a logic 0. This is looked for at input TUNESELECT 4 (pin 9). If neither is found the power down system is reached as in Figure 1.

A NEXT TUNE ( $p$ in 10) - TUNE SELECT 4 ( $\operatorname{pin} 9$ ) connection at the moment of test causes the next tune in the list to be played after a short pause (equal to a musical breve-the actual time depends on the setting of the tune speed control). The order of the tunes is A0 to E4 as given in the listing of standard AY-3-1350 tunes. If the last tune (E4) was played then the circuit will go on to play the first tune AO (and then successive ones). The chimes are not included in the cycling sequence.
A RESTART (pin 17) - TUNESELECT 4 (pin 9) connection at the moment of test at the end of a tune causes the same selected tune to be played again. Figure 3 shows that in this case the tune sensing mechanism is passed through once more so the tune would be different the second time if the switches were altered while the first tune was playing.
The connections referred to cannot be permanent because otherwise the circuit would never stop playing tunes. Figure 2 shows how transistors are used to make the connection in a practical application.


Fig. 2

| AY-3-1350 | INSTRUMERAL |
| :---: | :---: |

## ONE CHIP CUSTOM TUNES SYSTEM

## Customizing the Tunes

The AY-3-1350 has pre-programmed tunes, but the device is mask programmable during manufacture with any music required. A minimum of 1 tune to a maximum of 28 tunes can be incorporated. Examples as follows:

| Tunes | Total No. of notes, <br> all tunes together | Average notes <br> per tune |
| :---: | :---: | :---: |
| 1 | 252 | 252 |
| 2 | 251 | 126 |
| 5 | 248 | 50 |
| 10 | 243 | 24 |
| 20 | 233 | 12 |
| 25 | 228 | 9 |

(The general formula is Total No. of notes $=253-$ No. of tunes.) As an indication, about 90 seconds of music can be incorporated All musical rests are counted as one note. Semiquavers, quavers, dotted quavers, crotchets, dotted crotchets, minims, dotted minims and semibreves can all be accommodated. The range is about $21 / 2$ octaves. The position of these octaves can be chosen by the user up to a maximum pitch of $A=1760 \mathrm{~Hz}$. The tunes for incorporation in the device should be presented to General Instrument as normal music manuscript.

## Applications for Customized Tunes

If the number of tunes is less than the number of switch positions then the circuit will automatically proceed directly to power down if this mode is being used, or will find the next available tune if in the sequential mode.
All the different facilities described are still available when user tunes are masked into the device.

For toys, sequential tune playing adds variety and reduces the number of switches required, keeping costs to a minimum.
For musical boxes, playing the same tune repeatedly preserves the traditional features.

## TWO CHIP STANDARD AY-3-1350 PLUS PROM SYSTEM

## Introduction

With the addition of an external ROM or PROM the standard AY-3-1350 will play almost any tune or tunes desired. 28 tunes averaging 8 notes each or one tune of up to 252 notes is available. General Instrument can later integrate the external tunes into the main synthesizer to give a one chip system.

## Overall Coding Scheme

The external PROM should be $256 \times 8$ bits and of any static TTL compatible type.
It can have more words, but the tunes synthesizer will only use $256 \times 8$ bits at a time, e.g. if PROM type 2708 is used ( $1 \mathrm{~K} \times 8$ bits), the two higher order address lines should be connected to ground or switches put on them to give 4 times the amount of music (see logic diagram Figure 4). The rest of this article will assume a $256 \times 8$ bit PROM, and the addresses will be referred to as 000 to 377 Octal notation is used throughout.
The PROM address 000 must contain data 377 and address 377 must contain data 125 which is a key to open up the external PROM features All other addresses can contain tune data.
Each tune consists of a series of notes with one byte of PROM for each. Every tune must have a tune end marker byte 377 after the last note, and the final tune must have a byte 376 after the 377 end marker The memory allocation is shown diagrammatically in Figure 5. Tunes can be of any length and there can be any number of them subject only to the memory limit (28 max.).

| INSTRUMERENT | AY-3-1350 |
| :---: | :---: |



Fig. 3 SIMPLIFIED FLOW DIAGRAM

PROM Memory Allocation
Address DATA


Fig. 4

ALL TRANSISTORS TO HAVE $h_{\text {FE }}>80$ @ 1mA ON 4048 GATE: PINS 7, 8, 9, 10 and 15 TO GND. PINS 2 AND 16 TO +5V


Fig. 5 PLAYING YOUR OWN TUNES WITH EXTERNAL PROM (OR INTERNAL TUNES)

# Telephony 6 

Dialers 6-3<br>Multi-Frequency Generators 6-17<br>Code Conversion 6-21<br>Programmable Dialers 6-29

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| Dialers |  |  |  |
| PUSHBUTTON TELEPHONE DIALERS | Converts pushbutton input to rotary dial pulses. | AY-5-9151A/B | 6-4 |
|  |  | AY-5-9152/B | 6.4 |
|  |  | AY-5-9153A/B | 6-4 |
|  |  | AY-5-9154A | 6 -4 |
| LOOP DISCONNECT DIALER | Pushbutton-rotary dial converter with re-dial. | AY-5-9158 | 6-11 |
| MULTI-FREQUENCY DIALER | Dialer with dual tone. | AY-5-9559 | 6-14 |
| Multi-Frequency Generators |  |  |  |
| DUAL TONE MULTI-FREQUENCY GENERATORS | Generates DTMF/tone telephone frequencies. | AY-3-9400 | 6-18 |
|  |  | AY-3-9410 | - 6-18 |
| CODEC |  | Code Conversion |  |
|  | Duplex Delta-Sigma/PCM converter. | AY-3-9900 | 6-22 |
| Programmable Dialers |  |  |  |
| PROGRAMMABLE MACRO-COMPUTER TELEPHONE DIALERS | Single chip microcomputer pre-programmed for in-telephone applications. | T-2001 | 6-30 |
|  |  | TZ-2002 | 6-30 |
|  |  | TZ-2003 | 6-30 |

## INGENERAL

Dialers

| runction | \%W, \% | SARY NUMBER | PAGE' NUMBER" |
| :---: | :---: | :---: | :---: |
| PUSHBUTTON TELEPHONE DIALERS |  <br> Converto phesputton input to rotary dial pulses. <br>  | AY-5-8151A/B | 3-6-4 |
|  |  | AY 5 -9152/B | 64 |
|  |  | AY-5.99159AB | $\bigcirc 64$. |
|  |  | AY:5-9154A | 64. |
| LOOP DISCONNECT |  | AY509158: | $0 \cdot 11$ |
| MuLTFFREQUENCY DIALER: | Diferwith duaitone | AY5-9559 | 614 |

AY-5-9151A/B
AY-5-9153A/B
AY-5-9152/B AY-5-9154A

## Push Button Telephone Dialers

## FEATURES: AY-5-9151A

- 2.5 V to 5 V and $200 \mu \mathrm{~A}$ operation, plus standby mode
- Frequency of on-chip clock set by external RC network
- Selectable break: make ratio and interdigital pause
- Uses $3 \times 4$ matrix keyboard with no keyboard ground or common contact
- Keyboard inputs have antibounce protection
- Input pull-up or pull-down resistors on-chip
- Redial and access pause controlled from keyboard
- 22 digit capacity including access pauses
- Dialer reset for line power breaks $>200 \mathrm{~ms}$.

FEATURES: AY-5-9151B. Same as AY-5-9151A except:

- 18 Pin package

FEATURES: AY-5-9152. Same as AY-5-9151A except:

- Break: Make fixed at 60:40 plus:
- Two antiphase mask outputs for driving bistable relay

FEATURES: AY-5-9152/B. Same as AY-5-9152 except:

- 18 Pin package

FEATURES: AY-5-9153A. Same as AY-5-9151A when in $3 \times 4$ matrix keyboard mode plus:

- Pin selectable options of 1 of 12 keyboard, 2 of 7 keyboard wired to produce 4-bit code with common
- 8 bit output for displaying number in digit store
- Simple call-barring facility using display outputs

FEATURES: AY-5-9153B. Same as AY-5-9153A except:

- Keyboard is binary input with common

FEATURES: AY-5-9154A. Same as AY-5-9153A except:

- Break: Make fixed at 60:40 plus:
- Two antiphase mask outputs for driving bistable relay


## DESCRIPTION

This range of CMOS Pushbutton Dialers consists of seven devices AY-5-9151A to AY-5-9154A, all of which perform the function of converting input data (e.g. from a keyboard) into a series of pulses suitable for loop disconnect dialing. The series is based on two devices: a simple, basic dialer circuit and a more complex and versatile device which accepts a variety of data entry codes and has a display facility.
The use of CMOS technology results in low voltage and current requirements, enabling easy interfacing with a variety of telephones. The versatility of the devices and the low external component count enables the building of sophisticated, reliable telephones at low cost.

| Part Number | Min <br> Supply <br> Voltage | \# of <br> Pins | $\begin{gathered} \text { IDP } \\ \text { Pin Select } \end{gathered}$ | $\begin{gathered} \mathrm{B}: \mathrm{M} \\ \text { Pin Select } \end{gathered}$ | \# of Positive Voltage Supply Pins | Keyboard | Two <br> Antiphase Mask Outputs | Display Capability |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| *AY-5-9151A | 2.5 V | 22 | $\begin{gathered} \hline 700,800 \\ 500 \mathrm{~ms} \\ \hline \end{gathered}$ | yes | 2 | $4 \times 3$ | no | no |
| *AY-5-9151B | 2.5 V | 18 | $\begin{gathered} 700,800 \\ 500 \mathrm{~ms} \end{gathered}$ | yes | 2 | $4 \times 3$ | no | no |
| *AY-5-9152 | 2.5 V | 22 | $\begin{gathered} 700,800 \\ 500 \mathrm{~ms} \end{gathered}$ | $\begin{gathered} \text { fixed } \\ (60: 40) \end{gathered}$ | 2 | $4 \times 3$ | yes | no |
| *AY-5-9152/B | 2.5 V | 18 | $\begin{gathered} 700,800 \\ 500 \mathrm{~ms} \\ \hline \end{gathered}$ | $\begin{gathered} \text { fixed } \\ (60: 40) \\ \hline \end{gathered}$ | 2 | $4 \times 3$ | yes | no |
| *AY-5-9153A | 2.5 V | 28 | $\begin{gathered} 700,800 \\ 500 \mathrm{~ms} \end{gathered}$ | yes | 2 | $4 \times 3$ 1 of 12 4 bit $\&$ common | no | yes |
| *AY-5-9153B | 2.5 V | 28 | $\begin{gathered} 700,800 \\ 500 \mathrm{~ms} \end{gathered}$ | yes | 2 | binary input | no | yes |
| *AY-5-9154A | 2.5 V | 28 | $\begin{gathered} 700,800 \\ 500 \mathrm{~ms} \end{gathered}$ | $\begin{gathered} \text { fixed } \\ (60: 40) \end{gathered}$ | 2 | $4 \times 3$ 1 of 12 4 bit \& common | yes | yes |
| *AY-5-9158 | 2.5 V | 18 | $\begin{gathered} 800, \\ 500 \mathrm{~ms} \end{gathered}$ | fixed $(66.7: 33.3)$ | 1 | $4 \times 3$ | no | no |

*Redial capability: 22 digits
Dial Rate: 10pps

## PIN CONFIGURATIONS

22 LEAD DUAL IN LINE
AY-5-9151A


AY-5-9152
Top View


## PIN CONFIGURATIONS

## 18 LEAD DUAL IN LINE

## AY-5-9151B



AY-5-9152B


PIN CONFIGURATIONS

## 28 LEAD DUAL IN LINE

AY-5-9153A/9153B

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| $V_{D D} 1$ |  | 28 | KI11 |
| DO4/KI12 | 2 | 27 | $\square \mathrm{KIIO}$ |
| DISPLAY ENABLE | 3 | 26 | K14 |
| $\mathrm{V}_{\mathrm{DC}} 2$ | 4 | 25 | - K19/DO1 |
| CLOCK IN | 5 | 24 | $\square$ KEYPAD MODE |
| CLOCK | 6 | 23 | - Kı3 |
| ClOCK | 7 | 22 | KI2 |
| LINE OUTPUT | 8 | 21 | - Kı1 |
| B M SELECT | 9 | 20 | K18/DS4 |
| IDP SELECT | 10 | 19 | K17/KS3/DS3 |
| HANDSET | 11 | 18 | K16/KS2/DS2 |
| MASK | 12 | 17 | ] KI5/KS $1 / \mathrm{DS} 1$ |
| ACCESS PAUSE | 13 | 16 | $\square$ COMMON |
| $\mathrm{v}_{\text {ss }}$ | 14 | 15 | $\square$ INHIBIT |

## INSTRUNERAL

## PIN FUNCTIONS

$\mathbf{V}_{\text {ss }}$ - The negative supply to the device. All voltages are referenced to this pin.
$\mathbf{V}_{\text {DD1 }}$ - The positive supply to the digit store and write counter. Power must be maintained on this pin if the redial function is used.
$V_{D D 2}$ - The positive supply to the clock generator and control logic. $\mathrm{V}_{\mathrm{DD} 2}$ should rise to 2.5 V within 20 ms of switch-on.
Clock In, Clock, Clock - These pins are connected to an external RC network which controls the frequency of the clock generator and hence the timing of the line and mask outputs.
Handset Input - The state of the handset is used to control this input, a logic 1 on the input indicating that the handset is on-hook and a logic 0 indicating that the handset is off-hook. This input is used to reset the control logic depending on the past history of the input. If the input is taken from logic 1 to logic 0 , and the clock is not oscillating, a reset pulse is produced when clock pulses are detected. The device is then ready for operation.
If the input is taken to logic 1 for less than 200 ms and the clock generator is operating throughout this period, a reset pulse is not produced when the input is taken back to logic 0 . Thus short breaks in line power will not affect the operation of the circuit.
If the input is taken to logic 1 for more than 200 ms , and clock pulses are present throughout this period, a reset pulse will be generated at the end of the 200 ms period.
Line Output - The loop disconnect dial pulses appear at this output. It is an open drain output with the source of the output transistor being connected to $\mathrm{V}_{\text {ss. }}$. A break period corresponds to this transistor being switched on and a make period or IDP corresponds to the transistor being switched off. The first digit of any outdialing sequence is preceded by a pre-digit pause equal in length to an interdigital pause.
Mask Output/Mask 1 Output - This is a push-pull output and is used to mute the telephone speech circuit. A logic 1 indicates that the speech circuit is to be muted, this occurring immediately on recognition of an input from the keypad.
Mask 2 Output - The AY-5-9152/B and AY-5-9154A are fixed at 60:40 Break Make ratio and a Mask 2 output is substituted for the Break Make input. The mask 2 output is identical to the mask 1 but is driven in antiphase to enable a bistable mask relay to be used
On initial application of power, a pulse is produced on Mask 1 and Mask 2 outputs to reset a bistable relay which may be connected to these outputs.
IDP Input - This pin is used to select the duration of the interdigital pause. With a clock frequency of 18 kHz , interdigital pauses of 700 , 800 or 500 ms may be selected.

Break: Make Ratio - A choice of four break make ratio is available as a pin programmable option, 70:30, $666.333,60.40$ and 5050

Display Enable - When display data is being output from the dialer, this output goes to a logic 1.

Common Input - When a 4 bit code is used for data input a logic 1 on this input strobes the data into the device. Antibounce protection is provided for this input. A steady logic 1 of less than 5 ms duratıon will not be recognized and a steady logic 1 of greater than 10 ms duration will be recognized. This input has a pull down resistor to $V_{s s}$.

Inhibit Input - This is used to inhibit outdialing. If a logic 1 is placed on this input while a digit is being dialed, outdialing will cease when the digit has been completed. If the logic 1 appears during an IDP, outdialing will cease immediately. When outdialing has ceased, the Mask 1 output goes to logic 0 and Mask 2 goes to logic 1. When the input is taken to logic 0 , the Mask signal reappears and dialing continues, starting with an IDP.

Access Pause Output - When an access pause is reached in the dialing sequence, this output goes to logic 1 . By connecting this to the inhibit input, further outdialing will be prevented.

Keyboard Mode - The data on this pin determines whether the device will accept data from:
a) 1 of 12 keyboard with keyboard ground
b) 2 of 7 keyboard with keyboard ground and common switch
c) 4 bit binary code with common signal
d) $4 \times 3$ matrix keyboard without keyboard ground and common switch
When modes $b, \mathrm{c}$ or $d$ are in use with the AY-5-9153A/B or AY-5-9154A data in the form of two, four-bit words is available for display purposes, except when a key is pressed
Keyboard Inputs/Keyboard Scans/Display Outputs 1 of 12 Mode All twelve pins are used as keyboard inputs, on-chip pull-up resistors to logic 1 being incorporated A logical AND of the twelve inputs produces an on-chip Any Key Down signal when any input is taken to logic 0 . Detection of this signal initiates an anti-bounce period and at the end of this period, the data on the twelve inputs is read into the digit store, provided the Any Key Down signal is present throughout this period. Any further data is then inhibited untıl an antibounce period has been completed with all keys up If, during the antibounce period, the Any Key Down signal disappears, the antibounce timer will be reset

2 of 7 Mode - Keyboard inputs 1-4 are used for the 4-bit data, the common input strobing the data into the digit store On-chip pull down resistors to logic 0 are incorporated on the four data inputs and the common input When the common input is taken to logic 1 , an antibounce timer is started and if the common input is at logic 1 throughout, the data is read at the end of the period. Further data is then inhibited until the common input has been at logic 0 for an antibounce period.
Binary Mode - The 4-bit word is entered into the digit store via inputs $1-4$ by use of the common input, in a similar manner to the 2 of 7 mode. On-chip pull down resistors to logic 0 are incorporated. When data is not being read into the device ( 1 e when the common input is at logic 0) these four inputs are used as output pins for a 4-bit word for digit display purposes as described later
$4 \times 3$ Matrix Mode - This function will be described for the AY-5-9151 Series, and AY-5-9152/B. The mode of operation is slightly different for the AY-5-9153A/B and AY-5-9154A, as explained later.
A pulse to logic 0 is sequentially switched around the three keyboard scan outputs, taking 5 ms for a complete scan cycle When a key is pressed the pulse appears on one of the four keyboard inputs 1-4 (provided with pull-up resistors to logic 1), and if it occurs on the same input on the next scan cycle, the data is entered into the digit store Before a second key depression may be recognized, the first key must be released and a full scan cycle completed without a pulse on any input.
If two keys are pressed during the same scan cycle, the data will be rejected and again a full scan cycle must be completed without a pulse appearing on any of the inputs before another key depression may be recognized
If a key is pressed during an inhibit period, or two keys are pressed simultaneously, all three scan outputs will go to logic 0 until the key or keys is/are released.

Display Scans/Display Outputs - Data for the first 16 digits and access pauses in the store is available for display.
The position of a digit within a telephone number is indıcated by a 4 bit binary word from the Display Scan outputs. Display Scan 1 is the least significant bit and Display Scan 4 is the most significant bit. Binary word 0000 corresponds to the left-hand digit of the display (the first number entered) and 1111 corresponds to the right-hand (16th) digit of the display.
The digit being output is available as a 4 bit word on the display outputs (Display Out $1=$ least signıficant bit) Binary word 0001 represents digit 1 and so on to $0000=$ digit 10 Access pauses are represented by 1011.
When in the 2 of 7 mode or the Binary mode, the display data is inhibited by the appearance of the common signal When in the $4 \times 3$ matrix mode, depression of a key causes display scan data to appear on the keyboard inputs. The dialer then reverts to the normal keyboard scanning mode of operation.

## LINE AND MASK OUTPUT TIMING



The above sequence of events is that which occurs when the digit store is initially empty. The time intervals quoted in the following explanation are valid only for a clock frequency of 18 kHz . The time intervals are inversely proportional to the clock frequency.

## Event

1 The first key is depressed and the anti-bounce timer is started
2 The data from the keyboard is accepted. The mask output appears and the predigital pause commences. This is the same duration as the inter-digital pause and is pin selectable.
3 Dialing of the first digit starts. The example shown is a digit 2.
4 End of 1st digit and start of inter-digital pause.
5 Dialing of 2nd digit starts. The example shown is a digit 1.
6 End of 2nd digit and start of inter-digital pause.

## Time Interval

$T_{1-2}=5-10 \mathrm{~ms}$ after end of bounce
$T_{2-3}=700,800$, or 500 ms
(

## Event

1 Dialing of the last digit before the access pause commences. A digit 3 is shown in this example.
2 The end of the last digit before the access pause.
3 The mask signal is removed so that the telephone user can listen for the appearance of the second dial tone.

4 The telephone user presses the \# key to release the access pause. The antibounce timer is started.
5 The data from the \# key is $\quad T_{5-6}=700,800$, or 500 ms accepted or the inhibit input is taken to logic 0 and the mask signal reappears. A predigital pause equal in length to an inter-digital pause starts.
6 The digit after the access pause is dialed out. Dialing then contınues as normal.

## Access Pause and Redial Operation

These facilities are available on all devices, control being via the keypad or data input codes The 1 of 12 keypad and $4 \times 3$ keypad use the '*' button to insert an access pause and the '\#' button to release the access pause.
The '\#' button may also be used to redial the number in the digit store. If the redial mode is used, power must be maintained on $V_{D D 1}$ at all times.

## GENERAL <br> AY-5-9151A/B $\perp$ AY-5-9153A/B AY-5-9152/B ■ AY-5-9154A

## PIN SELECTABLE OPTIONS

a) Break:Make Ratio

| Ratio | Voltage On Pin |
| :---: | :---: |
| $70: 30$ | Clock |
| 66.6 .33 .3 | $V_{\text {DD }}$ |
| $60 \cdot 40$ | $\mathrm{~V}_{\text {SS }}$ |
| 50.50 | Clock |

b) IDP (with $\mathbf{1 8 k H z}$ clock frequency)

| IDP | Voltage on Pin |
| :---: | :---: |
| 700 ms | $\mathrm{~V}_{\mathrm{DD}} 2$ |
| 800 ms | $\mathrm{~V}_{\mathrm{SS}}$ |
| 500 ms | Clock |

c) Keyboard Mode

| Mode | Voltage On Pin |
| :---: | :---: |
| 2 of 7 | $V_{\text {DD }}$ |
| $3 \times 4$ | $V_{\text {SS }}$ |
| 1 of 12 | Clock |
| Binary | Clock |

DATA INPUT CODES
KI = Keyboard Input
Binary

| KI 4 | KI 3 | KI 2 | KI 1 | Digit |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 0 | 2 |
| 0 | 0 | 1 | 1 | 3 |
| 0 | 1 | 0 | 0 | 4 |
| 0 | 1 | 0 | 1 | 5 |
| 0 | 1 | 1 | 0 | 6 |
| 0 | 1 | 1 | 1 | 7 |
| 1 | 0 | 0 | 0 | 8 |
| 1 | 0 | 0 | 1 | 9 |
| 1 | 0 | 1 | 0 | 10 |
| 1 | 0 | 1 | 1 | Access Pause |
| 1 | 1 | 0 | 0 | Redial |

2 of 7

| KI 1 | KI 2 | KI 3 | KI 4 | Digit |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 1 |
| 0 | 0 | 0 | 1 | 2 |
| 0 | 0 | 1 | 0 | 3 |
| 0 | 1 | 0 | 0 | 4 |
| 0 | 1 | 0 | 1 | 5 |
| 0 | 1 | 1 | 0 | 6 |
| 1 | 0 | 0 | 0 | 7 |
| 1 | 0 | 0 | 1 | 8 |
| 1 | 0 | 1 | 0 | 9 |
| 0 | 0 | 1 | 1 | 10 |
| 1 | 1 | 0 | 0 | Access Pause |
| 1 | 1 | 0 | 1 | Redial |

4-bit codes other than those shown above are ignored.

DATA OUTPUT CODES
Display Scan (DS)

| $1{ }^{1} 2$ | 3 | 4 | 5 | 6 7 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DS4 |  | DS3 |  | DS2 | DS1 |  |  | Position |  |  |  |  |  |
| 0 |  | 0 |  | 0 | 0 |  |  | 1 |  |  |  |  |  |
| 0 | 0 |  |  | 0 | 1 |  |  | 2 |  |  |  |  |  |
| 0 |  | 0 |  | 1 | 0 |  |  | 3 |  |  |  |  |  |
| 0 |  | 0 |  | 1 | 1 |  |  | 4 |  |  |  |  |  |
| 0 |  | 1 |  | 0 | 0 |  |  | 5 |  |  |  |  |  |
| 0 |  | 1 |  | 0 |  | 1 |  | 6 |  |  |  |  |  |
| 0 |  | 1 |  | 1 | 0 |  |  | 7 |  |  |  |  |  |
| 0 |  | 1 |  | 1 | 1 |  |  |  |  |  |  |  |  |
| 1 |  | 0 |  | 0 | 0 |  |  |  |  |  | 9 |  |  |
| 1 |  | 0 |  | 0 | 1 |  |  | 10 |  |  |  |  |  |
| 1 |  | 0 |  | 1 |  | 0 |  | 11 |  |  |  |  |  |
| 1 |  | 0 |  | 1 |  | 1 |  | 12 |  |  |  |  |  |
| 1 |  | 1 |  | 0 | 0 |  |  | 13 |  |  |  |  |  |
| 1 |  | 1 |  | 0 | 1 |  |  | 14 |  |  |  |  |  |
| 1 |  | 1 |  | 1 | 0 |  |  | 15 |  |  |  |  |  |
| 1 |  | 1 |  | 1 | 1 |  |  | 16 |  |  |  |  |  |

Display Outputs (DO)

| DO4 | DO3 | DO2 | DO1 | Digit |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 1 | 0 | 2 |
| 0 | 0 | 1 | 1 | 3 |
| 0 | 1 | 0 | 0 | 4 |
| 0 | 1 | 0 | 1 | 5 |
| 0 | 1 | 1 | 0 | 6 |
| 0 | 1 | 1 | 1 | 7 |
| 1 | 0 | 0 | 0 | 8 |
| 1 | 0 | 0 | 1 | 9 |
| 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 1 | 1 | Access Pause |

The Display Scan outputs are continuously incremented, and the Display outputs changed accordingly, to enable the display of all the digits in the digit store by the use of multiplexing.
The Display Scan code is incremented at half the clock frequency.

The relationship between Clock, Display Data out and Display enable is as follows.

CLOCK


DISPLAY DATA


DISPLAY ENABLE


## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . . . . .$.
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}$
$\mathrm{V}_{\mathrm{DD} 1}=\mathrm{V}_{\mathrm{DD} 2}=2.5 \mathrm{~V}$ to $5.0 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{DD} 1} \geqslant \mathrm{~V}_{\mathrm{DD} 2}\right)$
$\mathrm{T}_{\mathrm{A}}=-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Clock frequency $=18 \mathrm{kHz}$ The device will function correctly from 8 kHz to 50 kHz but all timings (break period, IDP etc., ) will be directly dependent on the clock period.

| Characteristic | MIn. | Typ. | Max. | Units |  |
| :--- | :---: | :---: | :---: | :---: | :--- |
|  |  |  |  |  |  |

## NOTES:

1. The device will function correctly with a maximum logic ' 0 ' of 1.0 V and a minimum logic ' 1 ' of $\mathrm{V}_{\mathrm{DD}}-1.0 \mathrm{~V}$. However, use under these conditions may result in an increased supply current.
2. Measured with Break: Make, IDP, Inhibit and Keyboard Mode inputs at $V_{s s}$, and with no keys depressed.


Fig. 1 KEYBOARD CONNECTIONS FOR AY-5-9151A \& AY-5-9152


Fig. 2 PROVISIONAL PUSH-BUTTON DIALER CIRCUIT USING AY-5-9151A


RL $=$ Clare HDRM $-X-2096$
$K C=$ KEYBOARD COMMON SWITCH

Fig. 3 PUSHBUTTON DIALER USING MASK RELAY

## Loop Disconnect Dialer

## FEATURES

- 2.5 to 5.0 V supply voltage
- Low power standby mode for redial
- On-chip clock generator
- $4 \times 3$ matrix single contact keypad
- Pin selectable IDP
- On-chip input pull up/down devices
- Redial and access pause controlled from keypad
- 22 digit capacity including access pauses
- Plastic or Ceramic package


## DESCRIPTION

The AY-5-9158 is a CMOS loop disconnect dialer with full access pause and redıal capabılities, featuring pın-programmable Interdigital Pause. The use of a low voltage CMOS process realızes well known advantages of low power and high noıse immunity, partıcularly desirable features in a loop disconnect telephone dialer.

## PIN FUNCTIONS

## $V_{s s}$

This should be connected to the negative terminal of the power supply to the dialer. Voltages on all other pins of the dialer are normally referenced to this pin

## $V_{\text {dd }}$

This should be connected to the positive supply of the dialer. If the redial facility is required, power must be maintained on this pin when the handset is on-hook

## Clock Input, Clock and Clock

The clock pulse generator consists of two inverters, the frequency of oscillation being controlled by external components connected to these three pins. The circuit is sufficiently versatile to allow the use of a variety of external component configuratıons. Figure 1 shows the configuration used throughout this data sheet Details of the performance of this circuit are given in the section describing electrical characteristics

## IDP Select

The signal applied to this pin controls the duration of the interdigital pause as follows

| Voltage on Pin | IDP |
| :---: | :---: |
| Vss | 800 ms |
| Clock | 500 ms |

The pin may also be connected to $\overline{\text { CLOCK }}$ This increases the keypad scan frequency and outdialing frequency by a factor of 15 to facilitate high speed testıng of the device. The data on this pin is read during a reset controlled by the Trigger 1 input. This pin has an on-chip pull down device to $\mathrm{V}_{\text {ss }}$

## Line 1 and Line 2 Outputs

The loop disconnect dial pulses appear at these outputs. The ouput stage is a push-pull type with separate pins for the drains of

the output transistors as shown in Figure 2. During a dial pulse break period, the N channel device is off and the P channel device is on, creating a logic 1 at the Line 2 output During a make period and an IDP the N channel device is on and the P channel device is off, creating a logic 0 at the Line 1 output. The tımıng of the Line 1 output relative to the Mask output is shown in Figure 3. The Break Make ratio is fixed at 66733.3 .

## Mask Output

This is a push-pull output and is used to control the muting of the telephone speech circuit during dialing. A logic 1 indicates that the telephone is to be muted, the transitıon to logic 1 occurring immediately on recognition of a key depression

## Keypad Scans 1-3

These are push-pull outputs used to scan the keypad columns at a rate of 200 Hz Figure 4 shows how these outputs are connected to the keypad

## Keypad Inputs 1-4

The keypad contacts are used to connect one keypad scan output to one keypad input to enable recognition of a key depression Each of these inputs has an on-chip pull up device to Vdd For a descriptıon of how the keypad inputs recognize data, see Section 2.

## Trigger 1 and Trigger 2

These are connected to the input and output respectively of two inverters in series as shown in Figure 5 Connection of resistors R1 and R2 allows a Schmitt trigger circuit to be realized, the switching thresholds being determined by the values of these resistors. The characteristic of the Schmitt trigger is shown in Figure 6 If the input voltage $V_{T}$ is lower than the lower threshold $V_{T L}$, the clock generator is stopped and the scan outputs become high impedance. In this state the dialer consumes only a small leakage current and data in the RAM is maintaıned. If $V_{T}$ is increased and exceeds $V_{T H}$ the clock generator is started, the read and write counters are reset and a pulse appears at the Mask output as shown in Figure 7. The duration of the pulse is $16-19 \mathrm{~ms}$ for a clock frequency of 18 kHz .


Fig. 1


Fig. 2


The above sequence of events is that which occurs when the digit store is initially empty. The time intervals quoted in the following explanation are valid only for a clock frequency of 180 kHz . The time intervals are inversely proportional to the clock frequency.

Fig. 3

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\text {sS }}$. . . . . . . . . . . . . . . . +7.0 to -0.3
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise stated):
$\mathrm{V}_{\mathrm{ss}}=0.0 \mathrm{~V}$
$\mathrm{V}_{\mathrm{DD}}=2.5 \mathrm{~V}$ to 5.0 V
Ambient Temperature $=-25^{\circ} \mathrm{C}$ to $+80^{\circ} \mathrm{C}$
Clock frequency $=18 \mathrm{kHz}$ nominal (set by components shown in Fig. 1)

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Current IDD |  |  |  |  |  |
|  | - | $\overline{90}$ | 7240 | $\mu \mathrm{A}$$\mu \mathrm{A}$ |  |
|  |  |  |  |  | $\begin{aligned} & V_{d d}=50, V_{T \mathrm{~T}}=0.0 \\ & V_{d d}=V_{\mathrm{TL}}=50 \mathrm{~V} \end{aligned}$ |
|  |  |  |  |  | Note 1. |
| Inputs |  |  |  |  |  |
| KEYPAD SCANS |  |  |  |  |  |
| Logic '0' | -03 | - | 05 | v |  |
| Logic ' 1 ' | $V_{D D}$ | - | $V_{D D}$ | V |  |
|  | -0.5 | - | +0.3 | V |  |
| IDP. |  |  |  |  |  |
| Logic '0' | -03 | - | 02 | V |  |
| Logic '1' | $\mathrm{V}_{\text {dd }}$ | - | Vdd | V |  |
|  | -02 | - | +0.3 | V |  |
| $V_{\text {TH }}$ | 1.76 | - | 2.63 | V | $V_{D D} 36 \mathrm{~V}$, with specified Values of R1 and R2. Note 2. |
| $V_{\text {TL }}$ | . 96 | - | 1.84 | V |  |
|  |  |  |  |  |  |
| Keypad Inputs | 2 | - | 60 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {Ss }}$ |
| CURRENT SINK TO Vss. V $^{\text {S }}$ |  |  |  |  |  |
| IDP | 06 | - | 15 | $\mu \mathrm{A}$ | $V_{\text {IN }}=V_{\text {DD }}$ |
| LEAKAGE CURRENT: <br> Trigger 1, Clock 1 | - | - | 20 | nA | $T_{A}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {DD }}$ or $\mathrm{V}_{\text {SS }}$ |
| Outputs |  |  |  |  |  |
| Logic '0' Output Current | 2 | - | - | mA | $\mathrm{V}_{\mathrm{o}}=1.0 \mathrm{~V}$ |
| Logic '1' Output Current | 2 | - | - | mA | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{dd}}-1.0 \mathrm{~V}$ |
| LINE 1. |  |  |  |  |  |
| Logic '0' Output Current | 2 | - | - | mA | $V_{0}=10 \mathrm{~V}$ |
| Logic '1' Leakage Current | - | - | 1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{DD}}$ |
| LINE 2: |  |  |  |  |  |
| Logic '0' Leakage Current | - | - | 1 | $\mu \mathrm{A}$ mA | $V_{O}=V_{S S}$ $V_{0}=V_{\text {DO }}-10 V$ |
| KEYPAD SCANS, Trigger 2. |  |  |  |  |  |
| Logic '0' Current | 100 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{o}}=10$ |
| Logic '1' Current | 100 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{DD}}-10 \mathrm{~V}$ |
| Clock Frequency | 17.2 | - | 186 | kHz | $V_{\text {DD }}=775 \mathrm{~V}$ |
|  | 143 | - | - | kHz | $V_{D D}=2.5 \quad T_{A}=+25^{\circ} \mathrm{C}$ |
|  | - | - | 195 | kHz | $V_{D D}=50$ |
| Clock Frequency |  |  |  |  |  |
| Temperature Stability | - | - | $\pm 2$ | \% | Relative to value at $\mathrm{V}_{\mathrm{DD}}=5.0 \mathrm{~V}$ |
|  | - | - | $\pm 5$ | \% | Relative to value at $\mathrm{V}_{\mathrm{DD}}=25$ |

## NOTES

1. Measured with IDP at $\mathrm{V}_{\mathrm{SS}}$, Keypad Inputs at $\mathrm{V}_{\mathrm{DD}}$ and all outputs open circuit.
2. $\mathrm{R} 1=330 \mathrm{~K}$ ohms, $\mathrm{R} 2=1.5 \mathrm{M}$ ohms.

## Dual Tone Multi-Frequency Dialer

## FEATURES

- Pin for pin compatible with AMI S2559
- 2.5 V to 10 V supply voltage

■ Uses 3.58 MHz crystal to provide high accuracy tones

- $4 \times 3$ matrix single contact or 2 of 8 "telephone-type" keyboard
- Mute drivers on chip
- On chip reference voltage
- Dual and single tone capability
- Manufactured in General Instrument's proprietary OXI-CMOS* technology


## DESCRIPTION

The AY-5-9559 is a digital tone generator designed primarily for use as a DTMF telephone dialer. It is pin for pin and fuctionally equivalent to the AMI S2559 and pin for pin compatible with the Mostek MK5087.
Eight keyboard inputs provide an interface to either an X-Y format or 2 of 8 format (telephone type) keyboard. No common input is necessary. The inputs are arranged as four column and four row inputs, the column inputs being pulled high and the row inputs low by on-chip active current sources/sinks in the absence of a key depression When one key is depressed, a high level is detected on the appropriate row input. This causes the oscillator to start up and a keyboard scan routine to be initiated in order to detect which key has been depressed.
The eight inputs provide the ability for the chip to generate all 16 possible combinations of four low group and four high group frequencies according to Table 1, although in normal telephone dialing applications the highest high group frequency (initiated by column 4) is not used
The oscillator is crystal controlled, using a standard U.S. TV crystal at a frequency of 3.579545 MHz . Apart from the crystal, no external oscillator components are required. The fundamental accuracy of the generated tones is better than $0.75 \%$, as shown in Table 1, assuming the accuracy of the crystal (normally better than $0.01 \%$ ) does not impact on this figure.
When a valid key depression is detected, divide ratios are programmed into two counters, one for the high group tone and one

## PIN CONFIGURATION

16 LEAD DUAL IN LINE

for the low group tone. Each counter drives a 32 step weighted resistor ladder D-A converter to synthesize a sine wave of the correct frequency, at an amplitude governed by a voltage regulator. The two signals are linearly summed by an op amp which then drives the base of an open-emitter NPN transistor whose collector is connected to $\mathrm{V}_{\text {dd. }}$. This transistor provides sufficient current gain to drive a low impedance load in the emitter follower configuration.
Depression of a single key will activate one row and one column, thereby generating the appropriate two-tone combination. Depression of two keys in the same row or two keys in the same column will cause a single low group (row) tone or high group (column) tone to be generated, providing the Single Tone Inhibit input is either unconnected or held high If this input is connected low, no output will be generated if more than one key is depressed.
In the absence of a key depression the chip remains in its power down mode, the oscillator is disabled and the XMIT switch acts as a current source in order to power external circuitry. The MUTE output is held low as an indication of the state of the device. When a key is depressed, the chip switches to its operating mode, indicated by the MUTE output going high. The oscillator is enabled and the XMIT output goes open circuit, ceasing to source current to the external circuitry.

Table 1: FREQUENCIES GENERATED BY AY-5-9559

| $\begin{array}{c}\text { Keyboard } \\ \text { Input }\end{array}$ | $\begin{array}{c}\text { Tone Output } \\ \text { Standard }\end{array}$ |  | Actual |
| :---: | :---: | :---: | :---: |\(\left.] \begin{array}{c}\% <br>


Error\end{array}\right]\)| R1 | 697 | 699.1 | +0.30 |
| :---: | :---: | :---: | :---: |
| R2 | 770 | 766.2 | -0.49 |
| R3 | 852 | 847.4 | -0.54 |
| R4 | 941 | 948.0 | +0.74 |
| C1 | 1209 | 1215.9 | +057 |
| C2 | 1336 | 1331.7 | -0.32 |
| C3 | 1477 | 1471.9 | -0.35 |
| C4 | 1633 | 1645.0 | +0.73 |

*OXI-CMOS Technology

| AY-5-9559 | INSTRUMERAL |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltages on any Pin with Respect to $\mathrm{V}_{\text {ss }}$. . . . . . . . . . . . . . -0.3 V to +15 V
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature Range . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated):
Operating Temperature . . . . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
DC CHARACTERISTICS All voltages below referred to $\mathrm{V}_{\mathrm{ss}}=\mathrm{OV}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Positive Supply voltage | 2.5 | - | 10.0 | V | Active |
|  | 1.5 | - | 10.0 | V | Standby |
| Supply Current - active- standby | - | - | 2.0 | mA |  |
|  | - | - | 30.0 | $\mu \mathrm{A}$ ) | $V_{\text {dd }}=3 \mathrm{~V}$ |
| (see Note 1) $\begin{array}{ll}\text { - active } \\ & \text { - standby }\end{array}$ | - | - | 16.0 | mA | $\mathrm{V}_{\mathrm{dd}}=10 \mathrm{~V}$ |
|  | - | - | 100 | $\mu \mathrm{A}$ \} | $\mathrm{V}_{\mathrm{dd}}=10 \mathrm{~V}$ |
| Ambient temp. range | -25 | - | +80 | ${ }^{\circ} \mathrm{C}$ |  |
| Tone Output voltage - single tone (Row) | 110 | 315 | 495 | mV RMS | $\left.\mathrm{V}_{\text {dd }}=3.5 \mathrm{~V}\right\}_{\mathrm{R}_{\mathrm{L}}=390 \Omega}$ |
|  | 325 | 525 | 660 | mV RMS | $V_{\text {dd }}=5 \mathrm{~V} \quad \mathrm{~V}_{\mathrm{L}}=390 \Omega$ |
|  | 400 | 575 | 755 | mV RMS | $\mathrm{V}_{\mathrm{dd}}=10 \mathrm{~V} ; \mathrm{R}_{\mathrm{L}}=240 \Omega$ |
| Column/Row tone pre-emphasis | 10 | 2.0 | 30 | dB |  |
| Output signal distortion (Note 2) | - | - | 7 | \% |  |
|  | - | - | -23 | dB |  |
| Tone output rise time | - | - | 5 | ms |  |
| XMIT output voltage (high) (Standby) | 1.5 | - | - | V | $\mathrm{V}_{\text {dd }}=3 \mathrm{~V} ; \mathrm{I}_{\mathrm{ohx}}=15 \mathrm{~mA}$ |
|  | 8.5 | - | - | V | $\mathrm{V}_{\mathrm{dd}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{ohx}}=50 \mathrm{~mA}$ |
| XMIT output leakage current (low) (Active) | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {dd }}=10 \mathrm{~V} ; \mathrm{V}_{\text {olx }}=0 \mathrm{~V}$ |
| MUTE output voltage (high) - no load | 2.5 | - | - | V | $\mathrm{V}_{\mathrm{dd}}=2.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{ohm}}=0.5 \mathrm{~mA}$ |
|  | 9.5 | - | - | V | $\mathrm{V}_{\text {dd }}=10 \mathrm{~V} ; \mathrm{I}_{\text {ohm }}=0.6 \mathrm{~mA}$, |
| MUTE output voltage (low) - no load | - | - | 0.5 | v | $\mathrm{V}_{\text {dd }}=2.5 \mathrm{~V} ; \mathrm{I}_{\text {olm }}=0.5 \mathrm{~mA}$ |
|  | - | - | 0.5 | V | $\mathrm{V}_{\mathrm{dd}}=10 \mathrm{~V} ; \mathrm{I}_{\mathrm{olm}}=2 \mathrm{~mA}$ |
| Oscillator output sink current | 0.2 | - | - | mA |  |
|  | 08 | - | - | mA | $\left.V_{\text {dd }}=10 \mathrm{~V}\right\} \mathrm{V}_{\text {ol }}=0.5 \mathrm{~V}$ |
| Oscillator output source current | 01 | - | - | mA | $\mathrm{V}_{\text {dd }}=3 \mathrm{~V} ; \mathrm{V}_{\text {oh }}=2.5 \mathrm{~V}$ |
|  | 04 | - | - | mA | $\mathrm{V}_{\text {dd }}=10 \mathrm{~V} ; \mathrm{V}_{\text {oh }}=9.5 \mathrm{~V}$ |
| Oscıllator input sink current (Standby) | 25 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{11}=0.5 \mathrm{~V}$ |
| Oscillator start-up time | - | - | 5 | ms | $\mathrm{V}_{\text {dd }}=10 \mathrm{~V}$ |
|  | - | - | 4 | ms | $\mathrm{V}_{\mathrm{dd}}=3 \mathrm{~V}$ |
| Oscillator input/output capacitance | - | - | 16 | pF | $\mathrm{V}_{\text {dd }}=3 \mathrm{~V}$ |
|  | - | - | 14 | pF | $V_{\text {dd }}=10 \mathrm{~V}$ |
| Column input pull-up current | 100 | - | - | $\mu \mathrm{A}$ | $V_{\text {dd }}=3 \mathrm{~V} ; \mathrm{V}_{\text {in }}=2.5 \mathrm{~V}$ |
|  | 300 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{dd}}=10 \mathrm{~V} ; \mathrm{V}_{\text {th }}=9.5 \mathrm{~V}$ |
| Row input pull-down current | 10 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {dd }}=3 \mathrm{~V}, \mathrm{~V}_{11}=1 \mathrm{~V}$ |
|  | 10 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{dd}}=10 \mathrm{~V} ; \mathrm{V}_{\mathrm{tI}}=2.5 \mathrm{~V}$ |
| Single tone inhibit pull-up current | 1.5 20 | - | - | $\mu \mathrm{A}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{dd}}=3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{dd}}=10 \mathrm{~V} \end{aligned}$ |

## NOTES:

1. Active - one key selected; TONE, XMIT and MUTE outputs unloaded. Standby - no key selected; TONE, XMIT and MUTE outputs unloaded.
2. Distortion defined as the ratio of the total power of all extraneous frequencies in the voiceband above 500 Hz accompanying the signal, to the total power of the frequency parr.
PIN FUNCTIONS

| Signal | Function |
| :---: | :---: |
| $\mathrm{V}_{\text {dd }}$ | Positive supply voltage |
| $V_{\text {ss }}$ | Negative supply voltage |
| Osc In Osc Out | Input and output of a high gain amplifier designed to oscillate at 3.58 MHz with the addition of an external crystal. All other necessary oscillator components are provided on chip. |
|  | Column inputs for a $4 \times 4$ matrix keyboard, single or double contact With no key depressed, active pull-up devices pull these inputs high. |
|  | Row inputs for a $4 \times 4$ matrix keyboard, single or double contact. With no key depressed, active pull-down devices pull these inputs low. |
| XMIT Switch | Emitter connection of an open-emitter NPN switching transistor with collector connected to $\mathrm{V}_{\text {dd }}$. Functions as a current source when chip is in standby mode (no key depressed). |
| Mute | Output of a CMOS buffer. - Switches high when a key depression is detected, otherwise stays low. |




## Dual Tone Multi-Frequency Generators

## FEATURES

- No tuning required, inherent accuracy $\pm 0.25 \%$
- Uses low cost ceramic resonator
- 12 tone pairs ( 16 tone pairs with AY-3-9410 and chorce of high group pre-emphasis with AY-3-9410)
- Total harmonic distortion less than 8\% (but dependent on external filter)
- Instant generation of tone outputs
- Low voltage drop
- Low power consumption (less than 35 mW )
- Good thermal and voltage stability
- Keyboard lock out inhibits output if more than one key depressed
- N-channel ion implant construction
- High group pre-emphasis fixed at 3.52 dB (AY-3-9400), 3/6dB (AY-3-9410)
- Pre-emphasis can be varied by simple component adjustment.


## DESCRIPTION

The AY-3-9400/9410 DTMF circuits generate all the tone pairs required for multifrequency tone dialing. The tones are generated from a single ceramic controlled master oscillator, ensuring high accuracy and stability of the output frequencies and eliminating the need for any adjustments. The digitally synthesized tones give precisely controlled characteristics.
The AY-3-9400/9410 is fabricated using the ion implant N-channel low voltage process, and employs novel logic techniques to minimize power consumption and voltage drops. The circuit is suitable for operation direct from telephone line power, or it can be used with main power or battery supplies.

## PIN CONFIGURATION

14 LEAD DUAL IN LINE
AY-3-9400


16 LEAD DUAL IN LINE AY-3-9410



## OPERATION

When a key is pressed the chip will immediately start operating, the output tones both starting from zero on the first negative half cycle. The first cycle will be of full amplitude assuming the power supply is at the correct level. If power is applied at the same time as a key is pressed, the power on reset circuit will operate, preventing spurious outputs.
When two or more keys are pressed together, one or both tones will be switched off. The tones will start from zero as soon as the extra keys have been released. When all keys are released, the tone outputs will immediately cease.
If only one key contact is made, a single tone corresponding to the closed contact will be output. The "Any Key Down" output, which requires a pull-up resistor (typ. 47K), goes to logic '0' as soon as a key depression is recognized.

The tones are output on a single pin, as a mixture of pulse width modulated, constant amplitude square waves. This output signal is constructed into resultant sine waves in the external low pass filter. The approximation chosen yields a total harmonic distortion of less than $8 \%$.
The amplitude of the output signal is directly proportional to the $V_{C C}$ supply voltage.
A low pass filter buffer amplifier is used to remove switching noise and interface the tones to the line. There is an option of either a low impedance or a high impedance output for interfacing to telephone lines. The low impedance circuit is shown in Fig. 1; the high impedance circuit is shown in Fig. 2.
Pre-emphasis selection for the AY-3-9410 is accomplished by connecting pin 13 to $V_{c c}$ for 3 dB high group pre-emphasis, or to ground for 6dB pre-emphasis. The circuits are otherwise identical in operation to the AY-3-9400.


Fig. 1 LOW IMPEDANCE INTERFACE CIRCUIT


Fig. 2 HIGH IMPEDANCE INTERFACE CIRCUIT

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to Ground Pin . . . . . . . . +10 V to -0.3 V
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Ambient Operating Temperature Range . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$V_{c C}=+3.5$ to +8 V
F Clock $=559.7 \mathrm{kHz}$
Operating Temperature ( $\mathrm{T}_{\mathrm{A}}$ ) $-25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Logic '1' | +3.3 | - | +8 | Volts | Logic ' 1 ' actıvates tone |
| Input Logic '0' | -0.3 | - | +0.4 | Volts |  |
| Input pull down resistance | 20 | - | 100 | $\mathrm{k} \Omega$ | Resistor to ground |
| Input capacitance | - | - | 10 | pF |  |
| Tone output Low Group | - | 0.312 | - | $V$ peak | $V_{C C}=4 V$, Note 1, |
| Tone output High Group | - | 0.486 | - | $V$ peak | ) $V_{C l}=4 \mathrm{~V}$, Note 1 , |
| High group pre-emphasis | - | 3.52 | - | dB |  |
| Output impedance | - | - | 500 | $\Omega$ | Note 2, Note 3 |
| Any Key Down output |  |  |  |  |  |
| On resistance | - | - | 1 | $k \Omega$ | Vout $=+1 \mathrm{~V}$ |
| Off Leakage | - | - | 10 | $\mu \mathrm{A}$ | Vout $=+8 \mathrm{~V}$ |
| Total Distortıon | - | - | -23 | dB | Note 4 |
| Harmonic component | - | - | $-30$ | $d B$ | Note 4 |
| Supply current | - | - | 8 | mA | $V_{C l}=+3.5 \mathrm{~V}$ |
|  | - | - | 10 | mA | $V_{C l}=+8 \mathrm{~V}$ |

**Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.
NOTE:
1 The amplitudes of the output signals are directly related to the $\mathrm{V}_{\mathrm{cc}}$ supply voltage.
2. The chip output is intended to drive a low pass filter having an input impedance of greater than 8 K .

3 The output would be buffered to drive the line, the buffer can be arranged to have either a high impedance current output or a low impedance voltage output (See Fig. 1).

## FREQUENCY OUTPUTS

All output frequencies are derived from a 559.7 kHz master oscillator. The output frequencies are as follows:

|  | Nominal Frequency Hz | Actual Frequency Hz | $\begin{aligned} & \text { Error } \\ & \text { \% } \end{aligned}$ | Key | Input Tone Pair |  | Normal Digit Representation |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | LowGroup (Hz) | High Group (Hz) |  |
|  |  |  |  |  |  |  | C1 |
| Low Group | 697 | 695.28 | -0 25 | A | 697 | 1209 | 1 |
|  | 770 | 768.82 | -0.15 | B | 697 | 1336 | 2 |
|  | 852 | 850.61 | -0.16 | C | 697 | 1477 | 3 |
|  | 941 | 940.68 | -0.03 | D | 697 | 1633 | (A) |
|  |  |  |  |  | 770 | 1209 | 4 |
| High Group | 1209 | 1211.48 | +0.21 | E | 770 | 1336 | 5 |
|  | 1336 | 1332.62 | -0.25 | F | 770 | 1477 | 6 |
|  | 1477 | 148069 | +0 25 | G | 770 | 1633 | (B) |
|  | 1633 | 163178 | -0 07 | H | 852 | 1209 | 7 |
|  |  |  |  |  | 852 | 1336 | 8 |
|  |  |  |  |  | 852 | 1477 | 9 |
|  |  |  |  |  | 852 | 1633 | (C) |
|  |  |  |  |  | 941 | 1209 | * |
|  |  |  |  |  | 941 | 1336 | 0 |
|  |  |  |  |  | 941 | 1477 | \# |
|  |  |  |  |  | 941 | 1633 | (D) |

## GENERAL INSTRUMENT

## Code Conversion



## PCM Code Converter (CODEC)

## FEATURES

- Converts a delta-sigma modulated pulse stream at 2048 kbit/sec into 8 ksample/sec companded PCM
- Converts 8 ksample/sec companded pcm into a deltasigma modulated pulse stream at $2048 \mathrm{kbit} / \mathrm{sec}$
- Enables the realization of a single channel PCM Codec using a minimum of external components
- Serial PCM input/output interface can operate in a single channel mode at $64 \mathrm{kbit} / \mathrm{sec}$, or at up to $2048 \mathrm{kbit} / \mathrm{sec}$ for a multi-channel burst format
- All digital technique uses no on-chip precision components
- Pin-selectable A-law/ $\mu$-law companding characteristic
- Optional alternate digit inversion provided
- Direct interface with standard TTL or CMOS
- Encoder and Decoder can be clocked asynchronously (useful for PCM multiplex applications)


## DESCRIPTION

The AY-3-9900 is a PCM Code Converter containing all the logic necessary to realize a high performance low cost single channel PCM Codec according to the system block schematic, Fig. 1. It contains no analog components and is fabricated with General Instruments N-Channel Ion-Implant GIANT II process, ensuring high performance with proven reliability and production history. Together with the chip, an external delta-sigma modulator and demodulator using a small number of easily obtainable components, is required to construct the Codec, which uses delta-sigma modulation as an intermediate stage in the conversion of an analog signal into PCM and vice-versa. A pin-selectable companding characteristic which meets the CCITT recommenda-

## PIN CONFIGURATION <br> 24 LEAD DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| $\mathrm{V}_{\text {ss }}-1$ | 24 | ] NC |
| MS [ 2 | 23 | DSMR |
| DS1 ${ }^{-1}$ | 22 | $\square \mathrm{SCD}$ |
| DS2-4 | 21 | $\square \mathrm{CLKE}$ |
| ADI 5 | 20 | $\square$ CLKD |
| $V_{D D}-6$ | 19 | SCE |
| A $/ \mu-7$ | 18 | $\square$ DTW |
| $V_{\text {cc }}-8$ | 17 | $\square$ SGBO |
| DSMO-9 | 16 | $\square \mathrm{PCMI}$ |
| SGN 10 | 15 | $\square$ ETV |
| DSMI 11 | 14 | $\square$ SGBI |
| SRF 12 | 13 | $\square \mathrm{PCMO}$ |

tions G711/G712 for both. A-law and $\mu$-law with good safety margins is included, together with a very flexible serial PCM input/output interface to allow the Codec to be readily used in a wide number of applications.


## CIRCUIT DESCRIPTION

The AY-3-9900 consists of two autonomous logic systems, designated in this specification as encoder and decoder. The encoder provides the necessary logic for the digital conversion of a delta-sigma encoded pulse density signal at 2048 kbit/sec into standard 8 ksample/sec 8 bit compressed PCM codewords. The decoder provides the necessary logic for the digital conversion of standard 8 bit compressed PCM characters at $8 \mathrm{ksample} / \mathrm{sec}$ into a delta-sigma encoded pulse density signal at 2048 kbit/sec. Serial PCM input/output interfaces are also provided with facilities for a data rate of 64 to $2048 \mathrm{kbit} / \mathrm{sec}$ to enable its use in either a single channel system or a standard 30 channel TDM environment. For the necessary timing information to clarify this section reference should be made to the waveform diagrams, Figs. 5a, 5b, and $5 e$.
The encoder logic, operating continuously on the delta-sigma input pulse train, will generate a corresponding compressed PCM codeword every $125 \mu \mathrm{~s}$; with alternate digit inversion being provided if required by appropriate use of the ADI control input. A timing vector pulse (ETV) of nominal width equal to one encoder clock period, will define the required frame start time and should be repeated every $125 \mu$ s to ensure correct synchronization.
If the mode select (MS) input is connected high then the 8 bit PCM codeword will be transmitted serially at a rate of $64 \mathrm{kbit} / \mathrm{sec}$ at which speed each codeword will occupy the full $125 \mu$ s frame period for transmission, with the leading edge of the first bit occurring at a time defined by the ETV pulse.
Alternatively, if the MS input is left open circuit or connected low, the serial PCM transmission will be under the control of an externally generated shift clock (SCE) which can vary in frequency from 64 kHz to 2048 kHz . The timing of this input function allows the insertion of a number of signalling bits into the PCM stream via the SGBI input.
With the MS input connected high, an input PCM bit stream at 64 $\mathrm{kbit} / \mathrm{sec}$ will be accepted by the decoder logic under the control of internal clocks generated from the CLKD signal. Because of delays through the transmission network, normally under the control of transmission switches, the input pulse stream may be delayed in time by number of digit periods from the original pulse stream as transmitted. To allow for this, a discrete delay of 0 to 3 digit periods can be selected by the control inputs DS1 and DS2 which results in a controlled shift of decoder timing in order to realign bit 1 in its correct position in the input register. Alternatively, if the MS input is left open circuit or connected low, the decoder input interface will be under the control of externally generated waveforms in which case it requires an input shift clock (SCD) and timing waveform (DTW) to define the time when bit 1 of the input codeword occupies its correct position in the input register. In this mode, the device will accept an input PCM stream at up to $2048 \mathrm{kbit} / \mathrm{sec}$, with any signalling bits present in this signal being extracted via the SGBO output.
Upon receipt of a compressed PCM codeword, the decoder logic will first remove alternate digit inversions if necessary (under the control of the ADI input) after which the codeword will be linearized. A digital delta-sigma modulator will then generate a delta-sigma bit stream at 2048 kbit/sec for external decoding to produce the required analog signal.
All inputs and outputs of the AY-3-9900 are directly compatible with standard TTL (driving capacitive loads) or CMOS.

## INPUT/OUTPUT FUNCTIONS

## Supplies:

| $V_{\text {SS }}$ | GND |
| :--- | :--- |
| $V_{\text {cc }}$ | $+5 V$ |
| $V_{\text {DD }}$ | $+9 V$ |


| AY-3-9900 | INSTRUMERAL |
| :---: | :---: |

## DC Control Signals:

MS Mode Select - Selects between internal and external PCM I/O interface timing
Logic $0=$ external
Logic $1=$ internal
A resistor is connected internally between this input and $V_{\text {ss }}$.
ADI Alternate-digit-inversion control-Selects ADI or no ADI
Logic $0=$ no ADI
Logic $1=\mathrm{ADI}$
A resistor is connected internally between this input and $V_{\text {ss. }}$
DS1, Decoder delay select - A two bit binary word to select
DS2 the required digit delay between encoder and decoder.

| $\frac{\text { DS1 }}{0}$ |  | DS2 |  |
| :---: | :---: | :---: | :---: |
|  |  | 0 | 0 |
| 0 | 1 | 1 |  |
| 1 | 0 | 2 |  |
| 1 | 1 | 3 |  |

A resistor is connected internally between each input and $V_{\text {ss }}$.
A/ $\mu \quad$ Companding characteristic select-selects either A-law or $\mu$-law

Logic $0=$ A-law
Logic $1=\mu$-law
A resistor is connected internally between this unput and $V_{\text {ss. }}$

## CLOCKS \& AC CONTROL SIGNALS

CLKE Encoder main clock - 2.048 MHz clock signal
CLKD Decoder main clock -2.048 MHz clock signal
SCE Encoder shift clock - Used to control the output of serial PCM data from the encoder (when MS $=0$ )
SCD Decoder shift clock - Used to control the input of serial PCM data to the decoder (when MS=0)
ETV Encoder timing vector - A pulse defining the beginning of each frame, used to maintain encoder timing.
DTW Decoder timing waveform - A pulse used to indicate to the decoder when the input PCM stream is in the input register (only required when external shift clocks are used).
DSMR Delta-sigma reset - a pulse used to reset the digital delta sigma modulator during testing only Should be tied to ground during normal operation.

## ENCODER OPERATIONAL INPUTS \& OUTPUTS

DSMI Delta-Sigma modulated input signal - Input to the encoder from the delta-sigma modulator.
SRF Spectral redistribution function - 8 kHz Output signal used to operate on the delta-sigma modulator to reduce low frequency quantization noise.
SGN Sign bitoutput - Sign bit from theencoder, usedtooperate on the delta-sigma modulator for DC alignment
SGBI Signalling bit input - facility for adding sıgnalling bit(s) to the output PCM stream. ( $M S=0$ ).
PCMO PCMioutput - SerıalPCMoutputunderthecontrolofthe encoder shift clock $(M S=0)$ or the encoder main clock ( $M S=1$ ).

## DECODER OPERATIONAL INPUTS AND OUTPUTS

PCMI PCM input - Serial PCM input under the control of the decoder shift clock ( $M S=0$ ) or the decoder main clock ( $M S=1$ )
SGBO Signalling bit output - Serial output for extracting signalling bit(s) from the incoming PCM stream.
DSMO Delta-sigma modulated output signal - Output pulse stream from the decoder.

## A SINGLE CHANNEL PCM CODEC

The block schematic of a single channel Codec using the AY-39900 is shown in Fig. 1. It consists of a band limiting low pass filter followed by a delta-sigma modulator which, by sampling at a rate of 2048 kHz provides a highly over-sampled, waveform-tracking A/D conversion. The bit stream produced by this modulator at 2048 kbits, is then converted into 8 bit compressed PCM code words at the standard rate of $8 \mathrm{ksample} / \mathrm{sec}$; which, after conversion into serial format is transmitted serially at a bit rate of $64 \mathrm{kbit} / \mathrm{sec}$. By the application of external timing signals, the PCM output transmission rate can be increased to allow for multiplexing in a burst format, with a maximum bit rate of 2048 kbit/sec.
The PCM input interface will accept either a $64 \mathrm{kbit} / \mathrm{sec}$ bit stream or, by the application of external timing signals, a bit rate of up to
$2048 \mathrm{kbit} / \mathrm{sec}$ in a burst format. This input PCM stream will be converted into a delta-sigma modulated pulse stream at 2048 $\mathrm{kbit} / \mathrm{sec}$, from which the original analog signal can be recovered by the use of a low pass filter,cutting off just above the highest signal frequency to be recovered $(3.4 \mathrm{kHz})$.

The transition times and voltage levels of the delta-sigma modulated pulse streams are critical to the performance of the system. The delta-sigma modulator should therefore be constructed using TTL D-Types; with the delta-sigma modulated output pulse stream from the AY-3-9900 being clocked through a similar D-type before the analog signal is recovered.
Fig. 2 shows a more detailed diagram of the necessary external components (including component tolerances) required to realize a complete PCM Codec using the AY-3-9900. The response of such a Codec is shown graphically in Figs. 3 and 4.


Fig. 2 DETAILS OF DELTA-SIGMA MODULATOR, WITH DEMODULATOR LEVEL GENERATOR

TYPICAL PERFORMANCE MEASUREMENTS: A-LAW

$450-550 \mathrm{~Hz}$ NOISE TEST FOR LEVEL $<-10 \mathrm{dBmO}$
850 Hz SINEWAVE TEST FOR LEVEL > $-10 \mathrm{dbm0}$
TYPICAL PERFORMANCE MEASUREMENTS: $\mu$-LAW



REFERENCE LEVEL
OdB GAIN

| GENERAL | AY-3-9900 |
| ---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . .$.
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}$ (substrate voltage)
$V_{\text {cc }}=+5 \mathrm{~V} \pm 5 \%$
$\mathrm{V}_{\mathrm{DD}}=+8.5 \mathrm{~V}$ to +12.5 V
Operating temperature $\left(T_{A}\right)=-25^{\circ} \mathrm{C}$ to $+75^{\circ} \mathrm{C}$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Min. | Typ.** | Max. | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DC Control Inputs |  |  |  |  |  |
| Logic 1 | 4.75 | 5 | 10 | V | Connect to $\mathrm{V}_{\text {cc }}$ or $\mathrm{V}_{\text {DD }}$ |
| Logic 0 | 0 | - | 0.4 | V | Connect to $\mathrm{V}_{\text {ss }}$ |
| Pull down resistor | 200 | - | 1000 | k $\Omega$ | Resistor to $\mathrm{V}_{\text {ss }}$ |
| CLOCKS (CLKD \& CLKE) |  |  |  |  |  |
| Logic 1 | 3 | - | 10 | V |  |
| Logic 0 | -0.2 | 0 | 0.4 | V |  |
| Rise \& Fall Times | 5 | - | 40 | ns | 0.4V-3V transition |
| Frequency | - | 2.048 | - | MHz |  |
| Pulse Width | 200 | - | - | ns | Between 1.5V levels (Fig. 4c) |
| Input Capacitance | - | - | 10 | pF |  |
| Other A.C. Control Signals |  |  |  |  |  |
| Logic 1 | 3 | - | 10 | v |  |
| Logic 0 | -0.2 | 0 | 0.4 | V |  |
| Rise \& Fall times | 5 | - | 40 | ns | 0.4-3V transition |
| SCE/SCD pulse width | 200 | - | - | ns | between 1.5 V levels |
| ETV width (tvw) | - | 488 | - | ns $\}$ |  |
| edge variation (tvv) | - | - | 100 | ns $\}$ | See Fig. 4c. |
| DTW width | 10 | - | - | $\mu \mathrm{s}$ | One digit period (see Fig. 4c) |
| Input Capacitance | - | - | 10 | pF |  |
| Operational Inputs |  |  |  |  |  |
| Logic 1 | 3 | - | 10 | V |  |
| Logic 0 | -0.2 | 0 | 0.4 | V |  |
| Rise \& Fall Times | 5 | - | 40 | ns | 0.4-3V transition |
| Pulse Width | 200 | - | - | ns | between 1.5 V levels |
| Input capacitance | - | - | 10 | pF |  |
| Operational Outputs |  |  |  |  |  |
| Logic 1 | 4 | 5 | 5.25 | V |  |
| Logic 0 | 0 | - | 0.4 |  |  |
| Logic 1 source current | 100 | - | - | $\mu \mathrm{A}$ | at $\mathrm{V}_{0}=3 \mathrm{~V}$ |
| Logic 0 sink current | 1.6 | - | - | mA | at $\mathrm{V}_{0}=0.4 \mathrm{~V}$ |
| Rise \& Fall times | - | - | 40 | ns | 0.4-3V transition (driving 15 pF ) |
| PCMO delay (from SCE edge) | 40 | 100 | 140 | ns | between 1.5 V levels |
| Power Consumption | - | - | 450 | mW | at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=9 \mathrm{~V}$ |

**Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.

| AY-3-9900 | INSTRUMERAL |
| :---: | :---: |


(b) DETAIL OF ETV TIMING AND INTERNAL CLOCK MODE INPUT/OUTPUT TIMING

(a) PCM OUTPUT DATA STREAM (INTERNAL CLOCKS)


INTERNAL DECODER

(b) PCM INPUT DATA STREAM (INTERNAL CLOCKS)

## General INSTRUMENT

## Programmable Dialers

| FUNCTION | $\cdots$ DESCRIPTION $\because, \because \cdots$ | PART NUMBER | PAGE NUMEER |
| :---: | :---: | :---: | :---: |
| PROOGRAMMABLE | $\therefore$ | TZ-2001 | 6-30 |
| MCRO-COMPUTER TELEPHONE | Single chip microcomputer pre-programmed tor in-telephone applications. | Tz-2002 | 6-30 |
| $\therefore$ DIAEERS | $\because 2$, | I | 6-30 |

## Programmable Microcomputer Telephone Dialers

## FEATURES

- Microcomputer based dialer
- On board keyboard debounce circuitry
- Single button redial of last number dialed
- Program can be customized by single mask change


## STANDARD PROGRAMMED DEVICE FEATURES

## TZ-2001 - Pulse Dialer

- Outputs for 12 digit time multiplexed display
- 16 numbers by 12 digit repertory storage via 1 button recall
- Real time clock (hrs., min., sec.)
- Elapsed time timer/stopwatch
- Optional calculator interface with C-59X series

TZ-2002 - Dual Tone Dialer

- Outputs for 12 digit time MUX display
- 16 numbers by 12 digit repertory storage via 1 button recall
- Real time clock (hrs., min., sec.)
- Prompting display for simple operation

TZ-2003 - Pulse or Dual Tone Dialer

- 32 numbers by 16 digit repertory storage
- Selectable pulse dialing rates
- Selectable tone duration lengths
- Indicators for auto redial, hold and store modes


## DESCRIPTION

The TZ-2000 series telephone dialers are from the General Instrument PIC series microcomputers. They are programmed to function as dialer circuits to produce either dual tone or pulse dialing functions. As with the PIC microcomputers, the TZ-2000 series are fabricated in N -channel Ion Implant technology and contain RAM, I/O parts, C.P.U. and pre-programmed ROM.
The TZ-2001 is a pulse dialer that simulates the outputs of a rotary telephone dial. It also displays and stores up to 16 12-digit telephone numbers, keeps real time displaying hours, minutes, and seconds, and can act as a stopwatch to enable the telephone user to time a call.
The TZ-2002 is a dual-tone dialer that produces the tone codes for the General Instrument AY-3-9400 Dual Tone Multifrequency Generator to generate the tonal outputs in a telephone set. It also displays and stores up to 1612 -digit telephone numbers and keeps rea! time displaying hours, minutes, and seconds.
The TZ-2003 is a pulse or dual tone dialer with the ability to store 32 16-digit telephone numbers. It also has selectable pulse duration rates and selectable tone duration rates plus LED function indicator drivers.
The logic timing is provided by an on-chip oscillator using an external R-C network. The use of an external 32.768 kHz crystal is implemented for real time events.
The repertory storage is achieved through the use of external RAM devices. The TZ-2001 and TZ-2002 use a $256 \times 4$ bit RAM device.
The Keyboards required for these devices consist of single key depression switches arranged in matrixes. The TZ-2001 and TZ2002 devices require an $8 \times 4$ matrix and the TZ-2003 requires a $4 \times$ 4 matrix.


## TZ-2000 SERIES OPERATION

## Dial Mode

The TZ-2001 simulates a rotary dial telephone in that the output produces a series of pulses. The TZ-2001 may be dialed by consecutive numerical entries from the keyboard after depressing the Dial Key.
The number depressed will appear in the right hand side of the display. As consecutive numbers are entered the numbers will shift left on the display. The minimum time interval between number entries is 80 msec .
The "PA" key allows a pause in access or break within the dialed sequence. The "RE" key allows a redial of the number entered. A double depression of the "DIAL" key erases the number displayed.
The TZ-2002 drives the AY-3-9400 to generate a dual tone frequency. Depression of the "DIAL" key prompts the user with the words "DIAL PLEASE" on the display.
Consecutive digit entries with a minimum of 80 nsec between entries will be displayed and dialed.
A double depression of the "DIAL" Key enables the complete number to be redialed. A display of "NONE" indicates no number in storage or an erasure of a number. The " P " Key enables the user to pause or break the dial out sequence for 2 seconds. To dial from the repertory storage, depress one of the 16 storage keys L1 to L16 after a "DIAL PLEASE" prompt display.

## Store Mode

Depression of the "Store" key enables numbers to be entered into the storage memory. Both the TZ-2001 and TZ-2002 have prompting messages displayed after the store mode is entered.
The TZ-2001 prompts with a "ST" displayed and the TZ-2002 prompts with "STORE INTO" displayed after entering the "STORE" mode with the given prompting, the location must be selected by depressing one of the L1 to L16 keys. After the location is determined the TZ-2001 prompts with "STORE PLEASE" displayed. Then the telephone number can be entered as in the dial mode.

## Time Mode

Depression of the "TIME" key puts the TZ-2001 and TZ-2002 circuits into the time display mode. They both indicate real time in a hours, minutes and seconds format. To set the time of day on the TZ-2001 depress the "TIME SET" key on the TZ-2002 depress the " $P$ " key. Then enter the correct time starting with tens of hours, hours, tens of minutes then minutes. The real time starts with the fourth digit entry of the time.
The stop watch on the TZ-2001 starts with a double depression of the "TIME" key and can count up to 12 hours of elapsed time. Another depression of the "TIME" key stops the elapsed time and a final depression of the "TIME" reverts back to real time.

## TZ-2003 OPERATION

The TZ-2003 has four modes of operation:

1. Dial
2. Automatic redial
3. Store
4. Hold mode

## Dialing

Dialing can be operated in either the pulse or tone functions. Consecutive digit and pause entries cause the dialing to occur. Dialing may be made with either the hardset on hook or off hook. A redial of the same number can be made by depressing the redial key.

## Automatic Redial

Automatic redialing of the same number consecutively at 40 sec intervals can be augmented by depressing the redial key twice.

## Store

Depression of store key enters circuit into the store mode indicated by LED store indicator. Next two digits enters the storage location number from 01 to 32 .

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
$\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{xx}}$, all other I/O Voltages .... -0.3 V to 12.0 V (with Respect to $\mathrm{V}_{\mathrm{SS}}$ )
Standard Conditions (unless otherwise noted):
$V_{\mathrm{CC}}=+5.0 \mathrm{~V} \pm 5 \%$
$v_{\mathrm{xx}}=4.75 \mathrm{~V}$ to 10.0 V

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device rellability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Currents | $\begin{aligned} & \mathrm{I}_{\mathrm{CC}} \\ & \mathrm{I}_{\mathrm{Xx}} \end{aligned}$ | - | $\begin{gathered} 35 \\ 1 \end{gathered}$ | $\begin{gathered} 50 \\ 5 \end{gathered}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |  |
| Logic Inputs |  |  |  |  |  |  |
| Low | $\mathrm{V}_{\text {IL }}$ | 0 | - | 0.65 | V |  |
|  | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | Vcc | V |  |
| Logic Outputs |  |  |  |  |  |  |
| Low | Vol | - | - | 0.45 | V | $\mathrm{V}_{\mathrm{xx}}=5 \mathrm{~V} @ \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| High | V OH | 24 | - | V ${ }_{\text {cc }}$ | V | $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Osc Frequency | $f i n$ | 0.8 | - | 1.0 | MHz |  |
| Rt Clk Frequency | frt | - | 32.768 | - | kHz | Crystal Generated |
| CLK OUT Frequency | - | 0.25 fin | - | - | - |  |
| Key Debounce Time | tdb | 15.6 | - | 23.4 | ms |  |
| Interdigit Pause | IDP | - | 125 | - | ms |  |
| Tone Duration | - | - | 125 | - | ms |  |

TABLE 3: DUAL TONE FREQUENCY OUTPUTS

| DIGIT | LOW FREQUENCY (Hz) | HIGH FREQUENCY |
| :---: | :---: | :---: |
| 1 | 697 | 1209 |
| 2 | 697 | 1336 |
| 3 | 697 | 1477 |
| 4 | 770 | 1209 |
| 5 | 770 | 1336 |
| 6 | 770 | 1477 |
| 7 | 852 | 1209 |
| 8 | 852 | 1336 |
| 9 | 852 | 1477 |
| 0 | 941 | 1336 |
| A (*) | 941 | 1209 |
| $n(\#)$ | 941 | 1477 |

## KEYBOARD LAYOUT

TZ-2001


TZ-2002


TZ-2003





## Data Communications

| CUMCTION | 为 DESCRIPTION | PART NUMBER | PACE NUMBER |
| :---: | :---: | :---: | :---: |
| UAR/T Devices |  |  |  |
| $\therefore$ LAR/T | Complete 5 -8 bit receiver/transmitter interface, | AY-3-1015D | 7-4 |
| $\because \quad \therefore$ | $\because$ 吹 | AY-5-8116 | 7-13 |
| DUAL BAUD | 16 Feguency UART/USR ${ }^{\text {compatible }} \therefore$ | AY-5-8116T | 7-13 |
| RATE GENEFATORS |  | AY-5-8136 | 7-13 |
|  |  | AY-5-8136T | 7-13 |
| Clocks |  |  |  |
| 4 DIGIT CLOCK RADIO | 12/24 Hoúr clock 24 hour alarm, sleep timer, battery standby. | CK3300 | 7-18 |
| Appliances |  |  |  |
| DIGITAL THERMOMETER | Digital thermometer and temperature controller, | AY-3-1270: | , 7-32 |
| Remote Control |  |  |  |
| REMOTE CONTROL <br> TRANSMITTER | 256 Command PCM intrared transmiter | AY-3-8470 | 7-42 |
| REMOTE CONTROK $\because$ RECEVER | 256 command PcM intrared recelver | AY-3-8475 | 7 48 |

## GENERAL INSTRUMENT

## UAR/T Devices

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| UAR/T | Complete 5-8 bit receiver/transmitter interface. | AY'3-1015D | 7.4 |
| DUAL BAUD RATE GENERATORS | 16 Frequency, UART/USRT compatiblée. | AY-5-8116 | 7-13 |
|  |  | AY-5-8116T | $7 \times 13$ |
|  |  | AY-5-8136 | 7-13 |
|  |  | AY-5-8136T | $7 \times 13$ |

## UAR/T: Universal Asynchronous Receiver/Transmitter

## FEATURES

- DTL and TTL compatible-no interfacing circuits requireddrives one TTL load
- Fully Double Buffered-eliminates need for system synchronization, facilitates high-speed operation
- Full Duplex Operation-can handle multiple bauds (receiving-transmitting) simultaneously
- Start Bit Verification-decreases error rate with center sampling
- Receiver center sampling of serial input; $\mathbf{4 6 \%}$ distortion immunity
- High Speed Operation
- Three-State Outputs-bus structure capability
- Low Power - minimum power requirements
- Input Protected-eliminates handling problems


## AY-3-1015D

- Single Supply Operation: +4.75 V to +5.25 V
- $11 / 2$ stop bit mode
- External reset of all registers except control bits register
- N-channel Ion Implant Process
- 0 to 25 K baud
- Pull-up resistors to $\mathrm{V}_{\mathrm{CC}}$ on all inputs


## DESCRIPTION

The Universal Asynchronous Receiver/Transmitter (UAR/T) is an LSI subsystem which accepts binary characters from either a terminal device or a computer and receives/transmits this character with appended control and error detecting bits. All characters contain a start bit, 5 to 8 data bits, $1,1 \frac{1}{2}$, or 2 stop bit capability, and either odd/even parity or no parity. In order to make the UAR/T universal, the baud, bits per word, parity mode, and the number of stop bits are externally selectable. The device is constructed on a single monolithic chip. All inputs and outputs are directly compatible with MTOS/MTNS logic, and also with TTL/DTL/CMOS logic without the need for interfacing components. All strobed outputs are three-state logic.

PIN CONFIGURATION
40 LEAD DUAL IN LINE

|  | Top View |  |
| :---: | :---: | :---: |
| $v_{\text {cc }}(+5 \mathrm{~V})=1$ | 40 | T TCP |
| NC- 2 | 39 | $\square \mathrm{EPS}$ |
| GND 3 | 38 | $\square \mathrm{NB} 1$ |
| RDE 4 | 37 | NB2 |
| RD8 5 | 36 | ] TSB |
| RD7 -6 | 35 | $\square \mathrm{NP}$ |
| RD6 7 | 34 | Cs |
| RD5 8 | 33 | DB8 |
| RD4 9 | 32 | DB7 |
| RD3 10 | 31 | DB6 |
| RD2 11 | 30 | DB5 |
| RD1 12 | 29 | DB4 |
| PE 13 | 28 | DB3 |
| FE 14 | 27 | DB2 |
| OR 15 | 26 | DB1 |
| SWE 16 | 25 | so |
| RCP 17 | 24 | E EOC |
| RDAV 18 | 23 | $\square$ ठS |
| DAV 19 | 22 | TBMT |
| SI 20 | 21 | XR |

## BLOCK DIAGRAM



| Pin No. | Name (Symbol) | Function |
| :---: | :---: | :---: |
| 1 | $V_{c c}$ Power Supply ( $\mathrm{V}_{\mathrm{cc}}$ ) | +5V Supply |
| $\begin{aligned} & 2 \\ & 3 \end{aligned}$ | N.C. Ground | (Not connected) Ground |
| 4 | Received Data Enable (RDE) | A logic " 0 " on the receiver enable line places the received data onto the output lines. |
| 5-12 | Received Data Bits (RD8-RD1) | These are the 8 data output lines. Received characters are right justified. the LSB always appears on RD1 These lines have tristate outputs; i.e., they have the normal TTL ouput characteristics when $\overline{R D E}$ is " 0 " and a high impedance state when $\overline{R D E}$ is " 1 ". Thus, the data output lines can be bus structure oriented. |
| 13 | Parity Error (PE) | This line goes to a logic " 1 " if the received character parity does not agree with the selected parity. Tri-state. |
| 14 | Framing Error (FE) | This line goes to a logic " 1 " if the received character has no valid stop bit. Tri-state. |
| 15 | Over-Run (OR) | This line goes to a logic " 1 " if the previously received character is not read (DAV line not reset) before the present character is transferred to the receiver holding register Tri-state |
| 16 | $\overline{\text { Status Word Enable (SWE) }}$ | A logic " 0 " on this line places the status word bits (PE, FE, OR, DAV, TBMT) onto the output lines. Tri-state. |
| 17 | Receiver Clock (RCP) | This line will contain a clock whose frequency is 16 times (16X) the desired receiver baud. |
| 18 | $\overline{\text { Reset Data Available (RDAV) }}$ | A logic " 0 " will reset the DAV line. The DAV F/F is only thing that is reset. |
| 19 | Data Available (DAV) | This line goes to a logic " 1 " when an entire character has been received and transferred to the receiver holding register. Tri-state. Fig. 8. |
| 20 | Serial Input (SI) | This line accepts the serial bit input stream. A Marking (logic " 1 ") to spacing (logic " 0 ") transition is required for initiation of data reception. Fig. 7, 8. |
| 21 | External Reset (XR) | Resets all registers. Sets SO, EOC, and TBMT to a logic " 1 " Resets DAV, and error flags to " 0 ". Clears input data buffer. Must be tied to logic " 0 " when not in use. |
| 22 | Transmitter Buffer Empty (TBMT) | The transmitter buffer empty flag goes to a logic " 1 " when the data bits holding register may be loaded with another character. Tri-state. See Fig. 14, 16. |
| 23 | $\overline{\text { Data Strobe }}$ ( $\overline{\mathrm{DS}}$ ) | A strobe on this line will enter the data bits into the data bits holding register Initıal data transmission is initıated by the rising edge of $\overline{\mathrm{DS}}$ Data must be stable during entire strobe. |
| 24 | End of Character (EOC) | This line goes to a logic " 1 " each time a full character is transmitted. It remains at this level until the start of transmission of the next character. See Fig. 13, 15. |
| 25 | Serial Output (SO) | This line will serially, by bit, provide the entire transmitted character It will remain at a logic " 1 " when no data is berng transmitted. |
| 26-33 | Data Bit Inputs (DB1-DB8) | There are up to 8 data bit input lınes avaılable |
| 34 | Control Strobe (CS) | A logic " 1 " on this lead will enter the control bits (EPS, NB1, NB2, TSB, NP) into the control bits holdıng register This line can be strobed or hard wired to a logic " 1 " level |
| 35 | No Parity (NP) | A logic " 1 " on this lead will elimınate the parity bit from the transmitted and received character (no PE indication) The stop bit(s) will immediately follow the last data bit. If not used, this lead must be tıed to a logic " 0 " |
| 36 | Number of Stop Bits (TSB) | This lead will select the number of stop bits, 1 or 2 , to be appended immediately after the parity bit. A logic " 0 " will insert 1 stop bit and a logic "1" will insert 2 stop bits. The combined selection of 2 stop bits and 5 bits/character will produce $11 / 2$ stop bits. |
| 37-38 | Number of Bits/Character (NB2, NB1) | These two leads will be internally decoded to select either 5, 6, 7 or 8 data bits/character |
| 39 | Odd/Even Parity Select (EPS) | The logic level on this pin selects the type of parity which will be appended immediately after the data bits It also determines the parity that will be checked by the receiver A logic " 0 " will insert odd parity and a logic "1" will insert even parity. |
| 40 | Transmitter Clock (TCP) | This line will contain a clock whose frequency is 16 times (16X) the desired transmitter baud |


| INSTRUNERAK | AY-3-1015D |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
Vcc (with Respect to GND) . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to +16 V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Lead Temperature (Soldering, 10 sec ) . . . . . . . . . . . . . . . . . . . . $+330^{\circ} \mathrm{C}$
Standard Condition (unless otherwise noted):
$\mathrm{V}_{\mathrm{CC}}=+4.75 \mathrm{~V}$ to +5.25 V
Operating Temperature $\left(T_{A}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


## DC CHARACTERISTICS

| Characteristic | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Input Logic Levels (AY-3-1015) <br> Logic 0 <br> Logic 1 | 0 2.0 | - | ( 0.8 | Volts Volts | Has internal pull-up resistors to $\mathrm{V}_{\mathrm{cc}}$. |
| Input Capacitance All inputs | - | - | 20 | pF | 0 volts bias, $\mathrm{f}=1 \mathrm{MHz}$ |
| Output Impedance Tri-State Outputs | 1.0 | - | - | $\mathrm{M} \Omega$ |  |
| Data Output Levels <br> Logic 0 <br> Logic 1 | 2.4 | - | +0.4 | Volts Volts | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA} \text { (sink) } \\ & \mathrm{I}_{\mathrm{OH}}=-40 \mu \mathrm{~A} \text { (source)-at } \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \end{aligned}$ |
| Output Capacitance | - | 10 | 15 | pF |  |
| Short Ckt. Current | - | - | - | - | See Fig. 19 |
| Power Supply Current $I_{C C}$ at $V_{C C}=+5 \mathrm{~V}$ | - | 10 | 15 | mA | See Fig. 21 |

## Standard Conditions (unless otherwise noted)

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Output load capacitance 50pF max.

## AC CHARACTERISTICS

| Characteristic | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Frequency | DC | - | 400 | kHz | at $\mathrm{V}_{\mathrm{CC}}=+4.75 \mathrm{~V}$ |
| Baud | 0 | - | 25 | kbaud | at $\mathrm{V}_{\mathrm{CC}}=+4.75 \mathrm{~V}$ |
| Pulse Width |  |  |  |  |  |
| Clock Pulse | 1.0 | - | - | $\mu \mathrm{s}$ | See Fig. 5 |
| Control Strobe | 200 | - | - | ns | See Fig. 11 |
| Data Strobe | 200 | - | - | ns | See Fig. 10 |
| External Reset | 500 | - | - | ns | See Fig. 9 |
| Status Word Enable | 500 | - | - | ns | See Fig. 17 |
| Reset Data Available | 200 | - | - | ns | See Fig. 18 |
| Received Data Enable | 500 | - | - | ns | See Fig. 17 |
| Set Up \& Hold Time Input Data Bits Input Control Bits | 20 20 | - | - | ns | See Fig. 10 See Fig. 11 |
| Output Propagation Delay TPDO <br> TPD1 | - | - | 500 | ns | See Fig. 17 \& 20 |
| TPD1 | - | - | 500 | ns | See Fig. 17 \& 20 |

[^15]
## TIMING DIAGRAMS



Fig. 1 UAR/T - TRANSMITTER TIMING


Fig. 2 TRANSMITTER AT START BIT NOT A TEST POINT


Fig. 4. ALLOWABLE POINTS TO USE CONTROL STROBE

Fig. 3 TRANSMITTER AT START BIT


Fig. 5 ALLOWABLE TCP, RCP

## TIMING DIAGRAMS



Fig. 6 UAR/T - RECEIVER TIMING


Fig. 7


Fig. 8 RECEIVER DURING 1ST STOP BIT


WHEN NOT IN USE, XR WHEN NOT IN USE, XR
MUST BE HELD AT GND XR RESETS EVERY REGISTER EXCEPT THE CONTROL REGISTER. SO, TBMT, EOC ARE RESET TO 5 V ALL OTHER OUTPUTS RESET TO OV


Fig. $10 \overline{\mathrm{DS}}$

Fig. 9 XR PULSE


CONTROL BITS MUST BE STABLE FOR LAST 2OONS OF CS.

Fig. 11a CS


CONTROL STROBE AND CONTROL BITS MUST BE 500 ns MINIMUM


LEADING EDGE OF CONTROL DATA IS NOT CRITICAL AS LONG AS TRAILING EDGE AND PULSE WIDTH SPECS ARE OBSERVED.

Fig. 11b

* $20 n$ S MIN.

Fig. 12


Fig. 16 TBMT TURN-ON


Fig. 14 TBMT TURN-OFF


Fig. 17 RDE, SWE


Fig. 15 EOC TURN-OFF


Fig. 18 RDAV

## TYPICAL CHARACTERISTIC CURVES



Fig. 19 SHORT CIRCUIT OUTPUT CURRENT (only 1 output may be shorted at a time)

Fig. 21 +5 VOLT SUPPLY CURRENT

## UAR/T: Universal Asynchronous Receiver/Transmitter

## TRANSMITTER OPERATION



Fig. 23

## Initializing

Power is applied, external reset is enabled, and clock pulse is applied having a frequency of 16 times the desired baud. The previous conditions will set data available (DAV) to a logic " 1 ".
After initializing is completed, user should note that one set of control bits will be used for both receiver and transmitter making individual control bit setting unnecessary. Data reception starts when serial input signal changes from Marking (logic "1") to spacing (logic " 0 ") which initiates start bit. The start bit is valid if, after transition from logic " 1 " to logic " 0 ", the SI line continues to be at logic " 0 ", when center sampled, 8 clock pulses later. If, however, line is at a logic " 1 " when center sampling occurs, the start bit verification process will be reset. If the Serial Input line transitions from a logic " 1 " to a logic " 0 " (marking to spacing) when the $16 x$ clock is in a logic " 1 " state, the bit time, for center sampling will begin when the clock line transitions from a logic "1" to a logic " 0 " state. After verification of a genuine start bit, data bit reception, parity bit reception and stop bit(s), reception proceeds in an orderly manner.
While receiving parity and stop bit(s) the receiver will compare transmitted parity and stop bit(s) with control data bits (parity and number of stop bits) previously set and indicate an error by changing the parity error flip flop and/or the framing error flip flop to a logic " 1 ". It should be noted that if the No Parity Mode is selected the PE (parity error) will be unconditionally set to a logic " 0 ".
Once a full character is received, internal logic looks at the data available (DAV) signal to determine if data has been the read out. If the DAV signal is at a logic " 1 " the receiver will assume data has not been read out and the over run flip flop of the status word hoiding register will be set to a logic " 1 ". If the DAV signal is at a logic " 0 " the receiver will assume that data has been read out. After DAV goes to a logic " 1 ", the receiver shift register is now ready to accept the next character and has one full character time to remove the received character.


Fig. 25 TRANSMITTER BLOCK DIAGRAM


Fig. 26 RECEIVER BLOCK DIAGRAM

AY-5-8116/8116T AY-5-8136/8136T

## Dual Baud Rate Generator

## FEATURES

- Single +5 V power supply
- On-chip crystal oscillator 8116/8136 or external freq input 8116/8116T/8136/8136T
- Direct compatibility with UART/USRT
- Dual selectable 16x clock outputs
- High freq. reference output (Available only on $8136 / 8136 T$ )
- Reprogrammable ROM allowing generation of non-standard frequencies
- TTL, MOS compatibility
- Pin for pin and functionally compatible with SMC's COM8116/8116T/8136/8136T
- General Instrument Advanced N-Channel Silicon Gate Process


## DESCRIPTION

The General Instrument AY-5-8116/8136 Series is a very versatile family of Dual Buad Rate Generators. The AY-5-8116/8116T and AY-5-8136/8136T are pin for pin and functionally equivalent to SMC's COM8116/8116T/8136/8136T, respectively.
The AY-5-8116/8136 is designed to generate the full spectrum of 16 asynchronous/synchronous data communication frequencies for use with 16X UART/USRT devices.
An on-chip crystal oscillator available on the 8116 and 8136 is capable of providing a master reference frequency. Alternatively, complimentary TTL level clock signals can be input to pins 1 and 18. The 8116T and 8136T are only suitable for this external TTL reference. When using TTL outputs to drive the XTAL/EXT inputs, they should not be used to drive other TTL inputs due to excessive loading which may result in a reduction of noise immunity
Dividers are used on the output of the oscillator/buffer which generate the output frequencies $f_{T}$ and $f_{R}$. These dividers can divide any integer from 6 to $2^{19}+1$, inclusive When using an even divisor, the output will be square; an odd divisor will cause the output to be high longer than it is low by one clock period ( $\mathrm{f}_{\mathrm{x}}$ ). The clock frequency ( $f_{x}$ ) is used by the $8136 / 8136 \mathrm{~T}$ to provide a high frequency output ( $f_{x} / 4$ )
The 8116/8136 family allows generation of other frequencies with the use of its two divisor ROMs which contain 16 divisors, each 19 bits wide, allowing for up to 32 different divisors on custom parts

## PIN CONFIGURATIONS

AY-5-8116/8116T


AY-5-8136/8136T


Externally strobed data latches are used to hold the divisor select bits, $R_{A}-R_{D}$ and $T_{A}-T_{D}$. The strobe inputs, STR or STT, allow data to pass directly through the data latch when in the high state $A$ new frequency is initiated within 35 usec of a change in any of the four divisor select bits read by the device Pull-up resistors are provided on the divisor select inputs while are not present on the strobe inputs

## PIN FUNCTIONS

| Pin No. | Signal | Function |
| :---: | :---: | :---: |
| 1 | XTAL/EXT1 | Input is either one pin of the crystal package or one polarity of the external input |
| 2 | $\mathrm{V}_{\mathrm{cc}}$ | Positive power supply - normally +5 V . |
| 3 | $\mathrm{f}_{\mathrm{R}}$ | This output runs at a frequency selected by the Receiver divisor select data bits. |
| 4-7 | $\mathrm{R}_{\mathrm{A},}, \mathrm{R}_{\mathrm{B}}, \mathrm{R}_{\mathrm{C}}, \mathrm{R}_{\mathrm{D}}$ | These inputs, as shown in Table 1, select the receiver output frequency, $f_{R}$ |
| 8 | STR | A high level input strobe loads the receiver data ( $R_{A}, R_{B}, R_{C}, R_{D}$ ) into the receiver divisor select register This input may be strobed or hard-wired to a high level. |
| 9 | NC |  |
| 10 | NC or $\mathrm{f}_{\mathrm{X}} / 4$ | NC (8116/8116T), $\mathrm{f}_{\mathrm{x}} / 4$ (8136/8136T) |
| 11 | GND | Ground |
| 12 | STT | A high level input strobe loads the transmitter data $\left(T_{A}, T_{B}, T_{C}, T_{D}\right)$ into the transmitter divisor select register This input may be strobed or hard-wired to a high level |
| 13-16 | $\mathrm{T}_{\mathrm{D},} \mathrm{T}_{\mathrm{c}}, \mathrm{T}_{\mathrm{B},} \mathrm{T}_{\mathrm{A}}$ | These inputs, as shown in Table 1, select the transmitter output frequency, $\mathrm{f}_{\mathrm{T}}$. |
| 17 | $\mathrm{f}_{\mathrm{T}}$ | This output runs at a frequency selected by the Transmitter divisor select data bits |
| 18 | XTAL/EXT2 | This input is either the other pin of the crystal package or the other polarity of the external input. |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*


Storage Temperature Range $\ldots \ldots \ldots \ldots \ldots \ldots \ldots . . .55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Positive Voltage on any Pin, with respect to ground ................. 80 OV
Negative Voltage on any Pin, with respect to ground
-0.3V

Standard Conditions (unless otherwise noted):
$\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied. Operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typıcal" is presented for design guidance only and is not guaranteed

## DC CHARACTERISTICS

| Characteristic | Sym | Min | Typ | Max | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT VOLTAGE LEVELS |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\text {IL }}$ | - | - | 08 | V |  |
| High Level | $\mathrm{V}_{\mathrm{IH}}$ | 2.0 | - | - | V | excluding XTAL inputs |
| OUTPUT VOLTAGE LEVELS |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=16 \mathrm{~mA}$, for $\mathrm{f}_{\mathrm{x}} / 4$, |
|  |  | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$, for $\mathrm{f}_{\mathrm{R},} \mathrm{f}_{T}$ |
| High Level | $\mathrm{V}_{\mathrm{OH}}$ | 35 | - | - | V | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ |
| INPUT CURRENT |  |  |  |  |  |  |
| Low-level | $I_{\text {IL }}$ | - | - | -01 | mA | $V_{\text {IN }}=G N D, R_{A}-R_{D} \& T_{A}-T_{D}$ only |
| Input Capacitance All inputs |  | - | 5 | 10 | pF | $V_{\text {IN }}=$ GND, excludıng XTAL inputs |
| Power Supply Current | $I_{\text {cc }}$ | - | - | 50 | mA |  |

## AC CHARACTERISTICS

| Characteristic | Sym | Min | Typ | Max | Unit | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Frequency | $\mathrm{f}_{\mathrm{x}}$ | 001 | - | 51 | MHz | XTAL/EXT, $50 \%$ Duty Cycle $\pm 5 \%$ |
| Strobe Pulse Width | $\mathrm{t}_{\mathrm{PW}}$ | 150 | - | DC | ns |  |
| Input Set-up Tıme | $\mathrm{t}_{\mathrm{DS}}$ | 200 | - | - | ns |  |
| Input Hold Tıme | $\mathrm{t}_{\mathrm{DH}}$ | 50 | - | - | ns |  |
| Strobe to new Frequency Delay |  | - | - | 3.5 | $\mu \mathrm{~s}$ | $@ \mathrm{f}_{\mathrm{x}}=5.0 \mathrm{MHz}$ |

## TIMING DIAGRAM





BLOCK DIAGRAM: AY-5-8116/8116T/8136/8136T


Output Freq. AY-5-8116/8116T/8136/8136T
REFERENCE FREQUENCY $=5.068800 \mathrm{MHz}$

| Divisor <br> Select <br> DCBA | Desired <br> Baud <br> Rate | Clock <br> Factor | Desired <br> Frequency <br> (KHz) | Divisor | Actual <br> Baud <br> Rate | Actual <br> Frequency <br> (KHz) | Deviation |
| :---: | ---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0000 | 50.00 | $16 X$ | 0.80000 | 6336 | 50.00 | 0.800000 | $0.0000 \%$ |
| 0001 | 75.00 | $16 X$ | 1.20000 | 4224 | 75.00 | 1.200000 | $0.0000 \%$ |
| 0010 | 110.00 | $16 X$ | 1.76000 | 2880 | 110.00 | 1.760000 | $0.0000 \%$ |
| 0011 | 134.50 | $16 X$ | 2.15200 | 2355 | 134.52 | 2.152357 | $0.0166 \%$ |
| 0100 | 150.00 | $16 X$ | 2.40000 | 2112 | 150.00 | 2.400000 | $0.0000 \%$ |
| 0101 | 300.00 | $16 X$ | 4.80000 | 1056 | 300.00 | 4.800000 | $0.0000 \%$ |
| 0110 | 600.00 | $16 X$ | 9.60000 | 528 | 600.00 | 9.600000 | $0.0000 \%$ |
| 0111 | 1200.00 | $16 X$ | 19.20000 | 264 | 1200.00 | 19.200000 | $0.0000 \%$ |
| 1000 | 1800.00 | $16 X$ | 28.80000 | 176 | 1800.00 | 28.800000 | $0.0000 \%$ |
| 1001 | 2000.00 | $16 X$ | 32.00000 | 158 | 2005.06 | 32.081013 | $0.2532 \%$ |
| 1010 | 2400.00 | $16 X$ | 38.40000 | 132 | 2400.00 | 38.400000 | $0.0000 \%$ |
| 1011 | 3600.00 | $16 X$ | 57.60000 | 88 | 3600.00 | 57.600000 | $0.0000 \%$ |
| 1100 | 4800.00 | $16 X$ | 76.80000 | 66 | 4800.00 | 76.800000 | $0.0000 \%$ |
| 1101 | 7200.00 | $16 X$ | 115.20000 | 44 | 7200.00 | 115.200000 | $0.0000 \%$ |
| 1110 | 9600.00 | $16 X$ | 153.60000 | 33 | 9600.00 | 153.600000 | $0.0000 \%$ |
| 1111 | 19200.00 | $16 X$ | 307.20000 | 16 | 19800.00 | 316.800000 | $3.1250 \%$ |

## Output Freq. AY-5-8116/8116T/8136/8136T-005

REFERENCE FREQUENCY $=4.915200 \mathrm{MHz}$

| Divisor <br> Select <br> DCBA | Desired <br> Baud <br> Rate | Clock <br> Facior | Desired <br> Frequency <br> (KHz) | Divisor | Actual <br> Baud <br> Rate | Actual <br> Frequency <br> (KHz) | Deviation |
| :---: | ---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0000 | 50.00 | $16 X$ | 0.80000 | 6144 | 50.00 | 0.800000 | $0.0000 \%$ |
| 0001 | 75.00 | $16 X$ | 1.20000 | 4096 | 75.00 | 1.200000 | $0.0000 \%$ |
| 0010 | 110.00 | $16 X$ | 1.76000 | 2793 | 109.93 | 1.758983 | $0.0100 \%$ |
| 0011 | 134.50 | $16 X$ | 2.15200 | 2284 | 134.50 | 2.752000 | $0.0000 \%$ |
| 0100 | 150.00 | $16 X$ | 2.40000 | 2048 | 150.00 | 2.400000 | $0.0000 \%$ |
| 0101 | 300.00 | $16 X$ | 4.80000 | 1024 | 300.00 | 4.800000 | $0.0000 \%$ |
| 0110 | 600.00 | $16 X$ | 9.60000 | 512 | 600.00 | 9600000 | $0.0000 \%$ |
| 0111 | 1200.00 | $16 X$ | 19.20000 | 256 | 1200.00 | 19.200000 | $0.0000 \%$ |
| 1000 | 1800.00 | $16 X$ | 28.80000 | 171 | 1796.49 | 28.743859 | $0.1949 \%$ |
| 1001 | 2000.00 | $16 X$ | 32.00000 | 154 | 1994.81 | 31.916883 | $0.2597 \%$ |
| 1010 | 2400.00 | $16 X$ | 38.40000 | 128 | 2400.00 | 32.000000 | $0.0000 \%$ |
| 1011 | 3600.00 | $16 X$ | 57.60000 | 85 | 3614.11 | 57.825882 | $0.3921 \%$ |
| 1100 | 4800.00 | $16 X$ | 76.80000 | 64 | 4800.00 | 76.80000 | $0.0000 \%$ |
| 1101 | 7200.00 | $16 X$ | 115.20000 | 43 | 7144.19 | 114.306976 | $07751 \%$ |
| 1110 | 9600.00 | $16 X$ | 153.60000 | 32 | 9600.00 | 153.600000 | $0.0000 \%$ |
| 1111 | 19200.00 | $16 X$ | 307.20000 | 16 | 19200.00 | 307.200000 | $0.0000 \%$ |


| - EUNCTION: | DESCRIPTION | PART NUMEER | PACE NUMBER |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { 4DIGIT } \\ & \text { CLOCK RADIO } \end{aligned}$ | 12/24 Hour clock, 24 hour alarm, sleen timer, hatery standby | CK3300, | 7-粆 |

## 4 Digit Clock Radio Circuit

## FEATURES

- 4 Digits plus colons
- LED direct duplex drive
- No display-IC interface components
- No radio frequency interference problems
- No external contact noise elimination circuits required
- No external line frequency noise rejection circuits required
- 12 or 24 hour display
- Leading zero suppression in 24 hour mode
- PM indication in 12 hour mode
- Alarm-snooze indicator
- 50 Hz or 60 Hz operation
- On-chip oscillator for standby operation with battery during line Failure
- Line power interrupt indication
- Sleep operation indicator
- Low power dissipation (under 30 mW )


## CLOCK RADIO FEATURES

- Simple support electronics
- Analog sleep setting (user controlled 5 to 120 mins with 1 minute resolution). No necessity for daily adjustment
- Totally independent sleep and wake timing
- Independent volume of music during sleep and wake
- Radio sound muting during normal radio listening
- Wake to music or alarm tone
- Self-cancelling alarm after 80 minutes of wake
- 5 minute repeating snooze with radio and/or alarm
- Sleep override or sleep repeat
- Wake to alarm tone with quiet radio override (every 5 minutes) during snooze time (repeatable)
- Simple setting of time, alarm, and sleep
- Hold and synchronize capability for time setting
- Independent hours, minutes setting (carry propagation suppressed)
- 5 minute pre-alarm appliance switching
- Automatic tape recorder control (record your favorite program automatically 0-120 minutes-starting from the exact second)


## PIN CONFIGURATION <br> 28 LEAD DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{N}}$ | 01 V 28 | Vp |
| Colons | 227 | 50/60 Count Input |
| PM/Indicator/Sleep Indicator | $3 \quad 26$ | O OSC 1 (Standby Timing) |
| $\dagger^{\text {Digits } 3 \& 45}$ | 425 | O OSC 2 (Sleep Timing) |
| $g$ Digits $3 \& 45$ | $5 \quad 24$ | P Inc Hours (SIN) |
| e Digits 3 \& 4 - | 6 23 | Inc Mins (S C/S R ) |
| $d$ Digits $3 \& 45$ | 722 | Vst Set Time |
| c Digits 3 \& 4 - | $8 \quad 21$ | Q SA Set Alarm |
| $b$ Digits 3 \& 4 - | 920 | $\square$ Wake 1 Out ( $12 / 24 \mathrm{Hr}$ Sel) |
| a Digits 3 \& 4 - | $10 \quad 19$ | $\square$ Wake 2 Out ( $50 / 60 \mathrm{Sel}$ ) |
| a Digits 1 \& 2 C | $11 \quad 18$ | $\square$ Sleep Out |
| $f$ Digits 1 \& $2-$ | $12 \quad 17$ | $\square \mathrm{b}$ Digits 1 \& 2 |
| e Digits 1 \& 2 - | $13 \quad 16$ | g Digits 1 \& 2 |
| d Digits 1 \& 2 - | $14 \quad 15$ | c Digits 1 \& 2 |

## DESCRIPTION

The CK3300 N-Channel MOS I.C. contains all the necessary logic, contact noise elimination circuits, control switching, segment drivers and timing circuits to implement simple-to-use, low cost, multi-featured clock radios.
Due to the extreme difficulties in eliminating R.F.I. in radios when used in conjunction with digital electronics a great deal of care has gone into the design of the L.S.I. to ensure that little or no R.F.I. problems are met by the clock radio designer. The largest R.F.I. problem in Display Driving has been solved using a novel technique-that of half-line cycle anode duplexing using the half-sine waves produced by two diodes, and ensuring that all segment data changes occur at the zero crossings of the line cycle. This technique allows brightness control to be achieved simply by resistively dividing down the line voltage with a potentiometer, or a simple two level scheme using a transformer tap.
Segment driving of the two groups is directly from the I.C. through 50 ohm switches which allow the high current peaks required of LEDs, up to one inch in size, while keeping the I.C. Power dissipation, for reliability, down to the 200 to 250 mW level.
The I.C. also contains many unique features which enable the equipment designer to put into the clock radio his company's own product image.

## BLOCK DIAGRAM



## PIN FUNCTIONS

$\mathbf{V}_{\mathrm{N}}$ - (Pin 1)
Is the most negative power supply to the chip ( 0 volts).

## Segment Drivers (Pins 2-17)

These outputs are $50 \Omega$ switches which drive the segments of common anode LED's directly. Their use and operation is as follows:

To use the CK3300 with LEDs, the LEDs must be of the COMMON ANODE TYPE, and connected in the following manner.
segment a digit 1 connected to segment a digit 2 segment $b$ digit 1 connected to segment $b$ digit 2 segment c digit 1 connected to segment c digit 2 segment d digit 1 connected to segment d digit 2 segment e digit 1 connected to segment e digit 2 segment f digit 1 connected to segment f digit 2 segment $g$ digit 1 connected to segment $g$ digit 2 segment a digit 3 connected to segment a digit 4 segment $b$ digit 3 connected to segment $b$ digit 4 segment c digit 3 connected to segment c digit 4 segment d digit 3 connected to segment d digit 4 segment e digit 3 connected to segment e digit 4 segment f digit 3 connected to segment f digit 4 segment $g$ digit 3 connected to segment $g$ digit 4
Colon 1 segment connected to colon 2 segment
PM indicator segment connected to sleep/power down indicator segment
Anode digit 1 to anode digit 3
Anode PM indicator to anode digit 4
Anode sleep indicator to anode digit 1
Anode colon upper to anode digit 3
Anode digit 2 to anode digit 4
Anode colon lower to anode digit 2
The anodes can then be selected by the application of alternate half-cycle sine waves derived from a transformer from the line. The phase of the incoming $50 / 60 \mathrm{~Hz}$ count to IC will then automatically deliver the correct segment data to the display.


Anode phasing: 50/60 high = digit (1 \& 3) selected

$$
\text { low = digit }(2 \& 4) \text { selected }
$$

Sleep Output (Pin 18)
This output turns on while the sleep counter is running and is indicated as active by an indicator in the display (Pin 3). This output turns on immediately following a sleep initiate and is cancelled either by sleep time being complete, a sleep cancel, an alarm comparison taking place, or an end of snooze period. This pin is also used as an input during circuit test to speed up testing.
Wake 2 Output/50-60Hz Mode Select (Pin 19)
This output turns on at alarm compare time and stays on unless either an alarm cancel or a snooze repeat is activated.
If snooze repeat is activated this pin will go off until the next 5 minute period elapses when it will again turn on.
The snooze can be repeated indefinitely.
If the alarm is not cancelled this output will turn off 80 mins after the last snooze repeat re-triggering alarm for the next 24 hour period.
This pin is also the $50 / 60 \mathrm{~Hz}$ Select input during the time at which Set Time and Set Alarm are at a logic ' 1 ' (last data on this input when either Set Time or Set Alarm changes state is stored in an internal latch).
Wake 1 Output/12 or $\mathbf{2 4}$ Hour Select (Pin 20)
This output turns on at alarm compare time and stays on uninterrupted until either:
a. An alarm cancel
b. 80 continuous minutes from alarm time
c. 80 continuous minutes from last snooze repeat

| CK3300 | INSTRUMERAN |
| :---: | :---: |

During the time that Set Time and Set Alarm are at a logic ' 1 ' together, this pin is the $12 / 24$ hour select input.
The last data on this pin before a data change on Set Time or Set Alarm is stored internally in a latch, and defines 12 or 24 hour operation.

## Set Alarm (Pin 21)

This pin, held at zero while Set Time is at a logic ' 1 ', enables the Increment Minutes and Increment Hours inputs to the alarm counter, such that each change of state ( $1 \rightarrow 0$ ) of the increment inputs will advance the appropriate counter by one unit.

## Set Time (Pin 22)

Is identical in operation to the Set Alarm pin, but in this instance allows the counts to be entered into the time counter.
Taking both Set Time and Set Alarm to a logic ' 0 ' allows the Wake outputs to become active when the time reaches the alarm time. Returning either Set Time or Set Alarm to a logic '1' will cancel the alarm.
Increment Mins/Sleep Cancel/Snooze Repeat (Pin 23)
If Set Time or Set Alarm is at zero, this input provides one unit of increment for each logic transition from one to zero. (This input is de-bounced against switch noise). If both Set Time and Set Alarm are at a logic ' 1 ' or logic ' 0 ' and the sleep timer is running, a logic zero on this input will cancel sleep.
If both Set Time and Set Alarm are at a zero and the Wake outputs are active (i.e., post alarm time), then Wake 2 will be cancelled for a period of up to 5 mins when Pin 23 is taken to logic ' 0 '. If this input is at zero when the alarm comparison takes place, then Wake 2 will stay off until 5 minutes have passed.

## Increment Hours/Sleep Initiate (Pin 24)

If either Set Time or Set Alarm is at logic ' 0 ', this input provides one unit of increment to the required counter for each logic transition from 1 to 0 . (This input is de-bounced against switch noise). If both Set Alarm and Set Time are at logic '1' or logic '0', this input will cause Sleep output to become active for the time resulting from current sleep oscillator frequency.

## OSC 2 (Pin 25)

This pin produces a triangular wave oscillation depending on the value of resistance and capacitance. This oscillator is used to produce the sleep period by being gated internally with 160th of Osc 1 frequency (i.e. $50 / 60 \mathrm{~Hz}$ ).
Additionally connected to this pin is a low level detect circuit used with oscillator 1 for re-setting all internal logic to 12:00 in 12 hour mode and 0:00 in 24 hour mode. This low level detect is also used to detect that standby operation is required.

## OSC 1 (Pin 26)

This pin produces a triangular wave oscillation depending on the external value of resistance and capacitance. The signal is used during normal operation to provide internally to the IC a. the internal timing for a series of one-shot gates
b. After division, the frequency to de-bounce other external pins via D-type latches. This frequency is further divided down to $50 / 60 \mathrm{~Hz}$ and is used as the source frequency during standby operation.
Connected internally to this pin is a low level voltage detector which is used in conjunction with a low level voltage detector on Osc. 2 (pin 25) to reset all the internal logic to 12:00 in 12 hour mode and 0:00 in 24 hour mode. This low level detect is also used for test purposes.

## $50 / 60 \mathrm{~Hz} \ln (\operatorname{Pin} 27)$

This input is the normal source of timing. This input drives both the internal count and the alternate half line selection of the segment outputs.
For equal brightness in the display this input must have a 1:1 mark space ratio ( $\pm 20 \%$ ).
There is no necessity for eliminating line noise externally when providing this input signal as an internal arrangement eliminates undesired counts.
$\mathbf{V}_{\mathrm{P}}$ (Pin 28)
Is the most positive power supply to the chip (typically 10 volts)

## FUNCTIONAL OPERATION

Pins 19, 20, 23 and 24 are dual function pins which operate as inputs or outputs dependent on the state of the Set Time and Set Alarm inputs:

|  |  | INC | INC | SC/ | Wake Wake |  |  |  | $50 /$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| S.T. | S.A. | MIN | HR | SR | SIN | 1 | 2 | 60 | 24 |
|  |  |  |  | $*$ | $*$ |  |  | $*$ |  |
| 1 | 1 | - | - | $*$ | $*$ | - | - | $*$ | $*$ |
| 1 | 0 | $*$ | $*$ | - | - | - | - | - | - |
| 0 | 1 | $*$ | $*$ | - | - | - | - | - | - |
| 0 | 0 | - | - | $*$ | $*$ | $*$ | $*$ | - | - |

*Operable - Not Operable

| Set time (S.T.) | Pin 22 |
| :--- | :---: |
| Set alarm (S.A.) | Pin 21 |
| Increment minutes (inc min) | Pin 23 |
| Increment hours (inc hrs) | Pin 24 |
| Sleep cancel (S.C.) | Pin 23 |
| Snooze repeat (S.R.) | Pin 23 |
| Sleep initiate (SIN) | Pin 24 |
| Wake 1 | Pin 20 |
| Wake 2 | Pin 19 |
| $50 / 60 \mathrm{~Hz}$ Select | Pin 19 |
| $12 / 24 \mathrm{Hr}$. Select | Pin 20 |

## Using Wake 1 Or 2-Input/Output Functions

When the Set Time (S.T.) and Set Alarm (S.A.) inputs are at logic one, the IC outputs Wake 1 and Wake 2 become inputs to two bistable gates which store the logic conditions on those pins: $50 / 60 \mathrm{~Hz}$ Select on the Wake 2 pin and $12 / 24 \mathrm{Hr}$. Select on the Wake 1 pin.

## $50 / 60 \mathrm{~Hz}$ Select

Set Time or Set Alarm must be at zero before data on Wake 2 changes, or clock can change its $50 / 60$ pre-divide mode. To avoid this, the following circuit is recommended:


Fig. 1 SUGGESTED USE OF WAKE OUTPUTS TO ENSURE PROPER OPERATION OF INPUT/OUTPUT FUNCTION

With the Set switch in the center position the set inputs are pulled up to a logic ' 1 ' by the IC, provided the Alarm switch is in the off position. The load (R load) will pull the junction of the two diodes and R2 to a logic ' 1 '.
The output pin Wake 2 will either be pulled up or down depending on the connection of R3.
Changing of Set switch will pull down the appropriate input and not affect other external circuit conditions.
Change of position of alarm ON-OFF switch will allow R2 to pull down both Set inputs to zero before Wake 2 output is connected to load. This ensures that the internal IC latch is disconnected from wake line before data on wake line can influence stored data in latch.

## 12/24 Hr. Select

For the "Wake 1 output 12-24 hour select", changing the logic
polarity will immediately change the displayed time from 12 hour mode to 24 hour mode or vice versa.

| e.g. | $21: 56$ | becomes | $\bullet 9: 56$ |
| :--- | :--- | :--- | :--- |
| or | $\cdot 9: 56$ | becomes | $21: 56$ |

No leading zero is shown in 24 hour mode:
12:32 in 12 hour time becomes $0: 32$ in 24 hour time
(Note: 12 to 24 hour displayed time change can only be achieved when the alarm is not requested and not in set mode)
For economy of LEDs a single dot is employed which is illuminated during the PM period in 12 hour time.

## Time Setting

Four input pins (S.T., S.A., Inc Hr., Inc Mins.) are provided to enable the following four functions to be provided:
a. Setting the time
b. Setting the alarm
c. Stopping the clock
d. Starting the clock

For synchronizing purposes

## S.T. $=0$

Allows each depression of Inc Hrs to advance hrs by one count. Clock will stop on the first inc mins and will remain stopped until $S T=1$, thus allowing synchronization. The device assumes that the hours may need to be changed without affecting mins, but assumes clock is incorrect if minutes are changed, thus stopping clock and re-setting internal seconds counter to zero.
S.A. $=0$

Selects alarm time and, for each depression of Inc Hours, hours are advanced one and, for each depression of Inc Mins, minutes are advanced one.
NOTE:
No carries from minutes to hours occur during setting of time or alarm

## Radio Control Inputs

The inputs S.T., S.A., Inc Min, Inc Hr, serve as radio control inputs under the following conditions.

## S.T. And S.A.

At zero together-alarm is requested ST and S A at logic one together-alarm not requested, but if taken to logic one during post alarm, alarm is cancelled.
S.T. and S.A. different will also cancel alarm if alarm is active
S.T. S A. Pre-Alarm Post-alarm

| 1 | 1 | Not required | Cancel |
| :--- | :--- | :--- | :--- |
| 1 | 0 | Not required | Cancel |
| 0 | 1 | Not required | Cancel |

S.T., S.A. $=1$

If S.T. and S.A. are at a logic 1 together during pre-alarm time, the following functions can be obtained using Inc Min-Inc Hrs inputs Inc Hrs input going to logic zero for at least 20 msecs will result in sleep output going to zero for the period of time set by sleep potentiometer.
At any time Inc Mins input (SC/SR) going to zero for at least 20 msecs will cancel sleep tımer if sleep output is active
To reduce the number of knobs, switches, wiring etc., in the clock radio the following alternative feature is provided. If (S.C /S.R.) is wired to (SIN) a dual action is achieved, 1st depression of switch activates sleep, 2nd cancel sleep, 3rd re-activates etc. This allows features (a) if user decides he wishes radio off after he has been in bed for a few minutes, he pushes button, or (b) radio goes off automatically because sleep period has finished, but user is not asleep and would like radio to continue, so he presses button again.

## S.T., S.A. $=0$

In pre-alarm period the function performed when S.T., S.A. $=1$ is identical. (When the alarm sounds at the requested alarm time the input (S.C./S.R.) (Inc Mins) becomes the 5 min snooze repeat input.)

At alarm, the effect of (S.C./S.R.) becoming zero for at least 20 msecs is to turn Wake 2 output off until next 5 min interval, if again depressed, Wake 2 will turn off for a further $5 \mathrm{mins}-$ this sequence will go indefinitely until S.T., or S.A. or both are returned to logic ' 1 ', cancelling alarm. If inputs to the device are left unchanged for 80 mins then alarm will re-set for 24 hours.
Again to improve the radio features and simplify radio operation the tied function of (S.C./S.R.) and (SIN) on one button performs the following three functions:
Initiate sleep (SIN)
Cancel sleep (S.C.)
Snooze repeat (S.R.)

## Delaying Alarm by 5 Minutes

If, when Wake 1 ouput is capacitively coupled to (S.C./S.R.) input then at alarm time Wake 1 will turn on and stay on but Wake 2 will immediately become cancelled, hence no alarm will be heard from radio until 5 minutes later; this allows an electrical appliance to be turned on 5 minutes prior to alarm sounding.

## Use of Sleep Timer for Tape Recorder Control

If sleep input (SIN) in directly coupled to Wake 1 output, then a tape recorder or any electrical equipment can be turned on at alarm time using sleep output for a period of time set on sleep potentiometer.

## Radio Control Outputs

There are three radio control outputs:
a. Wake 1
b. Wake 2
c. Sleep output

Function

1. Wake 1-goes at zero; i.e. is on at alarm time for a period of 80 mins or until an alarm cancel.
2. Wake 2 goes to zero at alarm time, and stays at zero until a snooze repeat is activated then it will stay off until next 5 minute point then return to zero, for a period of 80 mins unless snooze repeat is re-activated. Snooze repeat can be used indefinitely, until either a continuous 80 mins occurs or alarm is cancelled.
Note: The 5 minute period is any 5 min interval from alarm time and not 5 min from each snooze repeat.
3. Sleep output goes low after a sleep initiate for the period of time set by sleep potentiometer. (Will be overridden by Wake if sooner.)
Colon Utilization

## FUNCTION

Set time
Set alarm
Stopped (Sync)
Run (alarm not requested)
Run (alarm requested)
Snooze period
COLON CONDITIONS

Sleep dot is on for sleep timer running, flashing for post line interrupt (removed from flashing by movement of S.T. or S.A. to '0')

## Stand-By Operation

If a circuit is employed to change the IC power source to battery during line failure, e.g. two diodes, then if the external timing components of oscillator 1 are set to give 8 kHz (nominally $\mathrm{R}=$ $120 \mathrm{~K} \Omega=2200 \mathrm{pF}$ ), then the IC will maintain operation to an accuracy of one part in 120 , i.e., 30 secs/ hr , during the failure. On return to main power the sleep indicator will flash at 1 Hz to notify user that indicated time could be in error.
The standby condition is detected by the failure of oscillator 2 to oscillate, therefore oscillator 2 is connected to the line-derived power source, not the battery.
It is assumed OSC 2 input has gone to zero volts.
To remove flash condition take S.T. or S.A. momentarily to zero.

## Analog Sleep Control

A second oscillator is provided on IC whose frequency can be controlled by an RC network. The oscillator is identical to oscillator one (Standby oscillator) and occupies the same silicon real estate location ensuring that process variations, temperature variations and voltage variations have as nearly as possible identical effects on frequency stability. Oscillator 1, which is set to 8 KHz is divided down to 50 Hz ( 20.0 msecs ) and is used as a gating time for oscillator 2 (Sleep Timer Source). The number of gated counts is loaded in the sleep timer (capacity 160 counts) and subsequently counted up at one per minute until 160 is reached.
The range of sleep time is controlled by varying OSC 2 resistance. At 4:1 change in resistance will give variation of 160 to 40 gated pulses, this giving a sleep time of 0 to 120 mınutes.
NOTE:
Minimum sleep time to ensure correct snooze operation should be a minimum of 5 minutes.


To initiate the sleep timer both S.T. and S.A. must logically be the same, and INC HR/SIN must be momentarily at zero. (See later section).


Fig. 3 OSCILLATOR CHARACTERISTICS FOR $V_{P}=10 \mathrm{~V}$


Fig. 4 OSCILLATOR CHARACTERISTICS WITH VOLTAGE


Fig. 5 OSCILLATOR CHARACTERISTICS FOR $V_{P}=7.5 \mathrm{~V}$


## Operation Clock Radio Example

(showing some features and their use) - ref Figs. 21 and 22.
Start-Up
Radio is connected to line for 1st time, then battery is inserted. Assume following switch position RADIO OFF, SET TIME SWITCH = RUN

## Actions

Display will illuminate and read 12:00 sleep indicator will flash at 1 Hz . Set clock as indicated previously (Flàshing will cease).
In 24 hr mode 0:00 will illuminate with flashing sleep indicator.

## Snooze Bar Action

IN RADIO OFF POSITION
1st button depression Low volume radio (set required volume)
2nd button depression Radio off
3rd button depression Radio on low volume 4th button depression Radio off
etc. ...

## IN RADIO ON POSITION

Radio comes on high volume (set wake volume required)
1 st button depression Low volume radio (mute facility)
2nd button depression High volume
3rd button depression 4th button depression

## as 1

as 2

## Radio Auto

In auto, alarm is requested at "set alarm" time. If sleep is desired press button. Subsequent button pusheṣ will have same effect as in radio "off" position.

## Select Wake to Alarm Tone or Radio

Assume radio selected
At alarm time radio will come on at wake volume setting.
1st button depression Radio will switch to low volume 2nd button depression Radio will switch off 3rd button depression Radio back a low volume
If after first depression radio is left untouched, radio will return to wake volume after five minutes.
If after 2 nd depression radio is left untouched, radio will stay off for five minutes then return to wake volume.
This wake volume, if left, will be maintained for 80 mins unless radio is returned to radio ON or radio OFF switch position, changing switch momentarily from auto to ON or OFF and back to auto will reset alarm and re-request for same time next day. The above, repeating snooze, can be maintained indefinitely if button is pushed before 80 mins elapses.
Vote: 80 mins is timed either from alarm time, if untouched, or 80 mins from last button depression

## Select Wake to Alarm Tone

The alarm tone or buzzer is obtained by placing positive feed-
back around the audio amplifier or radio in such a manner that the desired sound can be achieved and the feedback can be stopped by open circuit one point in the network.
At alarm time buzzer will sound:
On 1st button depression Buzzer will cease and radio will switch to low volume
2nd button depression Radio and buzzer will be off
If after first depression radio is left untouched, radio will return to buzzer after 5 mins.
If after 2 nd depression radio is left untouched, radio and buzzer will be off and at 5 mins BUZZER WILL AGAIN SOUND.
As for radio position-radio will reset after 80 mins for 24 hrs . At any time in buzzer sequencing, buzzer radio select can be changed over to radio, then the radio will alternate high-low volume with button. Cancelling in buzzer mode is identical to radio mode.

## Typical Application

To combine the S.A. and S.T. functions to provide simple and rapid clock setting. It is suggested that the following is incorporated in the clock radio.
Two toothed wheels are placed over two separate sprung contacts and coupled to two concentric rotating knobs, (say 12 teeth each) along side is a three position switch labeled 'set time, run, set alarm'.
To set clock, select time or alarm and rotate Hrs knob, or mins knob, each click will result in one unit change of time, rapid rotation will result in 12 increments per revolution of knob.
The above procedure results in an easy to use system with the advantage over mechanical clocks of independent hrs and mins setting.
NOTE:
No carries from mins to hrs can occur during setting of time or alarm.

## Use of Auto Tape

Fig. 21 shows - the facility for automatically switching on an appliance (e.g. tape recorder) at a specific time and keeping appliance active for a period of time up to 120 mins. In this mode the wake output is made to start the sleep-timer at the wake time.

Use of 5 Min Delayed Alarm with Appliance Switching
In this mode of operation the wake 1 output is made to cancel the first alarm through the SC (inc hr) input such that radio or alarm time will only occur at the end of the first snooze period.
This result in appliance being activated at set alarm time and after 5 mins the alarm or radio will sound.
Fig. 6 - shows a typical clock-radio block diagram
Fig. 7 - shows the chip/display circuit.


Fig. 6


Fig. 7

## Interface with a Radio

There are many possible configurations of clock radios in use today and a wide range of different radio chassis are employed in these units. It is necessary therefore that the clock radio I.C. be sufficiently flexible to allow simple interfacing to be accomplished.
The following section gives different options, features and interfacing to demonstrate some of the approaches possible with the CK3300.

## Power Supply Interface

To enable any existing line operated radio chassis to be used with the minimum of changes it is suggested that the following power supply is used with the adoption of a 2nd line transformer. This will (a) reduce the need for a change at the existing transformer. (It is unlikely that the existing transformer will be capable of providing the additional power required of the display).
a. Allow the electronic clock movement to be self contained therefore, keeping the interface wiring to a minimum.
b. Allow the same electronic movement to be used with several radio chassis.

## Options

1. Without battery standby facility Fig. 8
2. With battery standby facility Fig. 9

Display Interface and Power Source
Four options are shown

1. No brightness control Fig. 10
2. Day/night brightness (two level) Fig. 11
3. Manual brightness control Fig. 12
4. Automatic brightness control Fig. 13


Fig. 8 POWER SUPPLY INTERFACE WITHOUT STANDBY


Fig. 9 POWER SUPPLY INTERFACE WITH STANDBY OPTION


Fig. 10 NO BRIGHTNESS CONTROL


Fig. 11 TWO LEVEL BRIGHTNESS CONTROL


Fig. 12 MANUAL BRIGHTNESS CONTROL


Fig. 13 AUTOMATIC BRIGHTNESS CONTROL

| INSTRUMENT | CK3300 |
| ---: | :---: |

## Radio Switching

Option 1 Push button operation (Fig.14)
Option 2 Rotary switch operation (Fig.15)

## Radio Powering

Option 1(Fig.16A, 16B) Direct audio amplifier control (no active components)
Option 2 (Fig.17) Power supply switching using Transistor Option 3 (Fig.18) Power supply switching using a relay

## Tone Generation

Option 1 (Fig 19) Saw tooth generation independent of radio Option 2 (Fig 20) Sine wave generation independent of radio Option 3 (Fig.15,16B) Sine wave using the existing radio audio amplifier


Fig. 14 RADIO SWITCHING


Fig. 15 RADIO SWITCHING

## Additional Facilities

1. Automatic tape recording (Fig.21)
2. Appliance switching with delayed alarm (Fig.21)
3. Wake to normal radio with 5 minute alarm over-ride (Fig.21)
4. Wake to quiet radio with 5 minute alarm over-ride (Figs. 21 and/or 22)
5. Ratio muting during normal radio listening (Figs. 21 and /or 22)


Fig. 16a RADIO SWITCHING BY BIAS CHANGE


Fig. 16b TYPICAL TRANSFORMERLESS AUDIO AMPLIFIER


Fig. 17 RADIO POWER SWITCHED BY TRANSISTOR


Fig. 18 RADIO POWER SWITCHED BY RELAY


Fig. 19 SAW TOOTH OSC


Fig. 20 SINE-WAVE OSC

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage any Pin with Respect to $\mathrm{V}_{\mathrm{n}}$. . . . . . . . . . . . . . . . . . . . . . . . +20 V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Operating Temperature . . . . . . . . . . . . . . . . . . . . . . . . $-20^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Lead Temperature (Soldering 10 sec ) . . . . . . . . . . . . . . . . . . . . $+300^{\circ} \mathrm{C}$

| Characteristic | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Voltage Supply Current | 7 | $\begin{gathered} 10 \\ 2 \end{gathered}$ | - | Volts mA | $\mathrm{V}_{\mathrm{n}}=0 \mathrm{~V}$ |
| 50/60Hz Input |  |  |  |  |  |
| Frequency (must be identical to anodes) | 0 | 50/60 | 50,000 | Hz | $\mathrm{V}_{\mathrm{p}}=10 \mathrm{~V}$ |
| Logic '1' level | 0.6 Vp | - | Vp | Volts |  |
| Logic '0' level <br> Inputs (Excl Oscillators) | 0.0 | - | 0.7 | Volts |  |
| Logic '1' level | 0.6Vp | - | Vp | Volts |  |
| Logic '0' level | 0.0 | - | 0.7 | Volts |  |
| Segments Out (on) | - | 30 | - | mA | $\mathrm{V}_{\text {OUT }}=1.5 \mathrm{~V}$ |
| (off) | - | 10 | - | $\mu \mathrm{A}$ |  |
| Wake 1, 2, Sleep Out (on) | - | 30 | - | mA | $\mathrm{V}_{\text {OUT }}=1.5 \mathrm{~V}$ |
| (off) | - | 10 | - | $\mu \mathrm{A}$ |  |
| Wake 1, 2 (As Inputs) |  |  |  |  |  |
| Logic '1' level | 0.6Vp | - | Vp | Volts |  |
| Logic '0' level Oscillators 1 and 2 | 0.0 | - | 0.7 | Volts |  |
| Hi level | - | 5.5 | - | Volts | Free run |
| Lo level | - | 3.5 | - | Volts |  |
| Reset Level | - | - | 0.7 | Volts |  |

Unless specified otherwise, characteristics are defined with $\mathrm{V}_{\mathrm{p}}=10 \mathrm{~V}$ at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
**Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.
NOTES:

1. Under no circumstances during IC operation must any pin either input or output be taken to a voltage more negative than $\mathrm{V}_{\mathrm{n}}$ or IC malfunction will occur.
2. No input or output must be taken to a positive voltage greater than 20 volts or permanent damage can result.
3. No output must be allowed to dissipate a continuous power in excess of 100 mW .
4. Total chip continuous power dissipation must not exceed 500 mW .
5. The total current being returned to $\mathrm{V}_{\mathrm{n}}$ through all device pins must not exceed 1 amp


Input and Output Characteristics
INPUTS

$50 / 60 \mathrm{~Hz}$ count input, active pull down
For correct operation duty cycle of $50 / 60 \mathrm{~Hz}$ must be $1: 1 \pm 20 \%$

## OUTPUTS

Normally open circuit
Operate "on" (low impedance typically $50 \Omega$ )
INPUTS
Wake 1 -as input $\quad 1$ ' $=12 \mathrm{hr} \quad$ ' 0 ' $=24 \mathrm{hr}$
Wake $2-$ as input $\quad ' 1$ ' $=60 \mathrm{~Hz} \quad$ ' 0 ' $=50 \mathrm{~Hz}$

## CLOCK INPUT NOISE ELIMINATION TIMING

$50 / 60 \mathrm{~Hz}$-strobed every 4 ms internally for less than $1 \mu \mathrm{~s}$

## Testing I.C. Facilities

1. Master reset: This can be activated by pulling OSC1 (Pın 26) and OSC 2 (Pin 25) to zero volts together.
2 Internal debounce and predivider logic may be bypassed if OSC 1 is taken to zero volts while OSC 2 is left running.
a. Under this condition Inc Hrs and Inc Mins pins are not debounced to allow fast incrementing for test purposes.
b Also in this mode the $50 / 60 \mathrm{~Hz}$ input pin is directed straight to the main counters under control of the sleep pin. If Sleep pin at ' 0 ' $-50 / 60 \mathrm{~Hz}$ input clocks 120 minute sleep counter, and with Sleep at ' 1 ' it clocks the main minutes count by passing the debounce and divide by $50 / 60$ counter Under this condition it also clocks the 5 minute snooze counter.


FIg. 21 (a) TYPICAL "BASIC" CLOCK RADIO CIRCUITRY

| CK3300 | INSIRUMERAL |
| :---: | :---: |

Fig. 21 (b) TYPICAL "BASIC" CLOCK RADIO CIRCUITRY

| Instrancrent | CK3300 |
| :---: | :---: |



Fig. 22(a) TYPICAL "FULL-FEATURE" CLOCK RADIO CIRCUITRY


Fig.22(b) TYPICAL "FULL-FEATURE" CLOCK RADIO CIRCUITRY

| FUNCTION | DESCRIPTION | \% | $\begin{aligned} & \text { PART } \\ & \text { NUMBER } \end{aligned}$ | PAGE NUMBER |
| :---: | :---: | :---: | :---: | :---: |
| digital THERMOMETER | Digital thermometer and temperature controlle |  | AY-3-1270 | 7-32 |

## Digital Thermometer and Temperature Controller

## FEATURES

- Measurement and control range $-399^{\circ} \mathrm{C}$ to $+399^{\circ} \mathrm{C}$ (option $200^{\circ} \mathrm{C}$ to $499^{\circ} \mathrm{C}$ )
- Accuracy $\pm 1.5^{\circ} \mathrm{C}, 0^{\circ} \mathrm{C}$ to $-30^{\circ} \mathrm{C}$ using Thermistor temperature sensor
- Direct drive of liquid crystal displays
- Direct drive of $0.6^{\prime \prime}$ common anode L.E.D. displays
- 40 pin dual in line package
- Can be used as a digital voltmeter with digital autozero $\pm 399$ range
- 9 volt supply
- Leading zero blanking
- Power failure and over-range indication by flashing display
- Adjustable Hysteresis $0,0.2,0.4,0.8,2,4,8$ degrees
- Two control/alarm outputs, HIGH and LOW


## DESCRIPTION

The Digital Thermometer/Controller chip is an N-Channel MOS integrated circuit which when used in conjunction with a Thermistor, an L.E.D. or L.C.D display and a power supply forms a complete unit intended primarily for use in Deep Freezers, though it may also be used for the display and control of any parameter. Two control outputs are provided, one which operates when the reading is higher than the set point and the other when the reading is lower. The switching hysteresis is presettable as required.
A power fail detector is incorporated on the chip. If power is removed for more than a specified time, the initial reading at restoration of power will be retained and the display will flash. The display will also flash if during normal operation an over-range condition occurs.

With minor changes to the peripheral circuitry, the chip can be used for other temperature ranges, or used as a $23 / 4$ digit digital voltmeter.

## OPERATION

The chip uses a single ramp conversion technique to measure the imbalance of a thermistor bridge temperature sensor. A digital autozero system which operates on every other measurement cycle, is employed to compensate for offsets in the comparators.
The chip may be used as a digital voltmeter by removing the thermistor network and connecting the signal to be measured between the two comparator inputs.
The set point circuitry compares the actual reading to the value presented to the set point inputs.
Two outputs are provided, one which operates at Set Point plus Hysteresis and the other which operates at Set Point minus Hysteresis. In addition, $.05^{\circ}$ display hysteresis has been introduced

## PIN CONFIGURATION <br> 40 LEAD DUAL IN LINE

| Top View |  |  |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{Vss}^{\text {-1 }}$ | 40 | Sign o/p |  |
| Hyst strobe 2 | 39 | A3-B3-D3-G3 |  |
| Tens strobe 3 | 38 | F3 | Tens |
| Units strobe 4 | 37 | -1 | Segment |
| Tenths strobe 5 | 36 | -3 | Outputs |
| $2^{\circ} 1 / \mathrm{p}-6$ | 35 | $\square \mathrm{G} 2$ |  |
| $2^{1} 1 / \mathrm{p}-7$ | 34 | -F2 |  |
| $2^{2} 1 / \mathrm{p}-8$ | 33 | -E2 | Units |
| $2^{3} 1 / \mathrm{p} 9$ | 32 | D2 | Segment |
| Timer/Reset $1 / \mathrm{p}$ - 10 | 31 | -C2 | Outputs |
| Clock o/p 2 -11 | 30 | -B2 |  |
| Clock o/p 1.12 | 29 | $\square \mathrm{A} 2$ |  |
| Clock 1/p-13 | 28 | Dec Pt o/p |  |
| Comp $2 \mathrm{t} / \mathrm{p}-14$ | 27 | -G1 |  |
| Comp $1 \mathrm{l} / \mathrm{p} 15$ | 26 | -F1 |  |
| Ramp 1/p 16 | 25 | E1 | Segment |
| Control o/p 2 -17 | 24 | D1 | Segment |
| Control o/p 1.18 | 23 | $\square \mathrm{C} 1$ | pus |
| $\mathrm{Vcc}_{\text {co }} 19$ | 22 | B1 |  |
| LCD o/p-20 | 21 | A1 |  |

to prevent control output and L.S.D. jitter An optional power failure detection circuit is provided At power up the chip will read normally for about 10 sec-actual time determined by an external capacitor-then it will store the last reading and flash the display. In this condition the chip will continue to make measurements and operate the control outputs normally Operating the reset button will restore the normal display. If there is a short duration power failure the circuit will ignore it, if it lasts longer than 10 sec the alarm condition will occur

## HIGH READING OPTION

For normal operation Pin 39 drives segments A3, B3, D3 and G3 in parallel. Pin 38 drives segment F3, Pin 37 drives segments E3 and Pin 36 drives segment C3.
For 20.0 to 49.9 range Pin 39 drives segment C3. Pin 38 drives segment E3, Pin 37 drives segment A3 and D3 and Pin 36 drives segment F3. Segments B3, G3 are connected to Pin 28 (Decimal Point).

## PIN FUNCTIONS

| Pin No. | Name | Description |
| :---: | :---: | :---: |
| 1 | Vss | Negative Supply ( $0_{\text {v }}$ ) |
| 2 | Hysteresis Strobe Output | Common output for Hysteresis and LED select switches |
| 3 | Tens Strobe Output | Common output for Tens and Sign select switches |
| 4 | Units Strobe Output | Common output for Units select switches |
| 5 | Tenths Strobe Output | Common output for Tenths select switches |
| 6 | Set Point $2^{\circ}$ Input | Common input for $2^{\circ}$ bit |
| 7 | Set Point $2^{1}$ Input Control \& | Common input for $2^{1}$ bit |
| 8 | Set Point $2^{2}$ Input Hysteresis | Common input for $2^{2}$ bit |
| 9 | Set Point $2^{3}$ Input | Common input for $2^{3}$ bit |
| 10 | Timer Input/Reset Timer Input | Connected to a capacitor to $V_{s s}$ and switch to $V_{c c}$ for power failure detection and reset. The nominal delay time is 10 sec when a $10 \mu \mathrm{~F}$ capacitor is used |
| 11 | Clock Output 2 | Connected to frequency determining network |
| 12 | Clock Output 1 | See Figure 1 |
| 13 | Clock Input |  |
| 14 | Comparator Input 2 | Connected to nominal Vcc/2 reference |
| 15 | Comparator Input 1 | Connect to thermistor network |
| 16 | Ramp Input | Connect to Resistor to Vcc and Capacitor to Vss |
| 17 | Control Output 2 (HIGH) | Open drain output which turns ON when reading is greater than (Set Point + Hysteresis). Turns OFF again when reading equals Set Point |
| 18 | Control Output 1 (LOW) | Open drain output which turns OFF when reading equals (Set Point-Hysteresis) |
| 19 | Vcc | Positive supply (9V nom.) |
| 20 | LCD Backplate Output | Square wave output to drive backplate of LCD display |
| 21 | Segment A1 Output |  |
| 22 | Segment B1 Output |  |
| 23 | Segment C1 Output |  |
| 24 | Segment D1 Output |  |
| 25 | Segment E1 Output |  |
| 26 | Segment F1 Output |  |
| 27 | Segment G1 Output |  |
| 28 | Decimal Point Output |  |
| 29 | Segment A2 Output | Tens, Units and Tenths 7 segment outputs |
| 30 | Segment B2 Output | In LED mode these are open drain outputs |
| 31 | Segment C2 Output | designed to sink 12.5 mA per segment |
| 32 | Segment D2 Output | In LCD mode these are push pull outputs |
| 33 | Segment E2 Output |  |
| 34 | Segment F2 Output |  |
| 35 | Segment G2 Output |  |
| 36 | Segment C3 Output |  |
| 37 | Segment E3 Output |  |
| 38 | Segment F3 Output |  |
| 39 | Segment A3, B3, D3, G, |  |
| 40 | Sign Output | On for a negative reading |

## CLOCK OSCILLATOR

The Clock oscillator is designed to operate with an R-C network, an LC network or a Ceramic resonator. The choice will depend on the system Temperature and Voltage stability requirements.
As the thermometer reading is directly proportional to the clock frequency a ceramic resonator is recommended for frequency stability. In systems where only small variations in supply voltage and ambient temperature occur an R-C network could be used. The frequency variation over the specified operating range with an $\mathrm{R}-\mathrm{C}$ is about $\pm 22 \%$ (i.e. from 7 V to 11 V supply variation and $-25^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ Temperature variation).

| INSTRUMERE | AY-3-1270 |
| :--- | :--- |

## CHIP INTERFACE CIRCUITS

The input configuration on the Set Point inputs is shown in Fig. 2.
The circuit for the display drive is shown in Fig. 3. and shows the internal switching required to drive LED or LCD displays.


## ANALOG CIRCUITRY

The Temperature measuring circuit consists of a bridge network connected across the power supplies.
One side of the bridge (which is connected to comparator 2 input) consists of two equal value fixed resistors. These set up a reference potential of approximately $\mathrm{V}_{\mathrm{cc}} / 2(4.5 \mathrm{~V})$. The other side of the bridge (which is connected to Comparator 1 Input) consists of a Thermistor and a series resistor connected to $V_{c c}$ and a resistor connected to Vss. A suitable thermistor is Mullard Type 640-90003.
The bridge is arranged to balance at $0^{\circ}$. As the temperature varies, the voltage at Comparator 2 input goes from approximately 3 V (at $-39.9^{\circ}$ ) to $6 \mathrm{~V}\left(\right.$ at $\left.+39.9^{\circ}\right)$ in a non linear fashion.

A non linear ramp is generated by $R$ and $C$ and the time taken for the ramp voltage to change from one comparator input voltage to the other gives the temperature. $R$ is varied to adjust the FSD. The non linearity of the ramp to a large extent compensates for the non linearity of the thermistor network.
For use with linear sensors or as a digital voltmeter the Resistor would be replaced by a current source.
Reading will be negative if comparator input 1 voltage $<$ comparator input 2.
Typical circuit diagrams showing the AY-3-1270 displaying temperature in a freezer are shown in Fig 9 (with LED display) and Fig. 10 (with LCD display).

## SET POINT PROGRAMMING

To set the control temperature, diodes are inserted in the program matrix with the cathodes connected to the strobe lines on pins $2,3,4$. The code is B. C. D, and any temperature within the operating range can be selected by a suitable combination of diodes. For a negative temperature set point, a diode is inserted between pins 8 and 3
When an L.E D display is being used the diode between pins 9 and 2 is inserted, which inhibits the L.C D. backplate waveform This waveform is shown in Fig. 4.
A timıng waveform for the strobe lines is shown in Fig. 5

| $2^{0}$ <br> $($ pin 6) | $2^{1}$ <br> $($ pin 7) | $2^{2}$ <br> $($ pin 8) | $2^{3}$ <br> $($ pin 9) |
| :---: | :---: | :---: | :---: |
| 0.1 | 02 | 0.4 | 0.8 |
| 1 | 2 | 4 | 8 |
| 10 | 20 | Minus | Units (pin 4) <br> Do not <br> Use |
| A | B | Cens (pin 3) |  |
| C | LED <br> Display |  |  |

To set the hysteresis level, that is the temperature difference above and below the "set point" at which the control outputs operate, diodes are inserted in locatıons A, B, and C according to the following table Fig 6 shows the control output characteristıcs with temperature

|  | Hysteresis | A | B | C |
| :---: | :---: | :---: | :---: | :---: |
|  | 0 |  |  |  |
|  | $\pm 02$ | * |  |  |
|  | $\pm 04$ |  | * |  |
| Note 2 \{ | $\pm 08$ | * | * |  |
|  | $\pm 2$ | * |  | * |
|  | $\pm 4$ |  | * | * |
|  | $\pm 8$ | * | * | * |

## NOTES:

1. Set points must consist of valid BCD codes or incorrect readings will occur

2 The $1 / 2^{\circ}$ LSD Control and Display hysteresis should also be taken into account.
3. When in the "High Reading" mode it is necessary to program a set point $10^{\circ} \mathrm{C}$ lower than that required. e.g. To select $44^{\circ} \mathrm{C}$ diodes are inserted in the matrix between pins $6,3 / 7,3 / 8,4$

4 Nominal hysteresis value; for actual hysteresis obtained see table on following page.

InsREM

## HYSTERESIS

When $\pm 2, \pm 4$ or $\pm 8$ is set the actual hysteresis obtained is as shown.

| Set Temp. | Hyst. $\pm 2$ | Hyst. $\pm 4$ | Hyst. $\pm 8$ |
| :---: | :---: | :---: | :---: |
| +XX9 | +20/-1.9 | +4.0/-3.9 | +8.0/-7.9 |
| +XX8 | +2.1/-1.8 | +4.1/-3.8 | +8.1/-7.8 |
| +XX7 | +2.2/-1.7 | +4.2/-3.7 | +8.2/-7.7 |
| +XX6 | +2.3/-1.6 | +4.3/-3.6 | +8.3/-7.6 |
| +XX5 | +2.4/-1.5 | +4.4/-3.5 | +8.4/-7.5 |
| +XX4 | +2.5/-1.4 | +45/-3.4 | +85/-74 |
| +XX3 | +2.6/-1.3 | +4.6/-3.3 | +8.6/-7.3 |
| +XX2 | +2 7/-1.2 | +4.7/-3.2 | +8.7/-7.2 |
| +XX1 | +2 8/-11 | +4.8/-3 1 | +8.8/-71 |
| + X X0 | +29/-2.0 | +4.9/-4.0 | +8.9/-8.0 |
|  |  |  |  |
| +000 | +2.9/-2.9 | +4.9/-4.9 | +89/-8.9 |
| -000 | +29/-29 | +4.9/-4.9 | +8.9/-89 |
|  |  |  |  |
| -XX0 | +20/-29 | +40/-4.9 | +8.0/-8.9 |
| - XX1 | +11/-2.8 | +3.1/-48 | +7.1/-8.8 |
| -XX2 | +12/-27 | +3.2/-47 | +72/-8.7 |
| -XX3 | +1.3/-26 | +3.3/-4 6 | +7.3/-86 |
| -XX4 | +1.4/-25 | +3.4/-45 | +74/-85 |
| $-\times \times 5$ | +15/-24 | +3.5/-44 | +7.5/-8.4 |
| -XX6 | +16/-2.3 | +3.6/-4 3 | +7.6/-83 |
| $-\times \times 7$ | +1.7/-2.2 | +3.7/-42 | +77/-82 |
| -XX8 | +1.8/-2.1 | +3.8/-41 | +78/-81 |
| -XX9 | +1.9/-20 | +3.9/-40 | +79/-80 |

When $\pm 2, \pm 4$ or $\pm 8$ is set and the set point is less than or equal to the hysteresis setting then the actual hysteresis is given by the following table:

| Set Temp. | Hyst. $\pm 2$ | Hyst. $\pm 4$ | Hyst. $\pm 8$ |
| :---: | :---: | :---: | :---: |
| + XX9 | +2.0/-2.8 | +4.0/-4.8 | +8.0/-8.8 |
| + $\mathrm{XX8}$ | +2.1/-2.7 | +4.1/-4.7 | +8.1/-8.7 |
| + XX7 | +2.2/-2.6 | +4.2/-4.6 | +8.2/-8.6 |
| + XX6 | +2.3/-2.5 | +4.3/-4.5 | +8.3/-8.5 |
| + XX5 | +2.4/-2.4 | +4.4/-4.4 | +8.4/-8.4 |
| +XX4 | +2.5/-2.3 | +4.5/-4.3 | +8.5/-8.3 |
| + XX3 | +2.6/-2.2 | +4.6/-4.2 | +8.6/-8.2 |
| + XX 2 | +2.7/-2.1 | +4.7/-4.1 | +8.7/-8.1 |
| +XX1 | +2.8/-2.0 | +4.8/-4.0 | +8.8/-8.0 |
| +XX0 | +2.9/-2.9 | +4.9/-4.9 | +8.9/-8.9 |
|  |  |  |  |
| +000 | +2.9/-2.9 | +4.9/-4.9 | +8.9/-8.9 |
| -000 | +2.9/-2.9 | +4.9/-4.9 | +8.9/-8.9 |
|  |  |  |  |
| -XX0 | +2.9/-2.9 | +4.9/-4.9 | +8.9/-8.9 |
| - XX1 | +2.0/-2.8 | +4.0/-4.8 | +8.0/-8.8 |
| -XX2 | +2.1/-2.7 | +4.1/-4.7 | +8.1/-8.7 |
| -XX3 | +2.2/-2.6 | +4.2/-4.6 | +8.2/-8.6 |
| -XX4 | +2.3/-2.5 | +4.3/-4.5 | +8.3/-8.5 |
| $-\mathrm{XX5}$ | +2.4/-2.4 | +4.4/-4.4 | +8.4/-8.4 |
| -XX6 | +2.5/-2.3 | +4.5/-4.3 | +8.5/-8.3 |
| -XX7 | +2.6/-2.2 | +4.6/-4.2 | +8.6/-8.2 |
| -XX8 | +2.7/-2.1 | +4.7/-4.1 | +8.7/-8.1 |
| -XX9 | +2.8/-2.0 | +4.8/-4.0 | +8.8/-8.0 |



TC $=$ CLOCK PERIOD
Fig. 4 LCD DRIVE WAVEFORM


Tc IS CLOCK PERIOD
REPETITION RATE OF ABOVE CYCLES IS TWICE MEASUREMENT CYCLE

Fig. 5 STROBE OUTPUT TIMING


Fig. 6 SET POINT HYSTERESIS

## MEASUREMENT AND READ CYCLE

In order to compensate for offsets in the comparators, a digital autozero cycle operates on every other measurement cycle Fig. 7 shows the internal ramp and comparator waveform.


Fig. 7 TYPICAL MEASUREMENT/READ CYCLE

## SYSTEM DIAGRAM

Fig 8 shows a block schematic of the AY-3-1270 circuit


## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }}$. . . . . . . . . . . . . . . . . . -0.3 to +18
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Ambient Operating Temperature Range . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Maximum Power Dissipation at $70^{\circ} \mathrm{C}$. . . . . . . . . . . . . . . . . . . . . . 800mW
Maximum Segment Output Current (LED Mode) . . . . . . . . . . . . . . . . 20 mA
Maximum Switch Output Current . . . . . . . . . . . . . . . . . . . . . . . . . . 30mA
Maximum Total Output Current . . . . . . . . . . . . . . . . . . . . . . . . . . 250mA
Standard Conditions (unless otherwise stated):
$\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V} \quad \mathrm{~V}_{\mathrm{CC}}=(7.2 \mathrm{~V}$ to 10.8 V$) \quad \mathrm{T}_{\mathrm{amb}}=-25^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$, positive logic convention

| Characteristics | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Segment, DP, Sign Outputs LED mode |  |  |  |  |  |
| On resistance | - | - | 120 | $\Omega$ | $\mathrm{V}_{\text {out }}=+1.5 \mathrm{~V}_{\text {sink }}=12.5 \mathrm{~mA}$ |
| On resistance E3 | - | - | 60 | $\Omega$ | $\mathrm{V}_{\text {out }}=+1.5 \mathrm{~V}_{\text {sink }}=25 \mathrm{~mA}$ |
| On resistance DP | - | - | 40 | $\Omega$ | $\mathrm{V}_{\text {out }}=+1.5 \mathrm{~V} \mathrm{I}_{\text {sink }}=37.5 \mathrm{~mA}$ |
| On resistance (A3, B3, D3, G3) | - | - | 30 | $\Omega$ | $\mathrm{V}_{\text {out }}=+1.5 \mathrm{~V} \mathrm{I}_{\text {sink }}=50 \mathrm{~mA}$ |
| Segment, DP, Sign Outputs LCD mode |  |  |  |  |  |
| Logic '0' output | - | - | 400 | mV | Load $=50 \mathrm{pF}+1 \mathrm{MOhm}$ to |
| Logic ' 1 ' output | $\mathrm{v}_{\mathrm{cc}}-400$ | - | - | mV | ```E3 load = 100pF + 500k DP load = 150pF + 330K A3, B3, D3, G3 load = 200pF + 250K Backplate load = 1000pF +50K``` |
| Rise time | - | - | - | - | Under specified load conditions |
| Fall time | - | - | - | - | Under specified load conditions |
| Frequency | - | 68 | - | Hz | Clock ( 560 kHz ) |
| Control Outputs |  |  |  |  |  |
| On resistance | - | - | 75 | $\Omega$ | $V_{\text {out }}=+1.5 \mathrm{~V}_{\text {sink }}=20 \mathrm{~mA}$ |
| Off leakage | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {out }}=+15 \text { Volts }$ |
| Strobe Outputs |  |  |  |  |  |
| On resistance | - | - | 400 | $\Omega$ | $\mathrm{V}_{\text {out }}=+1 \mathrm{~V} \mathrm{I}_{\text {sink }}=2.5 \mathrm{~mA}$ |
| Off leakage | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {out }}=\mathrm{V}_{\text {cC }}$ |
| Frequency | - | - | - | - | $2 \times$ reading rate |
| Pulse width | - | 286 | - | $\mu \mathrm{s}$ | Clock frequency $=560 \mathrm{kHz}$ |
| Set Point Inputs |  |  |  |  |  |
| Logic '0' level | $\mathrm{V}_{\mathrm{ss}}$ | - | 2 | V |  |
| Logic '1' level | 6 | - | $\mathrm{v}_{\mathrm{cc}}$ | V |  |
| Pull up resistance | 20 | - | 100 | K $\Omega$ | to $\mathrm{V}_{\mathrm{CC}} \mathrm{V}_{\text {in }}=\mathrm{V}_{\text {SS }}$ |
| Comparator Inputs |  |  |  |  |  |
| Leakage current | - | - | 1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{cc}}$ |
| Resolution | 5 | - | - | mV |  |
| Common Mode Range Impedance between either input and ramp input | 0.1 | - | $\mathrm{V}_{\mathrm{cc}}-3 \mathrm{~V}$ | V |  |
|  | 1 | - | - | $\mathrm{M} \Omega$ | Clock frequency $=560 \mathrm{kHz}$ |
| Ramp Input |  |  |  |  |  |
| Discharge resistance | - | - | 100 |  | $V_{\text {out }}=+1 \mathrm{~V} \mathrm{I}_{\text {sink }}=10 \mathrm{~mA}$ See note 1 |
| Leakage current | - | - | 1 | $\mu \mathrm{A}$ | $V_{\text {in }}=V_{c c}$ |
| Timer Input |  |  |  |  |  |
| Flash Threshold | $05 \mathrm{~V}_{\text {OC }}$ | - | $0.7 \mathrm{~V}_{\text {oc }}$ | V |  |
| Reset Threshold | - | - | 6 | V |  |
| Pull up resistance | 500 | - | 2500 | $\mathrm{K} \Omega$ | to $V_{c c}\left(V_{\text {in }}=V_{s s}\right)$ |
| Pull down resistance | 50 | - | 250 | $\mathrm{k} \Omega$ | to $\mathrm{V}_{\mathrm{ss}}\left(\mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{cc}}\right)$ |
| Open circuit input voltage ( $\mathrm{V}_{\text {Oc }}$ ) | 2 | 2.6 | 3.5 | V |  |
| Clock |  |  |  |  |  |
| Frequency | 300 | - | 800 | kHz |  |
| Gain to output 1 (A1) | 3 | - | - | - | small signal open loop |
| Gain to output 2 (A2) | 3 | - | - | - | AC gain, $F=560 \mathrm{kHz}$ |
| Input capacitance | - | - | 12 | pF |  |
| Count frequency | - | 6.25 | - | kHz | Clock ( 560 kHz ) $\div 32$ see note 2 |
| Flash rate, Overrange and Power Fail | - | 1 | - | Hz | Clock ( 560 kHz ) $\div 158048$ |
| Supply current | - | 25 | - | mA | $\mathrm{V}_{\mathrm{cc}}=9 \mathrm{~V}, \mathrm{~T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |
|  | - | - | 45 | mA | $\mathrm{V}_{\mathrm{CC}}=11 \mathrm{~V}, \mathrm{~T}_{\mathrm{amb}}=-25^{\circ} \mathrm{C}$ |

NOTES 1 Minimum resistance to $\mathrm{V}_{\mathrm{cc}}=1 \mathrm{~K} \Omega$ Maximum capacitance to $\mathrm{V}_{\mathrm{ss}}=10 \mu \mathrm{f}$.
2. Readıng is measurement time divided by Count Frequency period Measurement tıme depends on both the voltage difference at the Comparator inputs and ramp speed at pin 16.

| INSTRUMENEN | AY-3-1270 |
| :---: | :---: |



Fig. 9 THERMOMETER WITH LEAD DISPLAY

## GENERAL INSTRUMENT

## Remote Control

| TUNOTION |  | PARY NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| REMOTE CONTHOL | 256 Command eCM infrared transmitter | AY-3-8470 | 7-42 |
| REMOTE CONXROL | 256 Commend POM intrared recelver. | AY-3-8475 | 748 |

## 256 Command Infrared Remote Control Transmitter

## FEATURES

- 256 Commands (possibly 32 commands by 3 bit address)
- Low Standby current ( $<20 \mu \mathrm{~A}$ )
- Low duty cycle ( $<8 \%$ )
- 6/9 Volt battery operatıon
- Simple RC defined on chip Oscıllator
- 22 pin DIL package
- Single shot or continuous operation
- Transmission format ensuring error free reception


## DESCRIPTION

The AY-3-8470 transmitter together with AY-3-8475 receiver, an infrared link and an amplifier, forms a complete remote control system Control of standard functions of radios and televisions is possible together with TV games, Teletext and Viewdata applications
Complementary MOS technology for this device allows low voltage battery operation with a very low standby current.
256 output commands are possible which can be simply activated by a standard $8 \times 4$ keypad together with 3 shift inputs.
A non critical, simple RC oscillator is used to fix the transmitter frequency

PIN CONFIGURATION
22 PIN DUAL IN LINE

|  | Top View |  |
| :---: | :---: | :---: |
| $\mathrm{VDO}^{-1}$ | $\bullet 1 \quad 22$ | Keyboard Input 2 |
| Keyboard Input 3 - 2 | 221 | Keyboard Input 1 |
| Keyboard Input 4-3 | 320 | Single Shot |
| Transmitter'active Output- 4 | $4 \quad 19$ | Single Shot/Continuous |
| Keyboard Strobe 8-5 | $5 \quad 18$ | Transmitter Output |
| Keyboard Strobe 76 | $6 \quad 17$ | Jvss |
| Keyboard Strobe 6-7 | $7 \quad 16$ | EClock Input |
| Keyboard Strobe 5-8 | $8 \quad 15$ | ]Shift Input 1 |
| Keyboard Strobe 4-9 | $9 \quad 14$ | IShift Input 2 |
| Keyboard Strobe 3-10 | $10 \quad 13$ | OShift Input 3 |
| Keyboard Strobe 2-11 | $11 \quad 12$ | Keyboard Strobe 1 |



## ELECTRICAL CHARACTERISTICS

Maximum Ratings*

Ambient Operating Temperature . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated)
Vss $=0$ Volts
$V_{D D}=+55$ to +10 Volts
Temperature $=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Frequency (16) | Fc | 60 | 80 | 100 | kHz | $V_{D D}=5.5 \text { to } 10.0 \mathrm{~V}, \mathrm{~T}=25^{\circ} \mathrm{C}$ <br> $\mathrm{C}_{c}$ and $\mathrm{R}_{\mathrm{c}}$ at typical values and $\mathrm{C}_{c} \mathrm{R}_{\mathrm{c}}$ tolerance $\pm 5 \%$ |
| Resistor to VDD | Rc | 12 | 39 | 100 | $\mathrm{K} \Omega$ |  |
| Capacitor to Vss | Cc | - | 220 | - | pF |  |
| Leakage to Vss | - | - | - | 2 | $\mu \mathrm{A}$ | Clock "OFF" in 'standby' and $\mathrm{V}_{\text {out }}=$ $V_{D D}=100$ Volts |
| Shift (13, 14, 15), Keyboard (2, 3, 21, 22) and Single Shot $(19,20)$ Input Thresholds Low Level |  |  |  |  |  |  |
|  | VIL | Vss | - | 1.5 | V | $\mathrm{V}_{\text {DD }}=55 \mathrm{~V}$ Olts |
|  | VIL | Vss | - | 25 | V | $V_{D D}=10.0$ Volts |
| High Level | V IH | VDD-1 5 | - | VDD | V | $V_{D D}=55$ Volts |
|  | $\mathrm{V}_{\mathrm{H}}$ | VDD-2 5 | - | VDD | V | $V_{D D}=10.0$ Volts |
| Pull Up to Vod |  |  |  |  |  |  |
| Low Level Source | ILL | - | - | 50 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=1.5$ Volts, $\mathrm{V}_{\text {DD }}=5.5$ Volts |
|  | ILL | - | - | 200 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=2.5$ Volts, $\mathrm{V}_{\text {DD }}=100$ Volts |
| High Level | - | $\mathrm{V}_{\mathrm{DD}}{ }^{-1.5}$ | - | - | V | $\mathrm{IIH}=2 \mu \mathrm{~A}$ source |
| Transmitter Output (18) |  |  |  |  |  |  |
| Low Level | Vol | - | - | 05 | V | $\mathrm{IOL}=75 \mu \mathrm{~A}$ sink |
| High Level | V OH | VDD-0.5 | - | - | V | $\mathrm{IOH}=1.0 \mathrm{~mA}$ source |
| Keyboard Strobe Outputs (5-12) |  |  |  |  |  |  |
| Low Level | Vol | - | - | 05 | V | $\mathrm{I}_{\mathrm{oL}}=150 \mu \mathrm{~A}$ sink, $\mathrm{V}_{\mathrm{DD}}=5.5 \mathrm{Volts}$ |
|  | VOL | - | - | 15 | V | $\mathrm{IOL}=600 \mu \mathrm{~A}$ sink, $\mathrm{V}_{\text {DD }}=10.00$ Volts |
| Off Leakage to VSs | - | - | - | 20 | $\mu \mathrm{A}$ | $V_{\text {OUT }}=V_{\text {DD }}=10.0$ Volts |
| Transmitter 'Active' Output (4) |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\text {OL }}$ | - | - | 15 | V | $\mathrm{IOL}=15 \mathrm{~mA}$ sink |
| Off Leakage to VSs | - | - | - | 2 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {DD }}=100$ Volts |
| Single Shot (20), Single Shot/Continuous (19) Inputs |  |  |  |  |  |  |
| Standby Pull Down to Vss |  | - | - | 05 | V | IOL $=10 \mu \mathrm{~A}$ sink |
| Supply Current VDD (1) | $I_{D D}$ | - | 1 | 3 | mA | $V_{D D}=100 \text { Volts }$ |
| Standby Current VDD (1) | IDD | - | 5 | 20 | $\mu \mathrm{A}$ | $V_{D D}=90$ Volts, $T=25^{\circ} \mathrm{C}$ |

NOTES 1 Pull Ups are confıgured with Enhancement FET's
2 Current from the device is defined as 'source' current, current into the device is 'sink' current


TYPICAL CLOCK VERSUS $\mathrm{V}_{\text {dd }} @ 25^{\circ} \mathrm{C}$


TYPICAL CLOCK VERSUS TEMPERATURE FOR V $\mathrm{V}_{\mathrm{dd}}=9$ VOLTS

| INSTRUMRENT | AY-3-8470 |
| :--- | :--- |

## PIN FUNCTIONS

| Pin No. | Name | Function |
| :---: | :---: | :---: |
| 1 | VDD | Positive Supply 5.5 to 100 Volts |
| 2 | Keyboard'Input 3 \} | Together with Pins 21, 22, these are the 4 keyboard inputs which under normal |
| 3 | Keyboard Input 4 \} | operatıons may only go actıve low one at a tıme |
| 4 | Transmitter 'actıve' output | Output goes low during a cycle in which a transmission is output |
| 5 | Keyboard O/P 8 ) |  |
| 6 | Keyboard O/P 7 |  |
| 7 | Keyboard O/P 6 |  |
| 8 | Keyboard O/P 5 \} | The 8 Keyboard Outputs are active low which strobe the Keyboard every transmission |
| 9 | Keyboard O/P 4 | cycle (i e every 1024 ms for $80 \mathrm{kHz} \mathrm{clock)} \mathrm{(See} \mathrm{Fig}$.1 ) The outputs are open drain. |
| 10 | Keyboard O/P 3 |  |
| 11 | Keyboard O/P 2 |  |
| 12 | Keyboard O/P1 |  |
| 13 |  |  |
| 14 15 | Shift 2 <br> Shift 1 | are active low. |
| 16 | Clock Input | Connect a resistor to VDD and a capacitor to VSs to determıne the clock frequency |
| 17 | Vss | Connect to 0 Volts |
| 18 | Transmitter Output | This output is in the form of a high going pulse stream at half clock rate modulated by the output code (See Fig. 1) |
| 19 | Single/Continuous Select | With this input low, Pin 19 high, and Shift 3 low, single shot is selected |
| 20 | Single Shot I/P | Connection low puts chip into single shot mode for all commands |
| 21 | Keyboard Input 1 |  |
| 22 | Keyboard Input 2 |  |

## OPERATION

## Standby

Standby mode is entered when power is applied to the chip in this mode the 'clock' is inhibited, 'pull ups' are inactive (except Keyboard inputs), and all the Keyboard outputs are low (active)

Any key depression will now be immediately recognized, the chip will come out of standby and the 'all Keyboard outputs active' condition will be removed

Keyboard outputs now strobe the keyboard and detect which key is depressed At the end of a complete keyboard scan the relevant output is transmitted Keyboard scans contınue and the relevant outputs transmitted, until a full keyboard scan occurs detecting no key depression, the chip then reverts to standby

## Invalid Inputs

Invalıd inputs occur due to multıple key depressions, they are
(a) More than one Keyboard input active during a single keyboard output strobe tıme
(b) More than one keyboard input active during different keyboard output strobe times within a 'full' keyboard scan
The above inputs are rejected as invalid and no output code is transmitted although the chip remains active scannıng the keyboard until t $^{-}$
(a) receives a valid input which can be transmitted or
(b) it detects no keys pressed and reverts to standby

## Output Code

Figure 1 shows a typical output code sequence and the relevant strobe tımings
The output code takes the form of an 8 bit word followed by its inverse so ensuring a 'secure' infrared link The infrared receiver being able to distinguish this 'data' from spurious inputs
An example of the data is shown below Note the LS Bit is transmitted first

$$
\begin{aligned}
& \begin{array}{lllllllllllllllll}
\mathrm{eg} & 0 & 0 & 1 & 1 & 0 & 1 & 0 & 0 & & 1 & 1 & 0 & 0 & 1 & 0 & 1
\end{array} 1 \\
& \text { INVERSE } \\
& \text { TRUE }
\end{aligned}
$$

Each ' 0 ' bit is comprised of 32 pulses and each ' 1 ' bit 48 pulses The complete command consists of 16 bursts of 32 or 48 pulses The pulses have a nomınal period of $25 \mu \mathrm{~s}$ ( 1 e 40 kHz repetition rate) A burst takes 1.6 ms and 16 bursts 256 ms . During the 768 ms the transmitter is inactive

## Output Code Derivation -'the 8 bit word'

Figure 2 identifies the binary output codes associated with the 'basic' keyboard matrix
Binary codes can be expanded up to 255 by means of the shift inputs The table Figure 3 shows the states of these inputs for relevant output codes

## Single Shot Operation

In this mode the code is transmitted only once after a key 'ON' is detected The key must now be released, the chip enters standby mode and is then ready for a further key depression. Commands can be entered up to a rate of 5 per second
An applicatıon for this mode of operation would be for transmitting page numbers for the General Instrument Teleview System.
The following table Fig. 4 shows the Single Shot modes of operation

## Keyboard Implementations

Figure 5 shows how diodes can be employed to expand the basic $8 \times 4$ matrix to 128 keys The further Shift input expands the matrix to 256 commands
Figure 6 shows how a simple 8 way switch can be used to enable 256 commands from the basic $8 \times 4$ matrix

## Transmitter

The circuit of Figure 6, employs 3 transmitting diodes pulsed at approximately 300 mA , giving a range of up to 20 meters Average battery current for transmission is around 20 mA with a standby current of only $20 \mu \mathrm{~A}$.


Fig. 1 OUTPUT TIMING WITH TYPICAL OUTPUT WORD


Decimal equivalent of binary output code for contact closure at $X$
Fig. 2 MATRIX FORMAT

| Shift Input 3 <br> (13) | Shift Input 2 <br> (14) | Shift Input 1 <br> (15) | Output Codes |
| :---: | :---: | :---: | :---: |
| H | H | H | 0 to 31 |
| H | H | L | 32 to 63 |
| H | L | H | 64 to 95 |
| H | L | L | 96 to 127 |
| L | H | H | 128 to 159 |
| L | H | L | 160 to 191 |
| L | L | H | 192 to 223 |
| L | L | L | 224 to 255 |

H signıfies High Level
L signifies Low Level
Fig. 3 SIGNIFICANCE OF SHIFT INPUTS

| Single Shot <br> Input (20) | Single Shot/ <br> Continuous (19) | Mode |
| :---: | :---: | :---: |
| H | H | Continuous on all <br> Codes. <br> Single Shot on all <br> Codes. <br> H |
| Lodes 0 to 127 |  |  |
| Continuous. |  |  |
| Codes 128 to 255 |  |  |
| Single shot |  |  |

NOTE: During Standby Single Shot Input (20) and Single Shot/ Continuous Input (19) are pulled low internally

Fig. 4 SINGLE SHOT MODES OF OPERATION

| GENERAL | AY-3-8470 |
| :---: | :--- |
| INSTRUMENT |  |


| Transmitted Code* | Receiver Functions <br> (Using the AY-3-8475) |
| :---: | :--- |
| 17 | Volume Decrease |
| 18 | Color Increase |
| 19 | Color Decrease |
| 20 | Brightness Increase |
| 21 | Brightness Decrease |
| 22 | Spare Increase |
| 23 | Spare Decrease |
| 24 | Normalize |
| 25 | Mute |
| 26 | ON/OFF to OFF |
| 27 | Spare 1 On |
| 28 | Spare 1 Off |
| 29 | Spare 1 Toggle |
| 30 | Spare 2 On |
| 31 | Spare 2 Off |
| $32-47$ | Program 17-32 |
| $48-255$ | Spare |

*Decımal equivalent of 8 bit binary word listed for convenience



## 256 Command Infrared Remote Control Receiver

## FEATURES

- 256 Commands
- Latched program number outputs
- 32 Programs
- 4 Analog Channels - 62 step
- ON/OFF facılity
- Normalize command on analog functions (except volume)
- 2 Auxiliary ON/OFF outputs (one with toggle facility)
- Local control of all 256 commands
- CPU Databus interface
- Direct Interface with General Instrument Teleview System
- Direct Interface with Economega TV and Radıo Tunıng Systems
- Command fully error checked ensuring secure lınk


## DESCRIPTION

The AY-3-8475 recelver together with the AY-3-8470 transmitter forms a complete 256 command infrared remote control system Applications include both radios and television. Control of normal TV functions is possible together with Teletext/Viewdata. Direct interface is possible with the Economega electronic tuning systems.

## OPERATION

All operations, repetition rates, set-up times and resolutions are related to the "Clock" Frequency of 25 MHz unless otherwise stated.

## Power On

When power is applied to the chip a power on reset is generated and outputs are as follows NOTE. power on to reset delay about $3 \mu \mathrm{~s}$
(a) Program Number Outputs set to 1 (00000) and Program No Strobe goes low for approximately 50 ms .
(b) Analog outputs set to a mark space ratio of 3231
(c) ON/OFF I/O set to OFF
(d) Auxiliary Outputs set to OFF
(e) Data Available set low.
(f) Input/Outputs A-H set low Note this data will only be presented to the output pins under control of the Digital Data Control input.
Any program command or a local ON command will turn on the ON/OFF output it will remain on until an 'OFF' command is received.

## Normalization

The Normalize command sets analog outputs 2, 3 and 4 (color, brightness and Spare), to a mark space ratio of 3231 Analog Output 1 (Volume) is not affected by the normalize command.

## Muting

Analog Output 1 (Volume) is set low when a mute command is received. It is returned to its previous mark space ratio by-
(a) A further mute command
(b) Recêption of any program command
(c) Switching on the ON/OFF output
(d) Reception of either the Volume increase, or Volume decrease commands

## PIN CONFIGURATION



For a remote mute command the command is repeated every 100 ms as long as the transmitter remains active. Only one mute command is actioned The transmitter must cease transmitting for at least 05 secs before a further mute command can be received, to toggle the function.

## Signal Input

Figure 1 shows a typical command input from the IR Transmitter A Valid input takes the form of an 8 'bit' word followed by its inverse The L.S Bit'arrives' fırst


Each ' 0 ' bit is comprised of 32 pulses and each ' 1 ' bit of 48 pulses The complete command therefore consists of 16 bursts of 32 or 48 pulses. The pulses have a nomınal period of $25 \mu \mathrm{~s}$ (i e 40 kHz repetition rate) A burst takes 1.6 ms and 16 bursts 25.6 ms . During the remaining 768 ms the transmitter is inactive
The receiver will decode input frequencies in the range 30 kHz to 50 kHz for its specified operatıng range of Clock Frequencies The mark space ratio of the input waveform is not critical, however the mark or space interval should be at least $2 \mu \mathrm{~s}$.
The receiver has an error margin of $\pm 8$ pulses in each burst i.e. a ' 0 ' will be decoded if 25-40 pulses are received and a ' 1 ' will be decoded if 41-56 pulses are received.
The receiver 'looks for' a valid data bit i.e. a burst of pulses. The decoder synchronizes to this valid data bit and then looks for further 'bits' and inter-bit 'gaps'. If a sequence of an 8 bit word occurs, followed by its inverse then this is decoded as a command. Any erroneous bits or their inverses cause the decoder to reset and await resynchronization
Command data outputs A-H correspond directly to the 8 'bit' word.


| INSTRUMEAL | AY-3-8475 |
| :---: | :---: |



Fig. 1 EXAMPLE INPUT FORMAT

## COMMAND DECODING

| Transmitted code and Output code (A-H)* | Receiver Functions | Transmitted code and Output code (A-H)* | Receiver Functions |
| :---: | :---: | :---: | :---: |
| 0 | Program 1 | 25 | Mute |
| 1 | Program 2 | 26 | ON/OFF to OFF |
| 2 | Program 3 | 27 | Spare 1 On |
| 3 | Program 4 | 28 | Spare 1 Off |
| 4 | Program 5 | 29 | Spare 1 Toggle |
| 5 | Program 6 | 30 | Spare 2 On |
| 6 | Program 7 | 31 | Spare 2 Off |
| 7 | Program 8 | 32 | Program 17 |
| 8 | Program 9 | 33 | Program 18 |
| 9 | Program 10 | 34 | Program 19 |
| 10 | Program 11 | 35 | Program 20 |
| 11 | Program 12 | 36 | Program 21 |
| 12 | Program 13 | 37 | Program 22 |
| 13 | Program 14 | 38 | Program 23 |
| 14 | Program 15 | 39 | Program 24 |
| 15 | Program 16 | 40 | Program 25 |
| 16 | Volume Increase | 41 | Program 26 |
| 17 | Volume Decrease | 42 | Program 27 |
| 18 | Color Increase | 43 | Program 28 |
| 19 | Color Decrease | 44 | Program 29 |
| 20 | Brightness Increase | 45 | Program 30 |
| 21 | Brightness Decrease | 46 | Program 31 |
| 22 | Spare Increase | 47 | Program 32 |
| 23 | Spare Decrease | 48-255 | Spare |
| 24 | Normalize |  |  |

*Decimal equivalent of 8 bit binary word is listed for convenience.
Command 'Outputs' appear approxımately $120 \mu$ s after the last bit of the 16 bit word has been input to the receiver Analog commands may be up to a maximum of $180 \mu \mathrm{~s}$ For the case of Local commands the outputs appear approximately $16 \mu \mathrm{~s}$ after the 20 ms debounce strobe. Analog commands may be up to a maximum of $70 \mu \mathrm{~s}$.

## Analog Outputs

The Analog outputs are variable mark space ratio outputs at a frequency of typically 20 kHz . The mark space ratio defines the analog level and can be varied from 1:62 to 62:1. Power on reset sets the outputs to mark space of 32.31 Analog outputs 2 to 4 can also be set to $32: 31$ with the Normalize command Analog output 1 (Volume) can be muted.
Remote commands cause analog channels to increment or decrement at the transmitter repetition rate. For local commands the rate will be approximately ten steps per second.


Fig. 7 BASIC SYSTEM SCHEMATIC


Fig. 8

## INSTRUERAL

## AY-3-8475

## Local Commands

Local Command Strobe input low convertsI/O's A-H to input mode and after a debounce period of 20 ms the local data is read in, decoded, and Data Available set to high. Input data must be 'valid' during the strobe time shown.
Local Command Strobe high outputs this new data on the I/Olines. Analog functions decrement or increment approximately once every 100 ms while the command is input.


Fig. 2 LOCAL COMMAND TIMING

## Program Strobe Output Timing

For the case where the Program Strobe I/O is not connected low externally, then on reception of a Program Command the strobe output will go low for approximately 50 ms . The strobe output goes low once only for each Program Command received even though the transmitter is repeating the command. The transmitter key must be released for at least 0.5 sec . (at typical receiver frequency) before a further Program Command can be received.


Fig. 3 PROGRAM STROBE TIMING

## Interface with CPU Databus

The receiver interfaces directly with the General Instrument Teleview System, Teletext and Viewdata. Interface with any CPU is possible however.
(a) Remote Control has exclusive use of the data bus. Data Available I/O and Digital Data Control input are connected together. Data Available high signals the CPU, the CPU reads in the data and then pulls Data Available and Digital Data Control input low for a minimum of $3 \mu \mathrm{~s}$. Data Available is now reset low If the CPU does not reply to the Data Available the next remote command received will reset Data Available low and then back again to high.
(b) The remote control outputs share a databus with other peripherals. Data Available to high signals the CPU, the CPU sets the Digital Data Control Input high which outputs the remote control data onto the bus. Data is now read and then the CPU resets Digital Data Control Input low which resets Data Available to low. If the CPU does not reply then the next remote transmission resets Data Available back to low and then high.
(c) With Digital Data Control input held high, Data is output on the bus permanently. At each command Data Available pulses high to act as a strobe for loading auxiliary latches.


Fig. 4 INTERFACE WITH C.P.U. DATABUS


NOTE DATA SET UP TIME SPECIFIED FOR 10pF LOAD CAPACITANCE

Fig. 5 INTERFACE WITH SHARED DATABUS


## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*


Ambient Operating Temperature Range . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)
$V_{D D}=+12$ Volts $\pm 10 \%$ (10 8 to 13.2)
$\mathrm{V}_{\mathrm{ss}}=0$ Volts
Operating temperature $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the-device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Min | Typ | Max | Units |  | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Clock (2) |  |  |  |  |  |  |
| Frequency | 15 | 2.5 | 2.8 | MHz | Note 2 |  |
| External resistor to $\mathrm{V}_{\mathrm{DD}}-\mathrm{R}_{\mathrm{C}}$ | 1.2 | 3.9 | - | $\mathrm{K} \Omega$ |  |  |
| External capacitor to $\mathrm{V}_{\text {SS }}$ | - | 47 | 250 | pF |  |  |
| Local Command Strobe (26) Input |  |  |  |  |  |  |
| Low Level | $V_{S S}$ | - | 0.8 | V |  |  |
| High Level | 22 | - | $\mathrm{V}_{\mathrm{DD}}$ | V |  |  |
| Pull up to $V_{\text {DD }}$ |  |  |  |  |  |  |
| Low Level Source | - | - | 300 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=0.4$ Volts |  |
| High Level | 24 | - | - | V | $I_{\text {SOURCE }}=30 \mu \mathrm{~A}$ |  |
| Digital Data Control Input (18) |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\text {SS }}$ | - | 0.8 | Volts |  |  |
| High Level | 3.0 | - | $V_{D D}$ | Volts |  |  |
| Pull-up to $V_{\text {DD }}$ |  |  |  |  |  |  |
| Low Level Source | - | - | 300 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=0.4 \mathrm{~V}$ |  |
| High Level Source | 32 | - | - | Volts | $I_{\text {SOURCE }}=20 \mu \mathrm{~A}$ |  |
| Signal Input (24) |  |  |  |  |  |  |
| Low Level | $V_{S S}$ | - | 0.8 | V |  |  |
| High Level | 3.0 | - | $V_{D D}$ | V |  |  |
| Leakage to $\mathrm{V}_{\text {SS }}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ |  |
| Input/Output A-H (14-17 and 20-23) |  |  |  |  |  |  |
| Input Low Level | $\mathrm{V}_{\text {SS }}$ | - | 0.8 | V |  |  |
| Input High Level | 22 | - | $V_{D D}$ | V |  |  |
| Pull-up to $V_{\text {DD }}$ |  |  |  |  |  |  |
| Low Level Source | - | - | 300 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=0.4$ Volts |  |
| High Level | 2.4 | - | - | V | $I_{\text {SOURCE }}=30 \mu \mathrm{~A}$ |  |
| Output Low Level | - | - | 05 | V | $\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}$ |  |
| Output High Level |  | ve Pu | High |  |  |  |
| Program No Outputs (7-9 and 12, 13) |  |  |  |  |  |  |
| Low Level | - | - | 05 | V | $\mathrm{I}_{\text {SINK }}=1.6 \mathrm{~mA}$ |  |
| High Level | 2.4 | - | - | V | $I_{\text {SOURCE }}=30 \mu \mathrm{~A}$ |  |
| Outputs 'OFF' Pull Up to $V_{D D}$ |  |  |  |  |  |  |
| Low Level Source | - | - | 300 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=0.4$ Volts |  |
| High Level |  | ve Ou | Hıgh |  |  |  |
| Program No Strobe I/O (10) |  |  |  |  |  |  |
| Input Low Level | $\mathrm{V}_{\text {SS }}$ | - | 0.8 | V |  |  |
| Input High Level | 30 | - | $V_{D D}$ | V |  |  |
| Pull up to $V_{D D}$ |  |  |  |  |  |  |
| Low Level Source | - | - | 300 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {iN }}=0.4$ Volts |  |
| High Level | 8 | - | - | V | $\mathrm{I}_{\text {SOURCE }}=10 \mu \mathrm{~A}$ |  |
| Output Low Level | - | - | 05 | V | $\mathrm{I}_{\text {SINK }}=2 \mathrm{~mA}$ |  |
| Output High Level | As above Pull Up High Level |  |  |  |  |  |
| Strobe Duration | 40 | 52 | 70 | ms |  |  |
| Analog Outputs (3-6) |  |  |  |  | Open Drain |  |
| Frequency | 15 | 20 | 25 | kHz |  |  |
| Low Level | - | - | 05 | V | $\mathrm{I}_{\text {SINK }}=2 \mathrm{~mA}$ |  |
| OFF Leakage to $\mathrm{V}_{\text {SS }}$ | - | - | 10 | $\mu \mathrm{A}$ | $V_{\text {OUT }}=V_{\text {DD }}$ |  |



## NOTES:

1. Pull Up's are configured with Depletion FET's with Gate connected to Source. They have non-linear VI characteristics.
2. System compatibility with the AY-3-8470 infra-red transmitter guaranteed for this range of frequencies.


PIN FUNCTIONS

| Pin No. | Name | Function |
| :---: | :---: | :---: |
| 1 | Vss | 0 Volts. Source/substrate connection. |
| 2 | Clock | Connect a resistor to VDD and a capacitor to $\mathrm{V}_{\text {SS }}$. Nominal frequency 2.5 MHz . |
| 3 | Analog Output 1 | Open drain pulse width modulated outputs. Mark space ratio variable from 1:62 to |
| 4 | Analog Output 2 | 62:1. Outputs increment one step for each command received. Increment rate |
| 5 | Analog Output 3 | approximately one step every 100 ms for continuous commands. |
| 6 | Analog Output 4 ) |  |
| 7 | $2^{4}$ Program No Output |  |
| 8 | $2^{3}$ Program No Output |  |
| 12 | $2^{2}$ Program No Output ${ }^{2}$ Program No Output | StrobeI/O connected low, latched program data is available. |
| 12 13 | $2^{1}$ Program No Output $2^{\circ}$ Program No Output |  |
| 10 | Program Number StrobeI/O | Goes low for approximately 50 ms when program data has been received. While low the Program Number Outputs are enabled. While high the Program Number outputs are all high. When this output is held low externally the Program Number outputs are permanently enabled. |
| 11 | Vdo | Positive power supply 12 Volts $\pm 10 \%$. |
| 14 | I/OA |  |
| 15 | I/OB |  |
| 16 | I/O C | 256 Command data under the control of the Digital Data Control input. |
| 17 | I/OD | A is the LS Bit. |
| 20 | I/OE | Local commands may be entered on the A-H lines under control of the Local Com- |
| 21 | I/O F | mand Strobe Input. |
| 22 | I/O G |  |
| 23 | I/OH |  |
| 18 | Digital Data Control Input | When high the 8 outputs A-H are enabled. This input also resets the Data Available output when taken low. When low outputs A-H are all high. |
| 19 | Data Available Output | This output is set high when new data is available. It remains high until reset by the Digital Data Control input going low. If the Digital Data Control input is permanently held high then Data Available output is a high going strobe pulse of typically $4 \mu \mathrm{~s}$. |
| 24 | Signal Input | This input should normally be low under no signal conditions. High going pulses are input when a remote command is triggered. |
| 25 | ON/OFFI/O | Open drain output used for switching 'ON' the television or radio, etc. This output is turned on by any one of the 32 program commands and turned off by the OFF command. The output can be latched on locally by connecting low for at least $128 \mu \mathrm{~s}$. When 'OFF' increment and decrement commands on the Analog channels are inhibited. Connect to 0 volts if not used. |
| 26 | Local Command Strobe Input | When low, I/O's A-H are in the input mode and the Signal Input is inhibited. Local commands may now be entered. When high are under control of the Digital Data Control input. |
| $\begin{aligned} & 27 \\ & 28 \end{aligned}$ | Auxiliary Output 1 \} Auxiliary Output 2 ) | Open drain outputs, turned on or off as required. In addition Auxiliary Output 1 can be toggled. Remote toggle commands have to be spaced at least 0.5 secs apart similar to the Mute toggle, see later Muting. |

# ULAs 8 

High Speed CMOS Uncommitted Logic Arrays (ULAs)

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| Uncommitted Logic Arrays |  |  |  |
| $\because \because$ |  | LAOB | 8-3 |
| HiGH SPEED CMOS |  | ca05 | 8.3 |
| UNCOMMITTED | Single mask; 5ns gate delay, single supply voltage, CMOS technology. othehip power-on reset. | LA10 | 8.3 |
| LOGIC ARRAYS |  | Cals | $8-3$ |
|  |  | LA20 | 8-3 |

## ULAs

## High Speed CMOS Uncommitted Logic Arrays

## FEATURES

- Offers advantages of custom design without the development cost or time
- "PC board on a chip" approach allows simple, easy to design technıque by customer or General Instrument
- Single mask commitment pattern
- 5ns gate delay
- Single supply voltage ( 3 V to 6 V )
- Low power dissipation due to silicon gate CMOS technology
- Available on-chip power-on reset optıon
- Full design package for customer designs available
- Short turnaround time, typically 6-8 weeks from layout to prototypes


## WHAT ARE GENERAL INSTRUMENT ULAs?

The General Instrument Uncommitted Logic Arrays consist of a matrix of pre-processed basic logic and peripheral cells which require only a single layer of metal interconnections to be made into a custom designed circuit
The design process consists of interconnectıng, via the extensive interconnection highway, standard cells selected from the comprehensive cell library (Each standard cell being constructed from one or more basic cells) This simple procedure, which requires no special semı-conductor design experience, is sımılar to printed circuit board layout and may be undertaken either by the customer or by General Instrument

## ARRAY DESCRIPTION

The gate array consists of rows of basic logic cells with interconnection highways between each row On the edge of the chip, surrounding the logic cells, are basic peripheral cells with an interconnection highway between the peripheral and the logic cells The peripheral cells buffer signals into and out of the chip See Figure 1.
The customer's circuit is built up using fully characterized standard cells selected from the large, comprehensive cell library Each standard cell is constructed from one or more of the basic logic cells (or from one basic peripheral cell in the case of the standard peripheral cells)

## THE GENERAL INSTRUMENT ARRAYS

| Type No. | No. of <br> Gates | No. of <br> I/O Pads | Minimum <br> Package Size |
| :---: | :---: | :---: | :---: |
| LA03 | 324 | 32 | 14 |
| LA05 | 560 | 40 | 16 |
| LA10 | 950 | 52 | 16 |
| LA15 | 1440 | 64 | 22 |
| LA20 | 2014 | 76 | 24 |
| 1 gate | $=1$ basıc logic cell |  |  |
| $=2$ N-Channel + 2 P-Channel transistors configurable |  |  |  |
| as a dual inverter, 2 input NAND gate, transmission |  |  |  |
| gate etc |  |  |  |

Note: Pin count includes 2 power pins.

## The cell library includes

Simple gates (AND, OR, NAND, NOR, exclusive OR etc ) Latches
Decoders
Shift Registers
Arithmetic Elements
Input Buffers
Output Buffers
A complete list of standard cells appears at the end of this data sheet and includes a cross-reference to standard 4000 series CMOS integrated circuits
The interconnection between the standard cells is done in the interconnection highways, each of which can carry up to ten tracks Extensive cross-under facilities are provided in these highways to allow tracks to cross each other in order to connect to the standard cells
The metal interconnections inside standard cells are held on the General Instrument graphics system and are automatıcally added to the interconnections between the cells at the digitization stage

## BASIC LOGIC CELL

The basic logic cell consists of 4 MOS transistors ( 2 N -Channel and 2 P -Channel) connected together as shown in Figure 2
The gate connections are in polysilicon, are contınuous through the cell and are avallable at the metal contacts both at the top and the bottom of the cell
The two P-Channel transistors each have one common source (drain) and one isolated source (drain) each of which may be connected to the metal contacts at the top of the cell
Similarly the N -Channel transistors have their source and drain at the bottom of the cell
The power supply lines are taken through every cell in metal
The internal connections of the cell (which convert the four separate transistors of one (or more) basic logic cells into a standard cell) are made in metal. See Figure 3.
The interconnections between standard cells are made to the metal contacts at the top and bottom of the cells

## BASIC PERIPHERAL CELL

The basic perıpheral cell consists of an input section and an output section See Figure 4
The input section has two MOS transistors (one N - and one P-Channel) connected to form an inverter A resistor in series with the gates plus two catching diodes gives input static protection $A$ $2 k \Omega$ and a $15 \mathrm{k} \Omega$ pull-up resistor are avallable which may be, optionally, connected to the input
The output section also has two MOS transistors (one N - and one P-Channel) which may be connected to form either an open drain, totem pole or tri-state output stage Two catching diodes are provided to give output static protection
The peripheral cell also has a bonding pad which is linked, inside the cell, to the input and/or output sections and is the point to which the external bond wires to the chip are connected

| INSTRUERAL | ULAS |
| :---: | :---: |



Fig. 1 BASIC GATE ARRAY LAYOUT


Fig. 2 BASIC LOGIC CELL SCHEMATIC

## INTERCONNECTION HIGHWAY

The interconnection highways between the rows of cells can accommodate up to ten tracks. See Figure 5
Connectıons across the highway may be made via the polysilicon underpasses as shown in Figure 5, where track 7 (marked start) is connected via the underpasses (which pass under tracks 1 to 6 ) to the contact window (marked end)
Connections are made between the metal tracks and the polysilicon underpasses only at the contact windows.

## DESIGN PROCESS

Designing with the General Instrument ULAs is no more complicated than designing in 4000 series CMOS or 7400 series TTL. Instead of a CMOS or TTL data book, the reference is the extensive General Instrument cell library of fully characterized logic and peripheral cells Choosing the appropriate element is as easy as looking up a CMOS catalog for the desired gate. If the design is already in standard CMOS, a quick cross-reference to the nearest equivalent in the ULA library is provided.
Once logic design is complete, the design process is reduced to one which very closely resembles a PC board layout and wiring
operation. General Instrument provides a sheet of temperaturestable mylar material with the cell placement grid and polysilicon underpasses drawn on it at a scale of 250:1. A portion of the grid is shown in Fig. 6.
In addition to the grid, adhesive backed logic decals are available from General Instrument for each of the library cells. Cell placement simply involves choosing the correct decal and locating it on the grid by aligning the registration marks on the decal with those on the grid. Fig. 6 also illustrates this process and Fig. 7 shows examples of the decals. As can be seen, the decals are drawn at the logic symbol level, no transistor-level information is provided, nor is it necessary for interconnecting one cell with another. The only other information available from the decals is the position of the input and output connections. When properly aligned with the grid registration points, these inputs and outputs appear precisely at the correct polysilicon underpasses.
Interconnections between cells are made by drawing metal tracks in the spaces provided in the interconnection highway or, alternatively, placing tape between the appropriate contacts Tape of the correct width is provided in the General Instrument design package and offers a better solution than pencil since it leaves no residual marks when removed.

This "PC board on a chip" concept makes for a highly flexible design technique and one which is ideal for customer designs since MOS knowledge and transistor-level acquaintance with the array layout are not prerequisites for undertaking a design.


Fig. 3 BASIC LOGIC CELL CONFIGURED AS A 2 INPUT NAND GATE

As an alternative to the manual design method described, a Computer Aided Design (CAD) technique is available from General Instrument. This approach facılitates ease and speed of design through the use of a Calma compatible software data base containing all necessary design information.


Fig. 4 BASIC PERIPHERAL CELL SCHEMATIC


Fig. 5 INTERCONNECTION HIGHWAY SCHEMATIC

| ULAs | INSTRUMERAL |
| :---: | :---: |

## CUSTOMER INTERFACES

There are three possible design routes which may be taken up to the prototype stage
I) General Instrument designs the ULA from the customer's logıc diagram This interfacing route will follow the flow chart of Figure 8
II) Customer designs in ULA format as shown in Figure 9
III) Customer takes design through layout General Instrument's involvement begins at the Digitization stage prior to mask generation Figure 10 defines this design route
Variatıons on these basic design routes are possible in consultation with General Instrument

## AVAILABLE FROM GENERAL INSTRUMENT

1 Data sheets and brief explanatıon of ULA desıgn procedures
2 Detaıled specification and design manual
3 Full design package including

- Cell library of fully characterized logic elements with complete electrical specification for each cell
- Mylar layout grid
- Set of logic decals
- Interconnection tape
- Calma data base

4 Traıning and advice on design procedures and interpretation of logic simulation results
5 Complete design capability

## BUDGETARY QUOTATIONS

To enable General Instrument to perform a realistic appraisal of a proposed ULA design, the following informatıon, at a mınımum, must be supplied
1 A clearly defined logic dıagram of the proposed ULA chip with a brief description of its operation
2 An electrical specification for important parameters including operating voltage range
3 Temperature range of operation
4 I/O definition and input/output impedances
5 Required package type
6 Proposed prototype delivery date.
7 The level of customer involvement, that is, which of the three design routes will be followed
8 Intended production volume

| INTRENEKRAL | ULAs |
| :--- | :--- |




Fig. 7 TYPICAL LAYOUT DECALS
$\square$

PROCEDURE I GENERAL INSTRUMENT DESIGNS ULA


Fig. 8 DESIGN INTERFACE

PROCEDURE II CUSTOMER DESIGNS IN ULA FORMAT


Fig. 9 DESIGN INTERFACE

| INSTRUERAL | ULAs |
| ---: | :---: |

PROCEDURE III CUSTOMER DESIGNS ULA
(a) GENERAL INSTRUMENT DIGITIZES
(b) CUSTOMER DIGITIZES

CUSTOMER


Fig. 10 DESIGN INTERFACE

| ULAs | INSTRUERAL |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

All inputs and outputs (with respect to GND) .................. -03 V to 7 V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Soldering Temperature of leads ( 10 seconds) . ................... $+300^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated).
Operatıng Voltage Range +3 V to +6 V
Operating Temperature Range $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

$$
-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C}
$$

*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied - operating ranges are specified in Standard Conditions Exposure to absolute maxımum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed

Typıcal gate delay at $25^{\circ} \mathrm{C}$ and +5 V is 5 ns However, the characteristics of each logic element are specified independently for each of the library cells Two examples are shown below

CELL LIBRARY SPECIFICATIONS
EXAMPLE 1:
2 INPUT NAND GATE (MCU2NAND)


LOGIC


BLOCK SCHEMATIC

| Characteristics | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Propagation Delay Time |  |  |  |  |  |
| High to Low Level | - | 0 | 0 | ns |  |
| Propagatıon Delay Time |  |  |  |  |  |
| Low to High Level | - | 0 | 0 | ns |  |
| Transitıon Tıme |  |  |  |  |  |
| High to Low Level | - | 4 | 52 | $\mathrm{ns} / \mathrm{pF}$ |  |
| Transition Time |  |  |  |  |  |
| Low to High Level | - | 45 | 58 | $\mathrm{ns} / \mathrm{pF}$ |  |
| Input Capacitance | - | 35 | . 5 | pF |  |
| Inherent Output Capacitance | - | 7 | 9 | pF |  |


| INSTRUMEAL | ULAs |
| :--- | :--- |

## EXAMPLE $2:$

D-TYPE FLIP-FLOP (MCUDT)


POSITIVE EDGE TRIGGERED FLIP-FLOP


TRUTH TABLE

| N |  | OUT |  |
| :---: | :---: | :---: | :---: |
| CL | D | Q | $\overline{\mathrm{Q}}$ |
| $\bar{\Omega}$ | O | O | 1 |
| $\bar{\Omega}$ | 1 | 1 | O |
| Z | X | Q | $\overline{\mathrm{Q}}$ |

NO CHANGE

## BLOCK SCHEMATIC



| Characteristics | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Propagation Delay Time: Clock to Q | - | 20 | 34 | ns |  |
| Clock to $\overline{\mathbf{Q}}$ | - | 7 | 12 | ns |  |
| Transition time |  |  |  |  | Note 1 |
| High to Low Level Q | - | 2.0 | 26 | $\mathrm{ns} / \mathrm{pF}$ |  |
| $\overline{\mathrm{Q}}$ | - | 40 | 54 | $\mathrm{ns} / \mathrm{pF}$ |  |
| Low to High Level Q | - | 4.5 | 58 | ns/pF |  |
| $\bar{Q}$ | - | 9 | 117 | $\mathrm{ns} / \mathrm{pF}$ |  |
| Clock Input Frequency (Q\& $\overline{\mathrm{Q}}$ Unloaded) | dc | - | 17 | MHz |  |
| Data Set Up Time | 30 | - | - | ns |  |
| Data Hold Time | 12 | - | - | ns |  |
| Clock Rise or Fall Time | - | - | 1000 | ns |  |
| Input Capacitance. Node CL | - | 35 | 5 | pF |  |
| D | - | 35 | 5 | pF |  |
| Inherent Output Capacitance: Node Q | - | 85 | 11 | pF | Note 2 |
| $\overline{\mathrm{Q}}$ | - | 135 | 18 | pF |  |

NOTES.

1. If $\bar{Q}$ is loaded total propagation delay time to $Q=$ propagation delay time to $Q+$ additional transition time to $\bar{Q}$.
2. If $Q$ or $\bar{Q}$ has to drive a switched load (eg. D input to MCUTRI) then outputs must be buffered with inverter cell.

| ULAs | INSTRUNERAN |
| :---: | :---: |


| Cell Description | Cell Name | No. of Gate Equivalents | Nearest CMOS Equivalent |
| :---: | :---: | :---: | :---: |
| Gates |  |  |  |
| Inverter Fast | MCUINV1 | 1 | 4069 |
| Dual Inverter | MCUINV2 | 1 | 4069 |
| 21P NAND Gate | MCU2NAND | 1 | 4011 |
| 21P NAND/AND Gate + Inverter | MCU2AND | 2 | 4018 |
| 31P NAND/Gate + Inverter | MCU3NAND | 2 | 4023 |
| 31 P NAND/AND Gate | MCU3AND | 2 | 4073 |
| 41P NAND Gate | MCU4NAND | 2 | 4012 |
| 41P AND/NAND Gate + Inverter | MCU4AND | 3 | 4082 |
| 21P NOR Gate | MCU2NOR | 1 | 4001 |
| 21P NOR/OR Gate + Inverter | MCU2OR | 2 | 4071 |
| 31 P NOR Gate + Inverter | MCU3NOR | 2 | 4025 |
| 31 P NOR/OR Gate | MCU3OR | 2 | 4075 |
| 41P NOR Gate | MCU4NOR | 2 | 4002 |
| 41P NOR/OR Gate + Inverter | MCU4OR | 3 | 4072 |
| 2 AND 2 NOR Gate | MCU2ANNO | 2 | 4085 |
| 2 AND NOR/OR Gate + Inverter | MCU2ANOR | 3 | 4019 |
| Transfer (Tri-State) Gate + Inverter | MCUTRI | 2 | 4070 |
| Exclusive OR/NOR Gate | MCUEXORN | 3 | 4077 |
| Arithmetic |  |  |  |
| Half Adder + Inverter | MCUHAD | 4 |  |
| Full Adder | MCUFAD | 7 | 4008 |
| Registers \& Latches |  |  |  |
| Set-Reset D Type Flip Flop | MCUSRDT | 8 | 4013 |
| Reset D Type Flip Flop | MCURDT | 7 | 4013 |
| Set D Type Flip Flop | MCUSDT | 7 | 4013 |
| D Type Flip Flop | MCUDT | 6 | 4013 |
| Set-Reset D Latch | MCUSRDL | 5 |  |
| Reset D Latch | MCURDL | 4 |  |
| Set D Latch | MCUSDL | 4 |  |
| D Latch | MCUDL | 4 | 4042 |
| NOR S/R Latch | MCUNOSR | 3 | 4043 |
| NAND S/R Latch | MCUNASR | 3 | 4044 |
| D Register (First Bit) | MCUDREGF | 5 |  |
| D Register (Middle Bit) Dual | MCUDREGM | 5 | 4042 |
| D Register (End BIt) | MCUDREGE | 3 |  |
| Shift Register (First Bit) | MCUSHRF | 10 |  |
| Shift Register (Middle Bit) | MCUSHRM | 5 | 4015 |
| Shift Register (End Bit) | MCUSHRE | 5 |  |
| Half Parallel Loading Shift Reg Clock Drivers | MCUHPLSF | 8 |  |
| Half Parallel Loading Shift Reg First and Middle Bit | MCUHPLSM | 7 | 4021 |
| Half Parallel Loading Shift Reg End Bit | MCUHPLSE | 7 |  |
| Decoders |  |  |  |
| Expandable 7-Segment Decode Segment a | MCU7SGA | 7 |  |
| Expandable 7-Segment Decode Segment b | MCU7SGB | 7 |  |
| Expandable 7-Segment Decode Segment c | MCUTSGC | 5 |  |
| Expandable 7-Segment Decode Segment d | MCUTSGD | 8 | 4055 |
| Expandable 7-Segment Decode Segment e | MCUTSGE | 5 |  |
| Expandable 7-Segment Decode Segment f | MCU7SGF | 8 |  |
| Expandable 7-Segment Decode Segment g | MCU7SGG | 8 |  |
| Service Elements 2 Row Interconnect | MCU2INT | 1 |  |
| Peripheral |  |  |  |
| Input Buffer Inverting | MCUNIP |  |  |
| Input Buffer Inverting with $15 \mathrm{k} \Omega$ Pull Up Resistor | MCURINIP |  |  |
| Input Buffer Inverting with 2k $\Omega$ Pull up Resistor | MCUR2NIP |  |  |
| Output Buffer Inverting | MCUNOP |  |  |
| Output Buffer Inverting Open Drain | MCUODNOP |  |  |
| Tri-State Output Buffer plus Inverting Input Buffer | MCU3IO |  |  |
| Dummy Pad | MCUDUM |  |  |

Video Display
Video Graphics
Video Games

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMEER |
| :---: | :---: | :---: | :---: |
|  |  | Video Display |  |
| TELEVIEW SYSTEM | The Teleview system is a powerful system to display information on a TV receiver. If can store data from either telephone lines or TV RF signal information. | TELEVIEW System | 9-4 |
|  |  | PIC1650A | $9 \cdot 9$ |
|  |  | P1C1650-536 | 9-15 |
|  |  | AY-3-9710 | 9-28 |
|  |  | AY-3-9735 | 9-33 |
|  |  | Video Graphics |  |
| PERSONAL TERMINAL | The 8900 system is a programable video display system, capable of detaifed graphics definition and manipulation. | General information | 9-42 |
|  |  | CP1610 | 9-22 |
|  |  | AY-3-8900 | 9-43 |
|  |  | AY-3-8900-1 | 9-43 |
|  |  | HO-3-9502 | 9-46 |
|  |  | nO-3-9503 | 9-49 |
|  |  | RO-3-9600 | 9.51 |
|  |  | RO-3-9504 | 9.54 |
|  |  | AY-3-8910 | 9-56 |
|  |  | AY-3-8912 | 9-56 |
|  |  | AY-3-8913 | 9-56 |
|  |  | AY-3-8915 | 9-57 |
|  |  | Video Games |  |
| BALL \& PADDLE | Six selectable games for one or two players, with vertical paddle motion. | AY-3-8500 | 9-60 |
|  |  | AY-3-8500-1 | 9-60 |
| 8600 SERIES | The 8600 series games consist of a set of single chip TV game integrated circuits. | General Information | 9-63 |
| ROADAACE | One or two player games where racing skill in "traffic" generates the highest score. | AY-3-8603 | 9-64 |
| WARFARE | One or two player games featuring subs, destroyers, cargo ships, and spaceships. | AY-3-8605 | 9-65 |
| WIPEOUT | One or two player games where players "wipe out" objects by controlling a ball in the play area. | AY-3-8606 | 9-66 |
| SHOOTING GALLERY | Twelve games for one or two players using external photocell rifles for shooting. | AY-3-8607 | 9-68 |
| SUPERSPORT | Ten selectable games for one or fwo players, with vertical and horizontal paddle motion. | AY-3-8610 | 9-70 |
| MOTOR CYCLE | One player cycle game with yariable skill selection. | AY-3-8765 | 972 |

## GENERAL INSTRUMENT

## Video Display

|  | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| TELEVIEW SYSTEM | The Teleview system is a powerful system to display information on a TV recelver. It can store data from either telephone lines or TV RF signal information. | TELEVIEW System | 9-4 |
|  |  | PIC1650A | 9-9 |
|  |  | PIC1650-536 | $9 \cdot 15$ |
|  |  | A Y -3-9710 | 9.28 |
|  |  | AY-3-9735 | 9-33 |

## INTRODUCTION

Teletext and Viewdata are the generic names for two basically sımilar systems for displaying pages of information on a TV screen
Teletext (otherwise known as Ceefax, Oracle, Videotext).
In the Teletext system the data is coded onto normally unused lines of a televisıon transmission It has the following features.
(a) Being a broadcast system, the data flow can be one way only. 'Pages' of data are sent continuously, on a rotating basis. The decoder will grab the required page as it passes.
(b) The number of spare TV lınes is limited. For a reasonable access time the data bank is restricted to $100-800$ pages per channel.
(c) Being broadcast the data may be 'live', it may update very rapidly and everyone receives the data simultaneously. Subtitles and newsflashes are good examples of live data.
Viewdata (otherwise known as Prestel, Bıldschirmtext)
In the Viewdata system the decoder is connected to the users telephone line and uses the public telephone network in order to transmit information to and from a computerized data bank It has the following features.
(a) There is a direct and individual connection to the user and the data flow may be two way The user thus requests the page he wants directly.
(b) The data bank may be as large as desıred, there are no system limıtations.
(c) Being an individual connection the service may be a personal one and the data content may reflect this, and may indeed be restricted to a selected group of users

## TELEVIEW

Teleview is a General Instruments' 3 chip integrated cırcuit kit which forms the basis of an ınexpensive, comprehensive Viewdata and Teletext system.
Other optional circuits provide additional features such a Infra Red Remote Control, Viewdata modem, Autodialer and Termınal identifier, and varıous TV Digital Tunıng Systems
The kit provides switchable Viewdata or Teletext operation with automatic selection of "on" and "off hours" operatıon. Provision has been made for addressing up to 8 pages of memory thus giving great flexibılity and economy of operation.
The system is organized around parallel Data and Address highways, this allows easy expansion of the system and the connection of other equipment such as Home Computers and Disc Memories.
A single chip microcomputer is used to control the system and to interface to the user The microcomputer allows easy alteration of the system features enabling manufacturers to have personalized systems if desired
As far as possible adjustable and critical components have been eliminated and the circuitry has been designed to facilitate the use of single sided printed circuit boards.

## TELEVIEW FEATURES

- Switchable Viewdata - Teletext, 625 line system with 24 rows of 40 characters
- Up to 8 page stores
- Microcomputer controlled, gives system flexibility
- Data bus organization for easy system expansion
- On/Off hours operation
- Don't care digit feature in Teletext
- Half page expansion feature
- Black/White output for Monochrome TV and Printers
- Special Graphics feature for high resolution
- Boxed clock capability in Teletext
- Selectable character roundıng
- Simple printed board layout
- $4 \times 4$, ASCII, REMOTE Keyboard options
- Low power consumption typically +12 V at +12 V at 100 mA
+5 V at 400 mA$\}$ for a single page store
-5 V at 10 mA


## SYSTEM DESCRIPTION

The system consists of four basic blocks.
(a) Data Acquisition

This block acquires data from either the TV IF (Teletext) or the telephone line (Viewdata) and after verification passes it to the Page Store

## (b) Page Store

The page store, of which there may be up to 8 , is the repository for the information to be displayed. It is written into by the Data Acquisition block and read by the Video Generator.

## (c) Video Generator

The Video Generator reads the information in the store, decodes it into a dot pattern and outputs video signals to TV tube. The information to be displayed is chosen by the user via the Controller

## (d) Controller

The Controller (which is a single chıp microcomputer) is primarily the interface between the operator and the system.
Fig. 1 shows a typical complete system broken up into the blocks described.
An important feature to note is the way that each block in the system communicates to the others by means of a 10 bit Address highway and an 8 bit Data Highway The interchange of data is controlled by the signals TS1 and TS2 which are provided by the Video Generator.

## KEY FUNCTIONS

Picture Text-Repeated operation of this key switches the system between Picture and Text modes
Mix-Repeated operation of this key switches the system between Mix and Normal modes. In the Mix Mode Captions, Subtitles and Newsflashes are inset into the picture.
Half Page-Repeated operation of this key cycles the system from Normal to Upper Half Expanded to lower Half Expanded back to Normal. Operation of the P key restores Normal Mode
Store Select-Operating Store Select and Digit 1-8 selects a new store for display (assuming that more than one is provided).
Box Clock-Operation of this key when in Picture Mode causes the Clock to be Boxed into the picture in Double Height Characters. A second operation cancels the command.
Hold-Operation of this key will hold displayed the current one of a set of rotating pages. If more than one store is provided the remainder of the set will be automatically stored in the unselected stores. In Viewdata mode it disconnects the Telephone line.
Reveal-Repeated operation of this key Reveals and Conceals concealed information.
Update (Clear)-Operation of this key removes the information from the display until the page is updated. A second operation restores the display.
Update (Clear)-Operation of $P$ or Store Select also restores the display (In Viewdata mode this key acts as a Clear)
Roll Headers-Operation of this key starts the Teletext headers rolling.

Cursor OFF $\}$ Operation of these keys switch the cursor
Cursor ON $\}$ ON and OFF in Viewdata mode.
Rounding OFF-Operation of this key removes the character rounding and inhibits the flashing of characters. Normally used when printing. Reception of a new page or operation of Cursor ON or OFF restores rounding.
$\underline{P}\left({ }^{*}\right)$ Page No. Key Operation of this key prımes the system to accept a 3 digit page number ( ${ }^{*}$ in Viewdata mode).
$T(\#)$ Time Key. Operation of this key primes the system to accept a 4 digit time code. (// in Viewdata mode).

## INITIALIZATION

At Power Up the page stores are cleared and up to 10 characters of text are inserted in the middle of the page.
For PIC1650A-518 TELEVIEW in White is displayed and Picture mode is selected.
For PIC1650A-532 (IR) TELEVIEW in Yellow is displayed and Picture mode is selected.
For PIC1650A-532 (ASCII) TELEVIEW in Cyan is displayed and Picture mode is selected
Page No. X00 is selected to be stored in store 7 (so that the Teletext indexis immediately avaılable) (Note: alternative initialization can be provided).
For PIC1650A-519 TELEVIEW in Yellow on Blue is displayed. Text mode and Store 1 are selected.
For PIC1650A-533 TELEVIEW in Yellow on Blue is displayed. Text mode and Store 1 are selected.

## PAGE SELECTION

In Teletext mode pages are selected by pressing the $P$ key and entering a page number. Teleview has the ability to accept don't care digits $(-)$ as well as normal digits (0-9). Operation of the Update Key (which has no use at this time) enters the (-) so, if for instance, 1-0 were keyed every tenth page starting at page 100 would be displayed as soon as it was transmitted (approximately at 2 sec intervals).
Operation of the time code Key T terminates the page no entry and fills any unentered page digits as blanks.
The rolling of pages described above can be stopped by pressing Store Select or Hold. If the Hold key is pressed and more than one store is provided subsequent pages will automatıcally be stored. The $P$ key will also stop rolling but the page may be erased.
Page selection may also take place in the Picture mode in which case the page header will be boxed (in double height characters) for 5 seconds after each digit is pressed.


Fig. 1 TELEVIEW BLOCK DIAGRAM



## TELEVIEW Control Chip

## FEATURES

- Interfaces user to Teleview system
- Initializes Teleview system
- PIC1650A-518 $4 \times 4$ Keyboard, Teletext and Viewdata
- PIC1650A-519 $4 \times 4$ Keyboard, Viewdata only, local programing of EAROM
- PIC1650A-532 ASCII or IR remote, Teletext and Viewdata
- PIC1650A-533 ASCII or IR remote, Viewdata only, local programing of EAROM


## DESCRIPTION

The Teleview control chip PIC1650A interfaces the user to the Teleview system and generally organizes the operation of the system.
It is available in several versions each providing alternative user inputs and operating features.

Customized versions can be provided if required.
The features of the various versions are shown in the appendices.

## PIN CONFIGURATION

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {SS }}$ (negative supply) | $\bullet 1$ | 40 | $\mathrm{v}_{\mathrm{xx}}$ (positive supply) |
| AO Address Input/Output |  | 39 | $\mathrm{V}_{\mathrm{D}}$ |
| A1 Address Input/Output | 3 | 38 | $\square-$ |
| A2 Address Input/Output | 4 | 37 | EESET |
|  | 5 | 36 | $\square$ OSC |
| A3 Address Input/Output | 6 | 35 | Clock Output |
| A4 Address Input/Output | 7 | 34 | D7 Data Input/Output |
| A5 Address Input/Output |  | 33 | D6 Data Input/Output |
| A6 Address Input/Output |  | 32 | D5 Data Input/Output |
| A7 Address Input/Output | 10 | 31 | D4 Data Input/Output |
| A8 Address input/Output |  | 30 | D3 Data Input/Output |
| A9 Address Input/Output | 12 | 29 | D2 Data Input/Output |
| Read/Write Output | 13 | 28 | $\square$ D1 Data Input/Output |
| SSO Store Select Output | 14 | 27 | $\square$ Do Data Input/Output |
| SS1 Store Select Output | 15 | 26 | KB7 Keyboard Interface |
| SS2 Store Select Output | 16 | 25 | KB6 Keyboard Interface |
| TS1 Timeslot Input | 17 | 24 | KB5 Keyboard Interface |
| TS2 Timeslot Input |  | 23 | KB4 Keyboard Interface |
| KB0 Keyboard Interface | 19 | 22 | KB3 Keyboard Interface |
| KB1 Keyboard Interface |  | 21 | ] KB2 Keyboard Interface |



PIN FUNCTIONS

| Pin No. | Name | Function |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {SS }}$ | Negative supply (Ground). |
| 2-12 | A0-A9 | Address Input/Outputs which are connected to the Teleview Address Bus. |
| 5 | $\mathrm{V}_{\text {SS }}$ | Test pin - connect to $\mathrm{V}_{\text {SS }}$. |
| 13 | Read/Write | Control output connected to the Teleview R/W input. |
| 14-16 | SS0-SS2 | Store Select outputs. |
| 17, 18 | TS1, TS2 | Time Slot Inputs from Video Generator. |
| 19-26 | KB0-KB7 | Keyboard Interface, may be Inputs, Outputs or Inputs/Outputs depending upon the version. |
| 27-34 | D0-D7 | Data Inputs/Outputs which are connected to the Teleview Data Bus |
| 35 | Clock Output | Not used except to check the Clock frequency (output frequency $f_{x} / 4$ ). |
| 36 | Oscillator | Oscillator resistor and capacitor connected to this pin |
| 37 | $\overline{\text { Reset }}$ | Master reset input which must be kept at ground potential until the $V_{D D}$ power is within specification. |
| 38 |  | Not used. |
| 39 40 | $V_{D D}$ $V_{x X}$ | Positive power supplies +5 V Nom. |

ELECTRICAL CHARACTERISTICS
(See PIC1650A Data Sheet for full specification).


* Exceeding these ratings could cause permanent damage to the device. This is a stress ratıng only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maxımum ratıng conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed

| Characteristic | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Frequency | 0.8 | - | 1 | MHz |  |
| Input Low Voltage | -0.2 | - | 0.8 | V |  |
| Input High Voltage | 2.4 | - | - | V |  |
| Input High Voltage (Reset) | $V_{D D}{ }^{-1}$ | - | - | V |  |
| Input Low Current | -200 | - | -1600 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ |
| Input High Current | -100 | - | - | $\mu \mathrm{A}$ | $\mathrm{V}_{1 \mathrm{H}}=2.4 \mathrm{~V}$ |
| Input Leakage Current (Reset) | -10 | - | 10 | $\mu \mathrm{A}$ |  |
| Output Low Voltage | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Output High Voltage | 2.4 | - | - | v | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}$ |
| Supply Current: IDD $I_{x x}$ | - | - | 55 5 | mA |  |

## APPENDIX 1/PIC1650A-518

This version interfaces with a $4 \times 4$ keyboard and provides basic Teletext/Viewdata operation. It replaces pattern 514.

| INPUT | $4 \times 4$ matrix keyboard |
| :--- | :--- |
| POWER UP MODE | Picture |
| POWER UP DISPLAY | Teleview White |
| POWER UP PAGE | XOO in Store 7 |
| KEYBOARD INTERFACE |  |
| KB0 pin 19 | Row Input/Output |
| KB1 pin 20 | Row Input/Output |
| KB2 pin 21 | Row Input/Output |
| KB3 pin 22 | Row Input/Output |
| KB4 pin 23 | Column Input/Output |
| KB5 pin 24 | Column Input/Output |
| KB6 pin 25 | Column Input/Output |
| KB7 pin 26 | Column Input/Output |

## KEYBOARD CODES

KB0/KB4 7 KB2/KB4 1
KB0/KB5 $8 \quad \mathrm{~KB} 2 / \mathrm{KB} 52$
KB0/KB6 $9 \quad$ KB2/KB6 3
KB0/KB7 Picture/Text KB2/KB7 Reveal/Conceal
KB1/KB4 4 KB3/KB4 Page/*
KB1/KB5 $5 \quad$ KB3/KB5 0
KB1/KB6 6 KB3/KB6 Time/\#
KB1/KB7 Update KB3/KB7 Store Select

## NOTES:

1. Details of the operating features are contained in the general Teleview documents.
2. Two double key operations are recognized:
(a) Store Select 9 is equivalent to Box Clock.
(b) Store Select 0 is equivalent to Hold.

## APPENDIX 2/PIC1650A-532

This version interfaces either with an ASCII return to zero keyboard or with an AY-3-8475 remote control receiver. It replaces pattern 516



Binary Code Key Meaning
MSB LSB
$1101100 \quad 1$
11011012
$1101110 \quad 3$
1101111 Reveal/Conceal
1110000 Page (or*in Viewdata)
11100010
1110010 Time (or \# in Viewdata)
1110011 Update/Clear
1110100 Rounding + Flash Off
1110101 Cursor ON
1110110 Cursor OFF
1110111 Roll Headers

## NOTES:

1. During initialization the PIC1650A-532 decides whether an ASCII keyboard or an AY-3-8475 remote control receiver is being used. If all Keyboard Interface inputs are low an ASCII keyboard is assumed.
(a) ASCII Mode

Return to zero signalling is employed, the KB7 input being used to switch from full ASCII to local Binary.
With KB7 equal to 1 the other 7 bits are read as standard ASCII. (Note this input must be pulsed with the other bits).
With KB7 equal to ' 0 ' the other 7 bits are read as binary with meanings detailed above.

## (b) Remote Mode

In this case the same binary codes are used but an acknowledgement routine is performed by the PIC1650A-532. See AY-3-8475 data sheet for details.
The connections between the PIC1650A-532 and the AY-3-8475 are made as follows:
PIC1650A-532 AY-3-8475

| KB0 | pin 19 | l/O A pin 14 |  |
| :--- | :--- | :--- | :---: |
| KB1 | pin 20 | I/O B pin 15 |  |
| KB2 | pin 21 | I/O $C$ pin 16 |  |
| KB3 | pin 22 | I/O D pin 17 |  |
| KB4 | pin 23 | I/O E pin 20 |  |
| KB5 | pin 24 | I/O F pin 21 |  |
| KB6 | pin 25 | I/O G pin 22 |  |
| KB7 | pin 26 | Digital Data Control + Data |  |
|  |  | Available (pins 18, 19). |  |

2. The codes should be valid for a minimum of 20 ms . In the ASCII mode if the two key operation SSO is used the Second code $(0)$ should only be valid for a maximum of 120 ms to avoid changing keyboard modes.
3. The double key operations are recognized:
(a) Store Select 9 is equivalent to Roll Headers.
(b) Store Select 0 is equivalent to Reset (Clear Stores)

## APPENDIX 3/PIC1650A-519

This version interfaces with a $4 \times 4$ keyboard and as such may replace pattern 518.
It provides control of Viewdata functions only, together with local programing of Telephone numbers via PIC1650-536.

| INPUT | $4 \times 4$ matrix keyboard |
| :--- | :--- |
| POWER UP MODE | Text (picture mode not available) Cursor off |
| POWER UP DISPLAY | Double height Teleview in yellow on blue |
| POWER UP STORE | Store 1 (binary 000) |
| KEYBOARD INTERFACE |  |
| KBO pin 19 | Row Input/Output |
| KB1 pin 20 | Row Input/Output |
| KB2 pin 21 | Row Input/Output |
| KB3 pin 22 | Row Input/Output |
| KB4 pin 23 | Column Input/Output |
| KB5 pin 24 | Column Input/Output |
| KB6 pin 25 | Column Input/Output |
| KB7 pin 26 | Column Input/Output |
| KEYBOARD CODES |  |
| $0 / 4$ | 7 |
| $0 / 5$ | 8 |
| $0 / 6$ | 9 |

## Operation

(a) Star, Square and digits 0-9 transmitted to line via UAR/T and MODEM. If 536 autodialer fitted then the square key plus digits 1-4 are used to dial.
(b) Hold. If 536 autodialer fitted this key will cause the telephone line to be released while maintaning the display.
(c) Print The two key sequence SS. 9 is used to alternately put the system into MIX mode and back to normal Mix mode enables monochrome video to be generated and removes colored backgrounds. When entering mix mode character rounding and flashing are inhibited until a new page is received (only for AY-3-9735)
(d) Reveal/Conceal Alternately reveals and conceals concealed characters. Reveal mode off when new page received or new store selected
(e) Store select Followed by digits 1-8 will select one of eight possible Stores for display. If 536 autodialer fitted and system in "linkback" mode then local programing of telephone numbers may be enabled by selecting Store zero. SSO will clear screen and digits 1-4 may be pressed to enable the programing of the appropriate telephone number. The numbers entered using digits 0-9 (0 displayed as :), star for access pause (displayed as ,) and square for formatting and space filler (displayed as ?) to complete all 16 digits. SSO followed by Reveal will display all the telephone numbers on the screen.


## APPENDIX 4/PIC1650A-533

This version interfaces either with an ASCII, return to zero keyboard or with an AY-3-8475 remote control receiver and as such may replace pattern 532.
It provides control of Viewdata functions only together with Local Programıng of Telephone numbers via PIC1650-536.
INPUT
POWER UP MODE
POWER UP DISPLAY
POWER UP STORE
KEYBOARD INTERFACE
KBO pin 19
KB1 pin 20 LSB Input
KB2 pin $21 \quad$ LSB Input
KB3 pin 22 LSB Input
KB4 pin 23 LSB Input
KB5 pin 24 LSB Input
KB6 pin $25 \quad$ MSB Input
KB7 pin 26
KEYBOARD CODES
(a) ASCII

Full 7 bit ASCII set
(b) Binary (Local or Remote)

| Binary Code | Key Meaning |
| :--- | :--- |
| 1100000 | Picture/Text |
| 1100001 | Print |
| 1100010 | Half page expansion |
| 1100011 | Store Select |
| 1100100 | 7 |
| 1100101 | 8 |
| 1100110 | 9 |
| 1100111 | (not used) |
| 1101000 | 4 |
| 1101001 | 5 |
| 1101010 | 6 |
| 1101011 | Hold/Disconnect line |
| 1101100 | 1 |
| 1101101 | 2 |
| 1101110 | 3 |
| 1101111 | Reveal/Conceal |
| 1110000 | Star |
| 1110001 | 0 |
| 1110010 | Square |
| 1110011 | Clear (inhibit display) |
| 1110100 | Rounding \& Flashing off |
| 1110101 | Cursor ON |
| 1110110 | Cursor OFF |
| 1110111 | Reset |

Notes 1 and 2 as for pattern 532.
Operation
(a) ASCII codes transmitted directly to line via UAR/T and MODEM. If 536 autodialer fitted, square and digits 1-4 will enable dialing.
(b) Picture/Text. Switches display alternately between picture and text. If 536 autodialer fitted this key will drop the telephone connection
(c) Print. Alternately puts system into MIX mode and back to normal. Mix mode enables monochrome video to be generated and removes colored backgrounds. When entering mix mode character rounding and flashing are inhibited until new page received (only for AY-3-9735).
(d) Store/Select. Followed by digits 1-8 will select one of eight possible Stores for display. If 536 autodialer fitted and system in "linkback" mode then Local Programing of telephone numbers may be enabled by selecting store zero. SSO will clear screen and digits 1-4 may be pressed to enable the programing of the appropriate telephone number. The number is entered using digits 0-9 (0 displayed as:) star for access pause (displayed as;) and square as formatter and space filler (displayed as ?) to complete all 16 digits. SSO followed by Reveal will display all the telephone numbers on the screen.
(e) Hold. If the 536 autodialer is fitted this key will drop the telephone line.
(f) Reveal/Conceal. Will alternately reveal and conceal concealed characters. Initialızed to conceal state for new page or new Store.
(g) Clear. Clears the screen of all text. Display restored by second depression of the key and by reception of a new page.
(h) Rounding and Flashing Off. Character rounding and flashing may be inhibited in AY-3-9735 untıl a new page is received.
(i) Cursor ON/OFF. The cursor may be locally controlled by these codes.
(j) Reset. Simulate the power-on reset. All stores are cleared and initialized to "Teleview"

## TELEVIEW Autodialer/Terminal Identifier

## FEATURES

- Non-volatile storage of 4 telephone numbers of 16 digits
- 10 ips loop disconnect dialing
- Non-volatile storage of Identity Code of 16 digits
- Full remote programing capability
- Optıonal local programing
- Easy connection to Teleview system
- Spare memory locations


## DESCRIPTION

The Autodialer/Terminal identifier is an extension to the TELEVIEW system that is designed to perform the Autodialing function of a Viewdata system, to transmit the terminal identification (ID) code and to allow the remote programing of all the stored numbers.
The system consists of a PIC1650-536 attached to the TELEVIEW address and data highways, an ER1400 EAROM for non-volatile storage of the ID and telephone numbers and relays for controlling the telephone line

## PACKAGES

ER1400

$$
\begin{aligned}
& \text { - } 14 \text { lead DIL plastic } \\
& \text { - } 40 \text { lead DIL }
\end{aligned}
$$

PIC1650-536

## ABSOLUTE MAXIMUM RATINGS

See ER1400 and PIC1650 Data Sheets for detalls.

## ELECTRICAL CHARACTERISTICS

See ER1400 and PIC1650 Data Sheets for details.

## OPERATION

Autodialer - The system responds to inputs via the TELEVIEW keyboard in order to initiate the automatic dialing of the Viewdata telephone numbers. There are 4 stored telephone numbers that may be accessed by 4 keys as described in the Prestel Terminal Specification
Each Telephone number can consist of up to 16 digits including access pauses and formattıng codes.
The system may be operated fully automatically or with manual dialing.

Automatic Dialing - With the system off-line and in the Viewdata mode the initial action is to press the Square (\#) key. The Teleview system will be put in the Text mode and the currently displayed Store will be cleared. The telephone line will be looped and the audio should be switched to a loudspeaker.
Once dialing tone is heard a digit is pressed according to the Viewdata service required.
Digit 1 - will give the Prestel service. (Block 2)
Digit 2 - will give a second number for the Prestel service. (Block 3)
Digit 3 - will give the third number. (Block 6)
Digit 4 - will give the fourth number. (Block 7)
If a digit is not pressed for 30 seconds after the Square (\#) key the line will be released. The digits will be put onto the screen as they are being dialed and if formatting characters had been loaded in the digit store the display will be spaced accordingly.

| PIN CONFIGURATION TV 1650 |  |  |
| :---: | :---: | :---: |
| Top View |  |  |
| $V_{\text {SS }}$ (Ground) ${ }^{\circ}$ | 010 | $\square \mathrm{V}_{\mathrm{xx}}(+91 \mathrm{~V}$ Nom) |
| A0 Address Input/Output $\square_{2}$ | 239 | ] $\mathrm{V}_{\mathrm{DO}}(+5 \mathrm{~V}$ Nom) |
| A1 Address Input/Output 3 | 38 | $\square-$ |
| A2 Address Input/Output 4 | 437 | $\square \overline{\text { Reset }}$ Input |
| $V_{\text {SS }}$ Input/Output $\square^{5}$ | $5 \quad 36$ | $\square$ Oscillator Input |
| A3 Address Input/Output 6 | 635 | $\square$ Clock Output |
| A4 Address Input/Output $\square 7$ | $7 \quad 34$ | $\square$ D7 Data Input/Output |
| A5 Address Input/Output 8 | 833 | D D6 Data Input/Output |
| A6 Address Input/Output $\square 9$ | 932 | $\square$ D5 Data Input/Output |
| A7 Address Input/Output 10 | 1031 | $\square$ D4 Data Input/Output |
| A8 Address Input/Output 11 | 1130 | D3 Data Input/Output |
| A9 Address Input/Output 12 | 1229 | D2 Data Input/Output |
| $\overline{\text { Read/Write Input }} 13$ | 1328 | $\square$ D1 Data Input/Output |
| SS0 Store Select Input/Output 14 | 1427 | $\square$ D0 Data Input/Output |
| SS1 Store Select Input/Output 15 | 1526 | Dial Output (B) |
| SS2 Store Select Input/Output 16 | 1625 | $\square$ Mask Output (C) |
| TS1 Timeslot Inputs/Outputs 17 | 1724 | $\square$ Line Output (A) |
| TS2 Timeslot Inputs/Outputs 18 | 18 23 | ] 14 kHz Clock Output to ER1400 |
| Data Input/Output to ER1400 19 | 1922 | C1 Output to ER1400 |
| C3 Output/Carrier Present $\square 20$ | $20 \quad 21$ | $\square \mathrm{C} 2$ Output to ER1400 |

If a pause had been programed, for access to a further dial tone for example, the system will put a * on the screen and wait for release. To release the access pause the appropriate digit is pressed again and dialing will continue. If the system does not receive a manual release it will continue after a time-out of four seconds
If at the end of dialing the call fails, pressing the Square (\#) key will clear the call and then start again by relooping the line.
When the required incoming carrier tone is received the modem will return its appropriate tone to the Viewdata computer which may then send the first page of data and initiate terminal identification.
If the carrier tone is not received for any reason the line will be released after 30 seconds.
Once a satisfactory connection is made to the Viewdata computer (i.e. carrier is detected), the keypad will revert to normal Viewdata mode and dialing will not be possible.

Manual Dialing - If the required telephone number is not stored within the terminal the call may be made using the normal telephone. The system should start off-line and in the Viewdata mode. The number is dialed using the telephone in the normal way and when dialing is complete the Square (\#) Key is pressed. This will put the system into the Text mode, erase the currenty displayed store and hold the line. The telephone handset is replaced and once the carrier tone is received the procedure is as before.

Connection Release - If at any time the carrier detection logic detects that the carrier is lost the connection will be immediately released.
The connection will also be released when the Teleview system is switched to the Picture or Teletext modes, or if the Hold Key is pressed (if available).


Alternatively the appropriate computer log off procedure may be used.
In all cases the content of the Teleview Stores will remain as they were at the moment of disconnection

Remote Programing - The Teleview highways will be monitored for those special ESC sequence codes that indicate the entry into the Program-Verify mode as described in the Prestel Termınal Specification.
In the Teleview System the Data Acquisition chip receives data from the Viewdata computer and normally loads data to the display store. Any codes, particularly ESC sequences, that it does not use, it puts out onto the Teleview highway system where the remote programing device may receive them.
The basic programıng sequences are as described in the Prestel Specification except that the data for programing the EAROM will initially be put into the display store by the DA chip. The programing device will read the digits from this store and erase them after checking that they are all valid codes. The display will be blanked during programing.

Local Programing - For system security, particularly in the domestic environment, the local programıng of telephone numbers and identity codes is not encouraged.
However, the Teleview system has been designed such that it may "talk to itself" and by doing this and having some additional keys (especially ESC, ENQ, ?, : and ;) a very secure local programing mode is available.
The UAR/T transmit and receive clocks are connected to a single frequency, the output joined to the input and the carrier present input is forced and true. The standard programing sequences may then be input to the system to read out and/or modify the content of the digit store.

Spare Storage - While only the first 7 blocks of storage are defined (as ID code plus 6 telephone numbers) a further 4 blocks are available and may be accessed by the Program/Verify sequences if required. They could, for example, be used to store alternative identity/security codes for private Viewdata systems.

Programing Routine - (The following is an extract from the Prestel Terminal Specification.)
The programing Routine is entered by a 4 character sequence ESC1 ESC2. This puts the termınal into Program-Verify mode (See Fig. 1). The memory is divided into seven 16 character blocks. A skip block command ESC 3 is used to skip through the blocks. Default is block 1 at entry to Program-Verify mode After a number $(0-6)$ of skip block commands, Verify mode may be selected by ENQ, or Program mode may be selected by ESC 4.
Entry of Verify mode shall cause the terminal to transmit down the telephone line the contents of the current block (excluding any space-filling characters) and $75 \mathrm{bit} / \mathrm{s}$ and then revert to normal mode
Program data shall follow ESC 4 using the numbers 0-9 for the Identity Code and the codes given below for telephone numbers. Character $3 / 15$ (?) will be used as a space filling character after valid data characters to make the total number of characters in a block equal to $16.3 / 15$ (?) may also be used between parts of the number to identify "natural" breaks. It may then be displayed as a space if the number is displayed for the user, e.g.:1?618?1111????? displayed as 016181111.
After receiving these 16 characters the termınal reverts to normal mode.

## Dialer Codes

DIALED DIGIT

| 1 | 1 |
| :---: | :---: |
| 2 | 2 |
| 3 | 3 |
| 4 | 4 |
| 5 | 5 |
| 6 | 6 |
| 7 | 7 |
| 8 | 8 |
| 9 | 9 |
| 0 |  |
| PAUSE |  |
| RESERVED | $>$ |
| SPACE FILLER | $?$ |

A delay of at least 5 ms will be present between the last character to be written into the memory and the next attempt to leave Normal mode This is to facilitate the use of slow write/erase memories.
Blocks 1-7 are defined as follows: -

| Block 1 | Identity Number |
| :--- | :--- |
| Block 2 | Telephone Number A |
| Block 3 | Telephone Number B |
| Block 4 | Not used |
| Block 5 | Not used |
| Block 6 | Telephone Number E |
| Block 7 | Telephone Number F |

$A$ and $B$ are the Prestel Computer Center telephone numbers. $E$ and $F$ are the third and fourth choices

Line Interface - (The following is an extract from the Prestel Terminal Specification )

## Physical Termination

The Post Office will install a Jack 96A in customer's premises to access Prestel. The customer Prestel Termınal will require a suitable compatıble plug (e.g Post Office Plug 505)

## DC CONDITIONS

Four sets of DC conditions are specified for the line interface.
(a) The off-line condition (idle state) applies when the terminal is not using the telephone line
(b) The line holding condition applies when the terminal goes on-line, is sending tones to or receiving tones from the line and during inter-digit pauses
(c) The pulsing make condition applies during the make part of a dialed digit pulse.
(d) The pulsing break condition applies during the breakpart of a dialed digit pulse.

|  |  | Plug Points | Resistance | Capacitance |
| :---: | :---: | :---: | :---: | :---: |
| (a) | Off-Line | 2-3 | $>5$ Mohm* <br> <10 ohm <br> $\leqslant 300$ ohm $\ddagger$ | $\leqslant 0.01 \mu \mathrm{~F}$ |
|  | Idle Condition | 1-5 |  |  |
|  | Line | 2-3 |  |  |
|  | Holding |  |  |  |
|  | Condition | 1-5 | $>5 \mathrm{Mohm}$ |  |
| (c) | Pulsıng Make | 2-3 | $\leqslant 50$ ohm |  |
|  |  | 1-5 | $>5 \mathrm{Mohm}$ |  |
| (d) | Pulsing Break | 2-3 | $>5 \mathrm{Mohm}$ |  |
|  |  | 1-5 | $>5$ Mohm * |  |
|  | All times | Any to earth | >5 Mohm* | $\leqslant 0.01 \mu \mathrm{~F}$ |

* Measured at 250 vdc . All conditions to be independent of polarity.
$\ddagger$ Measured with line curents up to 120 mA .
The max dc short circuit available from line is 120 mA .


## AC CONDITIONS

When the terminal is on-line (i.e. line holding condition) it shall present an impedance between 400 and 900 ohms at an angle not greater than 45 degrees for all frequencies between 300 Hz and 3400 Hz between plug points 2 and 3 .

## AUTODIALING

If a loop disconnect autodialer is fitted then the following requirements must be met:

The digit signals shall appear as loop disconnect pulses between Plug Points 2 and 3 at a repetition rate of between 9 and 11 pulses per second. The break period shall be between $63 \%$ and $70 \%$ of the total pulse period (break plus make). The length of the break period condition (d) of each pulse shall be within the limits of 57.2

## PIN FUNCTIONS

| Pin No. | Name | Function |
| :---: | :---: | :---: |
| (A) ER1400 |  |  |
| ( 1 | Data | Input/Output |
| 2 | - |  |
| 3 | $V_{S S}$ | +9.1V supply |
| 4 | $V_{G G}$ | -26V supply |
| 5 | Clock | Input |
| 6 | C1 Input |  |
| 7 | C2 Input | Mode control pins |
| 8 | C3 Input |  |
| (B) PIC1650-635 |  |  |
| 1 | $V_{\text {SS }}$ | Ground |
| 2 | A0 |  |
| 3 | A1 $\}$ | Address Input/Output - connect to TELEVIEW Address Bus |
| 4 | A2 |  |
| 5 | $\mathrm{V}_{\text {SS }}$ |  |
| 6 | A3 |  |
| 7 | A4 |  |
| 8 | A5 |  |
| 9 | A6 $\}$ | Address Input/Output - connect to TELEVIEW Address Bus |
| 10 | A7 |  |
| 11 | A8 |  |
| 12 | A9 |  |
| 13 | $\overline{\text { Read/Write }}$ Input/Output | Control to Page Memory - connect to TELEVIEW R/W line |
| 14 | SSO |  |
| 15 | SS1 $\}$ | Store Select Inputs/Outputs - connect to TELEVIEW SS lines |
| 16 | SS2 |  |
| 17 | TS1 | Time Slot Inputs - connect to TELEVIEW TS lines |
| 18 | $\text { TS2 \} }$ |  |
| 19 | Data Input/Output |  |
| 20 | C3 Output |  |
| 21 | C2 Output | Interface to ER1400 non volatile memory. |
| 22 | C1 Output | Pin 20 doubles as the carrier present input |
| 23 | 14 kHzClock Output |  |
| 24 | Line Output | Output to Line Looping relay |
| 25 | Mask Output | Output to Mask relay |
| 26 | Dial Output | Output to Dialing relay |
| 27 | DO |  |
| 28 | D1 |  |
| 29 | D2 |  |
| 30 | D3 | Data Input/Output - connect to TELEVIEW Data Bus |
| 31 | D4 |  |
| 32 | D5 |  |
| 33 | D6 |  |
| 34 | D7 |  |
| 35 | Clock Output | Monitor point for Clock oscillator. Set frequency to 250 kHz nominal |
| 36 | Oscillator Input | Connect Clock oscillator components to this point |
| 37 | $\overline{\text { Reset Input }}$ | Master reset input connect to corresponding pin on TELEVIEW control PIC1650A |
| 38 | - | No connection |
| 39 | $V_{D D}$ | Positive supply +5 V nom. |
| 40 | $\mathrm{V}_{\mathrm{xx}}$ | Positive supply to output buffers +9.1 V nom. |



Fig. 1 FLOW DIAGRAM FOR PROGRAMING ID AND TELEPHONE NUMBERS
to 77.3 ms and the length of the make period condition (c) between any two break periods shall be within the limits 27.2 to 41.1 ms . For a period of at least 5 ms before and after pulsing condition (c) shall apply.
The digit to be dialed represents the number of break pulses to be sent except that digit 0 represents 10 pulses. Inter digit pauses shall be provided. The duration shall be between 800 and 900 ms . During the pause, conditıon (b) shall apply except during the first and last 5 ms periods when condition (c) shall apply. (Fig. 2 explains this diagramatically).
When the terminal is transferring to the line holding state the high impedance between Plug Points 1 and 5 must not be presented more than 20 ms before the low impedance is presented between Plug Points 2 and 3.

| PIC1650-536 | INSTRUMRAL |
| :---: | :---: |

## APPLICATION

The Autodialer/Terminal Identifier has been designed for easy incorporation into the basic Teleview system. Special care has been taken to ensure that pin connections allow an easy and logical printing circuit layout.
The circuit diagram of the main electronics is shown in Fig. 3 and that of the Line Interface in Fig. 4.
The system has the following power supply requirements:

| +9.1 V | $@$ | 13 mA |  |
| :--- | :--- | ---: | :--- |
| +5 V | $@$ | 140 mA | (Relays) |
| +5 V | $@$ | 55 mA | (Logic) |
| -26 V | $@$ | 8 mA |  |

It may be acceptable to eliminate RLC and substitute two silicon diodes back to back across the modem side of the isolation transformer. This will be subject to approval by the BPO if used in Prestel equipment.


Fig. 2 AUTODIALER PULSES




T1
RLA CLARE CUP-V 10301
RLB CLARE CUP-V 10201
RLC CLARE CUP-V 10001
GD1 CERBERUS UC 90Q
R1 $\quad 100$ OHMS
FS1 250 mA QUICK BLOW, ES4265
C1 $\quad 2 \mu \mathrm{f}$

Fig. 4 TELEVIEW LINE SWITCHING

## 16-Bit Microprocessor

## FEATURES

- 8 program accessible 16 -bit general purpose registers
- 86 basic instructions
- 4 addressing modes: immediate, direct, indirect, relative
- Conditional branching on status word and 16 external conditions
- Unlimited interrupt nesting and priority resolution
- 16-bit logic and 2's complement arithmetic
- Status logic and word: carry, overflow, sign, zero
- Direct memory access (DMA) for high speed data transfer
- 64K memory using single address
- TTL compatible/simple bus structure
- CP1610. $1 \mu$ s cycle time, 2 MHz 2 -phase clock


## DESCRIPTION

The CP1610 is a compatible member of the Series 1600 Microprocessor products family. It is a complete, 16-bit, single chip, high speed MOS-LSI Microprocessor. The Series 1600 family is fabricated with the General Instrument N-Channel Ion-Implant process, insuring high performance with proven reliability and production history. All members of the Series 1600 family are fully compatible with the CP1610.

The Microprocessor has been designed ior high speed data processing and real time applications. Typical applications include programable TV games, home computer systems/ home information centers, programable calculator systems, peripheral controllers, process controllers, intelligent terminals and instruments, data acquisition and digital communications processors, numerical control systems and many general purpose mini-computer applications. The Microprocessor can readily support a variety-of peripheral equipment such as TTY, CRT display, tape reader/punch, A/D \& D/A converter, keyboard,

## PIN CONFIGURATION

## 40 LEAD DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| EBCI 01 | 40 | ] $\overline{\mathrm{PCIT}}$ |
| MSYNC 2 | 39 | GND |
| BC1-3 | 38 | -1 |
| BC2 4 | 37 | - $\mathbf{2}^{2}$ |
| BDIR 5 | 36 | $\mathrm{V}_{\mathrm{DD}}(\stackrel{12 \mathrm{~V}}{ }$ ) |
| D15 6 | 35 | $\mathrm{V}_{s s}(-3 \mathrm{~V})$ |
| D14 | 34 | $\mathrm{V}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| D13 8 | 33 | BDRDY |
| D12 | 32 | STPST |
| D11 10 | 31 | B BUSRQ |
| D10 11 | 30 | HALT |
| D9 12 | 29 | B BUSAK |
| D8 13 | 28 | INTR |
| D0 14 | 27 | INTRM |
| D1 15 | 26 | TCl |
| D7 16 | 25 | ] ebcao |
| D6 17 | 24 | $\square$ ebcal |
| D5 - 18 | 23 | $\square$ EBCA2 |
| D4 - 19 | 22 | EBCA3 |
| 030 | 21 | D2 |

cassette tape, floppy disk, and RS-232C data communication lines.

The CP1610 utilizes third generatıon minicomputer architecture with eight general purpose registers to achieve a versatile, sophisticated microcomputer system. The 16 -bit word enables fast and efficient processing of alphanumeric or byte oriented data. The 16 -bit address capability permits access to 65,536 words in any combination of the program memory, data memory, or peripheral devices. This single address space concept, combined with a powerful instruction set, provides an efficient solution to microcomputer and many minicomputer-based product requirements.


## PROCESSOR SIGNALS

## DATA BUS

## D0-D15

Input/Output/High Impedance
Data 0-15: 16-bit bidirectional bus used to transfer data, addresses, and instructions between the microprocessor, memory, and peripheral devices.

## PROCESSOR CONTROL

## STPST

Input
STOP-STart: Edge-triggered by negative transition; used to control the running condition of the microprocessor.
HALT
Output
HALT: indicates that the microprocessor is in a stopped mode. MSYNC
Input
Master SYNC: Active low input synchronizes the microprocessor to the $\phi 1, \phi 2$ clocks during power-up initialization.
EBCA 0-3
Outputs
External Branch Condition Addresses 0-3: Address for one-of-16 external digital state tests via the BEXT (Branch on EXTernal) instruction.
EBCI
Input
External Branch Condition Input: Return signal from the one-of-16 selection made by EBCA 0-3.

| CP1610 | INSTRUMENA |
| :---: | :---: |

## BUS CONTROL

## BDIR, BC1, BC2

Outputs
Bus DIRection, Bus Controls 1, 2: Bus control signals externally decoded to define the state of bus operations (see State Flow Diagram).
BUSRQ
Input
BUSAK
Output
BUS ReQuest, BUS AcKnowledge: BUSRQ* requests the microprocessor to relinquish control of the bus indefinitely. BUSAK* informs devices that the bus has been released.

## BDRDY

Input
Bus Data ReaDY: causes the microprocessor to "wait" and resynchronize to slow memory and peripheral devices.
INTR , INTRM
INTeRupt, INTeRupt Masked: request the microprocessor to service an interrupt upon completion of current instruction.
TCI
Output
Terminate Current Interrupt: pulse outputted by the microprocessor in response to the TCl instruction.

## PCIT

Input/output
Program Counter Inhibit/Trap: As an input, inhibits incrementation of the Program Counter during the instruction fetch sequence. As an output, generates a pulse during execution of a Software INterrupt (SIN) instruction.

## CP1610 INTERNAL BLOCK DIAGRAM



SIMPLIFIED STATE FLOW DIAGRAM


BUS CONTROL SIGNALS

| BDIR | BC2 | BC1 | Signal |
| :---: | :---: | :---: | :--- |
| 0 | 0 | 0 | NACT |
| 0 | 0 | 1 | ADAR |
| 0 | 1 | 0 | IAB |
| 0 | 1 | 1 | DTB |
| 1 | 0 | 0 | BAR |
| 1 | 0 | 1 | DW |
| 1 | 1 | 0 | DWS |
| 1 | 1 | 1 | INTAK |

## Decoded Function

No ACTion, D0-D15 = high impedance Address Data to Address Register,
D0-D15 = high impedance
Interrupt Address to Bus, D0-D15 = Input
Data To Bus, D0-D15 = Input
Bus to Address Register
Data Write
Data Write Strobe
INTerrupt AcKnowledge

| CP1610 | INSENERAL |
| :---: | :---: |

INSTRUCTION SET (SUMMARY LISTING)


| INSENERAL | CP1610 |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

$\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{CC}}$, GND and all other Input/Output Voltages

Storage Temperature . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Temperature $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

Standard Conditions: (unless otherwise noted)

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functıonal operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed
$V_{D D}=+11 \mathrm{~V} \pm 5 \%, 70 \mathrm{~mA}$ (typ) , 110 mA (max.) $\quad \mathrm{V}_{\mathrm{BB}}=-2.2 \mathrm{~V} \pm 5 \%, 0.2 \mathrm{~mA}$ (typ), 2 mA (max.)
$\mathrm{V}_{\mathrm{cc}}=+5 \mathrm{~V} \pm 5 \%, 12 \mathrm{~mA}($ typ $), 25 \mathrm{~mA}(\max ) \quad$ Operating Temperature $\left(T_{A}\right)=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

| Characteristic | Sym | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Clock Inputs |  |  |  |  |  |  |
| High | $V_{\text {IHC }}$ | 10 | - | $\mathrm{V}_{\text {D }}$ | V |  |
| Low | $V_{\text {IIC }}$ | 0 | - | 06 | V |  |
| Input current | $\mathrm{I}_{\mathrm{C}}$ | - | - | 15 | mA | $\mathrm{V}^{\text {IHC }}$ $=\left(\mathrm{V}_{\mathrm{DD}}-1\right) \mathrm{V}$ |
| Logic Inputs |  |  |  |  |  |  |
| Low | $V_{11}$ | 0 | - | 065 | V |  |
| High (All Lines except BDRDY) | $V_{\text {IH }}$ | 24 | - | Vcl | V |  |
| High (Bus Data Ready Line See Note) | $V_{\text {IHB }}$ | 3 | - | Val | V |  |
| Logic Outputs |  |  |  |  |  |  |
| High | $\mathrm{V}_{\text {OH }}$ | 24 | V.c | - | V | $\mathrm{l}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Low (Data Bus Lines D0-D15) Low (Bus Control Lines, BC1,BC2,BDIR) | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 05 | V | $\mathrm{l}_{\mathrm{OL}}=16 \mathrm{~mA}$ |
|  | $\mathrm{V}_{\mathrm{OI}}$ | - | - | 045 | V | $\mathrm{l}_{\mathrm{ot}}=20 \mathrm{~mA}$ |
| Low (All Others) | $\mathrm{V}_{\text {OI }}$ | - | - | 045 | V | $l_{01}=16 \mathrm{~mA}$ |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Clock Pulse Inputs, $\phi 1$ or $\boldsymbol{\phi} 2$ |  |  |  |  |  |  |
| Pulse Width | ${ }^{\text {t }}$ ¢ $2, \mathrm{t}$ ¢ 2 | 250 |  | - | ns |  |
| Skew ( $\phi 1, \phi 2$ delay) | $\mathrm{t}_{12}, \mathrm{t}^{\prime} 1$ | 0 | - | - | ns |  |
| Clock Period | ${ }^{t} \mathrm{cy}$ | 05 | - | 2 | $\mu \mathrm{S}$ |  |
| Rise \& Fall Times | tr, tf | - | - | 15 | ns |  |
| Master SYNC: |  |  |  |  |  |  |
| Delay from $\phi$ | tms | - | - | 30 | ns |  |
| D0-D15 Bus Signals |  |  |  |  |  |  |
| Output delay from $\phi 1$ (float to output) | ${ }^{\text {t }} \mathrm{BO}$ | - | - | 100 | ns | 1 TTL Load \& 100pF |
| Output delay from $\$ 2$ (output to float) | $t_{\text {bF }}$ | - | 50 | - | ns | $1$ |
| Input setup time before $\phi 1$ | ${ }^{t} \mathrm{Bl}_{1}$ | 0 | - | - | ns |  |
| Input hold time after $\phi 1$ | $t_{B 2}$ | 10 | - | - | ns |  |
| Bus Control Signals BC1,BC2,BDIR |  |  |  |  |  |  |
| Output delay from $\phi 1$ | ${ }^{t} \mathrm{DC}$ | - | - | 100 | ns |  |
| Skew | - | - | - | 30 | ns |  |
| BUSAK Output delay from $\phi 1$ | $t_{B U}$ | - | 150 | - | ns |  |
| TCI Output delay from $\phi 1$ | $t$ то | - | 200 | - | ns |  |
| TCI Pulse Width | ${ }^{\text {tw }}$ | - | 300 | - | ns |  |
| EBCA output delay from BEXT input <br> EBCA wait time for EBCI input | $\begin{aligned} & t_{D E} \\ & t_{A I} \end{aligned}$ | - | - | $\begin{array}{r} 150 \\ 400 \\ \hline \end{array}$ | ns | - |
| CAPACITANCE |  |  |  |  |  | $\begin{aligned} & \mathrm{TA}=+25^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DD}}=+12 \mathrm{~V} ; \mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{BB}}=-3 \mathrm{~V}, \mathrm{t} \phi 1=\mathrm{t} \phi 2=120 \mathrm{~ns} \end{aligned}$ |
| \$1, \$2 Clock Input capacitance | C $\phi 1$, C $\phi 2$ | - | 20 | 30 | pF |  |
| D0-D15 | - | - | 8 | 15 | pF |  |
| All Other | - | - | 5 | 10 | pF |  |

[^16]| CP1610 | INSIRUMERENT |
| :---: | :---: |

## CLOCK AND BUS TIMING



TYPICAL INSTRUCTION SEQUENCE (EXTERNAL BRANCH TIMING)


## TELEVIEW Data Acquisition Chip

## FEATURES

- Processes Teletext and Viewdata input data
- Direct interface with Teleview highways
- Direct interface with standard UAR/T (AY-3-1015D)
- TTL compatible serial Teletext data input
- Full checking of Teletext data including parity, Hamming and data frequency
- "Don't care" digit facility
- Non-used Viewdata control codes made available to control processor
- Addresses up to eight page Stores


## DESCRIPTION

The Data Acquisition chip is one of the set of LSI devices comprising the General Instrument Teleview (Teletext/Viewdata) system. It receives data from a TV signal or Telephone Line via an appropriate interface and processes the data accordingly. Under instruction from a control device, it acquires the requested data and loads it into the correct location in the preselected page store. Control information extracted from the incoming data is provided to the Teleview system.
The device is fabricated in the General Instrument N -channel metal gate MOS process providing direct TTL interfacing, high speed, and good reliability. It is supplied in a 40 lead dual-in-line package.

## PIN CONFIGURATION



## PIN FUNCTIONS

| Pin Number | Name | Function |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {ss }}$ | Negative supply for the device and the reference for all signals and electrical parameters. |
| 2 | TELETEXT/DS INPUT/OUTPUT | When strapped to ground (low level), will process Teletext. In Viewdata it is the data strobe output to the UAR/T (active low). |
| 3-12 | A0 to A9 | 10 address bits connected to the Teleview System Address Bus. As outputs, they are tri-state and active push-pull for high speed Store driving. |
| 13 | Read/Write Output | Read/Write control of the page Stores. The Stores will output data (read) when signal is high. |
| 14-16 | SS0-SS2 Outputs | Three bits of Store Select code enabling one of the eight page Stores. |
| 17 | RSYNC Input/ Output | A low going pulse indicates the start of a Teletext line. The chip will output a low going pulse within a few microseconds to re-synchronize the Data Grabber. |
| 18 | TS2 Input | The second of the two time slot bits which, when true, indicates that the chip may use the Data and address highways. |
| 19-25 | $\overline{\mathrm{RD1}}-\overline{\mathrm{RD7}}$ Inputs | Received Data taken directly from the UAR/T. |
| 26 | Parity Error Input | Parity error signal from the UAR/T. |
| 27-34 | $\overline{\text { D0 }}$ - $\overline{\mathrm{D}}$ | Data I/O's for connection directly to the Teleview Data highway. As output, the active state is low and there is a passive pull-up on chip so that signals on the highway may be 'wire-ored.' |
| 35 | $\overline{\text { RDAV Output }}$ | Low active signal to the UAR/T which will reset data available output. |
| 36 | DAV Input | The Data Available signal from the UAR/T to indicate a character is available at the RD1-RD7 pins. |
| 37 | Teletext Data Input | Serial data input from Data Grabber. TTL compatible. If not used, this input should be held low. |
| 38 | Clock Input | Normally the Teletext clock running at 6.9375 MHz and synchronized to the Teletext data by $\overline{\mathrm{RSYNC}}$. In Viewdata, a 6 MHz clock (as used by the Video generator) may be input here. TTL compatible. |
| 39 | $\mathrm{V}_{\mathrm{cc}}$ | Connected to +5 V . This has a low current requirement and is used mainly for the output drivers. |
| 40 | $V_{D D}$ | Connected to +12 V , the main positive supply for the device. |

## OPERATION

The Data Acquisition (DA) chip takes data from either the TV (Teletext) or telephone line (Viewdata) via the appropriate interface, processes it accordingly to type and user requests, and loads the display data in the correct position in one of eight page Stores.
The processing of Teletext and Viewdata information is described in separate sections as is the interchange of data with the rest of Teleview system.

## TELETEXT

If pin 2 is held low the DA may receive data via the serial Teletext data input.

While TS2 is true the DA will monitor RSYNC and the address highways. If a pulse appears on $\overline{R S Y N C}$ it will process a Teletext data-line. At other times while TS2 is true it will respond to signals on the address highway and interchange data with a Control Device.
While TS2 is false the DA will be inactive.

## TELETEXT DATA RECEPTION

Data is extracted from the TV video signal by an external circuit called the Data Grabber. This circuit provides a serial data signal and a clock to the DA input.

A $0.5 \mu$ s negative pulse generated by the AY-3-9725 Video Generator will appear on the RSYNC line just before the data on a possible Teletext line. This pulse stops the clock in the low state and primes the AY-3-9710 to monitor the Teletext Data Input for clock run-in. The first negative transition restarts the clock which is used as a reference against which to compare the incoming signal. If the frequency is correct the AY-3-9710 outputs a second $\overline{R S Y N C}$ pulse which allows accurate resynchronization of the clock for the rest of the Teletext line. If the frequency clock fails the AY-3-9710 goes back to the idle state waiting for a new $\overline{R S Y N C}$ signal or the Data Interchange time.
After a valid clock run-in has been detected, Teletext data is clocked into a serial-to-parallel converter and Framing Code detector. A time out will cause the DA to go idle, while the detection of Framing Code will byte synchronize the S-P converter and start the DA receiving the Teletext data.
The first two words following the Framing Code have data protected by Hamming Code and the appropriate checks and corrections are performed. If the row address indicates that the data is a Page Header (Row 0) then the following 8 words are also processed by the Hamming Code circuit. If any Hamming Code fails such that it cannot be corrected, then that data line is rejected.
Requests for pages of Teletext data are input to the DA during Data Interchange periods, described later. When a new page is selected the Page and Time store in the DA is loaded with all ' 1 's indicating "don't care" digits. As keys are pressed by the user of the Teleview system, the values are loaded into the DA in the appropriate position
A comparator in the DA compares Magazine, Page and Time digits one at a time às they are received in the data stream with the digits stored. The comparator will give a true output if the digit compares exactly or if the stored digit is all 1 (value 15). Where an incoming digit has a range less than 4 bits, e.g. time hours tens has the range $0-3$ or 2 bits, the unused bits will be made to compare.
Every line of data received is checked for comparison on Magazine number. If this does not compare and the row address indicates that the row is not a Page Header than that row is rejected. If the magazine number does not compare and it is a Page Header then, with the exception of Rolling Headers, it is again rejected.
From the time that the DA is told that the $P$ key has been pressed until the selected page has been captured for the first time, all Page Headers that compare on Magazine number are loaded into the Store except those with the Interrupt Sequence bit (C9) set. This mode of display is referred to as Rolling Headers and pro-
vides an indication to the user that data is being received. During this mode the Magazine Serial bit (C11) will override the Magazine comparison. A page of data may be captured when the page number has been fully entered, i.e. the 3rd digit has been received or the $T$ key has been pressed, and a Page Header is received whose magazine, page and time digits compare with those stored in the DA. That header and all subsequent data lines with correct Magazine number will be stored up to and excluding the next Page Header of correct Magazine number. A 'Page being received' indication will be set at this time for transmission to the Control device.
Whenever a Page Header is received that fully compares the accompanying Control bits, that Header will be stored for subsequent transmission to the Control.
When the content of a data line is ready to be stored, that data is loaded into the appropriate Store as defined by the signal from the Control device. The position in the Store is defined by the Row Address of that data line, the location of the first character being 40 times the Row Address (with the exception of the Page Header which does not have the first 8 characters), with following characters being stored in the next 39 locations of Store.
Each character is checked for odd parity and if the check fails, that character is not written. The write signal is removed to avoid overwriting a possible valid character already existing in Store.
The last eight characters of every Page header contain the current clock time and are always written to Store.

## VIEWDATA

With pin 2 connected to the Data Strobe input to a UAR/T and not held to ground the DA will process Viewdata.
While TS2 is true the DA is active as far as the Teleview highways are concerned and it will monitor RSYNC and the Address highway.
When an RSYNC pulse appears the DA will process any Viewdata character it has available. Whenever it is not processing characters it may receive characters asynchronously from the Telephone Line, via the exclusive connection to the UAR/T, and store them within the DA. Up to three characters may be received and stored before the next processing period when they may be loaded into the page Store. Data interchange with the Teleview system may occur when TS2 is high.

## ASYNCHRONOUS DATA RECEPTION

The standard UAR/T will convert the serial data via the modem to parallel data for inputting to the DA and indicate a character is ready by the Data Available (DAV) line. At any time, except when actually processing previously received characters, the DA will read the data and acknowledge on $\overline{\operatorname{RDAV}}$, a minimum of $3 \mu$ s after the DAV signal.

## VIEWDATA CHARACTER PROCESSING

The eight bit input consists of seven bits of data plus a parity fail indication. Characters intended for storage are loaded into the Store in a location determined by the Character Address counter which is always arranged to point to the position in Store into which the next character will be written. The counter is manipulated by the Control Characters appearing in Columns 0 and 1 in the character table.

0/ 8, Back Space, will cause the Character Address counter to be decremented by one.
0/ 9, Horizontal Tab, will cause the Character Address counter to be incremented by one.
$0 / 10$, Line Feed, will increment by 40.
$0 / 11$, Vertical Tab, will decrement by 40.
$0 / 12$, Form Feed, will reset to zero.
0/13, Carriage Return, will position the Character Address counter to the beginning of the current block of 40.
$0 / 14$, Cursor Home, will reset to zero.


A character in columns 2-7 will be written into the appropriate Store at the location indicated by the Character Address counter which will then be incremented by one.
The ESC character (1/11) will cause some modification of the subsequent character as follows:

If the character is in columns 4 or 5 it will be written to Store with the most significant bit changed to Zero.
If the character is in column 3 it will not be written to Store but made ready for transmitting to the Control device.
Any other characters, except NUL, will cancel the ESC sequence and be ignored.
The Form Feed character (0/12) will cause the F bit to be set in the appropriate DA to Control signalling word.
All other control characters in columns 0 and 1 , except NUL, will be sent to the Control at the appropriate time.
If any character has the parity fail indication set then the character $7 / 15$ will be written to Store. At the start of a processing period (i.e. at $\overline{\text { RSYNC }}$ ) if a character is available for processing then the DA will erase the Cursor bit by reading the location pointed to by the Character Address counter and re-write it. Since the DA never writes the 8th bit in the Store the cursor will be removed.

## DATA INTERCHANGE

During the DA's active period, indicated by TS2, when it is not performing any data processing then it will monitor the Address highway for the following codes:
1111XXXXOX indicates the DA should receive data from the data highway.
1111XXXXXO indicates that the DA should send data to the data highway.
1111X0XXXX indicates that the DA should provide control to the UAR/T.
In the Receive mode the Control device may send data according to the codes in Table 1. The most significant bit of the data acts as a strobe which will cause the other 7 bits to be received and stored in the DA. Magazine, Page and Time digits will be stored in the appropriate location in the digit store, the Store Select number will be stored for use when accessing the Store and the indications of $P$ and $T$ keys being processed will also be latched for use in the processing period.
The receiving of data from the Control is completely asynchronous to the DA internal clock and is controlled entirely by the Strobe bit.
The Send mode will cause the DA to apply the first code, shown in Table 2, to the data highway. When the code has been read by Control, the signal will be acknowledged by Control forcing all 1's (low levels) which will step the DA onto the second word and so on. The Strobe bit is used in this case to indicate that the data is appearing for the first time and, once read by Control, is cleared until new data is available. The exception is the first word which always has the Strobe set.
The UAR/T control is recognized by the DA since it has the UAR/T connections and in this mode a Strobe on the data highway will cause the DA to provide a data strobe $\overline{\mathrm{DS}}$ to the UAR/T.
During the Data Interchange period the DA will monitor the Store Select lines and if they are all taken low it will output the current content of the Character Address counter to the address highway so that the Control may know where to insert the cursor.

Table 1 CONTROL TO DATA ACQUISITION SIGNALING
Active low signaling, most significant bit is a strobe.


Where Kk is key identification:

| P | 0 |
| :--- | :--- |
| T | 0 |
| Spare 1 | 0 |
| Spare 2 | 1 |

Sss is store select number, 000 to 111.
Dddd, Digit key value, initially values 0-9 and 15 used although any value may be sent. For Teletext the Magazine range is $0-7$, Time hours tens range $0-3$, Time minutes tens range $0-7$. In addition digit 15 is recognized by the DA as a 'don't care' digit causing automatic comparison.

## Table 2 DATA ACQUISITION TO CONTROL SIGNALING

Active low signaling, most significant bit is a strobe. Signals acknowledged by the Control forcing all ones Control word 1 is sent first and is always sent.

| Control word 1 | $1000 \quad$ T S S $\quad$ s |  |
| :--- | :--- | :--- |
| Where T |  | is the Teletext bit, $1=$ Teletext. |
| Ssss | is the Store Select number the |  |
|  | DA is currently using. |  |

Control words 2-4 depend on whether Teletext or Viewdata is being processed.

## TELETEXT

| Control word | 2 | 1001 | PBR | C4 | C6 | C5 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 3 | 1010 | C10 | C9 | C8 | C7 |
|  | 4 | 1011 | C14 | C13 | C12 | C11 |

Sent ${ }^{*}$ only when Valid Header received. PBR is set while a page is being received. C 4 to C 14 are the Teletext Control bits.

## VIEWDATA

| Control word | 2 | 1001 | X | $F$ | 0 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 3 | 1010 | b7 | 0 | b6 | b5 |
|  | 4 | 1011 | b4 | b3 | b2 | b1 |

Sent* only when a Control character received by DA. F is set when Form Feed character processed. b1-b7 are the 7 bits comprising the Viewdata Character.
NOTE: * 'Sent' means the Strobe bit is set. The other seven bits are put onto the highway at the request of the Control and may be used if appropriate (e.g. page being received).

AY-3-9710

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{ss}} . \ldots . . . . . . . . . . . . \quad-0.3 \mathrm{~V}$ to +15 V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
Supply Voltages: $\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (substrate voltage)

$$
\begin{aligned}
& V_{C C}=+5 V \pm 5 \% \\
& V_{D D}=+12 V \pm 10 \%
\end{aligned}
$$

Temperature Range: $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability Data labeled "typical" is presented for design guidance only and is not guaranteed

| Characteristics | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OUTPUTS <br> Address Outputs (tri-state) |  |  |  |  |  |
|  |  |  |  |  |  |
| High level | +2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\text {OH }}=-320 \mu \mathrm{~A}$ |
| Low level | - | +0.2 | +0.45 | v | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Capacitance | - | - | 15 | pf | $\mathrm{V}=0 \mathrm{~V}$ |
| T rise, $T$ fall | - | - | 200 | ns | $C_{\text {LOAD }}=100 \mathrm{pf}$ |
| Leakage, high impedance state | - | - | 5 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ or +5 V |
| Data Outputs (passive pull-up) |  |  |  |  |  |
| High Level | +2.4 | - | $\mathrm{V}_{\text {cc }}$ | V | $\mathrm{I}_{\mathrm{OH}}=-1.5 \mathrm{~mA}$ |
| Low Level | - | +0.2 | +0.45 | V | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Capacitance | - | - | 15 | pf | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ |
| R/W and Store Select Outputs |  |  |  |  |  |
| High Level | +2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-320 \mu \mathrm{~A}$ |
| Low Level | - | +0.2 | +0.45 | v | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Capacitance | - | - | 15 | pf | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ |
| Current sourced, 'off' state | 1.2 | - | 2.6 | mA | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ |
| TVDV and $\overline{\text { DS Outputs }}$ |  |  |  |  |  |
| High Level | +2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-25 \mu \mathrm{~A}$ |
| Low Level | - | +0.2 | +0.45 | V | $\mathrm{I}_{\mathrm{OL}}=100 \mu \mathrm{~A}$ |
| Capacitance | - | - | 15 | pf | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ |
| ESYNC Output (Open Drain) |  |  |  |  |  |
| Low Level | - | +0.2 | +0.45 | V | $\mathrm{I}_{\mathrm{OL}}=4 \mathrm{~mA}$ |
| Leakage, output off | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=+12 \mathrm{~V}$ |
| INPUTS (except Clock and Teletext Data) |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\mathrm{ss}}$ | - | +0.8 | V |  |
| Leakage (except I/O's) | Ss | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}=+12 \mathrm{~V}$ |
| Input Capacitance | - | - | 15 | pf | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ |
| DAV Input | - | 20 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=+5 \mathrm{~V}$ |
| Clock and Teletext Data Inputs |  |  |  |  |  |
| High Level | 2.8 | - | $V_{\text {D }}$ | - V |  |
| Low Level | $\mathrm{V}_{\mathrm{ss}}$ | - | 0.4 | V |  |
| Capacitance | - | - | 20 | pf | $\mathrm{V}_{1 \mathrm{~N}}=0 \mathrm{~V}$ |
| Leakage | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=+12 \mathrm{~V}$ |
| Frequency | 1.0 | - | 7.5 | MHz |  |
| Power |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ Supply Current | - | - | 15 | mA | $\mathrm{V}_{\mathrm{CC}}=+5.0 \mathrm{~V}$ |
| $V_{D D}$ Supply Current | - | - | 65 | mA | $\mathrm{V}_{\mathrm{DD}}=+12 \mathrm{~V}\left(\right.$ at $\left.25^{\circ} \mathrm{C}\right)$ |

## TELEVIEW 625 Line Interlace/Non Interlace Video Generator

## FEATURES

- Interlaced 625 line or non-interlaced 313 line operation
- 24 row x 40 character display
- Character Set options available
- On and Off Hours operation
- Half Page Expansion
- Boxed Clock and Header on Teletext
- Direct interfacing with the TELEVIEW busses
- Provides master timing signals for other TELEVIEW chips to indicate status of the display scan
- Address up to eight Page Stores
- Provides address information to scan allocated Page Store
- Provides composite synchronizing signals for receiver for 'Off-Hours' working
- Provides comprehensive set of display facilities
- Allows Teletext reception on lines 7-22


## DESCRIPTION

The Video Generator Chip is one of a set of LSI chips used in the General Instrument TELEVIEW (Teletext/Viewdata) system. It reads the contents of a Page Store and generates outputs suitable for driving a normal 625 line Color Television receiver to display the contents of the Page Store.
The chip also monitors the composite synchronizing signals within the receiver and locks the total TELEVIEW system onto the incoming interlaced signals. When no transmission is taking place, the chip generates an interlaced or non-Interlaced composite sync signal which is used to synchronize the receiver.
A full set of color display facilities as described in the Broadcast Teletext Specification (September 1976) is provided by the device.
The device is fabricated in the General Instrument N-Channel, metal gate, MOS process providıng direct TTL interfacıng, high speed, and good reliability.

## DISPLAY FACILITIES

1 Provides the following display facilities controlled by Control characters read from the store i.e. via the TELETEXT/VIEWDATA transmission.
a. Alpha-numerics/Graphics in seven color set
b Color or black backgrounds.
c Selected characters may be concealed
d Selected characters may be flashed
e. Characters may be boxed into the normal Television Picture. This can be done manually or automatically.
f. Characters may be either single or double height.

PIN CONFIGURATION

|  | Top View |  |
| :---: | :---: | :---: |
| Earth ( $\mathrm{V}_{\text {ss }}$ ) | $\bullet 1040$ | ar $+12 \mathrm{~V}\left(\mathrm{v}_{\text {DO }}\right)$ |
|  | 239 | - $+5 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{cc}}\right)$ |
| ${ }^{\text {a }} \mathrm{Cl}^{3}$ | $3 \quad 38$ | 8 clock input |
| A1 ${ }^{4}$ | $4 \quad 37$ | 7 Teletext Data Inp |
| A2 5 | $5 \quad 36$ | 6 dav input |
| A3 ${ }^{6}$ | $6 \quad 35$ | 5 RDAV Output |
| A4 ${ }^{7}$ | $7 \quad 34$ | 4 - $\overline{\mathrm{D7}}$ |
| A5 $\mathrm{C}^{8}$ | $8 \quad 33$ | 3 - $\overline{6}$ |
| A6 ${ }^{\text {a }}$ | 932 | 2 曰 $\overline{\text { D }}$ |
| ${ }^{\text {A }}$ 7 1 | 1031 | 1 - $\overline{04}$ |
| A8 | $11 \quad 30$ | $0{ }^{\overline{D 3}}$ |
| A9 - | $12 \quad 29$ | $9{ }^{\text {D } 2}$ |
| Read/Write Output | $13 \quad 28$ | 87 |
| SSO Output | $14 \quad 27$ | 7 日 $\overline{\text { Do }}$ |
| SS1 Output | $15 \quad 26$ | 6 Parity Error Input |
| SS2 Output | $16 \quad 25$ | 5 RD7 Input |
| $\overline{\text { RSYNC }}$ input/Output 17 | $17 \quad 24$ | $4 \mathrm{RD6}$ Input |
| TS2 Input | $18 \quad 23$ | 3 RD5 Input |
| RD1 Input | $19 \quad 22$ | $2 \mathrm{RD4} 4$ Input |
| RD2 Input | $20 \quad 21$ | 1 P RD3 Input |

g. Graphics characters may be contıguous or separated.
$h$ Graphics characters may be held during other control characters
i Special graphics for high resolution applicatıons.
2 Provides the following display facilities controlled from the user's keyboard/keypad via the control chip.
a. Switch between normal and data video
b Teletext or Viewdata Operation.
c. Clock time can be boxed into a normal picture (Teletext only).
d. Display of one half page in double height.
e. Monochrome output of data Mix Mode.
f. Inhibiting of character rounding and flashing.
g. Enabling of a cursor
h. Inhibit the display until updated.
i. Reveal concealed characters.

## CHARACTER SETS

| Englısh | AY-3-9735-002 |
| :--- | :--- |
| German | AY-3-9735-003 |
| Finnısh/Swedish | AY-3-9735-004 |
| Italian | AY-3-9735-006 |



PIN FUNCTIONS

| Pin Number | Name | Function |
| :---: | :---: | :---: |
| 1 | $\mathrm{V}_{\text {SS }}$ | This is the negative supply for the chip and is used as a reference for all electrical parameters. |
| 2 | $\overline{\text { Chip Select }}$ Input | The chip can be put in its deselected state by connecting this input to $\mathrm{V}_{\mathrm{cc}}$. The input has an internal pull down to $\mathrm{V}_{\mathrm{SS}}$. If connected to $\mathrm{V}_{\mathrm{DD}}$ the test mode is selected. |
| 3-12 | A0-A9 | These pins are connected to the Address Bus of the TELEVIEW system. They are used for address Input/Output. |
| 13 | Read//Write Output | This output is used to drive the Random Access Memories forming the Page Memory. |
| 14-16 | SS0-SS2 Outputs | These binary coded outputs are used to select the required Page Store. |
| 17,18 | TS1, TS2 Outputs | These outputs are generated by the Video Generator from the status of the raster scan and are used to indicate this status to other chips within the TELEVIEW system. |
| 19,20 | $19.2 \mathrm{KHz} \text { and } 1.2 \mathrm{KHz}$ Outputs | These outputs provide 19.2 KHz and 1.2 KHz square wave signals which are used by the UAR/T as reception and transmission clocks respectively. |
| 21 | 6 MHz Input | This input is fed from a 6 MHz oscillator which is phase locked to the normal transmission for Teletext On Hours operation. During Off Hours working a free running crystal oscillator is normally used. |
| 22 | $\overline{\text { RSYNC Output }}$ | Open-drain output, used to indicate the presence of Teletext lines to the DA Chip and Data Grabber. |
| 23-25 | Red, Green and Blue Outputs | Push-pull outputs which go high to turn on the relevant color gun for displaying. These outputs are closely matched for propagation delay and rise and fall times. |
| 26 | Picture//Text Output | This output may be used by the TV receiver to determine whether to display the normal TV Picture or the generated Text as provided at the Red, Green and Blue outputs. In the mix mode this generates monochrome video. It will then be matched to the gun outputs for propagation delay and rise and fall times. |
| 27-34 | $\overline{\mathrm{D} 0}-\overline{\mathrm{D7}}$ Inputs | The Data Inputs form the communication highway between the Video Generator and the Control Processor and Page Memory. |
| 35 | Phase Comparator Output/Interlace Select Input | In On Hours operation the display Line Flyback signal is compared for phase with an internal $64 \mu$ s period signal derived from the 6 MHz display clock. The output is a pulse which produces a voltage for controlling the frequency of a 6 MHz display oscillator, thus locking the display to the incoming picture. In Off Hours operation this open-drain output goes high permanently, and thus can be used as an indication of On Hours/Off Hours status. When this output is high the oscillator must run fast and when this output is low the oscillator must run slow. In Off Hours operation, if the Phase Comparator output is held low a 313 line noninterlaced sync is provided at the Composite Sync output. If the Phase Comparator output is pulled high connected to $\mathrm{V}_{\mathrm{CC}}$ via a 4.7 K resistor, interlaced sync will be provided. |
| 36 | Line Flyback Input | The Line Flyback input is a signal from the display deflection circuitry which is used for positioning the display on the TV screen. Line Flyback pulses are positive. If no Line Flyback is provided in Off Hours mode the display will be positioned so that the start of video is approximately $16 \mu \mathrm{~s}$ after the negative edge of line sync. |
| 37 | Comp Sync Output | Open-drain output. In On Hours working or in Picture mode it outputs a regenerated composite sync signal from the composite sync input. In Off Hours working it outputs an internally generated composite sync. |
| 38 | Comp Sync Input | The composite sync input monitors the composite sync/video being received and extracts synchronizing information and On Hours/Off Hours information for the Video Generator. This input must be predominantly high for Off Hours switching. Sync pulses are negative. |
| 39 | $V_{C C}$ | This pin is connected to the +5 V supply. |
| 40 | $V_{D D}$ | This pin is connected to the +12 V supply. |

## CHIP DESCRIPTION

The Video Generator Chip contains the logic and control functions to interrogate a selected TELEVIEW Page Store and display the contained information at the correct period within the raster scan on a normal TV receiver. The chip also generates the master timing signals TS1 and TS2 which indicate the raster status to the Control processor and Data Acquisition chips.

Comp Sync Generator and On Hours Detector - The prime function of this block is to detect negative going sync signals from the incoming mixed sync and to synchronize the TELEVIEW system with the transmitted signal. When the incoming transmission is turned off, (i.e. goes Off Hours), this is recognized by the detector after at least 300 ms of missing sync pulses. An internally generated Composite Sync is then switched to the Composite Sync out pin. Thus the receiver will continue in lock but synchronized to the Video Generator. Similarly if the normal transmission resumes, the fact that external sync pulses are being received is recognized by the Video Generator and the chip will re-synchronize itself with the incoming transmission. Because the Video Generator is aware of the status of the mixed sync at all times the chip can detect frame sync, line sync and even and odd frames. Thus with this information the chip can continuously monitor the current line number. The relevant sections of the line scan are decoded and are indicated externally by the TS1 and TS2 time slot outputs:
a. Writing to RAM. TS10

This occurs during lines 7 to 22 under control of the DA chip.
b. Reading from RAM. TSOO

This occurs under control of the Video Generator chip between lines 48 and 288 , and is when the display is active.
c. Data Interchange Period. TS11

The interchange of information between DA, Control Processor and Video Generator occurs during this period (lines 23-47).
d. Spare TSO1

During lines 289-006 the Video Generator does not use the Data Bus.
As the chip is aware of the raster status it also starts and stops the address counter/latch combination which is used to scan the relevant Page Memory.

Character Counter and Address Logic - The address counter is a binary counter which is incremented at the Character Display Rate ( 1 MHz ). It can also be loaded from a latch which contains the start address of each character row. Since each character consists of 10 vertical lines of raster scan, the counter is incremented 40 times from a start address and then is reloaded with the same start address ready for the next raster scan of the same forty characters. This occurs nine times. On the last line the counter is incremented once and this new address is stored in the latch. This address being the start address of the next row of forty characters. The above sequence is then repeated.
If displaying only one half of a page with all characters in double height, the Video Generator scans the same forty addresses nineteen times and stores the new address on the twentieth raster scan. If it is in the bottom half of the page, the address counter is initialized to 480 .
The display format of 40 characters, each $1 \mu \mathrm{~s}$ wide occurs on a line of $64 \mu \mathrm{~s}$ duration thus leaving a border of $12 \mu \mathrm{~s}$ at each end of the character row. This address counter is actually started some $4 \mu \mathrm{~s}$ before the start of the proper character display thus allowing time for address generation, RAM access time, ROM access time and display processing, these actions being pipelined. Facilities are also provided such that the output address can be reduced by 40 thus allowing accessing of the character in the row above. This is a necessary operation for a Double Height display option which will be described later. This facility is inhibited while displaying

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| :---: | :---: |

on half of a page. The address so produced is presented on the address bus and the required Page Memory is activated by the Store Select Outputs. The address drivers are tristate thus allowing easy bus interface, being active for $40 \mu$ s starting $3.5-6 \mu$ s after LFB.

Input Latches and Character Read Only Memory - The data being read from the required Page Memory is placed on the Data Bus and is latched into the Data Bus latches. A total of 450 ns is allowed for the RAM read cycle and thus quite slow Random Access memories may be used. Having been latched by the Video Generator chip the seven bit character is used to address the character Read Only Memory. This memory is organized as 96 characters each of 45 dots ( $5 \times 9$ array).

Data Control Latches (Color Background Control) - Certain characters indicate to the video generator a change in display status. These characters are contained within columns 0 and 1 of the character set and may be used to change character color, background color, height, etc.

Output Logic and Drivers - The output logic reads the character ROM into a six bit parallel to serial shift register. This operation occurs at the left-hand side of the character to be displayed, the data in the register is then shifted out at 6 MHz (character dot-rate) the data bits selecting between character and background information. This information is used to drive the fast Gun output drivers. These outputs are closely matched for propagation delay and rise and fall time to ensure good legibility.

## DATA INTERCHANGE

During the TS11 timeslot the Video Generator can receive information from other devices attached to the TELEVIEW system busses. This is normally used by the control chip to update the control and display latches within the Video Generator. The Video Generator is enabled to receive by putting the address 111XXOXXXX on the address highway (active high).
The latches are updated by the following control words, active low signaling, most significant bit is a strobe.

| Highway Free | 0000 | 0 | 0 | 0 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Control Word 1 | 1000 | T | S | s | s |  |
| Control Word 2 <br> Control Word 3 | 1001 1010 | $x$ | $\mathrm{C}_{4}$ | $\begin{aligned} & \mathrm{C}_{6} \\ & \mathrm{C}_{8} \end{aligned}$ | $\left.\begin{array}{l} C_{5} \\ C_{7} \end{array}\right\}$ | Teletext |
| Control Word 4 | 1011 | $\mathrm{C}_{14}$ | $\mathrm{C}_{13}$ | $\mathrm{C}_{12}$ | $\mathrm{C}_{11}$ |  |
| Control Word 2 | 1001 | X | F | 0 | 0 |  |
| Control Word 3 | 1010 | $\mathrm{b}_{7}$ | 0 | $\mathrm{b}_{6}$ | $\mathrm{b}_{5}$ | Viewdata |
| Control Word 4 | 1011 | $\mathrm{b}_{4}$ | $\mathrm{b}_{3}$ | $\mathrm{b}_{2}$ | $b_{1}$ |  |
| Store Select |  |  |  |  |  |  |
| for Display | 1100 | SP | D | d | d |  |
| Key Data | 1101 | * | P | * | * |  |
| Other Facilities | 1110 | X | BH | M | BC |  |

The Control bits are as follows: -
T TELETEXT Mode i.e. not VIEWDATA
Sss Identification of Store being written
Ddd Identification of Store being displayed
(a) Teletext
$\mathrm{C}_{4} \quad$ Erases rows 1-23 of Store defined by Sss and resets
Reveal if Sss = Ddd
$\mathrm{C}_{5} \quad$ Newsflash
$\mathrm{C}_{6}$ Subtitle
$\mathrm{C}_{7} \quad$ Suppress Header
$\mathrm{C}_{8} \quad$ Update Indicator
$\mathrm{C}_{9} \quad$ No action
$\mathrm{C}_{10} \quad$ Inhibit display
$\mathrm{C}_{11} \quad$ No action
$\mathrm{C}_{12}-\mathrm{C}_{14}$ No action (may be programed to enable and disable the chip)

## Instivinent

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Character Rounding - Characters are normally rounded by adding half dots to smooth diagonals. For normal height characters the extra TV lines made available by interlace are utilized for this and so if in non-interlace mode single height characters cannot be rounded.
Character rounding can be inhibited totally by a signal from Control and in this mode, intended specifically for printers, flashing is also suppressed. Reset by P key or new Viewdata page.

Cursor - The cursor is stored as the 8th bit of the appropriate character in the Data Store. When switched on it is displayed as a bar on the bottom line of the character rectangle flashing between foreground color and black in antiphase to normal flashing characters.

Non Interlaced Operation - When interlaced composite sync is input to the chip it operates in normal Interlaced Mode and regenerates interlaced composite sync.
If there is no incoming sync the chip switches to the OFF hours mode.
If the Phase Comparator output is pulled high, e.g. 4.7 K to $\mathrm{V}_{\mathrm{CC}}$, Interlaced Sync is output. If the Phase Comparator output is held low Non-Interlaced Sync is output and character rounding for single height characters is inhibited.

## SIGNAL DETECTION CRITERIA

(For On Hours Operation)
The Video Generator detection circuitry for incoming sync signals is designed to prevent misoperation in the presence of noise. The criteria for detection is defined below.

Line Sync - The Composite Video Input must be negative for greater than $3 \mu \mathrm{~s}$.

Frame Sync - The Composite Video Input.must be negative for greater than $12 \mu$ s and at least 310 lines (Line Flyback pulses) must have occurred since the previous Frame Sync detection.

Odd Frame Detection - Odd Frame Detection occurs when a Line Flyback pulse falls in a window 12-39 $\mu$ s after frame Sync Detection. This is used to lock the line counter.

On Hours/Off Hours Detection - The incoming line flyback and line sync pulses are compared to determine whether a valid transmission is being received. Lack of coincidences/frame are accumulated and if more than $16 /$ frame occur for a period $350-$ 1000 ms the logic deems that a valid transmission is not being received and the chip switches Off Hours. If however, less than eight occur in any two successive $1 / 2$ frames, the logic deems that a valid Composite Sync is being received and the system goes On Hours.

For the chip to be able to look for synchronism the following phase relationship between Line Flyback and Composite Sync must be satisfied.
(a) Earliest back edge of LFB is $2 \mu$ s after leading edge of line sync.
(b) Latest leading edge of LFB is $2 \mu \mathrm{~s}$ after leading edge of line sync.
(c) Latest back edge of LFB is $12 \mu$ s after leading edge of line sync.
The minimum length of the LFB pulse is $8 \mu \mathrm{~s}$.
6MHz Display Oscillator - The 6MHz display oscillator must run fast in the OFF Hours mode but not so fast that the On/Off Hours detection criteria cannot be satisfied. This sets a maximum offset of +1.5 KHz , the minimum offset is set by lock time criteria and would typically be +0.5 KHz .
The frequency range of the oscillator must extend below the 6.0 MHz nominal frequency. The minimum frequency should be at least -0.5 KHz but can be as low as convenient.

## COMPOSITE SYNC INPUT

On-chip dc restore is provided which allows simple interfacing to the television, either Composite Sync signals or video being acceptable.
As the Composite Sync/Video signal from the television may not be referenced to the system ground it is ac coupled to the chip. A typical Interface Circuit is:

(b) Viewdata
$\mathrm{b}_{7}-\mathrm{b}_{1} \quad$ Cursor Control Bits
0010001 Cursor ON $\begin{aligned} & \text { O } 0010001 \text { Cursor OFF } \begin{array}{l}\text { The two Control Words that make up } \\ \text { these codes must be transmitted in } \\ \text { numerical order in the same } \\ \text { TS11 timeslot. }\end{array}\end{aligned}$
F Form feed or first appearance, Erases store defined by Sss, resets Reveal if Sss = Ddd
SP Sets Picture/Text to picture (for initialization)
P P Key pressed. Resets Reveal, Half Page Expansion, Newsflash/Subtitle (Auto Box), Suppress header, Inhibit display, Update.
M Mix Mode
BC Box Clock (TELETEXT only)
BH Box Header (TELETEXT only)
The latches are set and reset by the appropriate bit
*** These are coded as follows:
001 Picture/Text Key pressed
010 Reveal/Conceal Key Passed
$011 \quad 1 / 2$ Page Key Pressed (Cycles
Latches toggled by the Full, Top, Bottom, Full, etc)
100 Update/Clear Key pressed appropriate code

101 Rounding and Flashing OFF (Reset by P Key or new VIEWDATA page)
111 Hold (not used by AY-3-9735)

## DISPLAY OPTIONS

Logic is contained on the Video Generator chip to process the Display Modes as described in the Broadcast Teletext Specification. These facilities are outlined below.

Character Set - The chip can display 96 Alphanumeric characters and 64 Graphic shapes which may either be contiguous or separated. The alphanumeric format is determined by a 4320 bit Read Only Memory organized as:

96 (characters) $\times 5$ (dots) $\times 9$ (lines) $=4320$
This can be programed for different character fonts
The graphic shapes are determined directly from the bits of the character code.

Display and Background Color - The characters and the background can be displayed in one of seven colors. In addition the background may be black. This information is stored in two sets of three latches representing character and background colors.

Conceal and Flash - Selected characters can be concealed and optionally revealed by the viewer. Selected characters can be flashed on command. The flashing is controlled by an on-chip flash oscillator. During the flash period or when concealed, only background information is displayed. The flash rate is 1.56 Hz .

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| :---: | :---: |

Boxing - Text or graphics characters can be boxed into a normal video picture. While in Picture mode boxing is automatic if Newsflash or Sub-title and Sss = Ddd. Other boxed characters may be manually revealed by Reveal command.

Double Height - Double height characters are characters contained between the control characters Double Height and Normal Height or end of line. When a Double Height control character is read from the RAM only the top half of the subsequent character is displayed during the 10 raster scans. During the next 10 scan lines 40 is subtracted from the addresses being output on A0-A9 so the same 40 addresses are read from another 10 times. Characters which are not double height are displayed as the background color and the bottom of the double height character is displayed.

Hold Graphics - When this latch is set, any subsequent control characters (except change Double/Normal Height or Change Alpha/Graphics) are displayed as the last graphics character.

Special Graphics - While in Graphics Mode the Special Graphics command will give a special high resolution facility. In this mode there is a one to one correspondence between data bits b1, b2, b3, b4, b5, b7 and the six dots in each horizontal line of a character. This gives a possible graphics resolution of $6 \times 20$ for each character in interlace mode (or $6 \times 10$ if not interlaced).
Box Clock - When box clock is selected in Picture mode and Teletext the last eight characters of the page header are boxed in double height. To ensure that the live clock is displayed the store address is temporarily switched to that defined by Sss. This function is cleared in text mode.

Box Header - When box header is selected in Picture mode and Teletext the page header is boxed in double height (not if bottom half of page selected).

Half-page Operation - This allows either the top or bottom half of a normal Teletext/Viewdata page to be displayed over the whole screen, with each character in double height. This makes the display header easier to read from a distance. Double height characters are ignored in this mode.

Monochrome Output/Mix Mode - In normal operation the Picture/Text Output is used to blank the normal picture information for boxing or displaying a page of text.
In the mix mode this outputs Monochrome text information which is matched to the Gun Output signals in delay and drive. This can be used to superimpose text onto a picture by cutting away the picture below text data or as an output for Monochrome displays or printers. In this mode colored backgrounds are suppressed for viewing clarity. The output is at a low level to display a character.


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## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{SS}}$. . . . . . . . . . . . . . . -0.3 to +15 V
Storage Temperature Range. ........................... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted):
$\mathrm{V}_{\mathrm{SS}}=0 \mathrm{~V}$ (Substrate voltage)
$V_{\text {CC }}=+5 \mathrm{~V} \pm 5 \%$
$V_{D D}=+12 \mathrm{~V} \pm 10 \%$
Operating Temperature Ranges ( $\mathrm{T}_{\mathrm{A}}$ ): $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Clock Frequency 6.0 MHz

* Exceeding these ratings could cause permanen damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| INPUTS |  |  |  |  |  |
| Chip Select |  |  |  |  |  |
| Input Logic High | 2.2 | - | $\mathrm{V}_{\mathrm{cc}}$ | v |  |
| Input Logic Low | $\mathrm{V}_{\text {ss }}$ | - | 0.8 | V |  |
| Input Current | 10 | 25 | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=5 \mathrm{~V}$ |
| Comp Sync |  |  |  |  |  |
| Input Logic High | 1.0 | - | $\mathrm{V}_{\mathrm{cc}}$ | v |  |
| Input Logic Low | -0.3 | - | 0.05 | v | See Note 1 |
| Input Capacitance | - | - | 15 | pf | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |
| Source Current | - | 50 | - | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |
| 6 MHz |  |  |  |  |  |
| Input Logic High | 2.8 | - | $V_{D D}$ | v |  |
| Input Logic Low | $\mathrm{V}_{\mathrm{ss}}$ | - | 0.4 | V |  |
| Input Capacitance | S | - | 25 | pf | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ |
| Mark to Space Ratio | 40:60 | - | 60:40 |  |  |
| Frequency | 1.0 | - | 6.5 | MHz |  |
| Input Leakage | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=12 \mathrm{~V}$ |
| All Other Inputs |  |  |  |  |  |
| Input Logic High | 2.2 | - | $\mathrm{V}_{\mathrm{DD}}$ | v |  |
| Input Logic Low | $\mathrm{V}_{\mathrm{ss}}$ | - | 0.8 | v |  |
| Input Capacitance | - | - | 15 | pf | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |
| Input Leakage | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=12 \mathrm{~V}$ |
| OUTPUTS <br> Addresses, Read/ $\overline{\text { Write }}$ Store Select (Tri-State) (Note 2) |  |  |  |  |  |
| Logic High Output | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-320 \mu \mathrm{~A}$ |
| Logic Low Output | $\mathrm{V}_{\mathrm{ss}}$ | 0.2 | 0.45 | v | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| Capacitance | Ss | - | 15 | pf | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |
| T rise T fall | - | - | 200 | ns |  |
| Leakage (Disabled) | - | - | 10 | $\mu \mathrm{A}$ | $V_{O}=0 \mathrm{~V}, 5 \mathrm{~V}$ |
| Time Slots (TS1, TS2) (Push Pull) Logic High Output | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | v | $\mathrm{I}_{\mathrm{OH}}=-320 \mu \mathrm{~A}$ |
| Logic Low Output | $\mathrm{V}_{\mathrm{ss}}$ | 0.2 | 0.45 | v | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |
| T rise $T$ fall | - | - | 200 | ns | $\mathrm{C}_{\text {LOAD }}=200 \mathrm{pf}$ |
| Comp Sync (Open Drain) Logic Low Output | $\mathrm{V}_{\mathrm{ss}}$ | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |
| Logic High Leakage | Ss | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{O}}=12 \mathrm{~V}$ |
| Capacitance | - | - | 20 | pf | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ |
| Delay from Comp. Sync In. | - | - | 1 | $\mu \mathrm{s}$ | ON Hours only |
| RSYNC (Open Drain) |  |  |  |  |  |
| Logic Low Output | $\mathrm{V}_{\mathrm{ss}}$ | - | 0.45 |  | $\mathrm{I}_{\mathrm{OL}}=4.0 \mathrm{~mA}$ |
| Logic High Leakage | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{O}}=5 \mathrm{~V}$ |
| Capacitance | - | - | 15 | pf | $\mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ |
| Phase Comparator (Open Drain) |  |  |  |  |  |
| Logic Low Output | $\mathrm{V}_{\mathrm{ss}}$ | - | 0.45 | V | $\mathrm{I}_{\mathrm{OL}}=4.0 \mathrm{~mA}$ |
| Logic High Leakage | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{O}}=12 \mathrm{~V}$ |
| Capacitance | - | - | 15 | pf | $\mathrm{V}_{0}=0 \mathrm{~V}$ |

[^17]| Characteristics | Min | Typ** | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| R.G.B. Outputs Picture/Text Output (Tri-state) (Note 2) |  |  |  |  |  |
| Logic High Output | $\mathrm{V}_{\mathrm{CC}}{ }^{-1}$ | - | $\mathrm{v}_{\mathrm{cc}}$ | v | $\mathrm{I}_{\text {SOURCE }}=2 \mathrm{~mA}$ |
| Logic Low Output | $\mathrm{V}_{\mathrm{ss}}$ | - | 1 | V | $\mathrm{I}_{\text {SINK }}=5 \mathrm{~mA}$ |
| Capacitance | ss | - | 20 | pf | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ |
| T rise T fall (10\%-90\%) | - | - | 30 | ns | $\mathrm{C}_{\mathrm{L}}=30 \mathrm{pf}$ |
| Differential T rise T fall | - | - | 30 | ns | $\mathrm{C}_{\mathrm{L}}=30 \mathrm{pf}$ (Note 3) |
| Leakage (Disabled) | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ |
| $19.2 \mathrm{kHz}, 1.2 \mathrm{kHz}$ Outputs |  |  |  |  |  |
| Logic High Output | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | V | $\mathrm{I}_{\mathrm{OH}}=-32 \mu \mathrm{~A}$ |
| Logic Low Output | $\mathrm{V}_{\mathrm{ss}}$ | 02 | 0.45 | V | $\mathrm{I}_{\text {OL }}=320 \mu \mathrm{~A}$ |
| T rise T fall | - | - | 1 | $\mu \mathrm{s}$ | $C_{\text {LOAD }}=100 \mathrm{pf}$ |
| POWER |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ Supply | - | 25 | 40 | mA | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ |
| $V_{D D}$ Supply | - | 50 | 80 | mA | $\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}$ |

[^18]NOTES:

1. Voltages below -0.3 volts should be current limited to 1 mA .
2. All tristated when Chip Select $=V_{C C}$ R.G.B. outputs also tristated when displaying picture and not mixed.
3. Picture $/ \overline{\text { Text }}$ matched in mix mode only.

## GENERAL INSTRUMENT

## Video Graphics

|  |  |  |  |
| :---: | :---: | :---: | :---: |
|  | The 8000 systim is a programable yicoo fisplay system capable of detaller graphics. dellifilon and manipuration |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |
|  |  | W0-3s9504 |  |
|  |  | SAY 38010 |  |
|  |  |  |  |
|  |  | Ars-6913: |  |
|  |  |  |  |

## 8900 Programable Game System

## FEATURES

- Infinite game selection
- Lowest cost expandable system
- Uses programable Read Only Memories with 16K and 20K Storage (RO-3-9502, RO-3-9503, and RO-3-9504)
- Eight color selectable, coordinate addressable game objects
- Resident library of 256 complex game objects, including full 64 character alpha numerics
- Shape library extendable by a further 256 objects using graphics RAM.
- Full multicolor background capability
- Sixteen selectable color tones
- Program controllable moving background
- Two hundred and forty independently programable background locations


## DESCRIPTION

The 8900 system is based on two processors; one computes the game action against the stored program rules; and the second interprets a condensed memory area and uses this to generate the T.V. raster display. The second processor fetches moving and background pictures from the graphic picture storage and presents the data as a video output.
The set consists of five General Instrument supplied N-Channel circuits. The AY-3-8900 Standard Television Interface Circuit (STIC); the CP1610 GIMINI Microprocessor; an RO-3-9502 20K program ROM; a similar RO-3-9503 graphics picture ROM and an RA-3-9600 RAM. To complete the system the user supplies clocking and modulation circuitry plus any other peripheral control requirements. Other circuits may be optionally added to expand the system capabilities. They are the AY-3-8910 Sound Generator, the RO-3-9504 ROMs, and Standard RAM devices.


## Standard Television Interface Chip

## FEATURES

- Outputs include coded signal timings for CCIR or NTSC compatible video signal generation AY-3-8900 for CCIR, AY-3-8900-1 for NTSC
- Operation from a 4.000 MHz clock for AY-3-8900 and from a 3.579545 MHz clock for AY-3-8900-1
- 8 coordinate addressable foreground objects on a grid of 168 H by 104 V for AY-3-8900 or 167 H by 105 V for AY-3-8900-1 of which $159 \times 96$ are visible positions
- Foreground objects independently programable for half height, $y$ zoom, $x$ zoom and 8 or 16 character lines high
- Selectable background display on a matrix of $20 \mathrm{H} \times 12 \mathrm{~V}$ using $8 \times 8$ picture elements
- Capable of accepting data, address and graphics information on common multiplexed bus
- 16 digitally selectable colors


## DESCRIPTION

The AY-3-8900/8900-1 STIC is designed for use within a computer system having an external CPU and an area of ROM and RAM memory. Some of the memory must be dedicated to the support of the graphic character descriptors and patterns.
The display facilities of the circuit are separated into two simultaneously operating modes. The main chip function provides eight coordinate positioned "foreground" objects, which have a number of display options including selection from a choice of sixteen colors. The second mode provides a background display facility, which is composed of a matrix of twelve rows by twenty columns of which 19 are composed of $8 \times 8$ picture elements and the 20th $7 \times 8$ picture elements. The "background" mode utilizes a dedicated area of external memory ( 240 by 14 bit words) to store the character control codes for each display position and both modes require some external memory assigned to the storage of the character patterns. The graphic pattern memory is eight bits wide.
The AY-3-8900/8900-1 operates within the computer system by time sharing a bidirectional 14 bit bus. The demultiplexing and the system synchronization are defined by three sets of control signals.
The main synchronization which operates at the T.V. frame rate uses SR1, SR2 and SR3. The SR1 signal occurs once per frame and it is used to synchronize the CPU algorithms to the intended display sequences. SR1 indicates that STIC time is complete and that the AY-3-8900-1 has switched to the CPU controlled mode. SR2 is issued thirteen or fourteen times per picture frame depending on picture offset. The AY-3-8900/8900-1 takes this signal low to request the first line access for a new row of twenty characters.
The SR3 signal operates in conjunction with SR2 to read the "background" character descriptors out of external memory. The AY-3-8900/8900-1 pulses SR3 positive for each character posi-

tion. Once the first line has been accessed by the SR2, SR3 combination, the following fifteen lines to complete the $8 \times 8$ array are fetched by SR3 alone.
The SR3 signal is also issued during the CPU controlled mode in response to BAR, ADAR or DW to enable an external device onto the 14 bit BUS.

The second control bus is used to specify address, read and write sequences for the area of external memory used to store the graphic character "dot" patterns. The three signals on this BUS are BAR', DTB' and DWS'. The BAR" is output by the AY-3-8900/8900-1 when a valid graphics character address is on the 14 bit BUS. The external memory must latch this address for future read or write operations. The DTB' signal indicates that a "read" is requested and the external memory must place the eight bits of character pattern onto the 14 bit BUS. The DWS' signal indicates that a "write" is requested.
'The graphics control BUS is used during "STIC" time in the fetch of "foreground" object patterns and "background" object patterns. During the non "STIC" time when in the CPU controlled mode, the graphics control BUS can be used to link the memory area containing the graphics patterns to the main memory area of the external microprocessor.
The third control BUS communicates with the external CPU. This BUS comprises signals BC1, BC2 and BDIR. They are coded to signify address, read and write sequences. The CPU control BUS is only validated if the AY-3-8900/8900-1 is in the CPU controlled mode, otherwise it is ignored.

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
Temperature Under Bias

$\qquad$
$0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$

All Input or Output Voltages with Respect to $\mathrm{V}_{\mathrm{BB}} \ldots \ldots . . . \begin{aligned} & -0.2 \mathrm{~V} \text { to }+9.0 \mathrm{~V}\end{aligned}$


Standard Conditions (unless otherwise noted)
$\begin{array}{ll}T_{A}=0^{\circ} \mathrm{C} \text { to }+40^{\circ} \mathrm{C}, & \mathrm{V}_{\mathrm{BB}}=-3.3 \mathrm{~V}, \\ \mathrm{~V}_{\mathrm{CC}}= \pm 4.85 \mathrm{~V}- \pm 5.15 \mathrm{~V}, & \mathrm{~V}_{\mathrm{SS}}=00 \mathrm{~V}\end{array}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Bus Inputs |  |  |  |  |  |  |
| Input Logic Low | $\mathrm{V}_{\mathrm{IL}}$ | 0 | - | 07 | V |  |
| Input Logıc High | $\mathrm{V}_{1+}$ | 2.4 | - | - | V |  |
| Input Current | IL | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{cc}}$ |
| Bus Outputs |  |  |  |  |  |  |
| Output Logic Low | VoL | 0 | - | 05 | v | 1 TTL Load |
| Output Logic High | V OH | 2.4 | - | $V_{c c}$ | $v$ | +100pF |
| Supply Current |  |  |  |  |  |  |
| $V_{\text {cc }}$ Supply | Ico | - | - | 200 | mA | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=+5.25 \mathrm{~V} \\ & @ 40^{\circ} \mathrm{C} \end{aligned}$ |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Clock Input Frequency | fol | - | - | - | MHz | 4.000 for AY-3-8900 <br> 3.579545 for AY-3-8900-1 <br> both externally adjusted |
| Bus Inputs |  |  |  |  |  |  |
| Address Set Up | tas | 200 | - | - | ns |  |
| Address Overlap | tao | 30 | - | - | ns |  |
| Write Set Up | tws | 100 | - | - | ns |  |
| Write Overlap | two | 30 | - | - | ns |  |
| Bus Outputs |  |  |  |  |  |  |
| Turn ON Delay | tda | - | - | 140 | ns | 1 TTL Load |
| Turn OFF Delay | tdo | 0 | - | - | ns | +100pF |



## Program ROM

## FEATURES

- Mask programable storage providing $2048 \times 10$ bit words
- 16 bit on-chip address latch
- Control decoder
- Programable memory map circuitry to place 2 K ROM page within 65 K word memory space located on 2 K page boundaries
- Master logic with programable 16 bit vectored start address
- Interrupt logic with programable 16 bit vectored interrupt address
- 16 bit static address outputs for external memory
- Control signals for external memory:

ENABLE $=(\mathrm{DTB}+\mathrm{DWS})$ Address External $=$ R/E WRITE $=$ DWS. Address External $=R / \bar{W}$

- Programable memory map selection for external memory area
- Bus drive capability, 1 TTL load and 100pF plus tri-state


## CIRCUIT REQUIREMENTS

The RO-3-9502 operates as the program memory for systems using a CP1610 series microprocessor.
It is configured as $2048 \times 10$ bit words and contains several features which reduce the device count in a practical microprocessor application.

## OPERATING DESCRIPTION

The RO-3-9502 is initialized by the MSYNC Input and from the positive edge of this signal, it remains in a tri-state output condition, awaiting the IAB response. During the IAB, the 9502 transmits a 16 bit code onto the external bus thus providing the system start address vector. Tine completion of the MCLR sequence is recorded on chip such that any further IAB Codes output the second interrupt vector. From initialization, the 9502 waits for the first address code. For this address code and all subsequent address sequences, the 9502 reads the 16 bit external bus and latches the value into its address register. The contents of this address register are made available for connection to external memory and are supplied on 16 latched outputs with a drive capability of 1 TTL load and 100pF.
The 9502 contains a programable memory map location for its own 2 K page and if a valid address is detected, the particular addressed location will transfer its contents to the chip output buffers. If the control code following the address cycle was a Read, the 9502 will output the 10 bits of addressed data and also drive a logic zero on the top six bits of the bus.

## PIN CONFIGURATION <br> 40 LEAD DUAL IN LINE

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| $V_{\text {cc }}$ | ${ }^{\bullet 1}$ | 40 | BC1 |
|  | ${ }^{2}$ | 39 | BC2 |
| R/W | ${ }^{3}$ | 38 | $]$ BDIR |
| NC | 4 | 37 | DBo |
| DB15 | 5 | 36 | $\square$ addro |
| NC | $\square^{6}$ | 35 | DB1 |
| DB14 | ${ }^{7}$ | 34 | ADDR1 |
| NC | 8 | 33 | DB2 |
| DB13 | ${ }^{9}$ | 32 | ador2 |
| NC | 10 | 31 | DB3 |
| DB12 | 11 | 30 | ADDR3 |
| NC | 12 | 29 | DB4 |
| DB11 | 13 | 28 | ADDR4 |
| NC |  | 27 | DB5 |
| DB10 | 15 | 26 | ADDR5 |
| ADDR9 |  | 25 | DB6 |
| DB9 | 17 | 24 | ] ADDR6 |
| ADDR8 |  | 23 | DB7 |
| DB8 | 19 | 22 | ADDR7 |
| MSYNC | -20 | 21 | $\mathrm{V}_{\mathrm{ss}}$ |

INPUT CONTROL SIGNALS

| BDIR | BC1 | BC2 | EQUIVALENT <br> SIGNAL | RESPONSE |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | NACT | NACT |
| 0 | 0 | 1 | IAB | IAB |
| 0 | 1 | 0 | ADAR | ADAR |
| 0 | 1 | 1 | DTB | DTB |
| 1 | 0 | 0 | BAR | BAR |
| 1 | 0 | 1 | DWS | - |
| 1 | 1 | 0 | DW | - |
| 1 | 1 | 1 | INTAK | - |

## OPERATION WITH EXTERNAL MEMORY

The 16 bits from the address register are provided as static outputs for connection to external ROM or RAM devices. Two other signals are provided to control the external memory area. An enable signal is provided for any read or write operation, and a write signal, for any move out operation. The two external memory control signals are gated by a min-max memory map comparator. The minimum and maximum values are programable on boundaries within the 65 K word memory area. The memory map comparator for external memory is a simple single compare and the operation is such that when a 2 K area is chosen, a five bit compare is used and for a 4 K area a four bit compare, etc. The effect of this is that 2 K pages may start on 2 K boundaries, i.e., 0,2 , $4,6,8$ etc., but 4 K pages must be on 4 K boundaries, i.e., $0,4,8,12$, etc. The same is true for 8 K and 16 K pages.

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias $\qquad$ $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$ Storage Temperature . ................................... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ All Input or Output Voltages with Respect to $\mathrm{V}_{\mathrm{ss}} \ldots . . . .$.

Standard Conditions (unless otherwise noted)
$\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$

$$
V_{s s}=0.0 \mathrm{~V}
$$

$\mathrm{V}_{\mathrm{cc}}=+4.85 \mathrm{~V}-+5.15 \mathrm{~V}$

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Inputs |  |  |  |  |  |  |
| Input Logic Low | $V_{\text {IL }}$ | 0 | - | 0.7 | volts |  |
| Input Logic High | $\mathrm{V}_{\text {IH }}$ | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | volts |  |
| Input Leakage | VIL | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {cc }}$ |
| CPU BUS Outputs |  |  |  |  |  |  |
| Output Logic Low | Vol | 0 | - | 0.5 | volts | 1 TTL Load |
| Output Logic High | VOH | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | volts | +100pF |
| Address and Enable Outputs |  |  |  |  |  |  |
| Output Logic Low | VoL | 0 | - | 0.5 | volts | 1 TTL Load |
| Output Logic High | Vor | 2.4 | - | $V_{c c}$ | volts | +100pF |
| Supply Current Vcc Supply | $\mathrm{I}_{\mathrm{cc}}$ | - | - | 120 | mA | $V_{\text {cc }}=5.25 \mathrm{~V} @ 40^{\circ} \mathrm{C}$ |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Inputs |  |  |  |  |  |  |
| Address Set Up Address Overlap | tas tao | 300 | $\overline{50}$ | - | ns |  |
| Write Set Up | tws | 300 | - | - | ns |  |
| Write Overlap | two | - | 50 | - | ns |  |
| CPU BUS Outputs <br> Turn ON Delay <br> Turn OFF Delay | tda | - | - | 300 200 | ns | $\begin{aligned} & 1 \text { TTL Load } \\ & +100 \mathrm{pF} \end{aligned}$ |
| Address and Enable Outputs Turn ON Delay | tad,ted | - | - | 200 | ns |  |
| Turn OFF Delay | teo | - | - | 150 | ns |  |
| Turn ON Delay | twd | - | - | 300 | ns |  |
| Turn OFF Delay | two | - | - | 150 | ns |  |

## MEMORY TIMING RO-3-9502



## RO-3-9503

## Graphics ROM

## FEATURES

- Mask programable storage providing $2048 \times 8$ bit words
- 16 bit on-chip address latch
- Memory map circuitry to place the 2 K ROM page within a 65 K memory area
- 8 bit tri-state bus with higher 8 bits driven to zero during read operations
- 11 bit, static address outputs for external memory
- Control signals for external memory:

ENABLE
R/W

- Bus drive capability, 1 TTL load and 100 pf plus tri-state


## OPERATING DESCRIPTION

The device operates in three memory configurations. These configurations are selected via the input control signals.

1. When SR1 has been pulsed negative, the memory is located at 12288 to 14335. The external memory is addressed at 14336 to 16383.
2. When BUSAK has been pulsed negative, the memory is located at 0 to 2047. The external memory is addressed at 2048 to 4095.
3. When BAR' and DWS' are pulsed positive, the memory will not respond to address bit 9 and address bit 10 , which restricts the memory to 512 locations. The memory is now located from 0 to 511 relative to the current memory origin. The external mem-

## PIN CONFIGURATION

40 LEAD DUAL IN LINE
VCC
SR1
ory is also addressable from 0 to 511 relative to its current origin. Configuration three may be released by applying a negative pulse on the SR1 input.

## MEMORY TIMING



MEMORY POSITION RELATIVE TO CONTROL OPERATION


## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias $\qquad$
Storage Temperature
$0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
.... $5^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
All Input or Output Voltages with Respect to $\mathrm{V}_{\mathrm{ss}} \ldots \ldots . . .-0.2 \mathrm{~V}$ to +9.0 V

Standard Conditions (unless otherwise noted)
$T_{A}=0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
$\mathrm{V}_{\mathrm{cc}}=+4.85 \mathrm{~V}-+5.15 \mathrm{~V}$
$\mathrm{V}_{\mathrm{ss}}=0.0 \mathrm{~V}$

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Bus Inputs |  |  |  |  |  |  |
| Input Logic Low | VIL | 0 | - | 07 | Volts |  |
| Input Logic High | $\mathrm{V}_{1}$ | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | Volts |  |
| Input Leakage | IL | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {cc }}$ |
| CPU BUS Outputs |  |  |  |  |  |  |
| Output Logic Low | VoL | 0 | - | 05 | Volts | 1 TTL Load |
| Output Logic High | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | Volts | +100pF |
| Address and Enable Outputs |  |  |  |  |  |  |
| Output Logic Low | VoL | 0 | - | 05 | Volts | 1 TTL Load |
| Output Logic High | Vor | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | Volts | +100pF |
| Supply Current |  |  |  |  |  |  |
| $V_{c c}$ Current | Icc | - | - | 150 | mA | $\mathrm{V}_{\mathrm{cc}}=+5.25 \mathrm{~V} @ 40^{\circ} \mathrm{C}$ |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Bus Inputs |  |  |  |  |  |  |
| Address Set Up | tas | 300 | - | - | ns |  |
| Address Overlap | tao | - | 50 | - | ns |  |
| Write Set Up | tws | 300 | - | - | ns |  |
| Write Overlap | two | - | 50 | - | ns |  |
| CPU BUS Outputs |  |  |  |  |  |  |
| Turn ON Delay | tda |  | - | 300 | ns | 1 TTL Load |
| Turn OFF Delay | tdo | - | - | 200 | ns | +100pF |
| Address and Enable Outputs Turn ON Delay | tad,tes,twd | - | - | 200 |  |  |
| Turn OFF Delay | taa, ted,twd teo | - | - | 100 | ns | +100pF |

All delays measured between 2.2 Volts and 0.7 Volts test points

RA-3-9600

## System RAM

## features

- Memory area 352 words of 16 bits
- Address counter and control logic for D M.A operation
- Control decoder for CPU data control signals
- Memory map comparator and control logic for additional memory on 14 bit bus
- Current line buffer - 20 words of 14 bits
- Drive capability on 16 bit and 14 bit bus for 1 TTL load and 100pf


## FUNCTIONAL DESCRIPTION

The RA-3-9600 is a dual port interface and 16 bit wide RAM storage area The RA- $3-9600$ contaıns twenty 14 bit serial data buffer registers with separate bus control signals
The RA-3-9600 memory is $352 \times 16$ bit contiguous words from address 512-863 with the graphics descriptors using the first 240 words The graphics use only the lower 14 bits of each word leaving the two most significant bits available for user storage

## OPERATION DESCRIPTION

The RA-3-9600 RAM accepts data from the CPU via a 16 bit bi-directional bus which is time multiplexed with address and data A 3 bit control bus from the CPU is used to provide strobe signals for the on-chip address latch and main memory area

The RAM has two operating modes.
Mode 1-On decoding an interrupt the RAM is enabled into a bus copy mode in this mode the RAM copies the lower fourteen bits of the CPU bus onto the graphics bus The direction of copy is always from the CPU and towards the graphics except during a bus reversal condition The reversal condition is indicated when the CPU requests a read from an external graphics address on the 14 bit bus Under this condition the 9600 will turn its 14 bit bus outputs into tri-state and gate the 14 bit bus through to the 16 bit CPU bus

Mode 2-Is selected when the CPU issues $\overline{B U S A K}$ command (DMA request) The effect of $\overline{B U S A K}$ inside the 9600 is to reset the interrupt synchronizing logic and to switch the address decoder from the CPU address register to the graphics address counter This counter, which sequences through the 240 words of graphics data, will have been previously set to zero when the interrupt signal was decoded. When the CPU is in the DMA state, the graphics system will prepare to display a new row of twenty characters and to load the 20 buffer registers within the 9600 For the first cycle of DMA after interrupt the graphics address counter will be at zero and the data at that address is passed to the 14 bit output The action of SR3 will enable the output buffers and drive the 14 bit bus The twenty shift registers are also loaded at this time The negative edge of SR3 tri-states the 14 bit output and

## PIN CONFIGURATION

40 LEAD DUAL IN LINE

| Top View |  |
| :---: | :---: |
| DB6 $\square^{\bullet 1}$ | $40 \square$ SD6 |
| DB7 $\square^{2}$ | 39 SD5 |
| SD7 ${ }^{3}$ | $38 \mathrm{\square}$ DB5 |
| SD8 4 | $37 \mathrm{DB4}$ |
| DB8 5 | 36 SD 4 |
| DB9 -6 | 35 SD 3 |
| SD9 ${ }^{7}$ | $34 \square$ DB3 |
| \$2 -8 | $33 \mathrm{DB2}$ |
| $\mathrm{v}_{\mathrm{cc}} \square^{9}$ | ${ }^{32} \mathrm{SD} 2$ |
| $V_{\text {DO }}{ }^{\text {d }} 10$ | $31 . \mathrm{v}_{\text {s }}$ |
| Vbo 11 | $30 \square$ DB1 |
| BUSAK 12 | $29 \square$ SD1 |
| SR3 13 | 28 SDO |
| BC1 14 | 27 DBO |
| BC2 15 | 26. DB15 |
| BDIR 16 | 25 DB14 |
| DB10 17 | 24. DB13 |
| SD10 18 | 23 SD13 |
| SD11 - 19 | 22 SD 12 |
| DB11 20 | 21 DB12 |

increments the graphics address counter The shift registers are also clocked at this time The SR3 input provides twenty positive pulses to the 9600 and loads the shift register buffers while giving the graphics the first row of characters At the end of the first DMA cycle, after the CPU interrupt, the graphics address counter will be at value 20 The 9600 operation for the next fifteen lines will be to clock the 20 shift registers and gate the contents onto the 14 bit bus under control of the SR3 input. When the CPU is running and BUSAK is a logic 1, the graphics address counter is not incremented and it stays at the value 20. At the end of the first row of characters, the complete DMA operation is repeated and the address counter will be left at 40 This sequence occurs for the 12 rows of characters untll all 240 have been successfully accessed The operation of SR3, INCREMENT/TRI-STATE signal, is to step the shift register sequentially through each of the twenty characters If the $\overline{B U S A K}$ signal is low, i.e., in DMA, it also increments the graphics ADDRESS COUNTER SR3 disables the 14 bit graphics bus during the low period.
At the end of active picture the STIC issues an interrupt request to the CPU The RA-3-9600 tests for the INTAK* response from the CPU and uses this signal as an entry control for a copy mode between the two buses The end of the copy mode is controlled by the first $\overline{B U S A K}$ negative edge.
*INTAK, equivalent BC1, BC2, BDIR = ' 1 '

INGTRUERENA

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias ................................. $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
Storage Temperature.............................. $.5^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
All Input or Output Voltages with Respect to $\mathrm{V}_{\mathrm{BB}} \ldots \ldots . .-0.2 \mathrm{~V}$ to +18.0 V
$V_{C C}, V_{D D}$ and $V_{S S}$ with Respect to $V_{B E} \ldots \ldots . \ldots . .$.

## Standard Conditions (unless otherwise noted)

$$
\begin{array}{ll}
T_{A}=0^{\circ} \mathrm{C} \text { to }+40^{\circ} \mathrm{C} & \mathrm{~V}_{\mathrm{CC}}=+4.85 \mathrm{~V}-+5.15 \mathrm{~V} \\
\mathrm{~V}_{\mathrm{DD}}=+11.6 \mathrm{~V}-+12.4 \mathrm{~V} & \mathrm{~V}_{B B}=-3.3 \mathrm{~V}
\end{array}
$$

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Clock Inputs |  |  |  |  |  |  |
| Clock Input Freq. $\boldsymbol{\phi}^{2}$ | - | - | - | - | MHz | 1.79545 MHz |
| Input Logic Low | $V_{\text {ILC }}$ | 0 | - | 0.7 | Volts |  |
| Input Logic High | $\mathrm{V}_{\text {IHC }}$ | 2.4 | - | $V_{D D}$ | Volts |  |
| Input Current | ItLC | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{cc}}$ |
| Bus Inputs and Control Inputs |  |  |  |  |  |  |
| Input Logic Low | $\mathrm{V}_{\mathrm{LL}}$ | 0 | - | 0.7 | Volts |  |
| Input Logic High | $\mathrm{V}_{1+}$ | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | Volts |  |
| Input Currents | $\mathrm{I}_{\mathrm{L}}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{cc}}$ |
| Bus Outputs |  |  |  |  |  |  |
| Output Logic Low | $\mathrm{V}_{\text {IL }}$ | 0 | - | 0.5 | Volts | 1 TTL Load |
| Output Logic High | VoL | 2.4 | - | $\mathrm{V}_{\mathrm{cc}}$ | Volts | $+100 \mathrm{pF}$ |
| AC Characteristics |  |  |  |  |  |  |
| Clock Input Rise \& Fall Time | $\mathrm{tr}, \mathrm{t} \dagger$ | - | - | 50 | ns |  |
| CPU Bus Timing |  |  |  |  |  |  |
| Address Set Up Time | tas | 300 | - | - | ns |  |
| Address Hold Time | tao | - | - | 50 | ns |  |
| Data Access Time | tda | - | - | 500 | ns | 1 TTL Load |
| Data Hold Time | tdo | - | 100 | - |  | +100pF |
| Write Data Setup | tws | 100 | - | - | ns |  |
| Write Data Hold | tas | 0 | - | - | ns |  |
| Graphics Bus Timing |  |  |  |  |  |  |
| Data Access Time | tga | - | - | 150 | ns | 1 TTL Load |
| Data Hold Time | tgo | - | 100 | - | ns | +100pF |

CPU BUS TIMING (16 BIT)


GRAPHICS BUS (14 BIT)
SR3


Fig. 1 BUS TIMING


Fig. 2 RAM GRAPHICS OPERATION

RO-3-9504

## Cartridge ROM

## FEATURES

- Mask programable storage providing $2048 \times 8$ bit words
- 16 bit on-chip address latch
- Memory map circuitry to place the 2K ROM page within a 65K Memory area
- 16 bit tri-state bus with higher 6 bits driven to zero during read operations


## CIRCUIT REQUIREMENTS

The RO-3-9504 operates as the program memory for systems using a CP1610 microprocessor. It is configured as $2048 \times 10$ bit words and contains several features which reduce the device count in a practical microprocessor application.

## DESCRIPTION

From initialization, the RO-3-9504 waits for the first address code, i.e., BAR. For this address code and all subsequent address sequences, the 9504 reads the 16 -bit external bus and latches the value into its address register.

The 9504 contains a programable memory map location for its own 2K page, and if a valid address is detected, the particular address location will transfer its contents to the chip output buffers. If the control code following the address cycle was a READ, the 9504 will output the 10 bits of addressed data and drive a logic zero on the top six bits of the bus:

INPUT CONTROL SIGNALS

| BDIR | BC1 | BC2 | EQUIVALENT <br> SIGNAL | RESPONSE |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | NACT | NACT |
| 0 | 0 | 1 | IAB | NACT |
| 0 | 1 | 0 | ADAR | ADAR |
| 0 | 1 | 1 | DTB | DTB (READ) |
| 1 | 0 | 0 | BAR | BAR |
| 1 | 0 | 1 | DWS | - |
| 1 | 1 | 0 | DW | - |
| 1 | 1 | 1 | INTAK | - |

MEMORY TIMING RO-3-9504

CONTROL CODE

data out


## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
Storage Temperature $\qquad$ $55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
All Input or Output Voltages with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . .-0.2 \mathrm{~V}$ to +9.0 V

Standard Conditions (unless otherwise noted)
$T_{A}=0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
$V_{\mathrm{cc}}=+4.85 \mathrm{~V}-+5.15 \mathrm{~V}$
$\mathrm{V}_{\mathrm{ss}}=0.0 \mathrm{~V}$

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS |  |  |  |  |  |  |
| Inputs |  |  |  |  |  |  |
| Input Logic Low | $\mathrm{V}_{\text {IL }}$ | 0 | - | 0.7 | volts |  |
| Input Logic High | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | Vcc | volts |  |
| Input Leakage | $V_{\text {IL }}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {CC }}$ |
| CPU BUS Outputs |  |  |  |  |  |  |
| Output Logic Low | $\mathrm{V}_{\mathrm{OL}}$ | 0 | - | 0.5 | volts | 1 TTL Load |
| Output Logic High | V OH | 2.4 | - | V cc | volts | +100pf |
| Supply Current |  |  |  |  |  |  |
| $V_{c c}$ Supply | $I_{C C}$ | - | - | 120 | mA | $\mathrm{V}_{\mathrm{cc}}=5.25 \mathrm{~V} @ 40^{\circ} \mathrm{C}$ |
| AC CHARACTERISTICS |  |  |  |  |  |  |
| Inputs |  |  |  |  |  |  |
| Address Set Up | tas | 300 | - | - | ns |  |
| Address Overlap | tao | - | 50 | - | ns |  |
| Write Set Up | tws | 300 | - | - | ns |  |
| Write Overlap | two | - | 50 | - | ns |  |
| CPU BUS Outputs |  |  |  |  |  |  |
| Turn ON Delay | tda | - | - | 300 | ns | 1 TTL Load |
| Turn OFF Delay | tdo | - | - | 200 | ns | +100pf |

## Programable Sound Generator

## FEATURES

- Full software control of sound generation
- Interfaces to most 8-bit and 16-bit microprocessors
- Three independently programed analog outputs
- Two 8-bit general purpose I/O ports (AY-3-8910)
- One 8-bit general purpose I/O port (AY-3-8912)
- Single +5 V Supply


## DESCRIPTION

The AY-3-8910/8912/8913 Programable Sound Generator (PSG) is a Large Scale Integrated Circuit which can produce a wide variety of complex sounds under software control. The AY-3-8910/8912/ 8913 is manufactured in the General Instrument N-Channel Ion Implant Process. Operation requires a single 5V power supply, a TTL compatible clock, and a microprocessor controller such as the General Instrument 16-bit CP1600/1610 or one of the General Instrument PIC1650 series of 8-bit microcomputers.
The PSG is easily interfaced to any bus oriented system. Its flexibility makes it useful in applications such as music synthesis, sound effects generation, audible alarms, tone sıgnalling and FSK modems. The analog sound outputs can each provide 4 bits of logarithmic digital to analog conversion greatly enhancing the dynamic range of the sounds produced
In order to perform sound effects while allowing the processor to continue its other tasks, the PSG can continue to produce sound after the initial commands have been given by the control processor The fact that realistic sound production often involves more than one effect is satisfied by the three independently controllable channels available in the PSG.
All of the circuit control signals are digital in nature and intended to be provided directly by a microprocessor/microcomputer. This means that one PSG can produce the full range of required sounds with no change in external circuitry Since the frequency response of the PSG ranges from sub-audible at its lowest frequency to postaudible at its highest frequency, there are few sounds which are beyond reproduction with only the simplest electrical connections. Since most applications of a microprocessor/PSG system would also require interfacing between the outside world and the microprocessor, this facility has been designed into the PSG. The AY-3-8910 has two general purpose 8-bit l/O ports and is supplied in a 40 lead package; the AY-3-8912 has one port and 28 leads: the AY-3-8913 has no I/O ports and 24 leads.
See complete data sheets of AY-3-8910/8912/8913 in Audio Section.

## PIN CONFIGURATION

40 LEAD DUAL IN LINE
AY-3-8910

| Top View |  |  |
| :---: | :---: | :---: |
| $\mathrm{V}_{\text {SS }}$ (GND) $-\bullet$ | $\bullet 1 \times 40$ | $\mathrm{v}_{\mathrm{cc}}(+5 \mathrm{~V})$ |
| NC ${ }^{2}$ | 239 | - TEST 1 |
| analog channel b 3 | $3 \quad 38$ | a analog channel C |
| ANALOG CHANNELA 4 | $4 \quad 37$ | DAO |
| NC 5 | $5 \quad 36$ | DA1 |
| $1087{ }^{10}$ | $6 \quad 35$ | DA2 |
| 1086 $\square^{7}$ | $7 \quad 34$ | da3 |
| $10 \mathrm{B5} \mathrm{C}^{8}$ | $8 \quad 33$ | DA4 |
| 10b4 $\square^{9}$ | 932 | $\square$ das |
| 10b3 - 10 | $10 \quad 31$ | DA6 |
| IOB2 11 | $11 \quad 30$ | DA7 |
| $10 \mathrm{B1} \mathrm{C}^{12}$ | $12 \quad 29$ | BC 1 |
| Іово 13 | $13 \quad 28$ | BC2 |
| IOA7 ${ }^{-14}$ | $14 \quad 27$ | $\square$ BDIR |
| IOA6 - 15 | $15 \quad 26$ | TEST 2 |
| IOA5 16 | $16 \quad 25$ | ] A8 |
| IOA4 - 17 | $17 \quad 24$ | A $\overline{\text { 9 }}$ |
| IOA3 18 | $18 \quad 23$ | RESET |
| IOA2 ${ }^{-19}$ | $19 \quad 22$ | CLOCK |
| 1OA1 ${ }^{\text {a }}$ | $20 \quad 21$ | Ioao |

28 LEAD DUAL IN LINE
AY-3-8912

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| ANALOG CHANNEL C | ${ }^{\bullet 1}$ | 28 | DAO |
| TEST 1 | 2 | 27 | DA1 |
| $\mathrm{V}_{\mathrm{cc}}(+5 \mathrm{~V})$ | ${ }^{3}$ | 26 | DA2 |
| ANALOG CHANNEL B | 4 | 25 | DA3 |
| analog channel a | 5 | 24 | P DA4 |
| $\mathrm{V}_{\text {SS }}$ (GND) | 6 | 23 | D Da |
| IOA7 |  | 22 | ] dab |
| 10a6 | 8 | 21 | P DA7 |
| IOA5 | 9 | 20 | $\square \mathrm{BC} 1$ |
| IOA4 | 10 | 19 | BC2 |
| 10A3 |  | 18 | $\square$ bDir |
| IOA2 | 12 | 17 | A8 |
| IOA1 |  | 16 | $\square$ RESET |
| iOAO |  | 15 | Clock |

## Color Processor Chip

## FEATURES

- Operation from 715909 MHz crystal
- Five-line digital selection for 1 of 16 colors, blanking, sync and color burst
- 3579545 MHz buffered output


## DESCRIPTION

The required color to be displayed for each 280ns PIXEL is decoded on a four line binary coded input. This selects one of sixteen possible colors. An external resistor network completes the $D$ to $A$ function as shown in the schematic of Fig. 1. The waveform plus table illustrates the use of the five inputs to produce composite sync, color burst, line blanking, frame blanking and video.
The external video input pin provides the ability to superimpose white high resolution (140ns wide) video information over the picture (color image).

| $\begin{gathered} \text { INPUT } \\ \text { CODE } \\ \text { ASSIGNENT } \end{gathered}$ |  |  |  |  | TIME SLOT RELATIVE VOLTAGE AMPLITUDES |  |  |  | $\begin{gathered} \text { COLOR } \\ \text { OUTPUT } \\ \text { DESCRIPTION } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| V5 | V4 | v3 | v2 | V1 | +a | -1 | -Q | +1 |  |
| 0 | 0 | 0 | 0 | 0 | 3 | 3 | 3 | 3 | Black |
| 0 | 0 | 0 | 0 | 1 |  | 13 | 9 |  | Blue |
| 0 | 0 | 0 | 1 | 0 | 8 | 0 | 4 | 12 | Red |
| 0 | 0 | 0 | 1 | 1 | 4 | 4 | 12 | 12 | Tan |
| 0 | 0 | 1 | 0 | 0 | 3 | 8 | 11 | 6 | Grass Green ${ }^{\text {a }}$ Group A |
| 0 | 0 | 1 | 0 | - | 3 | 11 | 13 | 5 | Green |
| 0 | 0 | 1 | 1 | 0 | 9 | 11 | 15 | 13 | Yellow |
| 0 | 0 | 1 | 1 | 1 | 13 | 13 | 13 | 13 | White |
| 0 | 1 | 0 | 0 | 0 | 9 | 9 | 9 | 9 | Gray |
| 0 | 1 | 0 | 0 | 1 | 8 | 13 | 12 | 7 | Cyan |
| 0 | 1 | 0 | , | 0 | 9 | 4 | 9 | 14 | Orange |
| 0 | 1 | 0 | 1 | 1 | 4 | 4 | 8 | 8 | Brown |
| 0 | 1 | 1 | 0 | 0 | 13 | 5 | 3 | 11 | Magenta Group B |
| 0 | 1 | 1 | 0 | 1 | 12 | 12 | 6 | 6 | Light Blue |
| 0 | 1 | 1 | 1 | 0 | 5 | 9 | 13 | 9 | Yellow-Green |
| 0 | 1 | 1 | 1 | 1 | 10 | 5 | 2 | 7 | Purple |
| 1 | X | x | 0 | 0 | 3 | 3 | 3 | 3 | Blanking |
| 1 | X | x | 1 | 0 | 1 | 1 | 5 | 5 | Color Burst |
| 1 | X | x | 0 | 1 | 0 | 0 | 0 | 0 | Sync |
| 1 | 1 | 1 | 1 | 1 | 0 | 15 | 0 | 15 | Test |

## PIN CONFIGURATION <br> 18 LEAD DUAL IN LINE





| INSTRUNERENT | AY-3-8915 |
| :--- | :--- |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Temperature Under Bias ..................................... $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$

All Input or Output Voltages with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . \begin{aligned} & -0.2 \mathrm{~V} \text { to }+9.0 \mathrm{~V}\end{aligned}$
$\mathrm{V}_{\mathrm{cc}}$ with Respect to $\mathrm{V}_{s \mathrm{~s}} \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots \ldots . . .$.
Standard Conditions (unless otherwise noted)
$T_{A}=0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
$V_{c c}=+4.85 \mathrm{~V}-+5.15 \mathrm{~V}$
$\mathrm{V}_{\mathrm{ss}}=0.0 \mathrm{~V}$

* Exceeding these ratings could cause permanent damage to the device. This is a stress ratıng only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Oscillator Freq. In. | - | - | - | - | MHz | 7.15909MHz crystal <br> Trimmed by external capacitor |
| 3.579545MHz Clock Output <br> Output Logic Low <br> Output Logic High | V ${ }_{\text {OL }}$ | 0 2.4 | - | $\begin{aligned} & 0.5 \\ & V_{c c} \end{aligned}$ | volts volts |  |
| Logic Inputs V1, V2, V3, V4, V5, EXT. VIDEO <br> Input Logic Low <br> Input Logic High | V V1/ $\mathrm{V}_{\text {IH }}$ | 0 2.4 | - | 0.7 $V_{c c}$ | volts volts |  |
| Outputs RF1, RF2, RF4, RF8 <br> Output ON <br> Output OFF | $\begin{aligned} & \text { I } \\ & \text { I } \end{aligned}$ | 5 | - | 10 | ${ }_{\mu \mathrm{A}}^{\mathrm{A}}$ | $\begin{aligned} & \text { Vout }=+0.5 \mathrm{~V} \\ & \text { Vout }=+2.4 \mathrm{~V} \end{aligned}$ |
| Supply Current $V_{D D}$ | Icc | - | - | 80 | mA | $V_{c c}=5.25 \mathrm{~V} @ 40^{\circ} \mathrm{C}$ |


| FUNCTION | DESCRIPTION | PART NUMBER | PACE NUMBER |
| :---: | :---: | :---: | :---: |
| BALL \& PADDLE | Six selectable games for one or two players, with vertical paddie motion.. | AY-3-8500 | 9-60 |
|  |  | AY-3 88500-1 | 9-60 |
| 8600 SERIES | The 8600 series games consist of a set of single chip TV game integreted circuits. | General Information | 9-63 |
| ROADAACE | One or two player games where racing skill in "traffic" generates the highest score. | AY-3-8603 | 9-64 |
| WARFARE | One or two player games featuring subs, destroyers, cargo ships, and spaceships, | AY-3-8605 | 9-65 |
| WIPEOUT | One or two player games where players "wipe out" objects by controlling a ball in the play area. | AY-3-8606 | 9-66 |
| SHOOTING GALLERY | Twelve games for one or two players using external photocell riffes for shooting. | AY-3-8607 | 9-68 |
| SUPERSPORT | Ten selectable games for one or two players, with vertical and horizontal paddle motion. | AY-3-8610 | 9-70 |
| MOTOR CYCLE | One player cycle game with variable skill selection. | AY-3-8765 | 9-72 |

## Ball \& Paddle

## FEATURES

- 6 Selectable Games-Tennis, soccer, squash, practice and two rifle shooting games
- 625 Line (AY-3-8500) and 525 Line (AY-3-8500-1) versions
- Automatic Scoring
- Score display on T.V. Screen, 0 to 15
- Selectable Bat Size
- Selectable Rebound Angles
- Selectable Ball Speed
- Automatic or Manual Ball Service
- Action Sounds
- Shooting Forwards in Soccer Game
- Visually defined area for all Ball Games.


## DESCRIPTION

The AY-3-8500 and AY-3-8500-1 circuits have been designed to provide a TV games function which gives active entertainment using a standard domestic television receiver.

The circuit is intended to be battery powered and a minimum number of external components are required to complete the system.

## PIN CONFIGURATION

28 LEAD DUAL IN LINE

*Do not use as tie point.


Fig. 1 BLACK AND WHITE IMPLEMENTATION

## PIN FUNCTIONS (Pin numbers in parentheses)

Vss (2)
Negative supply input, nominally OV(GND).
Sound Output (3)
The hit ( 32 ms pulse/976Hz tone), boundary reflection ( 32 ms pulse $/ 488 \mathrm{~Hz}$ tone) and score ( 32 ms pulse $/ 1.95 \mathrm{KHz}$ tone) sounds are output on this pin.
Vcc (4)
Positive supply input.

## Ball Angles (5)

This input is left open circuit (Logic '1') to select two rebound angles and connected to Vss (Logic ' 0 ') to select four rebound angles. When two angles are selected they are $\pm 20^{\circ}$, when four are selected they are $\pm 20^{\circ}$ and $\pm 40^{\circ}$.
Ball Output (6)
The ball video signal is output on this pin.

## Ball Speed (7)

When this input is left open-circuit, low speed is selected (1.3 seconds for ball to traverse the screen). When connected to $\mathrm{V}_{\text {ss }}$ (Logic ' 0 '), the high speed option is selected ( 0.65 seconds for ball to traverse the screen).

## Manual Serve (8)

This input is connected to $V_{s s}$ (Logic ' 0 ') for automatic serving. When left open circuit (Logic ' 1 ') the game stops after each score.
The serve is indicated by momentarily connecting this input to Vs.
Right Player Output/Left Player Output $(9,10)$
The video signals for the right and left players are output on separate pins.

Right Bat Input/Left Bat Input $(\mathbf{1 1 , 1 2 )}$
An R-C network connected to each of these inputs controls the vertical position of the bats. Use a 10 K resistor in series with each pot.

## Bat Size (13)

This input is left open circuit (Logic ' 1 ') to select large bats and connected to $\mathrm{V}_{\text {SS }}$ (Logic ' 0 ') to select small bats. For a 19" T.V. screen, large bats are $1.9^{\prime \prime}$ and small bats are $0.95^{\prime \prime}$ high.

## Sync Output (16)

The T.V. vertical and horizontal sync signals are output on this pin. See Fig. 2
Clock Input (17)
The 2 MHz master timing clock is input to this pin. The exact frequency is $2.012160 \pm 1 \%$.
Rifle Game 1, Rifle Game 2, Tennis, Soccer, Squash, Practice (18 thru 23)
These inputs are normally left open circuit (Logic '1') and are connected to $V_{\text {ss }}$ (Logic ' 0 ') to select the desired game.
Score and Field Output (24)
The score and field video signal is output on this pin.
Reset (25)
This input is connected momentarily to Vss (Logic ' 0 ') to reset the score counters and start a new game. Normally left open circuit.

## Shot Input (26)

This input is driven by a positive pulse output of a monostable to indicate a "shot".

Hit Input (27)
This input is driven by a positive pulse output of a monostable which is triggered by the shot input if the target is on the sights of the rifle.

NOTE: The "Shot" and "Hit" inputs have on-chip pull-down resistors to Vss. All other inputs (except the "Bat" inputs) have on-chip pullup resistors to Vcc.

## ELECTRICAL CHARACTERISTICS

```
Maximum Ratings*
Voltage on any Pin with Respect to \(\mathrm{V}_{\mathrm{ss}} \mathrm{Pin} . . . . . . . . . . . . . . .\).
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . . . . . \(-20^{\circ} \mathrm{C}\) to \(+70^{\circ} \mathrm{C}\)
Ambient Operating Temperature Range............. \(.0^{\circ} \mathrm{C}\) to \(+40^{\circ} \mathrm{C}\)
Standard Conditions (unless otherwise noted)
\(V_{\mathrm{cc}}=+6\) to +7 V
\(V_{S S}=0 \mathrm{~V}\)
Operating Temperature \(\left(\mathrm{T}_{\mathrm{A}}\right)=0^{\circ} \mathrm{C}\) to \(+40^{\circ} \mathrm{C}\)
```

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied - operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics at $25^{\circ} \mathrm{C}$ and Vcc $=+6$ Volts | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Input |  |  |  |  | Maximum clock source impedance |
| Frequency | 1.99 | 2.01 | 2.03 | MHz | of 1 K to $\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{SS}}$. |
| Logic '0' | 0 | - | 0.5 | V |  |
| Logic ' 1 ' | $\mathrm{V}_{\mathrm{CC}}-2$ | - | $V_{\text {cc }}$ | V |  |
| Pulse Width - Pos. | - | 200 | - | ns |  |
| Pulse Width - Neg. | - | 300 | - | ns |  |
| Capacitance | - | 10 | - | pF | $V_{1 N}=0 \mathrm{~V}, \mathrm{~F}=1 \mathrm{MHz}$ |
| Leakage | - | 100 | - | $\mu \mathrm{A}$ |  |
| Control Inputs |  |  |  |  | Max contact resistance of 1 K to $\mathrm{V}_{\text {SS }}$ |
| Logic '0' | 0 | - | 0.5 | V |  |
| Logic ' 1 ' | $V_{C C}{ }^{-2}$ | - | $V_{\text {cc }}$ | V |  |
| Input Impedance | - | 1 | - | $M \Omega$ | Pull up to $V_{c C}$ |
| Rifle Input | - | 1 | - | $M \Omega$ | Pull down to $V_{\text {ss }}$ |
| Outputs |  |  |  |  |  |
| Logic '0' | - | - | 1 | V | I out $=0.5 \mathrm{~mA}$ |
| Logic '1' | $V_{C C}-2$ | - | - | $V$ | I out $=0.1 \mathrm{~mA}$ |
| Power Supply Current | - | 40 | 60 | mA | at $\mathrm{V}_{\mathrm{cc}}=+7 \mathrm{~V}$ |




Fig. 2 LOCATION OF DATA OUTPUT PULSES


Fig. 3 TIMING DIAGRAM

## TV Games

The Gimini 8600 Series games consist of a set of single chip TV game integrated circuits. This series consists of AY-3-8603 Roadrace, AY-3-8605 Warfare, AY-3-8606 Wipeout, AY-3-8607 Rifle, AY3-8610 Supersport, and AY-3-8765 Motorcycle chips. Circuit descriptions giving detailed information on each game chip are in the following pages of this section.
The TV games may be configured as dedicated games when packaged with a color processor and peripheral circuitry. When packaged as individual cartridges, able to be connected to a main console containing the color processor and peripheral circuitry, the game becomes programable by its user.
The following block diagram shows a programable game configuration which can be combined to provide a dedicated game if desired.

## DESCRIPTION

The console consists of a resident game/color processor, an R.F. video modulator, a calculator type keyboard for game selection, a set of three skill select switches, and a game reset switch. Attached to the console are the player controllers which can consist of joysticks or a variety of controls suited to the game.
The console need never be opened once in operation; all changes to the system are plugged in externally. The cartridges and controls are the only items that are altered to give the 8600 system new game characteristics.
The block diagram shows the basic system with its expandability.

## SECTION A

There are three switches that will allow skill. selections. These skills will be determined by the specific game cartridge and will control speeds, sizes and shapes of objects in any particular game cartridge. A fourth switch acts as game reset.

## SECTION B

The game selections will be made by a maximum of ten momentary switches similar to the calculator keyboard. Again the number of games is determined by the cartridge.

## SECTION C

The controls are always in pairs to allow for two players. Depending on the game cartridge, a variety of controls may be used.


Fig. 1 AY-3-8610 CARTRIDGE

Basically most games can be controlled by resistance joysticks. If controls are remote, the connectors used should be a minimum of six pins each to allow for game flexibility.

## SECTION D

The cartridges will all be compatible with the console and a variety will be offered. Each cartridge will give the game a completely new objective. The cartridge should have a minimum of 34 pins to allow for special connections such as sound effects, etc., and remain compatible with the system.
Fig. 1 illustrates as an example the straightforward layout for the AY-3-8610 Supersport game cartridge.


## Roadrace

## FEATURES

- Two game selections-one and two player games
- T.V. raster generator
- All timing signals for color or black and white application
- Direct compatibility with Economy "8600" game console
- Automatic on-screen scoring
- Score color-keyed for each player
- Skill selection for difficult or easy driving conditions
- Realistic motor and crash sound generation with a minimum of external components


## DESCRIPTION

The AY-3-8603 game circuit has been designed to provide a realistic roadrace game using a standard television receiver. The circuit is intended for color or black and white usage with a 625 (AY-3-8603) line receiver. The circuit is designed to be either a stand-alone game or an add-on for the Giminı Economy "8600" game series

## OPERATION

The AY-3-8603 utilizes two potentiometers to produce control voltage for the horizontal positioning of the race cars Each player controls his own car. The circuit displays a score for each driver, processes the game logic and produces composite sync, color burst location and blanking signals for a 625 line T.V. receiver. Sound outputs are also included to produce simulated engine and crash sounds with a minimum of external components.

## PIN CONFIGURATION

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied - operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.
Vss (GND) Top View
Sync
Comp Blanking


## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . . . . . . . . . .$.
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . . . . . $-20^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Ambient Operating Temperature Range ................... $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
Operating Voltage Supply Range . . . . . . . . . . . . . . . . . . . . . . . . 7 7 to +9 V
Standard Conditions (unless otherwise noted)
Parameter values at $T_{A}=25^{\circ} \mathrm{C}$

| Characteristic | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Clock Input |  |  |  |  |  |
| Frequency | - | 3.579545 | - | MHz |  |
| Logic '0'. . | 0 | - | 0.5 | V | 45-55\% duty cycle |
| Logic '1' | $\mathrm{V}_{\mathrm{p}}-2$ | - | Vp | V |  |
| Leakage | - | - | pror | - |  |
| Control Input |  |  |  |  |  |
| Logic '0' | 0 | - | 02 | V | Max. contact resistance of 1 K to $\mathrm{V}_{\text {ss }}$ |
| Logic '1' | V - 2 | - | $\mathrm{V}_{\mathrm{p}}$ | V |  |
| Input Impedance | p | 100 | - | $\mathrm{K} \Omega$ | Pull up to VP |
| Output pins | - | - | 1 | V | Iout $=2 \mathrm{~mA}$ |
| On Off | - | 1000 | - | $\mu \mathrm{A}$ | $V_{\text {out }}=V_{p}$ |
| Power Supply Current | - | - | 60 | mA | at $\mathrm{V}_{\mathrm{p}}=75 \mathrm{~V}$ |

## Warfare

## FEATURES

- Outputs include CCIR (AY-3-8605) compatible composite sync, color burst location and blanking
- Operation from a 3.579545 clock
- One or two player game
- Digital on-screen scoring
- Sound generation for engine, sonar, firing and explosions
- Outputs and power requirements compatible with the Gimini Economy "8600" game series


## DESCRIPTION

The AY-3-8605 game circuit has been designed to provide realistic sea and space battle games using a standard television receiver. The circuit is intended for use with a 625 (AY-3-8605) line receiver.

## OPERATION

The AY-3-8605 utilizes two potentiometers ( one for each player) or one axis of two joysticks to produce control voltages for internal Schmitt triggers. These position the submarine, destroyer, and spaceships, via rate controllers in the horizontal axis only The circuit displays an on-screen score for each player, processes the game logic and produces a composite sync, color burst location and blanking signals for a 625 line T.V. receiver. Sound outputs are also included to produce simulated engine, sonar, firing, and explosion sounds with a minimum of external components.
The outputs are designed for compatibility within the Gimini Economy Game series. Game selection is made via a 2 strobe $/ 3$ select switch matrix with momentary contacts. Two momentary switches that ground the "fire" input pins are used to activate the torpedoes, depth charges, and missiles.

## SOUND OUTPUTS

Space background noise-7 Bit Polynomial Counter clocked at 2 kHz rate

Torpedo or Depth Charge fired-1kHz signal for 2 frames then off for 4 frames.

Explosion - $\sim 8 \mathrm{kHz}$ signal for $\sim 31 / 2$ seconds.
Destroyer engine-Fast sound is a 240 Hz clock into a 4 bit poly counter-Slow sound is a 120 Hz clock rate.

Sonar for Submarine-Decaying 480 Hz signal for $\sim 2.9$ seconds followed by a 2 kHz signal burst for $\sim 200 \mathrm{~ms}$. This sound repeats every $31 / 2$ seconds.

## PIN CONFIGURATION

 28 LEAD DUAL IN LINE

## MOVEMENT

The cargo ship will traverse the screen in 16 seconds.
The destroyer ship will traverse the screen in 5.3 seconds. The submarine moves across the screen in 8 seconds.
The torpedo rises at a rate of 1 line per frame. To move the 100 lines to hit the destroyer will take 1.67 seconds.
The depth charge falls at a rate of 1 line every 2 frames. To hit the submarine will take 3.34 seconds.

AY-3-8606

## Wipeout

## FEATURES

- Outputs include CCIR for AY-3-8606
- Operation from a 3.579545 MHz clock
- One or two player games
- Digital on-screen scoring
- Sound generation for tones to indicate hits of ball to bat, ball to objects, and ball to border
- Outputs and power requirements compatible with Gimini Economy "8600" Game Series to allow plug-in operation


## DESCRIPTION

The AY-3-8606 game circuit has been designed to provide an active paddle/squares game using a standard television receiver. The circuit is intended for use with a 625 (AY-3-8606) line receiver.

## OPERATION

The AY-3-8606 utilizes two potentiometers (one for each player) one axis only of each joystick to produce control voltages for internal Schmitt triggers. These position the player's bats in the vertical axis only to allow play of the game. The circuit displays an on-screen score color coded to each player, processes the game logic and produces a composite sync, color burst location and blanking signals for a standard line TV receiver. Sound output is also included to produce tonal sounds for ball hits to bats, ball hits to borders and ball hits on objects with a minımum number of external components.
The outputs are designed for compatibility within the Gemıni Economy "8600" Game Series. Game selection is made via a 4 strobe, 3 select switch matrix with either fixed or momentary contact closures.
Two momentary switches that ground the input serve control pins are used to start the ball into motion after reset or when a reserve is necessary according to game rules. Three skill selection switches are used to determıne game difficulty.

## GAME OPERATION

## Select 1 Strobe 1 (Game \#1)

A single-player game in which the player manipulates the paddle in the vertical axis after manually serving the ball The objective is to wipe out as many boxes as possible in the seven serves that are allowed during a single game.

## Select 1 Strobe 2 (Game \#2)

A single-player game in which the player manipulates two paddles at each end of the playing area in the vertical axis after manually serving the ball. The objective is to wipe out as many boxes as possible in the seven serves that are allowed during a single game

## Select 1 Strobe 3 (Game \#3)

A two-player game in which each player manipulates his paddle at the ends of the playing area in the vertical axis The ball is served by the last player to score after game is in play. The objective is to wipe out all boxes in the playing area. The winner ends with the highest score

## Select 1 Strobe 4 (Game \#4)

A two-player game in which each player manipulates his paddle at the ends of the playing area in the vertical axis. The ball is served by the last player to score after the game is in play. The objective

PIN CONFIGURATION
28 LEAD DUAL IN LINE.

is to wipe out all the boxes in the playing area The winner ends with the highest score The ball will rebound off the center barrier.

## Select 2 Strobe 1 (Game \#5)

A single-player game in which the player manipulates two different colored paddles at each end of the playing area in the vertical axis after manually serving the ball The objective is for the player to wipe out as many correct colored objects depending on which color paddle hits the ball into the playing area as possible The game ends when all of one color objects are wiped out

## Select 2 Strobe 2 (Game \#6)

A two-player game in which each player manipulates his paddle at the ends of the playing area in the vertical axis The ball is served by the last player to score after the game is in play. The objective is to wipe out as many boxes color coordinated with the player's paddle The first color completely wiped out wins

## Select 2 Strobe 3 (Game \#7)

A two-player game in which each player manipulates his paddle at the ends of the playing area in the vertical axis The ball is served by the last player to score after the game is in play The objective is to wipe out as many boxes color coordınated with the player's paddle The first color completely wiped out wins

## Select 2 Strobe 4 (Game \#8)

A single-player game in which the player manipulates the paddle in the vertical axis after manually serving the ball The object is to wipe out as many color coordinated boxes with the player's paddle as possible in the seven serves that are allowed during a single
game. The ball alternates colors on each rebound, thus it can only hit one color square to wipe out and is transparent to the other color at any one time. After a hit and rebound, the ball can wipe out the opposite color square.

## Select 3 Strobe 1 (Game \#9)

A single-player game in which the player manipulates the paddle in the vertical axis after manually serving the ball. The objective is to break through the end wall and score on as many blocks as possible. The game ends after either seven serves or the first breakthrough.

## Select 3 Strobe 2 (Game \#10)

A two-player game in which each player manipulates his paddle in the center of the playing area in the vertical axis. The ball is kept in motion by each player trying to protect the wall behind his paddle. If a player misses a hit with the paddle, the ball will hit the wall and one block will disappear and the score will increment for the opposite player. The objective of this game is to knock out as

many blocks to get a high score before breaking through the wall. The first player to hit the ball through an open section of a wall ends the game.

NOTE: If the ball hits the left wall at a point where three blocks connect from the lower edge, the block in the same direction as the trajectory will disappear.

## SKILL SELECTION

The games mentioned can be made more difficult by selecting one or more of the following skills:

1. Bat Size (left player only)
2. Ball Size (in large ball size, bat must hit center of ball)
3. Ball Speed

A ground on any of these function pins shall:

1. Halve the bat size
2. Halve the ball size
3. Double the ball speed

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\mathrm{n}}$ Pin . . . . . . . . . . . . . . . . . -0.2 V to 12 V
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . . . . $-20^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)
$V_{p}=+7.5$ to +9.0 volts
Ambient Operating Temperature Range $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
Characteristics at $+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{p}}=7.5 \mathrm{~V}$

| Characteristics | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: |
| CLOCK INPUT |  |  |  |  |
| Frequency | - | - | MHz |  |
| Logic '0' | 0 | 0.5 | V | 45-55\% duty cycle |
| Logic ' 1 ' | $V_{p-2}$ | $V_{p}$ | V |  |
| Leakage | - | 100 | $\mu \mathrm{A}$ |  |
| CONTROL INPUT |  |  |  |  |
| Logic '0' | 0 | 0.5 | V | May contact resistance of 1 K to $\mathrm{V}_{\mathrm{n}}$ |
| Logic "1" | $V_{p-2}$ | V | V |  |
| Input Impedance | - | - | $\mathrm{K} \Omega$ |  |
| OUTPUT PINS 2-8, 13 |  |  |  |  |
| ON | - | 1 | V | Iout $=2 \mathrm{~mA}$ |
| OFF | - | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {out }}=\mathrm{V}_{\mathrm{p}}$ at 7.5 V |
| OUTPUT PINS 22-25 |  |  |  |  |
| ON | - | 1.0 | V | Iout $=.5 \mathrm{~mA}$ |
| OFF | - | $100 \mu \mathrm{~A}$ | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {out }}=\mathrm{V}_{\mathrm{p}}$ (open drain) |
| Power Supply Current | - | 75 | mA |  |

## Shooting Gallery

## FEATURES

- Outputs include CCIR (AY-3-8607) compatible composite sync, color burst location and blanking
- Operation from a 3.579545 MHz clock
- One or two player game
- Digital on-screen scoring
- Sound generation for flight, fall, hit and impact
- Outputs and power requirements compatible with Gimini Economy "8600" Game Series to allow plug-in operation


## DESCRIPTION

The AY-3-8607 game circuit has been designed to provide an active series of target games using a standard televisıon receiver. The circuit is intended for use with a 625 (AY-3-8607) line receiver.

## OPERATION

The AY-3-8607 utilizes an external photo cell mounted in a gun or rifle for recording hits. The logic requires the gun to input a shot pulse when the trigger is pulled and if the photo cell in the gun records the hit (if on target) a pulse will be transmitted to the chip. (No pulse if off target).
Some of the two-player games require two guns.
With the two-player game where one player controls the target and the other shoots, the joystick in the console will be used for target control.
Skill select switches on the console are used for (1) target size large or small (2) target speed, fast or slow. In two-player/tworifle games, the left joystick is used for additional handicapping/skill selection.

## PIN CONFIGURATION

28 LEAD DUAL IN LINE

*Pin functions are for one-player games.
For two-player games, the functions of pins 20 thru 23 are:

20-Player 1 Target Size
21-Player 1 Speed Select
22-Player 2 Target Size
23--Player 2 Speed Select

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $V_{n} \operatorname{Pin} . . . . . . . . . . . . . . . ~-0.3$ to +12.0 V
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-20^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Ambient Operating Temperature Range .................... $0^{\circ} \mathrm{C}$ to $40^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)
$\mathrm{V}_{\mathrm{dd}}=75$ to 9.0 Volts
$\mathrm{V}_{\mathrm{ss}}=0 \mathrm{Volts}$
All characteristics specified at $25^{\circ} \mathrm{C}$ and $V_{d d}=7.5$ volts

* Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied - operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: |
| Clock Input | - | - | - | Crystal controlled @ 3579545 MHz with $45 \%$ to $55 \%$ positive duty cycle. |
|  | 0 | 0.5 | V | Logic "0" level |
|  | $V_{d d}-2$ | $V_{\text {dd }}$ | V | Logic "1" level |
|  | - | 100 | $\mu \mathrm{A}$ | Leakage, $\mathrm{V}_{1 \mathrm{n}}=\mathrm{V}_{\text {dd }}$ |
| Outputs |  |  |  |  |
| Pins 2, 3, 4, 5, 6, 7 | - | $10$ | V | Logic "0" level Iout $=-2 \mathrm{~mA}$ |
|  | - | $100 \mu \mathrm{~A}$ | $\mu \mathrm{A}$ | Off volt $=\mathrm{V}_{\text {dd }}=7.5$ Volts |
| Output Pin \#8 | - | 1 | V | $\text { Iout }=-0.5 \mathrm{~mA}$ |
|  | $V_{d d}-2$ | - | V | $\text { Iout }=+0.5 \mathrm{~mA}$ |
| Output Pins 11, 13 | - | 1 | V | Iout $=-0.2 \mathrm{~mA}$ |
|  | $V_{\text {dd }}-2$ | - | V | Iout $=+02 \mathrm{~mA}$ |
| Output Pın \#22, 23 | - | 1 | V | Iout $=-05 \mathrm{~mA}$ |
|  | - | 35 | $\mu \mathrm{A}$ | Volt $=\mathrm{V}_{\text {dd }}=75$ Volts |
| Inputs |  |  |  |  |
| Pin \#26, 27, 28 | 150 | 375 | K | $\mathrm{V}_{\mathrm{dd}}=75$ Volts |
| Pin \#12, 14, 17, 18, 20 | 75 | 150 | K | $\mathrm{V}_{\text {dd }}=75$ Volts |
| Power supply current Idd | - | 65 | mA | $\mathrm{V}_{\text {dd }}=75$ Volts |

## Supersport

## FEATURES

- Ten selectable games - tennis, hockey, soccer, squash, practice, gridball, basketball, basketball practice, one and two player target
- 625 Line (AY-3-8610) versions
- T.V. raster generator
- Two axis player motion
- Automatic on-screen scoring, 0-15
- Automatic ball speed-up after 7 hits or may be disabled by ball speed inhibit input
- Realistic ball service and scoring
- Score color keyed to player
- Independent player selectable bat size for handicapping
- Fast ball speed inhibit
- Five segment bats giving high, low, and horizontal ball angles
- Sound outputs for hit, rebound and score
- Shooting forwards in hockey and soccer


## DESCRIPTION

The AY-3-8610 circuit has been designed to provide a TV 'game' function which gives active entertainment using a standard color or black and white domestic television receiver.
The circuit is intended to be battery powered and a minimum number of external components are required to complete the system.

PIN CONFIGURATION
28 LEAD DUAL IN LINE



Fig. 1 BLACK AND WHITE IMPLEMENTATION

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\text {sS }} \operatorname{Pin} \ldots \ldots . . . . . . .$.
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . . . . . $-20^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Ambient Operating Temperature Range . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise noted)
$V_{C C}=+7.5$ to +9.0 V
$\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}$

* Exceeding these ratings could cause permanent damage to these devices. This is a stress rating only and functional operation of these devices at these conditions is not implied - operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.


[^19]
## Motor Cycle

## FEATURES

- Full color operation with AY-3-8615 color processor
- 4 game selections - Time Out, Obstacle Race, Moto Jump and Rally Run
- 2 skill selections-PRO/AM
- 625 line (CCIR) and 525 line (NTSC) pin selectable
- Internal TV (raster) generator

E Automatic on-screen scoring

- Realistic sound effects


## DESCRIPTION

Motor Cycle is a game for one player who controls the speed of a motorbike and rider. At the start of each game the motorbike and rider are stationary at the upper left-hand side of the TV screen As the player moves the joystick, the motorbike and rider move across the screen on track 1 . The motorbike sound starts with the bike movement and as the bike and rider accelerate, the motorbike sound reflects these speed changes. The motorbike wheels have an appearance of rotating at a speed also related to the throttle settıng
At the end of track 1 the bike and rider reappear on track 2 at the left-hand side, and likewise at the end of track 2 the bike appears on track 3 at the left-hand side of the screen The movement of the bike and rider on track 3 to the right edge of the screen will cause a reinitialization of the bike and rider at the left of the screen on track 1. There will be no movement until the throttle is reset to a slow speed and then increased. Figure 1 shows the playing field for each game.

## GAME OPERATIONS

## Time Out

The object of this game is to reach the end of track 3 in the shortest time The three-digit score is automatically reset as the rider first begins to move on track 1 and the score is incremented until the game is over The score appears centered on the screen above track 1, and the score remains until the start of the next game.
Time Out requires a speed shifting to achieve the lowest tıme scores. As the throttle speed is increased and the rider begins to move, the bike object is in speed one and moves at a set rate across the screen. The only way to accelerate the bike object motion is to return the throttle to a "slow" position and then turn to a "fast" position. This shifting procedure will move the bike into speed 2 and the object will go across the screen at a faster rate. Another "shift" will allow speed 3
A PRO/AM option switch is provided to select a difficulty factor. In the hard mode, a crash occurs if the player tries to increase the throttle speed too rapidly. A crash will flip the bike and rider upside down and the sound will be a high-pitch screech. At the end of the crash the bike and rider are reinitialized on track 1 and the score reset. In the easy mode no crash is allowed.

## Obstacle Race

As the throttle speed is increased, the bike and rider move across track 1 at a rate determined by the throttle controller setting Obstacle Race has no speed shifting Located on each of the three tracks are obstacles. The easy/hard option switch selects the number of obstacles per track. The easy mode has one obstacle per track and the hard mode has two obstacles per track.
The object of this game is to traverse the three tracks in the shortest time, doing a wheelie over each obstacle. The score

## PIN CONFIGURATION <br> 28 LEAD DUAL IN LINE

| Top View |  |  |
| :---: | :---: | :---: |
| Ramps/Track Out $\square_{\bullet} 1$ | 28 | $\mathrm{V}_{\mathrm{p}}$ (Positive Power Supply) |
| Color Burst Locator 2 | 27 | Object Output |
| Test ( NC ) ${ }^{3}$ | 26 | Sync Out |
| Test ( $\mathrm{NC}^{\text {c }} \mathrm{S}^{4}$ | 25 | Blanking Out |
| Test ( NC ) ${ }^{5}$ | 24 | Background Out |
| -AL/NTSC Select 6 | 23 | Clock In (3579545MHz) |
| Obstacle Race ${ }^{7}$ | 22 | Test ( $\mathrm{NC}^{\text {c }}$ ) |
| Rally Run ${ }^{8}$ | 21 | - C |
| PRO/AM Select 9 | 20 | J C |
| Time Out 10 | 19 | UNC |
| Moto Jump - 11 | 18 | Throttle Input |
| Game Reset/POR 12 | 17 | UNC |
| Sound Out ${ }^{13}$ | 16 | Test ( NC ) |
| Vss 14 | 15 | Test (N C ) |

counters record the run time in the same manner as the Time Out Game
In Obstacle Race the crash is not caused by accelerating too rapidly. The crash is caused by not doing a wheelie over an obstacle. In the wheelie position, the bike will have the front wheel lifted off the track. A crash into an obstacle will flip the bike upside down and produce the screech sound The score is reset at the end of the crash.

## Moto Jump

The object of this game is to control the throttle speed to properly jump the ramp and buses located on track 3 The game begins with 8 buses and with each successful jump over the ramp and buses an additional bus appears The game is over when the maximum number of errors has been reached, which is 3 or 7 errors, depending on the position of the PRO/AM switch. The game is then started by reselecting the Moto Jump game input.
Errors are caused by accelerating too rapidly, insufficient speed to clear.the buses, or landing too far past the back ramp after the jump. The bike and rider flip upside down and a screeching sound indicates an error. The score records the number of errors in the first digit and the number of displayed buses in the next two digits.

## Rally Run

This game is similar to Moto Jump with the addition of obstacles on track 1 and track 2 The object of Rally Run is to do a wheelie over each obstacle and then adjust the throttle for the correct speed to jump the buses on track 3 The PRO/AM option switch selects two obstacles per track and allows three errors per game in the hard mode, and one obstacle per track and seven errors per game in the easy mode. Errors are caused by accelerating too rapidly, not in wheelie position over the obstacles, insufficient speed to clear the buses, or landing too far past the back ramp after the jump. The score records the number of errors and the number of buses displayed the same as in the game of Moto Jump.

## PIN FUNCTIONS

| Pin No. | Name | Function |
| :---: | :---: | :---: |
| 1 | Ramps and Tracks | The output of this pin is the video signal of ramps and tracks. |
| 2 | Color Burst Locator | The output of this pin is the color time slot which occurs after the sync signal during horizontal blanking. |
| 3 | Test | Not Connected |
| 4 | Test | Not Connected |
| 5 | Test | Not Connected |
| 6 | PAL/NTSC | This input is provided with an internal resistor pull-up to $V_{p}$. If this input is tied to $V_{s s}$ NTSC (262 vertical lines) is selected. If this input is tied to $V_{p}$ or allowed to float, PAL (312 vertical lines) is selected. |
| 7 | Obstacle Race | This pin is provided with an internal resistor pull-up to $V_{p}$. If this input is momentarily connected to $V_{s s}$, this game will be selected. Otherwise, this pin is normally open. |
| 8 | Rally Run | This pin is provided with an internal resistor pull-up to $V_{p}$. If this input is momentarily connected to Vss, this game will be selected. Otherwise, this pin is normally open. |
| 9 | PRO/AM Option | This pin is provided with an internal resistor pull-up to $V_{p}$. If this input is switched to $V_{\text {ss, }}$ the PRO (hard) mode is selected. Switching this pin to $V_{p}$ or allowing it to float selects the AM (easy) mode. |
| 10 | Time Out | This pin is provided with an internal resistor pull-up to $V_{p}$. If this input is momentarily connected to Vss , this game is selected. This pin is normally open |
| 11 | Moto Jump | This pin is provided with an internal resistor pull-up to $V_{p}$. If this input is momentarily connected to $\mathrm{V}_{\mathrm{ss}}$, this game is selected. This pin is normally open. |
| 12 | Game Reset and POR | The input to this pin is provided by an external RC network, which generates a reset signal. This network consists of a $100 \mathrm{~K} \Omega$ resistor from this pin to $\mathrm{V}_{\mathrm{p}}$ and a $0.1 \mu \mathrm{~F}$ capacitor from this pin to $\mathrm{V}_{\text {ss }}$. |
| 13 | Sound | The output of this pin is the sound for the bike engine, bus hit, crash, screech and a good jump. This output is designed to drive a PNP transistor, which in turn drives the game speaker. |
| 14 | Vss | This input is the negative power supply. |
| 15 | Test | Not Connected |
| 16 | Test | Not Connected |
| 17 | N.C. | Not Connected |
| 18 | Throttle | The input to this pin is an oscillator signal for controlling the motion of the bike and rider. |
| 19 | N.C. | Not Connected |
| 20 | N.C. | Not Connected |
| 21 | N.C. | Not Connected |
| 22 | Test | Not Connected |
| 23 | Clock In | The input to this pin is the 3.58 MHz oscillator. |
| 24 | Background | This output provides the background video signal. |
| 25 | Blanking | This output provides the horizontal composite blanking between each line of video information. |
| 26 | Sync | This pin provides the combined output of horizontal sync or vertical flybacks. |
| 27 | Object Output | The output of this pin is the video output signal for the bike, buses, score and obstacles. |
| 28 | $V_{p}$ | This input is the positive power supply. |

AY-3-8765

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots . . . . . . . . . . . . .$.
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . . . . . . $-20^{\circ}$ to $+70^{\circ} \mathrm{C}$
Ambient Operating Temperature Range ................. $0^{\circ} \mathrm{C}$ to $+40^{\circ} \mathrm{C}$
Operating Voltage Supply Range . . . . . . . . . . . . . . . . . . . . +7.5 to +9 Volts
Standard Conditions (unless otherwise noted)
Parameter values at $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied - operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: |
| Clock In (Pin 23) |  |  |  |  |
| Frequency | - | - | MHz | Nominal 3.579545 |
| Input low voltage | Vss -0.3 | Vss +0.3 | V |  |
| Input high voltage | Vss +6.5 | $\mathrm{V}_{\mathrm{p}}$ | V |  |
| Duty Cycle | 35 | 65 | \% | Clock swing from 0 to $\mathrm{V}_{\mathrm{p}}$ |
| Throttle (Pin 18) |  |  |  |  |
| Frequency | 50 | 250 | KHz |  |
| Pulse width-positive | 1.5 | - | $\mu \mathrm{s}$ |  |
| Input low voltage | $V_{\text {ss }}-0.3$ | V ss +0.2 | V |  |
| Input high voltage | Vss +6.5 | $\mathrm{V}_{\mathrm{p}}$ | V |  |
| $\begin{aligned} & \text { Inputs (Pins 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, } \\ & 16,22 \text { ) } \end{aligned}$ |  |  |  |  |
| Input high voltage | Vss +6.5 | $V_{p}$ | V |  |
| Input low voltage | Vss -0.3 | $V_{s s}+0.2$ | V |  |
| Sound Output (Pin 13) |  |  |  |  |
| Voltage output low vol. | - | $\mathrm{V}_{\text {ss }}+0.5$ | V | Force 0.75 mA at $\mathrm{V}_{\mathrm{p}}=7.5 \mathrm{~V}$ |
| FTC Out (Pin 19) Voltage output low (Vol) | - | $\mathrm{V}_{\text {ss }}+0.5$ | V | Force 0.5 mA at $\mathrm{V}_{\mathrm{p}}=7.5 \mathrm{~V}$ |
| Other Outputs (Pins 1, 2, 24, 25, 26, 27) | - | $\mathrm{V}_{\mathrm{ss}}+0.5$ | V | Force 1.0 mA at $\mathrm{V}_{p}=7.5 \mathrm{~V}$ |
| Voltage output low ( $\mathrm{V}_{01}$ ) | - | - | - |  |
| Power Supply Current | - | 75 | mA | At $\mathrm{V}_{\mathrm{p}}=7.5 \mathrm{~V}$ |

## TUNING

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE Number |
| :---: | :---: | :---: | :---: |
| Television |  |  |  |
| ECONOMEGAIIA digital tuning SYSTEM | Provides electronic control of a varactor tuned TV from keyboard entry. | AY-3-8211 | 10-4 |
| FREQUENCY LOCKED LOOP TUNING SYSTEMS | Provides frequency locked loop tuning in radio, TV applications. | Economega 10 It | 10-8 |
| PHASED LOCKED LOOP TUNING SYSTEM SYNTHESIZER | Provides PLL frequency synthesis for color TV tuning. | Economegan | 10-19 |
|  |  | AY-3-2012 | 10-22 |
|  |  | CT2010 | 10-27 |
|  |  | CT2017 | 10.29 |
| PHASED LOCKEDLOOP TV TUNINGSYSTEM CONTROL | Provides control and interface for PLi television tuning. $\because$ | P1C1650-020 | 10-33 |
|  |  | ER1400 | 10-33 |
| Synthesizer/Counter |  |  |  |
| FREQUENCY SYNTHESIZER/ COUNTER | Provides a time base for frequency synthésizer counting. | AY-5-8105 | 10-44 |
| EAROM |  |  |  |
| 512 BIT EAROM | 512 bits organized $32 \times 16$. | ER2051 | 10-48 |
|  |  | ER2051 IR | 10-48 |
|  |  | ER2051 HR | 10-48 |

## Television

| FUNCTION | DESCRIPTION | PART NUMBER | PAGE NUMBER |
| :---: | :---: | :---: | :---: |
| ECONOMEGA IIA DIGITAL TUNING SYSTEM | Provides efectronic control of a varactor tuned TV from keyboard entry, | AY-3-8211 | 10-4 |
| FREQUENCY LOCKED LOOP TUNHN SYSTEMS | Provides frequency locked loop tuning in radio, TV applications. | Economega ill | 10-8 |
| PHASED LOCKED LOOP TUNING SYSTEM SYNTHESIZER | Provides PLL frequency synthesis for color TV tuning | Economega N | 10-19 |
|  |  | AY-3-2012 | 10-22 |
|  |  | CT2010 | 10-27 |
|  |  | CT2017 | 10-29 |
| PHASED LOCKED LOOP TV TUNING SYSTEM CONTROL | Provides control and interface for PLL television tuning. | PIC1650-020 | 10-33 |
|  |  | ER 1400 | 10-33 |

## ECONOMEGA IIA Digital Tuning System

## FEATURES

- 16/32 Program Options
- 4 Bands
- 14 Bit Tuning Resolution on B3
- Program Copyıng
- Non-Volatile Memory without Battery
- Manual Up/Down Tuning
- Manual Band Switching
- Mute Output at Program Selection
- Search Active Output
- Local Program Up/Down Control
- Validate Circuitry
- Referenced Tuning Waveform Output
- Band Step Option 3/4 Select


## DESCRIPTION

The Economega IIA Digital Tuning system is a voltage synthesizer for both Radio and TV manual tuning applications.
The AY-3-8211 N-Channel control chip interfaces directly with an ER1400 non-volatile memory enabling storage of up to 32 programs.
Variable mark space ratio tuning information from the AY-3-8211 is amplified and filtered, and the resulting DC level used to control the TV or Radio tuner

## OPERATION

Tuning-Resolutions are as follows:

|  | Option 1 | Option 2 |
| :--- | :--- | :---: |
| B1 (Band 1) | 11 bits (16mV) | 12 bits ( 8 mV ) |
| B2 (Band III), B4 | 12 bits ( 8 mV ) | 13 bits ( 4 mV ) |
| B3 (UHF) | 14 bits (2mV) | 14 bits (2mV) |

These are the tuning information incrementing resolutions controlled by the Tune Up/Down, Band Inputs, and Fine Tune inputs. Voltages relate to approximately 30 volt tuning range.

Fine Tune-The Fine Tune steps approximately 8 times per second (related to system clock). The Fine Tune input is disabled when searching (Band inputs pressed or Tune Up/Down active) and when Mute is active Tuning resolutions as above.

Scanning-The actual tuning rates, fixed by the Tunıng Clock, may be adjusted over a wide limit, typical figures are quoted below
Operation of a Band Input or Tune Up/Down initiates scanning on the selected band, and the Search O/P goes low.
Typical Scan rates are as follows:

|  | Scan Time |  |
| :---: | :---: | :---: |
| Band | Option 1 | Option 2 |
| 1 | 1.25 sec | 25 sec |
| 2,4 | 2.5 sec | 5 sec |
| 3 | 10 sec | 10 sec |

This corresponds to a Tuning Clock of approximately 1.6 KHz .
When the Tuning Output overflows, scanning pauses for 256 ms to allow time for the tuning voltage, and if in Band Step Mode, the Band outputs to settle.
This pause occurs at the bottom of the tuning range when tuning up and at the top of the tuning range when tuning down.

Muting-When a program change is made, at Power ON, and 10-4

## PIN CONFIGURATION

40 LEAD DUAL IN LINE
Vap View
16/32 Option Input

Standby to OFF, the mute output is activated for 256 msecs and disables the Fine Tune inputs for this time, Mute $O / P$ is also active while scanning; i.e. when a Band I/P or Tune Up/Down I/P is active.

Tuning Procedure-Three tuning procedures are available:
(a) 1 Select required program number (1 to 16 or 32).
2. Press required band button, scanning commences from the station currently tuned, scanning stops immediately upon release of button.
3. Fine tune if required.
4. Tuning information is stored automatically upon release of band button or release of Fine Tune button.
5. Tuning information may be copied by pressing Copy and selecting a new program number.
(b) With Tuning Option selected:

1. Select Band-this is latched on.

2 Tune Up or Down using Tune Up/Down Input
3 Fine Tune if required.
4. Tuning information is stored automatically upon release of Tune Up/Down or release of Fine Tune Up/Down.
5. A program location is selected by first pressing Copy and then selecting the required Program number.
(c) With Band Step 3 or 4 selected and Tuning Option Selected:

1. Select band-this is latched on.
2. Tune Up or Down (Tuning will now follow from band to band).
3. Once a station is tuned, release Tune Up/Down and Fine Tune, if required.
4. Tuning information is stored automatically upon release of Tune Up/Down or release of Fine tune Up/Down.
5. A Program location is selected by first pressing copy and then selecting required program number.

Output Signals-Tuning voltage and Band outputs are not disturbed by internal sequences, for example; STORE and COPY. Only program change will disturb these outputs-program change being either a change of band and/or tuning information.

Memory Recall-The memory recall sequence is triggered by a program change and, after the 256 millisecond Power On reset. The sequence is as follows:
a) $\mathbf{2 0}$ millisecond antibounce delay on the I/O Select or Program inputs.
b) Mute and Fine Tune input inhibit triggered for 256 milliseconds and memory read initiated.
c) Approximately 12 milliseconds after initiation of memory read, new tuning and band information will be output.
d) Remainder of the $\mathbf{2 5 6}$ milliseconds period allows time for the band drives and tuning voltage to settle.

Power On-At power on ( $\mathrm{V}_{\mathrm{cc}}$ On), a 256 millisecond reset allows the power supplies to settle. Mute is active for this period and all inputs are inhibited. At the end of this 256 millisecond period a memory recall sequence is triggered.
Three recall modes are possible:
a) I/O select low (input) mode-in this case band and tuning voltage information will be output for the program number input.
b) I/O select high (output) mode-program 1 together with associated band and tuning voltage information will be output.
c) I/O select open circuit-program 1 band and tuning information will be output. If I/O Select goes high, program 1 will be output on the Program I/O lines.

Standby-When leaving standby, Mute is activated for 256 milliseconds, and all inputs are inhibited. A memory recall sequence now follows this delay period. Memory recall occurs regardless of program change status. Three Standby off modes are possible:
a) I/O Select in either output mode or open circuit. Program information will be as it was prior to Standby.
b) I/O Select in input mode, program remains unchanged. Program information will be as it was prior to Standby.
c) I/O Select in input mode and program changed. The new program information will be output during the memory recall sequence.

Tuning Output Waveform-The tuning output is a rectangular waveform of variable mark space ratio. This output is filtered to produce the tuning voltage. The mark space ratio and tuning voltage can be varied, up to a maximum resolution on Band 3, of 14 bits. See Tuning for the resolutions on other bands.
Seven fundamental frequency components can be present in the output waveform, depending upon tuning position. The following table lists these frequencies together with their maximum effective mark space ratioss The condition for which all 7 components make up the output waveform would result in a condition of maximum ripple at the output of the tuning filter. The worse case tuning voltage ripple can, therefore, be determined.

TABLE 1 FUNDAMENTAL TUNING WAVEFORM COMPONENTS

| Frequency | Mark/Space Ratio |
| :---: | :---: |
| 4 kHz | $1: 1$ |
| 2 kHz | $1: 511$ |
| 1 kHz | $1: 1023$ |
| 500 Hz | $1: 2047$ |
| 250 Hz | $1: 4095$ |
| 125 Hz | $1: 8191$ |
| 62.5 Hz | $1: 16383$ |



Fig. 1 PROGRAM STROBE TIMING
Any program input change is detected and, after a 20 millisecond antibounce period, the program lines are latched in and the corresponding tuning information output. The program lines must be stable for the 5 millisecond 'latch' time shown above.


Fig. 2 LATCHED PROGRAM TIMING
I/O Select to low converts the program lines to input mode and triggers a 20 ms antibounce period. The program lines are then latched into the chip and the corresponding tuning information output. The program data must be stable for the 5 ms latch period. I/O Select to high converts the program lines back to the output mode.

| INSTRUMENT | AY-3-8211 |
| ---: | :---: |

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
Voltage on any Pin with Respect to $\mathrm{V}_{\text {SS }}$ pin $\qquad$ -0.3 V to +20 V
Ambient Operating Temperature Range................ $.0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Storage Temperature Range $\qquad$ $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$

Standard Conditions (unless otherwise noted):
Temperature $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
$V_{S S}=0 \mathrm{~V}$
$\mathrm{V}_{\mathrm{CC}}=+12 \mathrm{~V}= \pm 10 \%$
System Clock $=1.44$ to $2.15 \mathrm{MHz}(2.048 \mathrm{MHz})$ Nominal ( 10.8 to 13.2 Volts)
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied - operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.


| AY-3-8211 | INSTRUMERAL |
| :---: | :---: |


| Characteristic | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Tuning Clock (15) |  |  |  |  |  |
| External Resistor to Vcc | 47 | - | 1000 | $\mathrm{K} \Omega$ |  |
| External Capacitor to $\mathrm{V}_{\text {ss }}$ | 1.0 | - | 220 | nf |  |
| Leakage to Vss (Tuning Clock OFF) | - | - | 1 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{cc}}$ |
| System Clock (33) |  |  |  |  |  |
| External Resistor to Vcc | 2 | - | 330 | $K \Omega$ |  |
| External Capacitor to $V_{\text {ss }}$ | 10 | - | 100 | pf | Normally adjusted for 16.0 KHz at Pin 7. |
| Valid 1 (27) Valid 2 (28) Inputs Low Level | * | - | 3 | V | * Note 4 |
| High Level | Vcc-3 | - | Vcc | V | Note 4 |
| Input Leakage to $V_{\text {ss }}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {cc }}$ |
| Valid Output (26) |  |  |  |  | Push Pull |
| Low Level | - | - | 1 | V | $\mathrm{Is}_{\text {INK }}=0.4 \mathrm{~mA}$ |
| High Level | $\mathrm{V}_{\mathrm{cc}}-1.0$ | - | - | V | IsOURCE $=1 \mathrm{~mA}$ |
| Tuning Output (29) |  |  |  |  | $\mathrm{V}_{\text {REF }}=5$ to 7.1 Volts |
| Low Level | - | - | 0.4 | V | $\mathrm{I}_{\text {SINK }}=500 \mu \mathrm{~A}$ |
| High Level | Vref-0.4 | - | - | V | Isource $=100 \mu \mathrm{~A}$ |
| Rise Time, Fall Time 10-90\% | - | - | 50 | ns | $C=10 \mathrm{pf}$ |
| Tuning Reference (30) | 5 | - | 7 | $V$ |  |
| Supply Current Vcc (40) | - | - | 50 | mA | $\mathrm{T}=70^{\circ} \mathrm{C}$ |

NOTES: 1. All Pull Ups, unless otherwise stated, are configured with depletion FET's with gate connected to source. They have nonlinear VI characteristics.
2. Rise time and fall times measured $\mathrm{V}_{\mathrm{CC}}-1$ to $\mathrm{V}_{\mathrm{CC}}-8$ Volts.
3. Tristate 'Pull Ups' and 'Pull Downs' are configured with enhancement FET's. They have non-linear VI characteristics.
4. Guard ring to clamp any input more negative than $\mathrm{V}_{\text {ss }}$. Maximum clamp current $=-100 \mu \mathrm{~A}$.

PIN FUNCTIONS


## Frequency Locked Loop Tuning Systems

## INTRODUCTION

Economega III is a powerful Frequency Locked Loop (FLL) tuning system with applications in Radio, TV and wherever the control of frequency or speed is required. It is based on the General Instrument PIC series of single chip microcomputers.
The FLL principle can be used for many applications with many varied implementations. Some examples are shown later but it should be emphasized that the system is specifically designed to be flexible and that variants having other features and cost/performance trade-offs can be provided.
Depending upon the requirements, the system will use any of the General Instrument PIC's (1650A, 1655A, 16C55, 1656, 1670, etc.) with or without an EAROM (ER1400, ER2055, etc.).
Low cost and simplicity are the key features of Economega III.

## TUNING SYSTEMS

## The Superheterodyne Receiver

Practically all Radio and TV receivers currently manufactured are of the Superheterodyne variety. These receivers mix the incoming signal with local oscillator to translate the signal to a third, fixed lower frequency called the Intermediate Frequency (IF). Most of the amplification and selectivity is provided at the IF, the signal is then demodulated to recover the Audio or Video. The receiver is tuned by varying the local oscillator frequency. The frequencies are related by the following equation:

$$
F_{\mathrm{S}}=F_{\mathrm{LO}}-F_{\mathrm{IF}}
$$

(in the typical case where the oscillator frequency is higher than the signal frequency).
To take a specific example in the FM Band,
if $F_{S}=87.7 \mathrm{MHz}, F_{\text {IF }}=10.7 \mathrm{MHz}$
then $F_{\text {Lo }}$ must be set to 98.4 MHz .
A simplified block diagram of an FM receiver is shown in Fig. 1

## Mechanical Tuning

The classical way to tune a receiver is to use a mechanical variable capacitor with a knob, slow motion drive, scale and pointer. This method is used in virtually all portable radios and in many low end TV sets (Figure 2).


Fig. 2 MECHANICAL TUNING


## Voltage Synthesis

The first mass production electronic tuning systems replaced the potentiometers with a digital store and a D/A convertor (Figure 4).
The digital words are stored in a non-volatile memory such as an ER1400. Since the tuning is fully electronic, it becomes relatively simple to add features that were previously difficult or uneconomic, such as favorite program storage, automatic tuning, remote control.

| Economega III | INSTRUERAN |
| :---: | :---: |

The systems so far described are all open loop and demand a high order of stability in all components to achieve long-term accuracy of tuning. Furthermore, there is no inherent readout of frequency availability, and expensive mechanical or electronic arrangements are necessary if readout is desired. Finally, if any component is changed, the receiver will have to be completely retuned. These disadvantages encouraged the adoption of closed loop systems where a highly stable quartz crystal is used as control reference.


Fig. 4 ELECTRONIC TUNING SYSTEM

## Phase Locked Loop (PLL) Frequency Synthesis

This was the first closed loop system to be adopted and was initially used in professional radio communications equipment which demand high stability and accuracy in extreme environments, using components that make it difficult or impossible to achieve the requirements using simpler techniques.
The basic system operates by phase locking a sub-multiple of the local oscillator frequency to a crystal controlled reference (for example a 1 KHz reference and a 1 MHz oscillator divided by 1000). By altering the division ratio, the oscillator frequency can be altered in steps (e.g. to 1.001 MHz by using a divide by 1001). The
local oscillator is varactor tuned and the tuning voltage is set by the output of a phase comparator which compares the reference and the divided local oscillator signal. As the oscillator tries to drift off frequency, the phase comparator output changes and the tuning voltage is readjusted to compensate. The rate at which corrections can be made is high, commonly more than 1000 per second. This is fast enough to improve the noise spectrum of a noisy oscillator or to reduce frequency modulation caused by mechanical vibration.
A basic PLL Synthesizer is shown in Figure 5.


| INSTRUERENT | Economega III |
| ---: | :---: |

Practical systems are often more complicated, especially where small frequency steps are required.
A typical system would contain a high frequency dual modulus divider (in ECL technology), a synthesizer (consisting of programable divider, reference divider and phase comparator), a buffer amplifier/filter, and a control block (usually a microcomputer). For certain well defined applications, some or all of the blocks may be contained in one integrated circuit.

## Frequency Locked Loop (FLL) Frequency Synthesis

The FLL synthesizer approaches the problem from a different direction. It assumes that it is fairly easy to make a low noise oscillator with good short-term stability (every conventional Radio and TV has one) and aims to add long-term stability and a means to accurately set the frequency.
At the heart of the system is a varactor tuner, the frequency of which is determined by the voltage stored on a capacitor. The basic stability of the tuner and the discharge rate of the capacitor are ideally specified so that uncorrected, the frequency would stay within acceptable limits for several seconds.
Longer-term stability is achieved by counting the frequency and
comparing it with the desired frequency. If the error exceeds acceptable limits a current pulse is fed to the capacitor to readjust the tuning voltage and bring the oscillator onto frequency. The amplitude and length of the pulse may be made proportional to the error to speed the initial tuning procedure.
To tune the system initially, it is desirable to repeat the frequency measurement fairly rapidly to minimize the tuning time. Once on tune, however, the measurements need only be made intermittently and measurement cycles may be omitted as desired. The system because of this, lends itself to implementation in software and the system control microcomputer can do the tuning as well. Compared to a PLL. the synthesizer block has been eliminated. Another simplification is in the prescaler which can be a simple divider.
Frequency synthesizer systems inherently give a frequency readout and, since microcomputers are used as controllers, it is very easy to provide features to simplify operations and differentiate products (Figure 6).
There is only one application for which FLL is not entirely suitable; single sideband reception. For this class of transmission, a very high order of short-term stability is required, a simple FLL system does not control the frequency closely enough.


Fig. 6 BASIC FLL SYNTHESIZER

## ECONOMEGA III

## Introduction

Economega III is a family of Tuning Systems with a wide variety of applications. All the varıants have in common the FLL principle and the General Instrument PIC microcomputer. The implementation, however, varies considerably as each has a different trade-off between cost, performance and features.
Each member of the family is designated by a letter suffix (e.g. Economega III E) and an optional numerical suffix where there is a minor variant (e.g. Economega III E-1). The individual PIC used is identified by its type and pattern number (e.g PIC1650A-031). Full PIC data sheets are in the Microcomputer section of this catalog Six existing Economega III systems are briefly described and compared in the following sections.

## Economega IIIA

This system is programed for European TV applications and tunes 61 channels in 3 bands. Favorite program storage is provided in EAROM for 16 stations (Figure 7).

| Economega III | GENERAL |
| :---: | :---: |

The control loop has been optimızed to give high stability and low noise together with fast locking.
A PIC1650A microcomputer is used as the control element and an ER1400 as the favorite program store together with a $\div 4096$ prescaler $(\div 256, \div 16)$.

## FEATURES

- Tunes CCIR Channels 2-4, 5-12 and 21-71
- Three Bands
- Non-Volatile Storage of 16 Favorite Programs
- Fine Tune $\pm 4 \mathrm{MHz}$ in 50 KHz steps
- $2+2$ Digit Display of Program and Channel Number
- Lock Time 200 ms (max)
- 389 MHz IF
- Local Commands for Channel 10's, Channel 1's, Fine Tune Up, Fine Tune Down
- Parallel Remote Control Input for Program Number
- Customizıng Service Available


Fig. 7 ECONOMEGA III A BLOCK DIAGRAM

| INSTRUMENT | Economega III |
| ---: | ---: |

## Economega IIIB

This system is programed for USA TV applications and tunes 82 channels in 3 bands. Favorite channel storage is provided in EAROM. A remote control receiver function is incorporated. This, in addition to controlling the tuning, provides a main ON/OFF output and a 16 step volume control (Figure 8).
A PIC1650A microcomputer is used as the controller and an ER2055 as the favorite channel store together with a $\div 2048 / 4096$ prescaler ( $\div 128, \div 16 / 32$ ).

## FEATURES

- Tunes 82 Channels
- Three Bands
- Favorite Channels Stored in EAROM
- Built in Remote Control Receiver
- Main ON/OFF Output
- 16 Step Volume Control
- Local Control of Volume and Channel
- Output for On Screen Display
- Lock Time 200 ms (typ)
- Customizing Service Available



## Economega IIIC

This system is programed for USA TV applications and tunes 82 channels in 3 bands. Favorite channel storage is provided in RAM. A remote control receiver function is incorporated. This, in addition to controlling the tuning, provides a main ON/OFF output and a 16 step volume control (Figure 9).
A PIC1650A microcomputer is used as the controller together with $a \div 2048 / 4096(\div 256 ; \div 8 / 19)$ prescaler and a 2102 RAM for favorite channel storage.

## FEATURES

- 82 Channels
- Three Bands
- Favorite Channel Storage in RAM
- Two Digit LED Display
- Local Keyboard
- Built in Remote Control Receiver
- 16 Step Volume Control
- Main ON/OFF Output
- Lock Time 200 ms (typ)


Fig. 9 ECONOMEGA IIIC BLOCK DIAGRAM

| INSTRUMERA | Economega III |
| ---: | :---: |

## Economega IIID

This system is programed for USA Radio applications and tunes MW and FM bands. It has direct frequency entry, manual tuning and a seek function (Figure 10).
A PIC1656 microcomputer is used as the controller together with a $\div 16 / 640$ prescaler $(\div 80 ; \div 8 / 16)$.

## FEATURES

- AM Band 530 KHz to $1610 \mathrm{KHz}, 10 \mathrm{KHz}$ Channels, $455 \mathrm{KHz} / 260 \mathrm{KHz}$ IF
- Direct Frequency Entry
- Manual Tune Up/Down
- Seek
- Fine Tune Up/Down
- 4 Digit LED Display
- Customızing Service Available


Fig. 10 ECONOMEGA IIID BLOCK DIAGRAM

## Economega IIIE

This system is a high performance Radio Tuning System programed for European applications. It tunes MW and VHF bands and provides storage for 43 favorite programs, direct frequency entry, manual tuning with a knob, and search tuning (Figure 11).
Two PIC1650 microcomputers are used as the controllers, an AY-5-8105 as the FLL counter/display driver and an ER1400 as the favorite program memory together with $a \div 8 / \div 80$ prescaler.

## FEATURES

- MW Band 510 KHz to $1609 \mathrm{KHz}, 1 \mathrm{KHz}$ Steps, $455 / 459 / 460 / 468 \mathrm{KHz}$ Selectable IF

| Economega III | INSTRUMERANT |
| :---: | :---: |

- FM Band $87.4-108.1 \mathrm{MHz}$ Steps,
10.64/10.67/10.70/10.73/10.76MHz Selectable IF
- FM Channel Mode
- Storage of 43 Favorite Programs in EAROM
- Direct Frequency Entry with Automatic Range Selection
- Manual Knob Tuning
- Up/Down Search Tuning
- $2+5$ Digit Fluorescent Display
- Lock Time 300ms (typ)
- Very Low Oscillator Noise
- Customizing Service Available


Fig. 11 ECONOMEGA IIIE BLOCK DIAGRAM

| GENERAL | Economega III |
| ---: | :---: |

## Economega IIIE-1

This system is a variant of Economega III E. It is a high performance Radio TuningSystem programed forEuropeanapplications (Figure 12).
It tunes LW, MW and VHF bands and provides storage for 38 favorite programs, direct frequency entry, push button manual tuning, and search tuning.
Two PIC1650 microcomputers are used as the controller, an AY-58105 as the FLL counter/display driver and an ER1400 as the favorite program memory together with a $\div 8 / \div 80$ prescaler.

## FEATURES

- LW Band $150-265 \mathrm{KHz}, 1 \mathrm{KHz}$ Steps
- MW Band $520-1609 \mathrm{KHz}, 1 \mathrm{KHz}$ Steps
- FM Band $87.4-108.1 \mathrm{MHz}, 10 \mathrm{KHz}$ Steps
- AM IF Programable $455 / 459 / 460 / 468 \mathrm{KHz}$

■ FM If Programable $10.64 / 10.67 / 10.70 / 10.73 / 10.76 \mathrm{MHz}$

- Storage of 39 Favorite Programs (Including Audio Functions)
- Direct Frequency Entry with Automatic Range Selection
- Manual Push Button Tuning
- Up/Down Search Tuning, 9 KHz Channels AM, 50 KHz Channels FM
- $2+5$ Digit Fluorescent Display
- Lock Time 300ms (typ)
- Very Low Oscillator Noise
- Customizing Service Available


Fig. 12 ECONOMEGA IIIE-1 BLOCK DIAGRAM

COMPARISON CHARTS
TABLE 1 TV Tuning Systems - Performance Comparison
TABLE 2 TV Tuning Systems - Components Comparison
TABLE 3 TV Tuning Systems - Performance Comparison
TABLE 4 TV Tuning Systems - Components Comparison

TABLE 1 ECONOMEGA III TV TUNING SYSTEMS - PERFORMANCE COMPARISON

| System | Bands/Channels | Tuning | Storage | Display | Fine Tune | Performance | Other |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| III A | $\begin{aligned} & \text { CCIR } \\ & \text { I Ch2-4 } \\ & \text { III Ch5-12 } \\ & \text { IV/V Ch21-71 } \end{aligned}$ | Remote Program/ Number | EAROM (ER1400) <br> 16 Favorite Programs | $2+2$ Digit LED Program Channel Number | $\begin{aligned} & \pm 4 \mathrm{MHz} \\ & 50 \mathrm{KHz} \text { Steps } \end{aligned}$ | Gate Time 10 ms | Parallel Remote |
|  |  |  |  |  |  | Lock Time 200ms (max) | Control Input |
|  |  |  |  |  |  | Stability $\pm 25 \mathrm{KHz}$ | Power Supplies |
|  |  |  |  |  |  | Correction Rate: | +33V |
|  |  | Local Channel Step Fine Tune Up/Down |  |  |  | 8 Hz absolute ( max ) | +9V |
|  |  |  |  |  |  | 2 Hz (typ) | +5V |
|  |  |  |  |  |  |  | -26V |
| III B | USA <br> VHF LO Ch2-8 <br> VHF HI Ch6-13 <br> UHF Ch14-83 | Remote Channel Number | EAROM (ER2055) 82 Favorite Channels | On Screen | None |  |  |
|  |  |  |  |  |  | Gate Time 250 ms | On Chip Remote |
|  |  |  |  |  |  | Lock Time 200ms (typ) | Receiver with |
|  |  |  |  |  |  | Stability $\pm 50 \mathrm{KHz}$ <br> Correction Rate 4 MHz | Volume Control Power Supplies |
|  |  | Local Channel Up/ Down |  |  |  |  | +33V |
|  |  |  |  |  |  |  | +5V |
|  |  |  |  |  |  |  | -30V |
| III C | USA <br> VHF LO Ch2-6 <br> VHF HI Ch6-13 <br> UHF Ch14-83 | Remote | RAM 82 Favorite Channels | 2 Digit LED | None | Gate Time 250 ms | On Chip Remote |
|  |  |  |  |  |  | Lock Time 200 ms (typ) | Receiver with |
|  |  |  |  |  |  | Stability $\pm 50 \mathrm{KHz}$ | Volume Control |
|  |  |  |  |  |  | Correction Rate 4 MHz | Power Supplies |
|  |  | Local |  |  |  |  | $+33 V$ |
|  |  |  |  |  |  |  |  |

TABLE 2 ECONOMEGA III TV TUNING SYSTEMS - COMPONENT COMPARISON (Excluding Displays and Decoupling Components)

| System | LSI |  | MSI/Linear |  | Discretes |  | PCB |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| III A | PIC1650A | 1 | SP4541 | 1 | Resistors | 20 | Holes | 191 |
|  | ER1400 | 1 | CT2017 | 1 | Capacitors | 5 |  |  |
|  |  |  | 7493 | 1 | Diodes | 2 |  |  |
|  |  |  | 4049 | 1 | Transistors | 7 |  |  |
|  |  |  | 7447 | 1 | Crystal | 1 |  |  |
|  |  |  | LED Driver | 1 |  |  |  |  |
| III B | PIC1650A | 1 | Prescaler | 1 | Resistors | 33 | Holes | 241 |
|  | ER2055 | 1 | CT2017 | 1 | Capacitors | 4 |  |  |
|  |  |  | 7493 | 2 | Diodes | 3 |  |  |
|  |  |  | 7404 | 1 | Transistors | 8 |  |  |
|  |  |  | LM321 | 1 | Crystal | 1 |  |  |
| III C | PIC1650A | 1 | Prescaler | 1 | Resistors | 49 | Holes | 280 |
|  | 2102 | 1 | CT2017 | 1 | Capacitors | 4 |  |  |
|  |  |  | 7493 | 1 | Diodes | 3 |  |  |
|  |  |  | 7404 | 1 | Transistors | 6 |  |  |
|  |  |  | 7447 | 2 | Crystal | 1 |  |  |
|  |  |  | LM324 | 1 |  |  |  |  |


| GENERAL | Economega III |
| ---: | :---: |

TABLE 3 ECONOMEGA III RADIO TUNING SYSTEMS - PERFORMANCE COMPARISON

| System | Ranges | Resolution | Tuning Methods | Storage | Display | Performance | Other |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| III D | $\begin{aligned} & 530 \mathrm{KHz}-1610 \mathrm{KHz} \\ & 87.7 \mathrm{MHz}-108.1 \mathrm{MHz} \end{aligned}$ | $\begin{aligned} & 10 \mathrm{KHz} \\ & 200 \mathrm{KHz} \end{aligned}$ | Direct Entry <br> Manual Up/Down Seek | None | 4 Digit LED | Gate Time 300 ms <br> Lock Time <br> Stability <br> Noise <br> Correction Rate <br> Steps | ```Fine Tune AM \pm16KHz, 1KHz Steps FM \pm160KHz, 10KHz``` |
| III E | $\begin{aligned} & 510 \mathrm{KHz}-900 \mathrm{KHz} \\ & 850 \mathrm{KHz}-1609 \mathrm{KHz} \\ & 87.4 \mathrm{MHz}-108.1 \mathrm{MHz} \\ & \mathrm{CH}-\mathrm{Ch} 70+ \end{aligned}$ | $\begin{aligned} & 1 \mathrm{KHz} \\ & 10 \mathrm{KHz} \\ & 100 \mathrm{KHz} \end{aligned}$ | Direct Entry Seek Up/Down Knob | EAROM 43 Programs on any Range | $5+2$ Digit <br> Fluorescent | Gate Time 8ms <br> Lock Time 300 ms <br> Stability $\pm 0.5 \mathrm{KHz}$ AM $\pm 5 \mathrm{KHz} \mathrm{FM}$ <br> Noise 5 Hz p-p AM Correction Rate 1 Hz (typ) | Automatic Range Selection |
| III E-1 | $\begin{aligned} & 150 \mathrm{KHz}-265 \mathrm{KHz} \\ & 520 \mathrm{KHz}-1609 \mathrm{KHz} \end{aligned}$ <br> 87.4MHz-108.1MHz <br> Audio 1, 2, 3 | 1 KHz Manual 9KHz Seek <br> 10 KHz Manual 50 KHz Seek | Direct Entry Seek Up/Down Manual Up/Down | EAROM 39 Programs on any Range | $5+2$ Digit <br> Fluorescent | Gate Time 8 ms <br> Lock Time 300 ms <br> Stability $\pm 0.5 \mathrm{KHz}$ AM $\pm 5 \mathrm{KHz}$ FM <br> Noise 5 Hz p-p AM 200 Hz p-p FM <br> Correction Rate 1 Hz (typ) | Automatic Range Selection <br> 3 Audio Ranges |

TABLE 4 ECONOMEGA III RADIO TUNING SYSTEMS - COMPONENT COMPARISON
(Exciuding Dispiays and Decoupling Componenis)

| System | LSI |  | LSI/Linear |  | Discretes |  | PCB |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| III D | PIC1650 | 1 | SP8627 | 1 | Resistors | 37 | Holes | 217 |
|  |  |  | 74LS93 | 1 | Capacitors | 7 |  |  |
|  |  |  | 4016 | 1 | Diodes | 9 |  |  |
|  |  |  |  |  | Transistors | 15 |  |  |
|  |  |  |  |  | Crystal |  |  |  |
| III E | PIC1650 | 2 | SP8794 | 1 | Resistors | 56 | Holes | 320 |
|  | AY-5-8105 | 1 | 74LS90 | 1 | Capacitors | 12 |  |  |
|  | ER1400 | 1 | LM324 | 1 | Diodes | 6 |  |  |
|  |  |  | CA3080 | 1 | Transistors | 8 |  |  |
|  |  |  | CA3130 | 1 | Crystal | 1 |  |  |
| III E-1 | PIC1650 <br> AY-5-8105 <br> ER1400 | 2 | SP8794 | 1 | Resistors | 47 | Holes | 293 |
|  |  | 1 | 74LS90 | 1 | Capacitors | 10 |  |  |
|  |  | 1 | LM324 | 1 | Diodes | 5 |  |  |
|  |  |  | CA3080 | 1 | Transistors | 7 |  |  |
|  |  |  | CA3130 | 1 | Crystal | 1 |  |  |

## ECONOMEGA IV

## PLL Tuning System

## FEATURES

- 100 Channel Tuning Capability - Includes All CCIR Standard Channels, Italian and Australian Special Channels
- 32 Favorite Programs
- Automatic Sweep Tuning Option (with Automatic Fine Tune)
- Fine Tune in 50 KHz Steps (Manual for Stable Transmitters, Automatic for Unstable Transmitters)
- Two Digit Channel Display
- Two Digit Program Display
- EAROM Non-Volatile Memory
- Lock Up Time 10 ms (typ)


## DESCRIPTION

Economega IV is a PLL Frequency Synthesizer system designed for accurate tuning of Color TV. It consists of the following five chips.
(a) Prescaler and preamplifier - CT2010 8 pin DIL
(b) Frequency Synthesizer - AY-3-2012 24 pin DIL
(c) Controller - AY-3-1650 40 pin DIL
(d) Non-Volatile Memory (optional) - ER1400 14 pin DIL
(e) Peripheral Circuit - CT2017 18 pin DIL.

The controller is microcomputer based and can be reprogramed to provide features and channels as required, with or without favorite program memory and direct channel tuning.

## FEATURES PROVIDED WITH CONTROLLER

## AY-3-1650-20

## Channel Entry

Two buttons, tens and units, allow the channel to be set. When operated the number increments every 0.5 sec (there is no carry from the units). On release of the button the channel number is stored in the memory against the selected Program Number.

## Program Entry

Activation of parallel 5 bit binary input recalls the required program.

## Program Display

Available as a 2 digit multiplexed BCD output.

## Channel Display

Available as a 2 digit multiplexed BCD output.

## Manual Fine Tune Up/Down

50 KHz steps with a range of +4.0 MHz and -3.95 MHz around the selected channel with roll over at both ends. On depression of the button one step is made. After a delay of 0.4 sec , steps are made every 50 ms . The fine tuning is automatically stored on release of the button.

## Automatic Fine Tune

This mode is selected if the Auto/Manual button is pressed. The status for any program is stored in the EAROM. The Fine Tuning is then controlled by the output of the AFC discriminator and the system will track the incoming signal within $\pm 25 \mathrm{KHz}$. If there is no signal present, the system will search within a range of $\pm 4 \mathrm{MHz}$ in 50 KHz steps at a rate of 12 ms per step.

## Auto Sweep Mode

Operating the Auto Sweep button causes the system to sweep though all channels in steps of 250 KHz at a rate of 100 steps per second. The channel number is incremented appropriately. When a station is found, the sweep stops and the Auto Fine tune mode is entered.

## Band Output

4 outputs are provided.

## Memory

An ER1400 non-volatile memory is used to store the channel, Fine Tune offset, and Fine Tune mode for each of the 32 programs.

## Power Up

At switch on, Program 1 is selected.

## PLL Tuning System - Synthesizer Block

The three devices described form the synthesizer block of the ECONOMEGA IV system, a complete family of integrated circuits for frequency synthesis in television receivers. The Phase Locked Loop is controlled via the Data Bus by a Control Block, which consists of a PIC1650 microcomputer and an ER1400 non-volatile memory.
The CT2010 and CT2017 are manufactured by Plessey Semiconductors and data is included for information only.



## Economega IV PLL Synthesizer Divider

## FEATURES

- 50 KHz Tuning Resolution, Range Approximately 80 to 1000 MHz
- Fine Tuning Range; -3.95 to +4.00 MHz in 50 KHz Steps
- 4 MHz Crystal Oscillator Reference


## DESCRIPTION

The AY-3-2012 forms part of the Economega IV phase locked loop TV tuning system. The chip is a synthesizer divider circuit fabricated in N channel MOS. Functions include a programable divider, reference oscillator and divider, phase/frequency comparator, prescaler modulus controller, and a band decoder. Tuning data is shifted into the chip under control of a PIC1650A microprocessor.

## PIN CONFIGURATIONS

24 PIN DUAL IN LINE


## Pin Functions

| Pin Number | Name | Function |
| :---: | :---: | :---: |
| 1-4 | $\mathrm{H}_{0}-\mathrm{H}_{3}$ Inputs | 4 Bit data highway $\mathrm{H}_{0}$ is LSB. $4 \mathrm{~K} \Omega$ (nom) pull up to +5 V |
| 5 | MPX Clock Input | Highway timing input |
| 6 | Reference Clock Output | 2.5 KHz output derived from 4 MHz clock |
| 7 | - |  |
| 8 | $V_{D D}$ | +5V (nom) Supply |
| 9 | Band 3 Output | Open drain band output, on when Band 3 is selected. Select by Code 01 |
| 10 | Band 2 Output | Open drain band output, on when Band 2 is selected. Select by Code 11 |
| 11 | Band 4 Output | Open drain band output, on when Band 4 selected. Select by Code 10 |
| 12 | Band 1 Output | Open drain band output, on when Band 1 is selected. Select by Code 00 |
| 13 | AV Output | Open drain output, on when AV Band input and AV input are both high |
| 14 | AV Band Input | input from band switch to allow AV mode to be selected |
| 15 | AV Input | Input from program decoder to allow AV mode to be selected |
| 16 | Modulus Control Output | Output to CT2010 prescaler to control the division ratio |
| 17 | Oscillator Monitor Output | 50 KHz output used to set the oscillator frequency |
| 18 | Crystal Trimmer | Oscillator input pin |
| 19 | $\div \mathrm{N}$ Out | Programable divider output used for test purposes |
| 20 | Crystal | Oscillator output pin |
| 21 | $\div \mathrm{N}$ In | Input from prescaler to programable divider |
| 22 | $\phi$ UP | Output to charge pump to raise oscillator frequency |
| 23 | $\phi$ DOWN | Output to charge pump to lower oscillator frequency |
| 24 | $\mathrm{V}_{\text {ss }}(0 \mathrm{~V})$ | Connect to zero volts |

## SYSTEM DESCRIPTION

The AY-3-2012 contains six main sections:

1. A section to recognize the Tune code (hexadecimal 1D) or Fine Tune code (hexadecimal 1E) on the data highway $\mathrm{H}_{3}$ to $\mathrm{H}_{0}$ and then latch the following relevant tuning information.
2. A 10 bit programable divider synchronously loaded with Tune data and counted down to part of the Fine Tune data. The amplifier on the clock input to the divider enables operation with a small swing from the output of the prescaler (CT2010). The small prescaler output keeps radiation and, hence, interference to a low level.
3. A fine tuning system which generates pulses to control the modulus of the prescaler enabling 50 KHz shifts in synthesized frequency.
4. A crystal oscillator circuit (for 4 MHz crystal) and fixed $\div 1600$ divider to give the 2.5 KHz comparison or reference frequency and the fine tuning timing.
5. A phase/frequency comparator for the programable divider and fixed divider outputs. Comparison frequency 2.5 KHz .
6. Logic for band decoding and for video time, constant switching for audio/visual (AV) mode.

## Tune Operation Highway Information Order

|  | $\mathrm{H}_{3} \mathrm{H} 2$ | H1 | H0 | Control code to synthesizer |
| :---: | :---: | :---: | :---: | :---: |
| TUNE CODE | 00 | 0 | 1 |  |
|  | 11 | 0 | 1 |  |
| DATA | 00 | 0 | 0 |  |
|  | 00 | 0 | 0 | Unused time slots |
|  | 00 | 0 | 0 |  |
|  | B1 B0 | Q9 | Q8 |  |
|  | Q7 Q6 | Q5 | Q4 | Band Frequency |
|  | Q3 Q2 | Q1 | Q0 | and Offset |
|  | 00 | 0 | R4 |  |
|  | R3 R2 | R1 | R0 |  |
| FINISH CODE | $\mathrm{X} \times$ | X | X |  |

## Fine Tune Operation

|  |  | H3 | H2 | H1 | H0 |
| :--- | :--- | :---: | :--- | :--- | :--- |
| FINE TUNE | C1 | 0 | 0 | 0 | 1 |
| CODE | C2 | 1 | 1 | 1 | 0 |
| DATA | D1 | F7 | F6 | F5 | F4 |
|  | D2 | F3 | F2 | F1 | F0 |
| FINISH CODE | $X$ | $X$ | $X$ | X |  |

Control Code
Fine Tune Number

An ' 0 ' refers to an input low level and a '1' refers to an input High level.

Four binary numbers define the synthesized frequency of the loop:

1. $Q$; a 10 bit number ( $Q_{9-0}$ ) loaded into the programable divider. This sets the synthesized frequency to the nearest 1 MHz .
2. $R$; a 5 bit number ( $R_{4-0}$ ) controlling the number of Fine Tune modulus control pulses. Zero to 19 steps of 50 KHz each reduce the synthesized frequency by up to 950 KHz . Combining $Q$ and $R$ the frequency is set to a resolution of 50 KHz .
3. $F$; an 8 bit number $\left(F_{7-0}\right)$ the four least significant bits of which provide 0 to 19 steps of 50 KHz each, similar to Fine Tune. The three most significant bits operating on the programable divider. Combining the effect of these two provides fine tuning of -3.95 MHz to +4.00 MHz around the channel center.
4. $B$; a 2 bit number ( $B_{1-0}$ ) selecting one of 4 bands.

## TUNING RANGE

Combining the Fine Tune range with the programable divider range allows tuning of the local oscillator, for all television broadcast channels in Bands I, II, IV and V, to within 25 KHz of channel center. In practice, all television channels are integer multiples of 50 KHz and so may be received exactly apart from any crystal frequency error. This frequency error can be trimmed out.
The Fine Tuning system gives a range of -3.95 to +4.00 MHz around the channel frequency.

## BAND AND AV LOGIC

Four open drain band outputs are provided for driving external PNP band switch transistors.
If AV Band and AV IN are both high then AV OUT will go low: this can be used to change the time constant of the video synchronizing circuit to suit domestic video recorders. The AV Band pin would be connected to the appropriate band switch transistor.

## PHASE COMPARATOR

Outputs $\phi$ UP and $\phi$ DOWN are generated by the phase comparator from the programable divider output and from the reference clock to give pulses whose length depends on the time difference between the rising edges of these signals. If Reference clock rises first the pulse will occur on $\phi$ DOWN. These phase comparator outputs control the loop integrator.
During the time used to demultiplex new tuning data, both outputs of the phase comparator are blocked in order to prevent erroneous
ramping when changing from one channel to another. This could occur for channels close in frequency but having very different values in the more significant bits, which are latched first. As an example, consider the change from $Q=1000000000$ to 011111 1111, a shift of 1 MHz , but the value will momentarily be 010000 0000 and 0111110000 before settling to the correct value. This represents spurious shifts of 256 and 16 MHz .

## REFERENCE GENERATION

The crystal oscillator is based on the well known Pierce circuit providing a sine wave output of sufficient purity to avoid picture patterning from radiation.
The circuit is chosen to prevent overtone oscillation with a 4 MHz series resonant crystal, and may be driven externally, if preferred. The oscillator output drives a fixed $\div 1600$ to provide the 2.5 KHz reference or comparison frequency. By decoding various states of the reference divider, the timing signals needed for the Fine Tuning and Fine Offset system are produced.
To aid accurate setting of the crystal trimmer capacitor, a 50 KHz output is provided.

## POWER ON

After power is applied to the chip, 16 Multiplex Clocks must be transferred to initialize the data decoder. Tune and Fine Tune codes may then be transferred.

## SIMPLIFIED TIMING DIAGRAMS

NOTE: Control Codes C1, C2 are latched ( $\uparrow$ ) on the rising edge of Multiplex Clock, Data D0...on the following edge


Fig. 1 HIGHWAY TIMING FOR TUNE


Fig. 2 FINE TUNING


Fig. 3 PHASE DETECTOR OUTPUTS


Fig. 4 CHANNEL SWEEP - TIMING DIAGRAMS


TUNING

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin (except Band and AV Outputs)

Voltage on Band and AV Outputs with Respect

Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ}$ to $+125^{\circ} \mathrm{C}$
Ambient Operating Temperature Range $\ldots \ldots \ldots \ldots \ldots . .0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated):
$V_{\mathrm{SS}}=0 \mathrm{~V}$
$V_{D D}=+5 \mathrm{~V} \pm 10 \%$
$T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Nominal Reference Clock frequency $=4 \mathrm{MHz}$

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\div$ - $n$ put (21) |  |  |  |  |  |  |
| Level | - | 200 | - | - | $m V_{\text {PP }}$ | AC coupled Sine Wave |
| Capacitance | - | - | - | 10 | pf |  |
| Frequency | $F_{\text {IN }}$ | 0.1 | - | 2.8 | MHz |  |
| $\mathrm{H}_{0}$ to $\mathrm{H}_{3}$ Data Inputs (1 to 4) |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\text {IL }}$ | - | - | 0.8 | v |  |
| High Level | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{DD}}-1$ | - | - | V |  |
| Pull Up Resistance | - | 2 | - | 6 | $\mathrm{K} \Omega$ | Note 1 |
| Capacitance | - | - | - | 10 | pf |  |
| Multiplex Clock Input (5) | MPX |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\text {IL }}$ | - | - | 0.8 | V |  |
| High Level | $\mathrm{V}_{\mathrm{IH}}$ | $V_{D D}-1$ | - | - | V |  |
| Leakage | - | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ |
| Capacitance | - | - | - | 10 | pf |  |
| Frequency | - | DC | - | 500 | KHz |  |
| Rise Time/Fall Time | $t_{\text {R }}, t_{\text {f }}$ | - | - | 200 | ns |  |
| AV Inputs (14 \& 15) |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\mathrm{IL}}$ | - | - | 0.8 | v |  |
| High Level | $\mathrm{V}_{\mathrm{IH}}$ | $V_{D D}-1$ | - | - | V |  |
| Leakage |  | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ |
| Capacitance | - | - | - | 10 | pf |  |
| 4MHz Clock Input (18) (if driven externally) |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\text {IL }}$ | - | - | 0.8 | v |  |
| High Level | $\mathrm{V}_{\text {IH }}$ | $\mathrm{V}_{\mathrm{DD}}-1$ | - | - | v |  |
| Input Current: |  |  |  |  |  |  |
| Low level source | $1 / 1$ | - | - | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=0.8 \mathrm{~V} \quad \text { Note } 2$ |
| High level sink | $\mathrm{I}_{\mathrm{H}}$ | - | - | 100 | $\mu \mathrm{A}$ | $V_{I N}=V_{D D}-1 V$ |
| Band \& AV Outputs (9 to 13) |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 5 | V | $\mathrm{I}_{\mathrm{OL}}=1 \mathrm{~mA}$ sink |
| Off Leakage | - | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=13.2 \mathrm{~V}$ |
| Reference Clock Output (6) |  |  |  |  |  |  |
| Low Level | $\mathrm{V}_{\text {OL }}$ | - | - | 0.4 | V | $\mathrm{l}_{\mathrm{OL}}=2 \mathrm{~mA}$ sink |
| High Level | $\mathrm{V}_{\mathrm{OH}}$ | $V_{D D}-0.5$ | - | - | V | $\mathrm{I}_{\mathrm{OH}}=0.5 \mathrm{~mA}$ source |
| Modulus Control Output (16) |  |  |  |  |  |  |
| Low Level | - | - | - | 0.4 | v | $\mathrm{I}_{\mathrm{OL}}=0.3 \mathrm{~mA}$ sink |
| High Level | - | $V_{D D}-0.5$ | - | - | v | $\mathrm{I}_{\mathrm{OH}}=0.1 \mathrm{~mA}$ source |
| $\text { Outputs (22, } 23 \text { \& 17) }$ |  |  |  |  |  |  |
| Low Level | - | - | - | 0.4 | v | $\mathrm{I}_{\mathrm{OL}}=0.8 \mathrm{~mA}$ sink |
| High Level | - | $V_{D D}-0.5$ | - | 45 | V | $\mathrm{I}_{\mathrm{OH}}=0.1 \mathrm{~mA}$ source |
| Supply current | ID | - | - | 45 | mA | Outputs/Inputs unloaded |
| Data to Clock timings (See Fig. 1) Data/Instruction time | $t_{D}, t_{1}$ | 1 | - | - | $\mu \mathrm{s}$ |  |
| Data/Instruction to Clock Set Up Time | $\mathrm{t}_{\mathrm{DS}}, \mathrm{t}_{1 \mathrm{~S}}$ | 400 | - | - | ns |  |
| Data Instruction to Clock Hold Time | $\mathrm{t}_{\text {DH, }}, \mathrm{t}_{\text {IH }}$ | 100 | - | - | ns |  |

NOTE:

1. Pull ups are configured with diffused resistors.
2. Current from the device is defined as source current, current into the device is sink current.

## CT2010

## $1 \mathrm{GHz} \div 380 / 400$ Prescaler

## FEATURES

- On Chip Wideband Amplifier
- High Input Sensitivity
- High Input Impedance
- Low Output Radiation
- Single ECL Output
- 5V Logic Level Control Input
- Control Independent of Distortion and Delay


## DESCRIPTION

The CT2010 is a 380/400 two modulus divider which will operate at frequencies between 80 MHz and 1 GHz . The device is the prescaler used in General Instrument Economega IV Tuning System. The input is terminated by a nominal 50 ohms and should be AC coupled to the signal source. The reference pin should be AC decoupled. The decoupling should be effective over the full operating frequency range.
The divider contains a fixed divide by 20 followed by a divide by 19/20. The divide by $19 / 20$ divides by 20 when no control pulses are applied to the control input. The divide by $19 / 20$ will divide by 19 once for every positive going edge applied to the control pin. The control input edge is latched and synchronized so that the follow-

## PIN CONFIGURATION


ing output cycle, commencing with a negative edge, is produced by 380 input cycles to the whole divider stage, rather than 400 . This means that the device is highly tolerant of delay in the control loop and distortion of the control waveform.
To ensure that there is an output cycle produced by 380 input cycles for every control pulse, the rate of control pulses should not exceed half the output frequency. (See timing diagrams).
The output source impedance is nominally 100 ohms. The output swing is nominally 300 mV and swings down from the positive supply.

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
Supply Voltage, $\mathrm{V}_{\text {CC }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +7 F
UHF Input Voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 2.5 V p-p
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ}$ to $+125^{\circ} \mathrm{C}$
Operating Ambient Temperature . . . . . . . . . . . . . . . . . . $-10^{\circ} \mathrm{C}$ to $+65^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated):
$\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{AMB}}=25^{\circ} \mathrm{C}$

* Exceeding these ratings could cause permanent damage to these devices. This is a stress rating only and functional operation of these devicec at these conditions is not implied-operating ranges are specified in Standard Conditions Exposure to absolute maxımum rating conditions for extended periods may affect device reliability
Data labeled "typical" is presented for design guidance only and is not guaranteed.

| Characteristics | Pin | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Voltage Range | 1 | 4.5 | - | 5.5 | V |  |
| Supply Current | 1 | - | 90 | 110 | mA |  |
| Input Voltage, $\mathrm{V}_{\text {IN }} \quad 80 \mathrm{MHz}$ | 8, 6 | 17.5 | - | 200 | mV | rms, sine wave $50 \Omega$ |
| 300 MHz | 8, 6 | 17.5 | - | 200 | mV | rms, sine wave $50 \Omega$ |
| 500 MHz | 8, 6 | 17.5 | - | 200 | mV | rms, sine wave $50 \Omega$ |
| 700 MHz | 8, 6 | 17.5 | - | 200 | mV | rms, sine wave $50 \Omega$ |
| 1000 MHz | 8, 6 | 17.5 | - | 200 | mV | rms, sine wave $50 \Omega$ |
| Output Voltage Swing | 3 | 240 | 300 | - | mV | p-p, no load |
| Output Impedance | 3 | - | 100 | - | $\Omega$ |  |
| Control Input, High | 2 | $2 / 3 V_{c c}$ | - | - | V |  |
| Control Input, High | - | - | - | 50 | $\mu \mathrm{A}$ |  |
| Control Input, Low | - | - | - | $1 / 3 \mathrm{~V}$ cc | V |  |
| Control Input, Low | - | -10 | - | - | $\mu \mathrm{A}$ |  |
| Control Input Pulse Width | - | 0.2 | 3 | - | $\mu \mathrm{s}$ |  |


| GENERAL | CT2010 |
| ---: | :---: |



Fig. 1 CT2010 BLOCK DIAGRAM


Fig. 3 TYPICAL APPLICATION WITH COMBINED INPUT


Fig. 4 TIMING DIAGRAM

## CT2017

## Synthesizer Tuning Interface

## FEATURES

- Low Varicap Driver
- Active Filter Charge Pump
- Logic Level Control
- Signal Quality Detector
- AFC Input Option
- Auto Up, Auto Down Logic Level Tuning Correction
- Power Low Detector


## DESCRIPTION

The CT2017 is designed for use in Frequency Synthesis Tuning Systems, in particular the Economega IV System.
The device contains a charge pump with a high impedance voltage follower, a signal detect circuit, a digital AFC circuit and a PowerOn low detect circuit.
The charge pump is operated by two 5 V logic inputs, UP (active low) and DOWN (active high). These inputs turn on a charge current and discharge current respectively. The charge pump circuit and its voltage follower operate from the +33 V supply rail. The combined charge pump, external filter and voltage follower may be used as the filter and varicap driver for synthesis tuning systems.
The signal detect circuit is used in tuning systems capable of automatically sweeping the received broadcast bands. The circuit examines the line synchronization pulse and line flyback pulse for coincidence. When a regular supply of adequate coincident line synchronization pulses occurs, the filter voltage falls. This indicates a received signal of a sufficient strength to produce a viewable picture.
When the signal detect filter voltage is higher than the signal detectors threshold the AUTO UP and AUTO DOWN outputs are clamped at Logic ' 0 '. When the filter detect voltage is below the level detector's threshold the AUTO UP and AUTO DOWN outputs are enabled. The enabling of AUTO UP and AUTO DOWN may be used to indicate that a signal of adequate strength has been received and the sweep may be stopped.
Using appropriate external components, pin 5 may be used as a sync pulse separator, when fed with negative video or a positive line sync pulse input.
The signal strength recognized as adequate depends upon the signal to noise ratio at the input to pin 5 . This will depend on the type of sync separation used, whether noise gating is used and the noise figure of the signal processing circuits. A digital AFC

circuit, which comprises AFC level detector and correction tuning control, examines the AFC signal ('S' curve) produced by conventional television AFC circuits. The circuit produces an AUTO UP Logic ' 1 ' output when the AFC voltage is greater than the upper AFC threshold, and an AUTO DOWN Logic ' 1 ' output when the AFC voltage falls below the lower AFC threshold. Both outputs are Logic ' 0 ' when the AFC voltage is between the upper and lower thresholds.

## CORRECTION TUNING

The AUTO UP and AUTO DOWN outputs may be used to adjust the correction tuning number of a synthesis tuning system and hence produce a digitally quantized AFC.
The power low detector circuit compares the +5 V supply and the +12 V supply against internal reference levels. When either supply falls below its relevant reference level the delay capacitor is discharged and the power low detector reset output is set to logic ' 1 '. When the supplies exceed their relevant reference levels, the delay capacitor is charged to the threshold level, which turns on a transistor and the output is set to logic ' 0 ' after a delay.
The resulting output pulse may be used for setting the logic of the tuning synthesizer and for protecting the memory from corruption during power on and power off.

| GENERAL | CT2017 |
| ---: | :---: |



Fig. 1 CT2017 BLOCK DIAGRAM

| CT2017 | INSTRUMERAL |
| :---: | :---: |

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

+12V Supply ( $\mathrm{V}_{\mathrm{CC} 1}$ ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +20 V
+5 V Supply ( $\mathrm{V}_{\mathrm{CC} 6}$ )
+33V Supply ( $\mathrm{V}_{\mathrm{CC} 12}$ ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . + +40V
Operating Temperature Range . . . . . . . . . . . . . . . . . . . . $-10^{\circ} \mathrm{C}$ to $+65^{\circ} \mathrm{C}$
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
Standard Conditions (unless otherwise stated):
$\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC} 1}=+12 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC} 6}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC} 12}=+33 \mathrm{~V}$
Test Circuit: Fig. 2

* Exceedıng these ratıngs could cause permanent damage to these devices. This is a stress rating only and functional operation of these devicec at these conditions is not implied-operating ranges are specified in Standard Conditions Exposure to absolute maxımum ratıng conditıons for extended periods may affect device reliability.
Data labelea "typical" is presented for design guidance only and is not guaranteed.

| Characteristic | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Voltage Range |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC} 1}(+12 \mathrm{~V})$ | 1 | 10.8 | - | 13.2 | v |  |
| $\mathrm{V}_{\mathrm{cc6}}(+5 \mathrm{~V})$ | 6 | 4.5 | - | 5.5 | V |  |
| $\mathrm{V}_{\mathrm{CC} 12}(+33 \mathrm{~V})$ | 12 | 31 | - | 36 | V |  |
| Supply Current |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC} 1}(+12 \mathrm{~V})$ | 1 | - | 8 | 12 | mA |  |
| $\mathrm{V}_{\mathrm{CC6}}(+5 \mathrm{~V})$ | 6 | - | 12 | 20 | mA | $\mathrm{V}_{\mathrm{S}}=0 \mathrm{~V}, \mathrm{~V}_{10}=0 \mathrm{~V}, \mathrm{~V}_{11}=+5 \mathrm{~V}$ |
| $\mathrm{V}_{\mathrm{CC} 12}(+33 \mathrm{~V})$ | 12 | 3.3 | 4.5 | 5.5 | mA | $\mathrm{I}_{9}=2 \mathrm{~mA}, \mathrm{~V}_{10}=0 \mathrm{~V}, \mathrm{~V}_{11}=+5 \mathrm{~V}$ |
| Varicap Control |  |  |  |  |  |  |
| High Level Output Voltage | 7 | 29.5 | - | - | V | $\mathrm{I}_{9}=2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CC} 12}=+33.0 \mathrm{~V}$ |
| Continuous Source Current | 7 | - | - | 1 | mA | $\mathrm{V}_{\mathrm{CC12}}=33.0 \mathrm{~V}$ |
| Low Level Output Voltage | 7 | 0.5 | - | 0.9 | V | $\mathrm{VCC12}=33.0 \mathrm{~V}$ |
| Transient Sink Currents | 7 | 1.51 | - | - | mA | $\mathrm{I}_{9}=0.1 \mathrm{~mA}$ to 2.5 mA |
| Filter Leakage Current | 8 | - | - | 40 | mA | $\mathrm{V}_{11}=+5 \mathrm{~V}, \mathrm{~V}_{10}=0 \mathrm{~V}$ |
| $\overline{\text { UP Control Input Active }}$ | 11 | - | - | 1 | V |  |
| UP Control Input Inactive | 11 | 3 | - | - | V |  |
| $\overline{\text { UP Control Input Current }}$ | 11 | - | - | 50 | $\mu \mathrm{A}$ | $\mathrm{V}_{11}=+5 \mathrm{~V}$ |
| DOWN Control Input Active | 10 | 3 | - | - | V |  |
| DOWN Control Input Inactive | 10 | - | - | 1 | V |  |
| DOWN Control Input Current | 10 | - | - | 50 | $\mu \mathrm{A}$ | $\mathrm{V}_{10}=+5 \mathrm{~V}$ |
| AFC Control |  |  |  | 8 |  |  |
| Detector High Threshold | 16 16 | 4.1 | 7.5 4.5 | 8 4.9 | V |  |
| Detector Window | 16 | 2.8 | 3 | 3.2 | V |  |
| Input Current | 16 | - | - | 2.5 | $\mu \mathrm{A}$ | $\mathrm{V}_{16}=+12 \mathrm{~V}$ |
| Correction Tuning Outputs (AUTO UP, AUTO DOWN) |  |  |  |  |  |  |
| Voltage High | 17, 18 | 4.5 | - | - | V | $\begin{aligned} & V_{17}(\text { high })=D O W N, V_{18}(\text { high })=U P \\ & \text { Current Source }=50 \mu \mathrm{~A} \end{aligned}$ |
| Voltage Low | 17, 18 | - | - | 0.5 | V | Both low = inactive current sink $=2 \mathrm{~mA}$ |
| Line Flyback Threshold |  |  |  |  |  |  |
| High | 4 | 2 | - | - | v |  |
| Low | 4 | - | - | 0.7 | v |  |
| Negative Video Input |  |  |  |  |  |  |
| Threshold | 5 | - | 0.7 | - | V |  |
| Sync Pulse Switching Current | 5 | - | - | 12 | $\mu \mathrm{A}$ |  |
| Leakage Current | 5 | - | - | 0.3 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{S}}=-5 \mathrm{~V}$ |
| Coincidence Detector Enable | 2 | 4.5 | - | - | V |  |
| Inhibit | 2 | - | - | 2 | V |  |
| Threshold | 3 | - | 2.4 | - | V |  |
| Power on Detector Output Voltage | 15 | 4.5 | - | - | V | Current source $=50 \mu \mathrm{~A}$ |
| Normal | - | - | - | 0.5 | v | Current sink $=2 \mathrm{~mA}$ |
| Detector Threshold |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC} 1}(+12 \mathrm{~V})$ | 1 | 9.2 | 9.9 | 10.6 | v | See Fig 4 |
| $\mathrm{V}_{\mathrm{Cc} 6}(+5 \mathrm{~V})$ | 6 | 3.7 | 4 | 4.3 | V | See Fig 4 |
| Delay Capacitor Charging Current | 14 | - | 10 | - | $\mu \mathrm{A}$ |  |
| Delay Threshold | 14 | - | 9 | - | V |  |


| INSTRUMERAL | CT2017 |
| ---: | ---: |



Fig. 2 TEST CONFIGURATION


NOTES:

1. $T_{2}$ period timed by delay capacitor.
2. Output is connected to +5 V supply via pull-up resistor.
3. $T_{2}$ is set by value of capacitor, changing current, and output threshold voltage. Changing current is normally $10 \mu \mathrm{~A}$. Threshold voltage is normally 9 V .

Fig. 3 POWER LOW DETECTOR TIMING DIAGRAM (POWER ON)


Fig. 4 POWER LOW DETECTOR TIMING DIAGRAM (POWER OFF)

## Economega IV TV PPL Tuning System Control

## FEATURES

- 100 Channel Tuning Capability - Includes CCIR Standard Channels, Italian and German Cable Channels
- 32 Favorite Program Storage in Non-Volatile Memory (ER1400)
- Automatic Sweep Tuning Option (with Automatic Fine Tune)
- Fine Tune in 50 KHz Steps (Manual or Automatic)
- Two Digit Channel Number Display
- Two Digit Program Number Display
- Fast Lock Up Time, 10ms (typ)
- Parallel Remote Control Input
- 389 MHz IF
- Easily Reprogramed for Different Channels (e g US A.), Features and Interfaces (Inquire for Alternative Versions)


## DESCRIPTION

This specification describes a PIC1650-020 microcomputer which is used as a control chip in a phase locked loop television tuning system. The microcomputer interfaces with a number of subsystems which are detailed below.
1 AY-3-8475 I.R. Receiver. The PIC1650-020 accepts program numbers from the receiver thus allowing remote program selection.
2 ER1400. Electrically Alterable ROM The ER1400 is used to store Channel, Fine Tune and AFT data for each program. Information is stored and recalled by the PIC1650-020 as required.
3. CT2012 Frequency Synthesizer. The PIC1650-020 sends frequency and band data to the synthesizer. This data is ultimately used to determine the local oscillator frequency. The PIC1650020 also controls the AVIN signal to the synthesizer chip.
4. CT2017 Tunıng Interface. Signals from this chip are monitored by the PIC1650-020 when operating in CHANNEL SWEEP or AUTO MODES. The Tuning Interface chip also controls the PIC1650-020 master clear input via an external inverter.
5. User controls including SN7447A, BCD to Binary decoder/ driver.
(a) Four 7 segment displays which are used to display Program and Channel information.
(b) One LED to indicate if AUTO mode is selected.
(c) Seven push button switches for channel selection, local Program Selection, Fine Tuning and AUTO Mode selection.
6. The PIC1650-020 supplies a MUTE signal to mute the TV sound during Program and Channel change.

## OPERATION

## Program Selection (A0-A5)

32 remote programs can be entered via inputs (A0-A4) from the I.R. receiver AY-3-8475 These lines contain valid program information only when the STROBE input (A5) is low. Information on A0-A4 is in the range 0-31 representing programs 1-32 respectively.
The PIC1650-020 will tune the TV to a new program only if the STROBE is low and the program data on A0-A4 is different from the current program data.
Program numbers are used to address the ER1400 allowing the user to allocate a TV channel to each program.
The TV sound is muted for 600 ms at each program change.
Changes in program number are ignored if any of the local switches are pressed.

## ER1400 Interface (B0-B4)

To enable the ER1400 inputs to be pulled high to $V_{x x}$, PIC1650-020 pins (B0-B4) have open drain outputs with external pull up resistors as shown in Fig. 2.
The ER1400 contains 100 words of 14 bits. Two words are needed to store the 17 bits of information required for each program.
CHANNEL information for PROGRAM $N$ is stored at ER1400 address N. The corresponding FINE TUNE NUMBER and AFT information is stored at address $\mathrm{N}+40$.

## Address Formats

| Address | MSB | DATA |  |
| :--- | :--- | :--- | :--- |
| $N$ | $X X X X X X$ | CT.CT.CT.CT. | CU.CU.CU.CU. |
| $N+40$ | $X X X X X A F T$ | FT.FT.FT.FT. | FT.FT.FT.FT. |

$X=$ Not Used

CT = BCD digit for CHANNEL TENS data
$\mathrm{CU}=\mathrm{BCD}$ digit for CHANNEL UNITS data
AFT $=\mathrm{AUTO} / \mathrm{MANUAL}$ mode. $\mathrm{AFT}=1=\mathrm{AUTO}$ mode
FT $=$ FINE TUNE NUMBER
Data is written to the ER1400 when:

1. Either the CHANNEL TENS or CHANNEL UNITS switch is released.
2. Either the FINE TUNE UP or FINE TUNE DOWN switch is released.
3. AUTO switch is pressed.
4. AUTO mode is entered from CHANNEL SWEEP.

Data is read from the ER1400 when a new program is selected. The data is converted to a suitable format and then transferred to the synthesizer. If the Channel data read from the ER1400 is not a valid BCD number then the channel number is set to 00 . Under these conditions it is likely that the Fine Tune data from the ER1400 will also be non-valid. No attempt is made to correct this data. It is sent to the synthesizer as read from the ER1400.

## Frequency Synthesizer Interface (B6, B7, C0-C3) <br> AVOUT - (B6)

This output is normally low and goes high when programs 16 or 32 are selected. It is routed via the synthesizer and can be used to modify the time constant of the video synchronizing circuit of the television for use with video recorders.

Data Highway \& Clock - (B7, C0-C3)
Tune information is transferred to the synthesizer on a 4 bit highway which is shared with the display decoder/driver The synthesizer ignores data on the highway unless a clock is present. Clock signals (SYN CLK) are generated by the PIC1650-020 as required. A tıming diagram is shown in Fig. 3
When the power is initially switched on 16 clock pulses, with random data, are sent to initialize the synthesizer. Under normal operating conditions 11 clock pulses are required to transfer Tune data and 5 clock pulses are required to transfer Fine Tune Data.

| INSTRUMENL | PIC1650-020 ■ ER1400 |
| ---: | :---: |


|  | TUNE DATA FORMAT |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | H3 | H2 | H1 | H0 |  |
| SC1 | 0 | 0 | 0 | 1 | Control Code to |
| SC2 | 1 | 1 | 0 | 1 | synthesizer |
| SD1 | 0 | 0 | 0 | 0 |  |
| SD2 | 0 | 0 | 0 | 0 |  |
| SD3 | 0 | 0 | 0 | 0 |  |
| SD4 | B1 | B0 | Q9 | Q8 | Band and |
| SD5 | Q7 | Q6 | Q5 | Q4 | Frequency |
| SD6 | Q3 | Q2 | Q1 | Q0 | Number Data |
| SD7 | 0 | 0 | 0 | R4 | Fine Offset |
| SD8 | R3 | R2 | R1 | R0 | data |
| SC3 | X | X | X | X | Not Specified |

## NOTES:

1. Band Information is coded as follows: B1 B0
00 BAND 1 - VHF I
01 BAND 3-VHF III
10 BAND 4-UHF
11 BAND 2 - NOT USED
2. Q9-Q0 is a binary number representing the required tune frequency in MHz . The frequency is in the range 84 MHz to 914 MHz . Q9 is the most significant bit.
3. R4-R0 is a binary number in the range $0-19$. This is used to modify the tune frequency in 20 steps of 50 KHz . R4 is the most significant bit. An increase in the Fine Offset number means a corresponding decrease in frequency.

## FINE TUNE DATA FORMAT

\(\left.\begin{array}{lllll} \& H3 \& H2 \& H1 \& H0 <br>
SC1 \& 0 \& 0 \& 0 \& 1 <br>
SC2 \& 1 \& 1 \& 1 \& 0 <br>
SD1 \& F7 \& F6 \& F5 \& F4 <br>

SD2 \& F3 \& F2 \& F1 \& F0\end{array}\right\} \quad\)| Control Code to |
| :--- |
| SC3 |
| X |
| Synthesizer |
| FINE TUNE |
| NUMBER Data |

## NOTES:

1. F7-F0 is a binary coded modular 20 number which is used to modify the tune frequency in 160 steps of 50 KHz . F 7 is the most significant bit. An increase in the Fine Tune Number means a corresponding decrease in frequency.

## Tuning Interface (CT2017)

## UP and DOWN (A6, A7)

These inputs are derived from an AFC circuit within the television. They perform two functions. They signal a Stop Sweep when in CHANNEL SWEEP and they control the television Fine Tuning when in AUTO mode.

## Master CLear (MCLR)

The PIC1650-020 Master Clear signal is controlled via an external inverter by the POWER ON DET signal from the Tuning Interface chip. The Master Clear signal must be held low for at least 1 ms after all power supplies become valid. When the Master Clear signal goes high the PIC1650-020 will tune the TV to the channel allocated to Program 1.

## User Controls

Four common anode 7 segment displays are used to display Channel and Program information. Two digits are used to display channel information in the range 00 to 99 . Leading zeros are not blanked. The remaining 2 digits display the selected program. Program information lies in the range 1-32. Leading zeros are blanked.

Digits are displayed in turn by enabling 1 of the 4 digit driver transistors (C4-C7) and simultaneously outputting the corresponding segment code on $\mathrm{CO}-\mathrm{C} 3$. Each digit is enabled for approximately 3 ms in any 12 ms period.
As the segment outputs share a common highway with the synthesizer the display is blanked, by switching off all 4 digit drivers, during a data transfer to the synthesizer. This blanking is not noticeable during normal operation.
It is not possible to maintain the displays when writing to the ER1400. Displays are blanked for 80 ms each time a WRITE takes place.
Seven push button switches are mounted on the front panel. Only one switch is serviced at any one time, all other switches being inhibited until the current switch is released.
The following functions are controlled by the switches:

1. Increment Channel Tens
2. Increment Channel Units
3. Fine Tune Up
4. Fine Tune Down
5. Program Step
6. Channel Sweep
7. Auto

## Increment Channel TENS or UNITS (D0, D1)

These switches enabie the television to be tuned to any of 100 channels in the range 00-99.
Closure of the Channel Tens switch causes the Channel Tens display to increment one step and thereafter one step every 0.5 sec , overflowing from 9 to 0 , until the switch is released. At each step the appropriate TUNE data is transferred to the synthesizer and MUTE is activated for 600 ms .
Closure of the Channel Units switch causes the Channel Units to increment similarly, there being no overflow to Channel Tens.
In both cases, at every step, the Fine Tune Number is set to its mid-point (128) and transferred to the synthesizer.
On release of either switch the current channel and Fine Tune Number are stored at the appropriate ER1400 address.
Fine Tune Up and Fine Tune Down (D3, D4)
Closure of a switch causes a single Fine Tune step, in the appropriate direction, to be executed. This is followed by a pause of 0.4 sed, thereafter steps occur at 50 ms intervals. The pause allows single step Fine Tuning to be carried out. At each step the new Fine Tune Number is transferred to the synthesizer.
On release of the switch current Channel and Fine Tune Number are stored at the appropriate ER1400 address.
NOTE: Fine Tune Up means decrease in Fine Tune Number which gives a corresponding increase in frequency.
Fine Tune Down acts in a similar fashion.
The Fine Tune Number allows tuning of $+4 \mathrm{MHz},-3.95 \mathrm{MHz}$, in 50 KHz steps around the allocated channel frequency.

## Program Step (D6)

Closure of the Program Step switch causes the displayed program number to increment one step and thereafter one step every 0.5 sec, overflowing from 32 to 1 , until the switch is released. At each step the channel display is updated and the appropriate TUNE information is sent to the synthesizer. The MUTE signal is activated for 600 ms at each step.

## Channel Sweep (D5)

The Channel Sweep enables the user to sweep through each channel in turn (in order of increasing Channel Number, with roll over from 99 to 00 ) stopping when a valid stop signal, as indicated by the UP and DOWN inputs, is detected. The sweep is implemented by decrementing the Fine Tune Number in steps of 5, at 12 ms intervals, which is equivalent to increasing the frequency in steps of 250 KHz .

Band 1 and Band 3 channel widths are 7 MHz and are swept $-3.45 \mathrm{MHz},+3.3 \mathrm{MHz}$ around the allocated channel frequency. UHF band channel widths are 8 MHz and are swept -3.95 MHz , +3.8 MHz around the allocated channel frequency
When the switch is initially closed the sweep starts from the bottom of the next channel. A pause of 250 ms is initiated before continuing. On succeeding channel boundaries there is a 12 ms pause unless a bank change is involved in which case there is a 0.5 sec pause.
For normal operation the sweep switch should be closed momentarily and then released. If the switch is held closed and a STOP is detected, AUTO mode is entered where the appropriate Channel and Fine Tune data is stored in the ER1400. At this point because the sweep is closed, the sweep is restarted from the bottom of the next channel.
The sweep mode can be terminated at any time by pressing any of the push buttons (other than CHANNEL SWEEP) on the front panel or by selecting a new program. A STOP signal, indicating a TV station has been found, is recognized by UP going high then low followed by DOWN going high (Fig. 4). When a TV station is found the PIC1650-020 enters the AUTO mode.

## Auto (D2)

Auto mode is entered either by pressing the AUTO push button or from channel sweep when a STOP is detected. Current Channel information is stored in the appropriate ER1400 address.
The FINE TUNE number stored is the current FINE TUNE number plus 20 FINE TUNE steps. This is equivalent to off-setting the frequency by -1 MHz to give a symmetrical AFC capture range. Note: The above -1 MHz offset is a maximum value. If by offsetting by -1 MHz a channel boundary is crossed the offset is reduced to stay within the current channel.
The AFT bit is stored as a 1 to indicate Auto mode is selected. To exit from the 'Auto' mode and cancel the AFT bit, either the Fine Tune Up, Fine Tune Down, Channel Tens or Channel Units switch must be operated.
In Auto mode if UP is high the Fine Tune number is decremented by one every 12 ms until UP goes low. Similarly if DOWN is high the Fine Tune number is incremented by one until it goes low. The
maximum tuning range is $-3.95 \mathrm{MHz}+4 \mathrm{MHz}$ around the allocated channel frequency. No roll over occurs when these limits are reached, i.e. the system will only tune down from the +4 MHz limit and up from the -3.95 MHz limit.
Auto Fine Tune Indicator (D7)
This is a LED which is ON when the system is operating in the AUTO mode. The state of the LED is determined by the AFT bit from the ER1400.

## Mute - (B5)

The Mute signal is normally high but goes active (low) for 600 ms each time TUNE data is transferred to the synthesizer i.e. during a channel or program change or when the power is initially switched on. In the Channel sweep mode the MUTE is active continuously from the start of sweep until 600ms after a STOP is detected. The Mute does not go active if only Fine Tune information is transferred to the synthesizer.
The Mute output serves to mute the sound of the television when disturbances are made to the tuning.

## OSC

This is an RC network which provides the basic oscillator frequency for the PIC1650-020. A 47K potentiometer is provided to allow accurate setting of the frequency to 1.0 MHz .

## Channel-Frequency Conversion

The channel data read from the ER1400 is converted by the PIC1650-020 into Frequency, Band and Offset information. The table below lists the Frequency Number (Q), Band (B) and Offset (R) allocated to each of the 100 channels.

For example the Tune data for channel 21 is as follows:-

$$
\begin{aligned}
& Q=514 \\
& B=2 \\
& R=17
\end{aligned}
$$

This information is transferred to the synthesizer in the Tune Data format specified earlier. If the Fine Tune data is set to 128 and transferred to the synthesizer then the local oscillator will be tuned to a frequency of 510.15 MHz .

ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Storage Temperature ...................................... $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Voltage on any Pin with Respect to $\mathrm{V}_{\text {ss }} \ldots \ldots \ldots \ldots \ldots \ldots . .0 .3 \mathrm{~F}$ to +12 V
Standard Conditions (unless otherwise noted):
Operating Temperature (Ambient) $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$

## DC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage | $V_{D D}$ | 4.5 | - | 7 | V |  |
| Output Buffer Supply Voltage | $\mathrm{V}_{\mathrm{xx}}$ | 4.5 | - | 10 | V |  |
| Supply Current | $I_{\text {do }}$ | - | 30 | 55 | mA | No Load |
| Output Buffer Supply Current | $\mathrm{I}_{\mathrm{xx}}$ | - | 1 | 5 | mA | No Load (see Note 1) |
| All Inputs Input Low Voltage | VIL | -0.2 | - | 0.8 | V |  |
| I/O Ports With Internal Pull-up Input High Voltage | $\mathrm{V}_{\mathrm{IH}}$ | 2.4 | - | $V_{D D}$ | V |  |
| $\overline{\text { MCLR }}, \overline{\text { RTCC }}$ \& OSC Input High Voltage | $\mathrm{V}_{\mathrm{IH}}$ | $V_{D D}-1$ | - | $V_{D D}$ | v |  |
| All Outputs Except CLK OUT |  |  |  |  |  |  |
| Output Low Voltage | $\mathrm{V}_{\text {OL }}$ | - | - | 0.45 0.90 | V | $\begin{aligned} & \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}(\text { see Note } 2,3,4) \mathrm{V}_{\mathrm{xx}}=4.5 \mathrm{~V} \\ & \left.\mathrm{I}_{\mathrm{OL}}=5 \mathrm{~mA} \text { (see Note } 2,3,4\right) \mathrm{V}_{\mathrm{xx}}=4.5 \mathrm{~V} \end{aligned}$ |
|  | - | - | 0.50 | - | V | $\mathrm{I}_{\mathrm{OL}}=5 \mathrm{~mA}$ (see Note 2, 3, 4) $\mathrm{V}_{\mathrm{xx}}=9 \mathrm{~V}$ |
|  | - | - | 0.9 | - | V | $\mathrm{I}_{\mathrm{OL}}=10 \mathrm{~mA}$ (see Note 2, 3, 4) $\mathrm{V}_{\mathrm{xx}}=9 \mathrm{~V}$ |
| CLK OUT <br> Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.45 | V | $\mathrm{V}_{\mathrm{xx}}=9.0 \mathrm{~V}$ |
| All Outputs With Internal Pull Up Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | 2.4 | - | - | V | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ (see Note 2, 3, 4) $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ (see Note 2, 3, 4) |
| All I/O Ports With Internal Pull Up Input Low Current | ILI | -0.2 | -0.6 | -1.6 | mA | $\mathrm{V}_{\text {IL }}=0.4 \mathrm{~V}$ (see Note 4) |
| Input High Current | $\mathrm{IH}^{\text {H }}$ | -0.1 | -0.4 | - | mA | $\mathrm{V}_{\mathrm{IH}}=2.4 \mathrm{~V}$ (see Note 4) |
| $\overline{\text { MCLR }}$, $\overline{\text { RTCCC }}$ Input Leakage Current | ILC | -10 | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SS }} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\text {DD }}$ (see Note 4) |
| I/O Ports With Open Drain Outputs Input High Voltage Input Leakage Current | $\mathrm{V}_{1 \mathrm{H}}$ $\mathrm{I}_{\mathrm{CL}}$ | $\begin{gathered} 2.4 \\ -10 \end{gathered}$ | - | $\begin{gathered} v_{x x} \\ 10 \end{gathered}$ | $\begin{gathered} \mathrm{V} \\ \mu \mathrm{~A} \end{gathered}$ | $\mathrm{V}_{\mathrm{SS}} \leqslant \mathrm{V}_{\text {IN }} \leqslant \mathrm{V}_{\mathrm{xx}}$ (see Note 4) |

## AC CHARACTERISTICS

| Characteristics | Sym | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OSC <br> Oscillator Frequency | $f$ | 0.2 | - | 1 | MHz |  |
| Instruction Cycle Time | ${ }^{\text {cry }}$ | 4 | - | 20 | $\mu \mathrm{s}$ | (see Note 6) |
| CLK OUT \& I/O Ports with Internal Pull Up <br> Rise Time | $t_{\text {R }}$ | - | - | 200 | ns | $1 \text { TTL Load + 100pf }$ |
| Fall Time | $\mathrm{t}_{\mathrm{F}}$ | - | - | 200 | ns | 1 TTL Load + 100pf |
| I/O Ports with Internal Pull Up Output Mode CLK OUT to Data Valid | $t_{\text {PD }}$ | 0 | 500 | . 800 | ns |  |
| Input Mode Data Set Up Time Data Hold Time | $t_{s}$ $t_{n}$ | 0 | - | $1 / 4 \mathrm{t}_{\mathrm{cr}}$ 25 ns | ns |  |
| $\overline{\text { RTCC }}$ Input |  |  |  |  |  |  |
| Period | $t_{\text {RT }}$ | ${ }^{1} \mathrm{cr}$ | - | - | $\mu \mathrm{s}$ |  |
| High Pulse Width | $\mathrm{t}_{\mathrm{RT} 1}$ | $1 / 2 t_{\text {cr }}$ | - | - | $\mu \mathrm{s}$ | (see Note 7) |
| Low Pulse Width | $\mathrm{t}_{\mathrm{RTH}}$ | $1 / 2 t_{\text {cr }}$ | - | - | $\mu \mathrm{s}$ |  |

## NOTES:

1. Maximum $I_{x x}$ occurs when all I/O ports are high.
2. Total $I_{\mathrm{OL}}$ for all outputs (I/O ports + CLK OUT) must not exceed 175 mA .
3. $\mathrm{V}_{\mathrm{xx}}$ supply drives $1 / \mathrm{O}$ ports. The $\mathrm{V}_{\mathrm{DD}}$ supply drives CLK OUT.
4. Positive Current indicates current flow into the device. Negative Current indicates current flow out of the device.
5. Oscillator circuit as shown in Fig. 1.
6. Both the instruction Cycle Time and CLK OUT period are equal to four times the oscillator frequency i.e. $t_{C Y}=4 / \mathrm{f}$ secs.
7. Due to the synchronous timing nature between CLK OUT and the sampling circuit used on the RTCC input, CLK OUT may be directly tied to the RTCC without any loss of counts.

CHANNEL FREQUENCY ALLOCATIONS

| Channel Number | Channel Name | L.O. Freq MHz | Band | Q (Freq) <br> Number | R (Offset) Number | Band |  | Channel Width |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | AY-3-2012 Output | B |  |
| 00 | 1 | 80.15 | 1 | 84 | 17 | BAND 1 | 0 | 7 MHz |
| 01 | 1 | 80.15 | 1 | 84 |  |  | 1 | , |
| 02 | 2 | 87.15 | 7 VHFI | 91 |  |  | , |  |
| 03 | 3 | 94.15 | , | 98 |  | $\downarrow$ | 1 |  |
| 04 | 4 | 101.15 | - CCIR | 105 |  | 1 | 1 |  |
| 05 | 5 | 214.15 | - | 218 |  | BAND 3 | 1 |  |
| 06 | 6 | 221.15 |  | 225 |  |  |  |  |
| 07 | 7 | 228.15 |  | 232 |  |  |  |  |
| 08 | 8 | 235.15 | VHF III | 239 |  |  |  |  |
| 09 | 9 | 242.15 | CCIR | 246 |  |  |  |  |
| 10 | 10 | 249.15 |  | 253 |  |  |  |  |
| 11 | 11 | 256.15 |  | 260 |  | 1 | 1 |  |
| 12 | 12 | 263.15 | - | 267 |  | $\gamma$ | 1 |  |
| 13 | A1 | 108.15 | 7 | 112 |  | BAND 1 | 0 |  |
| 14 | B1 | 115.15 |  | 119 |  |  | $1$ |  |
| 15 | C1 | 122.15 |  | 126 |  |  |  |  |
| 16 | D1 | 12915 |  | 133 |  |  |  |  |
| 17 | E1 | 136.15 |  | 140 |  |  |  |  |
| 18 | F1 | 85.15 |  | 89 |  |  |  |  |
| 19 | G1 | 98.15 |  | 102 |  | 1 | 1 | 1 |
| 20 | H1 | 132.15 | - | 136 |  | $\gamma$ | 1 | $\checkmark$ |
| 21 | 21 | 510.15 | - | 514 |  | UHF | 2 | 8 MHz |
| 22 | 22 | 51815 |  | 522 |  |  |  | 1 |
| 23 | 23 | 526.15 |  | 530 |  |  |  |  |
| 24 | 24 | 534.15 |  | 538 |  |  |  |  |
| 25 | 25 | 54215 |  | 546 |  |  |  |  |
| 26 | 26 | 550.15 |  | 554 |  |  |  |  |
| 27 | 27 | 558.15 |  | 562 |  |  |  |  |
| 28 | 28 | 566.15 | UHF | 570 |  |  |  |  |
| 29 | 29 | 57415 | CCIR | 578 |  |  |  |  |
| 30 | 30 | 58215 |  | 586 |  |  |  |  |
| 31 | 31 | 59015 |  | 594 |  |  |  |  |
| 32 | 32 | 598.15 |  | 602 |  |  |  |  |
| 33 | 33 | 60615 |  | 610 |  |  |  |  |
| 34 | 34 | 614.15 |  | 618 |  |  |  |  |
| 35 | 35 | 622.15 |  | 626 |  |  |  |  |
| 36 | 36 | 630.15 |  | 634 |  |  |  |  |
| 37 | 37 | 638.15 |  | 642 |  |  |  |  |
| 38 | 38 | 64615 |  | 650 |  |  |  |  |
| 39 | 39 | 654.15 |  | 658 |  |  |  |  |
| 40 | 40 | 662.15 |  | 666 |  |  |  |  |
| 41 | 41 | 670.15 |  | 674 |  |  |  |  |
| 42 | 42 | 678.15 |  | 682 |  |  |  |  |
| 43 | 43 | 686.15 |  | 690 |  |  |  |  |
| 44 | 44 | 694.15 |  | 698 |  |  |  |  |
| 45 | 45 | 702.15 |  | 706 |  |  |  |  |
| 46 | 46 | 710.15 |  | 714 |  |  |  |  |
| 47 | 47 | 718.15 |  | 722 |  |  |  |  |
| 48 | 48 | 726.15 |  | 730 |  |  |  |  |
| 49 | 49 | 734.15 | UHF | 738 |  |  |  |  |
| 50 | 50 | 742.15 | CCIR | 746 |  |  |  |  |
| 51 | 51 | 750.15 |  | 754 |  |  |  |  |
| 52 | 52 | 758.15 |  | 762 |  |  |  |  |
| 53 | 53 | 766.15 |  | 770 |  |  |  |  |
| 54 | 54 | 774.15 |  | 778 |  |  |  |  |
| 55 | 55 | 782.15 |  | 786 |  |  |  | , |
| 56 | 56 | 790.15 |  | 794 | , | , | , |  |
| 57 | 57 | 798.15 |  | 802 | 1 | 1 | $\checkmark$ | 1 |
| 58 | 58 | 806.15 |  | 810 | 1 | 1 | 1 | 1 |
| 59 | 59 | 814.15 | 1 | 818 | 17 | UHF | 2 | 8 MHz |


| INSTRUMERENT | PIC1650-020 - ER1400 |
| :---: | :---: |

## CHANNEL FREQUENCY ALLOCATIONS

| Channel Number | Channel Name | L.O. Freq MHz | Band | Q (Freq) Number | R (Offset) Number | Band |  | Channel Width |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | AY-3-2012 Output | B |  |
| 60 | 60 | 822.15 |  | 826 | 17 | UHF | 2 | 8 MHz |
| 61 | 61 | 830.15 |  | 834 | 1 | I |  |  |
| 62 | 62 | 838.15 |  | 842 |  |  |  |  |
| 63 | 63 | 846.15 |  | 850 |  |  |  | , |
| 64 | 64 | 854.15 |  | 858 |  |  |  | , |
| 65 | 65 | 862.15 |  | 866 |  |  |  |  |
| 66 | 66 | 870.15 |  | 874 |  |  |  |  |
| 67 | 67 | 878.15 |  | 882 |  |  |  |  |
| 68 | 68 | 886.15 |  | 890 |  |  |  |  |
| 69 | 69 | 894.15 |  | 898 | $\downarrow$ |  | 1 |  |
| 70 | 70 | 902.15 | UHF | 906 | 1 | 1 | $\gamma$ | $\downarrow$ |
| 71 | 71 | 910.15 | CCIR | 914 | 17 |  | 2 | 1 |
| 72 | A | 92.65 |  | 96 | 7 | BAND 1 | 0 | 7 MHz |
| 73 | B | 101.15 |  | 105 | 17 | 1 | 0 | 1 |
| 74 | C | 121.15 |  | 125 | 17 |  | 0 |  |
| 75 | D | 214.15 | ITALIAN | 218 | 17 | BAND 3 | 1 |  |
| 76 | E | 222.65 |  | 226 | 7 |  | $1$ |  |
| 77 | F | 231.15 |  | 235 | 17 |  |  |  |
| 78 | G | 240.15 |  | 244 | 1 |  |  |  |
| 79 | H | 249.15 |  | 253 |  |  |  |  |
| 80 | S1 | 144.15 |  | 148 |  |  |  |  |
| 81 | S2 | 151.15 |  | 155 |  |  |  |  |
| 82 | S3 | 158.15 |  | 162 |  |  |  |  |
| 83 | S4 | 165.15 |  | 169 |  |  |  |  |
| 84 | S5 | 172.15 |  | 176 |  |  |  |  |
| 85 | S6 | 179.15 |  | 183 |  |  |  |  |
| 86 | S7 | 186.15 |  | 190 |  |  |  |  |
| 87 | S8 | 193.15 |  | 197 |  |  |  |  |
| 88 | S9 | 200.15 |  | 204 |  |  |  |  |
| 89 | S10 | 207.15 | GERMAN | 211 |  |  |  |  |
| 90 | S11 | 270.15 | CABLE | 274 |  |  |  |  |
| 91 | S12 | 277.15 |  | 281 |  |  |  |  |
| 92 | S13 | 284.51 |  | 288 |  |  |  |  |
| 93 | S14 | 291,15 |  | 295 |  |  |  |  |
| 94 | S15 | 298.15 |  | 302 |  |  |  |  |
| 95 | S16 | 305.15 |  | 309 |  |  |  |  |
| 96 | S17 | 312.15 |  | 316 |  |  |  |  |
| 97 | S18 | 319.15 |  | 323 | 1 | 1 | 1 | 1 |
| 98 | S19 | 326.15 |  | 330 | 1 | , | $\gamma$ | $\gamma$ |
| 99 | S20 | 333.15 |  | 337 | 17 | BAND 3 | 1 | 7 MHz |

I/O TIMING

CLK OUT

OUTPUT

INPUT


TYPICAL INTERFACE-BIDIRECTIONAL I/O LINE


Fig. 1 I/O TIMING AND INTERFACE


NOTES:

1. I/O's B0, B1, B2, B3, B4, B5, C0, C1, C2, C3 \& D7 have open drain outputs.
2. Unless otherwise noted:
a. Diodes are IN914
b. NPN Transistors are 2N3904
c. PNP Transistors are BC327

Fig. 2 CIRCUIT DIAGRAM


| Parameter | Notes |  |
| :--- | :---: | :---: |
| Clock Pulse Width | $\mathrm{T}_{\mathrm{p}}$ | $4 \mu \mathrm{~s}$ |
| Clock Period | $\mathrm{T}_{\mathrm{p} 1}$ | $56 \mu \mathrm{~s}$ |
|  | $\mathrm{~T}_{\mathrm{p} 2}$ | $44 \mu \mathrm{~s}$ |
| Data Set Up Time | $\mathrm{t}_{\mathrm{s}}$ | $4 \mu \mathrm{~s}$ |
| Data Hold Time | $\mathrm{T}_{\mathrm{m}}$ | $>36 \mu \mathrm{~s}$ |
| Clock or Data |  |  |
| Rise Tıme | $\mathrm{t}_{\mathrm{r}}$ | 200 ns |
| Clock or Data |  |  |
| Fall Time | $\mathrm{t}_{\mathrm{f}}$ | 200 ns |

NOTES.

1. Rise and Fall times are maximum values. Other times are typical values with a tolerance of $\pm 250 \mathrm{~ns}$.
2. Times other than rise or fall times are based on a PIC 1650 clock frequency of 1 MHz .
3. Logic Levels: '0' $<0.5 \mathrm{~V}$; ' 1 ' $>2.0 \mathrm{~V}$.

| Parameter |  | Value |
| :---: | :---: | :---: |
| Clock Period | $\mathrm{T}_{\mathrm{p}}$ | $72 \mu \mathrm{~s}$ |
| Clock Duty Cycle |  | 50\% |
| Control Set Up Time | T cs | $52 \mu \mathrm{~s}$ |
| Control Hold Time | $\mathrm{T}_{\mathrm{CH}}$ | $4 \mu \mathrm{~s}$ |
| Address Set Up Time | $\mathrm{T}_{\text {AS }}$ | $8 \mu \mathrm{~s}$ |
| Address Hold Time | $\mathrm{T}_{\text {AH }}$ | $4 \mu \mathrm{~s}$ |
| Write Data Set Up |  |  |
| Time |  |  |
| Logic 0 | $\mathrm{T}_{\text {so }}$ | $16 \mu \mathrm{~s}$ |
| Logic 1 | $\mathrm{T}_{\mathrm{S} 1}$ | $32 \mu \mathrm{~s}$ |
| Write Data Hold Time |  |  |
|  |  |  |
| Logic 0 | $\mathrm{T}_{\mathrm{Ho}}$ | $4 \mu \mathrm{~s}$ |
| Logic 1 | $\mathrm{T}_{\mathrm{H} 1}$ | $20 \mu \mathrm{~s}$ |
| Read Data sample |  |  |
| Time | $\mathrm{T}_{\mathrm{RD}}$ | 36-40 $\mu \mathrm{s}$ |
| Control or Clock |  |  |
| Rise Time | $t_{\text {R }}$ | $1 \mu \mathrm{~s}$ |
| Control or Clock |  |  |
| Fall Time | $\mathrm{t}_{\mathrm{F}}$ | $1 \mu \mathrm{~s}$ |
| Data Rise Time | $\mathrm{T}_{\mathrm{R}}$ | $8 \mu \mathrm{~s}$ |
| Data Fall Time | $\mathrm{T}_{\mathrm{F}}$ | $4 \mu \mathrm{~s}$ |




NOTES:

1. Rise and fall times are maximum values. Other times are typical values with a tolerance of $\pm 250 \mathrm{~ms}$. Times are measured to $50 \%$ values.
2. Times other than rise and fall times are based on a PIC1650 clock frequency of 1 MHz .
3. Address transfer is shown for ER1400 address of 74.
4. ER1400 Erase/Write cycles-continuous clock pulses for 18.5 ms .
5. Logic Levels: ' 0 ' $<\left(\mathrm{V}_{\mathrm{xx}}-8\right)$ Volts; ' 1 ' $>\left(\mathrm{V}_{\mathrm{xx}}-1\right)$ Volts.

## INSTRUNERAL

## Synthesizer/Counter



## Frequency Synthesizer/Counter

## FEATURES

- Three Display Ranges: MW 9,999KHz, FM 399.99 MHz , SW $39,999 \mathrm{KHz}$
- AM IF Offset: Five User Programable Frequencies ( 0,455 , $459,460,468 \mathrm{KHz}$ )
- FM IF Offset: Five User Programable Frequencies (10.64, $10.67,10.70,10.73,10.76 \mathrm{MHz}$ )
- High Voltage Capability for Direct Drive of Fluorescent Displays
- Together with PIC1650A Controller, Forms the Economega III E and F Tuning Systems


## DESCRIPTION

The AY-5-8105 is a PMOS integrated cırcuit containing a 39,999 count frequency synthesizer/counter for use in radio receivers Three main display ranges are provided: $39,999 \mathrm{KHz}$ for SW , 399.99 MHz for FM and $9,999 \mathrm{KHz}$ for MW. FM frequencies can aiso be displayed in the standard European channel format ( 0 to 99+). The timebase is provided by an on-chip oscillator using a 4.096 MHz quartz crystal A 50 Hz output derived from this oscillator is avaılable to serve as the tımebase for an AY-5-1200A dıgital clock which can share the same display.
Digit and segment outputs have high voltage capability and will drive fluorescent displays.
The AY-5-8105 is configured to work in conjunction with the PIC1650 family of controllers The bidirectional SERIAL LINK provides the path for data exchange between the two devices to form a synthesized frequency-locked radio tuning system.

## PIN CONFIGURATION

|  | Top View |  |  |
| :---: | :---: | :---: | :---: |
| $v_{\text {ss }}$ | $\bigcirc \cdot 1$ | 40 | SE |
| SG | ${ }^{2}$ | 39 | SDP |
| SF | $\square^{3}$ | 38 | SL |
| SD | $4^{4}$ | 37 | x1 |
| sc | 5 | 36 | x2 |
| SB | $\square^{6}$ | 35 | 1024 MHz |
| SA | $\square^{7}$ | 34 | IFS2 |
| D1 | $\square^{8}$ | 33 | AMIF |
| D2 | $\square^{9}$ | 32 | FMIF |
| D3 | 10 | 31 | RC |
| D4 | 811 | 30 | RD |
| D5 | -12 | 29 | IFS1 |
| SNG | 13 | 28 | Cl |
| SNF | 14 | 27 | UP |
| SNE | 15 | 26 | down |
| SND | 16 | 25 | Lock |
| SNC | 17 | 24 | A0 |
| SNB | 18 | 23 | A1 |
| SNA | 19 | 22 | A2 |
| $V_{\text {D }}$ | 20 | 21 | A3 |

OPERATION
AY-5-8105 Synthesizer Under PIC1650 Control


Fig. 1 AY-5-8105 BLOCK DIAGRAM

## ELECTRICAL CHARACTERISTICS

## Maximum Ratings*

Voltage on any Pin with Respect to $V_{S S}$ pin
(except Segment and Digit outputs) . . . . . . . . . . . . . . . . . . . +0.3 to -20V
Voltage on Segment and Digit outputs with Respect
to $V_{S S}$ pin. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . +0.3 V to -35 V
Storage Temperature Range . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Power Dissipation - 40 pin package . . . . . . . . . . . . . . . . . . . . . . . . 800mW
Standard Conditions (unless otherwise noted):
$\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}$
$V_{D D}=-12 \mathrm{~V} \pm 1.2 \mathrm{~V}$
Operating Temperature range $=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$
Crystal frequency $=4.096 \mathrm{MHz} \pm 0.01 \%$

| Characteristic | Min | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: |
| All Inputs Capacitance | - | 15 | pf | at 1 MHz |
| Cl (Note 1) |  |  |  |  |
| Input Frequency | 0.05 | 2 | MHz |  |
| Input Pulse Width (High or Low) | 2 | - | ns |  |
| Input Low | $\mathrm{V}_{\mathrm{DD}}$ | -4 | V |  |
| Input High | -1 | $\mathrm{v}_{\mathrm{ss}}$ | V |  |
| Input Source | - | 3 | mA | $\mathrm{V}_{\text {IN }}=-4.9 \mathrm{~V}$ |
| Current | 0.15 | - | mA | $\mathrm{V}_{\text {IN }}=-1 \mathrm{~V}$ |
| AM IF, FM IF (Note 2) |  |  |  |  |
| Input Low | $V_{\text {D }}$ | -4 | V |  |
| Input High | -1.2 | $\mathrm{v}_{\text {ss }}$ | V |  |
| Input Sink | - | 0.3 | mA | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {Ss }}$ |
| Current | 30 |  | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {IN }}=-5.4 \mathrm{~V}$ |
| A0-A3, RC, RD (Note 1) |  |  |  |  |
| Input Low | $V_{D D}$ | -4 | v |  |
| Input High | -1 | $\mathrm{v}_{\mathrm{ss}}$ | V |  |
| Input Source | - | 0.3 | mA | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DD}}$ |
| Current | 20 | - | $\mu \mathrm{A}$ | $V_{\text {IN }}=-1 \mathrm{~V}$ |
| SL (as input) (Note 1) |  |  |  |  |
| Input Low | $\mathrm{V}_{\mathrm{DD}}$ | -4 | V |  |
| Input High | -1 | $\mathrm{v}_{\mathrm{ss}}$ | - |  |
| Input Source | - | 2.5 | mA | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {D }}$ |
| Current | 50 | - | $\mu \mathrm{A}$ | $V_{\text {IN }}=-1 \mathrm{~V}$ |
| SL (as output) (Note 3) |  |  |  |  |
| High Voltage | -2 | $\mathrm{v}_{\mathrm{ss}}$ | v | $\mathrm{I}_{\text {SOURCE }}=0.2 \mathrm{~mA}$ |
| Off Current (Leakage) | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {DD }}$ |
| 1.024MHz, UP, DOWN (Note 3) LOCK |  |  |  |  |
| High Voltage | -2 | $\mathrm{v}_{\mathrm{ss}}$ | V | $\mathrm{I}_{\text {SOURCE }}=1 \mathrm{~mA}$ |
| Off Current (Leakage) | - | 2 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {SS }}-5 \mathrm{~V}$ |
| IFS1 (Note 3) |  |  |  |  |
| High Voltage | -0.5 | $\mathrm{v}_{\text {ss }}$ | v | $\mathrm{I}_{\text {SOURCE }}=3 \mathrm{~mA}$ |
| Off Current (Leakage) | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {DD }}$ |
| IFS2 (Note 3) |  |  |  |  |
| High Voltage | -0.5 | $\mathrm{v}_{\text {ss }}$ | v |  |
| Low Voltage | $\mathrm{V}_{\mathrm{DD}}$ | -8.5 | v | $\mathrm{I}_{\text {SINK }}=0.1 \mathrm{~mA}$ |
| Segment Outputs (Note 4) |  |  |  |  |
| High Voltage | -2 | $\mathrm{V}_{\mathrm{ss}}$ | v | $\mathrm{I}_{\text {SOURCE }}=2 \mathrm{~mA}$ |
| Off Current (Leakage) | - | 10 | $\mu \mathrm{A}$ | $V_{\text {OUT }}=-33 \mathrm{~V}$ |
| Digit Outputs D2-5 (D1) (Note 4) |  |  |  |  |
| High Voltage | -3 | $\mathrm{v}_{\text {ss }}$ | V | $\mathrm{I}_{\text {SOURCE }}=7 \mathrm{~mA}(14 \mathrm{~mA})$ |
| Off Current (Leakage) | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {OUT }}=-33 \mathrm{~V}$ |
| Supply Current | - | 40 | mA | $\mathrm{V}_{\mathrm{DD}}=-13.2 \mathrm{~V}$ |

## NOTES:

1. These inputs have pull-ups to $V_{S S}$.
2. These inputs have pull-downs to $V_{D D}$
3. These are open-drain outputs. Maximum applied negative voltage $=15 \mathrm{~V}$.
4. These are open-drain outputs. Maximum applied negative voltage $=33 \mathrm{~V}$.

## GENERAL INSTRUMENT

| FUNCTION | DESCRIPTION | PAIIT NUMEER | PAGE: NUMBER |
| :---: | :---: | :---: | :---: |
| S12 BIT EAROM | 512 bits organized $32 \times 16$ | En2051 | 10-48 |
|  |  | ER20511R | 10-48 |
|  |  | ER2051 HR | $10-48$ |

## 512 Bit Electrically Alterable Read Only Memory

- 32 Word x 16 Bit Organization
- 5 Bit Binary Addressing
- $+5,-28 \mathrm{~V}$ Power Supplies
- Word Alterable
- 10 Year Data Storage for ER2051 (at $+70^{\circ} \mathrm{C}$ )
- 1 Year Data Storage for ER2051IR (at $+85^{\circ} \mathrm{C}$ ) and ER2051HR (at $+125^{\circ} \mathrm{C}$ )
- TTL Compatibility with Pull-Up Resistors on Inputs
- Tri-State Outputs
- Read Time: $1 \mu \mathrm{~s}$ (ER2051), $2 \mu \mathrm{~s}$ (ER2051IR and ER2051HR)
- Write/Erase Time: 50 ms (ER2051), 100 ms (ER2051HR)
- No Voltage Switching Required
- Chip Select
- Two Extended Temperature Ranges;
$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ER2051IR
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ ER2051HR


## DESCRIPTION

The ER2051, ER2051IR and ER2051HR are fully decoded $32 \times 16$ electrically erasable and reprogramable ROMs. Write, erase, and read voltages are switched internally via a 2-bit code applied to C1 and C2.
Data is stored by applying negative writing pulses that selectively tunnel charge into the oxide-nitride interface of the gate insulator of the 512 MNOS memory transistors. When the writing voltage is removed the charge trapped at the interface is manifested as a negative shift in the threshold voltage of the selected memory transistors.
The EAROM may be operated with the $\mathrm{V}_{\text {ss }}$ power supply between +5 V and +10 Volts , as long as the $\mathrm{V}_{\mathrm{Ss}}-\mathrm{V}_{G G}$ always equals 33 Volts. Thus, $V_{s s}$ can be +5 Volts for TTL compatibility or up to +10 Volts for CMOS compatibility, if $\mathrm{V}_{\mathrm{GG}}$ is appropriately adjusted. The ER2051IR and ER2051HR are screened to Mil Std. 883B/ method 5004.1/level B, pre-cap visual inspection, environmental testing, burn-in and external visual. They are available in 28 lead ceramic dual in line packages.

## OPERATION

Data is stored in a two transistor memory cell After the cell is preconditioned by an erase signal (which causes a positive shift in the threshold of both transistors), data is written into one of the transistors making its threshold more negative. A sensing flip flop is used to read the memory cell and presents a logic high or low to the output depending upon which transistor is written.

## PIN CONFIGURATION

28 LEAD DUAL IN LINE Top View

## BLOCK DIAGGRAM



It is important to note two things. first, that an erase is required before a wire to precondition the cell, and second, that after an erase, both transistors will have the same threshold voltage and valid data will not be present at the output.
The ER2051, ER2051IR and ER2051HR EAROM's use internal dynamic, edge triggered circuits. This requires either a mode change, a clock, or a transition of the chip select between successive operations. Thus successive operations in the same mode must be separated by transitions of one of these four lines. Clock pulses are not normally required during erase or write operations, but are needed for successive operations if the chip select is held high, i.e., applications where one EAROM is used.

## PIN FUNCTIONS

| Pin No | Name | Function |
| :---: | :---: | :---: |
| 19, 20, 21, 22 | $\mathrm{A}_{0}-\mathrm{A}_{4}$ | 5-Bit Word Address. |
| 1-6, 8-14, 28 | $\mathrm{D}_{0}-\mathrm{D}_{15}$ | Data input and output pins. |
| 27 | CS | Chip Select. Chip selected at logic " 1 ". When chip select is at logic " 0 ", outputs are open circuit, read, write and erase are disabled. Power is reduced. |
| 25, 26 | C1, C2 | Mode Control Inputs. |
|  |  | C1 C2 |
|  |  | 0.1 Erase Mode: stored data is erased at addressed location. |
|  |  | 1 Don't Care Read Mode: addressed data read after clock pulse. Output data retained at output <br> $0 \quad 0 \quad \begin{aligned} & \text { pins until chip deselected or control lines switched. } \\ & \text { Write Mode: input data written at addressed location. Clock not required. }\end{aligned}$ |
| 18 | CLK | Clock input. Pulse to logic "1" for read operation. |
| 17 | $\mathrm{V}_{\text {Ss }}$ | Substrate supply. Normally at +5 volts. |
| 7 | $\mathrm{V}_{\text {G1 }}$ | Ground Input. |
| 24 | $V_{G G}$ | Power Supply Input. Normally at -28 volts. |

## ELECTRICAL CHARACTERISTICS

Maximum Ratings*
All Inputs and Outputs (with Respect to $\mathrm{V}_{\mathrm{SS}}$ ) ............... -35 V to +0.3 V

Soldering Temperature of Leads ( 10 seconds) $\ldots \ldots \ldots \ldots \ldots \ldots .+300^{\circ} \mathrm{C}$
Standard Conditions (for TTL compatibility)
$V_{\text {ss }}=+5 \mathrm{~V} \pm 5 \%$
$V_{G G}=-28 V \pm 5 \%$
$\mathrm{v}_{\mathrm{GI}}=\mathrm{GND}$
Operating Temperature $T_{A}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ for ER2051

$$
\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \text { for ER2051 IR }
$$

$\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ for ER2051 HR
*Exceeding these ratings could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operating ranges are specified in Standard Conditions. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

Output Load $=100$ pf, 1 TTL load

| Characteristics | Sym | ER2051 |  |  | ER2051 IR/ER2051 HR |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ.** | Max. | Min. | Typ.** | Max. | Units | Conditions |
| DC CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Input Logic "1" | $V_{\text {IH }}$ | $V_{\text {ss }}-1.5$ | - | $V_{\text {ss }}+0.3$ | $V_{S S}-1.5$ | - | $\mathrm{V}_{\text {ss }}+0.3$ | V |  |
| Input Logic "0" | $V_{\text {IL }}$ | $V_{\text {ss }}-15$ | - | 0.8 | $\mathrm{V}_{S S}-10$ | - | 0.6 | V |  |
| Output Logic "1" | V OH | $V_{s s}-15$ | - | - | $\mathrm{V}_{\text {SS }}-1.5$ | - | - | V | $\mathrm{I}_{\mathrm{OH}}=100 \mu \mathrm{~A}$ |
| Output Logic "0" | VoL | - | - | 0.6 | - | - | 0.6 | $v$ | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ for $\mathrm{V}_{\mathrm{SS}}=+5 \mathrm{~V}$ |
| Input Leakage | IL | - | 2 | 10 | - | 2 | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {SS }}-15$ |
| Output Leakage | Io | - | 2 | 10 | - | 2 | 10 | $\mu \mathrm{A}$ | Chip deselected |
| Power Supply Current |  |  |  |  |  |  |  |  |  |
| Read | $\mathrm{I}_{\mathrm{GG}}$ | - | - | 14 | - | - | 18 | mA | 1 |
| Write | $I_{\text {GG }}$ | - | - | 11 | - | - | 15 | mA | $\left\{I_{\text {GG }}\right.$ returned |
| Erase | $\mathrm{I}_{\mathrm{GG}}$ | - | - | 11 | - | - | 15 | $m A$ | through $\mathrm{V}_{\text {ss }}$ |
| Deselected | IGG | - | - | 9 | - | - | 12 | mA |  |
| AC CHARACTERISTICS |  |  |  |  |  |  |  |  |  |
| Access Time | $t_{\text {ACC }}$ | - | - | 1 | - | - | 2 | $\mu \mathrm{S}$ |  |
| Clock Pulse Width | $t_{\text {Pw }}$ | 2 | - | 20 | 2 | - | 20 | $\mu \mathrm{s}$ |  |
| Erase Cycle Time | $t_{\text {E }}$ | 50 | - | 200 | 100 | - | 200 | ms |  |
| Write Cycle Time | $t_{w}$ | 50 | - | 200 | 100 | - | 200 | ms |  |
| Read Cycle Time | $t_{\text {R }}$ | 3.5 | - | 24 | 4.5 | - | 25 | $\mu \mathrm{s}$ |  |
| Address to Clock Time | $t_{A}$ | 50 | - | - | 50 | - | - | ns |  |
| Data Set Up Time | tos | 50 | - | - | 50 | - | - | ns |  |
| Data Hold Time | $t_{\text {DH }}$ | 50 | - | - | 50 | - | - | ns |  |
| Control to Address\& Data Change | $\mathrm{tc}_{c}$ | 0 | - | - | 0 | - | - | ns |  |
| Number of Reads/Word Refresh | $\mathrm{N}_{\mathrm{RA}}$ | 10'' | - | - | $10^{\prime \prime}$ | - | - |  |  |
| Number of Erase/Write Cycles | $\mathrm{N}_{\mathrm{w}}$ | $10^{6}$ | - | - | $10^{5}$ | - | - | - |  |
| Input Capacitance (all pins) | $\mathrm{C}_{10}$ | - | 8 | 15 | - | 8 | 15 | pf |  |
| Unpowered Data Storage Time | $t_{s}$ | 10 | - | - | 1 | - | - | Years | at max temperature |
| Power Dissipation Read Cycle | PD | - | 450 | 500 | - | 450 | 500 | mW | at $25^{\circ} \mathrm{C} \mathrm{V}_{\mathrm{SS}}=+5, \mathrm{~V}_{G G}=-29$ |
|  | Po | not | applic |  | - | - | 500 | mW | at $125^{\circ} \mathrm{C} \mathrm{V}_{\mathrm{SS}}=+5, \mathrm{~V}_{\mathrm{GG}}=-29$ |
|  | $P_{0}$ |  | applic |  | - | - | 600 | mW | at $-55^{\circ} \mathrm{C} V_{S S}=+5, V_{G G}=-29$ |
| Pulse Rise, Fall Time | $t_{8,} t_{\text {d }}$ | 10 | - | 100 | 10 | - | 100 | ns |  |

[^20]

# General Information 11 

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## A Total Technological Service

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| GERMANY | Intesi |
| :---: | :---: |
| Berlin | Via Le Milanofiori |
| Roederstein-Baulemente | Assago, Milan |
| Vertriebs GmbH | Tel: 8242151 |
| Grunewaldstrasse 39a | Telex: 311351 |
| 1000 Berlin 41 | Claitron |
| Tel: $030 / 7914029$ | Viale Certosa 269 |
| Telex: 0184327 | 20100 Milan |
| Heilbronn | Tel: $3088506+3088083$ |
| Elbatex GmbH | Rome |
| Cacilienstrasse 24 | Pantronic |
| 7100 Heilbronn | Via Flaminia 219 |
| Tel: 071 31/8 9001 | 00100 Rome |
| Telex: 728362 | Tel: (06) 3284866 |
| Munchen | Telex: 612406 |
| Electronic 2000 | Modena |
| Vertriebs-GmbH | Hellis Di B. Prati |
| Neumarkter Str. 75 | Plazza Amendola |
| 8000 Munchen 80 | 41049 Sassuolo |
| Tel: 0 89/43 4061 | Modena |
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| Weisbaden | NORWAY |
| Elcowa | J.M. Feiring A/S |
| 6200 Wiesbaden | Box 101, Bryn, Oslo 6 |
| Strasse der Republik 17-19 | Tel: (02) 19.62.00 |
| Posfach 129409 | Telex: 16435 |
| Telex: 04186202 | PORTUGAL |
| HOLLAND | Lisbon Decada |
| Curijn Hasselaar | Rue Pedro Nunes 47C |
| Van Utenhoveweg 100 | 1000 Lisboa |
| P.O. Box 37, Geldermalsen | Tel: 574984 |
| Tel: 03455-3150 | Telex: 18469 Nunio P |
| Telex: 40259 | SPAIN |
| ITALY | Sagitron S.A. |
| Adrep Srl | c/, Castello, n.25, $2^{\circ} \mathrm{D}$ |
| Via Jacopo Palma 1 | Madrid-1. <br> Tel: 4-02.60.85 |
| 20146 Milan | Telex: 43.819 |
| Tel: (02) 408.41.01 |  |
| Telex: 315459 | SWEDEN |
| International Commerce Company | Bexab Elektronik AB P.O. Box 2101 |
| Via Jacopo Palma 9 20146 Milan | 18302 Taby |
| Tel: $4045747+405197$ | Tel: 4687680560 |

# Agencies \& Distributors 

## SWITZERLAND

Ellyptic AG
Fellenbergerstrasse 281
CH-8047 Zurich
Tel: 01541100
Telex: 56835
Elbatex AG
Alb. Zwyssig Strasse 28
CH-5430 Wettingen
Tel: 056/26 5641
Telex: 55239
UNITED KINGDOM
Keighley
Semicomps Ltd.
Halifax Road
Keighley, W. Yorks
Tel: 053565191
Telex: 517343

## Oldham

Vako Electronics Ltd.
Pass Street
Werneth, Oldham Lancs,
Tel: 061-652 6316
Telex: 668250

## Stevenage

Campbell Collins Ltd., 162 High Street
Stevenage, Hertfordshire
Tel: 043869466
Telex: 825610

## Slough

Gothic Crellon Ltd.
380 Bath Road
Slough
Tel: 062864434
Telex: 847571

## West Drayton

Semiconductor Specialists Ltd.
Carroll House
159 High Street, Yiewsley West Drayton, Middlesex
Tel: West Drayton 45522
Telex: 21958
YUGOSLAVIA
Computel
Via S. Francesco 18
34133 Trieste, Italy
Tel: (040) 77734
Telex: 460575

## MIDDLE EAST

ISRAEL
Alexander Schneider Ltd.
44 Petach Tikva Road
Tel-Aviv
Tel: 3 320.89-3 346.07
Telex: 33613

## ASIA

INDIA
Bee Arosales (Exporters) 36 Eastcastle Street
London W.I.
Tel: 01-636-6614/01-636 8211
PAKISTAN
Bee Arosales (Exporters)
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Tel: 01-636-6614/01-636 8211
KOREA (Rep.)
Dae Ho Corp.
Dong Young Bldg. 903
82, 1-KA, Ulgiro,
Chungku, Seoul
Tel: 777-3848, 2487
Telex: K26264 Samin
THAILAND
Choakchai Electronic Supplies Ltd., Part. 128/22 Thanon Atsadang, Bangkok 2, Thailand
Tel: 221-0432, 5384
SINGAPORE
General Electronics \& Instrumentation Corp. Pte Ltd.
Suite 117, 1st Floor
Singapore Electrical
Electronic \& Hardware Centre
101, Kitchener Road
Singapore, 0820
Tel: 2587633
Telex: 24416
TAIWAN
President Enterprises Corp.
5 FL., No. 66-1
Sec. 1 Chung Ching South Road
Taipei, Taiwan
Tel: (02) 3317571
Telex: 23135

## AUSTRALIA

Victoria (Rep.)
Daneva Control Pty. Ltd.
66 Bay Road
Sandringham, 3191
Tel: (03) 598-5622
Telex: 34439

## SOUTH AFRICA

Transvaal
Pace Electronic Components (Pty.) Ltd. P.O. 701

Isando 1600, Transvaal
Tel: (011) 361213
Telex: 83196

1. FORMATION OF CONTRACT. Any term of Buyer's order or of releases pertaining thereto or in any communication from Buyer, which is in any way inconsistent with or in addition to these Terms of Sale, shall not be applicable hereto or binding upon Seller Buyer's failure to object to any of these Terms
of Sale in writing prior to the commencement of performance by Seller or the acceptance of any of the of Sale in writing prior to the commencement of performance by Seller or the acceptance of any of the
goods or services described on the front hereof (the "items") shall be conclusively deemed to be goods or services described on the front hereof (the "items") shall be conclusively deemed to be
acceptance of all these Terms of Sale (without regard to whether Buyer makes or may make any acceptance of all these Terms of Sale (without regard to whether Buyer makes or may make any
inspection with respect to such items) Seller's failure to object to terms contained in any communication inspection with respect to such tems) Se ler's fallure to object to terms
from Buyer shall not be deemed to be a waiver of these Terms of Sale
2. PRICES. Prices are F O B Seller's plant, unless otherwise specified on the front hereof Prices do not 2. PRICES. Prices are F O B Seller's plant, uniess otherwise specified on the front hereof Prices do not
include any taxes or duties, now or hereafter enacted, applicable to the items or to this transaction, all of which taxes and duties shall be Buyer's responsibility Such taxes and duties shall be added by Seller to which taxes and duties shall be Buyer's respo
the sales price hereunder, where appropriate
the sales price hereunder, where appropriate
3. PAYMENT TERMS. If Seller extends credit to Buyer, terms of payment will be net thirty (30) days 3. PAYMENT TERMS. If Seller extends credit to Buyer, terms of payment will be net thirty (30) days balance (annual rate of 18\%) or the maximum late payment penalty charge permitted by law will be added for each month or part thereof that payment is delayed Seller has the right, at any time, to change the amount of credit or terms of payment or to withdraw credit, and to require partial or full payment in shall be deemed to be a separate delivery for purposes of this paragraph Payment shall be made without regard to whether Buyer has made or may make any inspection or tests Anything herein to the contrary regard to whether Buyer has made or may make any inspection or tests Anything herein to the contrary prepared to make
risk and expense. Seller puts the goods into possession of a carrier for shipment to Buyer (the carrier being deemed to be acting as Buyer's agent) Seller has the right to ship in installiments Shipping dates are approximate only Seller shall not be liable for any loss or expense (consequential or otherwise) incurred by Buyer if Seller fails to meet such dates for any reason, including, but not limited to, the contingencies stated in paragraph 7 hereof or any other unavoidable production delays, delays in prompt approval of samples by Buyer, modification of specifications previously agreed upon or delays in submission of specifications acceptable to Seller Delays in shipment, non-conformity or non-shipment of an installment shall not relieve Buyer of its obligations hereunder with respect to any other installments, each installment being deemed to be a separate contract Buyer hereby authorizes Seller to produce all or substantially all of the
total quantity of any product set forth on the front hereof in advance of the estımate shipment date(s) and total quantity of any product set forth on the front hereof in advance of the estımate shipment date(s) and
hold for shipment in accordance with such date(s) Unless specified on the front hereof, Seller shall hold for shipment in accordance with such date(s) Unless specified on the front hereof, Seller shall select the mode of transportation and the carrier All right, title and interest in and to all items covered by
Buyer's order are reserved to Seller until the full purchase price for all such items has been paid Buyer Buyer's order are reserved to Seller until the full purchase price for all such items has been paid Buyer
hereby authorizes Seller to execute and file, at any time or times, one or more financıng statements with respect to such items, signed only by Selle
4. INSPECTION AND ACCEPTANCE. The electrical performance specifications for the product hall be in accord with the Seller's customer procurement specifications referenced on the front hereof or in lieu thereof, Seller's published data sheet The Buyer shall inspect and accept the products within three weeks of date of Buyer's receipt or six weeks from the date of the Seller's shipment, whichever is the shorter period Any claim for goods nonconforming to conditions of inspection must be made in writing within this period Seller has the right to examine at Buyer's premises any items the Buyer claims are nonconforming Seller has the right to impose a rescreening charge of not less than 25¢ per unit it Seller's responsibility may, at Seller's election, be made at Buyer's premises
Selier's responsibility may, at Selier's election, be made at Buyer's premises
5. QUANTITIES. Any variation in quantities shipped over or under the quantities ordered (not to exceed $5 \%$ for standard products or $10 \%$ for custom and custom-patterned products) shall constitute exceediance with Buyer's order and the unit price shall continue to apply All claims for shortages in excess of such variations shall be made within ten (10) days after date of receipt of shipment
6. CONTINGENCIES. Seller shall not be hable for any delay in performance or for non-performance, in whole or in part, caused by a labor dispute or the occurrence of any contingency beyond the reasonable control either of Seller or Seller's suppliers, including, but not limited to, war (whether an act of a public enemy, fallure or delay in transportation, act of any government or any agency or subdivision thereof affecting the terms of this contract or otherwise, judicial action, accident, fire, explosion, flood, storm or other act of God, shortage of labor, fuel, raw materials, tools, dies, or equipment, or technical or yield failure Any such delays shall excuse Seller from performance, and Seller's time for performance shall be extended, for the period of the delays and for a reasonable period thereafter If any contingency occurs, Seller may aliocate production and deliveries among any or all of Seller's customers as Seller may determine, including, without limitation, regular customers not then
under contract and Seller's (including Seller's subsidiaries' and affiliates') own requirements for further manufacture or other use
7. SUBSTITUTION AND MODIFICATION OF GOODS. Seller has the right to modify the specifi cations of goods designed
modified specifications

## modified specifications 9. WARRANTIES. S

9. WARRANTIES. Seller, except as otherwise herein provided, warrants that the goods shall be free om defects in materials and workmanship (under normal use and services) from the earlier of a) date of voice or b) date code indicated on the goods for the following periods
A Packaged LSI Devices - 1 year
B Processed Semiconductor chips - 30 days
Selter's warranties shall not extend to any items subjected to accident, misuse, neglect, alteration proper installation, improper testing or unauthorized repair
Seller makes NO WARRANTY as to experımental or developmental goods or goods not manufactured by Seller As to goods not manufactured by Seller, at Buyer's request, Seller, to the extent permitted
by Seller's contract with its supplier, shall assign to Buyer any rights Seller may have under any warranty by Seller's contract with its supplier, shall assign to Buyer any rights Seller may have under any warranty of the supplier thereof

Seller's warranties extend to the Buyer and to no other person or entity
Selier's warranties as hereınabove set forth shall not be enlarged, diminished or affected by, and no obligation or liability shall arıse or grow out of, Seller's rendering of technical advice or service in connection with Buyer's order of the goods furnished hereunder

The foregoing are in lieu of all warranties, express, implied or statutory, including, but not limited to any implied warranty of merchantability or fitness for a particular purpose and any other warranty obligation on the part of the Selier.
10. PROPRIETARY RIGHTS AND

PROPRIETARY RIGHTS AND CONFIDENTIALITY.
(a) All information, know-how, programming, software, trademarks, trade secrets, plans, drawings, specifications, designs and patterns furnished or created by Selier or by Seller's agents or contractors (other than Buyer) and any and all property rights embodied therein are and shall remain the sol (b) Buyer recognizes and acknowledges that certain confidential secret or propritary inform
(b) Buyer recognizes and acknowledges that certain confidential, secret or proprietary information possessed by Seller ("Information") is a valuable business asset of Seller and that disclosure of the Information would cause grave and irreparable injury to Seller Buyer shall at all times, whether during
the term of this contract or subsequent thereto, honor, maintain and protect the confidentiality and the term of this contract or subsequent thereto, honor, maintain and protect the confidentiality and secrecy of such of the Information as Seller may disclose to Buyer or its agents Buyer shall not make any
copies of any of the Information without prior written consent of Seller and will take appropriate action to copies of any of the information without prior written consent of Selier and wili take appropriate action to restrict access to the Information to those of its employees and agents who have an actual need for such
access in the course of their duties This provision shall survive the performance, termination or cancellation of this contract
cancellation of this contract
11. TOOLING. Uniess otherwise expressly provided, Seller will retain title to, possession of, and the right to exclusive use of, all jIgs, dies, fixtures, molds, patterns, gauges, taps, equipment, manufacturing aids and similar devices, made or obtained for the performance of this contract, without regard to whether a separate charge is made for the same
12. PATENT INDEMNITY. Seller will defend any suit or proceeding brought against Buyer to the extent that such suit or proceeding is based on a claım that goods manufactured and sold by Seller to Buyer constitute a direct infringement of any valıd United States patent and Seller shall pay all damages
and costs awarded by final judgment (from which no appeal may be taken) against Buyer, on condition and costs awarded by final judgment (from which no appeal may be taken) against Buyer, on condition
that Seller (1) is promptly informed and furnished a copy of each communication, notice or other action that Seller (1) is promptly informed and furnished a copy of each communication, notice or other action
relating to the alleged infringement, (iI) is given authority, information and assistance necessary to defend relating to the alieged infringement, (ii) is given authority, information and assistance necessary to defend
or settle such suit or proceeding in such manner as Seller shall determine, and (iii) is given sole control of or sedefse (including the right to select counsel), and the sole right to compromise and settle such suit or
the defens
proceeding Selier shall not be obligated to defend or be liable for costs and damages if the infringement arises out of compliance with Buyer's design or specifications or from a combination with, an addition to, or modification of the goods after delivery by Seller, or from use of the goods, or any part thereof, in the practice of a process No license, express or implied, is granted under any United States or foreign patent, covering the goods manufac
in the practice of a process

If any goods manufactured and supplied by Seller to Buyer are held to directly infringe any valid
in United States patent and Buyer is enjoined from using the same, or if Seller believes such infringement is likely, Seller will exert reasonable efforts, at its optıon and at its expense, (1) to procure for Buyer the right to use such goods free of any liability for patent infringement, or (ii) to replace (or modify) such goods with a
non-ınfringing substitute otherwise complying substantially with all the requirements of the contract, or (iii) upon return of the goods, refund the purchase price and the transportation costs of such goods if the (iii) upon return of the goods, refund the purchase price and the transportation costs of such goods inge further shipments without being in breach of contract. If Seller has not been enjoined rom selling such goods to Buyer, Selier may (at Seller's sole election), at Buyer's request, supply such goods to Buyer, in

The same patent indemnity shall be deemed to be extended to Seller by Buyer if any suit or proceeding is brought against Seller based on a claim that the goods m
compliance with Buyer's specifications infringe any valid United States patent.

The foregoing states the sole and exclusive llabllity of the parties patent. of patents, trademarks and copyrights, whether direct or contributory, and is in lieu of all warrantles, express, Implied or statutory in regard thereto, including,
Infringement specified in the Uniform Commerclal Code.
13. SOFTWARE INDEMNIFICATION AND DISCLAIMER.
(a) In the event any software used by Seller in the products shown on the front hereof is furnished or created by someone other than Seller, Buyer shall indemnify and hold Seller harmless from and against
any and all loss, claim, damages, liability, cost, expense (including reasonable attorneys' fees) and any causes of action whatsoever, arising out of or in connection with claims by third parties of any description or nature concerning any such software, including, but not limited to, a claım that such software is owned by a third party
(b) Seller hereby disclaıms any and all liability for any claıms or damages of any description or nature arising from (1) the unknowing duplication or use of Buyer's software, in whole or in part, in products manufactured by Seller for others, or (2) alleged error in any software furnished or created by (1) any person other than Seller or (11) Seller if Buyer has approved such software
14. TERMINATION. Except as provided in paragraph 15(a) this contract may not be terminated by Buyer without Seller's prior written consent If Seller so consents to such termination, Buyer shall be liable for termination charges including, without limitation, a price adjustment based on the quantity of goods
actually delivered and all costs, direct and indirect, incurred and committed for this contract together with actually delivered and all costs, direct and indirect, incurred and com
reasonable allowance for prorated expenses and anticipated profits
reasonable allowance for prorated ex
15. REMEDIES AND DAMAGES.
(a) Where Buyer rightfully and timely rejects or justifiably revokes acceptance of items, or where Buyer has accepted nonconforming items and has timely notified Seller of a breach of warranty, Seller's sole and exclusive liability will be (at Seller's option) to repair, replace or credit Buyer's account with espect to any nonconforming goods returned to Seller during the applicable warranty period set forth above, and with respect to any nonconforming services, on condition that (i) Seller is, promptly upon Buyer's discovery of the nonconformity, notified in writing with a detailed explanation, (ii) Selier issues a Return Material Authorization (RMA) number for return of goods, F O B Seller's designated plant, such items are nonconforming

Where Seller falls to make shipment or repudiates or breaches any other material provisions of this contract (other than the warranty against patent infringements), including, without ilmitation, Seller's obligations with respect to nonconforming Items, Buyer shall promptly give written notice to Seller. In the
event that Seller does not cure any such fallure to ship, repudiation or breach within 60 days after recelpt of shipped, or terminate this contract as to the titems as to which such repudiation or oreach related, and that shall be Buyer's sole and exclusive remedy. If Buyer

Except as set forth above, in no event will Seller be llable to anyone for direct, indirect, special, imited to, breach of provisions regarding warranties, Indemnities and patenis contract, including, but not damages Include, without limitation, costs of removal and reinstaliation of items, loss of goodwill, loss of profits and loss of use.
(b) Seller has the right to terminate this contract if, in Seller's sole judgement, Buyer's financial
ndition does not justify the terms of payment applicable from time to time, and upon demand Buyer does condition does not justify the terms of payment applicable from time to time, and upon demand Buyer does not immediat
paragraph 3
If Seller e
4 If Seller exercises such termination right, Buyer shall be liable for the charges referred to in paragraph 14 in addition to any other remedies Seller may have hereunder or at law
16. WAIVER. In the event of any default or breach by Buyer Sell
16. WAIVER. In the event of any default or breach by Buyer, Seller has the right to refuse to make
further shipments Seller's fallure to enforce at any time or for any perion further shipments Seller's falure to enforce at any time or for any period of tıme any of the provisions of
this contract shall not constitute a waiver of such provisions or of the right of Seller to enforce each and this contract shall
every provision
17. GOVERNING LAW. The validity, construction and performance of this contract and the transactions to which it relates shall be governed by the laws of the State in which the chief executive offices of the Seller are located, without regard to conflict of laws principles All actions, claims or legal proceedings in any way pertaining to this contract or such transactions shall be commenced and maintained in the courts of such State or in a federal court of the United States physically situated in such State and in 18. GOVERNMENT CONTRACTS. If the items to be furnished hereunder are to be used in the performance of a United States Government contract or subcontract and a United States Government contract number appears on Buyer's order or other written communication to Seller, those clauses of the applicable United States Government procurement regulation which are mandatorily required by federal statute to be included in United States Government subcontracts will be deemed incorporated herein by reference and will control if inconsistent with any provisions of this contract
19. ASSIGNMENT. This contract is binding upon and inures to the benefit of the parties hereto and the successors and assigns of the entire business and goodwill of either Seller or Buyer or that part of the business of either used in the performance of this contract, but will not be otherwise assignable except that Seller has the right to assign accounts receivable, or the proceeds of this contract Nothing in this contract
shall inure to the benefit of or be deemed to give rise to any rights in any third party, whether by operation of law or otherwIse
20. SEVERABILITY
ther tribunal or entity having these Terms of Sale is declaredinvalid by a court, agency, commission or ircumstances other than the and each term not so declared as to which it is held invalid or unenforceable shall not be affected thereby, permitted by law and the rights andid or unenforceable shail be valid and be enforced to the fullest exigh a alid commercially reasonable term consistent with the undertakings of the parties under this contract had been substituted in place of the invalid provision
21. SET-OFF. Buyer may not set-off any amount owing from Seller to Buyer against any amount 22. MERGER. This contract constitutes the final written
2.
22. MERGER. This contract constitutes the final written expression of all terms of the agreement those terms. This contract supersedes all previous communications, representations, agreements, prom-
then Ises or statements, either oral or written, with respect to such transactions (including, without limitation,
any terms proposed by Buyer) and no communications, representations, agreements, promises or
statements of any kind made oy any representative of Seller, which are not stated herein, shall be binding Seller unless made in writing (referring specifically to Buyer's order) and signed oy an officer of Seller. No course of deailing or usage of trade or course
supplement any term expressed in this contract.



[^0]:    **Typical Values are at $+25^{\circ} \mathrm{C}$ and nominal voltages

[^1]:    *See Timing Diagram
    ${ }^{* *}$ Typical Values are at $+25^{\circ} \mathrm{C}$ and nominal voltages

[^2]:    ${ }^{* *}$ Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages
    *** Preliminary specification

[^3]:    ** Typical Values are at $+25^{\circ} \mathrm{C}$ and Nominal Voltages.

[^4]:    ** Capacitance is periodically sampled and is not $100 \%$ tested.
    NOTES:

    1. Measured with device selected and outputs unloaded.
    2. Applies to " $A$ " versions only and measured with $\overline{C E}=2.0 \mathrm{~V}$.
    3. Applies to Non-"A"versions only.
    4. Applies to " $A$ " versions (power down) only.
    5. Output low impedance delay $\left(\mathrm{t}_{\mathrm{Lz}}\right)$ is measured from $\overline{\mathrm{CE}}$ going low or CS going active.
    6. Output high impedance delay ( $t_{\mathrm{HZ}}$ ) is measured from $\overline{\mathrm{CE}}$ going high or CS going inactive.
    7. Power Up Time ( $\mathrm{t}_{\mathrm{Pu}}$ ) is not additive to Chip Enable Access Time ( $\mathrm{t}_{\mathrm{ACE}}$ ).

    | Part <br> Number | Maximum <br> Access Time | Operating <br> Current | Standby <br> Current |
    | :---: | :---: | :---: | :---: |
    | RO9464B | 450 ns | 100 mA | NA |
    | RO9464C | 300 ns | 100 mA | NA |
    | RO9464D | 200 ns | 100 mA | NA |
    | RO9464AB | 450 ns | 100 mA | 12 mA |
    | RO9464AC | 300 ns | 100 mA | 12 mA |
    | RO9464AD | 200 ns | 100 mA | 12 mA |

[^5]:    **Capacitance is periodically sampled and is not $100 \%$ tested.
    NOTES:

    1. Measured with device selected and outputs unloaded.
    2. Applies to " $A$ " versions only.
    3. Applies to non " $A$ " versions only.
    4. Output low impedance delay ( $t_{L z}$ ) is measured from $\overline{C E}$ and $\overline{O E}$ going low and CS going active, whichever occurs last.
    5. Output high impedance delay ( $t_{H Z}$ ) is measured from either $\overline{C E}$ or $\overline{O E}$ going high or CS going inactive, whichever occurs first.
    6. Power Up Time ( $t_{\text {PU }}$ ) is not additive to Chip Enable Access Time ( $t_{\text {ACE }}$ ).
[^6]:    * If the op-code is 00000 the key has no internal function but KPD will go low when it is processed.

[^7]:    **Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.

[^8]:    **Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages

[^9]:    * Exceeding these ratıngs could cause permanent damage to the device. This is a stress rating only and functional operation of this device at these conditions is not implied-operatıng ranges are specified in Standard Conditions Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Data labeled "typical" is presented for design guidance only and is not guaranteed.

[^10]:    ** Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages
    NOTES $1 T_{S}$ is for powered or unpowered storage
    $2 \mathrm{~N}_{\mathrm{w}}\left(=10^{4}\right)$ is a maximum for data retention times greater than 10 years. Beyond $10^{4}$ reprogramming cycles, there is a gradual, logarithmic reduction in retention time with 1 year being a typical value after $10^{5}$ cycles.

[^11]:    ** Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages
    NOTE 1: $T_{s}$ is for powered or unpowered storage
    NOTE 2; $\mathrm{N}_{\mathrm{w}}\left(=10^{4}\right)$ is a maximum for data retention times greater than 10 years. Beyond $10^{4}$ reprogramming cycles, there is a gradual, logarithmic reduction in retention time with 1 year being a typical value after $10^{5}$ cycles.

[^12]:    **Typıcal values are at $+25^{\circ} \mathrm{C}$ and nominal voltages

[^13]:    **Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.

[^14]:    ** Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.

[^15]:    ** Typical values are at $+70^{\circ} \mathrm{C}$ and nominal voltages.

[^16]:    "Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.
    NOTE: The Bus Data ReaDY(BDRDY) line is sampled during time period TSI after a BAR or ADAR bus control signal. BDRDY must go low requesting a wait state 50 ns before the end of TS1 and remain low for 50 ns minimum. BDRDY may go high asynchronously. In response to BDRDY, the CPU will extend bus cycles by adding additional microcycles up to a maximum of $40 \mu \mathrm{sec}$ duration.

[^17]:    ** Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.
    NOTES: 1 . Voltages below -0.3 volts should be current limited to 1 mA .
    2. All tristated when Chip $\overline{\text { Select }}=V_{C C}$ R.G.B. outputs also tristated when displaying picture and not mixed.
    3. Picture/Text matched in mix mode only.

[^18]:    ** Typical values are at $+25^{\circ} \mathrm{C}$ and nominal voltages.

[^19]:    **At $25^{\circ} \mathrm{C}$ \& $\mathrm{V} \mathrm{cc}=6 \mathrm{~V}$

[^20]:    **Typical values are at $+25^{\circ} \mathrm{C}$ and nomınal voltages

